

MCF52259 ColdFire[®] Integrated Microcontroller Reference Manual

Devices Supported:

MCF52252 MCF52254 MCF52255 MCF52256 MCF52258 MCF52259

Document Number: MCF52259RM Rev. 4 3/2011



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About This Book

The primary objective of this reference manual is to define the processor for software and hardware developers. The information in this book is subject to change without notice, as described in the disclaimers on the title page. As with any technical documentation, the reader must use the most recent version of the documentation.

To locate any published errata or updates for this document, refer to the world-wide web at http://www.freescale.com/coldfire.

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Audience

This manual is intended for system software and hardware developers and applications programmers who want to develop products with this ColdFire processor. It is assumed that the reader understands operating systems, microprocessor system design, basic principles of software and hardware, and basic details of the ColdFire® architecture.

Suggested Reading

This section lists additional reading that provides background for the information in this manual as well as general information about ColdFire architecture.

General Information

Useful information about the ColdFire architecture and computer architecture in general:

- ColdFire Programmers Reference Manual (MCF5200PRM/AD)
- Using Microprocessors and Microcomputers: The Motorola Family, William C. Wray, Ross Bannatyne, Joseph D. Greenfield
- Computer Architecture: A Quantitative Approach, Second Edition, by John L. Hennessy and David A. Patterson.
- Computer Organization and Design: The Hardware/Software Interface, Second Edition, David A. Patterson and John L. Hennessy.

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ColdFire Documentation

ColdFire documentation is available from the sources listed on the back cover of this manual, as well as our web site, http://www.freescale.com/coldfire.

- Reference manuals These books provide details about individual ColdFire implementations and are intended to be used in conjunction with the *ColdFire Programmers Reference Manual*.
- Data sheets Data sheets provide specific data regarding pin-out diagrams, bus timing, signal behavior, and AC, DC, and thermal characteristics, as well as other design considerations.
- Product briefs Each device has a product brief that provides an overview of its s. This document is roughly equivalent to the overview (Chapter 1) of an device's reference manual.
- Application notes These short documents address specific design issues useful to programmers and engineers working with Freescale Semiconductor processors.

Additional literature is published as new processors become available. For a current list of ColdFire documentation, refer to http://www.freescale.com/coldfire.

Conventions

This document uses the following notational conventions:

cleared/set When a bit takes the value zero, it is said to be cleared; when it takes a value of

one, it is said to be set.

MNEMONICS In text, instruction mnemonics are shown in uppercase.

mnemonics In code and tables, instruction mnemonics are shown in lowercase.

italics Italics indicate variable command parameters.

Book titles in text are set in italics.

0x0 Prefix to denote hexadecimal number

0b0 Prefix to denote binary number

REG[FIELD] Abbreviations for registers are shown in uppercase. Specific bits, fields, or ranges

appear in brackets. For example, RAMBAR[BA] identifies the base address field

in the RAM base address register.

nibble A 4-bit data unit
byte An 8-bit data unit
word A 16-bit data unit
longword A 32-bit data unit

x In some contexts, such as signal encodings, x indicates a don't care.

n Used to express an undefined numerical value

NOT logical operator
 & AND logical operator
 OR logical operator

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¹The only exceptions to this appear in the discussion of serial communication modules that support variable-length data transmission units. To simplify the discussion these units are referred to as words regardless of length.



| Field concatenation operator

OVERBAR An overbar indicates that a signal is active-low.

Register Figure Conventions

This document uses the following conventions for the register reset values:

Undefined at reset.Unaffected by reset.

[signal_name] Reset value is determined by the polarity of the indicated signal.

The following register fields are used:

| R 0 W | Indicates a reserved bit field in a memory-mapped register. These bits are always read as zeros. |
|----------------------|--|
| R 1 W | Indicates a reserved bit field in a memory-mapped register. These bits are always read as ones. |
| R FIELDNAME | Indicates a read/write bit. |
| R FIELDNAME W | Indicates a read-only bit field in a memory-mapped register. |
| R W FIELDNAME | Indicates a write-only bit field in a memory-mapped register. |
| R FIELDNAME W w1c | Write 1 to clear: indicates that writing a 1 to this bit field clears it. |
| R 0 W FIELDNAME | Indicates a self-clearing bit. |

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Chapter 1 Overview

1.1 Introduction

This chapter provides an overview of the major features and functional components of the MCF52259 family of microcontrollers. The differences between these parts are summarized in Table 1-1. This document is written from the perspective of the MCF52259.

The MCF52259 represents a family of highly integrated 32-bit reduced instruction set computing (RISC) microcontrollers based on the V2 ColdFire® microarchitecture. Featuring 64 Kbytes of internal SRAM and 512 Kbytes of flash memory, four 32-bit timers with DMA request capability, a 4-channel DMA controller, two I²CTM modules, a Fast Ethernet Controller, an external Mini-FlexBus interface, an Enhanced Multiply Accumulate Unit, a Crytographic Acceleration Unit, 3 UARTs and a queued SPI, the family has been designed for general-purpose industrial control applications.

This 32-bit device is based on the Version 2 (V2) ColdFire reduced instruction set computing (RISC) core with an enhanced multiply-accumulate unit (EMAC) and hardware divider providing 76 Dhrystone 2.1 MIPS at a frequency up to 80 MHz. On-chip modules include the following:

- V2 ColdFire core with enhanced multiply-accumulate unit (EMAC)
- 64 Kbytes of internal SRAM
- 512 Kbytes of on-chip flash memory
- Three universal asynchronous receiver/transmitters (UARTs)
- Two inter-integrated circuit (I²C) bus controller
- 12-bit analog-to-digital converter (ADC)
- Queued serial peripheral interface (QSPI) module
- Four-channel, 32-bit direct memory access (DMA) controller
- Four 32-bit general purpose timers with optional DMA support
- Two 16-bit periodic interrupt timers (PITs)
- Programmable software watchdog timer
- Two interrupt controllers capable of handling up to 128 interrupt sources
- Clock module with 8 MHz on-chip relaxation oscillator and integrated phase-locked loop (PLL)
- External Mini-FlexBus interface
- Fast Ethernet Controller
- Cryptographic Acceleration Unit

To locate any published errata or updates for this document, refer to the ColdFire products website at http://www.freescale.com/coldfire.



1.2 MCF52259 Family Configurations

Table 1-1. MCF52259 Family Configurations

| Module | 52252 | 52254 | 52255 | 52256 | 52258 | 52259 |
|---|------------|------------------------|------------------------------|------------------------|-----------------------|------------------------------|
| Version 2 ColdFire Core with eMAC (Enhanced multiply-accumulate unit) and CAU (Cryptographic acceleration unit) | • | • | • | • | • | • |
| System Clock | up to 66 c | or 80 MHz ¹ | up to 80 MHz ¹ | up to 66 o | r 80 MHz ¹ | up to 80 MHz ¹ |
| Performance (Dhrystone 2.1 MIPS) | | | up to 6 | 63 or 76 | | • |
| Flash | 256 KB | 512 KB | 512 KB | 256 KB | 512 KB | 512 KB |
| Static RAM (SRAM) | 32 KB | 64 KB | 64 KB | 32 / 64 KB | 64 KB | 64 KB |
| Two Interrupt Controllers (INTC) | • | • | • | • | • | • |
| Fast Analog-to-Digital Converter (ADC) | • | • | • | • | • | • |
| USB On-The-Go (USB OTG) | • | • | • | • | • | • |
| Mini-FlexBus external bus interface | _ | _ | _ | • | • | • |
| Fast Ethernet Controller (FEC) | • | • | • | • | • | • |
| Random Number Generator and Cryptographic Acceleration Unit (CAU) | _ | _ | • | _ | _ | • |
| FlexCAN 2.0B Module | Varies | Varies | • | Varies | Varies | • |
| Four-channel Direct-Memory Access (DMA) | • | • | • | • | • | • |
| Software Watchdog Timer (WDT) | • | • | • | • | • | • |
| Secondary Watchdog Timer | • | • | • | • | • | • |
| Two-channel Periodic Interrupt Timer (PIT) | 2 | 2 | 2 | 2 | 2 | 2 |
| Four-Channel General Purpose Timer (GPT) | • | • | • | • | • | • |
| 32-bit DMA Timers | 4 | 4 | 4 | 4 | 4 | 4 |
| QSPI | • | • | • | • | • | • |
| UART(s) | 3 | 3 | 3 | 3 | 3 | 3 |
| I ² C | 2 | 2 | 2 | 2 | 2 | 2 |
| Eight/Four-channel 8/16-bit PWM Timer | • | • | • | • | • | • |
| General Purpose I/O Module (GPIO) | • | • | • | • | • | • |
| Chip Configuration and Reset Controller Module | • | • | • | • | • | • |
| Background Debug Mode (BDM) | • | • | • | • | • | • |
| JTAG - IEEE 1149.1 Test Access Port | • | • | • | • | • | • |
| Package | | 100 LQFP | • | 144 LQFP or 144 MAPBGA | | |

¹ 66 MHz = 63 MIPS; 80 MHz = 76 MIPS

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Overview

1.3 Block Diagram

The superset device in the MCF52259 family comes in a 144-lead low-profile quad flat package (LQFP) or a 144-lead molded-array process ball-grid array (MAPBGA). Figure 1-1 shows a top-level block diagram of the MCF52259.

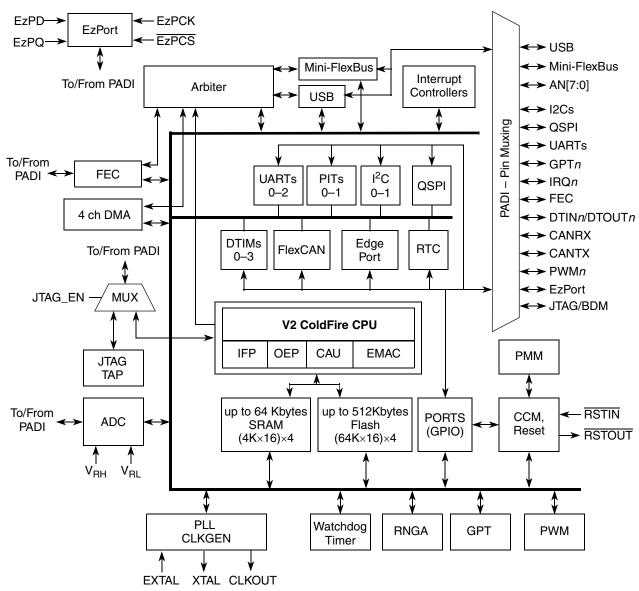


Figure 1-1. MCF52259 Block Diagram

1.4 Part Numbers and Packaging

The table below summarizes the features of the product family. Several speed/package options are available to match cost- or performance-sensitive applications.

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| Freescale Part Number | FlexCAN | Encryption | Speed (MHz) | Flash (Kbytes) | SRAM (Kbytes) | Package | Temp range (°C) | |
|--------------------------|---------|------------|----------------|-------------------|------------------|-------------|--------------------|----------|
| MCF52252AF80 | _ | _ | 80 | 256 | 32 | 100 LQFP | 0 to +70 | |
| MCF52252CAF66 | • | _ | 66 | 250 | 32 | 100 LQIT | -40 to +85 | |
| MCF52254AF80 | _ | _ | 80 | 512 | 64 | 100 LQFP | 0 to +70 | |
| MCF52254CAF66 | • | _ | 66 | | 04 | 100 LQFF | -40 to +85 | |
| MCF52255CAF80 | • | • | 80 | 512 | 64 | 100 LQFP | -40 to +85 | |
| MCF52256AG80 | _ | _ | 80 | | | 32 | 144 LQFP | 0 to +70 |
| MCF52256CAG66 | • | _ | 66 | 256 | 64 | 144 LQFF | -40 to +85 | |
| MCF52256CVN66 | • | _ | 66 | 250 | 64 | 144 MAPBGA | -40 to +85 | |
| MCF52256VN80 | _ | _ | 80 | | 32 | 144 MAI DOA | 0 to +70 | |
| MCF52258AG80 | _ | _ | 80 | 512 | 64 | 144 LQFP | 0 to +70 | |
| MCF52258CAG66 | • | _ | 66 | | | 144 LQFF | -40 to +85 | |
| MCF52258CVN66 | • | _ | 66 | | | 144 MAPBGA | -40 to +85 | |
| MCF52258VN80 | _ | _ | 80 | | | 144 MAPBGA | 0 to +70 | |
| MCF52259CAG80 | • | • | 80 | 512 | 64 | 144 LQFP | -40 to +85 | |
| MCF52259CVN80 | • | • | 00 | 312 | 04 | 144 MAPBGA | -40 to +85 | |

Table 1-2. Orderable Part Number Summary

1.5 Features

The MCF52259 family includes the following features:

- Version 2 ColdFire variable-length RISC processor core
 - Static operation
 - 32-bit address and data paths on-chip
 - Up to 80 MHz processor core frequency
 - 40 MHz or 33 MHz peripheral bus frequency
 - Sixteen general-purpose, 32-bit data and address registers
 - Implements ColdFire ISA_A with extensions to support the user stack pointer register and four new instructions for improved bit processing (ISA_A+)
 - Enhanced Multiply-Accumulate (EMAC) unit with four 32-bit accumulators to support $16\times16 \rightarrow 32$ or $32\times32 \rightarrow 48$ operations
 - Cryptographic Acceleration Unit (CAU)
 - Tightly-coupled coprocessor to accelerate software-based encryption and message digest functions
 - Support for DES, 3DES, AES, MD5, and SHA-1 algorithms
- System debug support
 - Real-time trace for determining dynamic execution path

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- Background debug mode (BDM) for in-circuit debugging (DEBUG B+)
- Real-time debug support, with six hardware breakpoints (4 PC, 1 address and 1 data) configurable into a 1- or 2-level trigger

· On-chip memories

- Up to 64-Kbyte dual-ported SRAM on CPU internal bus, supporting core, DMA, and USB access with standby power supply support for the first 16 Kbytes
- Up to 512 Kbytes of interleaved flash memory supporting 2-1-1-1 accesses

Power management

- Fully static operation with processor sleep and whole chip stop modes
- Rapid response to interrupts from the low-power sleep mode (wake-up feature)
- Clock enable/disable for each peripheral when not used (except backup watchdog timer)
- Software controlled disable of external clock output for low-power consumption

FlexCAN 2.0B module

- Based on and includes all existing features of the Freescale TouCAN module
- Full implementation of the CAN protocol specification version 2.0B
 - Standard data and remote frames (up to 109 bits long)
 - Extended data and remote frames (up to 127 bits long)
 - Zero to eight bytes data length
 - Programmable bit rate up to 1 Mbit/sec
- Flexible message buffers (MBs), totalling up to 16 message buffers of 0–8 byte data length each, configurable as Rx or Tx, all supporting standard and extended messages
- Unused MB space can be used as general purpose RAM space
- Listen-only mode capability
- Content-related addressing
- No read/write semaphores
- Three programmable mask registers: global for MBs 0–13, special for MB14, and special for MB15
- Programmable transmit-first scheme: lowest ID or lowest buffer number
- Time stamp based on 16-bit free-running timer
- Global network time, synchronized by a specific message
- Maskable interrupts
- Universal Serial Bus On-The-Go (USB OTG) dual-mode host and device controller
 - Full-speed / low-speed host controller
 - USB 1.1 and 2.0 compliant full-speed / low speed device controller
 - 16 bidirectional end points
 - DMA or FIFO data stream interfaces
 - Low power consumption
 - OTG protocol logic

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- Fast Ethernet controller (FEC)
 - 10/100 BaseT/TX capability, half duplex or full duplex
 - On-chip transmit and receive FIFOs
 - Built-in dedicated DMA controller
 - Memory-based flexible descriptor rings
- Mini-FlexBus
 - External bus interface available on 144 pin packages
 - Supports glueless interface with 8-bit ROM/flash/SRAM/simple slave peripherals. Can address up to 2 Mbytes of addresses
 - 2 chip selects (FB CS[1:0])
 - Non-multiplexed mode: 8-bit dedicated data bus, 20-bit address bus
 - Multiplexed mode: 16-bit data and 20-bit address bus
 - FB CLK output to support synchronous memories
 - Programmable base address, size, and wait states to support slow peripherals
 - Operates at up to 40 MHz (bus clock) in 1:2 mode or up to 80 MHz (core clock) in 1:1 mode
- Three universal asynchronous/synchronous receiver transmitters (UARTs)
 - 16-bit divider for clock generation
 - Interrupt control logic with maskable interrupts
 - DMA support
 - Data formats can be 5, 6, 7 or 8 bits with even, odd, or no parity
 - Up to two stop bits in 1/16 increments
 - Error-detection capabilities
 - Modem support includes request-to-send (RTS) and clear-to-send (CTS) lines for two UARTs
 - Transmit and receive FIFO buffers
- Two I²C modules
 - Interchip bus interface for EEPROMs, LCD controllers, A/D converters, and keypads
 - Fully compatible with industry-standard I²C bus
 - Master and slave modes support multiple masters
 - Automatic interrupt generation with programmable level
- Queued serial peripheral interface (QSPI)
 - Full-duplex, three-wire synchronous transfers
 - Up to three chip selects available
 - Master mode operation only
 - Programmable bit rates up to half the CPU clock frequency
 - Up to 16 pre-programmed transfers
- Fast analog-to-digital converter (ADC)
 - Eight analog input channels

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Overview

- 12-bit resolution
- Minimum 1.125 μs conversion time
- Simultaneous sampling of two channels for motor control applications
- Single-scan or continuous operation
- Optional interrupts on conversion complete, zero crossing (sign change), or under/over low/high limit
- Unused analog channels can be used as digital I/O
- Four 32-bit timers with DMA support
 - 12.5 ns resolution at 80 MHz
 - Programmable sources for clock input, including an external clock option
 - Programmable prescaler
 - Input capture capability with programmable trigger edge on input pin
 - Output compare with programmable mode for the output pin
 - Free run and restart modes
 - Maskable interrupts on input capture or output compare
 - DMA trigger capability on input capture or output compare
- Four-channel general purpose timer
 - 16-bit architecture
 - Programmable prescaler
 - Output pulse-widths variable from microseconds to seconds
 - Single 16-bit input pulse accumulator
 - Toggle-on-overflow feature for pulse-width modulator (PWM) generation
 - One dual-mode pulse accumulation channel
- Pulse-width modulation timer
 - Support for PCM mode (resulting in superior signal quality compared to conventional PWM)
 - Operates as eight channels with 8-bit resolution or four channels with 16-bit resolution
 - Programmable period and duty cycle
 - Programmable enable/disable for each channel
 - Software selectable polarity for each channel
 - Period and duty cycle are double buffered. Change takes effect when the end of the current period is reached (PWM counter reaches zero) or when the channel is disabled.
 - Programmable center or left aligned outputs on individual channels
 - Four clock sources (A, B, SA, and SB) provide for a wide range of frequencies
 - Emergency shutdown
- Two periodic interrupt timers (PITs)
 - 16-bit counter
 - Selectable as free running or count down
- Real-Time Clock (RTC)



- Maintains system time-of-day clock
- Provides stopwatch and alarm interrupt functions
- Standby power supply (Vstby) keeps the RTC running when the system is shut down
- Software watchdog timer
 - 32-bit counter
 - Low-power mode support
- Backup watchdog timer (BWT)
 - Independent timer that can be used to help software recover from runaway code
 - 16-bit counter
 - Low-power mode support
- Clock generation features
 - Crystal, on-chip trimmed relaxation oscillator, or external oscillator reference options
 - Trimmed relaxation oscillator
 - Pre-divider capable of dividing the clock source frequency into the PLL reference frequency range
 - System can be clocked from PLL or directly from crystal oscillator or relaxation oscillator
 - Low power modes supported
 - 2^n ($0 \le n \le 15$) low-power divider for extremely low frequency operation
- Interrupt controller
 - Uniquely programmable vectors for all interrupt sources
 - Fully programmable level and priority for all peripheral interrupt sources
 - Seven external interrupt signals with fixed level and priority
 - Unique vector number for each interrupt source
 - Ability to mask any individual interrupt source or all interrupt sources (global mask-all)
 - Support for hardware and software interrupt acknowledge (IACK) cycles
 - Combinatorial path to provide wake-up from low-power modes
- DMA controller
 - Four fully programmable channels
 - Dual-address transfer support with 8-, 16-, and 32-bit data capability, along with support for 16-byte (4×32-bit) burst transfers
 - Source/destination address pointers that can increment or remain constant
 - 24-bit byte transfer counter per channel
 - Auto-alignment transfers supported for efficient block movement
 - Bursting and cycle-steal support
 - Software-programmable DMA requests for the UARTs (3) and 32-bit timers (4)
 - Channel linking support
- Reset
 - Separate reset in and reset out signals

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Overview

- Seven sources of reset:
 - Power-on reset (POR)
 - External
 - Software
 - Watchdog
 - Loss of clock / loss of lock
 - Low-voltage detection (LVD)
 - JTAG
- Status flag indication of source of last reset
- Chip configuration module (CCM)
 - System configuration during reset
 - Selects one of six clock modes
 - Configures output pad drive strength
 - Unique part identification number and part revision number
- General purpose I/O interface
 - Up to 56 bits of general purpose I/O on 100-pin package
 - Up to 96 bits of general purpose I/O on 144-pin package
 - Bit manipulation supported via set/clear functions
 - Programmable drive strengths
 - Unused peripheral pins may be used as extra GPIO
- JTAG support for system level board testing

1.5.1 V2 Core Overview

The version 2 ColdFire processor core is comprised of two separate pipelines decoupled by an instruction buffer. The two-stage instruction fetch pipeline (IFP) is responsible for instruction-address generation and instruction fetch. The instruction buffer is a first-in-first-out (FIFO) buffer that holds prefetched instructions awaiting execution in the operand execution pipeline (OEP). The OEP includes two pipeline stages. The first stage decodes instructions and selects operands (DSOC); the second stage (AGEX) performs instruction execution and calculates operand effective addresses, if needed.

The V2 core implements the ColdFire instruction set architecture revision A+ with support for a separate user stack pointer register and four new instructions to assist in bit processing. Additionally, the core includes the enhanced multiply-accumulate (EMAC) unit for improved signal processing capabilities. The EMAC implements a three-stage arithmetic pipeline, optimized for 32x32 bit operations, with support for four 48-bit accumulators. Supported operands include 16- and 32-bit signed and unsigned integers, signed fractional operands, and a complete set of instructions to process these data types. The EMAC provides support for execution of DSP operations within the context of a single processor at a minimal hardware cost.



1.5.2 Integrated Debug Module

The ColdFire processor core debug interface is provided to support system debugging with low-cost debug and emulator development tools. Through a standard debug interface, access to debug information and real-time tracing capability is provided on 144-lead packages. This allows the processor and system to be debugged at full speed without the need for costly in-circuit emulators.

The on-chip breakpoint resources include a total of nine programmable 32-bit registers: an address and an address mask register, a data and a data mask register, four PC registers, and one PC mask register. These registers can be accessed through the dedicated debug serial communication channel or from the processor's supervisor mode programming model. The breakpoint registers can be configured to generate triggers by combining the address, data, and PC conditions in a variety of single- or dual-level definitions. The trigger event can be programmed to generate a processor halt or initiate a debug interrupt exception. This device implements revision B+ of the ColdFire Debug Architecture.

The processor's interrupt servicing options during emulator mode allow real-time critical interrupt service routines to be serviced while processing a debug interrupt event. This ensures the system continues to operate even during debugging.

To support program trace, the V2 debug module provides processor status (PST[3:0]) and debug data (DDATA[3:0]) ports. These buses and the PSTCLK output provide execution status, captured operand data, and branch target addresses defining processor activity at the CPU's clock rate. The device includes a new debug signal, ALLPST. This signal is the logical AND of the processor status (PST[3:0]) signals and is useful for detecting when the processor is in a halted state (PST[3:0] = 1111).

The full debug/trace interface is available only on the 144-pin packages. However, every product features the dedicated debug serial communication channel (DSI, DSO, DSCLK) and the ALLPST signal.

1.5.3 JTAG

The processor supports circuit board test strategies based on the Test Technology Committee of IEEE and the Joint Test Action Group (JTAG). The test logic includes a test access port (TAP) consisting of a 16-state controller, an instruction register, and three test registers (a 1-bit bypass register, a boundary-scan register, and a 32-bit ID register). The boundary scan register links the device's pins into one shift register. Test logic, implemented using static logic design, is independent of the device system logic.

The device implementation can:

- Perform boundary-scan operations to test circuit board electrical continuity
- Sample system pins during operation and transparently shift out the result in the boundary scan register
- Bypass the device for a given circuit board test by effectively reducing the boundary-scan register to a single bit
- Disable the output drive to pins during circuit-board testing
- Drive output pins to stable levels

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Overview

1.5.4 On-Chip Memories

1.5.4.1 SRAM

The dual-ported SRAM module provides a general-purpose 64-Kbyte memory block that the ColdFire core can access in a single cycle. The location of the memory block can be set to any 64-Kbyte boundary within the 4-Gbyte address space. This memory is ideal for storing critical code or data structures and for use as the system stack. Because the SRAM module is physically connected to the processor's high-speed local bus, it can quickly service core-initiated accesses or memory-referencing commands from the debug module.

The SRAM module is also accessible by the DMA, FEC, and USB. The dual-ported nature of the SRAM makes it ideal for implementing applications with double-buffer schemes, where the processor and a DMA device operate in alternate regions of the SRAM to maximize system performance.

1.5.4.2 Flash Memory

The ColdFire flash module (CFM) is a non-volatile memory (NVM) module that connects to the processor's high-speed local bus. The CFM is constructed with four banks of 64-Kbyte×16-bit flash memory arrays to generate 512 Kbytes of 32-bit flash memory. These electrically erasable and programmable arrays serve as non-volatile program and data memory. The flash memory is ideal for program and data storage for single-chip applications, allowing for field reprogramming without requiring an external high voltage source. The CFM interfaces to the ColdFire core through an optimized read-only memory controller that supports interleaved accesses from the 2-cycle flash memory arrays. A backdoor mapping of the flash memory is used for all program, erase, and verify operations, as well as providing a read datapath for the DMA. Flash memory may also be programmed via the EzPort, which is a serial flash memory programming interface that allows the flash memory to be read, erased and programmed by an external controller in a format compatible with most SPI bus flash memory chips.

1.5.5 Cryptographic Acceleration Unit

The MCF52235 device incorporates two hardware accelerators for cryptographic functions. First, the CAU is a coprocessor tightly-coupled to the V2 ColdFire core that implements a set of specialized operations to increase the throughput of software-based encryption and message digest functions, specifically the DES, 3DES, AES, MD5 and SHA-1 algorithms. Second, a random number generator provides FIPS-140 compliant 32-bit values to security processing routines. Both modules supply critical acceleration to software-based cryptographic algorithms at a minimal hardware cost.

1.5.6 Power Management

The device incorporates several low-power modes of operation entered under program control and exited by several external trigger events. An integrated power-on reset (POR) circuit monitors the input supply and forces an MCU reset as the supply voltage rises. The low voltage detector (LVD) monitors the supply voltage and is configurable to force a reset or interrupt condition if it falls below the LVD trip point. The RAM standby switch provides power to RAM when the supply voltage to the chip falls below the standby battery voltage.

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1.5.7 FlexCAN

The FlexCAN module is a communication controller implementing version 2.0 of the CAN protocol parts A and B. The CAN protocol can be used as an industrial control serial data bus, meeting the specific requirements of reliable operation in a harsh EMI environment with high bandwidth. This instantiation of FlexCAN has 16 message buffers.

1.5.8 Mini-FlexBus

A multi-function external bus interface called the Mini-FlexBus is provided on the device with basic functionality of interfacing to slave-only devices with a maximum slave bus frequency up to 40 MHz in 1:2 mode and 80 MHz in 1:1 mode. It can be directly connected to the following asynchronous or synchronous devices with little or no additional circuitry:

- External ROMs
- Flash memories
- Programmable logic devices
- Other simple target (slave) devices

The Mini-FlexBus is a subset of the FlexBus module found on higher-end ColdFire microprocessors. The Mini-FlexBus minimizes package pin-outs while maintaining a high level of configurability and functionality.

1.5.9 USB On-The-Go Controller

The device includes a Universal Serial Bus On-The-Go (USB OTG) dual-mode controller. USB is a popular standard for connecting peripherals and portable consumer electronic devices such as digital cameras and handheld computers to host PCs. The OTG supplement to the USB specification extends USB to peer-to-peer application, enabling devices to connect directly to each other without the need for a PC. The dual-mode controller on the device can act as a USB OTG host and as a USB device. It also supports full-speed and low-speed modes.

1.5.10 Fast Ethernet Controller (FEC)

The Ethernet media access controller (MAC) supports 10 and 100 Mbps Ethernet/IEEE 802.3 networks. An external transceiver interface and transceiver function are required to complete the interface to the media. The FEC supports three different standard MAC-PHY (physical) interfaces for connection to an external Ethernet transceiver. The FECs supports the 10/100 Mbps MII, and the 10 Mbps-only 7-wire interface.

1.5.11 **UARTs**

The device has three full-duplex UARTs that function independently. The three UARTs can be clocked by the system bus clock, eliminating the need for an external clock source. On smaller packages, the third UART is multiplexed with other digital I/O functions.

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1.5.12 I²C Bus

The processor includes two I²C modules. The I²C bus is an industry-standard, two-wire, bidirectional serial bus that provides a simple, efficient method of data exchange and minimizes the interconnection between devices. This bus is suitable for applications requiring occasional communications over a short distance between many devices.

1.5.13 QSPI

The queued serial peripheral interface (QSPI) provides a synchronous serial peripheral interface with queued transfer capability. It allows up to 16 transfers to be queued at once, minimizing the need for CPU intervention between transfers.

1.5.14 Fast ADC

The fast ADC consists of an eight-channel input select multiplexer and two independent sample and hold (S/H) circuits feeding separate 12-bit ADCs. The two separate converters store their results in accessible buffers for further processing. Signals on the SYNCA and SYNCB pins initiate an ADC conversion.

The ADC can be configured to perform a single scan and halt, a scan when triggered, or a programmed scan sequence repeatedly until manually stopped.

The ADC can be configured for sequential or simultaneous conversion. When configured for sequential conversions, up to eight channels can be sampled and stored in any order specified by the channel list register. Both ADCs may be required during a scan, depending on the inputs to be sampled.

During a simultaneous conversion, both S/H circuits are used to capture two different channels at the same time. This configuration requires that a single channel may not be sampled by both S/H circuits simultaneously.

Optional interrupts can be generated at the end of the scan sequence if a channel is out of range (measures below the low threshold limit or above the high threshold limit set in the limit registers) or at several different zero crossing conditions.

1.5.15 DMA Timers (DTIM0-DTIM3)

There are four independent, DMA transfer capable 32-bit timers (DTIM0, DTIM1, DTIM2, and DTIM3) on the device. Each module incorporates a 32-bit timer with a separate register set for configuration and control. The timers can be configured to operate from the system clock or from an external clock source using one of the DTIN*n* signals. If the system clock is selected, it can be divided by 16 or 1. The input clock is further divided by a user-programmable 8-bit prescaler that clocks the actual timer counter register (TCR*n*). Each of these timers can be configured for input capture or reference (output) compare mode. Timer events may optionally cause interrupt requests or DMA transfers.



General Purpose Timer (GPT) 1.5.16

The general purpose timer (GPT) is a four-channel timer module consisting of a 16-bit programmable counter driven by a seven-stage programmable prescaler. Each of the four channels can be configured for input capture or output compare. Additionally, channel three, can be configured as a pulse accumulator.

A timer overflow function allows software to extend the timing capability of the system beyond the 16-bit range of the counter. The input capture and output compare functions allow simultaneous input waveform measurements and output waveform generation. The input capture function can capture the time of a selected transition edge. The output compare function can generate output waveforms and timer software delays. The 16-bit pulse accumulator can operate as a simple event counter or a gated time accumulator.

1.5.17 Periodic Interrupt Timers (PIT0 and PIT1)

The two periodic interrupt timers (PIT0 and PIT1) are 16-bit timers that provide interrupts at regular intervals with minimal processor intervention. Each timer can count down from the value written in its PIT modulus register or it can be a free-running down-counter.

Real-Time Clock (RTC) 1.5.18

The Real-Time Clock (RTC) module maintains the system (time-of-day) clock and provides stopwatch, alarm, and interrupt functions. It includes full clock features: seconds, minutes, hours, days and supports a host of time-of-day interrupt functions along with an alarm interrupt.

1.5.19 **Pulse-Width Modulation (PWM) Timers**

The device has an 8-channel, 8-bit PWM timer. Each channel has a programmable period and duty cycle as well as a dedicated counter. Each of the modulators can create independent continuous waveforms with software-selectable duty rates from 0% to 100%. The timer supports PCM mode, which results in superior signal quality when compared to that of a conventional PWM. The PWM outputs have programmable polarity, and can be programmed as left aligned outputs or center aligned outputs. For higher period and duty cycle resolution, each pair of adjacent channels ([7:6], [5:4], [3:2], and [1:0]) can be concatenated to form a single 16-bit channel. The module can, therefore, be configured to support 8/0, 6/1, 4/2, 2/3, or 0/4 8-/16-bit channels.

1.5.20 **Software Watchdog Timer**

The watchdog timer is a 32-bit timer that facilitates recovery from runaway code. The watchdog counter is a free-running down-counter that generates a reset on underflow. To prevent a reset, software must periodically restart the countdown.

1.5.21 **Backup Watchdog Timer**

The backup watchdog timer is an independent 16-bit timer that, like the software watchdog timer, facilitates recovery from runaway code. This timer is a free-running down-counter that generates a reset

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on underflow. To prevent a reset, software must periodically restart the countdown. The backup watchdog timer can be clocked by either the relaxation oscillator or the system clock.

1.5.22 Phase-Locked Loop (PLL)

The clock module contains a crystal oscillator, 8 MHz on-chip relaxation oscillator (OCO), phase-locked loop (PLL), reduced frequency divider (RFD), low-power divider status/control registers, and control logic. To improve noise immunity, the PLL, crystal oscillator, and relaxation oscillator have their own power supply inputs: VDDPLL and VSSPLL. All other circuits are powered by the normal supply pins, VDD and VSS.

1.5.23 Interrupt Controllers (INTC*n*)

The device has two interrupt controllers that supports up to 128 interrupt sources. There are 56 programmable sources, 49 of which are assigned to unique peripheral interrupt requests. The remaining seven sources are unassigned and may be used for software interrupt requests.

1.5.24 DMA Controller

The direct memory access (DMA) controller provides an efficient way to move blocks of data with minimal processor intervention. It has four channels that allow byte, word, longword, or 16-byte burst line transfers. These transfers are triggered by software explicitly setting a DCR*n*[START] bit or by the occurrence of certain UART or DMA timer events.

1.5.25 Reset

The reset controller determines the source of reset, asserts the appropriate reset signals to the system, and keeps track of what caused the last reset. There are seven sources of reset:

- External reset input
- Power-on reset (POR)
- Watchdog timer
- Phase locked-loop (PLL) loss of lock / loss of clock
- Software
- Low-voltage detector (LVD)
- JTAG

Control of the LVD and its associated reset and interrupt are managed by the reset controller. Other registers provide status flags indicating the last source of reset and a control bit for software assertion of the RSTO pin.

1.5.26 **GPIO**

Nearly all pins on the device have general purpose I/O capability and are grouped into 8-bit ports. Some ports do not use all eight bits. Each port has registers that configure, monitor, and control the port pin.



1.6 Memory Map Overview

Table 1-3. System Memory Map

| Base Address (Hex) | Size | Use |
|--------------------|------------|-----------------------------|
| 0x0000_0000 | 1G | On-Chip Flash/RAM Array1 |
| 0x4000_0000 | 64 bytes | System Control Module |
| 0x4000_0040 | 64 bytes | Reserved |
| 0x4000_0080 | 128 bytes | Mini-FlexBus |
| 0x4000_0100 | 16 bytes | DMA (Channel 0) |
| 0x4000_0110 | 16 bytes | DMA (Channel 1) |
| 0x4000_0120 | 16 bytes | DMA (Channel 2) |
| 0x4000_0130 | 16 bytes | DMA (Channel 3) |
| 0x4000_0140 | 196 bytes | Reserved |
| 0x4000_0200 | 64 bytes | UART0 |
| 0x4000_0240 | 64 bytes | UART1 |
| 0x4000_0280 | 64 bytes | UART2 |
| 0x4000_02C0 | 64 bytes | Reserved |
| 0x4000_0300 | 64 bytes | I2C0 |
| 0x4000_0340 | 64 bytes | QSPI |
| 0x4000_0380 | 64 bytes | I2C1 |
| 0x4000_03C0 | 64 bytes | Reserved |
| 0x4000_0400 | 64 bytes | TMR0 |
| 0x4000_0440 | 64 bytes | TMR1 |
| 0x4000_0480 | 64 bytes | TMR2 |
| 0x4000_04C0 | 64 bytes | TMR3 |
| 0x4000_0500 | 1792 bytes | Reserved |
| 0x4000_0c00 | 256 bytes | Interrupt Cntl |
| 0x4000_0d00 | 256 bytes | Interrupt Cntl 1 |
| 0x4000_0e00 | 256 bytes | Reserved |
| 0x4000_0f00 | 256 bytes | Global Interrupt Ack Cycles |
| 0x4000_1000 | 2048 bytes | FEC |
| 0x4000_1800 | 1M - 6K | Reserved |

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Overview

Table 1-3. System Memory Map (continued)

| Base Address (Hex) | Size | Use |
|--------------------|-----------------|---|
| 0x4010_0000 | 64K | Ports |
| 0x4011_0000 | 64K | CIM_IBO |
| 0x4012_0000 | 64K | Clocks (PLLMRBI) |
| 0x4013_0000 | 64K | Edge Port |
| 0x4014_0000 | 64K | Backup Watchdog Timer |
| 0x4015_0000 | 64K | Programmable Interval Timer 0 |
| 0x4016_0000 | 64K | Programmable Interval Timer 1 |
| 0x4017_0000 | 64K | Flexcan |
| 0x4018_0000 | 64K | RTC |
| 0x4019_0000 | 64K | ADC |
| 0x401a_0000 | 64K | Timer |
| 0x401b_0000 | 64K | PWM |
| 0x401c_0000 | 64K | USB-OTG |
| 0x401d_0000 | 64K | CFM (Flash) control registers |
| 0x401e_0000 | 64k | Reserved |
| 0x401f_0000 | 64K | RNGA |
| 0x4020_0000 | 64M - 2M | Reserved |
| 0x4400_0000 | 512K | CFM (Flash) memory for IPS reads and writes |
| 0x4402_0000 | 1G - 62M - 512K | Reserved |
| 0x8000_0000 | 2G | Mini-FlexBus |



Chapter 2 Signal Descriptions

2.1 Introduction

This chapter describes signals implemented on this device and includes an alphabetical listing of signals that characterizes each signal as an input or output, defines its state at reset, and identifies whether a pull-up resistor should be used.

NOTE

The terms assertion and negation are used to avoid confusion when dealing with a mixture of active-low and active-high signals. The term asserted indicates that a signal is active, independent of the voltage level. The term negated indicates that a signal is inactive.

Active-low signals, such as \overline{UCTS} and \overline{RSTI} , are indicated with an overbar.

2.2 Overview

Figure 2-1 shows the block diagram of the device with the signal interface.



Signal Descriptions

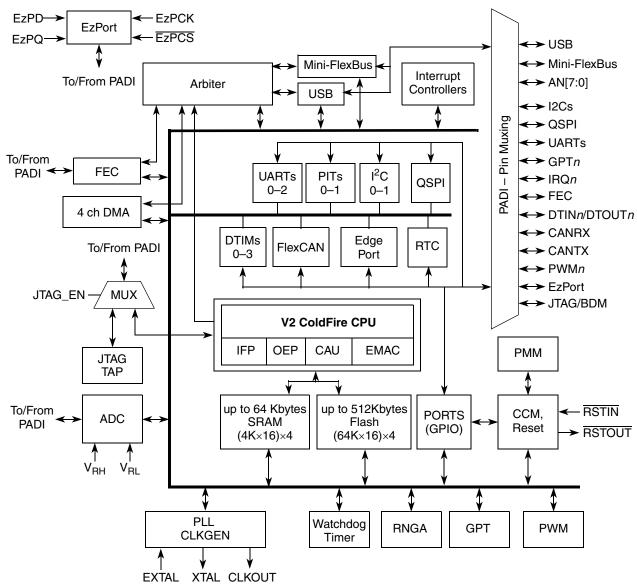


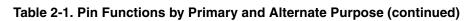
Figure 2-1. Block Diagram with Signal Interfaces

Figure 2-1 shows the pin functions by primary and alternate purpose. It also illustrates which packages contain each pin.

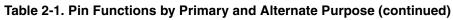
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| Pin Group | Primary Function | Secondary Function (Alt 1) | Tertiary Function (Alt 2) | Quaternary Function (GPIO) | Slew Rate | Drive Strength/Co ntrol ¹ | Pull-up/ Pull-down ² | Pin on 144 MAPBGA |
|------------|---------------------|----------------------------------|---------------------------------|----------------------------------|------------------|--|------------------------------------|---|
| ADC | AN[7:0] | _ | _ | PAN[7:0] | Low | Low | _ | L12, K10, K12, K11, K9, L9, M10, M9 |
| | VDDA | _ | _ | _ | N/A | N/A | _ | L11 |
| | VSSA | _ | _ | _ | N/A | N/A | _ | M12 |
| | VRH | _ | _ | _ | N/A | N/A | _ | L10 |
| | VRL | _ | _ | _ | N/A | N/A | _ | M11 |
| Clock | EXTAL | _ | _ | _ | N/A | N/A | _ | C12 |
| Generation | XTAL | _ | _ | _ | N/A | N/A | _ | D12 |
| | VDDPLL | _ | _ | _ | N/A | N/A | _ | C11 |
| | VSSPLL | _ | _ | _ | N/A | N/A | _ | D11 |
| RTC | RTC_EXTAL | _ | _ | _ | N/A | N/A | _ | D1 |
| | RTC_XTAL | _ | _ | _ | N/A | N/A | _ | E1 |
| Debug | ALLPST | _ | _ | _ | Low | High | _ | L3 |
| Data | DDATA[3:0] | _ | _ | PDD[7:4] | Low | High | _ | G9, H10, F11, F10 |
| | PST[3:0] | _ | _ | PDD[3:0] | Low | High | _ | F9, G10, G11, G12 |
| FEC | FEC_COL | _ | _ | PTI0 | PSRRH[0] | PDSRH[0] | _ | B11 |
| | FEC_CRS | _ | _ | PTI1 | PSRRH[1] | PDSRH[1] | _ | B12 |
| | FEC_RXCLK | _ | _ | PTI2 | PSRRH[2] | PDSRH[2] | _ | B8 |
| | FEC_RXD[3:0] | _ | _ | PTI[6:3] | PSRRH[6:3] | PDSRH[6:3] | _ | D7, C7, B7, A8 |
| | FEC_RXDV | _ | _ | PTI7 | PSRRH[7] | PDSRH[7] | _ | C8 |
| | FEC_RXER | _ | _ | PTJ0 | PSRRH[8] | PDSRH[8] | _ | A9 |
| | FEC_TXCLK | _ | _ | PTJ1 | PSRRH[9] | PDSRH[9] | _ | В9 |
| | FEC_TXD[3:0] | _ | _ | PTJ[5:2] | PSRRH[13:10] | PDSRH[13:1 0] | _ | A11, B10, C9, D9 |



| Pin Group | Primary Function | Secondary Function (Alt 1) | Tertiary Function (Alt 2) | Quaternary Function (GPIO) | Slew Rate | Drive Strength/Co ntrol ¹ | Pull-up/ Pull-down ² | Pin on 144 MAPBGA |
|--------------------------------|----------------------------|----------------------------------|---------------------------------|----------------------------------|--------------|--|------------------------------------|----------------------|
| FEC | FEC_TXEN | _ | _ | PTJ6 | PSRRH[14] | PDSRH[14] | _ | A10 |
| | FEC_TXER | _ | _ | PTJ7 | PSRRH[15] | PDSRH[15] | _ | D8 |
| I ² C0 ³ | I2C_SCL0 | _ | UTXD2 | PAS0 | PSRR[0] | PDSR[0] | Pull-Up ⁴ | H1 |
| | I2C_SDA0 | _ | URXD2 | PAS1 | PSRR[0] | PDSR[0] | Pull-Up ⁴ | H2 |
| Interrupts | IRQ7 | _ | _ | PNQ7 | Low | Low | Pull-Up ⁴ | E12 |
| | IRQ5 | FEC_MDC | _ | PNQ5 | Low | Low | Pull-Up ⁴ | A7 |
| | IRQ3 | FEC_MDI O | _ | PNQ3 | Low | Low | Pull-Up ⁴ | A6 |
| | IRQ1 | _ | USB_ALT CLK | PNQ1 | Low | High | Pull-Up ⁴ | E9 |
| JTAG/BDM | JTAG_EN | _ | _ | _ | N/A | N/A | Pull-Down | M2 |
| | TCLK/ PSTCLK/ CLKOUT | _ | FB_CLK | _ | Low | Low | Pull-Up ⁵ | М3 |
| | TDI/DSI | _ | _ | _ | N/A | N/A | Pull-Up ⁵ | L1 |
| | TDO/DSO | _ | _ | _ | Low | Low | _ | L2 |
| | TMS/BKPT | _ | _ | _ | N/A | N/A | Pull-Up ⁵ | K1 |
| | TRST/DSCLK | _ | _ | _ | N/A | N/A | Pull-Up ⁵ | K2 |
| Mode | RCON/EZPCS | _ | _ | _ | N/A | N/A | Pull-Up | E4 |
| Selection | CLKMOD[1:0] | _ | _ | _ | N/A | N/A | Pull-Down | D4, D5 |
| QSPI | QSPI_CS3 | SYNCA | USB_DP PDOWN | PQS6 | PSRR[7] | PDSR[7] | _ | G4 |
| | QSPI_CS2 | SYNCB | USB_DM - PDOWN | PQS5 | PSRR[6] | PDSR[6] | _ | G3 |
| | QSPI_CS0 | I2C_SDA0 | UCTS1 | PQS3 | PSRR[4] | PDSR[4] | Pull-Up ⁶ | H4 |
| | QSPI_CLK/ EZPCK | I2C_SCL0 | URTS1 | PQS2 | PSRR[3] | PDSR[3] | Pull-Up ⁶ | НЗ |



| | | 1 | ı | | | | . ` | , |
|--------------------|---------------------|----------------------------------|---------------------------------|----------------------------------|--------------|--|------------------------------------|----------------------|
| Pin Group | Primary Function | Secondary Function (Alt 1) | Tertiary Function (Alt 2) | Quaternary Function (GPIO) | Slew Rate | Drive Strength/Co ntrol ¹ | Pull-up/ Pull-down ² | Pin on 144 MAPBGA |
| QSPI | QSPI_DIN/ EZPD | I2C_SDA1 | URXD1 | PQS1 | PSRR[2] | PDSR[2] | Pull-Up ⁶ | G2 |
| | QSPI_DOUT/ EZPQ | I2C_SCL1 | UTXD1 | PQS0 | PSRR[1] | PDSR[1] | Pull-Up ⁶ | G1 |
| Reset ⁷ | RSTI | _ | _ | _ | N/A | N/A | Pull-Up ⁷ | A3 |
| | RSTO | _ | _ | _ | Low | High | _ | A2 |
| Test | TEST | _ | _ | _ | N/A | N/A | Pull-Down | B1 |
| Timer 3, 16-bit | GPT3 | _ | PWM7 | PTA3 | PSRR[23] | PDSR[23] | Pull-Up ⁸ | M7 |
| Timer 2, 16-bit | GPT2 | _ | PWM5 | PTA2 | PSRR[22] | PDSR[22] | Pull-Up ⁸ | J10 |
| Timer 1, 16-bit | GPT1 | _ | PWM3 | PTA1 | PSRR[21] | PDSR[21] | Pull-Up ⁸ | J11 |
| Timer 0, 16-bit | GPT0 | _ | PWM1 | PTA0 | PSRR[20] | PDSR[20] | Pull-Up ⁸ | F12 |
| Timer 3, 32-bit | DTIN3 | DTOUT3 | PWM6 | PTC3 | PSRR[19] | PDSR[19] | _ | F4 |
| Timer 2, 32-bit | DTIN2 | DTOUT2 | PWM4 | PTC2 | PSRR[18] | PDSR[18] | _ | J8 |
| Timer 1, 32-bit | DTIN1 | DTOUT1 | PWM2 | PTC1 | PSRR[17] | PDSR[17] | _ | C1 |
| Timer 0, 32-bit | DTIN0 | DTOUT0 | PWM0 | PTC0 | PSRR[16] | PDSR[16] | _ | D2 |
| UART 0 | UCTS0 | _ | USB_VB USE | PUA3 | PSRR[11] | PDSR[11] | _ | E2 |
| | URTS0 | _ | USB_VB USD | PUA2 | PSRR[10] | PDSR[10] | _ | F3 |
| | URXD0 | _ | _ | PUA1 | PSRR[9] | PDSR[9] | _ | F2 |
| | UTXD0 | _ | _ | PUA0 | PSRR[8] | PDSR[8] | _ | F1 |



| Function (Alt 1) | Function (Alt 2) | Function (GPIO) | Slew Rate | Strength/Co ntrol ¹ | Pull-up/ Pull-down ² | Pin on 144 MAPBGA |
|---------------------|---------------------|--------------------|--------------|-----------------------------------|------------------------------------|----------------------|
| SYNCA | URXD2 | PUB3 | PSRR[15] | PDSR[15] | _ | K7 |
| SYNCB | UTXD2 | PUB2 | PSRR[14] | PDSR[14] | | M8 |
| I2C_SDA1 | | PUB1 | PSRR[13] | PDSR[13] | Pull-Up ⁶ | L8 |
| I2C_SCL1 | | PUB0 | PSRR[12] | PDSR[12] | Pull-Up ⁶ | K8 |
| I2C_SCL1 | USB_ VBUSCH G | PUC3 | PSRR[27] | PDSR[27] | Pull-Up ⁶ | E11 |
| I2C_SDA1 | USB_ VBUSDIS | PUC2 | PSRR[26] | PDSR[26] | Pull-Up ⁶ | E10 |

PSRR[25]

PSRR[24]

N/A

N/A

N/A

N/A

Drive

PDSR[25]

PDSR[24]

N/A

N/A

N/A

N/A

C10

D10

H11

H12

J9

H9

Table 2-1. Pin Functions by Primary and Alternate Purpose (continued)

Secondary Tertiary Quaternary

PUC₁

PUC0

Primary

Function

UCTS1

URTS1

URXD1

UTXD1

UCTS2

URTS2

URXD2

UTXD2

USB_DM

USB_DP

USB_VDD

USB_VSS

CANRX

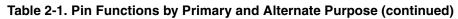
CANTX

Pin Group

UART 1

UART 2

USB OTG



| Pin Group | Primary Function | Secondary Function (Alt 1) | Tertiary Function (Alt 2) | Quaternary Function (GPIO) | Slew Rate | Drive Strength/Co ntrol ¹ | Pull-up/ Pull-down ² | Pin on 144 MAPBGA |
|----------------------|---------------------|----------------------------------|---------------------------------|----------------------------------|--------------|--|------------------------------------|--------------------------------------|
| Mini- | FB_ALE | FB_CS1 | _ | PAS2 | PSRRL[20] | PDSRL[20] | _ | K3 |
| FlexBus ⁹ | FB_AD[7:0] | _ | _ | PTE[7:0] | PSRRL[7:0] | PDSRL[7:0] | _ | J2, J1, K4, K6, J6, M6, L6, L7 |
| | FB_AD[15:8] | _ | _ | PTF[7:0] | PSRRL[15:8] | PDSRL[15:8] | _ | C4, B2, C3, C2, D3, E3, J3, J4 |
| | FB_AD[19:16] | _ | _ | PTG[3:0] | PSRRL[19:16] | PDSRL[19:1 6] | _ | B6, C6, D6, C5 |
| | FB_CS0 | _ | _ | PTG5 | PSRRL[21] | PDSRL[21] | _ | M5 |
| | FB_R/W | _ | _ | PTG7 | PSRRL[31] | PDSRL[31] | _ | M4 |
| | FB_OE | _ | _ | PTG6 | PSRRL[30] | PDSRL[30] | _ | B5 |
| | FB_D7 | CANRX | _ | PTH5 | PSRRL[29] | PDSRL[29] | _ | A5 |
| | FB_D6 | CANTX | _ | PTH4 | PSRRL[28] | PDSRL[28] | _ | A4 |
| | FB_D5 | I2C_SCL1 | _ | PTH3 | PSRRL[27] | PDSRL[27] | Pull-Up ⁶ | B4 |
| | FB_D4 | I2C_SDA1 | _ | PTH2 | PSRRL[26] | PDSRL[26] | Pull-Up ⁶ | B3 |
| | FB_D3 | USB_ VBUSD | _ | PTH1 | PSRRL[25] | PDSRL[25] | _ | L4 |
| | FB_D2 | USB_ VBUSE | _ | PTH0 | PSRRL[24] | PDSRL[24] | _ | K5 |
| | FB_D1 | SYNCA | _ | PTH7 | PSRRL[23] | PDSRL[23] | _ | L5 |
| | FB_D0 | SYNCB | _ | PTH6 | PSRRL[22] | PDSRL[22] | _ | J5 |
| Standby Voltage | VSTBY | _ | _ | _ | N/A | N/A | _ | J12 |

| Table 2-1. Pin F | functions by Primar | y and Alternate Pu | rpose (continued) |
|------------------|---------------------|--------------------|-------------------|
| | | | |

| Pin Group | Primary Function | Secondary Function (Alt 1) | Tertiary Function (Alt 2) | Quaternary Function (GPIO) | Slew Rate | Drive Strength/Co ntrol ¹ | Pull-up/ Pull-down ² | Pin on 144 MAPBGA |
|-------------------|---------------------|----------------------------------|---------------------------------|----------------------------------|--------------|--|------------------------------------|-----------------------------------|
| VDD ¹⁰ | VDD | _ | _ | | N/A | N/A | _ | E5–E8; F5; G5; H5–7; J7 |
| VSS | VSS | _ | _ | _ | N/A | N/A | _ | A1; A12; F6–8; G6–8; H8; M1 |

The PDSR and PSSR registers are part of the GPIO module. All programmable signals default to 2mA drive in normal (single-countries All signals have a pull-up in GPIO mode.

3 I²C1 is multiplexed with specific pins of the QSPI, UART1, UART2, and Mini-FlexBus pin groups.

⁴ For primary and GPIO functions only.

⁵ Only when JTAG mode is enabled.

⁶ For secondary and GPIO functions only.

⁷ RSTI has an internal pull-up resistor; however, the use of an external resistor is strongly recommended.

⁸ For GPIO functions, the Primary Function has pull-up control within the GPT module.

⁹ Available on 144-pin packages only.

¹⁰ This list for power and ground does not include those dedicated power/ground pins included elsewhere, such as in the ADC, US



Reset Signals 2.3

Table 2-2 describes signals used to reset the chip or as a reset indication.

Table 2-2. Reset Signals

| Signal Name | Abbreviation | Function | I/O |
|-------------|--------------|---|-----|
| Reset In | | Primary reset input to the device. Asserting RSTI immediately resets the CPU and peripherals. | I |
| Reset Out | RSTO | Driven low for 512 CPU clocks after the reset source has deasserted and PLL locked. | 0 |

PLL and Clock Signals 2.4

Table 2-3 describes signals used to support the on-chip clock generation circuitry.

Table 2-3. PLL and Clock Signals

| Signal Name | Abbreviation | Function | I/O |
|-------------------|--------------|--|-----|
| External Clock In | EXTAL | Crystal oscillator or external clock input. | I |
| Crystal | XTAL | Crystal oscillator output. | 0 |
| Clock Out | CLKOUT | This output signal reflects the internal system clock. | 0 |

2.5 **Real-Time Clock Signals**

Table 2-4 describes signals used to support the on-chip clock generation circuitry.

Table 2-4. RTC Signals

| Signal Name | Abbreviation | Function | I/O |
|-----------------------|--------------|---|-----|
| RTC external clock in | RTC_EXTAL | Crystal oscillator or external clock input for the real-time clock. | I |
| RTC crystal | RTC_XTAL | Crystal oscillator output for the real-time clock. | 0 |

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Signal Descriptions

2.6 Mode Selection

Table 2-5 describes signals used in mode selection.

Table 2-5. Mode Selection Signals

| Signal Name | Abbreviation | Function | I/O |
|----------------------|--------------|---|-----|
| Reset Configuration | RCON | The serial flash programming mode is entered by asserting the RCON pin (with the TEST pin negated) as the chip comes out of reset. During this mode, the EzPort has access to the flash memory which can be programmed from an external device. | 1 |
| Clock Mode Selection | CLKMOD[1:0] | Configures the clock mode after reset. | - 1 |
| Test | TEST | Reserved for factory testing only and in normal modes of operation should be connected to VSS to prevent unintentional activation of test functions. | Ι |

2.7 External Interrupt Signals

Table 2-6 describes the external interrupt signals.

Table 2-6. External Interrupt Signals

| Signal Name | Abbreviation | Function | 1/0 |
|---------------------|--------------|-----------------------------|-----|
| External Interrupts | ĪRQ[7,5,3,1] | External interrupt sources. | I |

2.8 Queued Serial Peripheral Interface (QSPI)

Table 2-7 describes the QSPI signals.

Table 2-7. Queued Serial Peripheral Interface (QSPI) Signals

| Signal Name | Abbreviation | Function | I/O |
|--|----------------|--|-----|
| QSPI Synchronous Serial Output | QSPI_DOUT | Provides the serial data from the QSPI and can be programmed to be driven on the rising or falling edge of QSPI_CLK. | 0 |
| QSPI Synchronous Serial Data Input | QSPI_DIN | Provides the serial data to the QSPI and can be programmed to be sampled on the rising or falling edge of QSPI_CLK. | I |
| QSPI Serial Clock | QSPI_CLK | Provides the serial clock from the QSPI. The polarity and phase of QSPI_CLK are programmable. | 0 |
| Synchronous Peripheral Chip Selects | QSPI_CS[3,2,0] | QSPI peripheral chip selects that can be programmed to be active high or low. | 0 |

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2.9 Fast Ethernet Controller Signals

Table 2-8 describes the fast ethernet controller (FEC) signals.

Table 2-8. Ethernet Module (FEC) Signals

| Signal Name | Abbreviation | Function | I/O |
|--------------------------|--------------|---|-----|
| Management Data | FEC_MDIO | Transfers control information between external PHY and the media-access controller. Data is synchronous to FEC_MDC. Applies to MII mode operation. This signal is an input after reset. When the FEC is operated in 10Mbps 7-wire interface mode, this signal should be connected to VSS. | I/O |
| Management Data Clock | FEC_MDC | In Ethernet mode, FEC_MDC is an output clock that provides a timing reference to PHY for data transfers on FEC_MDIO signal. Applies to MII mode operation. | 0 |
| Collision | FEC_COL | Asserted upon collision detection and remains asserted while collision persists. This signal is not defined for full-duplex mode. | I |
| Carrier Receive Sense | FEC_CRS | When asserted, indicates transmit or receive medium is not idle. Applies to MII mode operation. | I |
| Transmit Clock | FEC_TXCLK | Input clock providing a timing reference for FEC_TXEN, FEC_TXD[3:0] and FEC_TXER | I |
| Transmit Enable | FEC_TXEN | Indicates when valid nibbles are present on MII. This signal is asserted with the first nibble of a preamble and is negated before the first FEC_TXCLK following the final nibble of the frame. | 0 |
| Transmit Data 0 | FEC_TXD0 | FEC_TXD0 is the serial output Ethernet data and is valid only during the assertion of FEC_TXEN. This signal is used for 10-Mbps Ethernet data. Also used for MII mode data in conjunction with FEC_TXD[3:1]. | 0 |
| Transmit Data 1–3 | FEC_TXD[3:1] | In Ethernet mode, these pins contain serial output Ethernet data and are valid only during assertion of FEC_TXEN in MII mode. | 0 |
| Transmit Error | FEC_TXER | In Ethernet mode, when FEC_TXER is asserted for one or more clock cycles while FEC_TXEN is also asserted, the PHY sends one or more illegal symbols. FEC_TXER has no effect at 10 Mbps or when FEC_TXEN is negated. Applies to MII mode operation. | 0 |
| Receive Clock | FEC_RXCLK | Provides a timing reference for FEC_RXDV, FEC_RXD[3:0], and FEC_RXER. | I |
| Receive Data Valid | FEC_RXDV | Asserting the FEC_RXDV input indicates that the PHY has valid nibbles present on the MII. FEC_RXDV should remain asserted from the first recovered nibble of the frame through to the last. Assertion of FEC_RXDV must start no later than the SFD and exclude any EOF. | I |
| Receive Data 0 | FEC_RXD0 | FEC_RXD0 is the Ethernet input data transferred from the PHY to the media-access controller when FEC_RXDV is asserted. This signal is used for 10-Mbps Ethernet data. This signal is also used for MII mode Ethernet data in conjunction with FEC_RXD[3:1]. | I |

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Signal Descriptions

Table 2-8. Ethernet Module (FEC) Signals (continued)

| Signal Name | Abbreviation | Function | I/O |
|------------------|--------------|---|-----|
| Receive Data 1-3 | FEC_RXD[3:1] | In Ethernet mode, these pins contain Ethernet input data transferred from the PHY to the media access controller when FEC_RXDV is asserted in MII mode operation. | _ |
| Receive Error | FEC_RXER | In Ethernet mode, when asserted with FEC_RXDV, FEC_RXER indicates that the PHY has detected an error in current frame. When FEC_RXDV is not asserted FEC_RXER has no effect. Applies to MII mode operation. | _ |

2.10 USB On-the-Go Signals

Table 2-9 describes the USB OTG module signals.

Table 2-9. USB Module Signals

| Signal Name | Abbreviation | Function | I/O |
|--------------------------|--------------|--|-----|
| USB Alternate Clock | USB_ALTCLK | Alternate input clock for the USB module. If used, the frequency of this clock must be 48 MHz. | I |
| USB On-the-Go D- | USB_DM | D- output of the dual-speed transceiver for the On-the-Go module. | 0 |
| USB On-the-Go D+ | USB_DP | D+ output of the dual-speed transceiver for the On-the-Go module. | 0 |
| USB OTG VBUS enable | USB_VBUSE | Enables the off-chip VBUS charge pump when USB OTG module is configured as a host. | 0 |
| | USB_VBUSD | Detects whether VBUS is on or off when configured as a device. | I |
| USB_DM pulldown controll | USB_DM_PDOWN | Controls the external pull-down resistor connected to the USB_DM signal. | 0 |
| USB_DP pulldown control | USB_DP_PDOWN | Controls the external pull-down resistor connected to the USB_DP signal. | 0 |
| USB VBUS charge | USB_VBUSCHG | Charges the VBUS power pin on the USB connector. | 0 |
| USB VBUS discharge | USB_VBUSDIS | Discharges the VBUS power pin on the USB connector. | 0 |
| USB Supply Voltage | USB_VDD | USB OTG power supply. | _ |
| | USB_VSS | | _ |

2.11 FlexCAN Signals

Table 2-10 describes the FlexCAN module signals.

Table 2-10. FlexCAN Signals

| Signal Name | Abbreviation | Function | 1/0 |
|------------------|--------------|---|-----|
| FlexCAN Transmit | CANTX | Controller area network transmit data output. | 0 |
| FlexCAN Receive | CANRX | Controller area network receive data input. | I |

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2.12 I²C I/O Signals

Table 2-11 describes the two I²C serial interface module signals.

Table 2-11. I²C I/O Signals

| Signal Name | Abbreviation | Function | I/O |
|---------------------------------|--------------|---|-----|
| I ² C 0 Serial Clock | I2C0_SCL | Open-drain I ² C 0 clock signal for the for the I ² C interface. It is driven by the I ² C module when the bus is in master mode or it becomes the clock input when the I ² C is in slave mode. | I/O |
| I ² C 1 Serial Clock | I2C1_SCL | Open-drain I ² C 1 clock signal for the for the I ² C interface. It is driven by the I ² C module when the bus is in master mode or it becomes the clock input when the I ² C is in slave mode. | I/O |
| I ² C 0 Serial Data | I2C0_SDA | Open-drain I^2C 0 signal that serves as the data input/output for the I^2C interface. | I/O |
| I ² C 1 Serial Data | I2C1_SDA | Open-drain I^2C 1 signal that serves as the data input/output for the I^2C interface. | I/O |

2.13 UART Module Signals

Table 2-12 describes the UART module signals.

Table 2-12. UART Module Signals

| Signal Name | Abbreviation | Function | 1/0 |
|-----------------------------|---------------|---|-----|
| Transmit Serial Data Output | UTXDn | Transmitter serial data outputs for the UART modules. The output is held high (mark condition) when the transmitter is disabled, idle, or in the local loopback mode. Data is shifted out, LSB first, on this pin at the falling edge of the serial clock source. | 0 |
| Receive Serial Data Input | URXDn | Receiver serial data inputs for the UART modules. Data is received on this pin LSB first. When the UART clock is stopped for power-down mode, any transition on this pin restarts it. | I |
| Clear-to-Send | <u>UCTS</u> n | Indicate to the UART modules that they can begin data transmission. | I |
| Request-to-Send | ŪRTS <i>n</i> | Automatic request-to-send outputs from the UART modules. This signal can also be configured to be asserted and negated as a function of the RxFIFO level. | 0 |

2.14 General Purpose Timer (GPT) Signals

Table 2-13 describes the signals of the four 16-bit timer modules.

Table 2-13. General Purpose Timer Signals

| Signal Name | Abbreviation | Function | I/O |
|------------------------------------|--------------|---|-----|
| General purpose timer input/output | GPT[3:0] | Input/output for the 16-bit general purpose timers. | I/O |

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Signal Descriptions

2.15 DMA Timer Signals

Table 2-14 describes the signals of the four DMA timer modules.

Table 2-14. DMA Timer Signals

| Signal Name | Abbreviation | Function | I/O |
|------------------|--------------|---|-----|
| DMA Timer Input | DTINn | Event input to the DMA timer modules. | 1 |
| DMA Timer Output | DTOUTn | Programmable output from the DMA timer modules. | 0 |

2.16 ADC Signals

Table 2-15 describes the signals of the analog-to-digital converter.

Table 2-15. ADC Signals

| Signal Name | Abbreviation | Function | I/O |
|------------------|------------------|---|-----|
| Analog Inputs | AN[7:0] | Inputs to the A-to-D converter. | I |
| ADC Sync | SYNCA | Initiates an ADC conversion. | I |
| | SYNCB | | ı |
| Analog Reference | V _{RH} | Reference voltage high and low inputs. | I |
| | V _{RL} | | I |
| Analog Supply | V _{DDA} | Isolate the ADC circuitry from power supply noise | _ |
| | V _{SSA} | | _ |

2.17 Pulse Width Modulator Signals

Table 2-16 describes the PWM signals.

Table 2-16. PWM Signals

| Signal Name | Abbreviation | Function | I/O |
|---------------------|--------------|---|-----|
| PWM Output Channels | PWM[7:0] | Pulse width modulated output for PWM channels | 0 |

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2.18 Debug Support Signals

The signals in Table 2-17 are used as the interface to the on-chip JTAG controller and also to interface to the BDM logic.

Table 2-17. Debug Support Signals

| Signal Name | Abbreviation | Function | I/O |
|------------------------------|--------------|---|-----|
| JTAG Enable | JTAG_EN | Select between debug module and JTAG signals at reset | I |
| Test Reset | TRST | This active-low signal is used to initialize the JTAG logic asynchronously. | I |
| Test Clock | TCLK | Used to synchronize the JTAG logic. | I |
| Test Mode Select | TMS | Used to sequence the JTAG state machine. TMS is sampled on the rising edge of TCLK. | I |
| Test Data Input | TDI | Serial input for test instructions and data. TDI is sampled on the rising edge of TCLK. | I |
| Test Data Output | TDO | Serial output for test instructions and data. TDO is three-stateable and is actively driven in the shift-IR and shift-DR controller states. TDO changes on the falling edge of TCLK. | 0 |
| Development Serial Clock | DSCLK | Development Serial Clock. Internally synchronized input. (The logic level on DSCLK is validated if it has the same value on two consecutive rising bus clock edges.) Clocks the serial communication port to the debug module during packet transfers. Maximum frequency is PSTCLK/5. At the synchronized rising edge of DSCLK, the data input on DSI is sampled and DSO changes state. | I |
| Breakpoint | ВКРТ | Breakpoint. Input used to request a manual breakpoint. Assertion of BKPT puts the processor into a halted state after the current instruction completes. Halt status is reflected on processor status signals (PST[3:0]) as the value 0xF. | I |
| Development Serial Input | DSI | Development Serial Input. Internally synchronized input that provides data input for the serial communication port to the debug module after the DSCLK has been seen as high (logic 1). | I |
| Development Serial Output | DSO | Development Serial Output. Provides serial output communication for debug module responses. DSO is registered internally. The output is delayed from the validation of DSCLK high. | 0 |

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Table 2-17. Debug Support Signals (continued)

| Signal Name | Abbreviation | Function | I/O |
|---------------------------------|--------------|--|-----|
| Debug Data | DDATA[3:0] | Debug data. Displays captured processor data and breakpoint status. The CLKOUT signal can be used by the development system to know when to sample DDATA[3:0]. | 0 |
| Processor Status Clock | PSTCLK | Processor Status Clock. Delayed version of the processor clock. Its rising edge appears in the center of valid PST and DDATA output. PSTCLK indicates when the development system should sample PST and DDATA values. If real-time trace is not used, setting CSR[PCD] keeps PSTCLK, and PST and DDATA outputs from toggling without disabling triggers. Non-quiescent operation can be reenabled by clearing CSR[PCD], although the external development systems must resynchronize with the PST and DDATA outputs. PSTCLK starts clocking only when the first non-zero PST value (0xC, 0xD, or 0xF) occurs during system reset exception processing. | 0 |
| Processor Status Outputs | PST[3:0] | Indicate core status. Debug mode timing is synchronous with the processor clock; status is unrelated to the current bus transfer. The CLKOUT signal can be used by the development system to know when to sample PST[3:0]. | 0 |
| All Processor Status Outputs | ALLPST | Logical AND of PST[3.0] | 0 |

2.19 EzPort Signal Descriptions

Table 2-18 contains a list of EzPort external signals.

Table 2-18. EzPort Signal Descriptions

| Signal Name | Abbreviation Function | | I/O |
|------------------------|-----------------------|---|-----|
| EzPort Clock | EZPCK | Shift clock for EzPort transfers | I |
| EzPort Chip Select | EZPCS | Chip select for signaling the start and end of serial transfers | I |
| EzPort Serial Data In | EZPD | EZPD is sampled on the rising edge of EZPCK | I |
| EzPort Serial Data Out | EZPQ | EZPQ transitions on the falling edge of EZPCK | 0 |

2.20 Mini-FlexBus

Table 2-11 describes the Mini-FlexBus external bus interface signals.

Table 2-19. Mini-FlexBus Signals

| Signal Name | I/O | Description |
|-------------|-----|--|
| FB_A[19:0] | I/O | In a non-multiplexed configuration, this bus is the address bus. In a multiplexed configuration this bus is the address/data bus, FB_AD[19:0]. |
| FB_D[7:0] | I/O | In a non-multiplexed configuration, this bus is the data bus. In multiplexed configurations, this bus is not used. |

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| Signal Name | I/O | Description |
|-------------|-----|---|
| FB_OE | 0 | Output enable |
| FB_R/W | 0 | Read/write. 1 = Read, 0 = Write |
| FB_ALE | 0 | Address latch enable. This signal is multiplexed with $\overline{\text{FB_CS1}}$ on a configurable package pin. |
| FB_CS[1:0] | 0 | General purpose chip-selects. In multiplexed mode, only FB_CS0 is available. FB_CS1 is multiplexed with FB_ALE on a configurable package pin. |

2.21 Power and Ground Pins

The pins described in Table 2-20 provide system power and ground to the chip. Multiple pins are provided for adequate current capability. All power supply pins must have adequate decoupling (bypass capacitance) for high-frequency noise suppression.

Table 2-20. Power and Ground Pins

| Signal Name | Abbreviation | Function | I/O |
|-------------------------------|-------------------|---|-----|
| PLL Analog Supply | VDDPLL, VSSPLL | Dedicated power supply signals to isolate the sensitive PLL analog circuitry from the normal levels of noise present on the digital power supply. | |
| RTC & SRAM Standby Voltage | VSTBY | Standby voltage for the internal SRAM and real-time clock module | |
| Positive Supply | VDD | These pins supply positive power to the core logic. | _ |
| Ground | VSS | This pin is the negative supply (ground) to the chip. | _ |

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Chapter 3 ColdFire Core

3.1 Introduction

This section describes the organization of the Version 2 (V2) ColdFire[®] processor core and an overview of the program-visible registers. For detailed information on instructions, see the ISA_A+ definition in the *ColdFire Family Programmer's Reference Manual*.

3.1.1 Overview

As with all ColdFire cores, the V2 ColdFire core is comprised of two separate pipelines decoupled by an instruction buffer.

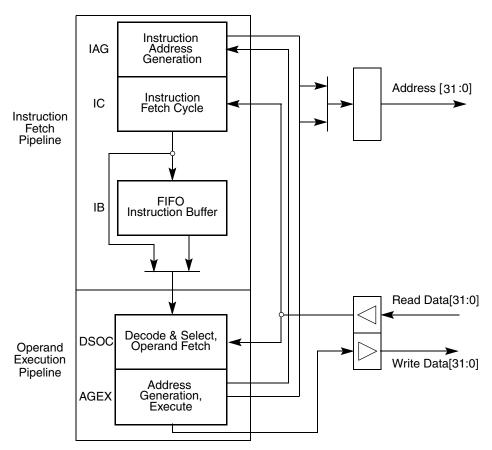


Figure 3-1. V2 ColdFire Core Pipelines

The instruction fetch pipeline (IFP) is a two-stage pipeline for prefetching instructions. The prefetched instruction stream is then gated into the two-stage operand execution pipeline (OEP), that decodes the instruction, fetches the required operands, and then executes the required function. Because the IFP and OEP pipelines are decoupled by an instruction buffer serving as a FIFO queue, the IFP is able to prefetch instructions in advance of their actual use by the OEP thereby minimizing time stalled waiting for instructions.

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The V2 ColdFire core pipeline stages include the following:

- Two-stage instruction fetch pipeline (IFP) (plus optional instruction buffer stage)
 - Instruction address generation (IAG) Calculates the next prefetch address
 - Instruction fetch cycle (IC)—Initiates prefetch on the processor's local bus
 - Instruction buffer (IB) Optional buffer stage minimizes fetch latency effects using FIFO queue
- Two-stage operand execution pipeline (OEP)
 - Decode and select/operand fetch cycle (DSOC)—Decodes instructions and fetches the required components for effective address calculation, or the operand fetch cycle
 - Address generation/execute cycle (AGEX)—Calculates operand address or executes the instruction

When the instruction buffer is empty, opcodes are loaded directly from the IC cycle into the operand execution pipeline. If the buffer is not empty, the IFP stores the contents of the fetched instruction in the IB until it is required by the OEP.

For register-to-register and register-to-memory store operations, the instruction passes through both OEP stages once. For memory-to-register and read-modify-write memory operations, an instruction is effectively staged through the OEP twice; the first time to calculate the effective address and initiate the operand fetch on the processor's local bus, and the second time to complete the operand reference and perform the required function defined by the instruction.

The resulting pipeline and local bus structure allow the V2 ColdFire core to deliver sustained high performance across a variety of demanding embedded applications.

3.2 Memory Map/Register Description

The following sections describe the processor registers in the user and supervisor programming models. The programming model is selected based on the processor privilege level (user mode or supervisor mode) as defined by the S bit of the status register (SR). Table 3-1 lists the processor registers.

The user-programming model consists of the following registers:

- 16 general-purpose 32-bit registers (D0–D7, A0–A7)
- 32-bit program counter (PC)
- 8-bit condition code register (CCR)
- EMAC registers (described fully in Chapter 4, "Enhanced Multiply-Accumulate Unit (EMAC
 - Four 48-bit accumulator registers partitioned as follows:
 - Four 32-bit accumulators (ACC0–ACC3)
 - Eight 8-bit accumulator extension bytes (two per accumulator). These are grouped into two 32-bit values for load and store operations (ACCEXT01 and ACCEXT23).

Accumulators and extension bytes can be loaded, copied, and stored; results from EMAC arithmetic operations generally affect the entire 48-bit destination.

— One 16-bit mask register (MASK)



 One 32-bit Status register (MACSR) including four indicator bits signaling product or accumulation overflow (one for each accumulator: PAV0–PAV3)

The supervisor programming model is to be used only by system control software to implement restricted operating system functions, I/O control, and memory management. All accesses that affect the control features of ColdFire processors are in the supervisor programming model, that consists of registers available in user mode as well as the following control registers:

- 16-bit status register (SR)
- 32-bit supervisor stack pointer (SSP)
- 32-bit vector base register (VBR)
- Two 32-bit memory base address registers (RAMBAR, FLASHBAR)

Table 3-1. ColdFire Core Programming Model

| BDM ¹ | Register | Width (bits) | Access | Reset Value | Written with MOVEC | Section/Page |
|-----------------------------------|--|--------------|-----------|----------------------------------|--------------------|--------------|
| | Supervisor/Use | r Access | s Registe | rs | | |
| Load: 0x080 Store: 0x180 | Data Register 0 (D0) | 32 | R/W | 0xCF20_64 | No | 3.2.1/3-5 |
| Load: 0x081 Store: 0x181 | Data Register 1 (D1) | 32 | R/W | 0x10A0_1070 | No | 3.2.1/3-5 |
| Load: 0x082-7 Store: 0x182-7 | Data Register 2–7 (D2–D7) | 32 | R/W | Undefined | No | 3.2.1/3-5 |
| Load: 0x088-8E Store: 0x188-8E | Address Register 0–6 (A0–A6) | 32 | R/W | Undefined | No | 3.2.2/3-5 |
| Load: 0x08F Store: 0x18F | Supervisor/User A7 Stack Pointer (A7) | 32 | R/W | Undefined | No | 3.2.3/3-6 |
| 0x804 | MAC Status Register (MACSR) | 32 | R/W | 0x0000_0000 | No | 4.2.1/4-5 |
| 0x805 | MAC Address Mask Register (MASK) | 32 | R/W | 0xFFFF_FFFF | No | 4.2.2/4-7 |
| 0x806, 0x809, 0x80A, 0x80B | MAC Accumulators 0–3 (ACC0–3) | 32 | R/W | Undefined | No | 4.2.3/4-9 |
| 0x807 | MAC Accumulator 0,1 Extension Bytes (ACCext01) | 32 | R/W | Undefined | No | 4.2.4/4-9 |
| 0x808 | MAC Accumulator 2,3 Extension Bytes (ACCext23) | 32 | R/W | Undefined | No | 4.2.4/4-9 |
| 0x80E | Condition Code Register (CCR) | 8 | R/W | Undefined | No | 3.2.4/3-7 |
| 0x80F | Program Counter (PC) | 32 | R/W | Contents of location 0x0000_0004 | No | 3.2.5/3-8 |

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Table 3-1. ColdFire Core Programming Model (continued)

| BDM ¹ | Register | Width (bits) | Access | Reset Value | Written with MOVEC | Section/Page |
|------------------|---|--------------|---------|----------------------------------|--------------------|--------------|
| | Supervisor Acce | ess Only | Registe | rs | | |
| 0x800 | User/Supervisor A7 Stack Pointer (OTHER_A7) | 32 | R/W | Contents of location 0x0000_0000 | No | 3.2.3/3-6 |
| 0x801 | Vector Base Register (VBR) | 32 | R/W | 0x0000_0000 | Yes | 3.2.6/3-8 |
| 0x80E | Status Register (SR) | 16 | R/W | 0x27 | No | 3.2.7/3-8 |
| 0xC04 | Flash Base Address Register (FLASHBAR) | 32 | R/W | 0x0000_0000 | Yes | 3.2.8/3-9 |
| 0xC05 | RAM Base Address Register (RAMBAR) | 32 | R/W | See Section | Yes | 3.2.8/3-9 |

¹ The values listed in this column represent the Rc field used when accessing the core registers via the BDM port. For more information see Chapter 33, "Debug Module".

3.2.1 Data Registers (D0–D7)

D0–D7 data registers are for bit (1-bit), byte (8-bit), word (16-bit) and longword (32-bit) operations; they can also be used as index registers.

NOTE

Registers D0 and D1 contain hardware configuration details after reset. See Section 3.3.4.15, "Reset Exception" for more details.

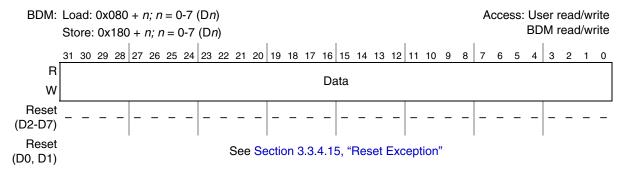


Figure 3-2. Data Registers (D0-D7)

3.2.2 Address Registers (A0–A6)

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These registers can be used as software stack pointers, index registers, or base address registers. They can also be used for word and longword operations.

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² The D1 value at reset depends on memory size. The reset value shown is for 256 KB flash and 32 KB SRAM.



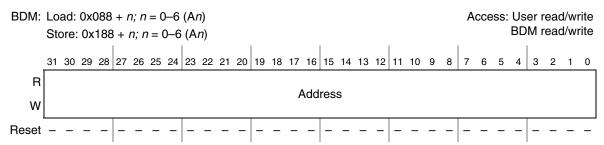


Figure 3-3. Address Registers (A0-A6)

3.2.3 Supervisor/User Stack Pointers (A7 and OTHER A7)

The ColdFire architecture supports two independent stack pointer (A7) registers—the supervisor stack pointer (SSP) and the user stack pointer (USP). The hardware implementation of these two program-visible 32-bit registers does not identify one as the SSP and the other as the USP. Instead, the hardware uses one 32-bit register as the active A7 and the other as OTHER A7. Thus, the register contents are a function of the processor operation mode, as shown in the following:

```
if SR[S] = 1
                 A7 = Supervisor Stack Pointer
         then
                 OTHER A7 = User Stack Pointer
                 A7 = User Stack Pointer
         else
                 OTHER A7 = Supervisor Stack Pointer
```

The BDM programming model supports direct reads and writes to the (active) A7 and OTHER A7. It is the responsibility of the external development system to determine, based on the setting of SR[S], the mapping of A7 and OTHER A7 to the two program-visible definitions (SSP and USP).

To support dual stack pointers, the following two supervisor instructions are included in the ColdFire instruction set architecture to load/store the USP:

```
move.1 Ay, USP; move to USP
move.1 USP, Ax; move from USP
```

These instructions are described in the ColdFire Family Programmer's Reference Manual. All other instruction references to the stack pointer, explicit or implicit, access the active A7 register.

NOTE

The USP must be initialized using the move. 1 Ay, USP instruction before any entry into user mode.

The SSP is loaded during reset exception processing with the contents of location 0x0000 0000.

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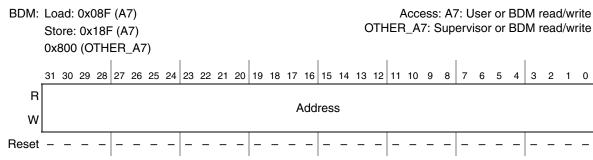


Figure 3-4. Stack Pointer Registers (A7 and OTHER A7)

3.2.4 Condition Code Register (CCR)

The CCR is the LSB of the processor status register (SR). Bits 4–0 act as indicator flags for results generated by processor operations. The extend bit (X) is also an input operand during multiprecision arithmetic computations.

NOTE

The CCR register must be explicitly loaded after reset and before any compare (CMP), Bcc, or Scc instructions are executed.

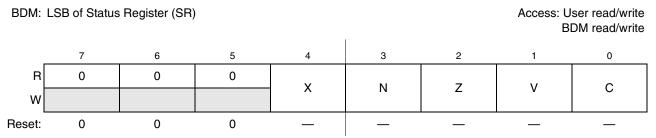


Figure 3-5. Condition Code Register (CCR)

Table 3-2. CCR Field Descriptions

| Field | Description |
|--------|---|
| 7–5 | Reserved, must be cleared. |
| 4 X | Extend condition code bit. Set to the C-bit value for arithmetic operations; otherwise not affected or set to a specified result. |
| 3 N | Negative condition code bit. Set if most significant bit of the result is set; otherwise cleared. |
| 2 Z | Zero condition code bit. Set if result equals zero; otherwise cleared. |
| 1 V | Overflow condition code bit. Set if an arithmetic overflow occurs implying the result cannot be represented in operand size; otherwise cleared. |
| 0 C | Carry condition code bit. Set if a carry out of the operand msb occurs for an addition or if a borrow occurs in a subtraction; otherwise cleared. |

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3.2.5 Program Counter (PC)

The PC contains the currently executing instruction address. During instruction execution and exception processing, the processor automatically increments PC contents or places a new value in the PC. The PC is a base address for PC-relative operand addressing.

The PC is initially loaded during reset exception processing with the contents at location 0x0000_0004.

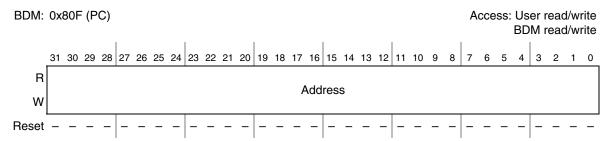
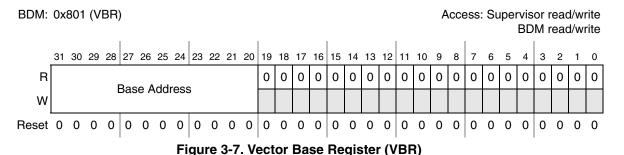


Figure 3-6. Program Counter Register (PC)

3.2.6 Vector Base Register (VBR)

The VBR contains the base address of the exception vector table in the memory. To access the vector table, the displacement of an exception vector is added to the value in VBR. The lower 20 bits of the VBR are not implemented by ColdFire processors. They are assumed to be zero, forcing the table to be aligned on a 1 MB boundary.



3.2.7 Status Register (SR)

The SR stores the processor status and includes the CCR, the interrupt priority mask, and other control bits. In supervisor mode, software can access the entire SR. In user mode, only the lower 8 bits (CCR) are accessible. The control bits indicate the following states for the processor: trace mode (T bit), supervisor or user mode (S bit), and master or interrupt state (M bit). All defined bits in the SR have read/write access when in supervisor mode.

NOTE

The lower byte of the SR (the CCR) must be loaded explicitly after reset and before any compare (CMP), Bcc, or Scc instructions execute.

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BDM: 0x80E (SR)

Access: Supervisor read/write

BDM read/write

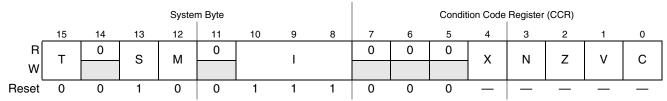


Figure 3-8. Status Register (SR)

Table 3-3. SR Field Descriptions

| Field | Description |
|------------|--|
| 15 T | Trace enable. When set, the processor performs a trace exception after every instruction. |
| 14 | Reserved, must be cleared. |
| 13 S | Supervisor/user state. 0 User mode 1 Supervisor mode |
| 12 M | Master/interrupt state. Bit is cleared by an interrupt exception and software can set it during execution of the RTE or move to SR instructions. |
| 11 | Reserved, must be cleared. |
| 10–8 I | Interrupt level mask. Defines current interrupt level. Interrupt requests are inhibited for all priority levels less than or equal to current level, except edge-sensitive level 7 requests, which cannot be masked. |
| 7–0 CCR | Refer to Section 3.2.4, "Condition Code Register (CCR)". |

3.2.8 Memory Base Address Registers (RAMBAR, FLASHBAR)

The memory base address registers are used to specify the base address of the internal SRAM and flash modules and indicate the types of references mapped to each. Each base address register includes a base address, write-protect bit, address space mask bits, and an enable bit. FLASHBAR determines the base address of the on-chip flash, and RAMBAR determines the base address of the on-chip RAM. For more information, refer to Section 12.2.1, "SRAM Base Address Register (RAMBAR)" and Section 18.3.2, "Flash Base Address Register (FLASHBAR)".

3.3 Functional Description

3.3.1 Version 2 ColdFire Microarchitecture

From the block diagram in Figure 3-1, the non-Harvard architecture of the processor is readily apparent. The processor interfaces to the local memory subsystem via a single 32-bit address and two unidirectional 32-bit data buses. This structure minimizes the core size without compromising performance to a large degree.

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A more detailed view of the hardware structure within the two pipelines is presented in Figure 3-9 and Figure 3-10 below. In these diagrams, the internal structure of the instruction fetch and operand execution pipelines is shown:

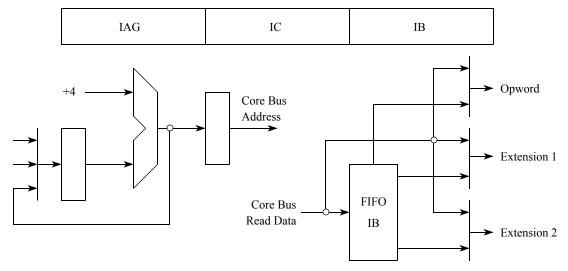


Figure 3-9. Version 2 ColdFire Processor Instruction Fetch Pipeline Diagram

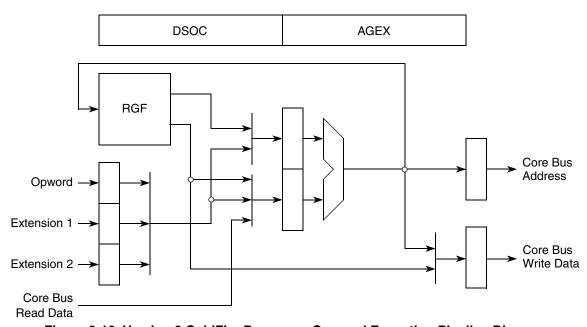


Figure 3-10. Version 2 ColdFire Processor Operand Execution Pipeline Diagram

The instruction fetch pipeline prefetches instructions from local memory using a two-stage structure. For sequential prefetches, the next instruction address is generated by adding four to the last prefetch address. This function is performed during the IAG stage and the resulting prefetch address gated onto the core bus (if there are no pending operand memory accesses assigned a higher priority). After the prefetch address is driven onto the core bus, the instruction fetch cycle accesses the appropriate local memory and returns the instruction read data back to the IFP during the cycle. If the accessed data is not present in a local memory (e.g., an instruction cache miss, or an external access cycle is required), the IFP is stalled in the

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IC stage until the referenced data is available. As the prefetch data arrives in the IFP, it can be loaded into the FIFO instruction buffer or gated directly into the OEP.

The V2 design uses a simple static conditional branch prediction algorithm (forward-assumed as not-taken, backward-assumed as taken), and all change-of-flow operations are calculated by the OEP and the target instruction address fed back to the IFP.

The IFP and OEP are decoupled by the FIFO instruction buffer, allowing instruction prefetching to occur with the available core bus bandwidth not used for operand memory accesses. For the V2 design, the instruction buffer contains three 32-bit locations.

Consider the operation of the OEP for three basic classes of non-branch instructions:

• Register-to-register:

Embedded load:

• Register-to-memory (store)

```
move Ry, <mem>x
```

For simple register-to-register instructions, the first stage of the OEP performs the instruction decode and fetching of the required register operands (OC) from the dual-ported register file, while the actual instruction execution is performed in the second stage (EX) in one of the execute engines (e.g., ALU, barrel shifter, divider, EMAC). There are no operand memory accesses associated with this class of instructions, and the execution time is typically a single machine cycle. See Figure 3-11.

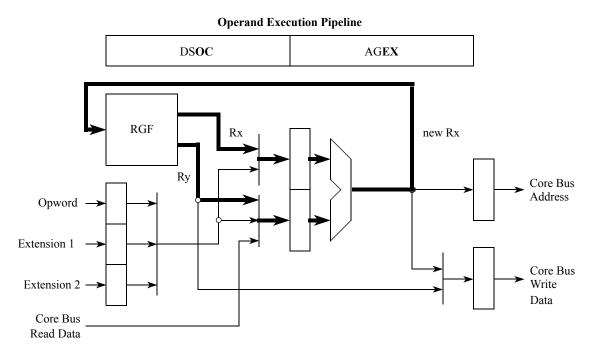


Figure 3-11. V2 OEP Register-to-Register

For memory-to-register (embedded-load) instructions, the instruction is effectively staged through the OEP twice with a basic execution time of three cycles. First, the instruction is decoded and the components

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of the operand address (base register from the RGF and displacement) are selected (DS). Second, the operand effective address is generated using the ALU execute engine (AG). Third, the memory read operand is fetched from the core bus, while any required register operand is simultaneously fetched (OC) from the RGF. Finally, in the fourth cycle, the instruction is executed (EX). The heavily-used 32-bit load instruction (move.1 < mem>y, Rx) is optimized to support a two-cycle execution time. The following example in Figure 3-12 shows an effective address of the form expression = exp

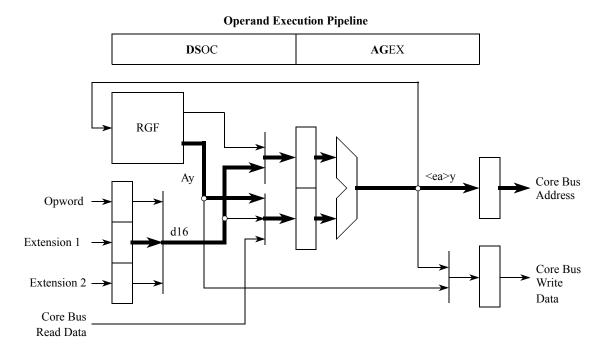


Figure 3-12. V2 OEP Embedded-Load Part 1

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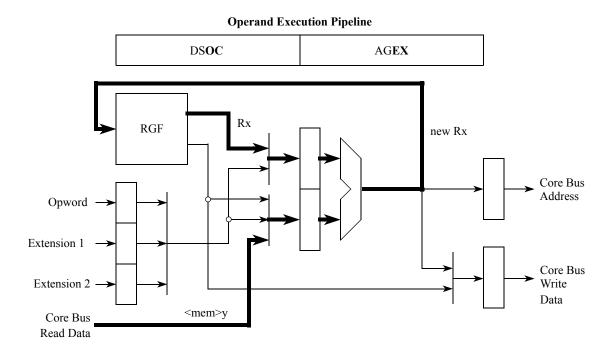


Figure 3-13. V2 OEP Embedded-Load Part 2

For register-to-memory (store) operations, the stage functions (DS/OC, AG/EX) are effectively performed simultaneously allowing single-cycle execution. See Figure 3-14 where the effective address is of the form $\langle ea \rangle x = (d16,Ax)$, i.e., a 16-bit signed displacement added to a base register Ax.

For read-modify-write instructions, the pipeline effectively combines an embedded-load with a store operation for a three-cycle execution time.



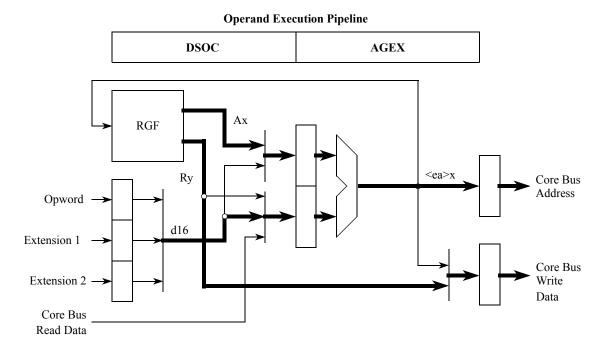


Figure 3-14. V2 OEP Register-to-Memory

The pipeline timing diagrams of Figure 3-15 depict the execution templates for these three classes of instructions. In these diagrams, the x-axis represents time, and the various instruction operations are shown progressing down the operand execution pipeline.

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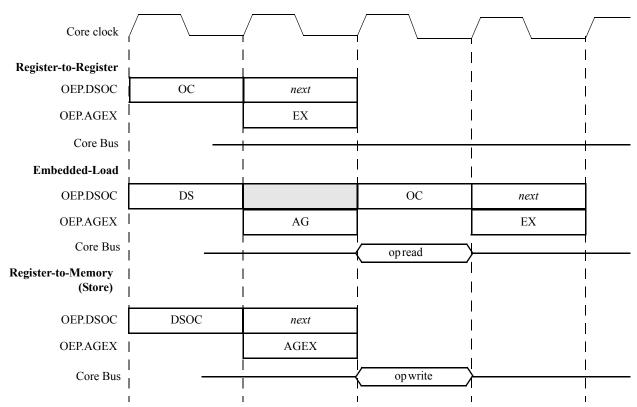


Figure 3-15. V2 OEP Pipeline Execution Templates

3.3.2 Instruction Set Architecture (ISA_A+)

The original ColdFire instruction set architecture (ISA_A) was derived from the M68000 family opcodes based on extensive analysis of embedded application code. The ISA was optimized for code compiled from high-level languages where the dominant operand size was the 32-bit integer declaration. This approach minimized processor complexity and cost, while providing excellent performance for compiled applications.

After the initial ColdFire compilers were created, developers noted there were certain ISA additions that would enhance code density and overall performance. Additionally, as users implemented ColdFire-based designs into a wide range of embedded systems, they found certain frequently-used instruction sequences that could be improved by the creation of additional instructions.

The original ISA definition minimized support for instructions referencing byte- and word-sized operands. Full support for the move byte and move word instructions was provided, but the only other opcodes supporting these data types are CLR (clear) and TST (test). A set of instruction enhancements has been implemented in subsequent ISA revisions, ISA_B and ISA_C. The added opcodes primarily addressed three areas:

- 1. Enhanced support for byte and word-sized operands
- 2. Enhanced support for position-independent code
- 3. Miscellaneous instruction additions to address new functionality



Table 3-4 summarizes the instructions added to revision ISA A to form revision ISA A+. For more details see the ColdFire Family Programmer's Reference Manual.

Table 3-4. Instruction Enhancements over Revision ISA A

| Instruction | Description |
|---------------|---|
| BITREV | The contents of the destination data register are bit-reversed; new Dn[31] equals old Dn[0], new Dn[30] equals old Dn[1],, new Dn[0] equals old Dn[31]. |
| BYTEREV | The contents of the destination data register are byte-reversed; new Dn[31:24] equals old Dn[7:0],, new Dn[7:0] equals old Dn[31:24]. |
| FF1 | The data register, Dn, is scanned, beginning from the most-significant bit (Dn[31]) and ending with the least-significant bit (Dn[0]), searching for the first set bit. The data register is then loaded with the offset count from bit 31 where the first set bit appears. |
| Move from USP | USP → Destination register |
| Move to USP | Source register → USP |
| STLDSR | Pushes the contents of the status register onto the stack and then reloads the status register with the immediate data value. |

3.3.3 **Exception Processing Overview**

Exception processing for ColdFire processors is streamlined for performance. The ColdFire processors differ from the M68000 family because they include:

- A simplified exception vector table
- Reduced relocation capabilities using the vector-base register
- A single exception stack frame format

All ColdFire processors use an instruction restart exception model. However, Version 2 ColdFire processors require more software support to recover from certain access errors. See Section 3.3.4.1, "Access Error Exception" for details.

Exception processing includes all actions from fault condition detection to the initiation of fetch for first handler instruction. Exception processing is comprised of four major steps:

- 1. The processor makes an internal copy of the SR and then enters supervisor mode by setting the S bit and disabling trace mode by clearing the T bit. The interrupt exception also forces the M bit to be cleared and the interrupt priority mask to set to current interrupt request level.
- 2. The processor determines the exception vector number. For all faults except interrupts, the processor performs this calculation based on exception type. For interrupts, the processor performs an interrupt-acknowledge (IACK) bus cycle to obtain the vector number from the interrupt controller. The IACK cycle is mapped to special locations within the interrupt controller's address space with the interrupt level encoded in the address.

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- 3. The processor saves the current context by creating an exception stack frame on the system stack. The exception stack frame is created at a 0-modulo-4 address on top of the system stack pointed to by the supervisor stack pointer (SSP). As shown in Figure 3-16, the processor uses a simplified fixed-length stack frame for all exceptions. The exception type determines whether the program counter placed in the exception stack frame defines the location of the faulting instruction (fault) or the address of the next instruction to be executed (next).
- 4. The processor calculates the address of the first instruction of the exception handler. By definition, the exception vector table is aligned on a 1 MB boundary. This instruction address is generated by fetching an exception vector from the table located at the address defined in the vector base register. The index into the exception table is calculated as (4 × vector number). After the exception vector has been fetched, the vector contents determine the address of the first instruction of the desired handler. After the instruction fetch for the first opcode of the handler has initiated, exception processing terminates and normal instruction processing continues in the handler.

All ColdFire processors support a 1024-byte vector table aligned on any 1 Mbyte address boundary (see Table 3-5).

The table contains 256 exception vectors; the first 64 are defined for the core and the remaining 192 are device-specific peripheral interrupt vectors. See Chapter 16, "Interrupt Controller Module" for details on the device-specific interrupt sources.

Table 3-5. Exception Vector Assignments

| Vector Number(s) | Vector Offset (Hex) | Stacked Program Counter | Assignment | |
|---------------------|------------------------|-------------------------------|----------------------------------|--|
| 0 | 0x000 | _ | Initial supervisor stack pointer | |
| 1 | 0x004 | _ | Initial program counter | |
| 2 | 0x008 | Fault | Access error | |
| 3 | 0x00C | Fault | Address error | |
| 4 | 0x010 | Fault | Illegal instruction | |
| 5 | 0x014 | Fault | Divide by zero | |
| 6–7 | 0x018-0x01C | _ | Reserved | |
| 8 | 0x020 | Fault | Privilege violation | |
| 9 | 0x024 | Next | Trace | |
| 10 | 0x028 | Fault | Unimplemented line-A opcode | |
| 11 | 0x02C | Fault | Unimplemented line-F opcode | |
| 12 | 0x030 | Next | Debug interrupt | |
| 13 | 0x034 | _ | Reserved | |
| 14 | 0x038 | Fault | Format error | |
| 15–23 | 0x03C-0x05C | _ | Reserved | |
| 24 | 0x060 | Next | Spurious interrupt | |
| 25–31 | 0x064-0x07C | | Reserved | |

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| Vector Number(s) | Vector Offset (Hex) | Stacked Program Counter | Assignment | | |
|---------------------|------------------------|-------------------------------|----------------------------|--|--|
| 32–47 | 0x080-0x0BC | Next | Trap # 0-15 instructions | | |
| 48–63 | 0x0C0-0x0FC | _ | Reserved | | |
| 64–255 | 0x100-0x3FC | Next | Device-specific interrupts | | |

Table 3-5. Exception Vector Assignments (continued)

All ColdFire processors inhibit interrupt sampling during the first instruction of all exception handlers. This allows any handler to disable interrupts effectively, if necessary, by raising the interrupt mask level contained in the status register. In addition, the ISA_A+ architecture includes an instruction (STLDSR) that stores the current interrupt mask level and loads a value into the SR. This instruction is specifically intended for use as the first instruction of an interrupt service routine that services multiple interrupt requests with different interrupt levels. For more details, see *ColdFire Family Programmer's Reference Manual*.

3.3.3.1 Exception Stack Frame Definition

Figure 3-16 shows exception stack frame. The first longword contains the 16-bit format/vector word (F/V) and the 16-bit status register, and the second longword contains the 32-bit program counter address.

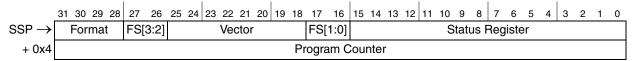


Figure 3-16. Exception Stack Frame Form

The 16-bit format/vector word contains three unique fields:

• A 4-bit format field at the top of the system stack is always written with a value of 4, 5, 6, or 7 by the processor, indicating a two-longword frame format. See Table 3-6.

SSP @ 1st Original SSP @ Time Instruction of **Format Field** of Exception, Bits 1:0 Handler 00 Original SSP - 8 0100 01 Original SSP - 9 0101 Original SSP - 10 10 0110 11 Original SSP - 11 0111

Table 3-6. Format Field Encodings

• There is a 4-bit fault status field, FS[3:0], at the top of the system stack. This field is defined for access and address errors only and written as zeros for all other exceptions. See Table 3-7.

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Fault refers to the PC of the instruction that caused the exception. Next refers to the PC of the instruction that follows the instruction that caused the fault.



Table 3-7. Fault Status Encodings

| FS[3:0] | Definition |
|--------------|--|
| 00 <i>xx</i> | Reserved |
| 0100 | Error on instruction fetch |
| 0101 | Reserved |
| 011x | Reserved |
| 1000 | Error on operand write |
| 1001 | Attempted write to write-protected space |
| 101x | Reserved |
| 1100 | Error on operand read |
| 1101 | Reserved |
| 111x | Reserved |

• The 8-bit vector number, vector[7:0], defines the exception type and is calculated by the processor for all internal faults and represents the value supplied by the interrupt controller in case of an interrupt. See Table 3-5.

3.3.4 Processor Exceptions

3.3.4.1 Access Error Exception

The exact processor response to an access error depends on the memory reference being performed. For an instruction fetch, the processor postpones the error reporting until the faulted reference is needed by an instruction for execution. Therefore, faults during instruction prefetches followed by a change of instruction flow do not generate an exception. When the processor attempts to execute an instruction with a faulted opword and/or extension words, the access error is signaled and the instruction is aborted. For this type of exception, the programming model has not been altered by the instruction generating the access error.

If the access error occurs on an operand read, the processor immediately aborts the current instruction's execution and initiates exception processing. In this situation, any address register updates attributable to the auto-addressing modes, (for example, (An)+,-(An)), have already been performed, so the programming model contains the updated An value. In addition, if an access error occurs during a MOVEM instruction loading from memory, any registers already updated before the fault occurs contain the operands from memory.

The V2 ColdFire processor uses an imprecise reporting mechanism for access errors on operand writes. Because the actual write cycle may be decoupled from the processor's issuing of the operation, the signaling of an access error appears to be decoupled from the instruction that generated the write. Accordingly, the PC contained in the exception stack frame merely represents the location in the program when the access error was signaled. All programming model updates associated with the write instruction are completed. The NOP instruction can collect access errors for writes. This instruction delays its



execution until all previous operations, including all pending write operations, are complete. If any previous write terminates with an access error, it is guaranteed to be reported on the NOP instruction.

3.3.4.2 Address Error Exception

Any attempted execution transferring control to an odd instruction address (if bit 0 of the target address is set) results in an address error exception.

Any attempted use of a word-sized index register (Xn.w) or a scale factor of eight on an indexed effective addressing mode generates an address error, as does an attempted execution of a full-format indexed addressing mode, which is defined by bit 8 of extension word 1 being set.

If an address error occurs on a JSR instruction, the Version 2 ColdFire processor calculates the target address then the return address is pushed onto the stack. If an address error occurs on an RTS instruction, the Version 2 ColdFire processor overwrites the faulting return PC with the address error stack frame.

3.3.4.3 Illegal Instruction Exception

The ColdFire variable-length instruction set architecture supports three instruction sizes: 16, 32, or 48 bits. The first instruction word is known as the operation word (or opword), while the optional words are known as extension word 1 and extension word 2. The opword is further subdivided into three sections: the upper four bits segment the entire ISA into 16 instruction lines, the next 6 bits define the operation mode (opmode), and the low-order 6 bits define the effective address. See Figure 3-17. The opword line definition is shown in Table 3-8.

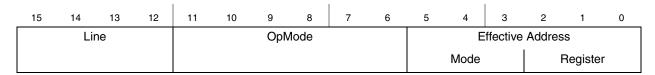


Figure 3-17. ColdFire Instruction Operation Word (Opword) Format

Table 3-8. ColdFire Opword Line Definition

| Opword[Line] | Instruction Class |
|--------------|--|
| 0x0 | Bit manipulation, Arithmetic and Logical Immediate |
| 0x1 | Move Byte |
| 0x2 | Move Long |
| 0x3 | Move Word |
| 0x4 | Miscellaneous |
| 0x5 | Add (ADDQ) and Subtract Quick (SUBQ), Set according to Condition Codes (Scc) |
| 0x6 | PC-relative change-of-flow instructions Conditional (Bcc) and unconditional (BRA) branches, subroutine calls (BSR) |
| 0x7 | Move Quick (MOVEQ), Move with sign extension (MVS) and zero fill (MVZ) |
| 0x8 | Logical OR (OR) |
| 0x9 | Subtract (SUB), Subtract Extended (SUBX) |

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Table 3-8. ColdFire Opword Line Definition (continued)

| Opword[Line] | Instruction Class | | | | |
|--------------|---|--|--|--|--|
| 0xA | EMAC, Move 3-bit Quick (MOV3Q) | | | | |
| 0xB | Compare (CMP), Exclusive-OR (EOR) | | | | |
| 0xC | Logical AND (AND), Multiply Word (MUL) | | | | |
| 0xD | Add (ADD), Add Extended (ADDX) | | | | |
| 0xE | Arithmetic and logical shifts (ASL, ASR, LSL, LSR) | | | | |
| 0xF | Cache Push (CPUSHL), Write DDATA (WDDATA), Write Debug (WDEBUG) | | | | |

In the original M68000 ISA definition, lines A and F were effectively reserved for user-defined operations (line A) and co-processor instructions (line F). Accordingly, there are two unique exception vectors associated with illegal opwords in these two lines.

Any attempted execution of an illegal 16-bit opcode (except for line-A and line-F opcodes) generates an illegal instruction exception (vector 4). Additionally, any attempted execution of any non-MAC line-A and most line-F opcodes generate their unique exception types, vector numbers 10 and 11, respectively. ColdFire cores do not provide illegal instruction detection on the extension words on any instruction, including MOVEC.

3.3.4.4 Divide-By-Zero

Attempting to divide by zero causes an exception (vector 5, offset equal 0x014).

3.3.4.5 Privilege Violation

The attempted execution of a supervisor mode instruction while in user mode generates a privilege violation exception. See *ColdFire Programmer's Reference Manual* for a list of supervisor-mode instructions

There is one special case involving the HALT instruction. Normally, this opcode is a supervisor mode instruction, but if the debug module's CSR[UHE] is set, then this instruction can be also be executed in user mode for debugging purposes.

3.3.4.6 Trace Exception

To aid in program development, all ColdFire processors provide an instruction-by-instruction tracing capability. While in trace mode, indicated by setting of the SR[T] bit, the completion of an instruction execution (for all but the stop instruction) signals a trace exception. This functionality allows a debugger to monitor program execution.

The stop instruction has the following effects:

- 1. The instruction before the stop executes and then generates a trace exception. In the exception stack frame, the PC points to the stop opcode.
- 2. When the trace handler is exited, the stop instruction executes, loading the SR with the immediate operand from the instruction.

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3. The processor then generates a trace exception. The PC in the exception stack frame points to the instruction after the stop, and the SR reflects the value loaded in the previous step.

If the processor is not in trace mode and executes a stop instruction where the immediate operand sets SR[T], hardware loads the SR and generates a trace exception. The PC in the exception stack frame points to the instruction after the stop, and the SR reflects the value loaded in step 2.

Because ColdFire processors do not support any hardware stacking of multiple exceptions, it is the responsibility of the operating system to check for trace mode after processing other exception types. As an example, consider a TRAP instruction execution while in trace mode. The processor initiates the trap exception and then passes control to the corresponding handler. If the system requires that a trace exception be processed, it is the responsibility of the trap exception handler to check for this condition (SR[T] in the exception stack frame set) and pass control to the trace handler before returning from the original exception.

3.3.4.7 **Unimplemented Line-A Opcode**

A line-A opcode is defined when bits 15-12 of the opword are 0b1010. This exception is generated by the attempted execution of an undefined line-A opcode.

3.3.4.8 **Unimplemented Line-F Opcode**

A line-F opcode is defined when bits 15-12 of the opword are 0b1111. This exception is generated when attempting to execute an undefined line-F opcode.

Debug Interrupt 3.3.4.9

See Chapter 33, "Debug Module," for a detailed explanation of this exception, which is generated in response to a hardware breakpoint register trigger. The processor does not generate an IACK cycle, but rather calculates the vector number internally (vector number 12). Additionally, SR[M,I] are unaffected by the interrupt.

RTE and Format Error Exception 3.3.4.10

When an RTE instruction is executed, the processor first examines the 4-bit format field to validate the frame type. For a ColdFire core, any attempted RTE execution (where the format is not equal to {4,5,6,7}) generates a format error. The exception stack frame for the format error is created without disturbing the original RTE frame and the stacked PC pointing to the RTE instruction.

The selection of the format value provides some limited debug support for porting code from M68000 applications. On M68000 family processors, the SR was located at the top of the stack. On those processors, bit 30 of the longword addressed by the system stack pointer is typically zero. Thus, if an RTE is attempted using this old format, it generates a format error on a ColdFire processor.

If the format field defines a valid type, the processor: (1) reloads the SR operand, (2) fetches the second longword operand, (3) adjusts the stack pointer by adding the format value to the auto-incremented address after the fetch of the first longword, and then (4) transfers control to the instruction address defined by the second longword operand within the stack frame.

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3.3.4.11 TRAP Instruction Exception

The TRAP #n instruction always forces an exception as part of its execution and is useful for implementing system calls. The TRAP instruction may be used to change from user to supervisor mode.

3.3.4.12 Unsupported Instruction Exception

If execution of a valid instruction is attempted but the required hardware is not present in the processor, an unsupported instruction exception is generated. The instruction functionality can then be emulated in the exception handler, if desired.

All ColdFire cores record the processor hardware configuration in the D0 register immediately after the negation of RESET. See Section 3.3.4.15, "Reset Exception," for details.

3.3.4.13 Interrupt Exception

Interrupt exception processing includes interrupt recognition and the fetch of the appropriate vector from the interrupt controller using an IACK cycle. See Chapter 16, "Interrupt Controller Module," for details on the interrupt controller.

3.3.4.14 Fault-on-Fault Halt

If a ColdFire processor encounters any type of fault during the exception processing of another fault, the processor immediately halts execution with the catastrophic fault-on-fault condition. A reset is required to to exit this state.

3.3.4.15 Reset Exception

Asserting the reset input signal (RESET) to the processor causes a reset exception. The reset exception has the highest priority of any exception; it provides for system initialization and recovery from catastrophic failure. Reset also aborts any processing in progress when the reset input is recognized. Processing cannot be recovered.

The reset exception places the processor in the supervisor mode by setting the SR[S] bit and disables tracing by clearing the SR[T] bit. This exception also clears the SR[M] bit and sets the processor's SR[I] field to the highest level (level 7, 0b111). Next, the VBR is initialized to zero (0x0000_0000). The control registers specifying the operation of any memories (e.g., cache and/or RAM modules) connected directly to the processor are disabled.

NOTE

Other implementation-specific registers are also affected. Refer to each module in this reference manual for details on these registers.

After the processor is granted the bus, it performs two longword read-bus cycles. The first longword at address $0x0000_0000$ is loaded into the supervisor stack pointer and the second longword at address $0x0000_0004$ is loaded into the program counter. After the initial instruction is fetched from memory, program execution begins at the address in the PC. If an access error or address error occurs before the first instruction is executed, the processor enters the fault-on-fault state.

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ColdFire processors load hardware configuration information into the D0 and D1 general-purpose registers after system reset. The hardware configuration information is loaded immediately after the reset-in signal is negated. This allows an emulator to read out the contents of these registers via the BDM to determine the hardware configuration.

Information loaded into D0 defines the processor hardware configuration as shown in Figure 3-18.

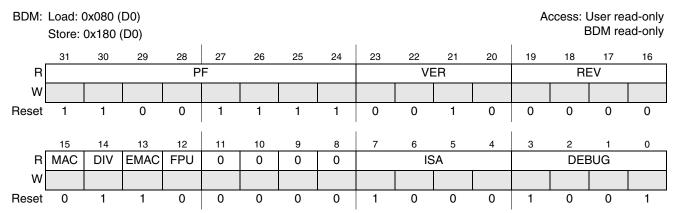


Figure 3-18. D0 Hardware Configuration Info

Table 3-9. D0 Hardware Configuration Info Field Description

| Field | Description |
|--------------|---|
| 31–24 PF | Processor family. This field is fixed to a hex value of 0xCF indicating a ColdFire core is present. |
| 23–20 VER | ColdFire core version number. Defines the hardware microarchitecture version of ColdFire core. 0001 V1 ColdFire core 0010 V2 ColdFire core (This is the value used for this device.) 0011 V3 ColdFire core 0100 V4 ColdFire core 0101 V5 ColdFire core Else Reserved for future use |
| 19–16 REV | Processor revision number. The default is 0b0000. |
| 15 MAC | MAC present. This bit signals if the optional multiply-accumulate (MAC) execution engine is present in processor core. 0 MAC execute engine not present in core. (This is the value used for this device.) 1 MAC execute engine is present in core. |
| 14 DIV | Divide present. This bit signals if the hardware divider (DIV) is present in the processor core. 0 Divide execute engine not present in core. 1 Divide execute engine is present in core. (This is the value used for this device.) |
| 13 EMAC | EMAC present. This bit signals if the optional enhanced multiply-accumulate (EMAC) execution engine is present in processor core. 0 EMAC execute engine not present in core. 1 EMAC execute engine is present in core. (This is the value used for this device.) |
| 12 FPU | FPU present. This bit signals if the optional floating-point (FPU) execution engine is present in processor core. 0 FPU execute engine not present in core. (This is the value used for this device.) 1 FPU execute engine is present in core. |

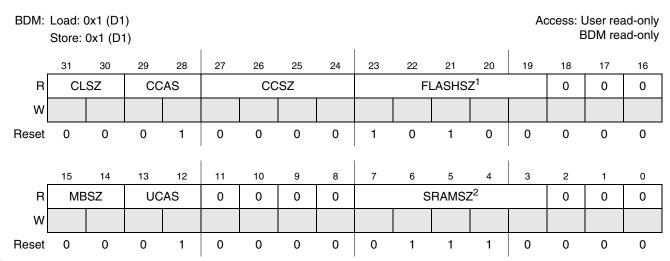


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Table 3-9. D0 Hardware Configuration Info Field Description (continued)

| Field | Description |
|--------------|--|
| 11–8 | Reserved. |
| 7–4 ISA | ISA revision. Defines the instruction-set architecture (ISA) revision level implemented in ColdFire processor core. 0000 ISA_A 0001 ISA_B 0010 ISA_C 1000 ISA_A+ (This is the value used for this device.) Else Reserved |
| 3–0 DEBUG | Debug module revision number. Defines revision level of the debug module used in the ColdFire processor core. 0000 DEBUG_A 0001 DEBUG_B 0010 DEBUG_C 0011 DEBUG_D 0100 DEBUG_E 1001 DEBUG_B+ (This is the value used for this device.) 1011 DEBUG_D+ 1111 DEBUG_D+PST Buffer Else Reserved |

Information loaded into D1 defines the local memory hardware configuration as shown in the figure below.



¹ The FLASHSZ size depends on memory size. The size shown is for 256 KB flash.

Figure 3-19. D1 Hardware Configuration Info

² The SRAMSZ size depends on memory size. The size shown is for 16 KB SRAM.



Table 3-10. D1 Hardware Configuration Information Field Description

| Field | Description |
|------------------|---|
| 31–30 CLSZ | Cache line size. This field is fixed to a hex value of 0x0 indicating a 16-byte cache line size. |
| 29–28 CCAS | Configurable cache associativity. 00 Four-way 01 Direct mapped (This is the value used for this device) Else Reserved for future use |
| 27–24 CCSZ | Configurable cache size. Indicates the amount of instruction/data cache. The cache configuration options available are 50% instruction/50% data, 100% instruction, or 100% data, and are specified in the CACR register. No configurable cache (This is the value used for this device) 1 KB configurable cache 1 KB configurable cache |
| 23–19 FLASHSZ | Flash bank size. 00000-01110 No flash 10000 64 KB flash 10010 128 KB flash 10011 96 KB flash 10100 256 KB flash (This is the value used for this device) 10110 512 KB flash Else Reserved for future use |
| 18–16 | Reserved |
| 15–14 MBSZ | Bus size. Defines the width of the ColdFire master bus datapath. 00 32-bit system bus datapath (This is the value used for this device) 01 64-bit system bus datapath Else Reserved |
| 13–8 | Reserved, resets to 0b01_0000 |
| 7–3 SRAMSZ | SRAM bank size. 00000 No SRAM 00010 512 bytes 00100 1 KB 00110 2 KB 01000 4 KB 01010 8 KB 01100 16 KB 01111 24 KB 01111 32 KB (This is the value used for this device) 10000 64 KB 10010 128 KB Else Reserved for future use |
| 2–0 | Reserved. |

The following three CACR bits are implemented in this device:

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| Field | Description |
|-------------|---|
| 10 CEIB | Cache enable non-cacheable instruction bursting. Setting this bit enables the line-fill buffer to be loaded with burst transfers under control of CLNF[1:0] for non-cacheable accesses. Non-cacheable accesses are never written into the memory array. 0 Disable burst fetches on non-cacheable accesses 1 Enable burst fetches on non-cacheable accesses |
| 8 DBWE | Default buffered write enable. This bit defines the default value for enabling buffered writes. If DBWE = 0, the termination of an operand write cycle on the processor's local bus is delayed until the external bus cycle is completed. If DBWE = 1, the write cycle on the local bus is terminated immediately and the operation buffered in the bus controller. In this mode, operand write cycles are effectively decoupled between the processor's local bus and the external bus. Generally, enabled buffered writes provide higher system performance but recovery from access errors can be more difficult. For the ColdFire core, reporting access errors on operand writes is always imprecise and enabling buffered writes further decouples the write instruction and the signaling of the fault 0 Disable buffered writes |
| 4 EUSP | Enable user stack pointer. See Section 3.2.3, "Supervisor/User Stack Pointers (A7 and OTHER_A7)"for more information on the dual stack pointer implementation. 0 Disable the processor's use of the User Stack Pointer 1 Enable the processor's use of the User Stack Pointer |
| 1–0 CLNF | Cache line fill. These bits control the size of the memory request the cache issues to the bus controller for different initial instruction line access offsets. |

3.3.5 Instruction Execution Timing

This section presents processor instruction execution times in terms of processor-core clock cycles. The number of operand references for each instruction is enclosed in parentheses following the number of processor clock cycles. Each timing entry is presented as C(R/W) where:

- C is the number of processor clock cycles, including all applicable operand fetches and writes, and all internal core cycles required to complete the instruction execution.
- R/W is the number of operand reads (R) and writes (W) required by the instruction. An operation performing a read-modify-write function is denoted as (1/1).

This section includes the assumptions concerning the timing values and the execution time details.

3.3.5.1 Timing Assumptions

For the timing data presented in this section, these assumptions apply:

- 1. The OEP is loaded with the opword and all required extension words at the beginning of each instruction execution. This implies that the OEP does not wait for the IFP to supply opwords and/or extension words.
- 2. The OEP does not experience any sequence-related pipeline stalls. The most common example of stall involves consecutive store operations, excluding the MOVEM instruction. For all STORE operations (except MOVEM), certain hardware resources within the processor are marked as busy for two clock cycles after the final decode and select/operand fetch cycle (DSOC) of the store instruction. If a subsequent STORE instruction is encountered within this 2-cycle window, it is

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- stalled until the resource again becomes available. Thus, the maximum pipeline stall involving consecutive STORE operations is two cycles. The MOVEM instruction uses a different set of resources and this stall does not apply.
- 3. The OEP completes all memory accesses without any stall conditions caused by the memory itself. Thus, the timing details provided in this section assume that an infinite zero-wait state memory is attached to the processor core.
- 4. All operand data accesses are aligned on the same byte boundary as the operand size; for example, 16-bit operands aligned on 0-modulo-2 addresses, 32-bit operands aligned on 0-modulo-4 addresses.

The processor core decomposes misaligned operand references into a series of aligned accesses as shown in Table 3-11.

| address[1:0] | Size | Bus Operations | Additional C(R/W) |
|--------------|------|---------------------|-----------------------------------|
| 01 or 11 | Word | Byte, Byte | 2(1/0) if read 1(0/1) if write |
| 01 or 11 | Long | Byte, Word, Byte | 3(2/0) if read 2(0/2) if write |
| 10 | Long | Word, Word | 2(1/0) if read 1(0/1) if write |

Table 3-11. Misaligned Operand References

3.3.5.2 MOVE Instruction Execution Times

Table 3-12 lists execution times for MOVE. {B,W} instructions; Table 3-13 lists timings for MOVE.L.

NOTE

For all tables in this section, the execution time of any instruction using the PC-relative effective addressing modes is the same for the comparable An-relative mode.

$$ET \ with \ \{ = (d16,PC)\} \\ ET \ with \ \{ = (d8,PC,Xi*SF)\} \\ equals \ ET \ with \ \{ = (d8,An,Xi*SF)$$

The nomenclature xxx.wl refers to both forms of absolute addressing, xxx.w and xxx.l.

| Source | Destination | | | | | | |
|--------|-------------|--------|--------|--------|----------|---------------|--------|
| | Rx | (Ax) | (Ax)+ | -(Ax) | (d16,Ax) | (d8,Ax,Xi*SF) | xxx.wl |
| Dy | 1(0/0) | 1(0/1) | 1(0/1) | 1(0/1) | 1(0/1) | 2(0/1) | 1(0/1) |
| Ау | 1(0/0) | 1(0/1) | 1(0/1) | 1(0/1) | 1(0/1) | 2(0/1) | 1(0/1) |
| (Ay) | 3(1/0) | 3(1/1) | 3(1/1) | 3(1/1) | 3(1/1) | 4(1/1)) | 3(1/1) |

Table 3-12. MOVE Byte and Word Execution Times

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Table 3-12. MOVE Byte and Word Execution Times (continued)

| Source | Destination | | | | | | |
|---------------|-------------|--------|--------|---------|----------|---------------|--------|
| | Rx | (Ax) | (Ax)+ | -(Ax) | (d16,Ax) | (d8,Ax,Xi*SF) | xxx.wl |
| (Ay)+ | 3(1/0) | 3(1/1) | 3(1/1) | 3(1/1) | 3(1/1) | 4(1/1)) | 3(1/1) |
| -(Ay) | 3(1/0) | 3(1/1) | 3(1/1) | 3(1/1) | 3(1/1) | 4(1/1)) | 3(1/1) |
| (d16,Ay) | 3(1/0) | 3(1/1) | 3(1/1) | 3(1/1) | 3(1/1) | _ | _ |
| (d8,Ay,Xi*SF) | 4(1/0) | 4(1/1) | 4(1/1) | 4(1/1) | _ | _ | _ |
| xxx.w | 3(1/0) | 3(1/1) | 3(1/1) | 3(1/1) | _ | _ | _ |
| xxx.l | 3(1/0) | 3(1/1) | 3(1/1) | 3(1/1) | _ | _ | _ |
| (d16,PC) | 3(1/0) | 3(1/1) | 3(1/1) | 3(1/1) | 3(1/1) | _ | _ |
| (d8,PC,Xi*SF) | 4(1/0) | 4(1/1) | 4(1/1) | 4(1/1)) | _ | _ | _ |
| #xxx | 1(0/0) | 3(0/1) | 3(0/1) | 3(0/1) | _ | _ | _ |

Table 3-13. MOVE Long Execution Times

| Source | Destination | | | | | | | | | | |
|---------------|-------------|--------|--------|--------|----------|---------------|--------|--|--|--|--|
| Source | Rx | (Ax) | (Ax)+ | -(Ax) | (d16,Ax) | (d8,Ax,Xi*SF) | xxx.wl | | | | |
| Dy | 1(0/0) | 1(0/1) | 1(0/1) | 1(0/1) | 1(0/1) | 2(0/1) | 1(0/1) | | | | |
| Ау | 1(0/0) | 1(0/1) | 1(0/1) | 1(0/1) | 1(0/1) | 2(0/1) | 1(0/1) | | | | |
| (Ay) | 2(1/0) | 2(1/1) | 2(1/1) | 2(1/1) | 2(1/1) | 3(1/1) | 2(1/1) | | | | |
| (Ay)+ | 2(1/0) | 2(1/1) | 2(1/1) | 2(1/1) | 2(1/1) | 3(1/1) | 2(1/1) | | | | |
| -(Ay) | 2(1/0) | 2(1/1) | 2(1/1) | 2(1/1) | 2(1/1) | 3(1/1) | 2(1/1) | | | | |
| (d16,Ay) | 2(1/0) | 2(1/1) | 2(1/1) | 2(1/1) | 2(1/1) | _ | _ | | | | |
| (d8,Ay,Xi*SF) | 3(1/0) | 3(1/1) | 3(1/1) | 3(1/1) | _ | _ | _ | | | | |
| XXX.W | 2(1/0) | 2(1/1) | 2(1/1) | 2(1/1) | _ | _ | _ | | | | |
| xxx.l | 2(1/0) | 2(1/1) | 2(1/1) | 2(1/1) | _ | _ | _ | | | | |
| (d16,PC) | 2(1/0) | 2(1/1) | 2(1/1) | 2(1/1) | 2(1/1) | _ | _ | | | | |
| (d8,PC,Xi*SF) | 3(1/0) | 3(1/1) | 3(1/1) | 3(1/1) | _ | _ | _ | | | | |
| #xxx | 1(0/0) | 2(0/1) | 2(0/1) | 2(0/1) | _ | _ | _ | | | | |

3.3.5.3 Standard One Operand Instruction Execution Times

Table 3-14. One Operand Instruction Execution Times

| Opcode | <ea></ea> | | Effective Address | | | | | | | | |
|---------|-----------|--------|-------------------|-------|-------|----------|---------------|--------|------|--|--|
| Opcode | \LA> | Rn | (An) | (An)+ | -(An) | (d16,An) | (d8,An,Xn*SF) | xxx.wl | #xxx | | |
| BITREV | Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ | | |
| BYTEREV | Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ | | |

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Table 3-14. One Operand Instruction Execution Times (continued)

| Opcode | <ea></ea> | | | | Effecti | ve Address | : | | |
|--------|-----------|--------|--------|--------|---------|------------|---------------|--------|--------|
| Opcode | <ea></ea> | Rn | (An) | (An)+ | -(An) | (d16,An) | (d8,An,Xn*SF) | xxx.wl | #xxx |
| CLR.B | <ea></ea> | 1(0/0) | 1(0/1) | 1(0/1) | 1(0/1) | 1(0/1) | 2(0/1) | 1(0/1) | _ |
| CLR.W | <ea></ea> | 1(0/0) | 1(0/1) | 1(0/1) | 1(0/1) | 1(0/1) | 2(0/1) | 1(0/1) | _ |
| CLR.L | <ea></ea> | 1(0/0) | 1(0/1) | 1(0/1) | 1(0/1) | 1(0/1) | 2(0/1) | 1(0/1) | _ |
| EXT.W | Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| EXT.L | Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| EXTB.L | Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| FF1 | Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| NEG.L | Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| NEGX.L | Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| NOT.L | Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| SCC | Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| SWAP | Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| TST.B | <ea></ea> | 1(0/0) | 3(1/0) | 3(1/0) | 3(1/0) | 3(1/0) | 4(1/0) | 3(1/0) | 1(0/0) |
| TST.W | <ea></ea> | 1(0/0) | 3(1/0) | 3(1/0) | 3(1/0) | 3(1/0) | 4(1/0) | 3(1/0) | 1(0/0) |
| TST.L | <ea></ea> | 1(0/0) | 2(1/0) | 2(1/0) | 2(1/0) | 2(1/0) | 3(1/0) | 2(1/0) | 1(0/0) |

3.3.5.4 Standard Two Operand Instruction Execution Times

Table 3-15. Two Operand Instruction Execution Times

| | | | | | Effe | ctive Addre | ess | | |
|--------|-----------------|--------|--------|--------|--------|----------------------|--------------------------------|--------|--------|
| Opcode | < EA > | Rn | (An) | (An)+ | -(An) | (d16,An) (d16,PC) | (d8,An,Xn*SF) (d8,PC,Xn*SF) | xxx.wl | #xxx |
| ADD.L | <ea>,Rx</ea> | 1(0/0) | 3(1/0) | 3(1/0) | 3(1/0) | 3(1/0) | 4(1/0) | 3(1/0) | 1(0/0) |
| ADD.L | Dy, <ea></ea> | _ | 3(1/1) | 3(1/1) | 3(1/1) | 3(1/1) | 4(1/1) | 3(1/1) | _ |
| ADDI.L | #imm,Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| ADDQ.L | #imm, <ea></ea> | 1(0/0) | 3(1/1) | 3(1/1) | 3(1/1) | 3(1/1) | 4(1/1) | 3(1/1) | _ |
| ADDX.L | Dy,Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| AND.L | <ea>,Rx</ea> | 1(0/0) | 3(1/0) | 3(1/0) | 3(1/0) | 3(1/0) | 4(1/0) | 3(1/0) | 1(0/0) |
| AND.L | Dy, <ea></ea> | _ | 3(1/1) | 3(1/1) | 3(1/1) | 3(1/1) | 4(1/1) | 3(1/1) | _ |
| ANDI.L | #imm,Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| ASL.L | <ea>,Dx</ea> | 1(0/0) | _ | _ | _ | _ | _ | _ | 1(0/0) |
| ASR.L | <ea>,Dx</ea> | 1(0/0) | _ | _ | _ | _ | _ | _ | 1(0/0) |
| BCHG | Dy, <ea></ea> | 2(0/0) | 4(1/1) | 4(1/1) | 4(1/1) | 4(1/1) | 5(1/1) | 4(1/1) | _ |



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Table 3-15. Two Operand Instruction Execution Times (continued)

| | | | | | Effe | ctive Addre | ess | | |
|---------|-----------------|----------|----------|----------|----------|----------------------|--------------------------------|---------|---------|
| Opcode | < EA > | Rn | (An) | (An)+ | -(An) | (d16,An) (d16,PC) | (d8,An,Xn*SF) (d8,PC,Xn*SF) | xxx.wl | #xxx |
| BCHG | #imm, <ea></ea> | 2(0/0) | 4(1/1) | 4(1/1) | 4(1/1) | 4(1/1) | _ | _ | _ |
| BCLR | Dy, <ea></ea> | 2(0/0) | 4(1/1) | 4(1/1) | 4(1/1) | 4(1/1) | 5(1/1) | 4(1/1) | |
| BCLR | #imm, <ea></ea> | 2(0/0) | 4(1/1) | 4(1/1) | 4(1/1) | 4(1/1) | _ | _ | |
| BSET | Dy, <ea></ea> | 2(0/0) | 4(1/1) | 4(1/1) | 4(1/1) | 4(1/1) | 5(1/1) | 4(1/1) | _ |
| BSET | #imm, <ea></ea> | 2(0/0) | 4(1/1) | 4(1/1) | 4(1/1) | 4(1/1) | _ | _ | _ |
| BTST | Dy, <ea></ea> | 2(0/0) | 3(1/0) | 3(1/0) | 3(1/0) | 3(1/0) | 4(1/0) | 3(1/0) | |
| BTST | #imm, <ea></ea> | 1(0/0) | 3(1/0) | 3(1/0) | 3(1/0) | 3(1/0) | _ | _ | _ |
| CMP.L | <ea>,Rx</ea> | 1(0/0) | 3(1/0) | 3(1/0) | 3(1/0) | 3(1/0) | 4(1/0) | 3(1/0) | 1(0/0) |
| CMPI.L | #imm,Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| DIVS.W | <ea>,Dx</ea> | 20(0/0) | 23(1/0) | 23(1/0) | 23(1/0) | 23(1/0) | 24(1/0) | 23(1/0) | 20(0/0) |
| DIVU.W | <ea>,Dx</ea> | 20(0/0) | 23(1/0) | 23(1/0) | 23(1/0) | 23(1/0) | 24(1/0) | 23(1/0) | 20(0/0) |
| DIVS.L | <ea>,Dx</ea> | ≤35(0/0) | ≤38(1/0) | ≤38(1/0) | ≤38(1/0) | ≤38(1/0) | _ | _ | _ |
| DIVU.L | <ea>,Dx</ea> | ≤35(0/0) | ≤38(1/0) | ≤38(1/0) | ≤38(1/0) | ≤38(1/0) | _ | _ | _ |
| EOR.L | Dy, <ea></ea> | 1(0/0) | 3(1/1) | 3(1/1) | 3(1/1) | 3(1/1) | 4(1/1) | 3(1/1) | _ |
| EORI.L | #imm,Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| LEA | <ea>,Ax</ea> | _ | 1(0/0) | _ | _ | 1(0/0) | 2(0/0) | 1(0/0) | _ |
| LSL.L | <ea>,Dx</ea> | 1(0/0) | _ | _ | _ | _ | _ | _ | 1(0/0) |
| LSR.L | <ea>,Dx</ea> | 1(0/0) | _ | _ | _ | _ | _ | _ | 1(0/0) |
| MOVEQ.L | #imm,Dx | _ | _ | _ | _ | _ | _ | _ | 1(0/0) |
| OR.L | <ea>,Rx</ea> | 1(0/0) | 3(1/0) | 3(1/0) | 3(1/0) | 3(1/0) | 4(1/0) | 3(1/0) | 1(0/0) |
| OR.L | Dy, <ea></ea> | _ | 3(1/1) | 3(1/1) | 3(1/1) | 3(1/1) | 4(1/1) | 3(1/1) | _ |
| ORI.L | #imm,Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| REMS.L | <ea>,Dx</ea> | ≤35(0/0) | ≤38(1/0) | ≤38(1/0) | ≤38(1/0) | ≤38(1/0) | _ | _ | _ |
| REMU.L | <ea>,Dx</ea> | ≤35(0/0) | ≤38(1/0) | ≤38(1/0) | ≤38(1/0) | ≤38(1/0) | _ | _ | _ |
| SUB.L | <ea>,Rx</ea> | 1(0/0) | 3(1/0) | 3(1/0) | 3(1/0) | 3(1/0) | 4(1/0) | 3(1/0) | 1(0/0) |
| SUB.L | Dy, <ea></ea> | _ | 3(1/1) | 3(1/1) | 3(1/1) | 3(1/1) | 4(1/1) | 3(1/1) | _ |
| SUBI.L | #imm,Dx | 1(0/0) | _ | _ | _ | _ | | | _ |
| SUBQ.L | #imm, <ea></ea> | 1(0/0) | 3(1/1) | 3(1/1) | 3(1/1) | 3(1/1) | 4(1/1) 3(1/1) | | _ |
| SUBX.L | Dy,Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |

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3.3.5.5 Miscellaneous Instruction Execution Times

Table 3-16. Miscellaneous Instruction Execution Times

| | | | | | Effecti | ve Address | | | |
|---------|-------------------------|--------|----------|--------|---------|------------|---------------|--------|---------------------|
| Opcode | < EA > | Rn | (An) | (An)+ | -(An) | (d16,An) | (d8,An,Xn*SF) | xxx.wl | #xxx |
| CPUSHL | (Ax) | _ | 11(0/1) | _ | _ | _ | _ | _ | _ |
| LINK.W | Ay,#imm | 2(0/1) | _ | _ | _ | _ | _ | _ | _ |
| MOVE.L | Ay,USP | 3(0/0) | _ | _ | _ | _ | _ | _ | _ |
| MOVE.L | USP,Ax | 3(0/0) | _ | _ | _ | _ | _ | _ | _ |
| MOVE.W | CCR,Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| MOVE.W | <ea>,CCR</ea> | 1(0/0) | _ | _ | _ | _ | _ | _ | 1(0/0) |
| MOVE.W | SR,Dx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| MOVE.W | <ea>,SR</ea> | 7(0/0) | _ | _ | _ | _ | _ | _ | 7(0/0) ² |
| MOVEC | Ry,Rc | 9(0/1) | _ | _ | _ | _ | _ | _ | _ |
| MOVEM.L | <ea>, and list</ea> | _ | 1+n(n/0) | _ | _ | 1+n(n/0) | _ | _ | _ |
| MOVEM.L | and list, <ea></ea> | _ | 1+n(0/n) | _ | _ | 1+n(0/n) | _ | _ | _ |
| NOP | | 3(0/0) | _ | _ | _ | _ | _ | _ | _ |
| PEA | <ea></ea> | _ | 2(0/1) | _ | _ | 2(0/1) 4 | 3(0/1) 5 | 2(0/1) | _ |
| PULSE | | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| STLDSR | #imm | _ | _ | _ | _ | _ | _ | _ | 5(0/1) |
| STOP | #imm | _ | _ | _ | _ | _ | _ | _ | 3(0/0) ³ |
| TRAP | #imm | _ | _ | _ | _ | _ | _ | _ | 15(1/2) |
| TPF | | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| TPF.W | | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| TPF.L | | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| UNLK | Ax | 2(1/0) | _ | _ | _ | _ | _ | _ | _ |
| WDDATA | <ea></ea> | _ | 3(1/0) | 3(1/0) | 3(1/0) | 3(1/0) | 4(1/0) | 3(1/0) | _ |
| WDEBUG | <ea></ea> | _ | 5(2/0) | _ | _ | 5(2/0) | _ | _ | _ |

¹The n is the number of registers moved by the MOVEM opcode.

²If a MOVE.W #imm,SR instruction is executed and imm[13] equals 1, the execution time is 1(0/0).

³The execution time for STOP is the time required until the processor begins sampling continuously for interrupts.

⁴PEA execution times are the same for (d16,PC).

⁵PEA execution times are the same for (d8,PC,Xn*SF).

3.3.5.6 EMAC Instruction Execution Times

Table 3-17. EMAC Instruction Execution Times

| | | | | | Effectiv | e Address | 3 | | |
|--------|---|---------------------|-------|-------|----------|--------------------|-------------------|--------|--------|
| Opcode | <ea></ea> | Rn | (An) | (An)+ | -(An) | (d16,An) | (d8,An, Xn*SF) | xxx.wl | #xxx |
| MAC.L | Ry, Rx, Raccx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| MAC.L | Ry, Rx, <ea>, Rw, Raccx</ea> | _ | (1/0) | (1/0) | (1/0) | (1/0) ¹ | _ | _ | _ |
| MAC.W | Ry, Rx, Raccx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| MAC.W | Ry, Rx, <ea>, Rw, Raccx</ea> | _ | (1/0) | (1/0) | (1/0) | (1/0) ¹ | _ | _ | _ |
| MOVE.L | <ea>y, Raccx</ea> | 1(0/0) | _ | _ | _ | _ | _ | _ | 1(0/0) |
| MOVE.L | Raccy, Raccx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| MOVE.L | <ea>y, MACSR</ea> | 5(0/0) | _ | _ | _ | _ | _ | _ | 5(0/0) |
| MOVE.L | <ea>y, Rmask</ea> | 4(0/0) | _ | _ | _ | _ | _ | _ | 4(0/0) |
| MOVE.L | <ea>y,Raccext01</ea> | 1(0/0) | _ | _ | _ | _ | _ | _ | 1(0/0) |
| MOVE.L | <ea>y,Raccext23</ea> | 1(0/0) | _ | _ | _ | _ | _ | _ | 1(0/0) |
| MOVE.L | Raccx, <ea>x</ea> | 1(0/0) ² | _ | _ | _ | _ | _ | _ | _ |
| MOVE.L | MACSR, <ea>x</ea> | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| MOVE.L | Rmask, <ea>x</ea> | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| MOVE.L | Raccext01, <ea.x< td=""><td>1(0/0)</td><td>_</td><td>_</td><td>_</td><td>_</td><td>_</td><td>_</td><td>_</td></ea.x<> | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| MOVE.L | Raccext23, <ea>x</ea> | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| MSAC.L | Ry, Rx, Raccx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| MSAC.W | Ry, Rx, Raccx | 1(0/0) | _ | _ | _ | _ | _ | _ | _ |
| MSAC.L | Ry, Rx, <ea>, Rw, Raccx</ea> | _ | (1/0) | (1/0) | (1/0) | (1/0) ¹ | _ | _ | _ |
| MSAC.W | Ry, Rx, <ea>, Rw, Raccx</ea> | _ | (1/0) | (1/0) | (1/0) | (1/0) ¹ | _ | _ | _ |
| MULS.L | <ea>y, Dx</ea> | 4(0/0) | (1/0) | (1/0) | (1/0) | (1/0) | _ | _ | _ |
| MULS.W | <ea>y, Dx</ea> | 4(0/0) | (1/0) | (1/0) | (1/0) | (1/0) | (1/0) | (1/0) | 4(0/0) |
| MULU.L | <ea>y, Dx</ea> | 4(0/0) | (1/0) | (1/0) | (1/0) | (1/0) | | | |
| MULU.W | <ea>y, Dx</ea> | 4(0/0) | (1/0) | (1/0) | (1/0) | (1/0) | (1/0) | (1/0) | 4(0/0) |

¹ Effective address of (d16,PC) not supported

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Storing an accumulator requires one additional processor clock cycle when saturation is enabled, or fractional rounding is performed (MACSR[7:4] equals 1---, -11-, --11)



NOTE

The execution times for moving the contents of the Racc, Raccext[01,23], MACSR, or Rmask into a destination location <ea>x shown in this table represent the best-case scenario when the store instruction is executed and there are no load or M{S}AC instructions in the EMAC execution pipeline. In general, these store operations require only a single cycle for execution, but if preceded immediately by a load, MAC, or MSAC instruction, the depth of the EMAC pipeline is exposed and the execution time is four cycles.

3.3.5.7 Branch Instruction Execution Times

Table 3-18. General Branch Instruction Execution Times

| | | | Effective Address | | | | | | | | | |
|--------|---------------|----|-------------------|---------|-------|----------------------|--------------------------------|--------|------|--|--|--|
| Opcode | < EA > | Rn | (An) | (An)+ | -(An) | (d16,An) (d16,PC) | (d8,An,Xi*SF) (d8,PC,Xi*SF) | xxx.wl | #xxx | | | |
| BRA | | | _ | _ | _ | 2(0/1) | _ | _ | _ | | | |
| BSR | | _ | _ | _ | _ | 3(0/1) | _ | _ | _ | | | |
| JMP | <ea></ea> | _ | 3(0/0) | _ | _ | 3(0/0) | 4(0/0) | 3(0/0) | _ | | | |
| JSR | <ea></ea> | - | 3(0/1) | _ | _ | 3(0/1) | 4(0/1) | 3(0/1) | _ | | | |
| RTE | | _ | _ | 10(2/0) | _ | _ | _ | _ | _ | | | |
| RTS | | _ | _ | 5(1/0) | _ | _ | _ | _ | _ | | | |

Table 3-19. Bcc Instruction Execution Times

| Opcode | Forward | Forward | Backward | Backward |
|--------|---------|-----------|----------|-----------|
| | Taken | Not Taken | Taken | Not Taken |
| Всс | 3(0/0) | 1(0/0) | 2(0/0) | 3(0/0) |



Chapter 4 Enhanced Multiply-Accumulate Unit (EMAC)

4.1 Introduction

This chapter describes the functionality, microarchitecture, and performance of the enhanced multiply-accumulate (EMAC) unit in the ColdFire family of processors.

4.1.1 Overview

The EMAC design provides a set of DSP operations that can improve the performance of embedded code while supporting the integer multiply instructions of the baseline ColdFire architecture.

The MAC provides functionality in three related areas:

- 1. Signed and unsigned integer multiplication
- 2. Multiply-accumulate operations supporting signed and unsigned integer operands as well as signed, fixed-point, and fractional operands
- 3. Miscellaneous register operations

The ColdFire family supports two MAC implementations with different performance levels and capabilities. The original MAC features a three-stage execution pipeline optimized for 16-bit operands, with a 16x16 multiply array and a single 32-bit accumulator. The EMAC features a four-stage pipeline optimized for 32-bit operands, with a fully pipelined 32×32 multiply array and four 48-bit accumulators.

The first ColdFire MAC supported signed and unsigned integer operands and was optimized for 16x16 operations, such as those found in applications including servo control and image compression. As ColdFire-based systems proliferated, the desire for more precision on input operands increased. The result was an improved ColdFire MAC with user-programmable control to optionally enable use of fractional input operands.

EMAC improvements target three primary areas:

- Improved performance of 32×32 multiply operation.
- Addition of three more accumulators to minimize MAC pipeline stalls caused by exchanges between the accumulator and the pipeline's general-purpose registers
- A 48-bit accumulation data path to allow a 40-bit product, plus 8 extension bits increase the dynamic number range when implementing signal processing algorithms

The three areas of functionality are addressed in detail in following sections. The logic required to support this functionality is contained in a MAC module (Figure 4-1).



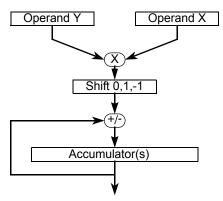


Figure 4-1. Multiply-Accumulate Functionality Diagram

4.1.1.1 Introduction to the MAC

The MAC is an extension of the basic multiplier in most microprocessors. It is typically implemented in hardware within an architecture and supports rapid execution of signal processing algorithms in fewer cycles than comparable non-MAC architectures. For example, small digital filters can tolerate some variance in an algorithm's execution time, but larger, more complicated algorithms such as orthogonal transforms may have more demanding speed requirements beyond scope of any processor architecture and may require full DSP implementation.

To balance speed, size, and functionality, the ColdFire MAC is optimized for a small set of operations that involve multiplication and cumulative additions. Specifically, the multiplier array is optimized for single-cycle pipelined operations with a possible accumulation after product generation. This functionality is common in many signal processing applications. The ColdFire core architecture is also modified to allow an operand to be fetched in parallel with a multiply, increasing overall performance for certain DSP operations.

Consider a typical filtering operation where the filter is defined as in Equation 4-1.

$$y(i) = \sum_{k=1}^{N-1} a(k)y(i-k) + \sum_{k=0}^{N-1} b(k)x(i-k)$$
Eqn. 4-1

Here, the output y(i) is determined by past output values and past input values. This is the general form of an infinite impulse response (IIR) filter. A finite impulse response (FIR) filter can be obtained by setting coefficients a(k) to zero. In either case, the operations involved in computing such a filter are multiplies and product summing. To show this point, reduce Equation 4-1 to a simple, four-tap FIR filter, shown in Equation 4-2, in which the accumulated sum is a past data values and coefficients sum.

$$y(i) = \sum_{k=0}^{3} b(k)x(i-k) = b(0)x(i) + b(1)x(i-1) + b(2)x(i-2) + b(3)x(i-3)$$
 Eqn. 4-2



4.2 Memory Map/Register Definition

The following table and sections explain the MAC registers:

Table 4-1. EMAC Memory Map

| BDM ¹ | Register | Width (bits) | Access | Reset Value | Section/Page |
|------------------|--|--------------|--------|-------------|--------------|
| 0x804 | MAC Status Register (MACSR) | 32 | R/W | 0x0000_0000 | 4.2.1/4-5 |
| 0x805 | MAC Address Mask Register (MASK) | 32 | R/W | 0xFFFF_FFFF | 4.2.2/4-7 |
| 0x806 | MAC Accumulator 0 (ACC0) | 32 | R/W | Undefined | 4.2.3/4-9 |
| 0x807 | MAC Accumulator 0,1 Extension Bytes (ACCext01) | 32 | R/W | Undefined | 4.2.4/4-9 |
| 0x808 | MAC Accumulator 2,3 Extension Bytes (ACCext23) | 32 | R/W | Undefined | 4.2.4/4-9 |
| 0x809 | MAC Accumulator 1 (ACC1) | 32 | R/W | Undefined | 4.2.3/4-9 |
| 0x80A | MAC Accumulator 2 (ACC2) | 32 | R/W | Undefined | 4.2.3/4-9 |
| 0x80B | MAC Accumulator 3 (ACC3) | 32 | R/W | Undefined | 4.2.3/4-9 |

¹ The values listed in this column represent the Rc field used when accessing the core registers via the BDM port. For more information see Chapter 33, "Debug Module."

4.2.1 MAC Status Register (MACSR)

The MAC status register (MACSR) contains a 4-bit operational mode field and condition flags. Operational mode bits control whether operands are signed or unsigned and whether they are treated as integers or fractions. These bits also control the overflow/saturation mode and the way in which rounding is performed. Negative, zero, and multiple overflow condition flags are also provided.

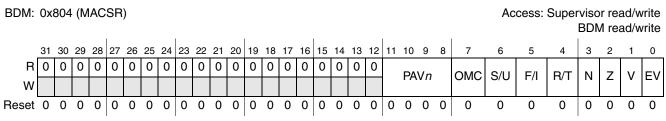


Figure 4-2. MAC Status Register (MACSR)



Table 4-2. MACSR Field Descriptions

| Field | Description |
|----------------------|--|
| 31–12 | Reserved, must be cleared. |
| 11–8 PAV <i>n</i> | Product/accumulation overflow flags. Contains four flags, one per accumulator, that indicate if past MAC or MSAC instructions generated an overflow during product calculation or the 48-bit accumulation. When a MAC or MSAC instruction is executed, the PAVn flag associated with the destination accumulator forms the general overflow flag, MACSR[V]. Once set, each flag remains set until V is cleared by a move.1, MACSR instruction or the accumulator is loaded directly. Bit 11: Accumulator 3 |
| | Bit 8: Accumulator 0 |
| 7 OMC | Overflow saturation mode. Enables or disables saturation mode on overflow. If set, the accumulator is set to the appropriate constant (see S/U field description) on any operation that overflows the accumulator. After saturation, the accumulator remains unaffected by any other MAC or MSAC instructions until the overflow bit is cleared or the accumulator is directly loaded. |
| 6 S/U | Signed/unsigned operations. In integer mode: S/U determines whether operations performed are signed or unsigned. It also determines the accumulator value during saturation, if enabled. O Signed numbers. On overflow, if OMC is enabled, an accumulator saturates to the most positive (0x7FFF_FFFF) or the most negative (0x8000_0000) number, depending on the instruction and the product value that overflowed. 1 Unsigned numbers. On overflow, if OMC is enabled, an accumulator saturates to the smallest value (0x0000_0000) or the largest value (0xFFFF_FFFF), depending on the instruction. In fractional mode: S/U controls rounding while storing an accumulator to a general-purpose register. O Move accumulator without rounding to a 16-bit value. Accumulator is moved to a general-purpose register as a 32-bit value. 1 The accumulator is rounded to a 16-bit value using the round-to-nearest (even) method when moved to a general-purpose register. See Section 4.3.1.1, "Rounding". The resulting 16-bit value is stored in the lower word of the destination register. The upper word is zero-filled. This rounding procedure does not affect the accumulator value. |
| 5 F/I | Fractional/integer mode. Determines whether input operands are treated as fractions or integers. O Integers can be represented in signed or unsigned notation, depending on the value of S/U. Fractions are represented in signed, fixed-point, two's complement notation. Values range from -1 to 1 - 2 ⁻¹⁵ for 16-bit fractions and -1 to 1 - 2 ⁻³¹ for 32-bit fractions. See Section 4.3.4, "Data Representation." |
| 4 R/T | Round/truncate mode. Controls rounding procedure for move.1 ACCx, Rx, or MSAC.L instructions when in fractional mode. Truncate. The product's lsbs are dropped before it is combined with the accumulator. Additionally, when a store accumulator instruction is executed (move.1 ACCx, Rx), the 8 lsbs of the 48-bit accumulator logic are truncated. Round-to-nearest (even). The 64-bit product of two 32-bit, fractional operands is rounded to the nearest 40-bit value. If the low-order 24 bits equal 0x80_0000, the upper 40 bits are rounded to the nearest even (lsb = 0) value. See Section 4.3.1.1, "Rounding". Additionally, when a store accumulator instruction is executed (move.1 ACCx, Rx), the lsbs of the 48-bit accumulator logic round the resulting 16- or 32-bit value. If MACSR[S/U] is cleared and MACSR[R/T] is set, the low-order 8 bits are used to round the resulting 32-bit fraction. If MACSR[S/U] is set, the low-order 24 bits are used to round the resulting 16-bit fraction. |

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Table 4-2. MACSR Field Descriptions (continued)

| Field | Description |
|---------|---|
| 3 N | Negative. Set if the msb of the result is set, otherwise cleared. N is affected only by MAC, MSAC, and load operations; it is not affected by MULS and MULU instructions. |
| 2 Z | Zero. Set if the result equals zero, otherwise cleared. This bit is affected only by MAC, MSAC, and load operations; it is not affected by MULS and MULU instructions. |
| 1 V | Overflow. Set if an arithmetic overflow occurs on a MAC or MSAC instruction, indicating that the result cannot be represented in the limited width of the EMAC. V is set only if a product overflow occurs or the accumulation overflows the 48-bit structure. V is evaluated on each MAC or MSAC operation and uses the appropriate PAV <i>n</i> flag in the next-state V evaluation. |
| 0 EV | Extension overflow. Signals that the last MAC or MSAC instruction overflowed the 32 lsbs in integer mode or the 40 lsbs in fractional mode of the destination accumulator. However, the result remains accurately represented in the combined 48-bit accumulator structure. Although an overflow has occurred, the correct result, sign, and magnitude are contained in the 48-bit accumulator. Subsequent MAC or MSAC operations may return the accumulator to a valid 32/40-bit result. |

Table 4-3 summarizes the interaction of the MACSR[S/U,F/I,R/T] control bits.

Table 4-3. Summary of S/U, F/I, and R/T Control Bits

| S/U | F/I | R/T | Operational Modes |
|-----|-----|-----|--|
| 0 | 0 | Х | Signed, integer |
| 0 | 1 | 0 | Signed, fractional Truncate on MAC.L and MSAC.L No round on accumulator stores |
| 0 | 1 | 1 | Signed, fractional Round on MAC.L and MSAC.L Round-to-32-bits on accumulator stores |
| 1 | 0 | х | Unsigned, integer |
| 1 | 1 | 0 | Signed, fractional Truncate on MAC.L and MSAC.L Round-to-16-bits on accumulator stores |
| 1 | 1 | 1 | Signed, fractional Round on MAC.L and MSAC.L Round-to-16-bits on accumulator stores |

4.2.2 Mask Register (MASK)

The 32-bit MASK implements the low-order 16 bits to minimize the alignment complications involved with loading and storing only 16 bits. When the MASK is loaded, the low-order 16 bits of the source operand are actually loaded into the register. When it is stored, the upper 16 bits are all forced to ones.

This register performs a simple AND with the operand address for MAC instructions. The processor calculates the normal operand address and, if enabled, that address is then ANDed with {0xFFFF, MASK[15:0]} to form the final address. Therefore, with certain MASK bits cleared, the operand address



can be constrained to a certain memory region. This is used primarily to implement circular queues with the (An)+ addressing mode.

This minimizes the addressing support required for filtering, convolution, or any routine that implements a data array as a circular queue. For MAC + MOVE operations, the MASK contents can optionally be included in all memory effective address calculations. The syntax is as follows:

```
mac.sz Ry, RxSF, <ea>y&, Rw
```

The & operator enables the MASK use and causes bit 5 of the extension word to be set. The exact algorithm for the use of MASK is:

```
if extension word, bit [5] = 1, the MASK bit, then
    if <ea> = (An)
        oa = An & {0xFFFF, MASK}

if <ea> = (An) +
        oa = An
        An = (An + 4) & {0xFFFF, MASK}

if <ea> =-(An)
        oa = (An - 4) & {0xFFFF, MASK}
        An = (An - 4) & {0xFFFF, MASK}
        An = (An - 4) & {0xFFFF, MASK}

if <ea> = (d16,An)
        oa = (An + se_d16) & {0xFFFF0x, MASK}
```

Here, *oa* is the calculated operand address and *se_d16* is a sign-extended 16-bit displacement. For auto-addressing modes of post-increment and pre-decrement, the updated An value calculation is also shown.

Use of the post-increment addressing mode, {(An)+} with the MASK is suggested for circular queue implementations.

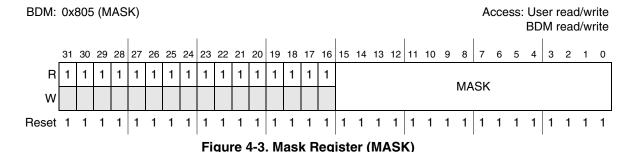


Table 4-4. MASK Field Descriptions

| Field | Description | |
|--------------|--|--|
| 31–16 | Reserved, must be set. | |
| 15–0 MASK | Performs a simple AND with the operand address for MAC instructions. | |

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4.2.3 Accumulator Registers (ACC0-3)

The accumulator registers store 32-bits of the MAC operation result. The accumulator extension registers form the entire 48-bit result.

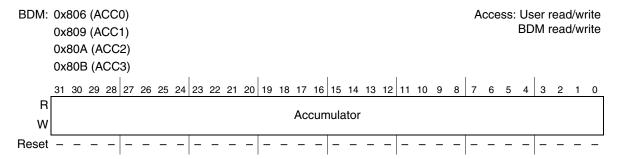


Figure 4-4. Accumulator Registers (ACC0-3)

Table 4-5. ACC0-3 Field Descriptions

| Field | Description | |
|---------------------|---|--|
| 31–0 Accumulator | Store 32-bits of the result of the MAC operation. | |

4.2.4 Accumulator Extension Registers (ACCext01, ACCext23)

Each pair of 8-bit accumulator extension fields are concatenated with the corresponding 32-bit accumulator register to form the 48-bit accumulator. For more information, see Section 4.3, "Functional Description."

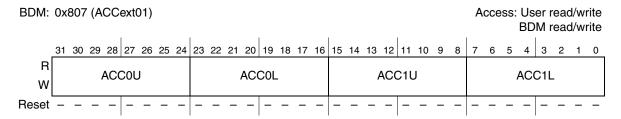


Figure 4-5. Accumulator Extension Register (ACCext01)

Table 4-6. ACCext01 Field Descriptions

| Field | Description | |
|----------------|------------------------------------|--|
| 31–24 ACC0U | Accumulator 0 upper extension byte | |
| 23–16 ACC0L | Accumulator 0 lower extension byte | |
| 15–8 ACC1U | Accumulator 1 upper extension byte | |
| 7–0 ACC1L | Accumulator 1 lower extension byte | |

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Figure 4-6. Accumulator Extension Register (ACCext23)

Table 4-7. ACCext23 Field Descriptions

| Field | Description | |
|----------------|------------------------------------|--|
| 31–24 ACC2U | Accumulator 2 upper extension byte | |
| 23–16 ACC2L | Accumulator 2 lower extension byte | |
| 15–8 ACC3U | Accumulator 3 upper extension byte | |
| 7–0 ACC3L | Accumulator 3 lower extension byte | |

4.3 Functional Description

The MAC speeds execution of ColdFire integer-multiply instructions (MULS and MULU) and provides additional functionality for multiply-accumulate operations. By executing MULS and MULU in the MAC, execution times are minimized and deterministic compared to the 2-bit/cycle algorithm with early termination that the OEP normally uses if no MAC hardware is present.

The added MAC instructions to the ColdFire ISA provide for the multiplication of two numbers, followed by the addition or subtraction of the product to or from the value in an accumulator. Optionally, the product may be shifted left or right by 1 bit before addition or subtraction. Hardware support for saturation arithmetic can be enabled to minimize software overhead when dealing with potential overflow conditions. Multiply-accumulate operations support 16- or 32-bit input operands in these formats:

- Signed integers
- Unsigned integers
- Signed, fixed-point, fractional numbers

The EMAC is optimized for single-cycle, pipelined 32 × 32 multiplications. For word- and longword-sized integer input operands, the low-order 40 bits of the product are formed and used with the destination accumulator. For fractional operands, the entire 64-bit product is calculated and truncated or rounded to the most-significant 40-bit result using the round-to-nearest (even) method before it is combined with the destination accumulator.

For all operations, the resulting 40-bit product is extended to a 48-bit value (using sign-extension for signed integer and fractional operands, zero-fill for unsigned integer operands) before being combined with the 48-bit destination accumulator.

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Figure 4-7 and Figure 4-8 show relative alignment of input operands, the full 64-bit product, the resulting 40-bit product used for accumulation, and 48-bit accumulator formats.

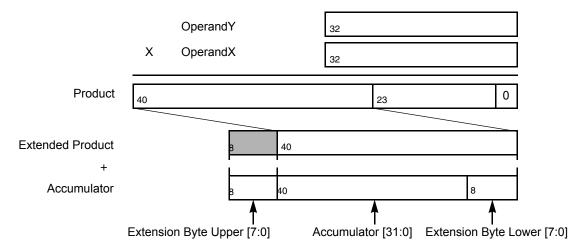


Figure 4-7. Fractional Alignment

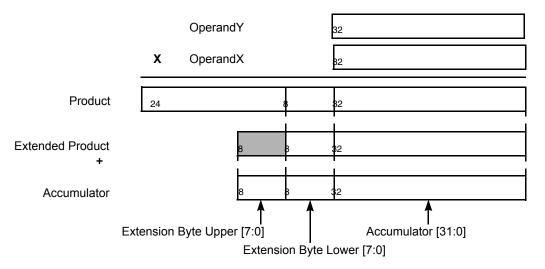


Figure 4-8. Signed and Unsigned Integer Alignment

Therefore, the 48-bit accumulator definition is a function of the EMAC operating mode. Given that each 48-bit accumulator is the concatenation of 16-bit accumulator extension register (ACCext*n*) contents and 32-bit ACC*n* contents, the specific definitions are:

The four accumulators are represented as an array, ACCn, where n selects the register.

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Although the multiplier array is implemented in a four-stage pipeline, all arithmetic MAC instructions have an effective issue rate of 1 cycle, regardless of input operand size or type.

All arithmetic operations use register-based input operands, and summed values are stored in an accumulator. Therefore, an additional MOVE instruction is needed to store data in a general-purpose register. One new feature in EMAC instructions is the ability to choose the upper or lower word of a register as a 16-bit input operand. This is useful in filtering operations if one data register is loaded with the input data and another is loaded with the coefficient. Two 16-bit multiply accumulates can be performed without fetching additional operands between instructions by alternating word choice during calculations.

The EMAC has four accumulator registers versus the MAC's single accumulator. The additional registers improve the performance of some algorithms by minimizing pipeline stalls needed to store an accumulator value back to general-purpose registers. Many algorithms require multiple calculations on a given data set. By applying different accumulators to these calculations, it is often possible to store one accumulator without any stalls while performing operations involving a different destination accumulator.

The need to move large amounts of data presents an obstacle to obtaining high throughput rates in DSP engines. Existing ColdFire instructions can accommodate these requirements. A MOVEM instruction can efficiently move large data blocks by generating line-sized burst references. The ability to load an operand simultaneously from memory into a register and execute a MAC instruction makes some DSP operations such as filtering and convolution more manageable.

The programming model includes a mask register (MASK), which can optionally be used to generate an operand address during MAC + MOVE instructions. The register application with auto-increment addressing mode supports efficient implementation of circular data queues for memory operands.

4.3.1 Fractional Operation Mode

This section describes behavior when the fractional mode is used (MACSR[F/I] is set).

4.3.1.1 Rounding

When the processor is in fractional mode, there are two operations during which rounding can occur:

- 1. Execution of a store accumulator instruction (move.1 ACCx, Rx). The lsbs of the 48-bit accumulator logic are used to round the resulting 16- or 32-bit value. If MACSR[S/U] is cleared, the low-order 8 bits round the resulting 32-bit fraction. If MACSR[S/U] is set, the low-order 24 bits are used to round the resulting 16-bit fraction.
- 2. Execution of a MAC (or MSAC) instruction with 32-bit operands. If MACSR[R/T] is zero, multiplying two 32-bit numbers creates a 64-bit product truncated to the upper 40 bits; otherwise, it is rounded using round-to-nearest (even) method.

To understand the round-to-nearest-even method, consider the following example involving the rounding of a 32-bit number, R0, to a 16-bit number. Using this method, the 32-bit number is rounded to the closest 16-bit number possible. Let the high-order 16 bits of R0 be named R0.U and the low-order 16 bits be R0.L.

- If R0.L is less than 0x8000, the result is truncated to the value of R0.U.
- If R0.L is greater than 0x8000, the upper word is incremented (rounded up).

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- If R0.L is 0x8000, R0 is half-way between two 16-bit numbers. In this case, rounding is based on the lsb of R0.U, so the result is always even (lsb = 0).
 - If the lsb of R0.U equals 1 and R0.L equals 0x8000, the number is rounded up.
 - If the lsb of R0.U equals 0 and R0.L equals 0x8000, the number is rounded down.

This method minimizes rounding bias and creates as statistically correct an answer as possible.

The rounding algorithm is summarized in the following pseudocode:

The round-to-nearest-even technique is also known as convergent rounding.

4.3.1.2 Saving and Restoring the EMAC Programming Model

The presence of rounding logic in the EMAC output datapath requires special care during the EMAC's save/restore process. In particular, any result rounding modes must be disabled during the save/restore process so the exact bit-wise contents of the EMAC registers are accessed. Consider the memory structure containing the EMAC programming model:

```
struct macState {
    int acc0;
    int acc1;
    int acc2;
    int acc3;
    int accext01;
    int accext02;
    int mack;
    int macsr;
} macState;
```

The following assembly language routine shows the proper sequence for a correct EMAC state save. This code assumes all Dn and An registers are available for use, and the memory location of the state save is defined by A7.

```
EMAC state save:
        move.l macsr,d7
                                  ; save the macsr
        clr.1
               d0
                                  ; zero the register to ...
        move.1 d0, macsr
                                  ; disable rounding in the macsr
        move.l acc0,d0
                                  ; save the accumulators
        move.l acc1,d1
        move.l acc2,d2
        move.l acc3,d3
        move.l accext01,d4
                                  ; save the accumulator extensions
        move.l accext23,d5
        move.1 mask,d6
                                  ; save the address mask
        movem.1 #0x00ff,(a7)
                                  ; move the state to memory
```

This code performs the EMAC state restore:

```
EMAC_state_restore:
```

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```
movem.l (a7),#0x00ff
                        ; restore the state from memory
move.l #0, macsr
                          ; disable rounding in the macsr
move.1 d0,acc0
                          ; restore the accumulators
move.l d1,acc1
move.1 d2,acc2
move.1 d3,acc3
move.l d4,accext01
                          ; restore the accumulator extensions
move.1 d5,accext23
move.1 d6, mask
                          ; restore the address mask
move.1 d7, macsr
                          ; restore the macsr
```

Executing this sequence type can correctly save and restore the exact state of the EMAC programming model.

4.3.1.3 MULS/MULU

MULS and MULU are unaffected by fractional-mode operation; operands remain assumed to be integers.

4.3.1.4 Scale Factor in MAC or MSAC Instructions

The scale factor is ignored while the MAC is in fractional mode.

4.3.2 EMAC Instruction Set Summary

Table 4-8 summarizes EMAC unit instructions.

Table 4-8. EMAC Instruction Summary

| Command | Mnemonic | Description |
|-----------------------------------|---|---|
| Multiply Signed | muls <ea>y,Dx</ea> | Multiplies two signed operands yielding a signed result |
| Multiply Unsigned | mulu <ea>y,Dx</ea> | Multiplies two unsigned operands yielding an unsigned result |
| Multiply Accumulate | mac Ry,RxSF,ACCx msac Ry,RxSF,ACCx | Multiplies two operands and adds/subtracts the product to/from an accumulator |
| Multiply Accumulate with Load | mac Ry,Rx, <ea>y,Rw,ACCx msac Ry,Rx,<ea>y,Rw,ACCx</ea></ea> | Multiplies two operands and combines the product to an accumulator while loading a register with the memory operand |
| Load Accumulator | move.l {Ry, #imm}, ACCx | Loads an accumulator with a 32-bit operand |
| Store Accumulator | move.l ACCx,Rx | Writes the contents of an accumulator to a CPU register |
| Copy Accumulator | move.l ACCy, ACCx | Copies a 48-bit accumulator |
| Load MACSR | move.l {Ry, #imm}, MACSR | Writes a value to MACSR |
| Store MACSR | move.l MACSR,Rx | Write the contents of MACSR to a CPU register |
| Store MACSR to CCR | move.l MACSR,CCR | Write the contents of MACSR to the CCR |
| Load MAC Mask Reg | move.l {Ry, #imm}, MASK | Writes a value to the MASK register |
| Store MAC Mask Reg | move.l MASK,Rx | Writes the contents of the MASK to a CPU register |
| Load Accumulator Extensions 01 | move.1 {Ry, #imm}, ACCext01 | Loads the accumulator 0,1 extension bytes with a 32-bit operand |

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| | | , | |
|------------------------------------|-----------------------------|--|--|
| Command | Mnemonic | Description | |
| Load Accumulator Extensions 23 | move.1 {Ry, #imm}, ACCext23 | Loads the accumulator 2,3 extension bytes with a 32-bit operand | |
| Store Accumulator Extensions 01 | move.l ACCext01,Rx | Writes the contents of accumulator 0,1 extension bytes into a CPU register | |
| Store Accumulator Extensions 23 | move.l ACCext23,Rx | Writes the contents of accumulator 2,3 extension bytes into a CPU register | |

Table 4-8. EMAC Instruction Summary (continued)

4.3.3 EMAC Instruction Execution Times

The instruction execution times for the EMAC can be found in Section 3.3.5.6, "EMAC Instruction Execution Times".

The EMAC execution pipeline overlaps the AGEX stage of the OEP (the first stage of the EMAC pipeline is the last stage of the basic OEP). EMAC units are designed for sustained, fully-pipelined operation on accumulator load, copy, and multiply-accumulate instructions. However, instructions that store contents of the multiply-accumulate programming model can generate OEP stalls that expose the EMAC execution pipeline depth:

```
mac.w Ry, Rx, Acc0
move.l Acc0, Rz
```

The MOVE.L instruction that stores the accumulator to an integer register (Rz) stalls until the program-visible copy of the accumulator is available. Figure 4-9 shows EMAC timing.

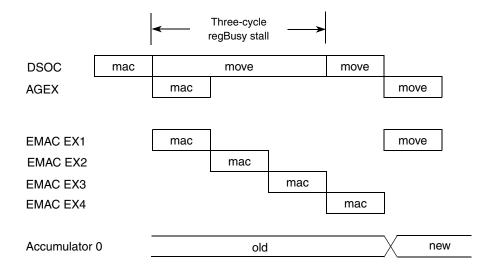


Figure 4-9. EMAC-Specific OEP Sequence Stall

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In Figure 4-9, the OEP stalls the store-accumulator instruction for three cycles: the EMAC pipeline depth minus 1. The minus 1 factor is needed because the OEP and EMAC pipelines overlap by a cycle, the AGEX stage. As the store-accumulator instruction reaches the AGEX stage where the operation is performed, the recently-updated accumulator 0 value is available.

As with change or use stalls between accumulators and general-purpose registers, introducing intervening instructions that do not reference the busy register can reduce or eliminate sequence-related store-MAC instruction stalls. A major benefit of the EMAC is the addition of three accumulators to minimize stalls caused by exchanges between accumulator(s) and general-purpose registers.

4.3.4 Data Representation

MACSR[S/U,F/I] selects one of the following three modes, where each mode defines a unique operand type:

- 1. Two's complement signed integer: In this format, an N-bit operand value lies in the range $-2^{(N-1)}$ < operand < $2^{(N-1)}$ 1. The binary point is right of the lsb.
- 2. Unsigned integer: In this format, an N-bit operand value lies in the range $0 \le operand \le 2^N$ 1. The binary point is right of the lsb.
- 3. Two's complement, signed fractional: In an N-bit number, the first bit is the sign bit. The remaining bits signify the first N-1 bits after the binary point. Given an N-bit number, $a_{N-1}a_{N-2}a_{N-3}... a_2a_1a_0$, its value is given by the equation in Equation 4-3.

value =
$$-(1 \cdot a_{N-1}) + \sum_{i=0}^{N-2} 2^{-(i+1-N)} \cdot ai$$
 Eqn. 4-3

This format can represent numbers in the range $-1 \le \text{operand} \le 1 - 2^{-(N-1)}$.

For words and longwords, the largest negative number that can be represented is -1, whose internal representation is 0x8000 and $0x8000_0000$, respectively. The largest positive word is 0x7FFF or $(1 - 2^{-15})$; the most positive longword is $0x7FFF_FFFF$ or $(1 - 2^{-31})$. Thus, the number range for these signed fractional numbers is [-1.0, ..., 1.0].

4.3.5 MAC Opcodes

MAC opcodes are described in the ColdFire Programmer's Reference Manual.

Remember the following:

- Unless otherwise noted, the value of MACSR[N,Z] is based on the result of the final operation that involves the product and the accumulator.
- The overflow (V) flag is managed differently. It is set if the complete product cannot be represented as a 40-bit value (this applies to 32 × 32 integer operations only) or if the combination of the product with an accumulator cannot be represented in the given number of bits. The EMAC design includes an additional product/accumulation overflow bit for each accumulator that are treated as sticky indicators and are used to calculate the V bit on each MAC or MSAC instruction. See Section 4.2.1, "MAC Status Register (MACSR)".



- For the MAC design, the assembler syntax of the MAC (multiply and add to accumulator) and MSAC (multiply and subtract from accumulator) instructions does not include a reference to the single accumulator. For the EMAC, assemblers support this syntax and no explicit reference to an accumulator is interpreted as a reference to ACC0. Assemblers also support syntaxes where the destination accumulator is explicitly defined.
- The optional 1-bit shift of the product is specified using the notation {<< |>>} SF, where <<1 indicates a left shift and >>1 indicates a right shift. The shift is performed before the product is added to or subtracted from the accumulator. Without this operator, the product is not shifted. If the EMAC is in fractional mode (MACSR[F/I] is set), SF is ignored and no shift is performed. Because a product can overflow, the following guidelines are implemented:
 - For unsigned word and longword operations, a zero is shifted into the product on right shifts.
 - For signed, word operations, the sign bit is shifted into the product on right shifts unless the product is zero. For signed, longword operations, the sign bit is shifted into the product unless an overflow occurs or the product is zero, in which case a zero is shifted in.
 - For all left shifts, a zero is inserted into the lsb position.

The following pseudocode explains basic MAC or MSAC instruction functionality. This example is presented as a case statement covering the three basic operating modes with signed integers, unsigned integers, and signed fractionals. Throughout this example, a comma-separated list in curly brackets, {}, indicates a concatenation operation.

```
switch (MACSR[6:5])
                        /* MACSR[S/U, F/I] */
                        /* signed integers */
  case 0:
    if (MACSR.OMC == 0 || MACSR.PAVn == 0)
         then {
               MACSR.PAVn = 0
               /* select the input operands */
               if (sz == word)
                  then {if (U/Ly == 1)
                       then operandY[31:0] = \{\text{sign-extended Ry[31], Ry[31:16]}\}
                        else operandY[31:0] = {sign-extended Ry[15], Ry[15:0]}
                        if (U/Lx == 1)
                       then operandX[31:0] = \{sign-extended Rx[31], Rx[31:16]\}
                        else operandX[31:0] = \{sign-extended Rx[15], Rx[15:0]\}
                  else {operandY[31:0] = Ry[31:0]
                        operandX[31:0] = Rx[31:0]
               /* perform the multiply */
               product[63:0] = operandY[31:0] * operandX[31:0]
               /* check for product overflow */
       if ((product[63:39] != 0x0000 00 0) && (product[63:39] != 0xffff ff 1))
                  then {
                               /* product overflow */
                        MACSR.PAVn = 1
                        MACSR.V = 1
                        if (inst == MSAC && MACSR.OMC == 1)
                           then if (product[63] == 1)
                                    then result[47:0] = 0 \times 0000 7fff ffff
                                    else result[47:0] = 0xffff 8000 0000
```

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```
then /* overflowed MAC,
                                        saturationMode enabled */
                                      if (product[63] == 1)
                                       then result[47:0] = 0xffff 8000 0000
                                       else result[47:0] = 0x0000 7fff ffff
               }
            /* sign-extend to 48 bits before performing any scaling */
                     product[47:40] = {8{product[39]}}
                                                          /* sign-extend */
            /* scale product before combining with accumulator */
            switch (SF)
                          /* 2-bit scale factor */
                case 0:
                            /* no scaling specified */
                   break;
                case 1:
                            /* SF = "<< 1" */
                   product[40:0] = {product[39:0], 0}
                   break;
                case 2:
                            /* reserved encoding */
                   break;
                            /* SF = ">> 1" */
                case 3:
                   product[39:0] = {product[39], product[39:1]}
                   break;
            }
            if (MACSR.PAVn == 0)
               then {if (inst == MSAC)
                        then result[47:0] = ACCx[47:0] - product[47:0]
                        else result[47:0] = ACCx[47:0] + product[47:0]
            /* check for accumulation overflow */
            if (accumulationOverflow == 1)
               then {MACSR.PAVn =
                     MACSR.V = 1
                     if (MACSR.OMC == 1)
                        then /* accumulation overflow,
                                saturationMode enabled */
                             if (result[47] == 1)
                                then result[47:0] = 0x0000 7fff ffff
                                else result[47:0] = 0xffff 8000 0000
            /* transfer the result to the accumulator */
            ACCx[47:0] = result[47:0]
      MACSR.V = MACSR.PAVn
      MACSR.N = ACCx[47]
      if (ACCx[47:0] == 0x0000 0000 0000)
         then MACSR.Z = 1
         else MACSR.Z = 0
      if ((ACCx[47:31] == 0x0000 0) || (ACCx[47:31] == 0xffff 1))
         then MACSR.EV = 0
         else MACSR.EV = 1
break;
                          /* signed fractionals */
   case 1,3:
   if (MACSR.OMC == 0 || MACSR.PAVn == 0)
```

else if (MACSR.OMC == 1)

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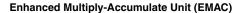
```
then {
            MACSR.PAVn = 0
            if (sz == word)
               then {if (U/Ly == 1)
                        then operandY[31:0] = \{Ry[31:16], 0x0000\}
                        else operandY[31:0] = \{Ry[15:0], 0x0000\}
                     if (U/Lx == 1)
                         then operandX[31:0] = \{Rx[31:16], 0x0000\}
                         else operandX[31:0] = \{Rx[15:0], 0x0000\}
               else {operandY[31:0] = Ry[31:0]
                     operandX[31:0] = Rx[31:0]
               }
            /* perform the multiply */
            product[63:0] = (operandY[31:0] * operandX[31:0]) << 1</pre>
            /* check for product rounding */
            if (MACSR.R/T == 1)
               then { /* perform convergent rounding */
                     if (product[23:0] > 0x80 0000)
                         then product[63:24] = product[63:24] + 1
               else if ((product[23:0] == 0x80 0000) && (product[24] == 1))
                                 then product[63:24] = product[63:24] + 1
            /* sign-extend to 48 bits and combine with accumulator */
            /* check for the -1 * -1 overflow case */
    if ((operandY[31:0] == 0x8000 0000) && (operandX[31:0] == 0x8000 0000))
               then product [71:64] = 0 \times 00
                                                           /* zero-fill */
               else product[71:64] = {8{product[63]}}
                                                          /* sign-extend */
            if (inst == MSAC)
               then result[47:0] = ACCx[47:0] - product[71:24]
               else result[47:0] = ACCx[47:0] + product[71:24]
            /* check for accumulation overflow */
            if (accumulationOverflow == 1)
               then \{MACSR.PAVn = 1
                     MACSR.V = 1
                     if (MACSR.OMC == 1)
                         then /* accumulation overflow,
                                 saturationMode enabled */
                              if (result[47] == 1)
                                 then result[47:0] = 0x007f ffff ff00
                                 else result[47:0] = 0xff80 0000 0000
            /* transfer the result to the accumulator */
            ACCx[47:0] = result[47:0]
              }
      MACSR.V = MACSR.PAVn
      MACSR.N = ACCx[47]
      if (ACCx[47:0] == 0x0000 0000 0000)
          then MACSR.Z = 1
          else MACSR.Z = 0
      if ((ACCx[47:39] == 0x00 0) || (ACCx[47:39] == 0xff 1))
          then MACSR.EV = 0
          else MACSR.EV = 1
break:
                     /* unsigned integers */
case 2:
   if (MACSR.OMC == 0 || MACSR.PAVn == 0)
      then {
```

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```
MACSR.PAVn = 0
/* select the input operands */
if (sz == word)
   then {if (U/Ly == 1)
            then operandY[31:0] = \{0x0000, Ry[31:16]\}
            else operandY[31:0] = \{0x0000, Ry[15:0]\}
         if (U/Lx == 1)
            then operandX[31:0] = \{0x0000, Rx[31:16]\}
            else operandX[31:0] = \{0x0000, Rx[15:0]\}
   else {operandY[31:0] = Ry[31:0]
         operandX[31:0] = Rx[31:0]
/* perform the multiply */
product[63:0] = operandY[31:0] * operandX[31:0]
/* check for product overflow */
if (product[63:40] != 0x0000 00)
                 /* product overflow */
   then {
         MACSR.PAVn = 1
         MACSR.V = 1
         if (inst == MSAC && MACSR.OMC == 1)
            then result[47:0] = 0x0000 0000 0000
            else if (MACSR.OMC == 1)
                    then /* overflowed MAC,
                            saturationMode enabled */
                         result[47:0] = 0xffff ffff ffff
/* zero-fill to 48 bits before performing any scaling */
                              /* zero-fill upper byte */
         product[47:40] = 0
/* scale product before combining with accumulator */
switch (SF)
               /* 2-bit scale factor */
    case 0:
                /* no scaling specified */
      break;
               /* SF = "<< 1" */
    case 1:
       product[40:0] = {product[39:0], 0}
       break;
    case 2:
                /* reserved encoding */
       break;
                /* SF = ">> 1" */
    case 3:
       product[39:0] = {0, product[39:1]}
       break;
}
/* combine with accumulator */
if (MACSR.PAVn == 0)
   then {if (inst == MSAC)
            then result[47:0] = ACCx[47:0] - product[47:0]
            else result[47:0] = ACCx[47:0] + product[47:0]
/* check for accumulation overflow */
if (accumulationOverflow == 1)
```

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```
then \{MACSR.PAVn = 1
                     MACSR.V = 1
                     if (inst == MSAC && MACSR.OMC == 1)
                        then result[47:0] = 0x0000 0000 0000
                        else if (MACSR.OMC == 1)
                             then /* overflowed MAC,
                                     saturationMode enabled */
                                  result[47:0] = 0xffff_ffff_ffff
               }
            /* transfer the result to the accumulator */
            ACCx[47:0] = result[47:0]
      MACSR.V = MACSR.PAVn
     MACSR.N = ACCx[47]
      if (ACCx[47:0] == 0x0000 0000 0000)
         then MACSR.Z = 1
         else MACSR.Z = 0
      if (ACCx[47:32] == 0x0000)
         then MACSR.EV = 0
         else MACSR.EV = 1
break;
```

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Chapter 5 Cryptographic Acceleration Unit (CAU)

5.1 Introduction

The cryptographic acceleration unit (CAU) is a ColdFire coprocessor implementing a set of specialized operations in hardware to increase the throughput of software-based encryption and hashing functions.

5.1.1 Block Diagram

Figure 5-1 shows a simplified block diagram of the CAU.

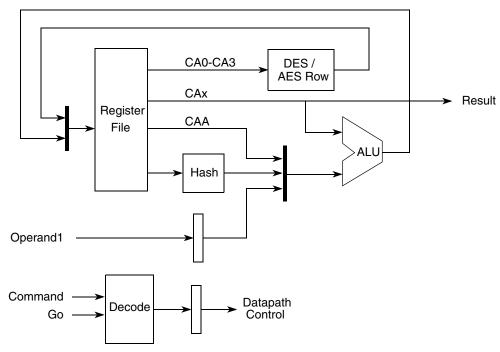


Figure 5-1. Top Level CAU Block Diagram

5.1.2 Overview

The CAU supports acceleration of the following algorithms:

- DES
- 3DES
- AES
- MD5



SHA-1

This selection of algorithms provides excellent support for network security standards (SSL, IPsec). Additionally, using the CAU efficiently permits the implementation of any higher level functions or modes of operation (HMAC, CBC, etc.) based on the supported algorithm.

The CAU is an instruction-level ColdFire coprocessor. The cryptographic algorithms are implemented partially in software with only functions critical to increasing performance implemented in hardware. The ColdFire coprocessor allows for efficient, fine-grained partitioning of functions between hardware and software.

- Implement the innermost round functions by using the coprocessor instructions
- Implement higher-level functions in software by using the standard ColdFire instructions

This partitioning of functions is key to minimizing size of the CAU while maintaining a high level of throughput. Using software for some functions also simplifies the CAU design. The CAU implements a set of 22 coprocessor commands that operate on a register file of eight 32-bit registers. It is tightly coupled to the ColdFire core and there is no local memory or external interface.

5.1.3 Features

The CAU includes these distinctive features:

- Supports DES, 3DES, AES, MD5, SHA-1 algorithms
- Simple, flexible programming model

5.2 Memory Map/Register Definition

The CAU only supports longword operations and register accesses. All registers support read, write, and ALU operations. However, only bits 1–0 of the CASR are writeable. Bits 31–2 of the CASR must be written as 0 for compatibility with future versions of the CAU.

| Code | Register | | AES | SHA-1 | MD5 | Access | Reset Value | Section/Page |
|------|----------------------------------|---|-----|-------|-----|--------|-------------|--------------|
| 0 | CAU status register (CASR) | | | _ | _ | R/W | 0x1000_0000 | 5.2.1/5-4 |
| 1 | CAU accumulator (CAA) | _ | _ | Т | а | R | 0x0000_0000 | 5.2.2/5-4 |
| 2 | General purpose register 0 (CA0) | | W0 | Α | _ | R | 0x0000_0000 | 5.2.3/5-5 |
| 3 | General purpose register 1 (CA1) | | W1 | В | b | R | 0x0000_0000 | 5.2.3/5-5 |
| 4 | General purpose register 2 (CA2) | | W2 | С | С | R | 0x0000_0000 | 5.2.3/5-5 |
| 5 | General purpose register 3 (CA3) | R | W3 | D | d | R | 0x0000_0000 | 5.2.3/5-5 |

Table 5-1. CAU Memory Map



| Code | Register | | AES | SHA-1 | SOM | Access | Reset Value | Section/Page |
|------|----------------------------------|---|-----|-------|-----|--------|-------------|--------------|
| 6 | General purpose register 4 (CA4) | _ | _ | Е | _ | R | 0x0000_0000 | 5.2.3/5-5 |
| 7 | General purpose register 5 (CA5) | | _ | W | _ | R | 0x0000_0000 | 5.2.3/5-5 |

5.2.1 CAU Status Register (CASR)

CASR contains the status and configuration for the CAU.

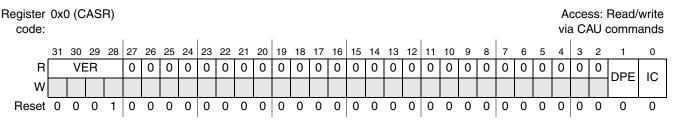


Figure 5-2. CAU Status Register (CASR)

Table 5-2. CASR Field Descriptions

| Field | Description |
|--------------|--|
| 31–28 VER | CAU version. Indicates CAU version 0x1 Initial CAU version (This is the value on this device) 0x2 Second version, added support for SHA-256 algorithm |
| 27–2 | Reserved, must be cleared. |
| 1 DPE | DES parity error. 0 No error detected 1 DES key parity error detected |
| 0 IC | Illegal command. Indicates an illegal instruction not found in Section 5.3.3, "CAU Commands," has been executed. 0 No illegal commands issued 1 Illegal coprocessor command issued |

5.2.2 CAU Accumulator (CAA)

CAU commands use the CAU accumulator for storage of results and as an operand for the cryptographic algorithms.

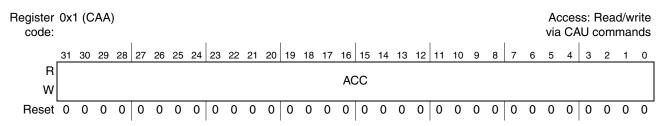


Figure 5-3. CAU Accumulator Register (CAA)

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Cryptographic Acceleration Unit (CAU)

Table 5-3. CAA Field Descriptions

| Field | Description |
|-------------|--|
| 31–0 ACC | Accumulator. Stores results of various CAU commands. |

5.2.3 CAU General Purpose Registers (CAn)

The nine CAU general purpose registers are used in the CAU commands for storage of results and as operands for the various cryptographic algorithms.

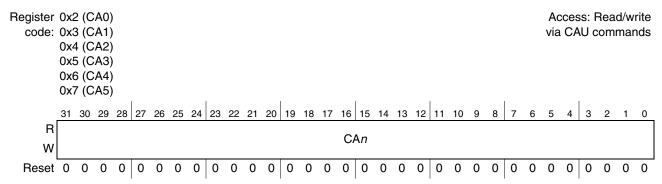


Figure 5-4. CAU General Purpose Registers (CAn)

Table 5-4. CAn Field Descriptions

| Field | Description |
|---------------------|--|
| 31–0 CA <i>n</i> | General purpose registers. Used by the CAU commands. Some cryptographic operations work with specific registers. |

5.3 Functional Description

5.3.1 Programming Model

The CAU is an instruction-level coprocessor. It has a dedicated register file, a specialized ALU, and specialized units for performing cryptographic operations. The CAU design uses a simple, flexible accumulator-based architecture. Most commands, including load and store, can specify any register in the register file. Some cryptographic operations work with specific registers.

5.3.2 Coprocessor Instructions

Operation of the CAU is controlled via standard ColdFire coprocessor load (cp0ld) and store (cp0st) instructions. The CAU has a dedicated register file accessed using these instructions. The load instruction loads CAU registers and specifies CAU operations. The store instruction stores CAU registers. The example assembler syntax for the CAU is:

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The <ea> field specifies the source operand (operand1) for load instructions and destination (result) for store instructions. The basic ColdFire addressing modes {Rn, (An), -(An), (An)+, (d16,An)} are supported for this field. The <CMD> field is a 9-bit value that specifies the CAU command for an instruction. Table 5-5 shows how the CAU supports a single command (STR) for store instructions and 21 commands for the load instructions. The CAU only supports longword operations. A CAU command can be issued every clock cycle.

5.3.3 CAU Commands

The CAU supports the commands shown in Table 5-5. All other encodings are reserved. The CASR[IC] bit is set if an undefined command is issued. A specific illegal command (ILL) is defined to allow software self-checking. Reserved commands should not be issued to ensure compatibility with future implementations.

The CMD field specifies the CAU command for the instruction.

Table 5-5. CAU Commands

| Inst Type | Command | Description | | СМД | | |) | | | | | | Operation | | | | |
|-----------|---------|--------------------|------|-----------|-----|-----------|-----|------|-------|-----|-----------------------|--|-----------|---------------------------------|--|--|--------------------------------|
| mst type | Name | Description | 8 | 8 7 6 5 4 | | 3 | | 2 | 1 | 1 | 0 | Operation | | | | | |
| cp0ld | CNOP | No Operation | | | | | (|)x00 | 0 |) | | | | | _ | | |
| cp0ld | LDR | Load Reg | | | 0x | 01 | | | | CAx | | | | | $Op1 \rightarrow CAx$ | | |
| cp0st | STR | Store Reg | | | 0x | 02 | | | | | C | Ax | | | $CAx \rightarrow Result$ | | |
| cp0ld | ADR | Add | | | 0x | 03 | | | | CAx | | | | | $CAx + Op1 \rightarrow CAx$ | | |
| cp0ld | RADR | Reverse and Add | | | 0x | 04 | | | | CAx | | | | | CAx + ByteRev(Op1) → CAx | | |
| cp0ld | ADRA | Add Reg to Acc | | | 0x | 05 | | | | | C | Ax | | | $CAx + CAA \rightarrow CAA$ | | |
| cp0ld | XOR | Exclusive Or | 0x06 | | | | CAx | | | | | $CAx \land Op1 \rightarrow CAx$ | | | | | |
| cp0ld | ROTL | Rotate Left | 0x07 | | | | CAx | | | | | $CAx <<< Op1 \rightarrow CAx$ | | | | | |
| cp0ld | MVRA | Move Reg to Acc | 0x08 | | | | CAx | | | | | $CAx \rightarrow CAA$ | | | | | |
| cp0ld | MVAR | Move Acc to Reg | | 0x09 | | CAx | | | | | $CAA \rightarrow CAx$ | | | | | | |
| cp0ld | AESS | AES Sub Bytes | | | 0x | 0A | | | CAx | | | | | SubBytes(CAx) \rightarrow CAx | | | |
| cp0ld | AESIS | AES Inv Sub Bytes | | | 0x(| 0B | | | CAx | | | | | | InvSubBytes(CAx) \rightarrow CAx | | |
| cp0ld | AESC | AES Column Op | | | 0x(| 0C | | | | CAx | | | | | $MixColumns(CAx)^Op1 \rightarrow CAx$ | | |
| cp0ld | AESIC | AES Inv Column Op | | | 0x(| 0D | | | | CAx | | | | | $InvMixColumns(CAx^{\wedge}Op1) \rightarrow CAx$ | | |
| cp0ld | AESR | AES Shift Rows | | | | | (| x0E | 0 | 0 | | | | | ShiftRows(CA0-CA3) \rightarrow CA0-CA3 | | |
| cp0ld | AESIR | AES Inv Shift Rows | 0x0F | | | 0x0F0 | | | 0x0F0 | | |) | | | | | InvShiftRows(CA0-CA3)→ CA0-CA3 |
| cp0ld | DESR | DES Round | 0x10 | | | ΙP | | FP | K | S[| 1:0] | DES Round(CA0-CA3)→CA0-CA3 | | | | | |
| cp0ld | DESK | DES Key Setup | 0x11 | | | 0 | | 0 | С | Р | DC | DES Key Op(CA0-CA1) \rightarrow CA0-CA1 Key Parity Error & CP \rightarrow CASR[1] | | | | | |
| cp0ld | HASH | Hash Function | 0x12 | | | 0 HF[2:0] | | | | 2:0 |] | Hash Func(CA1-CA3)+CAA→CAA | | | | | |

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Table 5-5. CAU Commands (continued)

| Inst Type | Command | Description | | | | | CMD |) | Operation | | | |
|-----------|---------|----------------------|-------|---|---|---|-----|-------------|-----------|---|---|-------------|
| ос туро | Name | 2 decinpation | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | - Operation |
| cp0ld | SHS | Secure Hash Shift | 0x130 | | | | | | | CAA <<< 5→ CAA, CAA→CA0, CA0→CA1, CA1 <<< 30 → CA2, CA2→CA3, CA3→CA4 | | |
| cp0ld | MDS | Message Digest Shift | 0x140 | | | | | | | CA3→CAA, CAA→CA1, CA1→CA2, CA2→CA3, | | |
| cp0ld | ILL | Illegal Command | 0x1F0 | | | | | 0x1→CASR[0] | | | | |

Section 5.4.2, "Assembler Equate Values," contains a set of assembly constants used in the command descriptions here. If supported by the assembler, macros can also be created for each instruction. The value CAx should be interpreted as any CAU register (CASR, CAA, CAn) and the <ea> field as one of the supported ColdFire addressing modes {Rn, (An), -(An), (An)+, (d16,An)}. For example, the instruction to add the value from the core register D1 to the CAU register CA0 is:

5.3.3.1 Coprocessor No Operation (CNOP)

cp0ld.l #CNOP

The CNOP command is the coprocessor no-op defined by the ColdFire coprocessor definition for synchronization. It is not actually issued to the coprocessor from the core.

5.3.3.2 Load Register (LDR)

cp0ld.l <ea>, #LDR+CAx

The LDR command loads CAx with the source data specified by <ea>.

5.3.3.3 Store Register (STR)

cp0st.l <ea>, #STR+CAx

The STR command stores the value from CAx to the destination specified by <ea>.

5.3.3.4 Add to Register (ADR)

cp0ld.l <ea>, #ADR+CAx

The ADR command adds the source operand specified by <ea> to CAx and stores the result in CAx.

5.3.3.5 Reverse and Add to Register (RADR)

cp0ld.l <ea>, #RADR+CAx

The RADR command performs a byte reverse on the source operand specified by <ea>, adds that value to CAx, and stores the result in CAx. Table 5-6 shows an example.

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Table 5-6. RADR Command Example

| Operand | CAx Before | CAx After |
|-------------|-------------|-------------|
| 0x0102_0304 | 0xA0B0_C0D0 | 0xA4B3_C2D1 |

5.3.3.6 Add Register to Accumulator (ADRA)

cp0ld.l #ADRA+CAx

The ADRA command adds CAx to CAA and stores the result in CAA.

5.3.3.7 Exclusive Or (XOR)

cp0ld.l <ea>, #XOR+CAx

The XOR command performs an exclusive-or of the source operand specified by <ea> with CAx and stores the result in CAx.

5.3.3.8 Rotate Left (ROTL)

cp0ld.l <ea>, #ROTL+CAx

ROTL rotates the CAx bits to the left with the result stored back to CAx. The number of bits to rotate is the value specified by <ea> modulo 32.

5.3.3.9 Move Register to Accumulator (MVRA)

cp0ld.l #MVRA+CAx

The MVRA command moves the value from the source register CAx to the destination register CAA.

5.3.3.10 Move Accumulator to Register (MVAR)

cp0ld.l #MVAR+CAx

The MVAR command moves the value from source register CAA to the destination register CAx.

5.3.3.11 AES Substitution (AESS)

cp0ld.l #AESS+CAx

The AESS command performs the AES byte substitution operation on CAx and stores the result back to CAx.

5.3.3.12 **AES Inverse Substitution (AESIS)**

cp0ld.l #AESIS+CAx

The AESIS command performs the AES inverse byte substitution operation on CAx and stores the result back to CAx.

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5.3.3.13 AES Column Operation (AESC)

cp0ld.l <ea>, #AESC+CAx

The AESC command performs the AES column operation on the contents of CAx then performs an exclusive-or of that result with the source operand specified by <ea> and stores the result in CAx.

5.3.3.14 AES Inverse Column Operation (AESIC)

cp0ld.l <ea>, #AESIC+CAx

The AESIC command performs an exclusive-or operation of the source operand specified by <ea> on the contents of CAx followed by the AES inverse mix column operation on that result and stores the result back in CAx.

5.3.3.15 AES Shift Rows (AESR)

cp0ld.l #AESR

The AESR command performs the AES shift rows operation on registers CA0, CA1, CA2, and CA3. Table 5-7 shows an example.

Table 5-7. AESR Command Example

| Register | Before | After |
|----------|-------------|-------------|
| CA0 | 0x0102_0304 | 0x0106_0B00 |
| CA1 | 0x0506_0708 | 0x050A_0F04 |
| CA2 | 0x090A_0B0C | 0x090E_0308 |
| CA3 | 0x0D0E_0F00 | 0x0D02_070C |

5.3.3.16 AES Inverse Shift Rows (AESIR)

cp0ld.l #AESIR

The AESIR command performs the AES inverse shift rows operation on registers CA0, CA1, CA2 and CA3. Table 5-8 has an example.

Table 5-8. AESIR Command Example

| Register | Before | After |
|----------|----------|----------|
| CA0 | 01060B00 | 01020304 |
| CA1 | 050A0F04 | 05060708 |
| CA2 | 090E0308 | 090A0B0C |
| CA3 | 0D02070C | 0D0E0F00 |

5.3.3.17 **DES Round (DESR)**

cp0ld.l #DESR+{IP}+{FP}+{KSx}

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The DESR command performs a round of the DES algorithm and a key schedule update with the following source and destination designations: CA0=C, CA1=D, CA2=L, CA3=R. If the IP bit is set, DES initial permutation performs on CA2 and CA3 before the round operation. If the FP bit is set, DES final permutation (inverse initial permutation) performs on CA2 and CA3 after the round operation. The round operation uses the source values from registers CA0 and CA1 for the key addition operation. The KSx field specifies the shift for the key schedule operation to update the values in CA0 and CA1. Table 5-9 defines the specific shift function performed based on the KSx field.

KSx **KS**x **Shift Function** Code **Define** KSL1 Left 1 1 KSL2 Left 2 2 KSR1 Right 1 3 KSR2 Right 2

Table 5-9. Key Shift Function Codes

5.3.3.18 DES Key Setup (DESK)

cp0ld.l #DESK+{CP}+{DC}

The DESK command performs the initial key transformation (permuted choice 1) defined by the DES algorithm on CA0 and CA1 with CA0 containing bits 1–32 of the key and CA1 containing bits 33–64 of the key¹. If the DC bit is set, no shift operation performs and the values C_0 and D_0 store back to CA0 and CA1 respectively. The DC bit should be set for decrypt operations. If the DC bit is not set, a left shift by one also occurs and the values C_1 and D_1 store back to CA0 and CA1 respectively. The DC bit should be cleared for encrypt operations. If the CP bit is set and a key parity error is detected, CASR[DPE] bit is set; otherwise, it is cleared.

5.3.3.19 Hash Function (HASH)

cp0ld.l #HASH+HFx

The HASH command performs a hashing operation on a set of registers and adds that result to the value in CAA and stores the result in CAA. The specific hash function performed is based on the HFx field as defined in Table 5-10.

| HFx Code | HFx Define | Hash Function | Hash Logic |
|-------------|---------------|-----------------------|-------------------------------|
| 0 | HFF | MD5 F() | (CA1 & CA2) (CA1 & CA3) |
| 1 | HFG | MD5 G() | (CA1 & CA3) (CA2 & CA3) |
| 2 | HFH | MD5 H(), SHA Parity() | CA1 ^ CA2 ^ CA3 |
| 3 | HFI | MD5 I() | CA2 ^ (CA1 CA3) |

Table 5-10. Hash Function Codes

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^{1.}The DES algorithm numbers the most significant bit of a block as bit 1 and the least significant as bit 64.

Cryptographic Acceleration Unit (CAU)

Table 5-10. Hash Function Codes (continued)

| HFx Code | HFx Define | Hash Function | Hash Logic |
|-------------|---------------|---------------|---|
| 4 | HFC | SHA Ch() | (CA1 & CA2) ^ (CA1 & CA3) |
| 5 | HFM | SHA Maj() | (CA1 & CA2) ^ (CA1 & CA3) ^ (CA2 & CA3) |

5.3.3.20 Secure Hash Shift (SHS)

```
cp0ld.l #SHS
```

The SHS command does a set of parallel register-to-register move and shift operations for implementing SHA-1. The following source and destination assignments are made: CAA=CAA<<<5, CA0=CAA, CA1=CA0, CA2=CA1<<<<30, CA3=CA2, CA4=CA3.

5.3.3.21 Message Digest Shift (MDS)

```
cp0ld.l #MDS
```

The MDS command does a set of parallel register-to-register move operations for implementing MD5. The following source and destination assignments are made: CAA=CA3, CA1=CAA, CA2=CA1, CA3=CA2.

5.3.3.22 Illegal Command (ILL)

```
cp0ld.l #ILL
```

The ILL command is a specific illegal command that sets CASR[IC]. All other illegal commands are reserved for use in future implementations.

5.4 Application/Initialization Information

5.4.1 Code Example

A code fragment is shown below as an example of how the CAU is used. This example shows the round function of the AES algorithm. Core register A0 is pointing to the key schedule.

```
cp0ld.l
         #AESS+CA0
                           ; sub bytes w0
cp0ld.1
        #AESS+CA1
                          ; sub bytes w1
cp0ld.l #AESS+CA2
                          ; sub bytes w2
cp0ld.l #AESS+CA3
                          ; sub bytes w3
cp0ld.l #AESR
                          ; shift rows
cp0ld.l
        (%a0)+, #AESC+CA0 ; mix col, add key w0
        (%a0)+,#AESC+CA1 ; mix col, add key w1
cp0ld.l
cp0ld.l
         (%a0)+, #AESC+CA2; mix col, add key w2
         (%a0)+, #AESC+CA3; mix col, add key w3
cp0ld.l
```

5.4.2 Assembler Equate Values

The following equates ease programming of the CAU.

```
; CAU Registers (CAx) .set CASR,0x0
```

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Cryptographic Acceleration Unit (CAU)

```
NE
```

```
.set
                  CAA,0x1
                  CA0,0x2
         .set
                  CA1,0x3
         .set
                  CA2,0x4
         .set
                  CA3,0x5
         .set
                  CA4,0x6
         .set
                  CA5,0x7
         .set
; CAU Commands
         .set
                  CNOP, 0x000
         .set
                 LDR, 0x010
         .set
                  STR, 0x020
                 ADR, 0x030
         .set
         .set
                 RADR, 0x040
         .set
                  ADRA, 0x050
                  XOR, 0x060
         .set
                 ROTL, 0x070
         .set
                 MVRA, 0x080
         .set
                 MVAR, 0x090
         .set
         .set
                 AESS, 0x0A0
                 AESIS, 0x0B0
         .set
         .set
                 AESC, 0x0C0
                AESIC, 0x0D0
         .set
                 AESR, 0x0E0
         .set
                 AESIR, 0x0F0
         .set
                 DESR, 0x100
         .set
                 DESK, 0x110
         .set
                 HASH, 0x120
         .set
                  SHS,0x130
         .set
         .set
                 MDS,0x140
         .set
                 ILL,0x1F0
; DESR Fields
                                   ; initial permutation
         .set
                  IP,0x08
         .set
                  FP,0x04
                                   ; final permutation
                  KSL1,0x00
                                   ; key schedule left 1 bit
         .set
                  KSL2,0x01
                                   ; key schedule left 2 bits
         .set
                 KSR1,0x02
                                   ; key schedule right 1 bit
         .set
                 KSR2,0x03
                                    ; key schedule right 2 bits
         .set
; DESK Field
                  DC,0x01
                                     ; decrypt key schedule
         .set
                 CP,0x02
                                     ; check parity
         .set
; HASH Functions Codes
                                    ; MD5 F() CA1&CA2 | ~CA1&CA3
         .set
                  HFF,0x0
                                   ; MD5 G() CA1&CA3 | CA2&~CA3
                 HFG,0x1
         .set
                 HFH,0x2
                                   ; MD5 H(), SHA Parity() CA1^CA2^CA3
         .set
                 HFI,0x3
                                   ; MD5 I() CA2^(CA1|~CA3)
         .set
                 HFC,0x4
                                   ; SHA Ch() CA1&CA2 ^ ~CA1&CA3
         .set
                 HFM,0x5
                                    ; SHA Maj() CA1&CA2 ^ CA1&CA3 ^ CA2&CA3
         .set
```

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Chapter 6 Random Number Generator (RNG)

6.1 Introduction

This chapter describes the random number generator (RNG), including a programming model, functional description, and application information.

6.1.1 Overview

The random number generator (RNG) module is capable of generating 32-bit random numbers. It complies with Federal Information Processing Standard (FIPS) 140 standards for randomness and non-determinism. The random bits generate by clocking shift registers with clocks derived from ring oscillators. The configuration of the shift registers ensures statistically good data (data that looks random). The oscillators with their unknown frequencies provide the required entropy needed to create random data.

CAUTION

There is no known cryptographic proof showing that this is a secure method of generating random data. In fact, there may be an attack against the random number generator if its output is used directly in a cryptographic application (the attack is based on the linearity of the internal shift registers). In light of this, it is highly recommended to use the random data produced by this module as an input seed to a NIST-approved (based on DES or SHA-1) or cryptographically-secure (RSA generator or BBS generator) random number generation algorithm.

It is also recommended to use other sources of entropy along with the RNG to generate the seed to the pseudorandom algorithm. The more random sources combined to create the seed the better. The following is a list of sources that can be easily combined with the output of this module.

- Current time using highest precision possible
- Mouse and keyboard motions (or equivalent if being used on a cell phone or PDA)
- Other entropy supplied directly by the user

NOTE

See Appendix D of the NIST Special Publication 800-90 "Recommendation for Random Number Generation Using Deterministic Random Bit Generators" for more information: http://csrc.nist.gov

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Random Number Generator (RNG)

6.2 Memory Map/Register Definition

Table 6-1 shows the address map for the RNG module. Detailed register descriptions are found in the following section.

Table 6-1. RNG Block Memory Map

| IPSBAR Offset | Register | Width (bits) | Access | Reset Value | Section/Page |
|------------------|------------------------------|--------------|--------|-------------|--------------|
| 0x1F_0000 | RNG Control Register (RNGCR) | 32 | R/W | 0x0000_0000 | 6.2.1/6-2 |
| 0x1F_0004 | RNG Status Register (RNGSR) | 32 | R | 0x0010_0000 | 6.2.2/6-3 |
| 0x1F_0008 | RNG Entropy Register (RNGER) | 32 | W | 0x0000_0000 | 6.2.3/6-4 |
| 0x1F_000C | RNG Output FIFO (RNGOUT) | 32 | R | 0x0000_0000 | 6.2.4/6-4 |

6.2.1 RNG Control Register (RNGCR)

Immediately following reset, the RNG begins generating entropy (random data) in its internal shift registers. Random data is not pushed to the output FIFO until after the RNGCR[GO] bit is set. After this, a random 32-bit word is pushed to RNGOUT every 256 cycles.

IPSBAR 0x1F_0000 (RNGCR) Access: User read/write Offset: 31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 0 HA GO SLM IM CI 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0

Figure 6-1. RNG Control Register (RNGCR)

Table 6-2. RNGCR Field Descriptions

| Field | Description |
|----------|---|
| 31–5 | Reserved, must be cleared. |
| 4 SLM | Sleep mode. The RNGA can be placed in low power mode by setting this bit. When this bit is set, the oscillators are disabled. Clearing this bit causes the RNGA to exit sleep mode. RNGOUT is not pushed while the RNGA is in sleep mode. O RNGA is not in sleep mode. RNGA is in sleep mode. |
| 3 CI | Clear interrupt. Writing a 1 to this bit clears the error interrupt and RNGSR[EI]. This bit is self-clearing, 0 Do not clear error interrupt. 1 Clear error interrupt. |
| 2 IM | Interrupt mask. 0 Error interrupt enabled. 1 Error interrupt masked. |

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Table 6-2. RNGCR Field Descriptions (continued)

| Field | Description |
|---------|--|
| 1 HA | High assurance. Notifies core when RNGOUT underflow has occurred (RNGOUT is read while empty). Enables the security violation bit in the RNGSR. Bit is sticky and only cleared by hardware reset. 0 Disable security violation notification. 1 Enable security violation notification. |
| 0 GO | Go bit. Starts/stops random data from being generated. Bit is sticky and only cleared by hardware reset. 0 RNGOUT not loaded with random data. 1 RNGOUT loaded with random data. |

6.2.2 RNG Status Register (RNGSR)

The RNGSR, shown in Figure 6-2, is a read only register which reflects the internal status of the RNG.

IPSBAR 0x1F_0004 (RNGSR) Access: User read-only Offset:

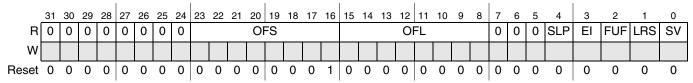


Figure 6-2. RNG Status Register (RNGSR)

Table 6-3. RNGSR Field Descriptions

| Field | Description |
|--------------|--|
| 31–24 | Reserved, must be cleared. |
| 23–16 OFS | Output FIFO size. Indicates size of the output FIFO (1 word) and maximum possible value of RNGR[OFL]. |
| 15–8 OFL | Output FIFO level. Indicates current number of random words in the output FIFO. Determines if valid random data is available for reading from the FIFO without causing an underflow condition. On this device, the maximum value for this field is 0x01. |
| 7–5 | Reserved, must be cleared. |
| 4 SLP | Sleep. This bit reflects whether the RNG is in sleep mode. When this bit is set, the RNGA is in sleep mode and the oscillator clocks are inactive. While in this mode, RNGOUT is not loaded. O RNGA is not in sleep mode. 1 RNGA is in sleep mode. |
| 3 El | Error interrupt. Signals a FIFO underflow. Reset by a write to RNGCR[CI] and not masked by RNGCR[IM]. 0 RNGOUT not read while empty. 1 RNGOUT read while empty. |
| 2 FUF | FIFO underflow. Signals FIFO underflow. Reset by reading RNGSR. 0 RNGOUT not read while empty since last read of RNGSR. 1 RNGOUT read while empty since last read of RNGSR. |



Random Number Generator (RNG)

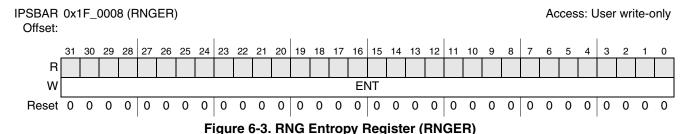
Table 6-3. RNGSR Field Descriptions (continued)

| Field | Description |
|----------|--|
| 1 LRS | Last read status. Reflects status of most recent read of RNGOUT. 0 During last read, RNGOUT was not empty. 1 During last read, RNGOUT was empty (underflow condition). |
| 0 SV | Security violation. When enabled by RNGCR[HA], signals that a RNGOUT underflow has occurred. Bit is sticky and is only cleared by hardware reset. O No violation occurred or RNGCR[HA] is cleared. Security violation (RNGOUT underflow) has occurred. |

6.2.3 RNG Entropy Register (RNGER)

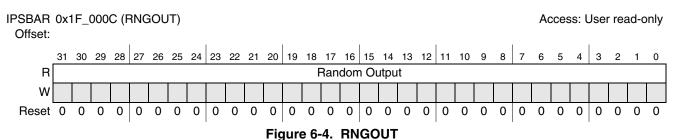
The RNGER is a write-only register which allows the user to insert entropy into the RNG. This register allows an external user to continually seed the RNG with externally generated random data. Although use of this register is recommended, it is optional. The RNGER can be written at any time during operation.

Each time the RNGER is written, the value updates the internal state of the RNG. The update is performed in such a way that the entropy in the RNG's internal state is preserved. Use of the RNGER can increase the entropy but never decrease it.



6.2.4 RNG Output FIFO (RNGOUT)

The RNGOUT provides temporary storage for random data generated by the RNG. As long as RNGOUT is not empty, a read of this address returns 32 bits of random data. If RNGOUT is read when it is empty, RNGSR[EI, FUF, LRS] are set. If the interrupt is enabled in RNGCR, an interrupt is triggered to the interrupt controller. The RNGSR[OFL], described in Section 6.2.2, "RNG Status Register (RNGSR)," can be polled to monitor if data is currently resident in RNGOUT. A new random word pushes into the FIFO every 256 clock cycles (as long as RNGOUT is not full). It is very important to poll RNGSR[OFL] to make sure random values are present before reading from RNGOUT.



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6.3 Functional Description

Figure 6-5 shows the RNG has three functional blocks: output FIFO, internal bus interface, and the RNG core/control logic blocks. The following sections describe these blocks in more detail.

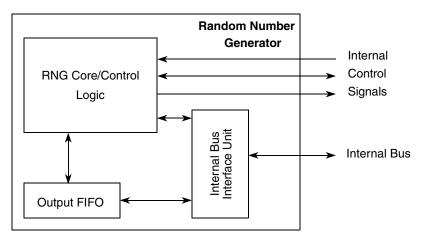


Figure 6-5. RNG Block Diagram

6.3.1 Output FIFO

RNGOUT stores the 32 bits of random data generated by the RNG core/control block. The RNGSR allows the user to check if random data has been written to RNGOUT, through the output FIFO level field. If the user reads from the FIFO when it is empty and the interrupt is enabled, the RNG drives an interrupt request to the interrupt controller. It is very important to poll RNGSR[OFL] to make sure random values are present before reading from RNGOUT.

6.3.2 RNG Core/Control Logic Block

This block contains the RNG's control logic as well as its core engine that generates random data.

6.3.2.1 RNG Control Block

The control block contains the address decoder, all addressable registers, and control state machines for the RNG. This block is responsible for communication with the peripheral interface and the FIFO interface. The block also controls the core engine to generate random data. The general functionality of the block is as follows. After reset, entropy generates and stores in the RNG's shift registers. After RNGCR[GO] is set, RNGOUT is loaded with a random word every 256 cycles.

6.3.2.2 RNG Core Engine

The core engine block contains the logic that generates random data. The logic within the core engine contains the internal shift registers, as well as the logic that generates the two oscillator based clocks. This logic is brainless and must be controlled by the control block. The control block controls how the shift registers are configured and when the oscillator clocks are turned on.

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Random Number Generator (RNG)

6.4 Initialization/Application Information

The intended general operation of the RNG is as follows:

- 1. Reset/initialize.
- 2. Write to the RNG entropy register (optional).
- 3. Write to the RNG control register and set the interrupt mask, high assurance, and GO bits.
- 4. Poll RNGSR[OFL] to check for random data in RNGOUT.
- 5. Read available random data from RNGOUT.
- 6. Repeat steps 3 and 4 as needed.



Chapter 7 Clock Module

7.1 Introduction

The clock module allows the device to be configured for one of several clocking methods. Clocking modes include internal phase-locked loop (PLL) clocking with an external clock reference or an external crystal reference supported by an internal crystal amplifier. The PLL can also be disabled and an external oscillator can be used to clock the device directly. The clock module contains the following:

- Crystal amplifier and oscillator (OSC)
- Phase-locked loop (PLL)
- Reduced frequency divider (RFD)
- Status and control registers
- Control logic
- Real-time clock (RTC) oscillator

7.2 Features

Features of the clock module include the following:

- Crystal, on-chip relaxation oscillator, or external oscillator reference options
- Trimmed relaxation oscillator
- Pre-divider capable of dividing the clock source frequency into the PLL reference frequency range
- External RTC/backup oscillator (nominal frequency 32.768 kHz)
- System can be clocked from PLL or directly from crystal oscillator or relaxation oscillator
- Support for low-power modes
- Separate clock out signal
- 2^n ($0 \le n \le 15$) low-power divider for extremely low frequency operation

7.3 Modes of Operation

The clock module can be operated in backup watchdog timer mode, RTC mode, normal PLL mode (default) or external clock mode (PLL disabled).



Clock Module

7.3.1 Backup Watchdog Timer Mode

In this mode, the backup watchdog timer is disabled after POR (power on reset), and the clock input to this timer is the system clock. The selection of the clock source for the secondary watchdog timer module can occur only once per POR. Thus, if the relaxation oscillator is selected as the timer's input source, subsequent attempts to select the relaxation oscillator as the system clock's source are blocked until the next POR. If the relaxation oscillator was already selected as the system clock's source and is subsequently selected as the timer's input source, the system and the timer can use the oscillator as the source.

7.3.2 RTC Mode

A dedicated RTC oscillator can be selected to run the RTC circuitry. In normal operation, this oscillator is powered by the VDDPLL and VSSPLL pins. When the part is shut down, this oscillator is powered by the VSTBY pin. The nominal expected frequency for the RTC oscillator is 32.768 kHz, but can range from 32 kHz to 40 kHz.

7.3.3 Normal PLL Mode

In normal PLL mode, the PLL is fully programmable. It can synthesize frequencies ranging from 1x to 18x the reference frequency and has a post divider capable of reducing this synthesized frequency without disturbing the PLL. The PLL reference can be a crystal oscillator or an external clock.

7.3.4 External Clock Mode

In external clock mode, the PLL is bypassed, and the external clock is applied to EXTAL. The resulting operating frequency is equal to the external clock frequency.

7.4 Low-Power Mode Operation

This subsection describes the operation of the clock module in low-power and halted modes of operation. Low-power modes are described in Chapter 7, "Clock Module." Table 7-1 shows the clock module operation in low-power modes.

| Low-power Mode | Clock Operation | Mode Exit |
|----------------|--|--|
| Wait | Clocks sent to peripheral modules only | Exit not caused by clock module, but normal clocking resumes upon mode exit |
| Doze | Clocks sent to peripheral modules only | Exit not caused by clock module, but normal clocking resumes upon mode exit |
| Stop | All system clocks disabled | Exit not caused by clock module, but clock sources are re-enabled and normal clocking resumes upon mode exit |
| Halted | Normal | Exit not caused by clock module |

Table 7-1. Clock Module Operation in Low-power Modes

In wait and doze modes, the system clocks to the peripherals are enabled and the clocks to the CPU and SRAM are stopped. Each module can disable its clock locally at the module level.

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In stop mode, all system clocks are disabled. There are several options for enabling or disabling the PLL or crystal oscillator in stop mode, compromising between stop mode current and wakeup recovery time. The PLL can be disabled in stop mode, but requires a wakeup period before it can relock. The oscillator can also be disabled during stop mode, but requires a wakeup period to restart.

When the PLL is enabled in stop mode (STPMD[1:0]), the external CLKOUT signal can support systems using CLKOUT as the clock source.

There is also a fast wakeup option for quickly enabling the system clocks during stop recovery. This eliminates the wakeup recovery time but at the risk of sending a potentially unstable clock to the system. To prevent a non-locked PLL frequency overshoot when using the fast wakeup option, change the RFD divisor to the current RFD value plus one before entering stop mode.

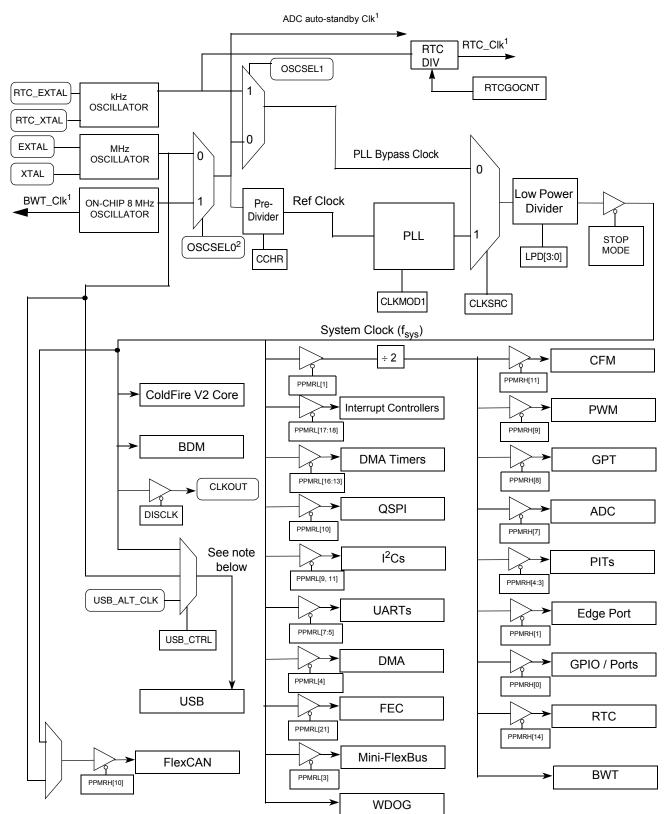
In external clock mode, there are no wakeup periods for oscillator startup or PLL lock.

7.5 Block Diagram

Figure 7-1 shows a block diagram of the entire clock module.



Clock Module



¹ These clocks are alternate clocks available to their respective modules.



OSCSEL0 is loaded from CLKMOD0 at reset.

Figure 7-1. Clock Module Block Diagram

7.6 Signal Descriptions

The clock module signals are summarized in Table 7-2 and a brief description follows. For more detailed information, refer to Chapter 2, "Signal Descriptions."

 Name
 Function

 EXTAL
 Oscillator or clock input

 XTAL
 Oscillator output

 CLKOUT
 System clock output

 CLKMOD[1:0]
 Clock mode select inputs

 RSTO
 Reset signal from reset controller

Table 7-2. Signal Properties

7.6.1 **EXTAL**

This input is driven by an external clock except when used as a connection to the external crystal when using the internal oscillator.

7.6.2 XTAL

This output is an internal oscillator connection to the external crystal. If CLKMOD0 is driven low during reset, XTAL is sampled to determine clocking mode.

7.6.3 **CLKOUT**

This output reflects the internal system clock.

7.6.4 CLKMOD[1:0]

These inputs are used to select the clock mode during chip configuration as described in Table 7-3.

CLKMOD[1:0] **XTAL Clocking Mode** 0 00 PLL disabled, clock driven by external oscillator 00 PLL disabled, clock driven by on-chip oscillator 1 PLL disabled, clock driven by external crystal 01 N/A PLL in normal mode, clock driven by external oscillator¹ 10 0 Reserved² 10 1 11 N/A PLL in normal mode, clock driven by external crystal¹

Table 7-3. Clocking Modes

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Clock Module

- The PLL pre-divider (CCHR+1) reset value is 6 and the PLL input reference range is 2–10 MHz, so in order to boot with the PLL enabled, the external clock or crystal frequency needs to be greater than 12 MHz. MCF5225x devices cannot boot with PLL enabled from an external clock or crystal oscillator with frequency than 12 MHz. This constraint does not apply to booting with PLL disabled.
- ² Cannot boot from the Internal 8MHz Relaxation oscillator with the PLL enabled. See note 1. Thus this mode has been removed from the table.

7.6.5 **RSTO**

The $\overline{\text{RSTO}}$ pin is asserted by one of the following:

- Internal system reset signal
- FRCRSTOUT bit in the reset control status register (RCR); see Section 11.5.1, "Reset Control Register (RCR)."

7.7 Memory Map and Registers

The clock module programming model shown in Table 7-4 consists of registers that define clock operation and status as well as additional peripheral power management registers.

Table 7-4. Clock Module Memory Map

| IPSBAR Offset ¹ | Register | | Access | Reset Value | Section/Page |
|-------------------------------|--|------|--------|-----------------------|---------------|
| | Supervisor Mode Access 0 | Only | | | |
| 0x12_0000 | Synthesizer Control Register (SYNCR) | 16 | R/W | 0x1002 | 7.7.1.1/7-7 |
| 0x12_0002 | Synthesizer Status Register (SYNSR) | 8 | R | 0x00 | 7.7.1.2/7-9 |
| 0x12_0004 | Relaxation Oscillator Control Register (ROCR) | 16 | R/W | See note ² | 7.7.1.3/7-11 |
| 0x12_0007 | Low Power Divider Register (LPDR) | 8 | R/W | 0x00 | 7.7.1.4/7-11 |
| 0x12_0008 | Clock Control High Register (CCHR) | 8 | R/W | 0x05 | 7.7.1.5/7-12 |
| 0x12_0009 | Clock Control Low Register (CCLR) | 8 | R/W | See note ³ | 7.7.1.6/7-12 |
| 0x12_000A | Oscillator Control High Register (OCHR) | 8 | R/W | See note ⁴ | 7.7.1.7/7-13 |
| 0x12_000B | Oscillator Control Low Register (OCLR) | 8 | R/W | See note ⁵ | 7.7.1.8/7-14 |
| 0x12_0012 | Real Time Clock Control Register (RTCCR) | 8 | R/W | 0x00 | 7.7.1.9/7-15 |
| 0x12_0013 | Backup Watchdog Timer Control Register (BWCR) | 8 | R/W | 0x00 ⁶ | 7.7.1.10/7-16 |
| 0x00_000C | Peripheral Power Management Register High (PPMRH) ⁷ | 32 | R/W | 0x00 | 10.2.1/10-2 |
| 0x00_0018 | Peripheral Power Management Register Low (PPMRL) ⁷ | 32 | R/W | 0x01 | 10.2.1/10-2 |

¹ Addresses not assigned to a register and undefined register bits are reserved for expansion.

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² The reset value for ROCR is loaded during reset from the flash information row (bits [9:0]). The bits reset to 0b10_0000_0000 during Power-On Reset.

³ CCLR reset state determined during reset configuration.

⁴ OCHR reset state determined during reset configuration.

⁵ OCLR reset state determined during reset configuration.

⁶ The contents of BWCR are reset only during Power-On Reset; they are preserved during a warm reset.



⁷ See Chapter 10, "Power Management."

7.7.1 Register Descriptions

This subsection provides a description of the clock module registers.

7.7.1.1 Synthesizer Control Register (SYNCR)

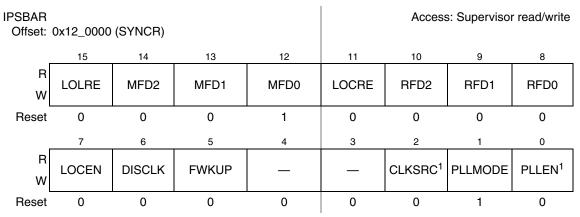


Figure 7-2. Synthesizer Control Register (SYNCR)

Table 7-5. SYNCR Field Descriptions

| Field | Description |
|-------------|---|
| 15 LOLRE | Loss-of-lock reset enable. Determines how the system manages a loss-of-lock indication. When operating in normal mode, the PLL must be locked before setting the LOLRE bit. Otherwise, reset is immediately asserted. To prevent an immediate reset, the LOLRE bit must be cleared before writing the MFD[2:0] bits or entering stop mode with the PLL disabled. 0 No reset on loss of lock 1 Reset on loss of lock Note: In external clock mode, the LOLRE bit has no effect. |

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The reset value of PLLEN and CLKSRC depend on the value of CLKMOD1 during reset (set to 1 if PLL is enabled when the device emerges from reset).



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Table 7-5. SYNCR Field Descriptions (continued)

| Field | Description | | | | | | | | | | |
|--------------|---|---|-----------------------------------|--------------------------|-------------|--------------|--------------|--------------|---------------------|--------------|--|
| 14–12 MFD | Multiplication Factor Divider. Contain the binary value of the divider in the PLL feedback loop. The MFD[2:0] value is the multiplication factor applied to the reference frequency. When MFD[2:0] are changed or the PLL is disabled in stop mode, the PLL loses lock. Note: In external clock mode, the MFD[2:0] bits have no effect. The following table shows the system frequency multiplier of the reference frequency ¹ in normal PLL mode. | | | | | | | | | | |
| | MFD[2:0] | | | | | | | | | | |
| | | | 000 ² (4x) | 001 ³ (6x) | 010 (8x) | 011 (10x) | 100 (12x) | 101 (14x) | 110 (16x) | 111 (18x) | |
| | | 000 ³ (÷ 1) |) 4 | 6 ³ | 8 | 10 | 12 | 14 | 16 | 18 | |
| | | 001 (÷ 2) | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | |
| | | 010 (÷ 4) | 1 | 3/2 | 2 | 5/2 | 3 | 7/2 | 4 | 9/2 | |
| | 5.5 | 011 (÷ 8) | 1/2 | 3/4 | 1 | 5/4 | 3/2 | 7/4 | 2 | 9/4 | |
| | DED[3:0] | 100 (÷ 16 |) 1/4 | 3/8 | 1/2 | 5/8 | 3/4 | 7/8 | 1 | 9/8 | |
| | | 101 (÷ 32 |) 1/8 | 3/16 | 1/4 | 5/16 | 3/8 | 7/16 | 1/2 | 9/16 | |
| | | 110 (÷ 64 |) 1/16 | 3/32 | 1/8 | 5/32 | 3/16 | 7/32 | 1/4 | 9/32 | |
| | | 111 (÷ 128 | 3) 1/32 | 3/64 | 1/16 | 5/64 | 3/32 | 7/64 | 1/8 | 9/64 | |
| | 2 | $f_{sys} = f_{ref} \times 2(M)$ (Max_Spec) M MFD = 000 not Default value o | Hz : valid for f _{re} | | | D + 2) | ≤ (Max_ | _Spec) | MHz, f _s | sys ≦ | |
| 11 LOCRE | Loss-of-clock reset enable. Determines how the system manages a loss-of-clock condition. When the LOCEN bit is clear, LOCRE has no effect. If the LOCS flag in SYNSR indicates a loss-of-clock condition, setting the LOCRE bit causes an immediate reset. To prevent an immediate reset, the LOCRE bit must be cleared before entering stop mode with the PLL disabled. 0 No reset on loss-of-clock 1 Reset on loss-of-clock Note: In external clock mode, the LOCRE bit has no effect. | | | | | | | | | | |
| 10–8 RFD | Reduced frequency divider field. The binary value written to RFD[2:0] is the PLL frequency divisor; see table in MFD bit description. Changing RFD[2:0] does not affect the PLL or cause a relock delay. Changes in clock frequency are synchronized to the next falling edge of the current system clock. To avoid surpassing the allowable system operating frequency, write to RFD[2:0] only when the LOCK bit is set. | | | | | | | | | | |
| 7 LOCEN | Enables the loss-of-clock function. LOCEN does not affect the loss-of-lock function. 0 Loss-of-clock function disabled 1 Loss-of-clock function enabled Note: In external clock mode, the LOCEN bit has no effect. | | | | | | | | | | |
| 6 DISCLK | Disable CLKOUT determines whether CLKOUT is driven. Setting the DISCLK bit holds CLKOUT low. 0 CLKOUT enabled 1 CLKOUT disabled | | | | | | | | | | |

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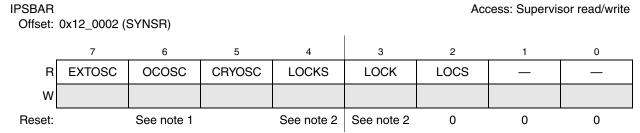


Table 7-5. SYNCR Field Descriptions (continued)

| Field | Description |
|--------------|--|
| 5 FWKUP | Fast wakeup. Determines when the system clocks are enabled during wakeup from stop mode. 0 System clocks enabled only when PLL is locked or operating normally 1 System clocks enabled on wakeup regardless of PLL lock status Note: When FWKUP = 0, if the PLL or oscillator is enabled and unintentionally lost in stop mode, the PLL wakes up in self-clocked mode or reference clock mode depending on the clock that was lost. In external clock mode, the FWKUP bit has no effect on the wakeup sequence. |
| 4–3 — | Reserved, must be cleared. |
| 2 CLKSRC | Clock Source. Determines whether the PLL output clock or the PLL reference clock is to drive the system clock. This bit is ignored when the PLL is disabled, in which case the PLL reference clock drives the system clock. Having this separate bit allows the PLL to first be enabled, and then the system clock can be switched to the PLL output clock only after the PLL has locked. When disabling the PLL, the clock can be switched before disabling the PLL so that a smooth transfer is ensured. 0) PLLreference clock (input clock) drives the system clock. 1) PLL output clock drives the system clock (provided the PLL is enabled). |
| 1 PLLMODE | Determines the operating mode of the PLL. This bit should only be changed after reset with the PLL disabled. For this device, this bit must be set to 1. 0) Reserved, do not use 1) PLL operates in normal mode |
| 0 PLLEN | Enables and disables the PLL. If the PLL is enabled out of reset, the chip does not leave the reset state until the PLL is locked and the system clock is driven by the PLL output clock. Use the CLKSRC control bit to switch the system clock between the PLL output clock and PLL bypass clock after the PLL is enabled. 0) PLL is disabled 1) PLL is enabled |

7.7.1.2 **Synthesizer Status Register (SYNSR)**

The SYNSR is a read-only register that can be read at any time. Writing to the SYNSR has no effect and terminates the cycle normally.



Note: 1. Reset state determined during reset configuration.

2. See the LOCKS and LOCK bit descriptions.

Figure 7-3. Synthesizer Status Register (SYNSR)

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Table 7-6. SYNSR Field Descriptions

| Field | Description |
|-------------|---|
| 7 EXTOSC | Indicates if an external oscillator is providing the reference clock source 0) Reference clock is not external oscillator 1 Reference clock is external oscillator |
| 6 OCOSC | Indicates if the on-chip oscillator is providing the reference clock source. O Reference clock is not on-chip oscillator 1 Reference clock is on-chip oscillator |
| 5 CRYOSC | Indicates if an external crystal is providing the reference clock source 0 Reference clock is not external crystal 1 Crystal clock reference |
| 4 LOCKS | Sticky indication of PLL lock status. O PLL loss of lock since last system reset or MFD change or currently not locked due to exit from STOP with FWKUP set No unintentional PLL loss of lock since last system reset or MFD change The lock detect function sets the LOCKS bit when the PLL achieves lock after: • A system reset • A write to SYNCR that changes the MFD[2:0] bits When the PLL loses lock, LOCKS is cleared. When the PLL relocks, LOCKS remains cleared until one of the two listed events occurs. In stop mode, if the PLL is intentionally disabled, then the LOCKS bit reflects the value prior to entering stop mode. However, if FWKUP is set, then LOCKS is cleared until the PLL regains lock. after lock is regained, the LOCKS bit reflects the value prior to entering stop mode. Furthermore, reading the LOCKS bit at the same time that the PLL loses lock does not return the current loss of lock condition. In external clock mode, LOCKS remains cleared after reset. In normal PLL mode, LOCKS is set after reset. |
| 3 LOCK | Set when the PLL is locked. PLL lock occurs when the synthesized frequency is within approximately 0.75% of the programmed frequency. The PLL loses lock when a frequency deviation of greater than approximately 1.5% occurs. Reading the LOCK flag at the same time that the PLL loses lock or acquires lock does not return the current condition of the PLL. The power-on reset circuit uses the LOCK bit as a condition for releasing reset. If operating in external clock mode, LOCK remains cleared after reset. PLL not locked PLL locked |
| 2 LOCS | Sticky indication of whether a loss-of-clock condition has occurred at any time since exiting reset in normal PLL mode. • LOCS = 0 when the system clocks are operating normally. • LOCS = 1 when system clocks have failed due to a reference failure or PLL failure. After entering stop mode with FWKUP set and the PLL and oscillator intentionally disabled (STPMD[1:0] = 11), the PLL exits stop mode in the SCM while the oscillator starts up. During this time, LOCS is temporarily set regardless of LOCEN. It is cleared after the oscillator comes up and the PLL is attempting to lock. If a read of the LOCS flag and a loss-of-clock condition occur simultaneously, the flag does not reflect the current loss-of-clock condition. A loss-of-clock condition can be detected only if LOCEN = 1 or the oscillator has not yet returned from exit from stop mode with FWKUP = 1. 0 Loss-of-clock not detected since exiting reset 1 Loss-of-clock detected since exiting reset or oscillator not yet recovered from exit from stop mode with FWKUP = 1. Note: The LOCS flag is always 0 in external clock mode. |
| 1–0 | Reserved, must be cleared. |

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7.7.1.3 Relaxation Oscillator Control Register (ROCR)

The ROCR is used to trim the frequency of the on-chip oscillator. Setting one of the TRIM bits engages its associated bypass capacitance, which increases or decreases the period of the output frequency. The largest capacitance, and thus the biggest frequency step (40%), is associated with TRIM9. The lowest capacitance, and thus the smallest frequency step (0.8%), is associated with TRIM0. The tuning steps are binary-weighted in terms of signal period, not frequency. The module was designed such that the approximate middle of the tuning range is 8 MHz.

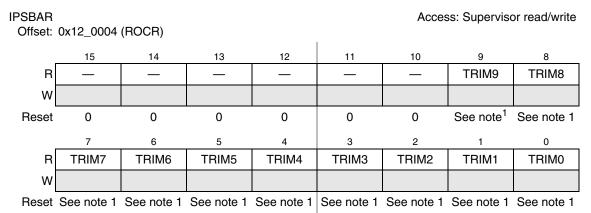


Figure 7-4. Relaxation Oscillator Control Register (ROCR)

Table 7-7. ROCR Field Descriptions

| Field | Description |
|-------------|---|
| 15–10 — | Reserved, must be cleared. |
| 9–0 TRIM | 10-bit trim value used to trim the frequency of the on-chip oscillator. |

7.7.1.4 Low-Power Divider Register (LPDR)

The LPDR contains a 4-bit field that divides down the system clock (regardless if the reference clock or PLL clock is driving the system clock) by a factor of 2ⁿ (where n is a number from 0 to 15 represented by the 4 bit field). The clock change takes effect with the next rising edge of the system clock.

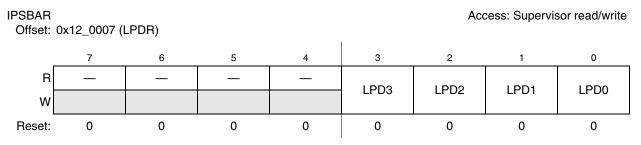


Figure 7-5. Low-Power Divider Register (LPDR)

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¹ Loaded during reset from the flash information row (bits [9:0]).



Table 7-8. LPDR Field Descriptions

| Field | Description |
|------------|---|
| 7–4 | Reserved, must be cleared. |
| 3–0 LPD | Low-Power Divider. This field is used to divide down the system clock by a factor of 2 ^{LPD} . |

7.7.1.5 Clock Control High Register (CCHR)

The CCHR sets the pre-division factor, which divides down the PLL input clock by 1 (CCHR[2:0] = 000) to 8 (CCHR[2:0] =111). This allows an external oscillator or crystal of more than 10 MHz to be used with the PLL. The division factor should be set to generate an input clock for the PLL refer to the device datasheet for crystal oscillator frequency range in normal PLL mode. When CCHR[2:0] are changed or the PLL is disabled in stop mode, the PLL loses lock.

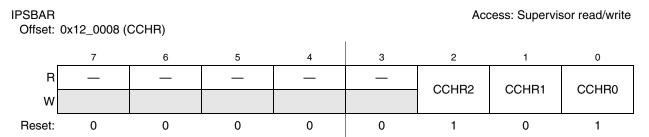


Figure 7-6. Clock Control High Register (CCHR)

Table 7-9. CCHR Field Descriptions

| Field | Description |
|-------------|---|
| 7–3 | Reserved, must be cleared. |
| 2-0 CCHR | Clock Control High Register. This field is used to divide down the PLL reference clock by a factor of CCHR+1. |

7.7.1.6 Clock Control Low Register (CCLR)

The CCLR selects the clock source for the PLL input/bypass clock. The two possible sources are the external oscillator (in external crystal or external oscillator mode) and the relaxation oscillator. When switching clock sources, the module ensures that the changeover does not cause spurious glitches in the system clock, and that the crystal and the relaxation oscillator remain enabled for the duration of the changeover.

When switching the clock source to the relaxation oscillator, OCHR[OCOEN] should be set before OSCSEL is set. Similarly, when switching the clock source to the external oscillator, OCLR[OSCEN] should be set before OSCSEL is cleared.



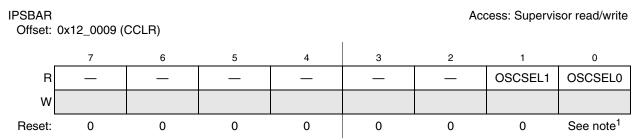


Figure 7-7. Clock Control Low Register (CCLR)

Table 7-10.

| Field | Description |
|--------------|---|
| 7–1 | Reserved, must be cleared. |
| 1 OSCSEL1 | Oscillator Select 1 bit. This bit works in conjunction with the OSCSEL0 bit to select the clock source for the PLL input/bypass clock, as shown in Table 7-11. O PLL input/bypass clock comes from the external oscillator. 1 PLL input/bypass clock comes from the relaxation oscillator. Note: When switching clock sources, the module ensures that, during the changeover, no spurious glitches occur in the system clock, and that the crystal and relaxation oscillators remain enabled. |
| 0 OSCSEL0 | Oscillator Select 0 bit. This bit works in conjunction with the OSCSEL1 bit to select the clock source for the PLL input/bypass clock, as shown in Table 7-11. O PLL input/bypass clock comes from the primary oscillator. 1 PLL input/bypass clock comes from the relaxation oscillator. Note: When switching clock sources, the module ensures that, during the changeover, no spurious glitches occur in the system clock, and that the crystal and relaxation oscillators remain enabled. |

Table 7-11. CCLR[OSCSEL1] and CCLR[OSCSEL0] Settings

| OSCSEL1 | OSCSEL0 | Source of PLL input/bypass clock |
|---------|---------|----------------------------------|
| 0 | 0 | Primary oscillator (default) |
| 0 | 1 | Relaxation oscillator |
| 1 | 0 | Secondary oscillator |
| 1 | 1 | |

7.7.1.7 Oscillator Control High Register (OCHR)

The OCHR is used to enable and configure the relaxation oscillator.

¹ The OSCSEL reset state is determined during reset configuration.



Clock Module

IPSBAR Access: Supervisor read/write Offset: 0x12_000A (OCHR) 7 0 OCOEN STBY

0 Figure 7-8. Oscillator Control High Register (OCHR)

0

0

0

0

0

0

See note1

Reset:

Table 7-12. OCHR Field Descriptions

| Field | Description | |
|------------|--|--|
| 7 OCOEN | On-chip Oscillator Enable bit. This bit enables the relaxation oscillator. O Relaxation oscillator is disabled. Relaxation oscillator is enabled. Note: When switching the clock source to the relaxation oscillator, this bit should be set before CCLR[OSCSEL] is set. | |
| 6 STBY | Relaxation oscillator standby. This bit configures the relaxation oscillator for Standby mode with the output clock running at 400 kHz. O Relaxation oscillator is running in normal mode with an output clock of 8 MHz. Relaxation oscillator is running in standby mode with an output clock of 400 kHz. | |
| 5–0 | Reserved, must be cleared. | |

Oscillator Control Low Register (OCLR) 7.7.1.8

The OCLR is used to enable and configure the external oscillator.

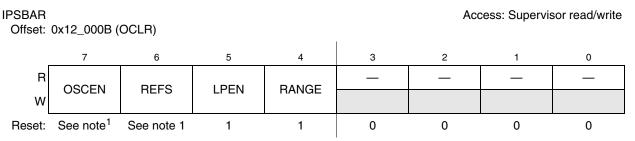


Figure 7-9. Oscillator Control Low Register (OCLR)

¹ The OCOEN reset state is determined during reset configuration.

¹ The OSCEN and REFS reset states are determined during reset configuration.



Table 7-13. OCLR Field Descriptions

| Field | Description | |
|------------|---|--|
| 7 OSCEN | External Oscillator Enable bit. This bit enables the crystal oscillator in external crystal or external oscillator mode. 0 External oscillator is disabled. 1 External oscillator is enabled. Note: When switching the clock source to the external oscillator, this bit should be set before CCLR[OSCSEL] is cleared. | |
| 6 REFS | Reference Source bit. This bit configures the external oscillator for operation with an external crystal or external oscillator. 0 External oscillator is running in external oscillator mode. 1 External oscillator is running in external crystal mode. | |
| 5 LPEN | Low-Power Enable bit. This bit configures the external oscillator to run in low-power mode when using an external crystal. 0 External oscillator runs in normal-power mode. 1 External oscillator runs in low-power mode. | |
| 4 RANGE | Range bit. This bit configures the external oscillator to run with different frequency crystals. 0 Support external crystal of 32 kHz. 1 Support external crystal in the range of 1 MHz to 16 MHz. | |
| 3–0 | Reserved, must be cleared. | |

Real-Time Clock Control Register (RTCCR) 7.7.1.9

The RTCCR is used to configure the RTC oscillator.

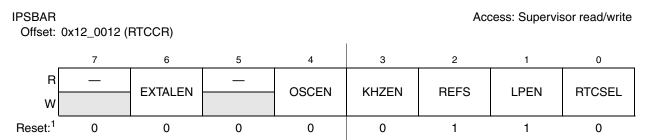


Figure 7-10. Real-Time Clock Control Register (RTCCR)

RTC registers are reset only once, during the first power-on reset (POR), and are never reset again as long as the power source is connected.



Table 7-14. RTCCR Field Descriptions

| Field | Description |
|-------------|--|
| 7 | Reserved, must be cleared. |
| 6 | The EXTALEN bit enables and disables the RTC_EXTAL pin, allowing current draw to be reduced if the RTC is not used: 0 RTC_EXTAL is disabled. 1 RTC_EXTAL is enabled. |
| 5 | Reserved, must be cleared. |
| 4 OSCEN | RTC Oscillator Enable bit. This bit enables the RTC oscillator. 0 RTC oscillator is disabled. 1 RTC oscillator is enabled. |
| 3 KHZEN | The KHZEN bit selects the operating frequency range of the oscillator O Oscillator operates in the kHz range. Oscillator operates in the MHz range. |
| 2 REFS | Reference Source bit. This bit configures the RTC oscillator for operation with an external crystal or external oscillator. 0 RTC oscillator is running in external oscillator mode. 1 RTC oscillator is running in external crystal mode. |
| 1 LPEN | Low-Power Enable bit. This bit configures the RTC oscillator to run in low-power mode when using an external crystal. O RTC oscillator runs in normal-power mode. 1 RTC oscillator runs in low-power mode. |
| 0 RTCSEL | RTC source selection bit. This bit configures the source of the RTC clock. O Source is the system clock. Source is the RTC oscillator. |

7.7.1.10 Backup Watchdog Timer Control Register (BWCR)

The BWCR is used to configure the interaction between the clock module and the Backup Watchdog Timer module (see Chapter 8, "Backup Watchdog Timer (BWT) Module").

NOTE

The BWCR is a write-once register. The contents of this register are preserved during a warm reset. This register is reset only by a Power-on Reset event.

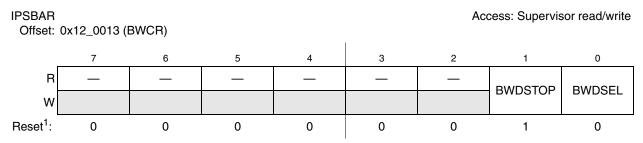


Figure 7-11. Backup Watchdog Timer Control Register (BWCR)

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The BWCR is reset to these values only after a Power-On Reset. The register contents are preserved during a warm reset.

Table 7-15. BWCR Field Descriptions

| Field | Description |
|--------------|---|
| 7–2 | Reserved, must be cleared. |
| 1 BWDSTOP | This bit determines whether the relaxation oscillator input to the BWT is stopped during Stop mode operation. O The relaxation oscillator input to the BWT is stopped when the device enters Stop mode. When the device leaves Stop mode, the relaxation oscillator input to the BWT is restored. The relaxation oscillator input continues to be provided to the BWT when the device enters Stop mode. |
| 0 BWDSEL | BWT clock source selection bit. This bit determines the source of the BWT clock. 0 The source for the BWT is half the system frequency, f _{sys/2} . 1 The source for the BWT is the relaxation oscillator. After this value is selected, CCLR[OSCSEL0] can no longer be set. |

7.8 **Functional Description**

This section provides a functional description of the clock module.

System Clock Modes 7.8.1

The system clock source and PLL mode (enabled/disabled) are determined during reset (see Table 11-5). The values of CLKMOD[1:0] (and XTAL if CLKMOD0 does not equal 1) are latched during reset and are of no importance after reset is negated. If CLKMOD1 or CLKMOD0 change during a reset other than power-on reset, the internal clocks may glitch as the system clock source is changed between external clock mode and PLL clock mode. When CLKMOD1 or CLKMOD0 is changed in reset, an immediate loss-of-lock condition occurs.

Table 7-16 shows the clock out frequency to clock in frequency relationships for the possible system clock modes.

Table 7-16. Clock Out and Clock In Relationships

| System Clock Mode | PLL Options ¹ |
|-----------------------|---|
| Normal PLL clock mode | $f_{sys} = f_{ref} \times 2(MFD + 2)/2^{RFD}$ |
| External clock mode | $f_{sys} = f_{ref}$ |

f_{ref} = input reference frequency f_{sys} = CLKOUT frequency MFD ranges from 0 to 7. RFD ranges from 0 to 7.

The external clock is divided by two internally to produce the system clocks.

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7.8.2 Clock Operation During Reset

In external clock mode, the system is static and does not recognize reset until a clock is generated from the reference clock source selected by the CLKMOD pins (see Section 7.6.4, "CLKMOD[1:0]).

In PLL mode, the PLL operates in self-clocked mode (SCM) during reset until the input reference clock to the PLL begins operating within the limits given in the electrical specifications.

If a PLL failure causes a reset, the system enters reset using the reference clock. Then the system clock source changes to the PLL operating in SCM. If SCM is not functional, the system becomes static. Alternately, if SYNCR[LOCEN] is cleared when the PLL fails, the system becomes static. If external reset is asserted, the system cannot enter reset unless the PLL is capable of operating in SCM.

7.8.3 System Clock Generation

In normal PLL clock mode, the default system frequency is six times the reference frequency after reset. The RFD[2:0] and MFD[2:0] bits in the SYNCR select the frequency multiplier. The LPD[3:0] field in the LPDR register provides additional settings for dividing down the system clock (including when the PLL is disabled) for low-power operation.

When programming the PLL, do not exceed the maximum system clock frequency listed in the electrical specifications. Use this procedure to accommodate the frequency overshoot that occurs when the MFD bits are changed:

- 1. Determine the appropriate value for the MFD and RFD fields in the SYNCR. The amount of jitter in the system clocks can be minimized by selecting the maximum MFD factor that can be paired with an RFD factor to provide the required frequency.
- 2. Write a value of 1 + RFD (from step 1) to the RFD field of the SYNCR.
- 3. Write the MFD value from step 1 to the SYNCR.
- 4. Monitor the LOCK flag in SYNSR. When the PLL achieves lock, write the RFD value from step 1 to the RFD field of the SYNCR. This changes the system clocks frequency to the required frequency.

NOTE

Keep the maximum system clock frequency below the limit given in the electrical characteristics

7.8.4 PLL Operation

In PLL mode, the PLL synthesizes the system clocks. The PLL can multiply the reference clock frequency by 4x to 18x, provided that the system clock frequency remains within the range listed in electrical specifications. For example, if the reference frequency is 2 MHz, the PLL can synthesize frequencies of 8 MHz to 36 MHz. In addition, the RFD can reduce the system frequency by dividing the output of the PLL. The RFD is not in the feedback loop of the PLL, so changing the RFD divisor does not affect PLL operation.

Figure 7-12 shows the external support circuitry for the crystal oscillator with example component values. Actual component values depend on crystal specifications.



The following subsections describe each major block of the PLL. Refer to Figure 7-12 to see how these functional sub-blocks interact.

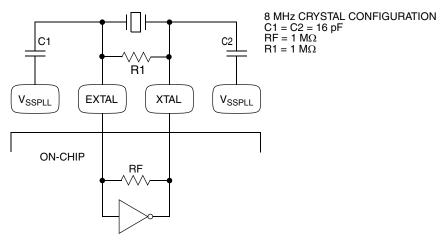


Figure 7-12. Crystal Oscillator Example

7.8.4.1 Phase and Frequency Detector (PFD)

The PFD is a dual-latch phase-frequency detector. It compares the phase and frequency of the reference and feedback clocks. The reference clock comes from the crystal oscillator or an external clock source.

The feedback clock comes from the following:

VCO output divided by the MFD in normal PLL mode

When the frequency of the feedback clock equals the frequency of the reference clock, the PLL is frequency-locked. If the falling edge of the feedback clock lags the falling edge of the reference clock, the PFD pulses the UP signal. If the falling edge of the feedback clock leads the falling edge of the reference clock, the PFD pulses the DOWN signal. The width of these pulses relative to the reference clock depends on how much the two clocks lead or lag each other. After phase lock is achieved, the PFD continues to pulse the UP and DOWN signals for very short durations during each reference clock cycle. These short pulses continually update the PLL and prevent the frequency drift phenomenon known as dead-banding.

7.8.4.2 Charge Pump/Loop Filter

In normal mode the current magnitude of the charge pump varies with the MFD as shown in Table 7-17.

| Charge Pump Current | MFD |
|---------------------|-------------|
| 1x | 0 ≤ MFD < 2 |
| 2x | 2 ≤ MFD < 6 |
| 4x | 6 ≤ MFD |

Table 7-17. Charge Pump Current and MFD in Normal Mode Operation

The UP and DOWN signals from the PFD control whether the charge pump applies or removes charge, respectively, from the loop filter. The filter is integrated on the chip.

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7.8.4.3 Voltage Control Output (VCO)

The voltage across the loop filter controls the frequency of the VCO output. The frequency-to-voltage relationship (VCO gain) is positive, and the output frequency is four times the target system frequency.

7.8.4.4 Multiplication Factor Divider (MFD)

The MFD divides the output of the VCO and feeds it back to the PFD. The PFD controls the VCO frequency via the charge pump and loop filter such that the reference and feedback clocks have the same frequency and phase. Thus, the frequency of the input to the MFD, which is also the output of the VCO, is the reference frequency multiplied by the same amount that the MFD divides by. For example, if the MFD divides the VCO frequency by six, the PLL is frequency locked when the VCO frequency is six times the reference frequency. The presence of the MFD in the loop allows the PLL to perform frequency multiplication, or synthesis.

7.8.4.5 PLL Lock Detection

The lock detect logic monitors the reference frequency and the PLL feedback frequency to determine when frequency lock is achieved. Phase lock is inferred by the frequency relationship, but is not guaranteed. The LOCK flag in the SYNSR reflects the PLL lock status. A sticky lock flag, LOCKS, is also provided.

The lock detect function uses two counters: one is clocked by the reference, and the other is clocked by the PLL feedback. When the reference counter has counted N cycles, its count is compared to that of the feedback counter. If the feedback counter has also counted N cycles, the process is repeated for N + K counts. Then, if the two counters continue to match, the lock criteria is relaxed by 1/2 and the system is notified that the PLL has achieved frequency lock.

After lock is detected, the lock circuit continues to monitor the reference and feedback frequencies using the alternate count and compare process. If the counters do not match at any comparison time, then the LOCK flag is cleared to indicate that the PLL has lost lock. At this point, the lock criteria is tightened and the lock detect process is repeated.

The alternate count sequences prevent false lock detects due to frequency aliasing while the PLL tries to lock. Alternating between tight and relaxed lock criteria prevents the lock detect function from randomly toggling between locked and non-locked status due to phase sensitivities. Figure 7-13 shows the sequence for detecting locked and non-locked conditions.

In external clock mode, the PLL is disabled and cannot lock.



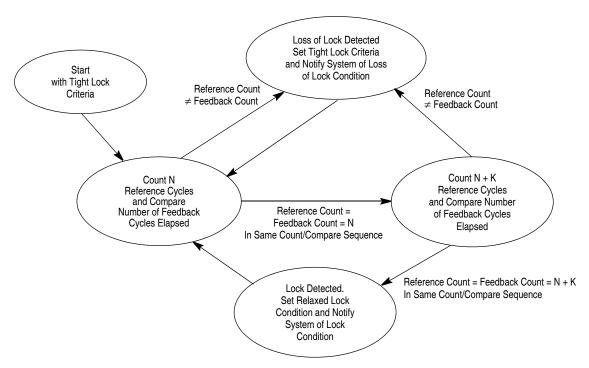


Figure 7-13. Lock Detect Sequence

7.8.4.6 PLL Loss of Lock Conditions

After the PLL acquires lock after reset, the LOCK and LOCKS flags are set. If the MFD is changed, or if an unexpected loss of lock condition occurs, the LOCK and LOCKS flags are negated. While the PLL is in the non-locked condition, the system clocks continue to be sourced from the PLL as the PLL attempts to relock. Consequently, during the relocking process, the system clocks frequency is not well defined and may exceed the maximum system frequency, violating the system clock timing specifications.

However, after the PLL has relocked, the LOCK flag is set. The LOCKS flag remains cleared if the loss of lock was unexpected. The LOCKS flag is set when the loss of lock is caused by changing MFD. If the PLL is intentionally disabled during stop mode, then after exit from stop mode, the LOCKS flag reflects the value prior to entering stop mode after lock is regained.

7.8.4.7 PLL Loss of Lock Reset

If the LOLRE bit in the SYNCR is set, a loss of lock condition asserts reset. Reset reinitializes the LOCK and LOCKS flags. Therefore, software must read the LOL bit in the reset status register (RSR) to determine if a loss of lock caused the reset. See Section 11.5.2, "Reset Status Register (RSR)."

To exit reset in PLL mode, the reference must be present, and the PLL must achieve lock.

In external clock mode, the PLL cannot lock. Therefore, a loss of lock condition cannot occur, and the LOLRE bit has no effect.

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7.8.4.8 Loss of Clock Detection

The LOCEN bit in the SYNCR enables the loss of clock detection circuit to monitor the input clocks to the phase and frequency detector (PFD). When the reference or feedback clock frequency falls below the minimum frequency, the loss of clock circuit sets the sticky LOCS flag in the SYNSR.

NOTE

In external clock mode, the loss of clock circuit is disabled.

7.8.4.9 Loss of Clock Reset

The clock module can assert a reset when a loss of clock or loss of lock occurs. When a loss-of-clock condition is recognized, reset is asserted if the LOCRE bit in SYNCR is set. The LOCS bit in SYNSR is cleared after reset. Therefore, the LOC bit must be read in RSR to determine that a loss of clock condition occurred. LOCRE has no effect in external clock mode.

To exit reset in PLL mode, the reference must be present, and the PLL must acquire lock.

Reset initializes the clock module registers to a known startup state as described in Section 7.7, "Memory Map and Registers."

7.8.4.10 Alternate Clock Selection

Depending on which clock source fails, the loss-of-clock circuit switches the system clocks source to the remaining operational clock. The alternate clock source generates the system clocks until reset is asserted. As Table 7-18 shows, if the reference fails, the PLL goes out of lock and into self-clocked mode (SCM). The PLL remains in SCM until the next reset. When the PLL is operating in SCM, the system frequency depends on the value in the RFD field. The SCM system frequency stated in electrical specifications assumes that the RFD has been programmed to binary 000. If the loss-of-clock condition is due to PLL failure, the PLL reference becomes the system clocks source until the next reset, even if the PLL regains and relocks

| Clock Mode | System Clock Source Before Failure | Reference Failure Alternate Clock Selected by LOC Circuit ¹ Until Reset | PLL Failure Alternate Clock Selected by LOC Circuit Until Reset | | | |
|---------------|---------------------------------------|---|--|--|--|--|
| PLL | PLL | PLL self-clocked mode | PLL reference | | | |
| External | External clock | None | NA | | | |

Table 7-18. Loss of Clock Summary

A special loss-of-clock condition occurs when the reference and the PLL fail. The failures may be simultaneous, or the PLL may fail first. In either case, the reference clock failure takes priority and the PLL attempts to operate in SCM. If successful, the PLL remains in SCM until the next reset. If the PLL cannot operate in SCM, the system remains static until the next reset. The reference and the PLL must be functioning properly to exit reset.

¹ The LOC circuit monitors the reference and feedback inputs to the PFD. See Figure 7-12.



7.8.4.11 Loss of Clock in Stop Mode

Table 7-19 shows the resulting actions for a loss of clock in stop mode when the device is being clocked by the various clocking methods.

Table 7-19. Stop Mode Operation

| MODE In | LOCEN | LOCRE | LOLRE | PLL | osc | FWKUP | Expected PLL Action at Stop | PLL Action During Stop | MODE Out | LOCKSS | LOCK | SOOT | Comments |
|------------|-------|-------|-------|-----|-----|-------|---|--|--------------------------|--------|------|--------|---|
| EXT | Χ | Χ | Х | Χ | Χ | Х | _ | _ | EXT | 0 | 0 | 0 | |
| | | | | | | | | Lose reference clock | Stuck | _ | _ | _ | |
| NRM | 0 | 0 | 0 | Off | Off | 0 | Lose lock, f.b. clock, | Regain | NRM | 'LK | 1 | 'LC | |
| | | | | | | | reference clock | No regain | Stuck | _ | _ | _ | |
| NRM | X | 0 | 0 | Off | Off | 1 | Lose lock, f.b. clock, reference clock | Regain clocks, but don't regain lock | SCM-> unstable NRM | 0->'LK | 0->1 | 1->'LC | Block LOCS and LOCKS until clock and lock respectively regain; enter SCM regardless of LOCEN bit until reference regained |
| | | | | | | | | No reference clock regain | SCM-> | 0-> | 0-> | 1-> | Block LOCS and LOCKS until clock and lock respectively regain; enter SCM regardless of LOCEN bit |
| | | | | | | | | No f.b. clock regain | Stuck | _ | _ | _ | |
| NRM | 0 | 0 | 0 | Off | On | 0 | Lose lock | Regain | NRM | 'LK | 1 | 'LC | Block LOCKS from being cleared |
| | | | | | | | | Lose reference clock or no lock regain | Stuck | _ | _ | _ | |
| | | | | | | | | Lose reference clock, regain | NRM | 'LK | 1 | 'LC | Block LOCKS from being cleared |

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Table 7-19. Stop Mode Operation (continued)

| MODE In | LOCEN | LOCRE | LOLRE | PLL | osc | FWKUP | Expected PLL Action at Stop | PLL Action During Stop | MODE Out | LOCKSS | LOCK | SOOT | Comments |
|------------|-------|-------|-------|-----|-----|-------|---|--|-----------------|--------|------|------|--|
| NRM | 0 | 0 | 0 | Off | On | 1 | Lose lock | No lock regain | Unstable NRM | 0->'LK | 0->1 | 'LC | Block LOCKS until lock regained |
| | | | | | | | | Lose reference clock or no f.b. clock regain | Stuck | _ | _ | _ | |
| | | | | | | | | Lose reference clock, regain | Unstable NRM | 0->'LK | 0->1 | 'LC | LOCS not set because LOCEN = 0 |
| NRM | 0 | 0 | 0 | On | On | 0 | _ | _ | NRM | 'LK | 1 | 'LC | |
| | | | | | | | | Lose lock or clock | Stuck | _ | | _ | |
| | | | | | | | | Lose lock, regain | NRM | 0 | 1 | 'LC | |
| | | | | | | | | Lose clock and lock, regain | NRM | 0 | 1 | 'LC | LOCS not set because LOCEN = 0 |
| NRM | 0 | 0 | 0 | On | On | 1 | _ | _ | NRM | 'LK | 1 | 'LC | |
| | | | | | | | | Lose lock | Unstable NRM | 0 | 0->1 | 'LC | |
| | | | | | | | | Lose lock, regain | NRM | 0 | 1 | 'LC | |
| | | | | | | | | Lose clock | Stuck | _ | _ | _ | |
| | | | | | | | | Lose clock, regain without lock | Unstable NRM | 0 | 0->1 | 'LC | |
| | | | | | | | | Lose clock, regain with lock | NRM | 0 | 1 | 'LC | |
| NRM | Х | Х | 1 | Off | Х | X | Lose lock, f.b. clock, reference clock | RESET | RESET | _ | _ | _ | Reset immediately |
| NRM | 0 | 0 | 1 | On | On | Χ | _ | _ | NRM | 'LK | 1 | 'LC | |
| | | | | | | | | Lose lock or clock | RESET | _ | _ | _ | Reset immediately |
| NRM | 1 | 0 | 0 | Off | Off | 0 | Lose lock, f.b. clock, reference clock | Regain | NRM | 'LK | 1 | 'LC | REF not entered during stop; SCM entered during stop only during oscillator startup |
| | | | | | | | | No regain | Stuck | - | | _ | |

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Table 7-19. Stop Mode Operation (continued)

| MODE In | LOCEN | LOCRE | LOLRE | PLL | osc | FWKUP | Expected PLL Action at Stop | PLL Action During Stop | MODE Out | LOCKSS | LOCK | SOOT | Comments |
|------------|-------|-------|-------|-----|-----|-------|---|------------------------------|-----------------|--------|------|------|----------------------------------|
| NRM | 1 | 0 | 0 | Off | On | 0 | Lose lock, f.b. clock | Regain | NRM | 'LK | 1 | 'LC | REF mode not entered during stop |
| | | | | | | | | No f.b. clock or lock regain | Stuck | _ | _ | _ | |
| | | | | | | | | Lose reference clock | SCM | 0 | 0 | 1 | Wakeup without lock |
| NRM | 1 | 0 | 0 | Off | On | 1 | Lose lock, f.b. clock | Regain f.b. clock | Unstable NRM | 0->'LK | 0->1 | 'LC | REF mode not entered during stop |
| | | | | | | | | No f.b. clock regain | Stuck | _ | _ | _ | |
| | | | | | | | | Lose reference clock | SCM | 0 | 0 | 1 | Wakeup without lock |
| NRM | 1 | 0 | 0 | On | On | 0 | _ | _ | NRM | 'LK | 1 | 'LC | |
| | | | | | | | | Lose reference clock | SCM | 0 | 0 | 1 | Wakeup without lock |
| | | | | | | | | Lose f.b. clock | REF | 0 | Х | 1 | Wakeup without lock |
| | | | | | | | | Lose lock | Stuck | _ | _ | _ | |
| | | | | | | | | Lose lock, regain | NRM | 0 | 1 | 'LC | |
| NRM | 1 | 0 | 0 | On | On | 1 | _ | _ | NRM | 'LK | 1 | 'LC | |
| | | | | | | | | Lose reference clock | SCM | 0 | 0 | 1 | Wakeup without lock |
| | | | | | | | | Lose f.b. clock | REF | 0 | Х | 1 | Wakeup without lock |
| | | | | | | | | Lose lock | Unstable NRM | 0 | 0->1 | 'LC | |
| NRM | 1 | 0 | 1 | On | On | Х | _ | _ | NRM | 'LK | 1 | 'LC | |
| | | | | | | | | Lose lock or clock | RESET | _ | _ | _ | Reset immediately |
| NRM | 1 | 1 | Х | Off | Х | Х | Lose lock, f.b. clock, reference clock | RESET | RESET | _ | _ | _ | Reset immediately |



Clock Module

Table 7-19. Stop Mode Operation (continued)

| MODE In | LOCEN | LOCRE | LOLRE | PLL | osc | FWKUP | Expected PLL Action at Stop | PLL Action During Stop | MODE Out | LOCKSS | LOCK | SOOT | Comments |
|------------|-------|-------|-------|-----|-----|-------|--------------------------------------|---------------------------|-----------------|--------|------|------|---------------------|
| NRM | 1 | 1 | 0 | On | On | 0 | _ | _ | NRM | 'LK | 1 | 'LC | |
| | | | | | | | | Lose clock | RESET | _ | _ | _ | Reset immediately |
| | | | | | | | | Lose lock | Stuck | _ | | _ | |
| | | | | | | | | Lose lock, regain | NRM | 0 | 1 | 'LC | |
| NRM | 1 | 1 | 0 | On | On | 1 | _ | _ | NRM | 'LK | 1 | 'LC | |
| | | | | | | | | Lose clock | RESET | _ | _ | _ | Reset immediately |
| | | | | | | | | Lose lock | Unstable NRM | 0 | 0->1 | 'LC | |
| | | | | | | | | Lose lock, regain | NRM | 0 | 1 | 'LC | |
| NRM | 1 | 1 | 1 | On | On | Χ | _ | _ | NRM | 'LK | 1 | 'LC | |
| | | | | | | | | Lose clock or lock | RESET | _ | _ | _ | Reset immediately |
| REF | 1 | 0 | 0 | Χ | Χ | Χ | _ | _ | REF | 0 | Х | 1 | |
| | | | | | | | | Lose reference clock | Stuck | _ | _ | _ | |
| SCM | 1 | 0 | 0 | Off | X | 0 | PLL disabled | Regain SCM | SCM | 0 | 0 | 1 | Wakeup without lock |
| SCM | 1 | 0 | 0 | Off | X | 1 | PLL disabled | Regain SCM | SCM | 0 | 0 | 1 | |
| SCM | 1 | 0 | 0 | On | On | 0 | _ | _ | SCM | 0 | 0 | 1 | Wakeup without |
| | | | | | | | | Lose reference clock | SCM | | | | lock |



Table 7-19. Stop Mode Operation (continued)

| MODE In | LOCEN | LOCRE | LOLRE | PLL | osc | FWKUP | Expected PLL Action at Stop | PLL Action During Stop | MODE Out | LOCKSS | ГОСК | rocs | Comments |
|------------|-------|-------|-------|-----|-----|-------|--------------------------------------|---------------------------|-------------|--------|------|------|----------|
| SCM | 1 | 0 | 0 | On | On | 1 | _ | _ | SCM | 0 | 0 | 1 | |
| | | | | | | | | Lose reference clock | SCM | | | | |

Note:

PLL = PLL enabled during STOP mode. PLL = On when STPMD[1:0] = 00 or 01

OSC = oscillator enabled during STOP mode. Oscillator is on when STPMD[1:0] = 00, 01, or 10

MODES

NRM = normal PLL crystal clock reference or normal PLL external reference mode. During normal external reference mode, the oscillator is never enabled. Therefore, during these modes, refer to the OSC = On case regardless of STPMD values.

EXT = external clock mode

REF = PLL reference mode due to losing PLL clock or lock from NRM mode

SCM = PLL self-clocked mode due to losing reference clock from NRM mode

RESET = immediate reset

LOCKS

'LK -= expecting previous value of LOCKS before entering stop

0->'LK = current value is 0 until lock is regained which then is the previous value before entering stop

0-> = current value is 0 until lock is regained but lock is never expected to regain

LOCS

'LC = expecting previous value of LOCS before entering stop

1->'LC = current value is 1 until clock is regained which then is the previous value before entering stop

1-> = current value is 1 until clock is regained but CLK is never expected to regain



Chapter 8 Backup Watchdog Timer (BWT) Module

8.1 Introduction

The Backup Watchdog Timer (BWT) module is used to help software recover from runaway code. This section presents the modes of operation, register information, and functional description of the BWT. A block diagram of the BWT is shown in Figure 8-1.

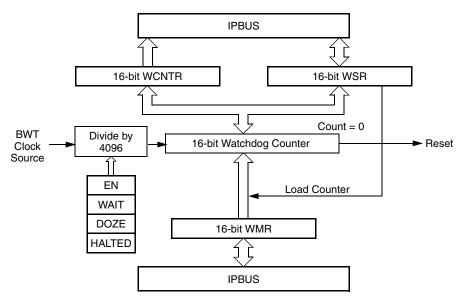


Figure 8-1. Backup Watchdog Timer Block Diagram

8.1.1 Overview

The BWT is a 16-bit timer that is useful in helping software to recover from runaway code. It incorporates a free-running up-counter that generates a warm reset on underflow. After generating the reset, the BWT sets bit 7 of the Reset Status Register. To prevent a reset, software must periodically restart the countdown by writing a special set of values to a register in the BWT. This periodic writing process is referred to as servicing the BWT.

The clock source for the BWT can come from the relaxation oscillator or the system clock (see Section 7.7.1.10, "Backup Watchdog Timer Control Register (BWCR)").

8.1.2 Modes of Operation

This section describes the operation of the BWT in low-power modes of operation. These modes are described in Chapter 10, "Power Management".

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Backup Watchdog Timer (BWT) Module

8.1.2.1 Wait Mode

The functionality of the BWT in Wait mode depends on the value of WCR[WAIT].

When WCR[WAIT]=1, the BWT stops when the device enters Wait mode. When the device leaves Wait mode, the BWT resumes from the state it was in when it stopped.

When WCR[WAIT]=0, the BWT continues to operate normally when the device enters Wait mode.

8.1.2.2 **Doze Mode**

The functionality of the BWT in Doze mode depends on the value of WCR[DOZE].

When WCR[DOZE]=1, the BWT stops when the device enters Doze mode. When the device leaves Doze mode, the BWT resumes from the state it was in when it stopped.

When WCR[DOZE]=0, the BWT continues to operate normally when the device enters Doze mode.

8.1.2.3 **Stop Mode**

The functionality of the BWT in Stop mode depends on the value of WCR[STOP].

When WCR[STOP]=1, the BWT stops when the device enters Stop mode. When the device leaves Stop mode, the BWT resumes from the state it was in when it stopped.

When WCR[STOP]=0, the BWT continues to operate normally when the device enters Stop mode.

8.2 Memory Map and Register Definition

The backup watchdog timer programming model includes registers in the BWT and clock modules. The registers used to configure the BWT are read-always/write once, and their contents are preserved during a warm reset. Only a Power-On Reset resets these registers to their default values.

8.2.1 Memory Map

Table 8-1. BWT Memory Map

| IPSBAR Offset ¹ | Register | Width (bits) | Access | Reset Value | Section/Page |
|-------------------------------|---|-----------------|------------------|-------------|---------------|
| 0x14_0000 | Backup Watchdog Timer Control Register (WCR) | 8 | R/W ² | 0x02 | 8.2.2.1/8-4 |
| 0x14_0002 | Backup Watchdog Timer Modulus Register (WMR) | 16 | R/W ² | 0xFFFF | 8.2.2.2/8-5 |
| 0x14_0004 | Backup Watchdog Timer Count Register (WCNTR) | 16 | R | 0xFFFF | 8.2.2.3/8-5 |
| 0x14_0006 | Backup Watchdog Timer Service Register (WSR) | 16 | R/W | 0x00 | 8.2.2.4/8-6 |
| 0x12_0013 | Clock Module Backup Watchdog Timer Control Register (BWCR) ³ | 8 | R/W ³ | 0x02 | 7.7.1.10/7-16 |

Addresses not assigned to a register and undefined register bits are reserved for expansion.

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² WCR and WMR are read-always/write-once, and cannot be changed until the next Power-On Reset event.

³ This read-always/write-once register is part of the Clock Module; see Section 7.7.1.10, "Backup Watchdog Timer Control Register (BWCR)," for a detailed description.



8.2.2 Register Descriptions

8.2.2.1 Backup Watchdog Timer Control Register (WCR)

The WCR, shown in Figure 8-2, configures the operation of the BWT. It is a read-always/write-once register; after the register is written, the contents cannot be changed until the next Power-On Reset event occurs.

This register must be written as a whole.

NOTE

To ensure that the BWT is properly enabled, the software must write a value to the WMR (see Section 8.2.2.2, "Backup Watchdog Timer Modulus Register (WMR)") prior to writing to the WCR.

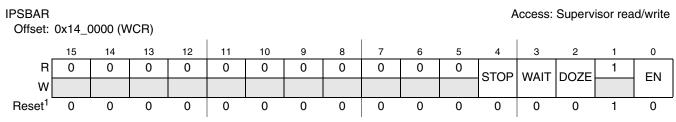


Figure 8-2. Backup Watchdog Timer Control Register (WCR)

Table 8-2. WCR Field Descriptions

| Field | Description |
|-----------|--|
| 15–5 | Reserved, should read 0. Writes have no effect and terminate without transfer error exception. |
| 4 STOP | Stop Mode bit. This read-always/write-once bit controls the function of the BWT in Stop mode. 0 BWT continues to operate when the device enters Stop mode as long as the BWT is provided with a clock. 1 BWT stops when the device enters Stop mode. |
| 3 WAIT | Wait Mode bit. This read-always/write-once bit controls the function of the BWT in Wait mode. 0 BWT continues to operate when the device enters Wait mode. 1 BWT stops when the device enters Wait mode. |
| 2 DOZE | Doze Mode bit. This read-always/write-once bit controls the function of the BWT in Doze mode. 0 BWT continues to operate when the device enters Doze mode. 1 BWT stops when the device enters Doze mode. |
| 1 | Reserved, should read 1. |
| 0 EN | BWT Enable bit. This read-always/write-once bit enables the BWT. 0 BWT is disabled. 1 BWT is enabled. |

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After Power-On Reset; the register contents are preserved during warm resets.



Backup Watchdog Timer (BWT) Module

8.2.2.2 Backup Watchdog Timer Modulus Register (WMR)

The WMR, shown in Figure 8-3, contains the value (modulus) that is loaded into the BWT count register (WCNTR) when the BWT is serviced. This value effectively corresponds to the BWT's timeout period. The software must service the timer within this period to avoid a reset. The timeout period is a function of the WMR, the period of the BWT's input clock, and the device operating mode, as shown in the equation in Table 8-3.

The WMR is a read-always/write-once register; after the register is written, the contents cannot be changed until the next Power-On Reset event occurs.

NOTE

To ensure that the BWT is properly enabled, the software must write a value to the WMR prior to writing to the WCR.

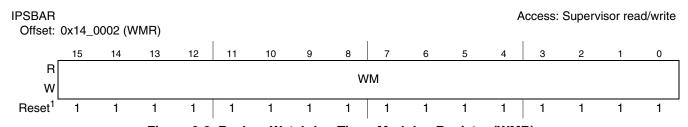


Figure 8-3. Backup Watchdog Timer Modulus Register (WMR)

Table 8-3. WMR Field Descriptions

| Field | Description |
|------------|---|
| 15–0 WM | BWT modulus. This value is loaded into the BWT count register (WCNTR) when the BWT is serviced. It thus corresponds to the BWT's timeout period. The actual timeout period is given by the following equations: |
| | Device in Stop/Wait/Doze mode: $T = [(WM + 1) \cdot 4096 + 16]\tau$ |
| | Device not in Stop/Wait/Doze mode: $T = [(WM + 1) \cdot 4096 + 4]\tau$ |
| | where T is the timeout period and τ is the period of the BWT's input clock. |

8.2.2.3 Backup Watchdog Timer Count Register (WCNTR)

The WCNTR, shown in Figure 8-4, reflects the current value in the BWT counter. This counter is reset to the value in WMR when the BWT is serviced.

WCNTR should be read as a whole; reading it with two 8-bit reads may not return the correct value. Writing to WCNTR has no effect and results in a normal write cycle termination.

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After Power-On Reset; the register contents are preserved during warm resets.



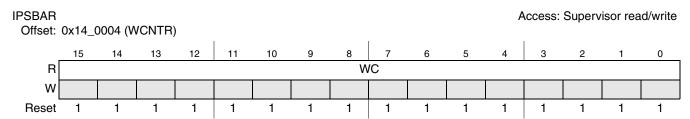


Figure 8-4. Backup Watchdog Timer Count Register (WCNTR)

Table 8-4. WCNTR Field Descriptions

| Field | Description |
|------------|--|
| 15–0 WC | BWT counter. This field reflects the current value in the BWT counter. |

8.2.2.4 Backup Watchdog Timer Service Register (WSR)

The WSR is shown in Figure 8-5, and is used to instruct the BWT to reset its internal counter to the value in WMR[WM]. This is known as servicing the BWT. To do so, the software must write the two values 0x5555 and 0xAAAA, in that order, to WSR. These two write operations must be completed before the BWT timeout period is reached (i.e., WCNTR[WC] reaches zero). If these operations are not completed before the end of the timeout period, the BWT asserts a system reset.

The software can execute other instructions between the two write instructions required to service the BWT (0x5555 and 0xAAAA). All instructions, however, must be completed before the timeout period is reached to prevent a reset.

Writing any values other than 0x5555 or 0xAAAA to the WSR resets the servicing sequence. The software must then begin the sequence again (writing 0x5555 and 0xAAAA to WSR) to service the BWT.

This register must be written as a whole.

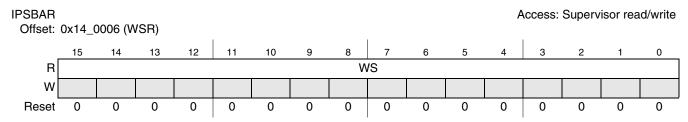


Figure 8-5. Backup Watchdog Timer Service Register (WSR)

Table 8-5. WSR Field Descriptions

| Field | Description |
|-------|---|
| | BWT service field. To service the BWT, the software must write the values 0x5555 and 0xAAAA, in that order, to this field before the BWT timeout period is reached. |

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Backup Watchdog Timer (BWT) Module

Functional Description 8.3

When the BWT is properly enabled, it loads the value in WMR[WM] into WCNTR[WC] and begins to decrement WCNTR[WC]. If WCNTR[WC] reaches zero, the BWT asserts a system reset. To prevent this reset, the BWT requires the software to write 0x5555 and 0xAAAA, in that order, to the WSR. This procedure, referred to as servicing the BWT, reinitializes the value of WCNTR[WC] to the value in WMR[WM]. This logic helps guard against runaway code.

The following procedure summarizes how to enable and service the BWT properly.

- 1. Select the desired clock source for the BWT from within the clock module (see Chapter 7, "Clock Module").
- 2. Write to the BWCR (see Section 7.7.1.10, "Backup Watchdog Timer Control Register (BWCR)") with the proper values for the chosen clock source.
- 3. Determine the desired timeout period for the BWT, and write it to the WMR. This step is recommended even if the default values are acceptable, to lock the register against accidental writes by runaway code.
- 4. Write to the WCR with WCR[EN]=1 and the WAIT, DOZE, and STOP bits configured as desired.
- 5. To prevent a reset, service the BWT by writing 0x5555 and 0xAAAA, in that order, to the WSR before the timeout period is reached.

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Chapter 9 Real-Time Clock

9.1 Introduction

This section discusses how to operate and program the real-time clock (RTC) module that maintains the system clock, provides stopwatch, alarm, and interrupt functions, and supports the following features.

9.1.1 Overview

Figure 9-1 is a block diagram of the Real-Time Clock (RTC) module. It consists of the following blocks:

- Time-of-day (TOD) clock counter
- Alarm
- Minute stopwatch
- Associated control and bus interface hardware

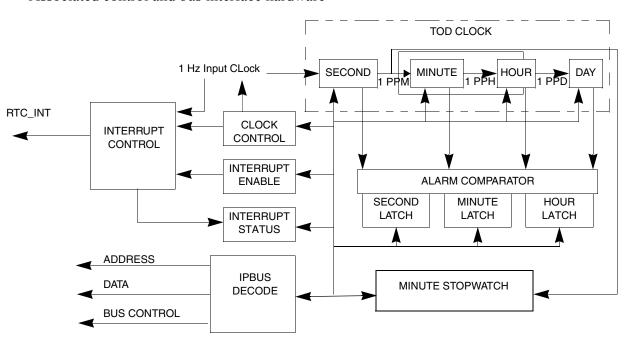


Figure 9-1. Real-Time Clock Block Diagram

9.1.2 Features

The RTC module includes the following features:

• Full clock—days, hours, minutes, seconds



Real-Time Clock

- Minute countdown timer with interrupt
- Programmable daily alarm with interrupt
- Once-per-day, once-per-hour, once-per-minute, and once-per-second interrupts

NOTE

For RTC clock signals, refer to Section 2.5, "Real-Time Clock Signals," and for RTC power/ground signals, refer to Section 2.20, "Mini-FlexBus."

9.1.3 Modes of Operation

The incoming 1 Hz signal is used to increment the seconds, minutes, hours, and days TOD counters. The alarm functions, when enabled, generate RTC interrupts when the TOD settings reach programmed values. The sampling timer generates fixed-frequency interrupts, and the minute stopwatch allows for efficient interrupts on minute boundaries.

Counter

The counter portion of the RTC module consists of four groups of counters that are physically located in three registers:

- The 6-bit seconds counter is located in the SECONDS register
- The 6-bit minutes counter and the 5-bit hours counter are located in the HOURMIN register
- The 16-bit day counter is located in the DAYR register

Alarm

There are three alarm registers that mirror the three counter registers. An alarm is set by accessing the real-time clock alarm registers (ALRM_HM, ALRM_SEC, and DAYALARM) and loading the exact time that the alarm should generate an interrupt. When the TOD clock value and the alarm value coincide, an interrupt occurs one half second later.

• Minute Stopwatch

The minute stopwatch performs a countdown with a one minute resolution. It can be used to generate an interrupt on a minute boundary.

9.2 Memory Map/Register Definition

The RTC module includes 10 32-bit registers. Table 9-1 summarizes these registers and their addresses.

Table 9-1. RTC Module Register Memory Map

| IPSBAR Offset | Use | Access |
|---------------|--|------------|
| 0x18_0000 | RTC Hours and Minutes Counter Register (HOURMIN) | read/write |
| 0x18_0004 | RTC Seconds Counter Register (SECONDS) | read/write |
| 0x18_0008 | RTC Hours and Minutes Alarm Register (ALRM_HM) | read/write |
| 0x18_000C | RTC Seconds Alarm Register (ALRM_SEC) | read/write |
| 0x18_0010 | RTC Control Register (RTCCTL) | read/write |
| 0x18_0014 | RTC Interrupt Status Register (RTCISR) | read/write |

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| IPSBAR Offset | Use | Access |
|---------------|---|------------|
| 0x18_0018 | RTC Interrupt Enable Register (RTCIENR) | read/write |
| 0x18_001C | Stopwatch Minutes Register (STPWCH) | read/write |
| 0x18_0020 | RTC Days Counter Register (DAYS) | read/write |
| 0x18_0024 | RTC Day Alarm Register (ALRM_DAY) | read/write |
| 0x18_0030 | Reserved | _ |
| 0x18_0034 | RTC General Oscillator Count Upper Register (RTCGOCU) | read/write |
| 0x18_0038 | RTC General Oscillator Count Lower Register (RTCGOCL) | read/write |

Table 9-1. RTC Module Register Memory Map (continued)

9.2.1 RTC Hours and Minutes Counter Register (HOURMIN)

The real-time clock hours and minutes counter register (HOURMIN) is used to program the hours and minutes for the TOD clock. It can be read or written at any time. After a write, the time changes to the new value. A power-on reset (POR) sets the RTC to the reset values shown in Figure 9-2.

| IPSBAR Offset: (| 0x18_(| 0000 (H | OURM | IN) | | | | | | | | | Ac | cess: L | lser rea | d/write |
|---------------------|--------|---------|------|-----|--------|--------|----|----|-------|----|----|----|---------|---------|----------|---------|
| | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
| R | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| w | | | | | | | | | | | | | | | | |
| Reset ¹ | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | | | | | ' I | | | | ' | | | | ' | | | |
| _ | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| R | 0 | 0 | 0 | | | HOURS | , | | 0 | 0 | | | MINU | ITEQ | | |
| w | | | | | | ilound | , | | | | | | IVIIINC | ILS | | |
| Reset ¹ | 0 | 0 | 0 | ? | ? | ? | ? | ? | 0 | 0 | ? | ? | ? | ? | ? | ? |

¹ RTC registers are reset only once, during the first power-on reset (POR), and are never reset again as long as the power source is connected.

Figure 9-2. RTC Hours and Minutes Counter Register (HOURMIN)

Table 9-2. HOURMIN Field Descriptions

| Field | Description |
|----------------|--|
| 31–13 | Reserved, should be cleared. |
| 12–8 HOURS | Hour setting; can be set to any value between 0 and 23. |
| 7–6 | Reserved, should be cleared. |
| 5-0 MINUTES | Minutes setting; can be set to any value between 0 and 59. |

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9.2.2 RTC Seconds Counter Register (SECONDS)

The real-time clock seconds register (SECONDS) is used to program the seconds for the TOD clock. It can be read or written at any time. After a write, the time changes to the new value. A power-on reset (POR) sets the RTC to the reset values shown in Figure 9-3.

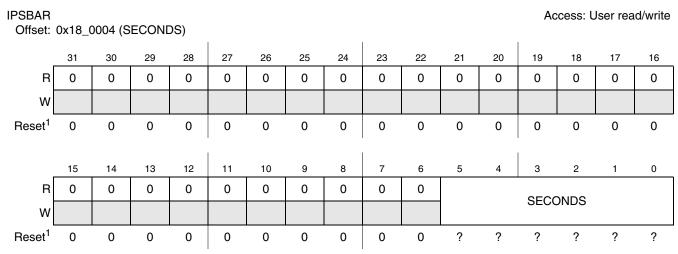


Figure 9-3. RTC Seconds Counter Register (SECONDS)

Table 9-3. SECONDS Field Descriptions

| Field | Description |
|----------------|--|
| 31–6 | Reserved, should be cleared. |
| 5-0 SECONDS | Seconds setting; can be set to any value between 0 and 59. |

9.2.3 RTC Hours and Minutes Alarm Register (ALRM_HM)

The real-time clock hours and minutes alarm (ALRM_HM) register is used to configure the hours and minutes setting for the alarm. The alarm settings can be read or written at any time.

¹ RTC registers are reset only once, during the first power-on reset (POR), and are never reset again as long as the power source is connected.



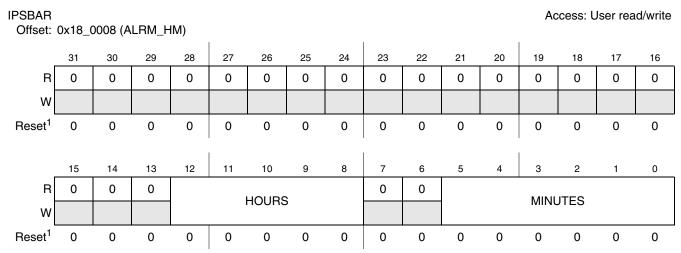


Figure 9-4. RTC Hours and Minutes Alarm Register (ALRM_HM)

Table 9-4. ALRM HM Field Descriptions

| Field | Description |
|----------------|---|
| 31–13 | Reserved, should be cleared. |
| 12-8 HOURS | Alarm hour setting; can be set to any value between 0 and 23. |
| 7–6 | Reserved, should be cleared. |
| 5-0 MINUTES | Alarm minute setting; can be set to any value between 0 and 59. |

RTC Seconds Alarm Register (ALRM_SEC) 9.2.4

The real-time clock seconds alarm (ALRM_SEC) register is used to configure the seconds setting for the alarm. The alarm settings can be read or written at any time.

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RTC registers are reset only once, during the first power-on reset (POR), and are never reset again as long as the power source is connected.



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| IPSBAR | | | | | | | | | | | | Ac | cess: L | Jser rea | ad/write | |
|---------------|---------|--------|------|----|----|----|-----|----|----|----|----|----|---------|----------|----------|--|
| Offset: 0x18_ | 000C (A | ALRM_S | SEC) | | | | | | | | | | | | | |
| | • | | • | I | | | | I | | | | I | | | | |
| 01 | 20 | 20 | 00 | 07 | 06 | OF | 0.4 | 00 | 00 | 01 | 20 | 10 | 10 | 17 | 16 | |

| | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
|--------------------|----|----|----|----|----|----|----|----|----|----|----|----|------|------|----|----|
| R | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| w | | | | | | | | | | | | | | | | |
| Reset ¹ | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | | | | | I | | | | | | | | I | | | |
| _ | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| R | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | | SECO | MDC | | |
| w | | | | | | | | | | | | | SECC | פטאכ | | |
| Reset ¹ | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

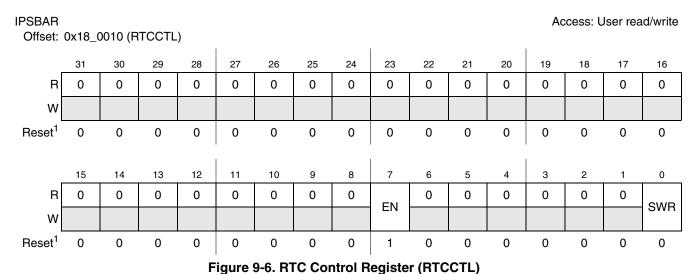
Figure 9-5. RTC Seconds Alarm Register (ALRM_SEC)

Table 9-5. ALRM_SEC Field Descriptions

| Field | Description |
|----------------|--|
| 31–6 | Reserved, should be cleared. |
| 5–0 SECONDS | Alarm seconds setting; can be set to any value between 0 and 59. |

9.2.5 RTC Control Register (RTCCTL)

The real-time clock control (RTCCTL) register is used to enable the real-time clock module and specify the reference frequency information for the prescaler.



¹ RTC registers are reset only once, during the first power-on reset (POR), and are never reset again as long as the power source is connected.

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¹ RTC registers are reset only once, during the first power-on reset (POR), and are never reset again as long as the power source is connected.



| Field | Description |
|----------|--|
| 31–8 | Reserved, should be cleared. |
| 7 EN | RTC Enables/Disable bit. This bit enables/disables the RTC. The software reset bit (SWR) has no effect on this bit. Bit description 0 Disable the real-time clock 1 Enable the real-time clock |
| 6–1 | Reserved, should be cleared. |
| 0 SWR | Software Reset bit. This bit resets the RTC to its default state. However, a software reset has no effect on the EN bit. 0 No effect 1 Reset the module to its default state |

9.2.6 RTC Interrupt Status Register (RTCISR)

The real-time clock interrupt status register (RTCISR) indicates the status of the various real-time clock interrupts. When an event of the types included in this register occurs, then the bit is set in this register regardless of its corresponding interrupt enable bit. These bits are cleared by writing a 1 to them; this also clears the interrupt. Interrupts may occur while the system clock is idle or in sleep mode.

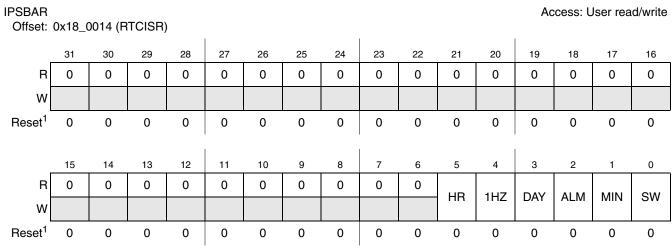


Figure 9-7. RTC Interrupt Status Register (RTCISR)

Table 9-7. RTCISR Field Descriptions

| Field | Description |
|---------|--|
| 31–6 | Reserved, should be cleared. |
| 5 HR | Hour flag bit. This bit indicates whether the hour counter has incremented. If enabled, this bit is set on every increment of the RTC hour counter. 0 No 1-hour interrupt occurred 1 A 1-hour interrupt has occurred |

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¹ RTC registers are reset only once, during the first power-on reset (POR), and are never reset again as long as the power source is connected.



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Table 9-7. RTCISR Field Descriptions (continued)

| Field | Description |
|----------|--|
| 4 1HZ | 1 Hz flag bit. This bit indicates whether the second counter has incremented. If enabled, this bit is set on every increment of the RTC second counter. 0 No 1 Hz interrupt occurred 1 A 1 Hz interrupt has occurred |
| 3 DAY | Day flag bit. This bit indicates whether the day counter has incremented. If enabled, this bit is set on every increment of the RTC day counter. 0 No 24-hour rollover interrupt occurred 1 A 24-hour rollover interrupt has occurred |
| 2 ALM | Alarm flag bit. This bit indicates that the RTC time matches the value in the alarm registers. The alarm reoccurs every 65536 days. For a single alarm, clear the interrupt enable for this bit in the interrupt service routine. 0 No alarm interrupt occurred 1 An alarm interrupt has occurred |
| 1 MIN | Minute flag bit. This bit indicates that the minute counter has incremented. If enabled, this bit is set on every increment of the RTC minute counter. 0 No 1-minute interrupt occurred 1 A 1-minute interrupt has occurred |
| 0 SW | Stopwatch flag bit. This bit indicates that the stopwatch countdown has timed out. O The stopwatch did not time out. The stopwatch timed out. |

9.2.7 RTC Interrupt Enable Register (RTCIENR)

The real-time clock interrupt enable register (RTCIENR) is used to enable/disable the various real-time clock interrupts. Masking an interrupt bit has no effect on its corresponding status bit.

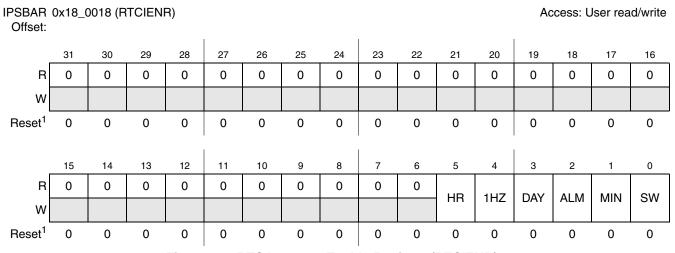


Figure 9-8. RTC Interrupt Enable Register (RTCIENR)

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¹ RTC registers are reset only once, during the first power-on reset (POR), and are never reset again as long as the power source is connected.



Table 9-8. RTCIENR Field Descriptions

| Field | Description |
|----------|--|
| 31-6 | Reserved, should be cleared. |
| 5 HR | Hour interrupt enable bit. This bit enables/disables an interrupt when the hour counter of the real-time clock increments. O The 1-hour interrupt id disabled. 1 The 1-hour interrupt is enabled. |
| 4 1HZ | 1 Hz interrupt enable bit. This bit enables/disables an interrupt when the second counter of the real-time clock increments. 0 The 1 Hz interrupt is disabled. 1 The 1 Hz interrupt is enabled. |
| 3 DAY | Day interrupt enable bit. This bit enables/disables an interrupt when the hours counter rolls over from 23 to 0 (midnight rollover). O The 24-hour interrupt is disabled. 1 The 24-hour interrupt is enabled. |
| 2 ALM | Alarm interrupt enable bit. This bit enables/disables the alarm interrupt. O The alarm interrupt is disabled. 1 The alarm interrupt is enabled. |
| 1 MIN | Minute interrupt enable bit. This bit enables/disables an interrupt when the RTC minute counter increments. O The 1-minute interrupt is disabled. The 1-minute interrupt is enabled. |
| 0 SW | Stopwatch interrupt enable; enables/disables the stopwatch interrupt. The stopwatch counts down and remains at decimal -1 until it is reprogrammed. If this bit is enabled with -1 (decimal) in the STPWCH register, an interrupt is posted on the next minute tick. Bit description 1 = Stopwatch interrupt is enabled. 0 = Stopwatch interrupt is disabled. |

9.2.8 RTC Stopwatch Minutes Register (STPWCH)

The stopwatch minutes (STPWCH) register contains the current stopwatch countdown value. When the minute counter of the TOD clock increments, the value in this register decrements.

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| IPSBAR Offset: (| IPSBAR Offset: 0x18_001C (STPWCH) Access: User read/write | | | | | | | | | | | | | | | |
|---------------------|--|----|----|----|--------|----|----|----|-------|----|----|----|---------|-----|----|----|
| _ | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
| R | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| w | | | | | | | | | | | | | | | | |
| Reset ¹ | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | | | | | ' I | | | | ' | | | | ' I | | | |
| _ | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| R | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | | <u></u> | ıT | | |
| w | | | | | | | | | | | | | Cl | N I | | |
| Reset ¹ | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |

Figure 9-9. RTC Stopwatch Minutes Register (STPWCH)

Table 9-9. STPWCH Field Descriptions

| Field | Description |
|------------|---|
| 31–6 | Reserved, should be cleared. |
| 5–0 CNT | Stopwatch count. This field contains the stopwatch countdown value. |
| | Note: The stopwatch counter is decremented by the minute (MIN) tick output from the real-time clock, so the average tolerance of the count is 0.5 minutes. For better accuracy, enable the stopwatch by polling the MIN bit of the RTCISR register or by polling the minute interrupt service routine. |

9.2.9 RTC Days Counter Register (DAYS)

The real-time clock days counter register (DAYS) is used to program the day for the TOD clock. When the HOUR field of the HOURMIN register rolls over from 23 to 00, the day counter increments. It can be read or written at any time. After a write, the time changes to the new value. This register cannot be reset because the real-time clock is always enabled at reset. Only 16-bit accesses to this register are allowed.

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¹ RTC registers are reset only once, during the first power-on reset (POR), and are never reset again as long as the power source is connected.



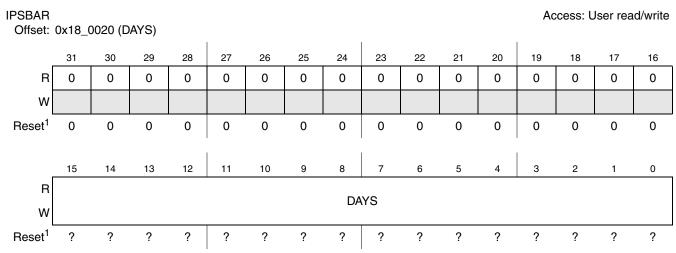


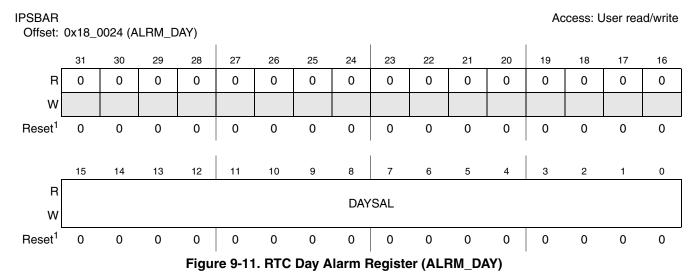
Figure 9-10. RTC Days Counter Register (DAYS)

Table 9-10. DAYS Field Descriptions

| Field | Description |
|--------------|---|
| 31–16 | Reserved, should be cleared. |
| 15–0 DAYS | Day Setting. This field indicates the current day count, and can be set to any value between 0 and 65535. |

9.2.10 RTC Day Alarm Register (ALRM_DAY)

The real-time clock day alarm (ALRM_DAY) register is used to configure the day for the alarm. The alarm settings can be read or written at any time.



RTC registers are reset only once, during the first power-on reset (POR), and are never reset again as long as the power source is connected.

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¹ RTC registers are reset only once, during the first power-on reset (POR), and are never reset again as long as the power source is connected.



Table 9-11. ALRM_DAY Field Descriptions

| Field | Description |
|----------------|---|
| 31–16 | Reserved, should be cleared. |
| 15–0 DAYSAL | Day Setting of the Alarm. This field can be set to any value between 0 and 65535. |

9.2.11 RTC General Oscillator Count Registers (RTCGOCU and RTCGOCL)

The real-time clock general oscillator count registers (RTCGOCU and RTCGOCL) contain the upper and lower 16 bits of a 32-bit field, RTCGOCNT. This field is used to control the 1 Hz clock and the sampling clock as described in Section 9.3, "Functional Description".

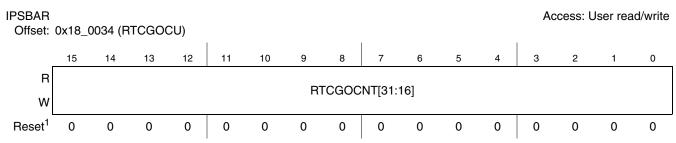


Figure 9-12. RTC General Oscillator Count Upper Register (RTCGOCU)

Table 9-12. RTCGOCU Field Descriptions

| Field | Description |
|-------|--|
| | RTC general oscillator count, bits 31:16. This field is used to control the 1 Hz clock and the sampling clock as described in Section 9.3, "Functional Description". |

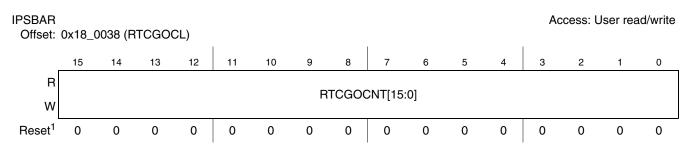


Figure 9-13. RTC General Oscillator Count Lower Register (RTCGOCL)

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¹ RTC registers are reset only once, during the first power-on reset (POR), and are never reset again as long as the power source is connected.

¹ RTC registers are reset only once, during the first power-on reset (POR), and are never reset again as long as the power source is connected.



Table 9-13. RTCGOCL Field Descriptions

| Field | Description |
|-------|---|
| | RTC general oscillator count, bits 15:0. This field is used to control the 1 Hz clock and the sampling clock as described in Section 9.3, "Functional Description". |

9.3 **Functional Description**

The RTC uses a supplied 1 Hz signal to increment the seconds, minutes, hours, and days TOD counters. The alarm functions, when enabled, generate RTC interrupts when the TOD settings reach programmed values. The minute stopwatch allows for efficient interrupts on minute boundaries.

The 1 Hz clock and the sampling clock are affected by the value of RTCGOCNT (see Section 9.2.11, "RTC General Oscillator Count Registers (RTCGOCU and RTCGOCL)") as follows:

- The 1 Hz clock is the input clock divided by RTCGOCNT[31:0].
- The sampling clock is the input clock divided by RTCGOCNT[31:9].
- If RTCGOCNT equals 0x0, the 1 Hz clock is shut down completely.

Table 9-14 presents several examples of this functionality.

Table 9-14. Sample RTC parameter values

| Sampling clock frequency | RTCGOCNT[31:0] value for 1 Hz | Divider output frequency | RTCGOCNT[31:9] value for 512 Hz | Output clock frequency |
|--------------------------|----------------------------------|--------------------------|------------------------------------|------------------------|
| 32.000 kHz | 0x1F40 | | 0x3E | 516.1 Hz |
| 32.768 kHz | 0x2000 | 1 Hz | 0x40 | 512 Hz |
| 38.400 kHz | 0x2580 | 1112 | 0x4B | 512 Hz |
| 48.000 kHz | 0x2EE0 | | 0x5D | 516.1 Hz |

9.3.1 **Prescaler and Counter**

A 1 Hz clock is supplied to the RTC. This 1 Hz clock drives the RTC's counters. The counter portion of the RTC module consists of four groups of counters that are physically located in three registers:

- The 6-bit seconds counter is located in the SECONDS register
- The 6-bit minutes counter and the 5-bit hours counter are located in the HOURMIN register
- The 16-bit day counter is located in the DAYR register

These counters cover a 24-hour clock over 65536 days. All three registers can be read or written at any time

Interrupts signal when each of the four counters increments, and can be used to indicate when a counter rolls over. For example, each tick of the seconds counter causes the 1HZ interrupt flag to be set. When the seconds counter rolls from 59 to 00, the minute counter increments and the MIN interrupt flag is set. The same is true for the minute counter with the HR signal, and the hour counter with the DAY signal.

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9.3.2 Alarm

There are three alarm registers that mirror the three counter registers. An alarm is set by accessing the real-time clock alarm registers (ALRM_HM, ALRM_SEC, and DAYALARM) and loading the exact time that the alarm should generate an interrupt. If RTCIENR[ALM] is set, when the TOD clock value and the alarm value coincide, an interrupt occurs one half second later. If the alarm is not disabled, it reoccurs every 65536 days. If a single alarm is desired, the alarm function must be disabled through RTCIENR.

9.3.3 Minute Stopwatch

The minute stopwatch performs a countdown with a one minute resolution. It can be used to generate an interrupt on a minute boundary. At each minute, the value in the stopwatch is decremented. When the stopwatch value reaches -1, the interrupt occurs. The value of the register does not change until it is reprogrammed. The actual delay includes the seconds from setting the stopwatch to the next minute tick.

9.4 Initialization/Application Information

9.4.1 RTC Register Access Protocol

- 1. Perform dummy read access to a non-RTC address location.
- 2. Perform dummy read to the targeted RTC address location.
- 3. Perform actual read or write access to the targeted RTC address location.

Steps 1 and 2 can be combined into one cycle that is a dummy read access to a non-RTC but targeted RTC address location. Then the protocol is:

- 1. Perform dummy read access to a non-RTC, targeted RTC address location.
- 2. Perform actual read or write access to targeted RTC address location.

9.4.2 Flow Chart of RTC Operation

Figure 9-14 shows the flow chart of a typical RTC operation.

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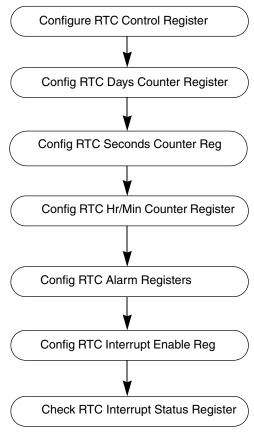


Figure 9-14. Flow Chart of RTC Operation

9.4.3 Code Example for Initializing the Real-Time Clock

Figure 9-15 shows sample code for initializing the RTC.

```
MCF_CLOCK_RTCCR=0b01010110; //RTCCC
MCF_RTCGOCL = 0x00002000; //32KHz
MCF_CLOCK_RTCCR=0b01010111; //RTCCC

MCF_RTC_HOURMIN = MCF_RTC_HOURMIN_HOURS(((uint32)time_temp % 24));
MCF_RTC_HOURMIN = MCF_RTC_HOURMIN_MINUTES(((uint32)time_temp % 60));
MCF_RTC_SECONDS = MCF_RTC_SECONDS SECONDS(((uint32)time_temp % 60));
```

Figure 9-15. Code Example for Initializing the Real-Time Clock

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Chapter 10 Power Management

10.1 Introduction

This chapter explains the low-power operation of the processor.

10.1.1 Features

The following features support low-power operation.

- Four modes of operation: run, wait, doze, and stop
- Ability to shut down most peripherals independently
- Ability to shut down the external CLKOUT pin

10.2 Memory Map/Register Definition

The power management programming model consists of registers from the SCM and CCM memory space, as shown in Table 10-1.

| IPSBAR Offset ¹ | Register | | Access | Reset Value | Section/Page |
|-------------------------------|---|---------------------------------|-------------------|-------------|---------------|
| 0x11_0004 | Chip Configuration Register (CCR) ² | 16 | R | See section | 13.3.1/13-3 |
| 0x11_0007 | Low-Power Control Register (LPCR) | 8 | R/W | 0x00 | 10.2.4.1/10-6 |
| 0x00_000C | Peripheral Power Management Register High (PPMRH) | 32 | R/W | 0x0000_0000 | 10.2.1/10-2 |
| 0x00_0010 | Core Reset Status Register (CRSR) ³ | 8 | R/W | See section | 14.5.3/14-5 |
| 0x00_0011 | Core Watchdog Control Register (CWCR) ³ | 8 | R/W | 0x00 | 14.5.4/14-6 |
| 0x00_0012 | Low-Power Interrupt Control Register (LPICR) | 8 | R/W 0x00 10.2.2/1 | | 10.2.2/10-4 |
| 0x00_0013 | Core Watchdog Service Register (CWSR) ³ | 8 R/W Uninitialized 14.5.5/14-8 | | 14.5.5/14-8 | |
| 0x00_0018 | 00_0018 Peripheral Power Management Register Low (PPMRL) 32 R/W 0x0040_0004 | | 10.2.1/10-2 | | |
| 0x00_0021 | Peripheral Power Management Set Register (PPMRS) | 8 | W | 0x00 | 10.2.3/10-5 |
| 0x00_0022 | D22 Peripheral Power Management Clear Register (PPMRC) 8 W | | 0x00 | 10.2.4/10-6 | |
| 0x00_0023 | IPS Bus Timeout Monitor (IPSBMT) | 8 | R/W | 0x08 | 10.3/10-7 |

Table 10-1. Power Management Memory Map

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Addresses not assigned to a register and undefined register bits are reserved for expansion.

The CCR is described in the Chip Configuration Module. It is shown here only to warn against accidental writes to this register when accessing the LPCR.

The CRSR, CWCR, and CWSR are described in the System Control Module. They are shown here only to warn against accidental writes to these registers when accessing the LPICR.



10.2.1 Peripheral Power Management Registers (PPMRH, PPMRL)

The PPMRH and PPMRL registers provide a bit map for controlling the generation of the module clocks for each decoded address space associated with the IPS controller. The PPMRx provides a unique control bit for each of these address spaces that defines whether the module clock for the given space is enabled or disabled.

NOTE

It is the software's responsibility to appropriately disable module clocks using the PPMRx only when a module is completely unused or quiescent.

Because the operation of the IPS controller and the system control module (SCM) are fundamental to the operation of the system, the clocks for these three modules cannot be disabled.

The individual bits of the PPMRx can be modified using a read-modify-write to this register directly or indirectly through writes to the PPMRS and PPMRC registers to set/clear individual bits.

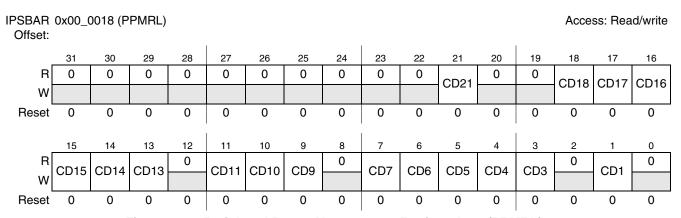


Figure 10-1. Peripheral Power Management Register Low (PPMRL)

CDn**Peripheral** CD1¹ Global space CD3 Mini-FlexBus CD4 DMA CD5 **UARTO** CD6 UART1 CD7 UART2 I²C0 CD9 **CD10 QSPI** I²C1 **CD11 CD13** DMA Timer 0 **CD14** DMA Timer 1

Table 10-2. PPMRL[CDn] Assignments

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Table 10-2. PPMRL[CDn] Assignments (continued)

| CDn | Peripheral |
|------|--------------------------------|
| CD15 | DMA Timer 2 |
| CD16 | DMA Timer 3 |
| CD17 | Interrupt controller 0 (INTC0) |
| CD18 | Interrupt controller 1 (INTC1) |
| CD21 | FEC |

¹ This bit disables just the registers of the modules, not the clocks of those modules. This bit does not disable the registers of the RTC or USB modules.

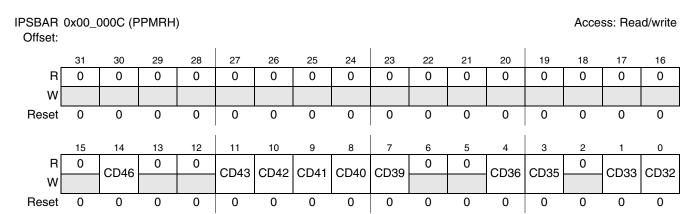


Figure 10-2. Peripheral Power Management Register High (PPMRH)

Table 10-3. PPMRH[CDn] Assignments

| CDn | Peripheral |
|------|--|
| CD32 | GPIO module |
| CD33 | Edge port |
| CD35 | PIT 0 |
| CD36 | PIT1 |
| CD39 | ADC |
| CD40 | General purpose timers |
| CD41 | PWM |
| CD42 | FlexCAN |
| CD43 | Common flash module (CFM) register interface |
| CD46 | RTC |

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Table 10-4. PPMRH & PPMRL Field Descriptions

| Field | Description | |
|-------|--|--|
| CDn | Module slot <i>n</i> clock disable. 0 The clock for this module is enabled. 1 The clock for this module is disabled. | |

Low-Power Interrupt Control Register (LPICR) 10.2.2

Implementation of low-power stop mode and exit from a low-power mode via an interrupt require communication between the CPU and logic associated with the interrupt controller. The LPICR is an 8-bit register that enables entry into low-power stop mode and includes the setting of the interrupt level needed to exit a low-power mode.

NOTE

The setting of the low-power mode select (LPMD) field in the power management module's low-power control register (LPCR) determines which low-power mode the device enters when a STOP instruction is issued.

If this field is set to enter stop mode, the ENBSTOP bit in the LPICR must also be set.

The following is the sequence needed to enable this functionality:

- 1. The LPICR is programmed, setting the ENBSTOP bit (if stop mode is the desired low-power mode) and loading the appropriate interrupt priority level.
- 2. At the appropriate time, the processor executes the privileged STOP instruction. After the processor has stopped execution, it asserts a specific Processor Status (PST) encoding. Issuing the STOP instruction when the LPICR[ENBSTOP] bit is set causes the SCM to enter stop mode.
- 3. The entry into a low-power mode is processed by the low-power mode control logic, and the appropriate clocks (usually those related to the high-speed processor core) are disabled.
- 4. After entering the low-power mode, the interrupt controller enables a combinational logic path that evaluates any unmasked interrupt requests. The device waits for an event to generate an interrupt request with a priority level greater than the value programmed in LPICR[XLPM IPL[2:0]].

NOTE

Only a fixed (external) interrupt can bring a device out of stop mode. To exit from other low-power modes, such as doze or wait, fixed or programmable interrupts may be used; however, the module generating the interrupt must be enabled in that particular low-power mode.

- 5. After an appropriately high interrupt request level arrives, the interrupt controller signals its presence and the SCM responds by asserting the request to exit low-power mode.
- 6. The low-power mode control logic senses the request signal and re-enables the appropriate clocks.
- 7. With the processor clocks enabled, the core processes the pending interrupt request.

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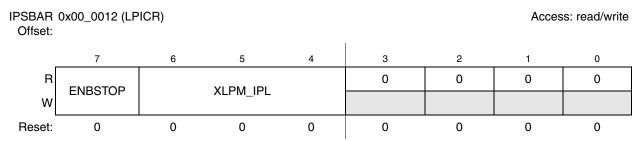


Figure 10-3. Low-Power Interrupt Control Register (LPICR)

Table 10-5. LPICR Field Description

| Field | Description | | |
|-----------------|---|--|--|
| 7 ENBSTOP | Enable low-power stop mode. 0 Low-power stop mode disabled 1 Low-power stop mode enabled. After the core is stopped and the signal to enter stop mode is asserted, processor clocks can be disabled. | | |
| 6–4 XLPM_IPL | Exit low-power mode interrupt priority level. This field defines the interrupt priority level needed to exit the low-power mode. OOO Any interrupt request exits low-power mode OO1 Interrupt request levels 2–7 exit low-power mode OOO Interrupt request levels 3–7 exit low-power mode OOO Interrupt request levels 4–7 exit low-power mode Interrupt request levels 5–7 exit low-power mode Interrupt request levels 6–7 exit low-power mode Interrupt request levels 7 exits low-power mode | | |
| 3–0 | Reserved, must be cleared. | | |

10.2.3 Peripheral Power Management Set Register (PPMRS)

The PPMRS register provides a simple memory-mapped mechanism to set a given bit in the PPMRx registers to disable the clock for a given IPS module without the need to perform a read-modify-write on the PPMR. The data value on a register write causes the corresponding bit in the PPMRx register to be set. A data value of 64 to 127 provides a global set function, forcing the entire contents of the PPMRx to be set, disabling all IPS module clocks. Reads of this register return all zeroes. See Figure 10-4 and Table 10-6 for the PPMRS definition.

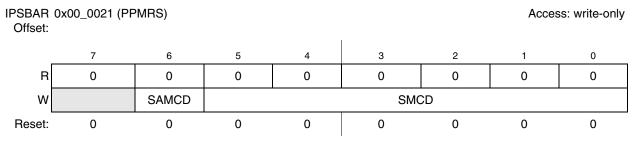


Figure 10-4. Peripheral Power Management Set Register (PPMRS)

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| Table 10-6 | . PPMRS | Field | Descri | ptions |
|-------------------|---------|--------------|--------|--------|
|-------------------|---------|--------------|--------|--------|

| Field | Description |
|---|---|
| 7 | Reserved, must be cleared. |
| 6 SAMCD | Set all module clock disables. O Set only those bits specified in the SMCD field 1 Set all bits in PPMRH and PPMRL, disabling all peripheral clocks |
| 5–0 Set module clock disable. Set the corresponding bit in PPM{H,L}R, disabling the peripheral clock. | |

10.2.4 Peripheral Power Management Clear Register (PPMRC)

The PPMRC register provides a simple memory-mapped mechanism to clear a given bit in the PPMRx registers to enable the clock for a given IPS module without the need to perform a read-modify-write on the PPMRx. The data value on a register write causes the corresponding bit in the PPMRx register to be cleared. A data value of 64 to 127 provides a global clear function, forcing the entire contents of the PPMRx to be zeroed, enabling all IPS module clocks. In the event on simultaneous writes of the PPMRS and PPMRC, the write to the PPMRC takes priority. Reads of this register return all zeroes. See Figure 10-5 and Table 10-7 for the PPMRC definition.

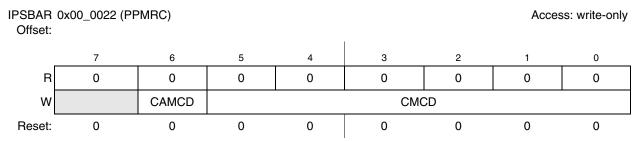


Figure 10-5. Peripheral Power Management Clear Register (PPMRC)

Table 10-7. PPMRC Field Descriptions

| Field | Description | | |
|--|--|--|--|
| 7 | Reserved, must be cleared. | | |
| 6 CAMCD | Clear all module clock disables. O Clear only those bits specified in the CMCD field Clear all bits in PPMRH and PPMRL, enabling all peripheral clocks | | |
| 5–0 Clear module clock disable. Clear the corresponding bit in PPMR{H,L}, enabling the periphorm | | | |

10.2.4.1 **Low-Power Control Register (LPCR)**

The LPCR controls chip operation and module operation during low-power modes. The low-power control register (LPCR) specifies the low-power mode entered when the STOP instruction is issued and controls clock activity in this low-power mode.

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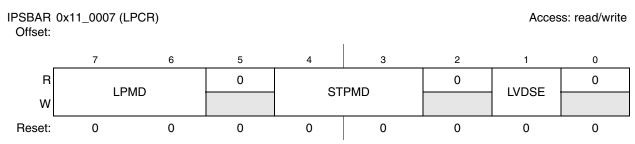


Figure 10-6. Low-Power Control Register (LPCR)

Table 10-8. LPCR Field Descriptions

| Field | Description |
|--------------|--|
| 7–6 LPMD | Low-power mode select. Used to select the low-power mode the chip enters after the ColdFire CPU executes the STOP instruction. These bits must be written prior to instruction execution for them to take effect. The LPMD[1:0] bits are readable and writable in all modes. 00 Run 01 Doze 10 Wait 11 Stop Note: If LPCR[LPMD] is cleared, then the device stops executing code upon issue of a STOP instruction. However, no clocks is disabled. |
| 5 | Reserved, must be cleared. |
| 4–3 STPMD | PLL/CLKOUT stop mode. Controls PLL and CLKOUT operation in stop mode as shown in Table 10-10 |
| 2 | Reserved, must be cleared. |
| 1 LVDSE | LDV standby enable. Controls whether the PMM enters VREG Standby Mode (LVD disabled) or VREG Pseudo-Standby (LVD enabled) mode when the PMM receives a power down request. This bit has no effect if the RCR[LVDE] bit is a logic 0. 1 VREG Pseudo-Standby mode (LVD enabled on power down request). 0 VREG Standby mode (LVD disabled on power down request). |
| 0 | Reserved, must be cleared. |

10.3 IPS Bus Timeout Monitor

The IPS controller implements a bus timeout monitor to ensure that every IPS bus cycle is properly terminated within a programmed period of time. The monitor continually checks for termination of each IPS bus cycle and completes the cycle if there is no response when the programmed monitor cycle count is reached. The error termination is propagated onto the system bus and eventually back to the ColdFire Core.

The monitor can be programmed from 8–1024 system bus cycles under control of the IPS Bus Monitor Timeout Register (IPSBMT). The timeout value must be selected so that it is larger than the response time of the slowest IPS peripheral device. The bus timeout monitor begins counting on the initial assertion of any IPS module enable and continues to count until the bus cycle is terminated via the negation of IPS_XFR_WAIT. If the programmed timeout value is reached before a termination, the bus monitor completes the cycle with an error termination. At reset, the IPSBMT is enabled with a maximum timeout value. See Figure 10-7 and Table 10-9 for the IPSBMT definition.

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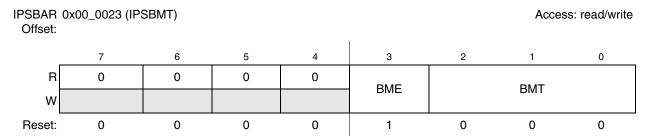


Figure 10-7. IPS Bus Timeout Monitor (IPSBMT) Register

Table 10-9. IPSBMT Field Description

| Field | Description |
|-----------------|--|
| 7–4 | Reserved, must be cleared. |
| 3 BME | Bus timeout monitor enable 0 The bus timeout monitor is disabled 1 The bus timeout monitor is enabled |
| 2-0 BMT[2:0] | Bus monitor timeout. This field selects the timeout period (measured in system bus clock cycles) for the bus monitor. 000 1024 cycles 001 512 cycles 010 256 cycles 011 128 cycles 100 64 cycles 101 32 cycles 101 8 cycles |

10.4 Functional Description

Table 10-10. PLL/CLKOUT Stop Mode Operation

| CTDMD[1.0] | Operation During Stop Mode | | | | | |
|------------|----------------------------|----------|----------|----------|------------------|--|
| STPMD[1:0] | System Clocks | CLKOUT | PLL | osc | РММ | |
| 00 | Disabled | Enabled | Enabled | Enabled | Enabled | |
| 01 | Disabled | Disabled | Enabled | Enabled | Enabled | |
| 10 | Disabled | Disabled | Disabled | Enabled | Enabled | |
| 11 | Disabled | Disabled | Disabled | Disabled | Low-Power Option | |

The functions and characteristics of the low-power modes, and how each module is affected by or affects these modes, are discussed in this section.

10.4.1 Low-Power Modes

The system enters a low-power mode by executing a STOP instruction. Which mode the device actually enters (stop, wait, or doze) depends on what is programmed in LPCR[LPMD]. Entry into any of these

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modes idles the CPU with no cycles active, powers down the system, and stops all internal clocks appropriately. During stop mode, the system clock is stopped low.

For entry into stop mode, the LPICR[ENBSTOP] bit must be set before a STOP instruction is issued.

A wakeup event is required to exit a low-power mode and return to run mode. Wakeup events consist of any of these conditions:

- Any type of reset
- Any valid, enabled interrupt request

Exiting from low-power mode via an interrupt request requires:

- An interrupt request whose priority is higher than the value programmed in the XLPM_IPL field
 of the LPICR.
- An interrupt request whose priority higher than the value programmed in the interrupt priority mask (I) field of the core's status register.
- An interrupt request from a source which is not masked in the interrupt controller's interrupt mask register.
- An interrupt request which has been enabled at the module of the interrupt's origin.

10.4.1.1 Run Mode

Run mode is the normal system operating mode. Current consumption in this mode is related directly to the system clock frequency.

10.4.1.2 Wait Mode

Wait mode is intended to be used to stop only the CPU and memory clocks until a wakeup event is detected. In this mode, peripherals may be programmed to continue operating and can generate interrupts, which cause the CPU to exit from wait mode.

10.4.1.3 Doze Mode

Doze mode affects the CPU in the same manner as wait mode, except that each peripheral defines individual operational characteristics in doze mode. Peripherals that continue to run and have the capability of producing interrupts may cause the CPU to exit the doze mode and return to run mode. Stopped peripherals restart operation on exit from doze mode as defined for each peripheral.

10.4.1.4 Stop Mode

Stop mode affects the CPU in the same manner as the wait and doze modes, except that all clocks to the system are stopped and the peripherals cease operation.

Stop mode must be entered in a controlled manner to ensure that any current operation is properly terminated. When exiting stop mode, most peripherals retain their pre-stop status and resume operation.

The following subsections specify the operation of each module while in and when exiting low-power modes.

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10.4.1.5 Peripheral Shut Down

Most peripherals may be disabled by software to cease internal clock generation and remain in a static state. Each peripheral has its own specific disabling sequence (refer to each peripheral description for further details). A peripheral may be disabled at any time and remain disabled during any low-power mode of operation.

10.4.2 Peripheral Behavior in Low-Power Modes

10.4.2.1 ColdFire Core

The ColdFire core is disabled during any low-power mode. No recovery time is required when exiting any low-power mode.

10.4.2.2 Static Random-Access Memory (SRAM)

SRAM is disabled during any low-power mode. No recovery time is required when exiting any low-power mode.

10.4.2.3 Flash

The flash module is in a low-power state if not being accessed. No recovery time is required after exit from any low-power mode.

10.4.2.4 System Control Module (SCM)

The SCM's core watchdog timer can bring the device out of all low-power modes except stop mode. In stop mode, all clocks stop, and the core watchdog does not operate.

When enabled, the core watchdog can bring the device out of wait and doze modes via a core watchdog interrupt. This system setup must meet the conditions specified in Section 10.4.1, "Low-Power Modes" for the core watchdog interrupt to bring the part out of wait and doze modes.

10.4.2.5 DMA Controller (DMA0-DMA3)

In wait and doze modes, the DMA controller is capable of bringing the device out of a low-power mode by generating an interrupt upon completion of a transfer or upon an error condition. The completion of transfer interrupt is generated when DMA interrupts are enabled by the setting of the DCR[INT] bit, and an interrupt is generated when the DSR[DONE] bit is set. The interrupt upon error condition is generated when the DCR[INT] bit is set, and an interrupt is generated when the CE, BES, or BED bit in the DSR becomes set.

The DMA controller is stopped in stop mode and thus cannot cause an exit from this low-power mode.

10.4.2.6 UART Modules (UART0, UART1, and UART2)

In wait and doze modes, the UART may generate an interrupt to exit the low-power modes.

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- Clearing the transmit enable bit (TE) or the receiver enable bit (RE) disables UART functions.
- The UARTs are unaffected by wait mode and may generate an interrupt to exit this mode.

In stop mode, the UARTs stop immediately and freeze their operation, register values, state machines, and external pins. During this mode, the UART clocks are shut down. Coming out of stop mode returns the UARTs to operation from the state prior to the low-power mode entry.

10.4.2.7 I²C Module

When the I²C Module is enabled by the setting of the I2CR[IEN] bit and when the device is not in stop mode, the I²C module is operable and may generate an interrupt to bring the device out of a low-power mode. For an interrupt to occur, the I2CR[IIE] bit must be set to enable interrupts, and the setting of the I2SR[IIF] generates the interrupt signal to the CPU and interrupt controller. The setting of I2SR[IIF] signifies the completion of one byte transfer or the reception of a calling address matching its own specified address when in slave receive mode.

In stop mode, the I²C Module stops immediately and freezes operation, register values, and external pins. Upon exiting stop mode, the I²C resumes operation unless stop mode was exited by reset.

10.4.2.8 Queued Serial Peripheral Interface (QSPI)

In wait and doze modes, the queued serial peripheral interface (QSPI) may generate an interrupt to exit the low-power modes.

- Clearing the QSPI enable bit (SPE) disables the QSPI function.
- The QSPI is unaffected by wait mode and may generate an interrupt to exit this mode.

In stop mode, the QSPI stops immediately and freezes operation, register values, state machines, and external pins. During this mode, the QSPI clocks are shut down. Coming out of stop mode returns the QSPI to operation from the state prior to the low-power mode entry.

10.4.2.9 DMA Timers (DTIM0-DTIM3)

In wait and doze modes, the DMA timers may generate an interrupt to exit a low-power mode. This interrupt can be generated when the DMA Timer is in input capture mode or reference compare mode.

In input capture mode, where the capture enable (CE) field of the timer mode register (DTMR) has a non-zero value and the DMA enable (DMAEN) bit of the DMA timer extended mode register (DTXMR) is cleared, an interrupt is issued upon a captured input. In reference compare mode, where the output reference request interrupt enable (ORRI) bit of DTMR is set and the DTXMR[DMAEN] bit is cleared, an interrupt is issued when the timer counter reaches the reference value.

DMA timer operation is disabled in stop mode, but the DMA timer is unaffected by the wait or doze modes and may generate an interrupt to exit these modes. Upon exiting stop mode, the timer resumes operation unless stop mode was exited by reset.

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10.4.2.10 Interrupt Controllers (INTC0, INTC1)

The interrupt controller is not affected by any of the low-power modes. All logic between the input sources and generating the interrupt to the processor is combinational to allow the ability to wake up the CPU processor during low-power stop mode when all system clocks are stopped.

An interrupt request causes the CPU to exit a low-power mode only if that interrupt's priority level is at or above the level programmed in the interrupt priority mask field of the CPU's status register (SR). The interrupt must also be enabled in the interrupt controller's interrupt mask register as well as at the module from which the interrupt request would originate.

10.4.2.11 Fast Ethernet Controller (FEC)

In wait and doze modes, the FEC may generate an interrupt to exit the low-power modes.

- Clearing the ECNTRL[ETHER EN] bit disables the FEC function.
- The FEC is unaffected by wait mode and may generate an interrupt to exit this mode.

In stop mode, the FEC stops immediately and freezes operation, register values, state machines, and external pins. During this mode, the FEC clocks are shut down. Coming out of stop mode returns the FEC to operation from the state prior to the low-power mode entry.

10.4.2.12 I/O Ports

The I/O ports are unaffected by entry into a low-power mode. These pins may impact low-power current draw if they are configured as outputs and are sourcing current to an external load. If low-power mode is exited by a reset, the state of the I/O pins reverts to their default direction settings.

10.4.2.13 Reset Controller

A power-on reset (POR) always causes a chip reset and exit from any low-power mode.

In wait and doze modes, asserting the external \overline{RESET} pin for at least four clocks causes an external reset that resets the chip and exit any low-power modes.

In stop mode, the RESET pin synchronization is disabled and asserting the external RESET pin asynchronously generates an internal reset and exit any low-power modes. Registers lose current values and must be reconfigured from reset state if needed.

If the phase lock loop (PLL) in the clock module is active and if the appropriate (LOCRE, LOLRE) bits in the synthesizer control register are set, any loss-of-clock or loss-of-lock resets the chip and exit any low-power modes.

This device contains two watchdog timers:

- If the backup watchdog timer (BWT) is enabled during wait, doze, or stop modes, then a watchdog timer timeout generates a reset to exit these low-power modes.
- The watchdog timer in the SCM is only able to request an interrupt, so a reset request must be performed in software.

When the CPU is inactive, a software reset cannot be generated to exit any low-power mode.

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10.4.2.14 Chip Configuration Module

The Chip Configuration Module is unaffected by entry into a low-power mode. If low-power mode is exited by a reset, chip configuration may be executed if configured to do so.

10.4.2.15 Clock Module

In wait and doze modes, the clocks to the CPU, flash, and SRAM are stopped and the system clocks to the peripherals are enabled. Each module may disable the module clocks locally at the module level. In stop mode, all clocks to the system are stopped.

During stop mode, the PLL continues to run. The external CLKOUT signal may be enabled or disabled when the device enters stop mode, depending on the LPCR[STPMD] bit settings. The external CLKOUT output pin may be disabled to lower power consumption via the SYNCR[DISCLK] bit. The external CLKOUT pin function is enabled by default at reset.

10.4.2.16 Edge Port

In wait and doze modes, the edge port continues to operate normally and may be configured to generate interrupts (an edge transition or low level on an external pin) to exit the low-power modes.

In stop mode, there is no system clock available to perform the edge detect function. Thus, only the level detect logic is active (if configured) to allow any low level on the external interrupt pin to generate an interrupt (if enabled) to exit the stop mode.

10.4.2.17 Programmable Interrupt Timers (PIT0–PIT1)

In stop mode (or in doze mode, if so programmed), the programmable interrupt timer (PIT) ceases operation, and freezes at the current value. When exiting these modes, the PIT resumes operation from the stopped value. It is the responsibility of software to avoid erroneous operation.

When not stopped, the PIT may generate an interrupt to exit the low-power modes.

10.4.2.18 FlexCAN

When enabled, the FlexCAN module is capable of generating interrupts and bringing the device out of a low-power mode. The module has 35 interrupt sources (32 sources due to message buffers and 3 sources due to Bus-off, Error and Wake-up).

When in stop mode, a recessive to dominant transition on the CAN bus causes the WAKE-INT bit in the error & status register to be set. This event can cause a CPU interrupt if the WAKE-MASK bit in module configuration register (MCR) is set.

When setting stop mode in the FlexCAN (by setting the MCR[STOP] bit), the FlexCAN checks for the CAN bus to be idle or waits for the third bit of intermission and checks to see if it is recessive. When this condition exists, the FlexCAN waits for all internal activity other than in the CAN bus interface to complete and then the following occurs:

• The FlexCAN shuts down its clocks, stopping most of the internal circuits, to achieve maximum possible power saving.

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- The internal bus interface logic continues operation, enabling CPU to access the MCR register.
- The FlexCAN ignores its Rx input pin, and drives its Tx pins as recessive.
- FlexCAN loses synchronization with the CAN bus, and STOP ACK and NOT RDY bits in MCR register are set.

Exiting stop mode is done in one of the following ways:

- Reset the FlexCAN (by hard reset or by asserting the SOFT RST bit in MCR).
- Clearing the STOP bit in the MCR.
- SELF-WAKE mechanism. If the SELF-WAKE bit in the MCR is set at the time the FlexCAN enters stop mode, then upon detection of recessive to dominant transition on the CAN bus, the FlexCAN resets the STOP bit in the MCR and resumes its clocks.

Recommendations for, and features of, FlexCAN's stop mode operation are as follows:

- Upon stop/self-wake mode entry, the FlexCAN tries to receive the frame that caused it to wake; that is, it assumes that the dominant bit detected is a start-of-frame bit. It does not arbitrate for the CAN bus then.
- Before asserting stop Mode, the CPU should disable all interrupts in the FlexCAN, otherwise it may be interrupted while in stop mode upon a non-wake-up condition. If desired, the WAKE-MASK bit should be set to enable the WAKE-INT.
- If stop mode is asserted while the FlexCAN is BUSOFF (see error and status register), then the FlexCAN enters stop mode and stops counting the synchronization sequence; it continues this count after stop mode is exited.
- The correct flow to enter stop mode with SELF-WAKE:
 - assert SELF-WAKE at the same time as STOP.
 - wait for STOP ACK bit to be set.
- The correct flow to negate STOP with SELF-WAKE:
 - negate SELF-WAKE at the same time as STOP.
 - wait for STOP ACK negation.
- SELF-WAKE should be set only when the MCR[STOP] bit is negated and the FlexCAN is ready; that is, the NOT RDY bit in the MCR is negated.
- If STOP and SELF WAKE are set and if a recessive to dominant edge immediately follows on the CAN bus, the STOP ACK bit in the MCR may never be set, and the STOP bit in the MCR is reset.
- If the user does not want to have old frames sent when the FlexCAN is awakened (STOP with Self-Wake), the user should disable all Tx sources, including remote-response, before stop mode entry.
- If halt mode is active at the time the STOP bit is set, the FlexCAN assumes that halt mode should be exited. Therefore, it tries to synchronize to the CAN bus (11 consecutive recessive bits), and only then does it search for the correct conditions to stop.
- Trying to stop the FlexCAN immediately after reset is allowed only after basic initialization has been performed.

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If stop with self-wake is activated, and the FlexCAN operates with single system clock per time-quanta, then there are extreme cases in which FlexCAN's wake-up upon recessive to dominant edge may not conform to the standard CAN protocol, in the sense that the FlexCAN synchronization is shifted one time quanta from the required timing. This shift lasts until the next recessive to dominant edge, which re-synchronizes the FlexCAN back to conform to the protocol. The same holds for auto-power save mode upon wake-up by recessive to dominant edge.

The auto-power save mode in the FlexCAN is intended to enable NORMAL operation with optimized power saving. Upon setting the AUTO POWER SAVE bit in the MCR register, the FlexCAN looks for a set of conditions in which there is no need for clocks to run. If all these conditions are met, then the FlexCAN stops its clocks, thus saving power. While its clocks are stopped, if any of the conditions below is not met, the FlexCAN resumes its clocks. It then continues to monitor the conditions and stops/resumes its clocks appropriately.

The following are conditions for the automatic shut-off of FlexCAN clocks:

- No Rx/Tx frame in progress.
- No moving of Rx/Tx frames between SMB and MB and no Tx frame is pending for transmission in any MB.
- No host access to the FlexCAN module.
- The FlexCAN is neither in halt mode (MCR bit 8), in stop mode (MCT bit 15), nor in BUSOFF.

10.4.2.19 PWM Module

The PWM module is user programmable as to how it behaves when the device enters wait mode (PWMCTL[PSWAI]) and doze mode (PWMCTL[PFRZ]). If either of these bits are set, the PWM input clock to the prescalar is disabled during the respective low power mode.

In stop mode the input clock is disabled and PWM generation is halted.

10.4.2.20 BDM

Entering halt mode via the BDM port (by asserting the external \overline{BKPT} pin) causes the CPU to exit any low-power mode.

10.4.2.21 JTAG

The JTAG (Joint Test Action Group) controller logic is clocked using the TCLK input and is not affected by the system clock. The JTAG cannot generate an event to cause the CPU to exit any low-power mode. Toggling TCLK during any low-power mode increases the system current consumption.

10.4.3 Summary of Peripheral State During Low-Power Modes

The functionality of each of the peripherals and CPU during the various low-power modes is summarized in Table 10-11. The status of each peripheral during a given mode refers to the condition the peripheral automatically assumes when the STOP instruction is executed and the LPCR[LPMD] field is set for the particular low-power mode. Individual peripherals may be disabled by programming its dedicated control

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bits. The wakeup capability field refers to the ability of an interrupt or reset by that peripheral to force the CPU into run mode.

Table 10-11. CPU and Peripherals in Low-Power Modes

| | Peripheral Status ¹ / Wakeup Capability | | | | | |
|-------------------------------------|--|------------------|-----------|------------------|-----------|------------------|
| Module | Wait Mode | | Doze Mode | | Stop Mode | |
| CPU | Stopped | No | Stopped | No | Stopped | No |
| SRAM | Stopped | No | Stopped | No | Stopped | No |
| Flash | Stopped | No | Stopped | No | Stopped | No |
| System Control Module | Enabled | Reset | Enabled | Reset | Stopped | No |
| Random Number Generator Accelerator | Enabled | No | Stopped | No | Stopped | No |
| DMA Controller | Enabled | Yes | Enabled | Yes | Stopped | No |
| UART0, UART1 and UART2 | Enabled | Interrupt | Enabled | Interrupt | Stopped | No |
| I ² C Module | Enabled | Interrupt | Enabled | Interrupt | Stopped | No |
| QSPI | Enabled | Interrupt | Enabled | Interrupt | Stopped | No |
| DMA Timers | Enabled | Interrupt | Enabled | Interrupt | Stopped | No |
| Interrupt Controller | Enabled | Interrupt | Enabled | Interrupt | Enabled | Interrupt |
| I/O Ports | Enabled | No | Enabled | No | Enabled | No |
| Reset Controller | Enabled | Reset | Enabled | Reset | Enabled | Reset |
| Chip Configuration Module | Enabled | No | Enabled | No | Stopped | No |
| Power Management | Enabled | No | Enabled | No | Stopped | No |
| Clock Module | Enabled | Interrupt | Enabled | Interrupt | Enabled | Interrupt |
| Real-Time Clock Module | Enabled | Interrupt | Enabled | Interrupt | Enabled | Interrupt |
| Edge port | Enabled | Interrupt | Enabled | Interrupt | Stopped | Interrupt |
| Programmable Interrupt Timers | Enabled | Interrupt | Program | Interrupt | Stopped | No |
| ADC | Enabled | Interrupt | Program | Interrupt | Stopped | No |
| General Purpose Timer | Enabled | Interrupt | Enabled | Interrupt | Stopped | No |
| FlexCAN | Enabled | Interrupt | Enabled | Interrupt | Stopped | No |
| PWM | Program | No | Program | No | Stopped | No |
| BDM | Enabled | Yes ² | Enabled | Yes ² | Enabled | Yes ² |
| JTAG | Enabled | No | Enabled | No | Enabled | No |

¹ Program Indicates that the peripheral function during the low-power mode is dependent on programmable bits in the peripheral register map.

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² The BDM logic is clocked by a separate TCLK clock. Entering halt mode via the BDM port exits any low-power mode. Upon exit from halt mode, the previous low-power mode is re-entered and changes made in halt mode remains in effect.



Chapter 11 Reset Controller Module

11.1 Introduction

The reset controller is provided to determine the cause of reset, assert the appropriate reset signals to the system, and keep a history of what caused the reset. The low-voltage detection module, which generates low-voltage detect (LVD) interrupts and resets, is implemented within the reset controller module.

11.2 Features

Module features include the following:

- Eight sources of reset:
 - External reset input
 - Power-on reset (POR)
 - Phase locked-loop (PLL) loss of lock
 - PLL loss of clock
 - Software
 - Low-voltage detector (LVD)
 - JTAG CLAMP, HIGHZ and EXTEST instructions
 - Watchdog event
- Software-assertable RSTO pin independent of chip reset state
- Software-readable status flags indicating the cause of the last reset
- LVD control and status bits for setup and use of LVD reset or interrupt

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11.3 Block Diagram

Figure 11-1 illustrates the reset controller and is explained in the following sections.

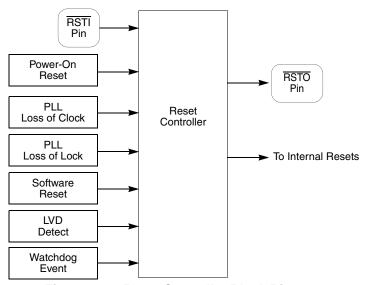


Figure 11-1. Reset Controller Block Diagram

11.4 Signals

Table 11-1 provides a summary of the reset controller signal properties. The signals are described in the following sections.

| Name | Direction | Input Hysteresis | Input Synchronization |
|------|-----------|---------------------|--------------------------|
| RSTI | I | Yes | Yes ¹ |
| RSTO | 0 | _ | _ |

Table 11-1. Reset Controller Signal Properties

11.4.1 **RSTI**

Asserting the external \overline{RSTI} for at least four rising CLKOUT edges causes the external reset request to be recognized and latched.

11.4.2 RSTO

This active-low output signal is driven low when the internal reset controller module resets the chip. When RSTO is active, you can drive override options on the data bus.

11.5 Memory Map and Registers

The reset controller programming model consists of these registers:

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¹ RSTI is always synchronized except when in low-power stop mode.



Reset Controller Module

- Reset control register (RCR)—selects reset controller functions
- Reset status register (RSR)—reflects the state of the last reset source

See Table 11-2 for the memory map and the following paragraphs for a description of the registers.

Table 11-2. Reset Controller Memory Map

| IPSBAR Offset ¹ | Register | Width (bits) | Access | Reset Value | Section/Page |
|-------------------------------|------------------------------|-----------------|--------|--------------------|--------------|
| 0x11_0000 | Reset Control Register (RCR) | 8 | R/W | 0x05 | 11.5.1/11-3 |
| 0x11_0001 | Reset Status Register (RSR) | 8 | R | Reset Dependent | 11.5.2/11-4 |

¹ Addresses not assigned to a register and undefined register bits are reserved for expansion.

11.5.1 Reset Control Register (RCR)

The RCR allows software control for requesting a reset, independently asserting the external RSTO pin, and controlling low-voltage detect (LVD) functions.

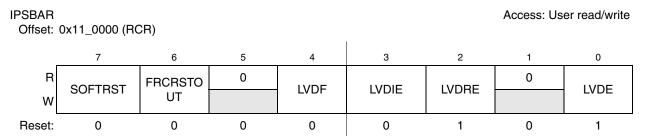


Figure 11-2. Reset Control Register (RCR)

Table 11-3. RCR Field Descriptions

| Field | Description |
|----------------|---|
| 7 SOFTRST | Allows software to request a reset. The reset caused by setting this bit clears this bit. 1 Software reset request 0 No software reset request |
| 6 FRCRSTOUT | Allows software to assert or negate the external RSTO pin. 1 Assert RSTO pin 0 Negate RSTO pin CAUTION: External logic driving reset configuration data during reset needs to be considered when asserting the RSTO pin when setting FRCRSTOUT. |
| 5 | Reserved, should be cleared. |
| 4 LVDF | LVD flag. Indicates the low-voltage detect status if LVDE is set. Write a 1 to clear the LVDF bit. 1 Low voltage has been detected 0 Low voltage has not been detected NOTE: The setting of this flag causes an LVD interrupt if LVDE and LVDIE bits are set and LVDRE is cleared when the supply voltage V _{DD} drops below V _{DD} (minimum). The vector for this interrupt is shared with INTO of the EPORT module. Interrupt arbitration in the interrupt service routine is necessary if both of these interrupts are enabled. Also, LVDF is not cleared at reset; however, it always initializes to a zero because the part does not come out of reset while in a low-power state (LVDE/LVDRE bits are enabled out of reset). |

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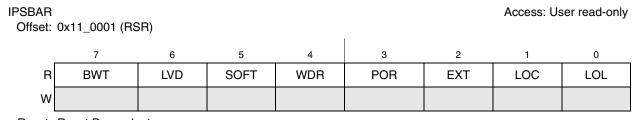
Table 11-3. RCR Field Descriptions (continued)

| Field | Description |
|------------|---|
| 3 LVDIE | LVD interrupt enable. Controls the LVD interrupt if LVDE is set. This bit has no effect if the LVDE bit is a logic 0. 1 LVD interrupt enabled 0 LVD interrupt disabled |
| 2 LVDRE | LVD reset enable. Controls the LVD reset if LVDE is set. This bit has no effect if the LVDE bit is a logic 0. LVD reset has priority over LVD interrupt, if both are enabled. 1 LVD reset enabled 0 LVD reset disabled |
| 1 | Reserved, should be cleared. |
| 0 LVDE | Controls whether the LVD is enabled. 1 LVD is enabled 0 LVD is disabled |

11.5.2 Reset Status Register (RSR)

The RSR contains a status bit for every reset source. When reset is entered, the cause of the reset condition is latched, along with a value of 0 for the other reset sources that were not pending at the time of the reset condition. These values are then reflected in RSR. One or more status bits may be set at the same time. The cause of any subsequent reset is also recorded in the register, overwriting the status from the previous reset condition.

RSR can be read at any time. Writing to RSR has no effect.



Reset: Reset Dependent

Figure 11-3. Reset Status Register (RSR)

Table 11-4. RSR Field Descriptions

| Field | Description |
|-----------|---|
| 7 BWT | This bit gets set when the backup watchdog timer (BWT) generates a reset. 1 BWT generated a reset 0 BWT did not generate a reset |
| 6 LVD | Low voltage detect. Indicates that the last reset state was caused by an LVD reset. 1 Last reset state was caused by an LVD reset 0 Last reset state was not caused by an LVD reset |
| 5 SOFT | Software reset flag. Indicates that the last reset was caused by software. 1 Last reset caused by software 0 Last reset not caused by software |

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Table 11-4. RSR Field Descriptions (continued)

| Field | Description |
|----------|---|
| 4 WDR | Watchdog reset flag. Indicates that the last reset was caused by the backup watchdog timer timeout. 1 Last reset caused by a backup watchdog timer timeout 0 Last reset not caused by a backup watchdog timer timeout |
| 3 POR | Power-on reset flag. Indicates that the last reset was caused by a power-on reset. 1 Last reset caused by power-on reset 0 Last reset not caused by power-on reset |
| 2 EXT | External reset flag. Indicates that the last reset was caused by an external device asserting the external RSTI pin. 1 Last reset state caused by external reset 0 Last reset not caused by external reset |
| 1 LOC | Loss-of-clock reset flag. Indicates that the last reset state was caused by a PLL loss of clock. 1 Last reset caused by loss of clock 0 Last reset not caused by loss of clock |
| 0 LOL | Loss-of-lock reset flag. Indicates that the last reset state was caused by a PLL loss of lock. 1 Last reset caused by a loss of lock 0 Last reset not caused by loss of lock |

Functional Description 11.6

11.6.1 **Reset Sources**

Table 11-5 defines the sources of reset and the signals driven by the reset controller.

| Source | Туре |
|--------------------------------------|--------------|
| Power on | Asynchronous |
| External RSTI pin (not stop mode) | Synchronous |
| External RSTI pin (during stop mode) | Asynchronous |
| Loss-of-clock | Asynchronous |
| Loss-of-lock | Asynchronous |
| Watchdog timer | Synchronous |
| Software | Synchronous |
| LVD reset | Asynchronous |

Table 11-5. Reset Source Summary

To protect data integrity, a synchronous reset source is not acted upon by the reset control logic until the end of the current bus cycle. Reset is then asserted on the next rising edge of the system clock after the cycle is terminated. When the reset control logic must synchronize reset to the end of the bus cycle, the internal bus monitor is automatically enabled regardless of the BME bit state in the chip configuration register (CCR). Then, if the current bus cycle is not terminated normally, the bus monitor terminates the cycle based on the length of time programmed in the BMT field of the CCR.

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Internal byte, word, or longword writes are guaranteed to complete without data corruption when a synchronous reset occurs. External writes, including longword writes to 16-bit ports, are also guaranteed to complete.

Asynchronous reset sources usually indicate a catastrophic failure. Therefore, the reset control logic does not wait for the current bus cycle to complete. Reset is asserted immediately to the system.

11.6.1.1 **Power-On Reset**

At power up, the reset controller asserts RSTO. RSTO continues to be asserted until V_{DD} has reached a minimum acceptable level and, if PLL clock mode is selected, until the PLL achieves phase lock. After approximately another 512 cycles, $\overline{\text{RSTO}}$ is negated and the part begins operation.

External Reset 11.6.1.2

Asserting the external \overline{RSTI} for at least four rising CLKOUT edges causes the external reset request to be recognized and latched. The bus monitor is enabled and the current bus cycle is completed. The reset controller asserts RSTO for approximately 512 cycles after RSTI is negated and the PLL has acquired lock. The part then exits reset and begins operation.

In low-power stop mode, the system clocks are stopped. Asserting the external \overline{RSTI} in stop mode causes an external reset to be recognized.

11.6.1.3 Watchdog Timer Reset

A watchdog timer timeout causes the watchdog timer reset request to be recognized and latched. The bus monitor is enabled. If the \overline{RESET} pin is negated and the PLL has acquired lock, the reset controller asserts RSTOUT for approximately 512 cycles. Then, the device exits reset and begins operation.

11.6.1.4 Loss-of-Clock Reset

This reset condition occurs in PLL clock mode when the LOCRE bit in the SYNCR is set and the PLL reference or the PLL itself fails. The reset controller asserts RSTO for approximately 512 cycles after the PLL has acquired lock. The device then exits reset and begins operation.

11.6.1.5 Loss-of-Lock Reset

This reset condition occurs in PLL clock mode when the LOLRE bit in the SYNCR is set and the PLL loses lock. The reset controller asserts $\overline{\text{RSTO}}$ for approximately 512 cycles after the PLL has acquired lock. The device then exits reset and resumes operation.

11.6.1.6 **Software Reset**

A software reset occurs when the SOFTRST bit is set. If the \overline{RSTI} is negated and the PLL has acquired lock, the reset controller asserts RSTO for approximately 512 cycles. Then the device exits reset and resumes operation.

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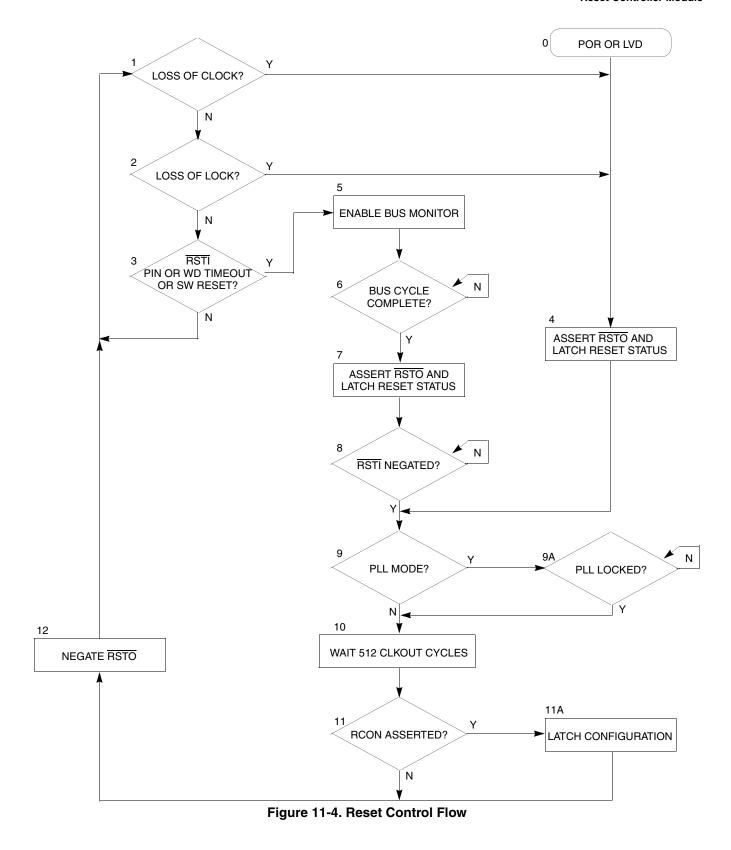
11.6.1.7 LVD Reset

The LVD reset occurs when the supply input voltage, V_{DD} drops below V_{LVD} (minimum).

11.6.2 Reset Control Flow

The reset logic control flow is shown in Figure 11-4. In this figure, the control state boxes have been numbered, and these numbers are referred to in the following flow description (within parentheses). All cycle counts given are approximate.





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Reset Controller Module

11.6.2.1 Synchronous Reset Requests

In this discussion, the references in parentheses refer to the state numbers in Figure 11-4. All cycle counts given are approximate.

If the external \overline{RSTI} signal is asserted by an external device for at least four rising CLKOUT edges (3) and if software requests a reset, the reset control logic latches the reset request internally and enables the bus monitor (5). When the current bus cycle is completed (6), \overline{RSTO} is asserted (7). The reset control logic waits until the \overline{RSTI} signal is negated (8) and for the PLL to attain lock (9, 9A) before waiting 512 CLKOUT cycles (1). The reset control logic may latch the configuration according to the \overline{RCON} signal level (11, 11A) before negating \overline{RSTO} (12).

If the external \overline{RSTI} signal is asserted by an external device for at least four rising CLKOUT edges during the 512 count (10) or during the wait for PLL lock (9A), the reset flow switches to (8) and waits for the \overline{RSTI} signal to be negated before continuing.

11.6.2.2 Internal Reset Request

If reset is asserted by an asynchronous internal reset source, such as loss of clock (1) or loss of lock (2), the reset control logic asserts \overline{RSTO} (4). The reset control logic waits for the PLL to attain lock (9, 9A) before waiting 512 CLKOUT cycles (1). Then the reset control logic may latch the configuration according to the \overline{RCON} pin level (11, 11A) before negating \overline{RSTO} (12).

If loss of lock occurs during the 512 count (10), the reset flow switches to (9A) and waits for the PLL to lock before continuing.

11.6.2.3 Power-On Reset/Low-Voltage Detect Reset

When the reset sequence is initiated by power-on reset (0), the same reset sequence is followed as for the other asynchronous reset sources.

11.6.3 Concurrent Resets

This section describes the concurrent resets. As in the previous discussion, references in parentheses refer to the state numbers in Figure 11-4.

11.6.3.1 Reset Flow

If a power-on reset or low-voltage detect condition is detected during any reset sequence, the reset sequence starts immediately (0).

If the external RSTI pin is asserted for at least four rising CLKOUT edges while waiting for PLL lock or the 512 cycles, the external reset is recognized. Reset processing switches to wait for the external RSTI pin to negate (8).

If a loss-of-clock or loss-of-lock condition is detected while waiting for the current bus cycle to complete (5, 6) for an external reset request, the cycle is terminated. The reset status bits are latched (7) and reset processing waits for the external \overline{RSTI} pin to negate (8).

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If a loss-of-clock or loss-of-lock condition is detected during the 512 cycle wait, the reset sequence continues after a PLL lock (9, 9A).

11.6.3.2 Reset Status Flags

For a POR reset, the POR and LVD bits in the RSR are set, and the SOFT, WDR, EXT, LOC, and LOL bits are cleared even if another type of reset condition is detected during the reset sequence for the POR.

If a loss-of-clock or loss-of-lock condition is detected while waiting for the current bus cycle to complete (5, 6) for an external reset request, the EXT, SOFT, and/or WDR bits along with the LOC and/or LOL bits are set.

If the RSR bits are latched (7) during the EXT, SOFT, and/or WDR reset sequence with no other reset conditions detected, only the EXT, SOFT, and/or WDR bits are set.

If the RSR bits are latched (4) during the internal reset sequence with the \overline{RSTI} pin not asserted and no SOFT or WDR event, then the LOC and/or LOL bits are the only bits set.

For a LVD reset, the LVD bit in the RSR is set, and the SOFT, WDR, EXT, LOC, and LOL bits are cleared to 0, even if another type of reset condition is detected during the reset sequence for LVD.



Chapter 12 Static RAM (SRAM)

12.1 Introduction

This chapter describes the on-chip static RAM (SRAM) implementation, including general operations, configuration, and initialization. It also provides information and examples showing how to minimize power consumption when using the SRAM.

12.1.1 Overview

The SRAM module provides a general-purpose memory block that the ColdFire processor can access in a single cycle. The location of the memory block can be specified to any 0-modulo-64K address within the 4-Gbyte address space. The memory is ideal for storing critical code or data structures or for use as the system stack. Because the SRAM module is physically connected to the processor's high-speed local bus, it can service processor-initiated accesses or memory-referencing commands from the debug module.

The SRAM is dual-ported to DMA, FEC, or USB provide access. The SRAM is partitioned into two physical memory arrays to allow simultaneous access to arrays by the processor core and another bus master. For more information see Chapter 14, "System Control Module (SCM)."

12.1.2 Features

The major features includes:

- One 64 Kbyte SRAM
- Single-cycle access
- Physically located on the processor's high-speed local bus
- Backdoor port for access by other system masters (DMA, FEC, and USB)
- Memory location programmable on any 0-modulo-64 Kbyte address
- Byte, word, and longword address capabilities

NOTE

16 KB of the 64 KB RAM is powered up during standby mode, and retains its contents.

12.2 Memory Map/Register Description

The SRAM programming model shown in Table 12-1 includes a description of the SRAM base address register (RAMBAR), SRAM initialization, and power management.

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| Rc[11:0] ¹ Register | | Width (bits) | Access | Reset Value | Written w/ MOVEC | Section/Page | |
|--------------------------------|------------------------------------|-----------------|--------|-------------|---------------------|--------------|--|
| | Supervisor Access Only Registers | | | | | | |
| 0xC05 | RAM Base Address Register (RAMBAR) | 32 | R/W | See Section | Yes | 12.2.1/12-2 | |

The values listed in this column represent the Rc field used when accessing the core registers via the BDM port. For more information see Chapter 33, "Debug Module."

12.2.1 SRAM Base Address Register (RAMBAR)

The configuration information in the SRAM base-address register (RAMBAR) controls the operation of the SRAM module.

- The RAMBAR holds the SRAM base address. The MOVEC instruction provides write-only access to this register.
- The RAMBAR can be read or written from the debug module.
- All undefined bits in the register are reserved. These bits are ignored during writes to the RAMBAR and return zeroes when read from the debug module.
- A reset clears the RAMBAR's valid bit. This invalidates the processor port to the SRAM (The RAMBAR must be initialized before the core can access the SRAM.) All other bits are unaffected.

NOTE

Do not confuse this RAMBAR with the SCM RAMBAR in Section 14.5.2, "Memory Base Address Register (RAMBAR) Although similar, this core RAMBAR enables core access to the SRAM memory, while the SCM RAMBAR enables peripheral (e.g., DMA and FEC) access to the SRAM.

The RAMBAR contains several control fields. These fields are shown in Figure 12-1.

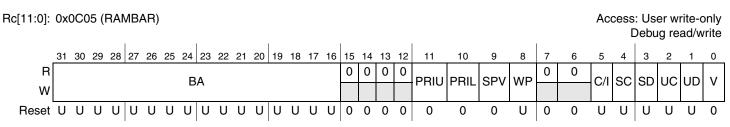


Figure 12-1. SRAM Base Address Register (RAMBAR)

Table 12-2. RAMBAR Field Descriptions

| Field | Description |
|-------------|---|
| 31–16 BA | Base Address. Defines the 0-modulo-64K base address of the SRAM module. By programming this field, the SRAM may be located on any 64-Kbyte boundary within the processor's 4-Gbyte address space. |
| 15–12 | Reserved, must be cleared. |

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Static RAM (SRAM)

Table 12-2. RAMBAR Field Descriptions (continued)

| Field | Description | | | | | | | |
|-------------------------------|---|---|--------------------------|-----------------------------|---|--|--|--|
| 11–10 PRIU PRIL | Priority Bit. PRIU determines if DMA/FEC/USB or CPU has priority in the upper 32K bank of memory. PRIL determines if DMA/FEC/USB or CPU has priority in the lower 32K bank of memory. If a bit is set, the CPU has priority. If a bit is cleared, DMA/FEC/USB has priority. Priority is determined according to the following table: | | | | | | | |
| | | PRIU,PRIL Upper Bank Priority Lower Bank Priority | | | | | | |
| | | 00 DMA/FEC/USB DMA/FEC/USB | | | | | | |
| | | 01 | DMA/FEC/USB | CPU | 1 | | | |
| | | 10 | CPU | DMA/FEC/USB | 1 | | | |
| | | 11 | CPU | CPU |] | | | |
| | Note: The recomi | mended setting | (maximum performance) fo | or the priority bits is 00. | _ | | | |
| 9 SPV | Secondary port valid. Allows access by DMA, USB, and FEC. 0 DMA, USB, and FEC access to memory is disabled. 1 DMA, USB, and FEC access to memory is enabled. Note: The BDE bit in the second RAMBAR register must also be set to allow dual port access to the SRAM. For more information, see Section 14.5.2, "Memory Base Address Register (RAMBAR)." | | | | | | | |
| 8 WP | Write Protect. Allows only read accesses to the SRAM. When this bit is set, any attempted write access from the core generates an access error exception to the ColdFire processor core. O Allows core read and write accesses to the SRAM module 1 Allows only core read accesses to the SRAM module Note: This bit does not affect non-core write accesses. | | | | | | | |
| 7–6 | Reserved, must be cleared. | | | | | | | |
| 5–1 C/I, SC, SD, UC, UD | Address Space Masks (ASn). These five bit fields allow types of accesses to be masked or inhibited from accessing the SRAM module. The address space mask bits are: C/I = CPU space/interrupt acknowledge cycle mask SC = Supervisor code address space mask SD = Supervisor data address space mask UC = User code address space mask UD = User data address space mask For each address space bit: | | | | | | | |
| | O An access to the SRAM module can occur for this address space Disable this address space from the SRAM module. If a reference using this address space is made, it is inhibited from accessing the SRAM module and is processed like any other non-SRAM reference. These bits are useful for power management as detailed in Section 12.3.2, "Power Management." In most applications, the C/I bit is set | | | | | | | |
| 0 V | Valid. When set, this bit enables the SRAM module; otherwise, the module is disabled. A hardware reset clears this bit. 0 Contents of RAMBAR are not valid 1 Contents of RAMBAR are valid | | | | | | | |

12.3 Initialization/Application Information

After a hardware reset, the SRAM module contents are undefined. The valid bit of the RAMBAR is cleared, disabling the processor port into the memory. If the SRAM requires initialization with instructions or data, perform the following steps:

1. Load the RAMBAR, mapping the SRAM module to the desired location within the address space.

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- 2. Read the source data and write it to the SRAM. Various instructions support this function, including memory-to-memory move instructions, or the MOVEM opcode. The MOVEM instruction is optimized to generate line-sized burst fetches on 0-modulo-16 addresses, so this opcode generally provides maximum performance.
- 3. After the data loads into the SRAM, it may be appropriate to load a revised value into the RAMBAR with a new set of attributes. These attributes consist of the write-protect and address space mask fields.

The ColdFire processor or an external debugger using the debug module can perform these initialization functions.

12.3.1 SRAM Initialization Code

The following code segment describes how to initialize the SRAM. The code sets the base address of the SRAM at 0x2000_0000 and initializes the SRAM to zeros.

The following loop initializes the entire SRAM to zero:

```
lea.l
                  RAMBASE, A0
                                               ; load pointer to SRAM
         move.1
                  #16384,D0
                                               ;load loop counter into D0 (SRAM size/4)
SRAM_INIT_LOOP:
         clr.1
                  (A0) +
                                               ; clear 4 bytes of SRAM
         clr.1
                  (A0) +
                                               ; clear 4 bytes of SRAM
         clr.1
                  (A0) +
                                               ; clear 4 bytes of SRAM
         clr.1
                  (A0) +
                                               ; clear 4 bytes of SRAM
         subq.1
                  #4,D0
                                               ;decrement loop counter
         bne.b
                  SRAM INIT LOOP
                                               ; if done, then exit; else continue looping
```

12.3.2 Power Management

If the SRAM is used only for data operands, setting the ASn bits associated with instruction fetches can decrease power dissipation. Additionally, if the SRAM contains only instructions, masking operand accesses can reduce power dissipation. Table 12-3 shows examples of typical RAMBAR settings.

| Data Contained in SRAM | RAMBAR[7:0] |
|------------------------|-------------|
| Instruction Only | 0x2B |
| Data Only | 0x35 |
| Instructions and Data | 0x21 |

 Table 12-3. Typical RAMBAR Setting Examples

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Chapter 13 Chip Configuration Module (CCM)

13.1 Introduction

This chapter describes the various operating configurations of the device and provides a description of signals used by the CCM and a programming model.

13.1.1 Block Diagram

The chip configuration module (CCM) controls the chip configuration and mode of operation for the processor.

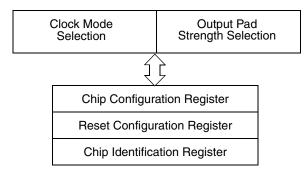


Figure 13-1. Chip Configuration Module Block Diagram

13.1.2 Features

The CCM selects the following:

- External clock or phase-lock loop (PLL) mode with internal or external reference
- Output pad drive strength
- Low-power configuration
- Processor status (PSTAT) and processor debug data (DDATA) functions
- BDM or JTAG mode

13.2 External Signal Descriptions

Table 13-1 provides an overview of the CCM signals.

Table 13-1. Signal Properties

| Name | Function | Reset State | |
|------|----------------------------|------------------------------|--|
| RCON | Reset configuration select | Internal weak pull-up device | |

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13.2.1 RCON

If the external $\overline{\text{RCON}}$ pin is asserted during reset, various chip functions, including the reset configuration pin functions after reset, are configured according to the levels driven onto the external data pins (see Section 13.4, "Functional Description"). The internal configuration signals are driven to reflect the levels on the external configuration pins to allow for module configuration.

If the RCON pin is not asserted during reset, the chip configuration and the reset configuration pin functions after reset are determined by the RCON register or fixed defaults, regardless of the states of the external data pins.

13.3 Memory Map/Register Definition

The CCM programming model consists of these registers:

- The chip configuration register (CCR) controls the main chip configuration.
- The reset configuration register (RCON) indicates the default chip configuration.
- The chip identification register (CIR) contains a unique part number.

Some control register bits are implemented as write-once bits. These bits are always readable, but after the bit has been written, additional writes have no effect, except during debug and test operations.

Some write-once bits can be read and written while in debug mode. When debug mode is exited, the chip configuration module resumes operation based on the current register values. If a write to a write-once register bit occurs while in debug mode, the register bit remains writable on exit from debug or test mode. Table 13-2 shows the accessibility of write-once bits.

| Configuration | Read/Write Access | | |
|--------------------|-------------------|--|--|
| All configurations | Read-always | | |
| Debug operation | Write-always | | |

Table 13-2. Write-Once Bits Read/Write Accessibility

Table 13-3. Chip Configuration Module Memory Map

| IPSBAR Offset ¹ | Register | | Access | Reset Value | Section/Page |
|-------------------------------|--|------|--------|-------------|--------------|
| | Supervisor Mode Access (| Only | | | |
| 0x11_0004 | Chip Configuration Register (CCR) | 16 | R | 0x0001 | 13.3.1/13-3 |
| 0x11_0007 | Low-Power Control Register (LPCR) ² | 8 | R/W | 0x00 | 10.2.2/10-4 |
| 0x11_0008 | Reset Configuration Register (RCON) | 16 | R | 0x0000 | 13.3.2/13-3 |
| 0x11_000A | 11_000A Chip Identification Register (CIR) | | R | 0x2000 | 13.3.3/13-4 |
| 0x11_0010 | nip Identification Extended Register (CCE) 8 | | R/W | 0x00 | 13.3.4/13-5 |

Addresses not assigned to a register and undefined register bits are reserved for expansion.

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SeeChapter 10, "Power Management," for a description of the LPCR. It is shown here only to warn against accidental writes to this register.

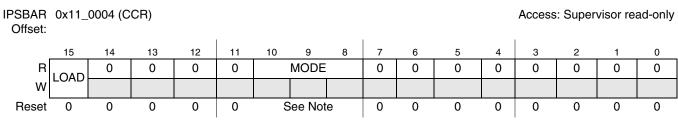


Chip Configuration Module (CCM)

NOTE

To safeguard against unintentionally activating test logic, write 0x0000 to the above reserved location during initialization (immediately after reset) to lock out test features. Setting any bits in the CCR may lead to unpredictable results.

13.3.1 Chip Configuration Register (CCR)



Note: Determined during reset configuration.

Figure 13-2. Chip Configuration Register (CCR)

Table 13-4. CCR Field Descriptions

| Field | Description |
|--------------|---|
| 15 LOAD | Pad driver load. Selects full or partial drive strength for selected pad output drivers. For maximum capacitive load, set the LOAD bit to select full drive strength. For reduced power consumption and reduced Electromagnetic Interference (EMI), clear the LOAD bit to select partial drive strength. O Partial drive strength Full drive strength |
| 14–11 | Reserved, must be cleared. |
| 10–8 MODE | Chip configuration mode. Reflects the chosen chip configuration mode (based on the choice of pins during reset, such as CLOCKMOD0, CLOCKMOD1, or XTAL). 0xx Reserved 100 Reserved 101 EzPort mode 110 Single-chip mode 111 Reserved |
| 7–0 | Reserved, must be cleared. |

13.3.2 Reset Configuration Register (RCON)

At reset, RCON determines the default operation of certain chip functions. All default functions defined by the RCON values can only be overridden during reset configuration (see Section 13.4.1, "Reset Configuration") if the external RCON pin is asserted. RCON is a read-only register.

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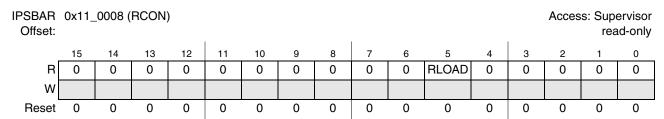


Figure 13-3. Reset Configuration Register (RCON)

Table 13-5. RCON Field Descriptions

| Field | Description |
|------------|--|
| 15–6 | Reserved, must be cleared. |
| 5 RLOAD | Pad driver load. Reflects the default pad driver strength configuration. 0 Partial drive strength (This is the default value.) 1 Full drive strength |
| 4–0 | Reserved, must be cleared. |

13.3.3 Chip Identification Register (CIR)

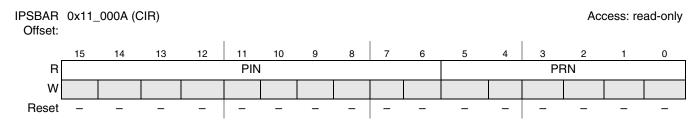


Figure 13-4. Chip Identification Register (CIR)

Table 13-6. CIR Field Description

| Field | Description |
|-------------|---|
| 15–6 PIN | Part identification number. Contains a unique identification number for the device. |
| 5–0 PRN | Part revision number. This number is increased by one for each new full-layer mask set of this part. The revision numbers are assigned in chronological order, beginning with zero. |

Table 13-7 lists the 10-bit binary values that represent chip-identification numbers for MCF52259 family devices.

Table 13-7. Chip Identification Numbers

| Part Number | Flash Size (in KBytes) | RAM Size (in KBytes) | Package | Chip Identification Number |
|---------------|------------------------|----------------------|----------|----------------------------|
| MCF52254AF80 | 512 | 64 | 100 LQFP | 0010000011 |
| MCF52252AF80 | 256 | 32 | 100 LQFP | 0010000110 |
| MCF52254CAF80 | 512 | 64 | 100 LQFP | 0010000111 |
| MCF52252CAF66 | 256 | 32 | 100 LQFP | 0010001010 |

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Chip Configuration Module (CCM)

| Part Number | Flash Size (in KBytes) | RAM Size (in KBytes) | Package | Chip Identification Number |
|---------------|------------------------|----------------------|------------|----------------------------|
| MCF52258AG80 | 512 | 64 | 144 LQFP | 0010001011 |
| MCF52258VN80 | 512 | 64 | 144 MAPBGA | 0010001011 |
| MCF52256AG80 | 256 | 32 | 144 LQFP | 0010001110 |
| MCF52256VN80 | 256 | 32 | 144 MAPBGA | 0010001110 |
| MCF52258CAG66 | 512 | 64 | 144 LQFP | 0010001111 |
| MCF52258CVN66 | 512 | 64 | 144 MAPBGA | 0010001111 |
| MCF52256CAG66 | 256 | 64 | 144 LQFP | 0010010000 |
| MCF52256CVN66 | 256 | 64 | 144 MAPBGA | 0010010000 |
| MCF52255CAF80 | 512 | 64 | 100 LQFP | 0010010001 |
| MCF52259CAG80 | 512 | 64 | 144 LQFP | 0010010010 |
| MCF52259CVN80 | 512 | 64 | 144 MAPBGA | 0010010010 |

Table 13-7. Chip Identification Numbers (continued)

13.3.4 Chip Configuration Extended Register (CCE)

The CCE register sets miscellanoius bits. It controls the Mini-FlexBus 1:1 mode. This register is write-once. After a value is written to this register, it cannnot be written for a second time. This register can be re-written only after a reset.

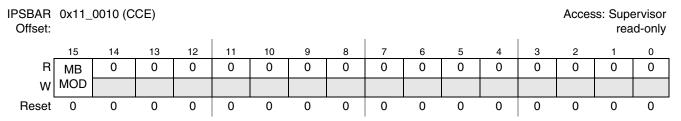


Figure 13-5. Chip Configuration Extended Register (CCE)

Table 13-8. CCE Field Descriptions

| Field | Description |
|-------------|--|
| 15 MBMOD | Mini-FlexBus 0 Mini-FlexBus is in 1:2 mode 1 Mini-FlexBus is in 1:1 mode |
| 14–0 | Reserved, must be cleared. |

13.4 Functional Description

Three functions are defined within the chip configuration module:

- Reset configuration
- Output pad strength configuration
- Clock mode selections

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These functions are described in the following sections.

13.4.1 Reset Configuration

During reset, the pins for the reset override functions are immediately configured to known states. Table 13-9 shows the states of the external pins while in reset.

Table 13-9. Reset Configuration Pin States During Reset

| Pin | Pin Function ¹ | I/O | Output State | Input State |
|------|--|-------|-----------------|------------------------------|
| RCON | RCON function for all modes ² | Input | _ | Internal weak pull-up device |

¹ If the external \overline{RCON} pin is not asserted during reset, pin functions are determined by the default operation mode defined in the RCON register. If the external \overline{RCON} pin is asserted, pin functions are determined by the override values driven on the external data bus pins.

If the \overline{RCON} pin is not asserted during reset, the chip configuration and the reset configuration pin functions after reset are determined by RCON or fixed defaults, regardless of the states of the external data pins. The internal configuration signals are driven to levels specified by the RCON register's reset state for default module configuration.

If the RCON pin is asserted during reset, then various chip functions, including the reset configuration pin functions after reset, are configured according to the levels driven onto the external data pins (see Table 13-10). The internal configuration signals are driven to reflect the levels on the external configuration pins to allow for module configuration.

Table 13-10. Configuration During Reset¹

| Pin(s) Affected | Default Configuration | Function | | | | |
|-----------------|--------------------------|---------------------------|---------|----------|-----------|-------------|
| | RCON[0] | Chip Mode | | | | |
| Varies | | Single chip mode | | | | |
| Variou | | 110011[0] | neentel | ricontoj | , noonqoj | EzPort mode |
| | | | | | | |
| | RCON[5] = 1 | Output Pad Drive Strength | | | | |
| All output pins | | Partial strength | | | | |
| | | Full strength | | | | |

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² During reset, the external RCON pin assumes its RCON pin function, but this pin changes to the function defined by the chip operation mode immediately after reset. See Table 13-10.



Chip Configuration Module (CCM)

Table 13-10. Configuration During Reset¹ (continued)

| Pin(s) Affected | Default Configuration | Function |
|------------------|--------------------------|---|
| | | Clock mode |
| | None | PLL disabled; clock derived from external osc |
| | | PLL disabled; clock derived from internal osc |
| Clock signals | | PLL enabled; clock derived from external osc |
| | | PLL enabled; clock derived from internal osc |
| | | PLL disabled; clock derived from external crystal |
| | | PLL enabled; clock derived from external crystal |
| | | Module Configuration |
| Module-dependent | | Default |
| | | Module-dependent |

¹ Modifying the default configurations is possible only if the external RON pin is asserted.

13.4.2 Output Pad Strength Configuration

Output pad strength is determined during reset configuration.

13.5 Reset

Reset initializes CCM registers to a known startup state as described in Section 13.3, "Memory Map/Register Definition." The CCM controls chip configuration at reset as described in Section 13.4, "Functional Description."



Chapter 14 System Control Module (SCM)

14.1 Introduction

This section details the functionality of the system control module (SCM) that provides the programming model for the system access control unit (SACU), system bus arbiter, 32-bit core watchdog timer (CWT), and system control registers and logic. Specifically, the system control includes the internal peripheral system (IPS) base address register (IPSBAR), the processor's dual-port RAM base address register (RAMBAR), and system control registers that include the core watchdog timer control.

14.2 Overview

The SCM provides the control and status for a variety of functions including base addressing and address space masking for the IPS peripherals and resources (IPSBAR) and the ColdFire core memory spaces (RAMBAR). The CPU core supports two memory banks, one for the internal SRAM and the other for the internal flash.

The SACU provides the mechanism needed to implement secure bus transactions to the system address space.

The programming model for the system bus arbitration resides in the SCM. The SCM sources the necessary control signals to the arbiter for bus master management.

The CWT provides a means of preventing system lockup due to uncontrolled software loops via a special software service sequence. If periodic software servicing action does not occur, the CWT times out with a programmed response (interrupt) to allow recovery or corrective action to be taken.

14.3 Features

The SCM includes these distinctive features:

- IPS base address register (IPSBAR)
 - Base address location for 1-Gbyte peripheral space
 - User control bits
- Processor-local memory base address register (RAMBAR)
- System control registers
 - Core reset status register (CRSR) indicates type of last reset
 - Core watchdog service register (CWSR) services watchdog timer
 - Core watchdog control register (CWCR) for watchdog timer control
- System bus master arbitration programming model (MPARK)

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System Control Module (SCM)

- System access control unit (SACU) programming model
 - Master privilege register (MPR)
 - Peripheral access control registers (PACRs)
 - Grouped peripheral access control registers (GPACR0, GPACR1)

14.4 Memory Map and Register Definition

The memory map for the SCM registers is shown in Table 14-1. All the registers in the SCM are memory-mapped as offsets within the 1-Gbyte IPS address space and accesses are controlled to these registers by the control definitions programmed into the SACU.

Table 14-1. SCM Register Map

| IPSBAR Offset ¹ | Register | Width (bits) | Access | Reset Value | Section/Page |
|-------------------------------|---|-----------------|--------|---------------|----------------|
| 0x00_0000 | IPS Base Address Register (IPSBAR) | 32 | R/W | 0x4000_0001 | 14.5.1/14-3 |
| 0x00_0008 | Memory Base Address Register (RAMBAR) | 32 | R/W | 0x0000_0000 | 14.5.2/14-4 |
| 0x00_000C | Peripheral Power Management Register High (PPMRH) ² | 32 | R/W | 0x0000_0000 | 10.2.1/10-2 |
| 0x00_0010 | Core Reset Status Register (CRSR) | 8 | R/W | See Section | 14.5.3/14-5 |
| 0x00_0011 | Core Watchdog Control Register (CWCR) | 8 | R/W | 0x00 | 14.5.4/14-6 |
| 0x00_0012 | Low-Power Interrupt Control Register (LPICR) ² | 8 | R/W | 0x00 | 10.2.2/10-4 |
| 0x00_0013 | Core Watchdog Service Register (CWSR) | 8 | R/W | Uninitialized | 14.5.5/14-8 |
| 0x00_0014 | DMA Request Control Register (DMAREQC) | 32 | R/W | 0x0000_0000 | 22.3.1/22-4 |
| 0x00_0018 | Peripheral Power Management Register Low (PPMRL) ² | 32 | R/W | 0x0000_0001 | 10.2.1/10-2 |
| 0x00_001C | Default Bus Master Park Register (MPARK) | 32 | R/W | 0x30E1_0000 | 14.6.3/14-10 |
| 0x00_0020 | Master Privilege Register (MPR) | 8 | R/W | 0x03 | 14.7.3.1/14-14 |
| 0x00_0021 | Peripheral Power Management Set Register (PPMRS) ² | 8 | W | 0x00 | 10.2.3/10-5 |
| 0x00_0022 | Peripheral Power Management Clear Register (PPMRC) ² | 32 | R/W | 0x00 | 10.2.4/10-6 |
| 0x00_0023 | IPS Bus Timeout Monitor Register (IPSBMT) ^{2,3} | 32 | R/W | 0x0000_0008 | 10.3/10-7 |
| 0x00_0024 | Peripheral Access Control Register (PACR0) | 8 | R/W | 0x00 | 14.7.3.2/14-14 |
| 0x00_0025 | Peripheral Access Control Register (PACR1) | 8 | R/W | 0x00 | 14.7.3.2/14-14 |
| 0x00_0026 | Peripheral Access Control Register (PACR2) | 8 | R/W | 0x00 | 14.7.3.2/14-14 |
| 0x00_0027 | Peripheral Access Control Register (PACR3) | 8 | R/W | 0x00 | 14.7.3.2/14-14 |
| 0x00_0028 | Peripheral Access Control Register (PACR4) | 8 | R/W | 0x00 | 14.7.3.2/14-14 |
| 0x00_0029 | Peripheral Access Control Register (PACR5) | 8 | R/W | 0x00 | 14.7.3.2/14-14 |
| 0x00_002A | Peripheral Access Control Register (PACR6) | 8 | R/W | 0x00 | 14.7.3.2/14-14 |
| 0x00_002B | Peripheral Access Control Register (PACR7) | 8 | R/W | 0x00 | 14.7.3.2/14-14 |
| 0x00_002C | Peripheral Access Control Register (PACR8) | 8 | R/W | 0x00 | 14.7.3.2/14-14 |
| 0x00_002E | Peripheral Access Control Register (PACR10) | 8 | R/W | 0x00 | 14.7.3.2/14-14 |

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| IPSBAR Offset ¹ | Register | Width (bits) | Access | Reset Value | Section/Page |
|-------------------------------|---|-----------------|--------|-------------|----------------|
| 0x00_0030 | Grouped Peripheral Access Control Register 0 (GPACR0) | 8 | R/W | 0x00 | 14.7.3.3/14-16 |
| 0x00_0031 | Grouped Peripheral Access Control Register 1 (GPACR1) | 8 | R/W | 0x00 | 14.7.3.3/14-16 |

Addresses not assigned to a register and undefined register bits are reserved for expansion.

14.5 Register Descriptions

14.5.1 Internal Peripheral System Base Address Register (IPSBAR)

The IPSBAR specifies the base address for the 1-Gbyte memory space associated with the on-chip peripherals. At reset, the base address is loaded with a default location of $0x4000_0000$ and marked as valid (IPSBAR[V]=1). If desired, the address space associated with the internal modules can be moved by loading a different value into the IPSBAR at a later time.

NOTE

Accessing reserved IPSBAR memory space could result in an unterminated bus cycle that causes the core to hang. Only a hard reset allows the core to recover from this state. Therefore, all bus accesses to IPSBAR space should fall within a module's memory map space.

If an address hits in overlapping memory regions, the following priority is used to determine what memory is accessed:

- 1. IPSBAR
- 2. RAMBAR

NOTE

This is the list of memory access priorities when viewed from the processor core.

IPSBAR 0x000 (IPSBAR) Access: read/write Offset: **BA30** BA31 Reset Reset

Figure 14-1. IPS Base Address Register (IPSBAR)

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² The PPMRH, LPICR, PPMRL, PPMRS, PPMRC, and IPSBMT are described in Chapter 10, "Power Management."

³ Register must be addressed as a byte.



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Table 14-2. IPSBAR Field Description

| Field | Description |
|-------------|--|
| 31–30 BA | Base address. Defines the base address of the 1-Gbyte internal peripheral space. This is the starting address for the IPS registers when the valid bit is set. |
| 29–1 | Reserved, must be cleared. |
| 0 V | Valid. Enables/disables the IPS Base address region. V is set at reset. 0 IPS Base address is not valid. 1 IPS Base address is valid. |

14.5.2 Memory Base Address Register (RAMBAR)

The device supports dual-ported local SRAM memory. This processor-local memory can be accessed directly by the core and/or other system bus masters. Because this memory provides single-cycle accesses at processor speed, it is ideal for applications where double-buffer schemes can be used to maximize system-level performance. For example, a DMA channel in a typical double-buffer application (also known as a ping-pong scheme) may load data into one portion of the dual-ported SRAM while the processor is manipulating data in another portion of the SRAM. After the processor completes the data calculations, it begins processing the recently loaded buffer while the DMA moves out the recently calculated data from the other buffer, and reloads the next data block into the recently freed memory region. The process repeats with the processor and the DMA ping-ponging between alternate regions of the dual-ported SRAM.

The device design implements the dual-ported SRAM in the memory space defined by the RAMBAR register. There are two physical copies of the RAMBAR register: one located in the processor core and accessible only via the privileged MOVEC instruction at CPU space address 0xC05 and another located in the SCM at IPSBAR + 0x008. ColdFire core accesses to this memory are controlled by the processor-local copy of the RAMBAR, while module accesses are enabled by the SCM's RAMBAR.

The physical base address programmed in both copies of the RAMBAR is typically the same value; however, they can be programmed to different values. By definition, the base address must be a 0-modulo-size value.

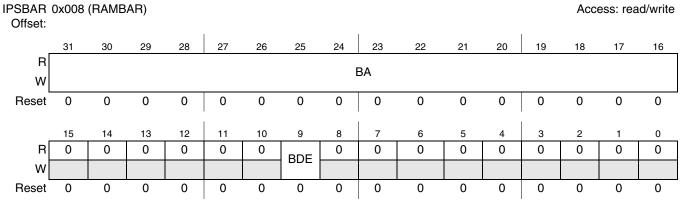


Figure 14-2. Memory Base Address Register (RAMBAR)

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Table 14-3. RAMBAR Field Description

| Field | Description |
|-------------|---|
| 31–16 BA | Base address. Defines the memory module's base address on a 64-Kbyte boundary corresponding to the physical array location within the 4 Gbyte address space supported by ColdFire. |
| 15–10 | Reserved, must be cleared. |
| 9 BDE | Back door enable. Qualifies non-core master module accesses to the memory. 0 Disables non-core master module accesses to the internal SRAM 1 Enables non-core master module accesses to the internal SRAM Note: The SPV bit in the CPU's RAMBAR must also be set to allow dual port access to the SRAM. For more information, see Section 12.2.1, "SRAM Base Address Register (RAMBAR)." |
| 8–0 | Reserved, must be cleared. |

The SRAM modules are configured through the RAMBAR shown in Figure 14-2.

- RAMBAR specifies the base address of the SRAM.
- All undefined bits are reserved. These bits are ignored during writes to the RAMBAR and return zeros when read.
- The back door enable bit, RAMBAR[BDE], is cleared at reset, disabling the module access to the SRAM.

NOTE

The RAMBAR default value of 0x0000_0000 is invalid. The RAMBAR located in the processor's CPU space must be initialized with the valid bit set before the CPU (or modules) can access the on-chip SRAM (see Chapter 12, "Static RAM (SRAM)," for more information.

For details on the processor's view of the local SRAM memories, see Section 12.2.1, "SRAM Base Address Register (RAMBAR)."

14.5.3 Core Reset Status Register (CRSR)

The CRSR contains a bit that indicates the reset source to the CPU. When the EXT bit (bit 7) reads as 1, an external device driving RSTI has caused the most recent reset. The CRSR is updated by the control logic when the reset is complete. Only one bit is set at any one time in the CRSR. The register reflects the cause of the most recent reset. To clear a bit, a logic 1 must be written to the bit location; writing a zero has no effect. Unused bits are reserved and should not be written.

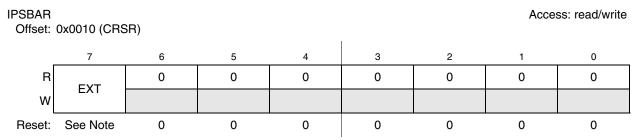
NOTE

The reset status register (RSR) in the reset controller module provides indication of all reset sources except the core watchdog timer (see Chapter 11, "Reset Controller Module").

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System Control Module (SCM)



Note: The reset value of EXT depend on the last reset source. All other bits are initialized to zero.

Figure 14-3. Core Reset Status Register (CRSR)

Table 14-4. CRSR Field Descriptions

| Field | Description |
|----------|---|
| 7 EXT | External reset. 1 An external device driving RSTI caused the last reset. Assertion of reset by an external device causes the processor core to initiate reset exception processing. All registers are forced to their initial state. |
| 6–0 | Reserved, must be zero. |

14.5.4 Core Watchdog Control Register (CWCR)

The core watchdog timer prevents system lockup if the software becomes trapped in a loop with no controlled exit. The core watchdog timer can be enabled or disabled through CWCR[CWE]. It is disabled by default. If enabled, the watchdog timer requires the periodic execution of a core watchdog servicing sequence. If this periodic servicing action does not occur, the timer times out, resulting in a watchdog timer interrupt, as programmed by CWCR[CWRI]. If the timer times out and the core watchdog transfer acknowledge enable bit (CWCR[CWTA]) is set, a watchdog timer interrupt is asserted. If a core watchdog timer interrupt acknowledge cycle has not occurred after another timeout, CWT TA is asserted in an attempt to allow the interrupt acknowledge cycle to proceed by terminating the bus cycle. The setting of CWCR[CWTAVAL] indicates that the watchdog timer TA was asserted.

To prevent the core watchdog timer from interrupting, the CWSR must be serviced by performing the following sequence:

- 1. Write 0x55 to CWSR.
- 2. Write 0xAA to the CWSR.

Both writes must occur in order before the time-out, but any number of instructions can be executed between the two writes. This order allows interrupts and exceptions to occur, if necessary, between the two writes. Caution should be exercised when changing CWCR values after the software watchdog timer has been enabled with the setting of CWCR[CWE], because it is difficult to determine the state of the core watchdog timer while it is running. The countdown value is constantly compared with the time-out period specified by CWCR[CWT]. The following steps must be taken to change CWT:

- 1. Disable the core watchdog timer by clearing CWCR[CWE].
- 2. Reset the counter by writing 0x55 and then 0xAA to CWSR.
- 3. Update CWCR[CWT].

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4. Re-enable the core watchdog timer by setting CWCR[CWE]. This step can be performed in step 3.

The CWCR controls the software watchdog timer, time-out periods, and software watchdog timer transfer acknowledge. The register can be read at any time, but can be written only if the CWT is not pending. At system reset, the software watchdog timer is disabled.

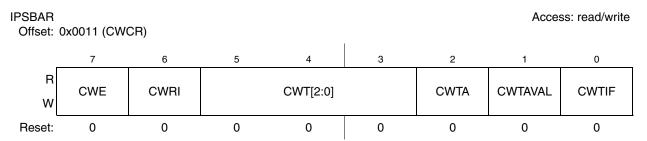


Figure 14-4. Core Watchdog Control Register (CWCR)

Table 14-5. CWCR Field Description

| Field | | | Description | |
|-----------------|--|---------------------|--|--|
| 7 CWE | Core watchdog ena 0 SWT disabled. 1 SWT enabled. | able. | | |
| 6 CWRI | Core watchdog interrupt select. 0 If a time-out occurs, the CWT generates an interrupt to the processor core. The interrupt level for the CWT is programmed in the interrupt control register 8 (ICR8) of INTC0. 1 Reserved. If a one is written, undetermined behavior results. Note: If a core reset is required, the watchdog interrupt should set the soft reset bit in the Reset Control register. | | | |
| 5–3 CWT[2:0] | Core watchdog timing delay. These bits select the timeout period for the CWT as shown in the following table. At system reset, the CWT field is cleared signaling the minimum time-out period but the watchdog is disabled (CWCR[CWE] = 0). the following table shows the core watchdog timer delay. | | | |
| | | CWT [2:0] | CWT Time-Out Period | |
| | | 000 | 2 ⁹ Bus clock frequency | |
| | | 001 | 2 ¹¹ Bus clock frequency | |
| | | 010 | 2 ¹³ Bus clock frequency | |
| | | 011 | 2 ¹⁵ Bus clock frequency | |
| | | 100 | 2 ¹⁹ Bus clock frequency | |
| | | 101 | 2 ²³ Bus clock frequency | |
| | | 110 | 2 ²⁷ Bus clock frequency | |
| | | 111 | 2 ³¹ Bus clock frequency | |
| 2 CWTA | CWTA Transfer a CWTA Transfer a | he transfer acknowl | ed. ed. After one CWT time-out perion | od of the unacknowledged assertion of the Γ to terminate a bus cycle and allow the |

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System Control Module (SCM)

Table 14-5. CWCR Field Description (continued)

| 1 CWTAVA L | Core watchdog transfer acknowledge valid. 0 CWTA Transfer Acknowledge has not occurred. 1 CWTA Transfer Acknowledge has occurred. Write a 1 to clear this flag bit. |
|------------------|---|
| | Core watchdog timer interrupt flag. 0 CWT interrupt has not occurred 1 CWT interrupt has occurred. Write a 1 to clear the interrupt request. |

Core Watchdog Service Register (CWSR) 14.5.5

Perform the software watchdog service sequence by using the CWSR as a data register to prevent a CWT time-out. The service sequence requires two writes to this data register: first a write of 0x55 followed by a write of 0xAA. Both writes must be performed in this order prior to the CWT time-out, but any number of instructions or accesses to the CWSR can be executed between the two writes. If the CWT has already timed out, writing to this register has no effect in negating the CWT interrupt. Figure 14-5 illustrates the CWSR. At system reset, the contents of CWSR are uninitialized.

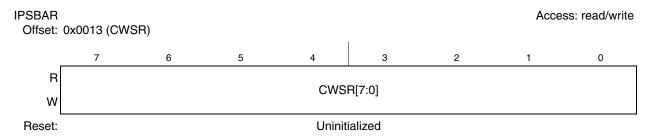


Figure 14-5. Core Watchdog Service Register (CWSR)

14.6 **Internal Bus Arbitration**

The internal bus arbitration is performed by the on-chip bus arbiter, which containing the arbitration logic that controls which of up to four MBus masters (M0–M3 in Figure 14-6) has access to the external buses. The function of the arbitration logic is described in this section.

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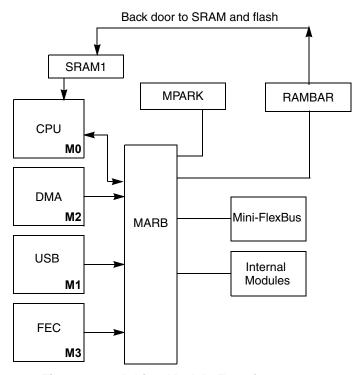


Figure 14-6. Arbiter Module Functions

14.6.1 Overview

The basic functionality is that of a two-port, pipelined internal bus arbitration module with the following attributes:

- The master pointed to by the current arbitration pointer may get on the bus with zero latency if the address phase is available. All other requesters face at least a one cycle arbitration pipeline delay to meet bus timing constraints on address phase hold.
- If a requester receives an immediate address phase (it is pointed to by the current arbitration pointer and the bus address phase is available), it is the current bus master and is ignored by arbitration. All remaining requesting ports are evaluated by the arbitration algorithm to determine the next-state arbitration pointer.
- There are two arbitration algorithms: fixed and round-robin. Fixed arbitration sets the next-state arbitration pointer to the highest priority requester. Round-robin arbitration sets the next-state arbitration pointer to the highest priority requester (calculated by adding a requester's fixed priority to the current bus master's fixed priority and then taking this sum modulo the number of possible bus masters).
- The default priority is M3 (if the USB is present) > DMA (M2) > internal master (M1) > CPU (M0), where M3 is the highest and M0 the lowest priority.
- There are two actions for an idle arbitration cycle, leave the current arbitration pointer as is or set it to the lowest priority requester.
- The anti-lock-out logic for the fixed priority scheme forces the arbitration algorithm to round-robin if any requester has been held for longer than a specified cycle count.

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System Control Module (SCM)

14.6.2 Arbitration Algorithms

There are two modes of arbitration: fixed and round-robin. This section discusses the differences between them.

14.6.2.1 Round-Robin Mode

Round-robin arbitration is the default mode after reset. This scheme cycles through the sequence of masters as specified by MPARK[Mn_PRTY] bits. Upon completion of a transfer, the master is given the lowest priority and the priority for all other masters is increased by one.

```
M3=TBD M2 =01 M1 = 10 M0 = 00

next +1 M3=TBD M2 =10 M1 = 11 M0 = 01

next +2 M3=TBD M2 =11 M1 = 00 M0 = 10

next +3 M3=TBD M2 =00 M1 = 01 M0 = 11
```

If no masters are requesting, the arbitration unit must park, pointing at one of the masters. There are two possibilities: park the arbitration unit on the last active master or park pointing to the highest priority master. Setting MPARK[PRK_LAST] causes the arbitration pointer to be parked on the highest priority master. In round-robin mode, programming the timeout enable and lockout bits MPARK[13,11:8] has no effect on the arbitration.

14.6.2.2 Fixed Mode

In fixed arbitration, the master with highest priority (as specified by the MPARK[Mn_PRTY] bits) wins the bus. That master relinquishes the bus when all transfers to that master are complete.

If MPARK[TIMEOUT] is set, a counter increments for each master for every cycle it is denied access. When a counter reaches the limit set by MPARK[LCKOUT_TIME], the arbitration algorithm is changed to round-robin arbitration mode until all locks are cleared. The arbitration then returns to fixed mode and the highest priority master is granted the bus.

As in round-robin mode, if no masters are requesting, the arbitration pointer parks on the highest priority master if MPARK[PRK_LAST] is set or parks on the master whose last requested the bus if cleared.

14.6.3 Bus Master Park Register (MPARK)

The MPARK controls the operation of the system bus arbitration module. The platform bus master connections are defined as the following:

- Master 3 (M3): Fact Ethernet Controller
- Master 2 (M2): 4-channel DMA
- Master 1 (M1): USB Controller
- Master 0 (M0): V2 ColdFire Core

The initial state of the master priorities is M3 > M2 > M1 > M0. System software should guarantee that the programmed Mn PRTY fields are unique, otherwise the hardware defaults to the initial-state priorities.



NOTE

The M1_PRTY field should not be set for a priority higher than third (default).

IPSBAR Access: read/write Offset: 0x001C (MPARK) R M2 P **BCR** M3_PRTY M2_PRTY M0_PRTY M1_PRTY _EN 24BIT W Reset R TIME PRK **FIXED** LCKOUT_TIME OUT LAST Reset

Figure 14-7. Default Bus Master Park Register (MPARK)

Table 14-6. MPARK Field Descriptions

| Field | Description |
|------------------|---|
| 31–26 | Reserved, must be cleared. |
| 25 M2_P_EN | DMA bandwidth control enable 0 Disable the use of the DMA's bandwidth control to elevate the priority of its bus requests. 1 Enable the use of the DMA's bandwidth control to elevate the priority of its bus requests. |
| 24 BCR24BIT | Enables the use of 24 bit byte count registers in the DMA module 0 DMA BCRs function as 16 bit counters. 1 DMA BCRs function as 24 bit counters. |
| 23–22 M3_PRTY | Master priority level for master 3 (Fast Ethernet Controller) 00 Fourth (lowest) priority 01 Third priority 10 Second priority 11 First (highest) priority |
| 21–20 M2_PRTY | Master priority level for master 2 (DMA Controller) 00 Fourth (lowest) priority 01 Third priority 10 Second priority 11 First (highest) priority |
| 19–18 M0_PRTY | Master priority level for master 0 (ColdFire Core) 00 Fourth (lowest) priority 01 Third priority 10 Second priority 11 First (highest) priority |
| 17–16 M1_PRTY | Master priority level for master 1 (USB Controller) 00 Fourth (lowest) priority 01 Third priority 10 Second priority 11 First (highest) priorityReserved, must be cleared. |
| 15 | Reserved, must be cleared. |

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System Control Module (SCM)

Table 14-6. MPARK Field Descriptions (continued)

| Field | Description |
|---------------------|--|
| 14 FIXED | Fixed or round robin arbitration O Round robin arbitration 1 Fixed arbitration |
| 13 TIMEOUT | Timeout Enable Disable count for when a master is locked out by other masters. Enable count for when a master is locked out by other masters and allow access when LCKOUT_TIME is reached. |
| 12 PRKLAST | Park on the last active master or highest priority master if no masters are active 0 Park on last active master 1 Park on highest priority master |
| 11-8 LCKOUT_TIME | Lock-out Time. Lock-out time for a master being denied the bus. The lock out time is defined as 2^ LCKOUT_TIME[3:0]. |
| 7–0 | Reserved, must be cleared. |

14.7 System Access Control Unit (SACU)

This section details the functionality of the system access control unit (SACU), which provides the mechanism needed to implement secure bus transactions to the address space mapped to the internal modules.

14.7.1 Overview

The SACU supports the traditional model of two privilege levels: supervisor and user. Typically, memory references with the supervisor attribute have total accessibility to all the resources in the system, while user-mode references cannot access system control and configuration registers. In many systems, the operating system executes in supervisor mode, while application software executes in user mode.

The SACU further partitions the access control functions into two parts: one control register defines the privilege level associated with each bus master, and another set of control registers define the access levels associated with the peripheral modules and memory space.

The SACU's programming model is physically implemented as part of the system control module (SCM) with the actual access control logic included as part of the arbitration controller. Each bus transaction targeted for the IPS space is first checked to see if its privilege rights allow access to the given memory space. If the privilege rights are correct, the access proceeds on the bus. If the privilege rights are insufficient for the targeted memory space, the transfer is immediately aborted and terminated with an exception, and the targeted module is not accessed.

14.7.2 Features

Each bus transfer can be classified by its privilege level and the reference type. The complete set of access types includes the following:

- Supervisor instruction fetch
- Supervisor operand read

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- Supervisor operand write
- User instruction fetch
- User operand read
- User operand write

Instruction fetch accesses are associated with the execute attribute.

While the bus does not implement the concept of reference type (code versus data) and only supports the user/supervisor privilege level, the reference type attribute is supported by the system bus. Accordingly, the access checking associated with privilege level and reference type is performed in the IPS controller using the attributes associated with the reference from the system bus.

The SACU partitions the access control mechanisms into three distinct functions:

- Master privilege register (MPR)
 - Allows each bus master to be assigned a privilege level:
 - Disable the master's user/supervisor attribute and force to user mode access
 - Enable the master's user/supervisor attribute
 - The reset state provides supervisor privilege to the processor core (bus master 0).
 - Input signals allow the non-core bus masters to have their user/supervisor attribute enabled at reset. This is intended to support the concept of a trusted bus master, and also controls the ability of a bus master to modify the register state of any of the SACU control registers; that is, only trusted masters can modify the control registers.
- Peripheral access control registers (PACRs)
 - Provide read/write access rights, supervisor/user privilege levels.
 - Reset state provides supervisor-only read/write access to these modules.
 - Nine 8-bit registers control access to 17 of the on-chip peripheral modules
- Grouped peripheral access control registers (GPACR0, GPACR1)
 - Provide read/write/execute access rights, supervisor/user privilege levels.
 - One single register (GPACR0) controls access to 14 of the on-chip peripheral modules.
 - One register (GPACR1) controls access for IPS reads and writes to the flash module.
 - Reset state provides supervisor-only read/write access to each of these peripheral spaces.

14.7.3 Register Definition

14.7.3.1 Master Privilege Register (MPR)

The MPR specifies the access privilege level associated with each bus master in the platform. The register provides one bit per bus master, where bit 3 corresponds to master 3 (Fast Ethernet controller), bit 2 to master 2 (DMA controller), bit 1 to master 1 (USB controller), and bit 0 to master 0 (ColdFire core).

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System Control Module (SCM)

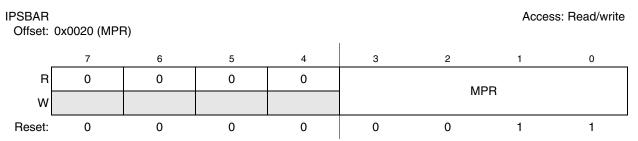


Figure 14-8. Master Privilege Register (MPR)

Table 14-7. MPR[n] Field Descriptions

| Field | Description | |
|------------|---|--|
| 7–4 | Reserved, must be cleared. | |
| 3–0 MPR | Each 1-bit field defines the access privilege level of the given bus master n. O All bus master accesses are in user mode. 1 All bus master accesses use the sourced user/supervisor attribute. | |

Only trusted bus masters can modify the access control registers. If a non-trusted bus master attempts to write any of the SACU control registers, the access is aborted with an error termination and the registers remain unaffected. The processor core is connected to bus master 0 and is always treated as a trusted bus master. Accordingly, MPR[0] is forced to 1 at reset.

Peripheral Access Control Registers (PACR0-PACR10) 14.7.3.2

Access to several on-chip peripherals is controlled by shared peripheral access control registers. A single PACR defines the access level for each of the two modules. These modules only support operand reads and writes. Each PACR follows the format illustrated in Figure 14-9. For a list of PACRs and the modules that they control, refer to Table 14-10.

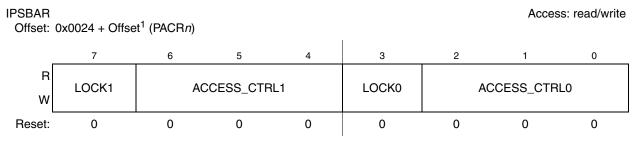


Figure 14-9. Peripheral Access Control Register (PACRn)

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See Table 14-1 for the full list of addresses.



Table 14-8. PACR Field Descriptions

| Field | Description |
|---------------------|--|
| 7 LOCK1 | This bit, when set, prevents subsequent writes to ACCESSCTRL1. Any attempted write to the PACR generates an error termination and the contents of the register are not affected. Only a system reset clears this flag. |
| 6–4 ACCESS_CTRL1 | This 3-bit field defines the access control for the given platform peripheral. The encodings for this field are shown in Table 14-9. |
| 3 LOCK0 | This bit, when set, prevents subsequent writes to ACCESSCTRL0. Any attempted write to the PACR generates an error termination and the contents of the register are not affected. Only a system reset clears this flag. |
| 2-0 ACCESS_CTRL0 | This 3-bit field defines the access control for the given platform peripheral. The encodings for this field are shown in Table 14-9. |

Table 14-9. PACR ACCESSCTRL Bit Encodings

| Bits | Supervisor Mode | User Mode |
|------|-----------------|------------|
| 000 | Read/Write | No Access |
| 001 | Read | No Access |
| 010 | Read | Read |
| 011 | Read | No Access |
| 100 | Read/Write | Read/Write |
| 101 | Read/Write | Read |
| 110 | Read/Write | Read/Write |
| 111 | No Access | No Access |

Table 14-10. Peripheral Access Control Registers (PACRs)

| IPSBAR Offset | Name | Modules Controlled ¹ | |
|---------------|--------|---------------------------------|--------------|
| IPSBAR Oliset | | ACCESS_CTRL1 | ACCESS_CTRL0 |
| 0x024 | PACR0 | SCM | _ |
| 0x025 | PACR1 | _ | DMA |
| 0x026 | PACR2 | UART0 | UART1 |
| 0x027 | PACR3 | UART2 | _ |
| 0x028 | PACR4 | I ² C0 | QSPI |
| 0x029 | PACR5 | I ² C1 | _ |
| 0x02A | PACR6 | DTIM0 | DTIM1 |
| 0x02B | PACR7 | DTIM2 | DTIM3 |
| 0x02C | PACR8 | INTC0 | _ |
| 0x02E | PACR10 | FEC | _ |

A value of "—" in these columns indicates that the bits are not associated with any module and are reserved.

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System Control Module (SCM)

At reset, these on-chip modules have only supervisor read/write access capabilities. If an instruction fetch access to any of these peripheral modules is attempted, the IPS bus cycle is immediately terminated with an error.

14.7.3.3 Grouped Peripheral Access Control Registers (GPACR0 & GPACR1)

The on-chip peripheral space starting at IPSBAR is subdivided into 16 64-Mbyte regions. Each of the first two regions has a unique access control register associated with it. The other 14 regions are in reserved space; the access control registers for these regions are not implemented. Bits [29:26] of the address select the specific GPACRn to be used for a given reference within the IPS address space. These access control registers are 8 bits wide so that read, write, and execute attributes may be assigned to the given IPS region.

NOTE

The access control for modules with memory space protected by PACR0–PACR10 are determined by the PACR0–PACR10 settings. The access control is not affected by GPACR0, even though the modules are mapped in its 64-Mbyte address space.

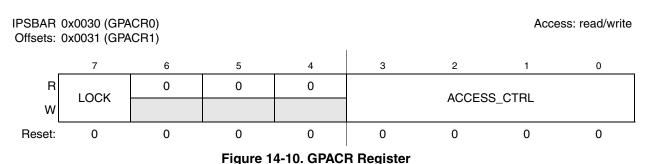


Table 14-11. Grouped Peripheral Access Control Register (GPACR) Field Descriptions

| Field | Description |
|--------------------|--|
| 7 LOCK | This bit, after set, prevents subsequent writes to the GPACR. Any attempted write to the GPACR generates an error termination and the contents of the register are not affected. Only a system reset clears this flag. |
| 6–4 | Reserved, must be cleared. |
| 3–0 ACCESS_CTRL | This 4-bit field defines the access control for the given memory region. The encodings for this field are shown in Table 14-12. |

At reset, these on-chip modules are configured to have only supervisor read/write access capabilities. Bit encodings for the ACCESS_CTRL field in the GPACR are shown in Table 14-12. Table 14-13 shows the memory space protected by the GPACRs and the modules mapped to these spaces.

Table 14-12. GPACR ACCESS_CTRL Bit Encodings

| Bits | Supervisor Mode | User Mode |
|------|-----------------|-----------|
| 0000 | Read / Write | No Access |
| 0001 | Read | No Access |
| 0010 | Read | Read |

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Table 14-12. GPACR ACCESS_CTRL Bit Encodings (continued)

| Bits | Supervisor Mode | User Mode |
|------|------------------------|------------------------|
| 0011 | Read | No Access |
| 0100 | Read / Write | Read / Write |
| 0101 | Read / Write | Read |
| 0110 | Read / Write | Read / Write |
| 0111 | No Access | No Access |
| 1000 | Read / Write / Execute | No Access |
| 1001 | Read / Execute | No Access |
| 1010 | Read / Execute | Read / Execute |
| 1011 | Execute | No Access |
| 1100 | Read / Write / Execute | Read / Write / Execute |
| 1101 | Read / Write / Execute | Read / Execute |
| 1110 | Read / Write | Read |
| 1111 | Read / Write / Execute | Execute |

Table 14-13. GPACR Address Space

| Register | Space Protected (IPSBAR Offset) | Modules Protected | | |
|----------|------------------------------------|--|--|--|
| GPACR0 | 0x0000_0000- 0x03FF_FFFF | Ports, CCM, PMM, Reset controller, Clock, EPORT, WDOG, PIT0–PIT3, QADC, FlexCAN, CFM (Control), etc. | | |
| GPACR1 | 0x0400_0000- 0x07FF_FFFF | CFM (Flash module's backdoor access for programming or access by a bus master other than the core) | | |



Chapter 15 General Purpose I/O Module

15.1 Introduction

Many of the pins associated with the external interface may be used for several different functions. When not used for their primary function, many of the pins may be used as general-purpose digital I/O pins. In some cases, the pin function is set by the operating mode and the alternate pin functions are not supported.

The digital I/O pins are grouped into 8-bit ports. Some ports do not use all 8 bits. Each port has registers that configure, monitor, and control the port pins. Figure 15-1 is a block diagram of the MCF52259 ports.

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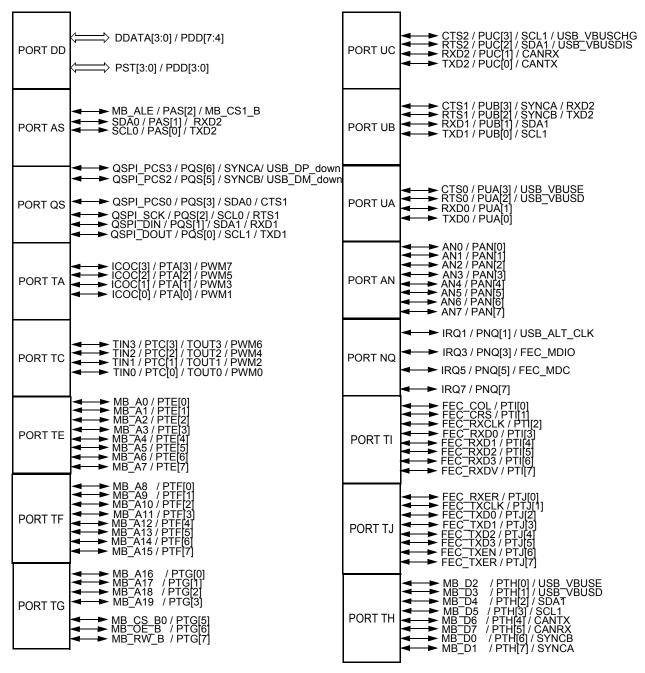


Figure 15-1. General Purpose I/O Module Block Diagram

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15.2 Overview

The MCF52259 ports module controls the configuration for the following external pins:

- External bus accesses
- Chip selects
- Debug data
- Processor status
- USB
- I²C serial control
- QSPI
- UART transmit/receive
- 16-bit timers
- 32-bit DMA timers
- ADC
- Fast Ethernet Controller

15.3 Features

The MCF52259 ports includes these distinctive features:

- Control of primary function use on all ports
- Digital I/O support for all ports; registers for:
 - Storing output pin data
 - Controlling pin data direction
 - Reading current pin state
 - Setting and clearing output pin data registers

15.4 Signal Descriptions

Refer to Chapter 2, "Signal Descriptions," for more detailed information on the different signals and pins.

15.5 Memory Map/Register Definition

15.5.1 Ports Memory Map

Table 15-1 summarizes all the registers in the MCF52259 ports address space.

Table 15-1. Registers in the MCF52259 Ports Address Space

| Offset ¹ | 31–24 | 23–16 | 15–8 | 7–0 | Access ² | | | |
|----------------------------|--------|--------|------|-----|---------------------|--|--|--|
| Port Output Data Registers | | | | | | | | |
| 0x10_0000 | PORTTE | PORTTH | S/U | | | | | |

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Table 15-1. Registers in the MCF52259 Ports Address Space (continued)

| Offset ¹ | 31–24 | 23–16 | 15–8 | 7–0 | Access ² | | | |
|-------------------------------|-------------------------------|------------------|------------------|---------------|---------------------|--|--|--|
| 0x10_0004 | PORTTI | Reserved | PORTTJ | Reserved | S/U | | | |
| 0x10_0008 | PORTNQ | Reserved | PORTAN | PORTAS | S/U | | | |
| 0x10_000C | PORTQS | Reserved | PORTTA | PORTTC | S/U | | | |
| 0x10_0010 | Reserved | PORTUA | PORTUB | PORTUC | S/U | | | |
| 0x10_0014 | PORTDD | Reserved | Reserved | Reserved | S/U | | | |
| | Port Data Direction Registers | | | | | | | |
| 0x10_0018 | DDRTE | DDRTF | DDRTG | DDRTH | S/U | | | |
| 0x10_001C | DDRTI | Reserved | DDRTJ | Reserved | S/U | | | |
| 0x10_0020 | DDRNQ | Reserved | DDRAN | DDRAS | S/U | | | |
| 0x10_0024 | DDRQS | Reserved | DDRTA | DDRTC | S/U | | | |
| 0x10_0028 | Reserved | DDRUA | DDRUB | DDRUC | S/U | | | |
| 0x10_002C | DDRDD | Reserved | Reserved | Reserved | S/U | | | |
| | | Port Pin Data/Se | t Data Registers | | , | | | |
| 0x10_0030 | PORTTEP/SETTE | PORTTFP/SETTF | PORTTGP/SETTG | PORTTHP/SETTH | S/U | | | |
| 0x10_0034 | PORTTIP/SETTI | Reserved | PORTTJP/SETTJ | Reserved | S/U | | | |
| 0x10_0038 | PORTNQP/SETNQ | Reserved | PORTANP/SETAN | PORTASP/SETAS | S/U | | | |
| 0x10_003C | PORTQSP/SETQS | Reserved | PORTTAP/SETTA | PORTTCP/SETTC | S/U | | | |
| 0x10_0040 | Reserved | PORTUAP/SETUA | PORTUBP/SETUB | PORTUCP/SETUC | S/U | | | |
| 0x10_0044 PORTDDP/SETDD Reser | | Reserved | Reserved | Reserved | S/U | | | |
| | | Port Clear Outpu | t Data Registers | | , | | | |
| 0x10_0048 | CLRTE | CLRTF | CLRTG | CLRTH | S/U | | | |
| 0x10_004C | CLRTI | Reserved | CLRTJ | Reserved | S/U | | | |
| 0x10_0050 | CLRNQ | Reserved | CLRAN | CLRAS | S/U | | | |
| 0x10_0054 | CLRQS | Reserved | CLRTA | CLRTC | S/U | | | |
| 0x10_0058 | Reserved | CLRUA | CLRUB | CLRUC | S/U | | | |
| 0x10_005C | CLRDD | Reserved | Reserved | Reserved | S/U | | | |
| | | Port Pin Assign | ment Registers | 1 | | | | |
| 0x10_0060 | PTEPAR | PTFPAR | PTGPAR | Reserved | S/U | | | |
| 0x10_0064 | PTIPAR | Reserved | PTJPAR | Reserved | S/U | | | |
| 0x10_0068 | PNC | PAR | PANPAR | PASPAR | S/U | | | |
| 0x10_006C | PQS | PAR | PTAPAR | PTCPAR | S/U | | | |
| 0x10_0070 | 0_0070 Reserved PUAPAR | | PUBPAR | PUCPAR | S/U | | | |

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Table 15-1. Registers in the MCF52259 Ports Address Space (continued)

| Offset ¹ | 31–24 | 23–16 | 15–8 | 7–0 | Access ² | | |
|---------------------|----------------------------|----------|----------|-----------|---------------------|--|--|
| 0x10_0074 | PDDPAR | Reserved | Reserved | CLKOUTPAR | S/U | | |
| | Port Pad Control Registers | | | | | | |
| 0x10_0078 | | PS | RR | | S/U | | |
| 0x10_007C | | PDSR | | | | | |
| 0x10_0080 | | PSRRL | | | | | |
| 0x10_0084 | Reserved PSRRH | | | | | | |
| 0x10_0088 | | PDSRL | | | | | |
| 0x10_008C | Rese | erved | PDS | SRH | S/U | | |
| 0x10_0090 | PTH | PAR | Rese | erved | S/U | | |

¹ The register address is the sum of the module base address and the base address offset.

15.6 Register Descriptions

15.6.1 Port Output Data Registers (PORT*n*)

The PORTn registers store the data to be driven on the corresponding port n pins when the pins are configured for digital output.

The PORT*n* registers with a full 8-bit implementation are shown in Figure 15-2. The remaining PORT*n* registers use fewer than 8 bits. Their bit definitions are shown in Figure 15-3, Figure 15-4, Figure 15-5, and Figure 15-6. The fields are described in Table 15-2, which applies to all PORT*n* registers.

The PORT*n* registers are read/write. At reset, all bits in the PORT*n* registers are set.

Reading a PORT*n* register returns the current values in the register, not the port *n* pin values.

PORT*n* bits can be set by setting the PORT*n* register, or by setting the corresponding bits in the PORT*n*P/SET*n* register. They can be cleared by clearing the PORT*n* register, or by clearing the corresponding bits in the CLR*n* register.

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² S/U = supervisor or user mode access. User mode accesses to supervisor-only addresses have no effect and cause a cycle termination transfer error.



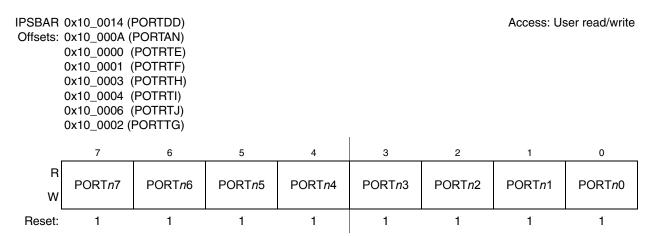


Figure 15-2. Port Output Data Registers with Bits 7:0 Implemented

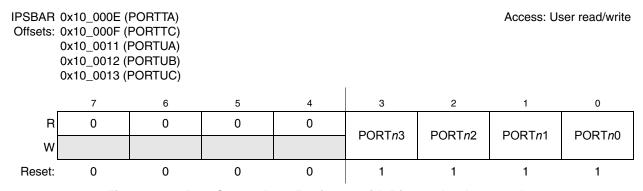


Figure 15-3. Port Output Data Registers with Bits 3:0 Implemented

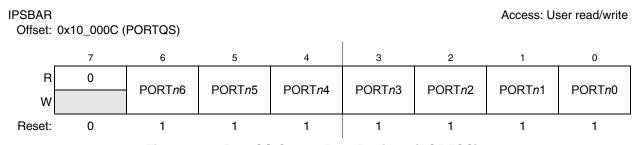


Figure 15-4. Port QS Output Data Register (PORTQS)

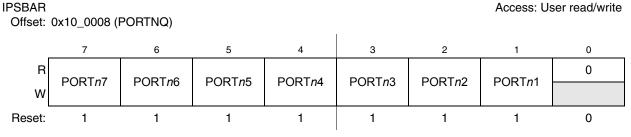


Figure 15-5. Port NQ Output Data Register (PORTNQ)

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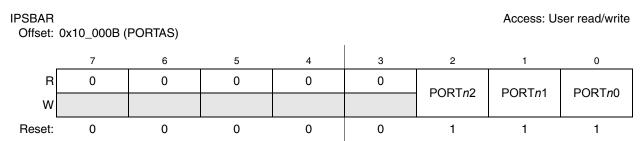


Figure 15-6. Port AS Output Data Register (PORTAS)

Table 15-2. PORTn Field Descriptions

| Field | Description |
|-----------------|--|
| Port <i>n</i> x | Data to be driven when the port pin is configured as a digital output. 1 Output is a logic 1 0 Output is a logic 0 |

15.6.2 Port Data Direction Registers (DDRn)

The DDRn registers control the direction of the port n pin drivers when the pins are configured for digital I/O.

The DDR*n* registers with a full 8-bit implementation are shown in Figure 15-7. The remaining DDR*n* registers use fewer than eight bits. Their bit definitions are shown in Figure 15-8, Figure 15-9, Figure 15-10, and Figure 15-11. The fields are described in Table 15-3, which applies to all DDR*n* registers.

The DDR*n* registers are read/write. At reset, all bits in the DDR*n* registers are cleared.

Setting any bit in a DDRn register configures the corresponding port n pin as an output. Clearing any bit in a DDRn register configures the corresponding pin as an input.

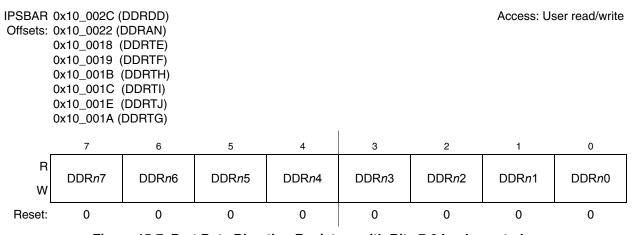


Figure 15-7. Port Data Direction Registers with Bits 7:0 Implemented

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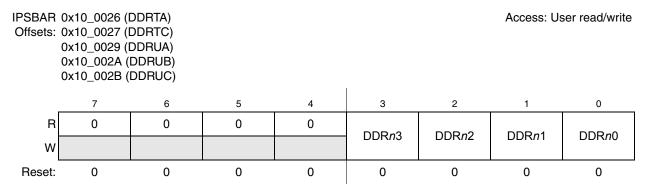


Figure 15-8. Port Data Direction Registers with Bits 3:0 Implemented

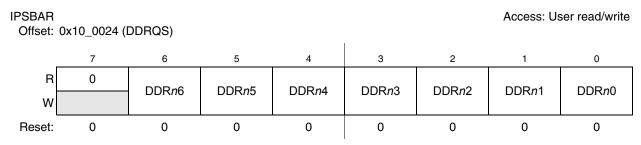


Figure 15-9. Port QS Data Direction Register (DDRQS)

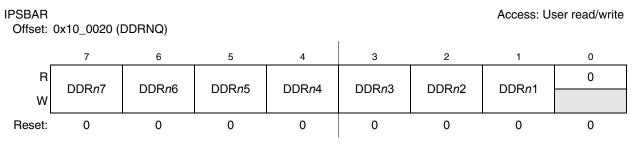


Figure 15-10. Port NQ Data Direction Register (DDRNQ)

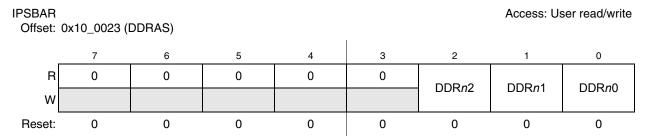


Figure 15-11. Port AS Data Direction Register (DDRAS)

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Table 15-3. DDRn Field Descriptions

| Field | Description | | | |
|----------------|--|--|--|--|
| DDR <i>n</i> x | Sets data direction for port <i>nx</i> pin when the port is configured as a digital output. 1 DDR <i>nx</i> is configured as an output 0 DDR <i>nx</i> is configured as an input | | | |

15.6.3 Port Pin Data/Set Data Registers (PORTnP/SETn)

The PORTnP/SETn registers reflect the current pin states and control the setting of output pins when the pin is configured for digital I/O.

The PORT*n*P/SET*n* registers with a full 8-bit implementation are shown in Figure 15-12. The remaining PORT*n*P/SET*n* registers use fewer than eight bits. Their bit definitions are shown in Figure 15-13, Figure 15-14, Figure 15-15, and Figure 15-16. The fields are described in Table 15-4, which applies to all PORT*n*P/SET*n* registers.

The PORTnP/SETn registers are read/write. At reset, the bits in the PORTnP/SETn registers are set to the current pin states.

Reading a PORT*n*P/SET*n* register returns the current state of the port *n* pins.

Writing 1s to a PORT*n*P/SET*n* register sets the corresponding bits in the PORT*n* register. Writing 0s has no effect.

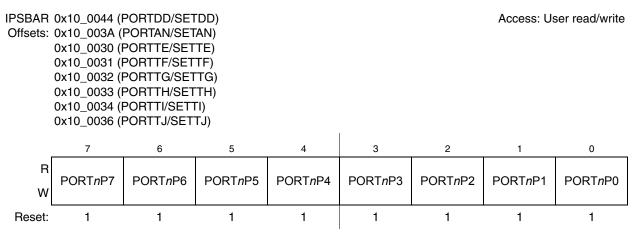


Figure 15-12. Port Pin Data/Set Data Registers with Bits 7:0 Implemented

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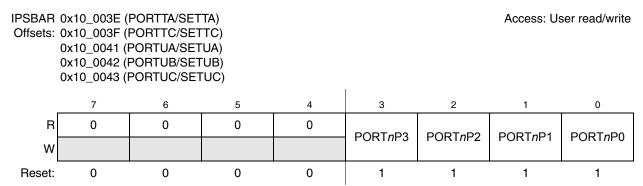


Figure 15-13. Port Pin Data/Set Data Registers with Bits 3:0 Implemented

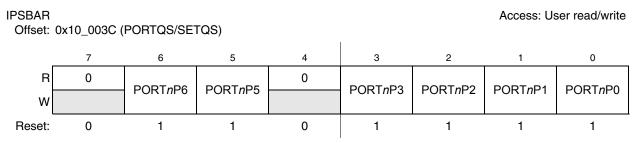


Figure 15-14. Port QS Pin Data/Set Data Register (PORTQS/SETQS)

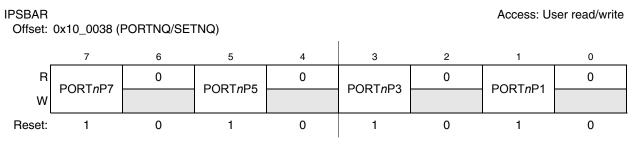


Figure 15-15. Port NQ Pin Data/Set Data Register (PORTNQ/SETNQ)

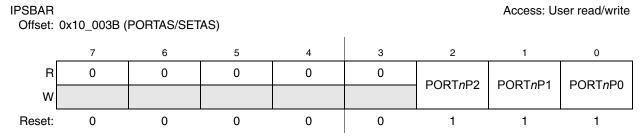


Figure 15-16. Port AS Pin Data/Set Data Register (PORTAS/SETAS)

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Table 15-4. PORTn/SETn Field Descriptions

| Field | Description | |
|------------------|---|--|
| Port <i>n</i> Px | Port <i>n</i> x pin data/set data bits. 1 Port <i>n</i> Px pin state is 1 (read); writing a 1 sets the corresponding port <i>n</i> x bit to 1 0 Port <i>n</i> Px pin state is 0 | |

15.6.4 Port Clear Output Data Registers (CLR*n*)

Writing 0s to a CLR*n* register clears the corresponding bits in the PORT*n* register. Writing 1s has no effect. Reading the CLR*n* register returns 0s.

The CLR*n* registers with a full 8-bit implementation are shown in Figure 15-17. The remaining DDR*n* registers use fewer than eight bits. Their bit definitions are shown in Figure 15-18, Figure 15-19, Figure 15-20, and Figure 15-21. The fields are described in Table 15-5, which applies to all CLR*n* registers.

The CLR*n* registers are read/write.

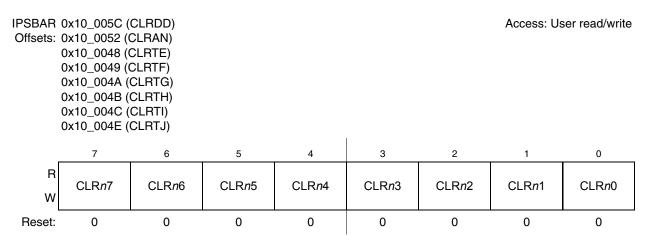


Figure 15-17. Port Clear Output Data Registers with Bits 7:0 Implemented

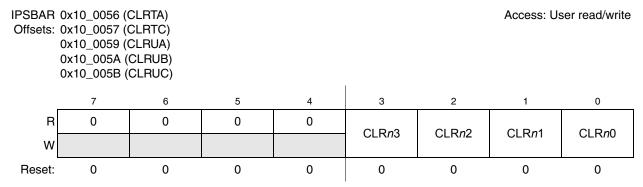


Figure 15-18. Port Clear Output Data Registers with Bits 3:0 Implemented

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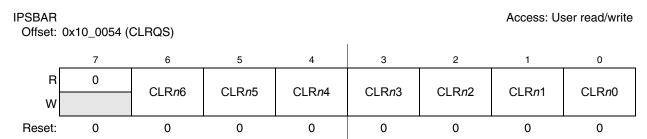


Figure 15-19. Port QS Clear Output Data Register (CLRQS)

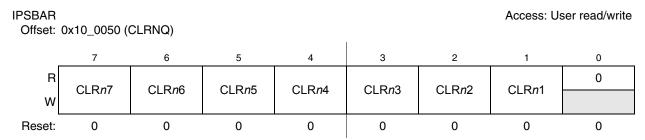


Figure 15-20. Port NQ Clear Output Data Register (CLRNQ)

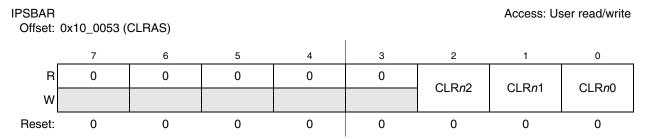


Figure 15-21. Port AS Clear Output Data Register (CLRAS)

Table 15-5. CLRn Field Descriptions

| Field | Description | | | |
|----------------|---|--|--|--|
| CLR <i>n</i> x | Port <i>n</i> x pin data/set data bits. 1 Never returned for reads; no effect for writes 0 Always returned for reads; clears corresponding port <i>n</i> x bit for writes | | | |

15.6.5 Pin Assignment Registers

All pin assignment registers are read/write. Refer to Table 2-1 for the different functions assignable to each pin.

Some signals can be assigned to different pins (see Table 2-1). However, a signal should not be assigned to more than one pin at the same time. If a signal is assigned to two or more pins simultaneously, the result is undefined.

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15.6.5.1 **Dual-Function Pin Assignment Registers**

The dual function pin assignment registers allow each pin controlled by each register bit to be configured for the primary function or the GPIO function. The fields are described in Table 15-6, which applies to all dual-function registers.

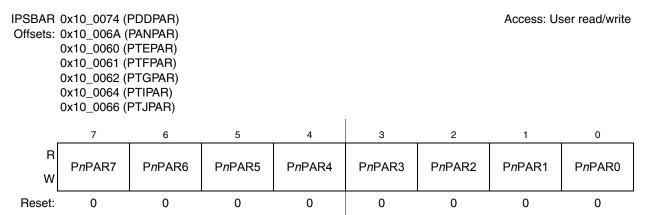


Figure 15-22. Dual-Function Pin Assignment Registers with Bits 7:0 Implemented

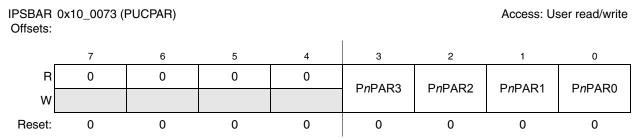


Figure 15-23. Dual-Function Pin Assignment Registers with Bits 3:0 Implemented (PTDPAR, PUCPAR)

Table 15-6. Dual-Function PnPAR Field Descriptions

| Field | Description |
|-------|--|
| | PnPARx pin assignment register bits. 1 Pin assumes the primary function 0 Pin assumes the GPIO function |

15.6.5.2 **Quad Function Pin Assignment Registers**

The quad function pin assignment registers allow each pin controlled by each register bit to be configured for the primary, alternate 1 (secondary), alternate 2 (tertiary), and GPIO (quaternary) functions. The fields are described in Table 15-7, which applies to all quad-function registers.



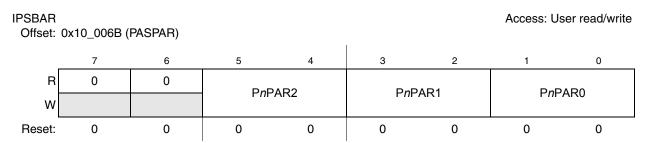


Figure 15-24. Port AS Pin Assignment Register (PASPAR)

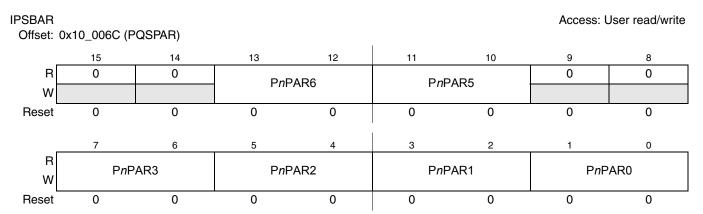


Figure 15-25. Port QS Pin Assignment Register

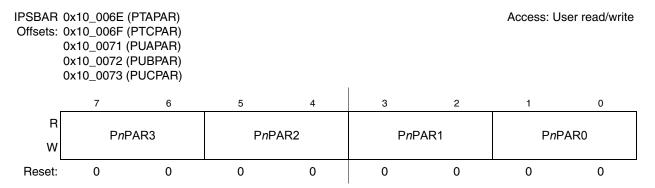


Figure 15-26. Quad-Function Pin Assignment Registers with Bits 7:0 Implemented

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IPSBAR Access: User read/write Offset: 0x10_0090 (PTHPAR) 13 12 10 8 R PnPAR7 PnPAR6 PnPAR5 PnPAR4 W 0 0 0 0 0 0 0 0 Reset 0 R PnPAR3 PnPAR2 PnPAR1 PnPAR0 W 0 0 0 Reset 0

Figure 15-27. Port TH Pin Assignment Register

Table 15-7. Quad-Function PnPAR Field Descriptions

| Field | Description |
|-----------------|---|
| P <i>n</i> PARx | PnPARx pin assignment register bits. 00 Pin assumes the GPIO function 01 Pin assumes the primary function 10 Pin assumes the alternate 1 function 11 Pin assumes the alternate 2 function |

IPSBAR Access: User read/write Offset: 0x10_0077 (CLKOUTPAR) 7 2 0 6 5 4 3 0 0 0 R 0 0 0 **CLKOUTPAR** 0 Reset: 0 0 0

Table 15-8. Quad-Function CLKOUTPAR Field Descriptions

Figure 15-28. Clkout Pin Assignment Register (CLKOUTPAR)

| Field | Description | | | | | | |
|-----------|--|--|--|--|--|--|--|
| CLKOUTPAR | OUTPAR pin assignment register bits. Reserved SYSCLK Reserved SYSCLK/2 | | | | | | |

15.6.5.3 Port NQ Pin Assignment Register (PNQPAR)

The port NQ pin assignment register (PNQPAR) contains quad-function (for $\overline{IRQ1}$) and dual-function pin assignment controls. Refer to Table 15-6 and Table 15-7 for the encodings for the different fields. The reset value of the PNQPAR register defaults to the primary function (\overline{IRQ}) instead of GPIO.

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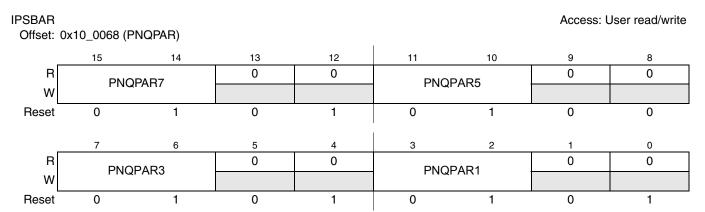


Figure 15-29. Port NQ Pin Assignment Register (PNQPAR)

Pad Control Registers 15.6.6

Pin Slew Rate Register (PSRR) 15.6.6.1

The pin slew rate register (PSRR) is read/write. Each bit resets to logic 0 in Single Chip mode (MCF52259 default) and logic 1 in EzPort and FAST mode. The fields are described in Table 15-9.

The slew rate control bits corresponding to each pin/signal are listed in Table 2-1.

| IPSBAR Offset: 0 | PSBAR Offset: 0x10_0078 (PSRR) Access: User read/write | | | | | | | |
|---------------------|--|--------|--------|--------|--------|--------|--------|--------|
| _ | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 |
| R W | PSRR31 | PSRR30 | PSRR29 | PSRR28 | PSRR27 | PSRR26 | PSRR25 | PSRR24 |
| Reset | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| _ | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
| R W | PSRR23 | PSRR22 | PSRR21 | PSRR20 | PSRR19 | PSRR18 | PSRR17 | PSRR16 |
| Reset | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| _ | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| R W | PSRR15 | PSRR14 | PSRR13 | PSRR12 | PSRR11 | PSRR10 | PSRR9 | PSRR8 |
| Reset | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| _ | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| R W | PSRR7 | PSRR6 | PSRR5 | PSRR4 | PSRR3 | PSRR2 | PSRR1 | PSRR0 |
| Reset | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Figure 15-30. Pin Slew Rate Register (PSRR)

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IPSBAR Access: User read/write

Offset: 0x10_0080 (PSRRL)

| | • | * | | | | | | |
|--------|---------|---------|---------|---------|---------|---------|---------|---------|
| _ | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 |
| R W | PSRRL31 | PSRRL30 | PSRRL29 | PSRRL28 | PSRRL27 | PSRRL26 | PSRRL25 | PSRRL24 |
| Reset | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | | | | | ' | | | |
| - | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
| R W | PSRRL23 | PSRRL22 | PSRRL21 | PSRRL20 | PSRRL19 | PSRRL18 | PSRRL17 | PSRRL16 |
| Reset | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | | | | | I I | | | |
| _ | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| R W | PSRRL15 | PSRRL14 | PSRRL13 | PSRRL12 | PSRRL11 | PSRRL10 | PSRRL9 | PSRRL8 |
| Reset | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | | | | | 1 | | | |
| _ | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| R W | PSRRL7 | PSRRL6 | PSRRL5 | PSRRL4 | PSRRL3 | PSRRL2 | PSRRL1 | PSRRL0 |
| Reset | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Figure 15-31. Pin Slew Rate Register Low (PSRRL)

IPSBAR Access: User read/write

Offset: 0x10_0086 (PSRRH)

| _ | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
|--------|---------|---------|---------|---------|---------|---------|--------|--------|
| R W | PSRRH15 | PSRRH14 | PSRRH13 | PSRRH12 | PSRRH11 | PSRRH10 | PSRRH9 | PSRRH8 |
| Reset | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | | | | | ! | | | |
| _ | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| R W | PSRRH7 | PSRRH6 | PSRRH5 | PSRRH4 | PSRRH3 | PSRRH2 | PSRRH1 | PSRRH0 |
| Reset | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Figure 15-32. Pin Slew Rate Register High (PSRRH)

Table 15-9. PSRR Field Descriptions

| Field | Description |
|-------|---|
| PSRRx | PSRRx slew rate register control bits. 1 Pin is configured for slow slew rate (delay is approximately 10 times slower) 0 Pin is configured for fast slew rate |

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15.6.6.2 Pin Drive Strength Register (PDSR)

The pin drive strength register is read/write. Each bit resets to logic 0 in single chip mode (MCF52259 default) and logic 1 in EzPort and FAST mode. The fields are described in Table 15-10.

Refer to Table 2-1 for details of which PDSR bit controls which pin.

| IPSBAR Offset: 0 |)x10_007C (P | DSR) | | | | | Access: \ | Jser read/write |
|---------------------|--------------|--------|--------|--------|--------|--------|-----------|-----------------|
| _ | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 |
| R W | PDSR31 | PDSR30 | PDSR29 | PDSR28 | PDSR27 | PDSR26 | PDSR25 | PDSR24 |
| Reset | | | | See r | note 1 | | | |
| | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
| R W | PDSR23 | PDSR22 | PDSR21 | PDSR20 | PDSR19 | PDSR18 | PDSR17 | PDSR16 |
| Reset | | | | See r | ote 1 | | | |
| | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| R W | PDSR15 | PDSR14 | PDSR13 | PDSR12 | PDSR11 | PDSR10 | PDSR9 | PDSR8 |
| Reset | | | | See r | note 1 | | | |
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| R W | PDSR7 | PDSR6 | PDSR5 | PDSR4 | PDSR3 | PDSR2 | PDSR1 | PDSR0 |
| Reset | | | | See r | note 1 | - | | |

¹⁾Each bit resets to logic 0 in single chip mode and logic 1 in EzPort mode.

Figure 15-33. Pin Drive Strength Register (PDSR)



| IPSBAR Offset: (| 0x10_0088 (P | DSRL) | | | | | Access: U | Jser read/write |
|---------------------|--------------|---------|---------|---------|---------|---------|-----------|-----------------|
| _ | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 |
| R W | PDSRL31 | PDSRL30 | PDSRL29 | PDSRL28 | PDSRL27 | PDSRL26 | PDSRL25 | PDSRL24 |
| Reset | | | | See r | note 1 | | | |
| _ | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
| R W | PDSRL23 | PDSRL22 | PDSRL21 | PDSRL20 | PDSRL19 | PDSRL18 | PDSRL17 | PDSRL16 |
| Reset | | | | See r | note 1 | | | |
| _ | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| R W | PDSRL15 | PDSRL14 | PDSRL13 | PDSRL12 | PDSRL11 | PDSRL10 | PDSRL9 | PDSRL8 |
| Reset | | | | See r | note 1 | | | |
| _ | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| R W | PDSRL7 | PDSRL6 | PDSRL5 | PDSRL4 | PDSRL3 | PDSRL2 | PDSRL1 | PDSRL0 |
| Reset | | | | See r | note 1 | | | |

¹⁾Each bit resets to logic 0 in single chip mode and logic 1 in EzPort mode.

Figure 15-34. Pin Drive Strength Register Low (PDSRL)

| IPSBAR | 0.40 000E (D | DODII) | | | | | Access: L | Jser read/write |
|---------|--------------|---------|---------|---------|---------|---------|-----------|-----------------|
| Offset: | 0x10_008E (P | DSRH) | | | | | | |
| _ | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| R W | PDSRH15 | PDSRH14 | PDSRH13 | PDSRH12 | PDSRH11 | PDSRH10 | PDSRH9 | PDSRH8 |
| Reset | See note 1 | | | | | | | |
| | | | | | I | | | |
| _ | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| R W | PDSRH7 | PDSR6H | PDSRH5 | PDSRH4 | PDSRH3 | PDSRH2 | PDSRH1 | PDSRH0 |
| Reset | | | | See r | note 1 | | | |

¹⁾Each bit resets to logic 0 in single chip mode and logic 1 in EzPort mode.

Figure 15-35. Pin Drive Strength Register High (PDSRH)

Table 15-10. PDSR Field Descriptions

| Field | Description |
|-------|---|
| PDSRx | PDSRx pin strength register control bits. 1 Pin is configured for high drive strength (10mA) 0 Pin is configured for low drive strength (2mA) |

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15.7 Ports Interrupts

The ports module does not generate interrupt requests.



Chapter 16 Interrupt Controller Module

This section details the functionality for the interrupt controller. The general features of the interrupt controller include:

- Interrupt sources
 - 119 fully-programmable interrupt sources (of which some are reserved)
 - 7 fixed-level interrupt sources
- Each of the sources has a unique interrupt control register (ICR*nx*) to define the software-assigned levels and priorities within the level
- Unique vector number for each interrupt source
- Ability to mask any individual interrupt source, plus global mask-all capability
- Supports hardware and software interrupt acknowledge cycles
- Wake-up signal from low-power stop modes

The 50 fully-programmable and seven fixed-level interrupt sources for the interrupt controller manage the complete set of interrupt sources from all of the modules on the device. This section describes how the interrupt sources are mapped to the interrupt controller logic and how interrupts are serviced.

16.1 68K/ColdFire Interrupt Architecture Overview

Before continuing with the specifics of the interrupt controller, a brief review of the interrupt architecture of the 68K/ColdFire family is appropriate.

The interrupt architecture of ColdFire is exactly the same as the M68000 family, where there is a 3-bit encoded interrupt priority level sent from the interrupt controller to the core, providing 7 levels of interrupt requests. Level 7 represents the highest priority interrupt level, while level 1 is the lowest priority. The processor samples for active interrupt requests once per instruction by comparing the encoded priority level against a 3-bit interrupt mask value (I) contained in bits 10:8 of the core's status register (SR). If the priority level is greater than the SR[I] field at the sample point, the processor suspends normal instruction execution and initiates interrupt exception processing. Level 7 interrupts are treated as non-maskable and edge-sensitive within the processor, while levels 1–6 are treated as level-sensitive and may be masked depending on the value of the SR[I] field. For correct operation, ColdFire requires that the interrupt source, after asserted, remains asserted until explicitly disabled by the interrupt service routine.

During the interrupt exception processing, the CPU enters supervisor mode, disables trace mode, and then fetches an 8-bit vector from the interrupt controller. This byte-sized operand fetch is known as the interrupt acknowledge (IACK) cycle, with the ColdFire implementation using a special encoding of the transfer type and transfer modifier attributes to distinguish this data fetch from a normal memory access. The fetched data provides an index into the exception vector table, which contains 256 addresses, each pointing



to the beginning of a specific exception service routine. In particular, vectors 64–255 of the exception vector table are reserved for user interrupt service routines. The first 64 exception vectors are reserved for the processor to manage reset, error conditions (access, address), arithmetic faults, system calls, etc. After the interrupt vector number has been retrieved, the processor continues by creating a stack frame in memory. For ColdFire, all exception stack frames are 2 longwords in length and contain 32 bits of vector and status register data, along with the 32-bit program counter value of the instruction that was interrupted (see Section 3.3.3.1, "Exception Stack Frame Definition," for more information on the stack frame format).

After the exception stack frame is stored in memory, the processor accesses the 32-bit pointer from the exception vector table using the vector number as the offset, and then jumps to that address to begin execution of the service routine. After the status register is stored in the exception stack frame, the SR[I] mask field is set to the level of the interrupt being acknowledged, effectively masking that level and all lower values while in the service routine.

For this device, the processing of the interrupt acknowledge cycle is fundamentally different than previous 68K/ColdFire cores. In the new approach, all IACK cycles are directly managed by the interrupt controller, so the requesting peripheral device is not accessed during IACK. As a result, the interrupt request must be explicitly cleared in the peripheral during the interrupt service routine. For more information, see Section 16.1.1.3, "Interrupt Vector Determination."

Unlike the M68000 family, all ColdFire processors guarantee that the first instruction of the service routine is executed before sampling for interrupts is resumed. By making this initial instruction a load of the SR, interrupts can be safely disabled if required.

During the execution of the service routine, the appropriate actions must be performed on the peripheral to negate the interrupt request.

For more information on exception processing, perform a keyword search at http://www.freescale.com/coldfire for "CFPRM," then click the CFPRM: ColdFire Family Programmer's Reference Manual link in the list of search results.

16.1.1 Interrupt Controller Theory of Operation

To support the interrupt architecture of the 68K/ColdFire programming model, the combined 63 interrupt sources are organized as 7 levels, with each level supporting up to 9 prioritized requests. Consider the priority structure within a single interrupt level (from highest to lowest priority) as shown in Table 16-1.

Interrupt ICR[2:0] **Priority Sources** 7 (Highest) 111 8-63 110 6 8-63 101 5 8-63 8-63 100 Fixed Midpoint Priority 1-7

Table 16-1. Interrupt Priority Within a Level

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| ICR[2:0] | Priority | Interrupt Sources |
|----------|------------|----------------------|
| 011 | 3 | 8–63 |
| 010 | 2 | 8–63 |
| 001 | 1 | 8–63 |
| 000 | 0 (Lowest) | 8–63 |

Table 16-1. Interrupt Priority Within a Level (continued)

The level and priority is fully programmable for all sources except interrupt sources 1–7. Interrupt source 1–7 (from the edge port module) are fixed at the corresponding level's midpoint priority. Thus, a maximum of 8 fully-programmable interrupt sources are mapped into a single interrupt level. The fixed interrupt source is hardwired to the given level and represents the mid-point of the priority within the level. For the fully-programmable interrupt sources, the 3-bit level and the 3-bit priority within the level are defined in the 8-bit interrupt control register (ICR*nx*).

The operation of the interrupt controller can be broadly partitioned into three activities:

- Recognition
- Prioritization
- Vector determination during IACK

16.1.1.1 Interrupt Recognition

The interrupt controller continuously examines the request sources and the interrupt mask register to determine if there are active requests. This is the recognition phase.

16.1.1.2 Interrupt Prioritization

As an active request is detected, it is translated into the programmed interrupt level, and the resulting 7-bit decoded priority level (IRQ[7:1]) is driven out of the interrupt controller.

16.1.1.3 Interrupt Vector Determination

After the core has sampled for pending interrupts and begun interrupt exception processing, it generates an interrupt acknowledge (IACK) cycle. The IACK transfer is treated as a memory-mapped byte read by the processor and routed to the appropriate interrupt controller. Next, the interrupt controller extracts the level being acknowledged from address bits 4:2, determines the highest priority interrupt request active for that level, and returns the 8-bit interrupt vector for that request to complete the cycle. The 8-bit interrupt vector is formed using the following algorithm:

```
For INTCO,
                        vector number = 64 + interrupt source number
                        vector number = 128 + interrupt source number
For INTC1,
```

Recall that vector numbers 0–63 are reserved for the ColdFire processor and its internal exceptions. Thus, the mapping of bit positions to vector numbers is as follows:

```
if interrupt source 1 is active and acknowledged,
                                                         then Vector number = 65
```

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```
if interrupt source 2 is active and acknowledged, then Vector number = 66
...
if interrupt source 8 is active and acknowledged, then Vector number = 72
if interrupt source 9 is active and acknowledged, then Vector number = 73
...
if interrupt source 62 is active and acknowledged, then Vector number = 126
```

The net effect is a fixed mapping between the bit position within the source to the actual interrupt vector number.

If there is no active interrupt source for the given level, a special spurious interrupt vector (vector number = 24) is returned. It is the responsibility of the service routine to manage this error situation.

This protocol implies the interrupting peripheral is not accessed during the acknowledge cycle because the interrupt controller completely services the acknowledge. This means the interrupt source must be explicitly disabled in the interrupt service routine. This design provides unique vector capability for all interrupt requests, regardless of the complexity of the peripheral device.

16.2 Memory Map

The register programming model for the interrupt controllers is memory-mapped to a 256-byte space. In the following discussion, there are a number of program-visible registers greater than 32 bits. For these control fields, the physical register is partitioned into two 32-bit values: a register high (the upper longword, represented by an appended H) and a register low (the lower longword, represented by an appended L).

The registers and their locations are defined in Table 16-3. The register names include the (zero-based) interrupt controller number n, which is useful in devices with multiple controllers. This device has two interrupt controllers; hence, n = 1.

| Interrupt Controller Number | Base Address |
|--|----------------|
| INTC0 | IPSBAR + 0xC00 |
| INTC1 | IPSBAR + 0xD00 |
| Global IACK Registers Space ¹ | IPSBAR + 0xF00 |

Table 16-2. Interrupt Controller Base Addresses

This address space only contains the L1ACK-L7IACK registers. See Section 16.3.7, "Software and Level m IACK Registers (SWIACKn, LmIACKn)" for more information

| Table 16-3. Interrup | Controller | Memory | Мар |
|----------------------|------------|--------|-----|
|----------------------|------------|--------|-----|

| Address | Register | | Access | Reset Value | Section/ Page | | |
|-----------|---|----|--------|-------------|------------------|--|--|
| | Interrupt Controller 0 | | | | | | |
| 0x00_0C00 | Interrupt Pending Register High (IPRH0) | 32 | R | 0x0000_0000 | 16.3.1/16-6 | | |
| 0x00_0C04 | Interrupt Pending Register Low (IPRL0) | 32 | R | 0x0000_0000 | 16.3.1/16-6 | | |

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Table 16-3. Interrupt Controller Memory Map (continued)

| Address Register Width Access Reset Value Section/ | | | | | |
|--|--|--------|--------|-------------|--------------|
| Address | negistei | (bits) | Access | neset value | Page |
| 0x00_0C08 | Interrupt Mask Register High (IMRH0) | 32 | R/W | 0xFFFF_FFFF | 16.3.2/16-7 |
| 0x00_0C0C | Interrupt Mask Register Low (IMRL0) | 32 | R/W | 0xFFFF_FFFF | 16.3.2/16-7 |
| 0x00_0C10 | Interrupt Force Register High (INTFRCH0) | 32 | R/W | 0x0000_0000 | 16.3.3/16-8 |
| 0x00_0C14 | Interrupt Force Register Low (INTFRCL0) | 32 | R/W | 0x0000_0000 | 16.3.3/16-8 |
| 0x00_0C18 | Interrupt Request Level Register (IRLR0) | 8 | R/W | 0x00 | 16.3.4/16-9 |
| 0x00_0C19 | Interrupt Acknowledge Level and Priority Register (IACKLPR0) | 8 | W | 0x00 | 16.3.5/16-9 |
| 0x00_0C40 + n (n=0:63) | Interrupt Control Registers (ICR0n) | 8 | W | 0x00 | 16.3.6/16-10 |
| 0x00_0CE0 | Software Interrupt Acknowledge (SWIACK0) | 8 | R | 0x00 | 16.3.7/16-11 |
| 0x00_0CE0 + 4 <i>n</i> (<i>n</i> =1:7) | Level <i>m</i> Interrupt Acknowledge Registers (L <i>m</i> IACK0) | 8 | R | 0x00 | 16.3.7/16-11 |
| | Interrupt Controller 1 | | | | |
| 0x00_0D00 | Interrupt Pending Register High (IPRH1) | 32 | R | 0x0000_0000 | 16.3.1/16-6 |
| 0x00_0D04 | Interrupt Pending Register Low (IPRL1) | 32 | R | 0x0000_0000 | 16.3.1/16-6 |
| 0x00_0D08 | Interrupt Mask Register High (IMRH1) | 32 | R/W | 0xFFFF_FFFF | 16.3.2/16-7 |
| 0x00_0D0C | Interrupt Mask Register Low (IMRL1) | 32 | R/W | 0xFFFF_FFFF | 16.3.2/16-7 |
| 0x00_0D10 | Interrupt Force Register High (INTFRCH1) | 32 | R/W | 0x0000_0000 | 16.3.3/16-8 |
| 0x00_0D14 | Interrupt Force Register Low (INTFRCL1) | 32 | R/W | 0x0000_0000 | 16.3.3/16-8 |
| 0x00_0D18 | Interrupt Request Level Register (IRLR1) | 8 | R/W | 0x00 | 16.3.4/16-9 |
| 0x00_0D19 | Interrupt Acknowledge Level and Priority Register (IACKLPR1) | 8 | W | 0x00 | 16.3.5/16-9 |
| 0x00_0D40 + n (n=0:63) | Interrupt Control Registers (ICR1n) | 8 | W | 0x00 | 16.3.6/16-10 |
| 0x00_0DE0 | Software Interrupt Acknowledge (SWIACK1) | 8 | R | 0x00 | 16.3.7/16-11 |
| 0x00_0DE0 + 4 <i>n</i> (<i>n</i> =1:7) | Level <i>m</i> Interrupt Acknowledge Registers (L <i>m</i> IACK1) | 8 | R | 0x00 | 16.3.7/16-11 |
| | Global IACK Registers | • | | | |
| 0x00_0F0E0 + 4 <i>n</i> (<i>n</i> =1:7) | Global Level <i>m</i> Interrupt Acknowledge Registers (GL <i>m</i> IACK) | 8 | R | 0x00 | 16.3.8/16-12 |

16.3 Register Descriptions

The interrupt controller registers are described in the following sections.

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16.3.1 Interrupt Pending Registers (IPRH*n*, IPRL*n*)

The IPRHn and IPRLn registers, Figure 16-1 and Figure 16-2, each 32 bits, provide a bit map for each interrupt request to indicate if there is an active request (1 = active request, 0 = no request) for the given source. The state of the interrupt mask register does not affect the IPRn. The IPRn is cleared by reset. The IPRn is a read-only register, so any attempted write to this register is ignored. Bit 0 is not implemented and reads as a zero.

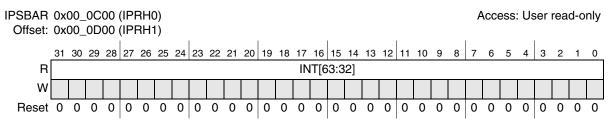


Figure 16-1. Interrupt Pending Register High (IPRHn)

Table 16-4. IPRHn Field Descriptions

| Field | Description |
|-------------|---|
| 31–0 INT | Interrupt pending. Each bit corresponds to an interrupt source. The corresponding IMRH <i>n</i> bit determines whether an interrupt condition can generate an interrupt. At every system clock, the IPRH <i>n</i> samples the signal generated by the interrupting source. The corresponding IPRH <i>n</i> bit reflects the state of the interrupt signal even if the corresponding IMRH <i>n</i> bit is set. O The corresponding interrupt source does not have an interrupt pending 1 The corresponding interrupt source has an interrupt pending |

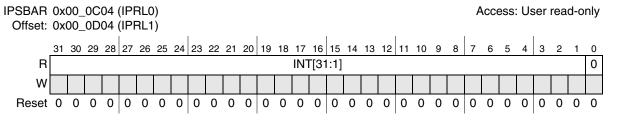


Figure 16-2. Interrupt Pending Register Low (IPRLn)

Table 16-5. IPRLn Field Descriptions

| Field | Description |
|-------------|---|
| 31–1 INT | Interrupt Pending. Each bit corresponds to an interrupt source. The corresponding IMRLn bit determines whether an interrupt condition can generate an interrupt. At every system clock, the IPRLn samples the signal generated by the interrupting source. The corresponding IPRLn bit reflects the state of the interrupt signal even if the corresponding IMRLn bit is set. 0 The corresponding interrupt source does not have an interrupt pending 1 The corresponding interrupt source has an interrupt pending |
| 0 | Reserved, must be cleared. |



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Interrupt Mask Registers (IMRHn, IMRLn) 16.3.2

The IMRH*n* and IMRL*n* registers are each 32 bits and provide a bit map for each interrupt to allow the request to be disabled (1 = disable the request, 0 = enable the request). The IMRn is set to all ones by reset, disabling all interrupt requests. The IMRn can be read and written. A write that sets bit 0 of the IMRLn forces the other 63 bits to be set, disabling all interrupt sources, and providing a global mask-all capability.

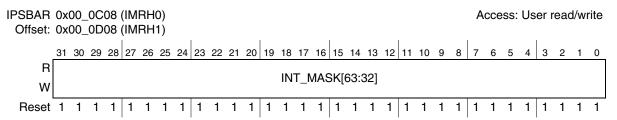


Figure 16-3. Interrupt Mask Register High (IMRHn)

Table 16-6. IMRHn Field Descriptions

| Field | Description |
|------------------|--|
| 31-0 INT_MASK | Interrupt mask. Each bit corresponds to an interrupt source. The corresponding IMRH <i>n</i> bit determines whether an interrupt condition can generate an interrupt. The corresponding IPRH <i>n</i> bit reflects the state of the interrupt signal even if the corresponding IMRH <i>n</i> bit is set. 0 The corresponding interrupt source is not masked 1 The corresponding interrupt source is masked |

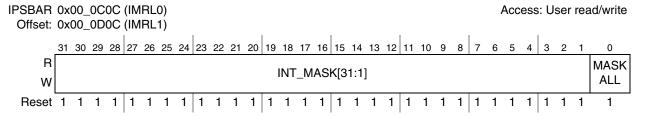


Figure 16-4. Interrupt Mask Register Low (IMRLn)

Table 16-7. IMRLn Field Descriptions

| Field | Description |
|--------------|--|
| | Interrupt mask. Each bit corresponds to an interrupt source. The corresponding IMRL <i>n</i> bit determines whether an interrupt condition can generate an interrupt. The corresponding IPRL <i>n</i> bit reflects the state of the interrupt signal even if the corresponding IMRL <i>n</i> bit is set. 0 The corresponding interrupt source is not masked 1 The corresponding interrupt source is masked |
| 0 MASKALL | Mask all interrupts. Setting this bit forces the other 63 bits of the IMRH <i>n</i> and IMRL <i>n</i> to ones, disabling all interrupt sources, and providing a global mask-all capability. |

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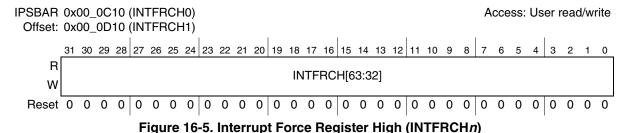
NOTE

A spurious interrupt may occur if an interrupt source is being masked in the interrupt controller mask register (IMR) or a module's interrupt mask register while the interrupt mask in the status register (SR[I]) is set to a value lower than the interrupt's level. This is because by the time the status register acknowledges this interrupt, the interrupt has been masked. A spurious interrupt is generated because the CPU cannot determine the interrupt source.

To avoid this situation for interrupts sources with levels 1–6, first write a higher level interrupt mask to the status register, before setting the mask in the IMR or the module's interrupt mask register. After the mask is set, return the interrupt mask in the status register to its previous value. Because level 7 interrupts cannot be disabled in the status register prior to masking, use of the IMR or module interrupt mask registers to disable level 7 interrupts is not recommended.

16.3.3 Interrupt Force Registers (INTFRCH*n*, INTFRCL*n*)

The INTFRCHn and INTFRCLn registers, each 32 bits, provide a mechanism to allow software generation of interrupts for each possible source for functional or debug purposes. The system design may reserve one or more sources to allow software to self-schedule interrupts by forcing one or more of these bits (1 = force request, 0 = negate request) in the appropriate INTFRCn register. The assertion of an interrupt request via the INTFRCn register is not affected by the interrupt mask register. The INTFRCn register is cleared by reset.



| Field | Description |
|---------|--|
| 31–0 | Interrupt force. Allows software generation of interrupts for each possible source for functional or debug purposes. |
| INTFRCH | 0 No interrupt forced on corresponding interrupt source |
| | 1 Force an interrupt on the corresponding source |

Table 16-8. INTFRCHn Field Descriptions

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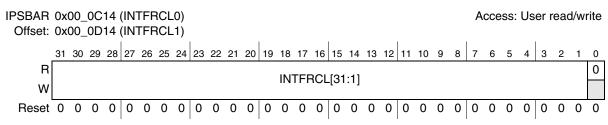


Figure 16-6. Interrupt Force Register Low (INTFRCLn)

Table 16-9. INTFRCLn Field Descriptions

| Field | Description |
|-------|---|
| | Interrupt force. Allows software generation of interrupts for each possible source for functional or debug purposes. O No interrupt forced on corresponding interrupt source 1 Force an interrupt on the corresponding source |
| 0 | Reserved, must be cleared. |

16.3.4 Interrupt Request Level Register (IRLRn)

This 7-bit register is updated each machine cycle and represents the current interrupt requests for each interrupt level, where bit 7 corresponds to level 7, bit 6 to level 6, etc.



Figure 16-7. Interrupt Request Level Register (IRLRn)

Table 16-10. IRLRn Field Descriptions

| Field | Description |
|------------|--|
| 7–1 IRQ | Interrupt requests. Represents the prioritized active interrupts for each level. O There are no active interrupts at this level 1 There is an active interrupt at this level |
| 0 | Reserved |

16.3.5 Interrupt Acknowledge Level and Priority Register (IACKLPRn)

Each time an IACK is performed, the interrupt controller responds with the vector number of the highest priority source within the level being acknowledged. In addition to providing the vector number directly for the byte-sized IACK read, this 8-bit register is also loaded with information about the interrupt level

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and priority being acknowledged. This register provides the association between the acknowledged physical interrupt request number and the programmed interrupt level/priority.

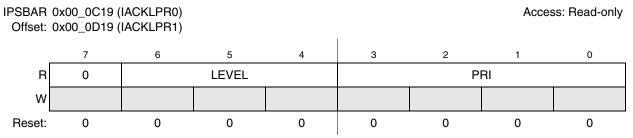


Figure 16-8. IACK Level and Priority Register (IACKLPRn)

Table 16-11. IACKLPRn Field Descriptions

| Field | Description |
|--------------|---|
| 7 | Reserved |
| 6–4 LEVEL | Interrupt level. Represents the interrupt level of the interrupt currently being acknowledged. |
| 3–0 PRI | Interrupt Priority. Represents the priority within the interrupt level of the interrupt currently being acknowledged. 0 Priority 0 1 Priority 1 2 Priority 2 3 Priority 3 4 Priority 4 5 Priority 5 6 Priority 6 7 Priority 7 8 Mid-point priority associated with the fixed level interrupts only |

16.3.6 Interrupt Control Registers (ICRnx)

Each ICRnx, where x = 1, 2, ..., 63, specifies the interrupt level (1-7) and the priority within the level (0-7). As shown in Table 16-12, all ICRnx registers can be read, but only ICRn8 through ICRn63 can be written. Registers ICRn1 through ICRn7 are read-only because the interrupt levels for IRQ1 through IRQ7 are hard-coded to their respective source numbers (see Section 16.1.1, "Interrupt Controller Theory of Operation"). The registers are described in Figure 16-9 and Table 16-13.

It is the responsibility of the software to program the ICR*nx* registers with unique and non-overlapping level and priority definitions. Failure to program the ICR*nx* registers in this manner can result in undefined behavior. If a specific interrupt request is completely unused, the ICR*nx* value can remain in its reset (and disabled) state.

Table 16-12. ICRnx Register Accessibility

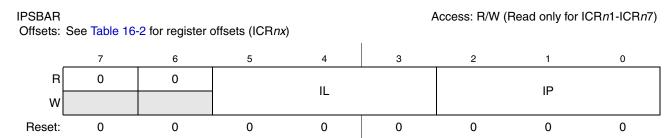
| Registers | Access |
|----------------|--------------|
| ICRn1 – ICRn7 | Read-only |
| ICRn8 – ICRn63 | Read / write |

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Note: It is the responsibility of the software to program the ICR*n*x registers with unique and non-overlapping level and priority definitions. Failure to program the ICR*n*x registers in this manner can result in undefined behavior. If a specific interrupt request is completely unused, the ICR*n*x value can remain in its reset (and disabled) state.

Figure 16-9. Interrupt Control Register (ICRnx)

Table 16-13. ICRnx Field Descriptions

| Field | Description |
|-----------|---|
| 7–6 | Reserved, must be cleared. |
| 5–3 IL | Interrupt level. Indicates the interrupt level assigned to each interrupt input. |
| 2–0 IP | Interrupt priority. Indicates the interrupt priority for internal modules within the interrupt-level assignment. 0x0 represents the lowest priority and 0x7 represents the highest. For the fixed level interrupt sources, the priority is fixed at the midpoint for the level, and the IP field always reads as 0x0. |

16.3.7 Software and Level *m* IACK Registers (SWIACK*n*, L*m*IACK*n*)

The eight IACK registers can be explicitly addressed via the CPU, or implicitly addressed via a processor-generated interrupt acknowledge cycle during exception processing. In either case, the interrupt controller's actions are very similar.

When a level-*m* IACK arrives in the interrupt controller, the controller examines all the currently-active level m interrupt requests, determines the highest priority within the level, and then responds with the unique vector number corresponding to that specific interrupt source. The vector number is supplied as the data for the byte-sized IACK read cycle. In addition to providing the vector number, the interrupt controller also loads the level and priority number for the level into the IACKLPR register, where it may be retrieved later.

This interrupt controller design also supports the concept of a software IACK. A software IACK allows an interrupt service routine to determine if there are other pending interrupts so that the overhead associated with interrupt exception processing (including machine state save/restore functions) can be minimized. In general, the software IACK is performed near the end of an interrupt service routine, and if there are additional active interrupt sources, the current interrupt service routine (ISR) passes control to the appropriate service routine, but without taking another interrupt exception.

When the interrupt controller receives a software IACK read, it returns the vector number associated with the highest level, highest priority unmasked interrupt source for that interrupt controller. The IACKLPR register is also loaded as the software IACK is performed. If there are no active sources, the interrupt

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controller returns an all-zero vector as the operand. For this situation, the IACKLPR register is also cleared

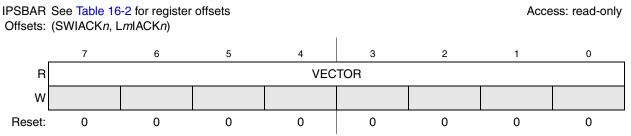


Figure 16-10. Software and Level m IACK Registers (SWIACKn, LmIACKn)

Table 16-14. SWIACKn and LmIACKn Field Descriptions

| Field | Description |
|-------|--|
| | Vector number. A read from the SWIACK register returns the vector number associated with the highest level, highest priority unmasked interrupt source. A read from one of the LmIACK registers returns the highest priority unmasked interrupt source within the level. |

16.3.8 Global Level m IACK Registers (GLmIACK)

In addition to the software IACK registers (Section 16.3.7, "Software and Level m IACK Registers (SWIACKn, LmIACKn)"), there are global IACK registers, GLmIACK. (There is no global SWIACK register.) On devices with multiple interrupt controllers, a read from one of the GLmIACK registers returns the vector for the highest priority unmasked interrupt within a level for all interrupt controllers.

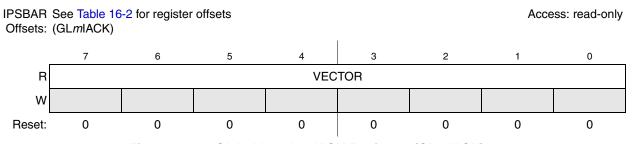


Figure 16-11. Global Level m IACK Registers (GLmIACK)

Table 16-15. GSWIACK and GLmIACK Field Descriptions

| | Field | Description |
|---|--------|--|
| , | /ECTOR | Vector number. A read from one of the L <i>m</i> IACK registers returns the vector for the highest priority unmasked interrupt within a level for all interrupt controllers. As implemented on the MCF52259, these registers contain the same information as L <i>m</i> IACK. |

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Interrupt Controller Module

16.3.8.1 Interrupt Sources

Table 16-6 lists the interrupt sources for each interrupt request line.

Table 16-16. Interrupt Source Assignments for INTC0

| Source | Module | Flag | Source Description | ce Description Flag Clearing Mechanism | | |
|--------|---------------------|------|---------------------------------|--|--|--|
| 0 | Not used (Reserved) | | | | | |
| 1 | | EPF1 | Edge port flag 1 | Write EPF1 = 1 | | |
| 2 | | EPF2 | Edge port flag 2 | Write EPF2 = 1 | | |
| 3 | | EPF3 | Edge port flag 3 | Write EPF3 = 1 | | |
| 4 | EPORT | EPF4 | Edge port flag 4 | Write EPF4 = 1 | | |
| 5 | | EPF5 | Edge port flag 5 | Write EPF5 = 1 | | |
| 6 | | EPF6 | Edge port flag 6 | Write EPF6 = 1 | | |
| 7 | | EPF7 | Edge port flag 7 | Write EPF7 = 1 | | |
| 8 | SCM | SWTI | Software watchdog timeout | Cleared when service complete. | | |
| 9 | | DONE | DMA Channel 0 transfer complete | Write DONE = 1 | | |
| 10 | DMA | DONE | DMA Channel 1 transfer complete | Write DONE = 1 | | |
| 11 | DMA | DONE | DMA Channel 2 transfer complete | Write DONE = 1 | | |
| 12 | | DONE | DMA Channel 3 transfer complete | Write DONE = 1 | | |
| 13 | UART0 | INT | UART0 interrupt | Automatically cleared | | |
| 14 | UART1 | INT | UART1 interrupt | Automatically cleared | | |
| 15 | UART2 | INT | UART2 interrupt | Automatically cleared | | |
| 16 | | | Not used (Re | served) | | |
| 17 | I ² C0 | IIF | I ² C interrupt | Write IIF = 0 | | |
| 18 | QSPI | INT | QSPI interrupt | Write 1 to appropriate QIR bit | | |
| 19 | DTIM0 | INT | DTIM0 interrupt | Write 1 to appropriate DTER0 bit | | |
| 20 | DTIM1 | INT | DTIM1 interrupt | Write 1 to appropriate DTER1 bit | | |
| 21 | DTIM2 | INT | DTIM2 interrupt | Write 1 to appropriate DTER2 bit | | |
| 22 | DTIM3 | INT | DTIM3 interrupt | Write 1 to appropriate DTER3 bit | | |

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Table 16-16. Interrupt Source Assignments for INTC0 (continued)

| Source | Module Flag Source Description Flag Clearing Mechanism | | | |
|--------|---|--------|---|--|
| 23 | | X_INTF | Transmit frame interrupt | Write X_INTF = 1 |
| 24 | | X_INTB | Transmit buffer interrupt | Write X_INTB = 1 |
| 25 | | UN | Transmit FIFO underrun | Write UN = 1 |
| 26 | | RL | Collision retry limit | Write RL = 1 |
| 27 | | R_INTF | Receive frame interrupt | Write R_INTF = 1 |
| 28 | | RINTB | Receive buffer interrupt | Write R_INTB = 1 |
| 29 | FEC | MII | MII interrupt | Write MII = 1 |
| 30 | | LC | Late Collision | Write LC = 1 |
| 31 | | HBERR | Heartbeat error | Write HBERR = 1 |
| 32 | | GRA | Graceful stop complete | Write GRA = 1 |
| 33 | | EBERR | Ethernet bus error | Write EBERR = 1 |
| 34 | | BABT | Babbling transmit error | Write BABT = 1 |
| 35 | BABR Babbling receive error Write BABR = 1 | | Write BABR = 1 | |
| 36 | Not used (Reserved) | | | |
| 37 | Not used (Reserved) | | | |
| 38 | Not used (Reserved) | | | |
| 39 | Not used (Reserved) | | | served) |
| 40 | RNGA | RNGA | RNGA Interrupt | Clears after one cycle of module reset |
| 41 | | TOF | Timer overflow | Write TOF = 1 or access TIMCNTH/L if TFFCA = 1 |
| 42 | | PAIF | Pulse accumulator input | Write PAIF = 1 or access PAC if TFFCA = 1 |
| 43 | | PAOVF | Pulse accumulator overflow | Write PAOVF = 1 or access PAC if TFFCA = 1 |
| 44 | GPT | C0F | Timer channel 0 | Write C0F = 1 or access IC/OC if TFFCA = 1 |
| 45 | | C1F | Timer channel 1 | Write 1 to C1F or access IC/OC if TFFCA = 1 |
| 46 | | C2F | Timer channel 2 | Write 1 to C2F or access IC/OC if TFFCA = 1 |
| 47 | C3F Timer channel 3 Write 1 to C3F or access IC/OC if TFFCA = 1 | | Write 1 to C3F or access IC/OC if TFFCA = 1 | |
| 48 | PMM | LVDF | LVD | Write LVDF = 1 |
| 49 | | ADCA | ADCA conversion complete | Write 1 to EOSI0 |
| 50 | ADC | ADCB | ADCB conversion complete | Write 1 to EOSI1 |
| 51 | | ADCINT | ADC Interrupt | Write 1 to ZCI, LLMTI and HLMTI |
| 52 | PWM | PWM | PWM Interrupt | Write PWMIF = 1 |

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Interrupt Controller Module

Table 16-16. Interrupt Source Assignments for INTC0 (continued)

| Source | Module | Flag | Source Description | Flag Clearing Mechanism | |
|--------|---------------------|--|--|---|--|
| 53 | USB | USB | USB Interrupt See Section 20.4.1.5, "OTG Interrupt Status Regi (OTG_INT_STAT)" and Section 20.4.1.9, "Interru Status Register (INT_STAT)" | | |
| 54 | | | Not used (Re | served) | |
| 55 | PIT0 | PIF | PIT interrupt flag | Write PIF = 1 or write PMR | |
| 56 | PIT1 | PIT1 PIF PIT interrupt flag Write PIF = 1 or write PMR | | Write PIF = 1 or write PMR | |
| 57 | Not Used (Reserved) | | | | |
| 58 | CFM | CBEIF | SGFM buffer empty | Write CBEIF = 1 | |
| 59 | | CCIF | SGFM command complete | Cleared automatically | |
| 60 | CFIVI | PVIF | Protection violation | Cleared automatically | |
| 61 | | AEIF | Access error | Cleared automatically | |
| 62 | I ² C1 | IIF | I ² C interrupt | Write IIF = 0 | |
| 63 | RTC | RTC | RTC Interrupt | See Section 9.2.6, "RTC Interrupt Status Register (RTCISR)" | |

Table 16-17. Interrupt Source Assignment for INTC1

| Source | Module | Flag | Source Description | Flag Clearing Mechanism |
|--------|-------------|--------|-----------------------------|--------------------------------------|
| 0–7 | Not used | | | ed |
| 8 | | BUF0I | Message Buffer 0 Interrupt | Write 1 to BUF0I after reading as 1 |
| 9 | - | BUF1I | Message Buffer 1 Interrupt | Write 1 to BUF1I after reading as 1 |
| 10 | - | BUF2I | Message Buffer 2 Interrupt | Write 1 to BUF2I after reading as 1 |
| 11 | - | BUF3I | Message Buffer 3 Interrupt | Write 1 to BUF3I after reading as 1 |
| 12 | - | BUF4I | Message Buffer 4 Interrupt | Write 1 to BUF4I after reading as 1 |
| 13 | - | BUF5I | Message Buffer 5 Interrupt | Write 1 to BUF5I after reading as 1 |
| 14 | - | BUF6I | Message Buffer 6 Interrupt | Write 1 to BUF6I after reading as 1 |
| 15 | FLEX CAN | BUF7I | Message Buffer 7 Interrupt | Write 1 to BUF7I after reading as 1 |
| 16 | - | BUF8I | Message Buffer 8 Interrupt | Write 1 to BUF8I after reading as 1 |
| 17 | - | BUF9I | Message Buffer 9 Interrupt | Write 1 to BUF9I after reading as 1 |
| 18 | - | BUF10I | Message Buffer 10 Interrupt | Write 1 to BUF10I after reading as 1 |
| 19 | - | BUF11I | Message Buffer 11 Interrupt | Write 1 to BUF11I after reading as 1 |
| 20 | | BUF12I | Message Buffer 12 Interrupt | Write 1 to BUF12I after reading as 1 |
| 21 | | BUF13I | Message Buffer 13 Interrupt | Write 1 to BUF13I after reading as 1 |
| 22 | • | BUF14I | Message Buffer 14 Interrupt | Write 1 to BUF14I after reading as 1 |

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| Source | Module | Flag | Source Description | Flag Clearing Mechanism |
|--------|-------------|----------|-----------------------------|---|
| 23 | | BUF15I | Message Buffer 15 Interrupt | Write 1 to BUF15I after reading as 1 |
| 24 | FLEX CAN | ERR_INT | Error Interrupt | Read reported error bits in ESR or write 0 to ERR_INT |
| 25 | | BOFF_INT | Bus-Off Interrupt | Write 0 to BOFF_INT |
| 26–63 | Not used | | | |

Table 16-17. Interrupt Source Assignment for INTC1 (continued)

Low-Power Wakeup Operation

The system control module (SCM) contains an 8-bit low-power interrupt control register (LPICR) used explicitly for controlling the low-power stop mode. This register must explicitly be programmed by software to enter low-power mode.

The interrupt controller provides a special combinatorial logic path to provide a special wake-up signal to exit from the low-power stop mode. This special mode of operation works as follows:

1. LPICR[6:4] is loaded with the specified mask level while the core is in stop mode. LPICR[7] must be set to enable this mode of operation.

NOTE

The wakeup mask level taken from LPICR[6:4] is adjusted by hardware to allow a level 7 IRQ to generate a wakeup. That is, the wakeup mask value used by the interrupt controller must be in the range of 0–6.

2. The processor executes a STOP instruction which places it in stop mode. After the processor is stopped, each interrupt controller enables a special logic path that evaluates the incoming interrupt sources in a purely combinatorial path; that is, there are no clocked storage elements. If an active interrupt request is asserted and the resulting interrupt level is greater than the mask value contained in LPICR[6:4], then the interrupt controller asserts the wake-up output signal, which is routed to the SCM and PLL module to re-enable the device's clock trees and resume processing.

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Chapter 17 Edge Port Module (EPORT)

17.1 Introduction

The edge port module (EPORT) has up to eight interrupt pins, $\overline{IRQ7} - \overline{IRQ0}$. Each pin can be configured individually as a level-sensitive interrupt pin, an edge-detecting interrupt pin (rising edge, falling edge, or both), or a general-purpose input/output (I/O) pin.

NOTE

Not all EPORT signals may be output from the device. See Chapter 2, "Signal Descriptions," to determine which signals are available.

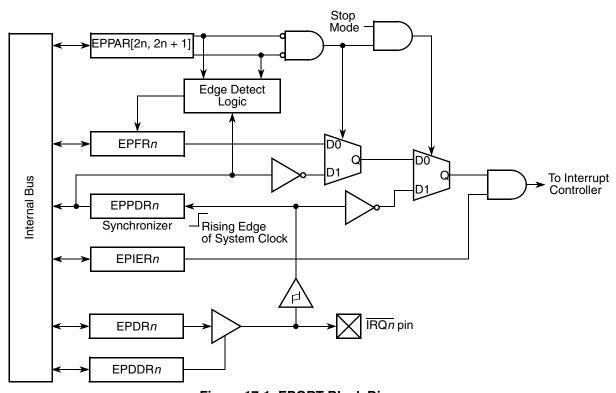


Figure 17-1. EPORT Block Diagram

NOTE

The GPIO module must be configured to enable the peripheral function of the appropriate pins (refer to Chapter 15, "General Purpose I/O Module") prior to configuring the edge-port module.

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17.2 Low-Power Mode Operation

This section describes the operation of the EPORT module in low-power modes. For more information on low-power modes, see Chapter 10, "Power Management". Table 17-1 shows EPORT-module operation in low-power modes and describes how this module may exit each mode.

NOTE

The low-power control register (LPCR) in the system control module specifies the interrupt level at or above what is needed to bring the device out of a low-power mode.

| Low-power Mode | EPORT Operation | Mode Exit |
|----------------|--------------------|---|
| Wait | Normal | Any IRQn interrupt at or above level in LPCR |
| Doze | Normal | Any IRQn interrupt at or above level in LPCR |
| Stop | Level-sensing only | Any IRQn interrupt set for level-sensing at or above level in LPCR. See note below. |

Table 17-1. Edge Port Module Operation in Low-Power Modes

In wait and doze modes, the EPORT module continues to operate as it does in run mode. It may be configured to exit the low-power modes by generating an interrupt request on a selected edge or a low level on an external pin. In stop mode, no clocks are available to perform the edge-detect function. Only the level-detect logic is active (if configured) to allow any low level on the external interrupt pin to generate an interrupt (if enabled) to exit stop mode.

NOTE

In stop mode, the input pin synchronizer is bypassed for the level-detect logic because no clocks are available.

17.3 Signal Descriptions

All EPORT pins default to general-purpose input pins at reset. The pin value is synchronized to the rising edge of CLKOUT when read from the EPORT pin data register (EPPDR). The values used in the edge/level detect logic are also synchronized to the rising edge of CLKOUT. These pins use Schmitt-triggered input buffers with built-in hysteresis designed to decrease the probability of generating false, edge-triggered interrupts for slow rising and falling input signals.

When a pin is configured as an output, it is driven to a state whose level is determined by the corresponding bit in the EPORT data register (EPDR). All bits in the EPDR are set at reset.

17.4 Memory Map/Register Definition

This subsection describes the memory map and register structure. Refer to Table 17-2 for a description of the EPORT memory map.



Table 17-2. Edge Port Module Memory Map

| IPSBAR Offset | Register | Width (bits) | Access | Reset Value | Section/Page | | |
|------------------|---|--------------|--------|-------------|--------------|--|--|
| | Supervisor Access Only Registers ¹ | | | | | | |
| 0x13_0000 | EPORT Pin Assignment Register (EPPAR) | 16 | R/W | 0x0000 | 17.4.1/17-3 | | |
| 0x13_0002 | EPORT Data Direction Register (EPDDR) | 8 | R/W | 0x00 | 17.4.2/17-4 | | |
| 0x13_0003 | EPORT Interrupt Enable Register (EPIER) | 8 | R/W | 0x00 | 17.4.3/17-4 | | |
| | Supervisor/User Access Registers | | | | | | |
| 0x13_0004 | EPORT Data Register (EPDR) | 8 | R/W | 0xFF | 17.4.4/17-5 | | |
| 0x13_0005 | EPORT Pin Data Register (EPPDR) | 8 | R | See Section | 17.4.5/17-5 | | |
| 0x13_0006 | EPORT Flag Register (EPFR) | 8 | R/W | 0x00 | 17.4.6/17-6 | | |

¹ User access to supervisor-only address locations have no effect and result in a bus error.

17.4.1 EPORT Pin Assignment Register (EPPAR)

The EPORT pin assignment register (EPPAR) controls the function of each pin individually.

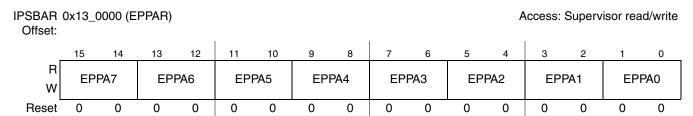


Figure 17-2. EPORT Pin Assignment Register (EPPAR)

Table 17-3. EPPAR Field Descriptions

| Field | Description |
|-----------------------|--|
| 15–0 EPPA <i>n</i> | EPORT pin assignment select fields. The read/write EPPA <i>n</i> fields configure EPORT pins for level detection and rising and/or falling edge detection. Pins configured as level-sensitive are active-low (logic 0 on the external pin represents a valid interrupt request). Level-sensitive interrupt inputs are not latched. To guarantee that a level-sensitive interrupt request is acknowledged, the interrupt source must keep the signal asserted until acknowledged by software. Level sensitivity must be selected to bring the device out of stop mode with an IRQn interrupt. Pins configured as edge-triggered are latched and need not remain asserted for interrupt generation. A pin configured for edge detection can trigger an interrupt regardless of its configuration as input or output. Interrupt requests generated in the EPORT module can be masked by the interrupt controller module. EPPAR functionality is independent of the selected pin direction. Reset clears the EPPAn fields. 00 Pin IRQn level-sensitive 01 Pin IRQn falling edge triggered 10 Pin IRQn falling edge triggered 11 Pin IRQn falling edge and rising edge triggered |

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17.4.2 EPORT Data Direction Register (EPDDR)

The EPORT data direction register (EPDDR) controls the direction of each one of the pins individually.

IPSBAR 0x13_0002 (EPDDR) Access: Supervisor read/write Offset: 3 7 4 EPDD7 EPDD6 EPDD5 EPDD4 EPDD3 EPDD2 EPDD1 EPDD0 0 0 0 0 0 0 Reset 0 0

Figure 17-3. EPORT Data Direction Register (EPDDR)

Table 17-4. EPDDR Field Descriptions

| Field | Description |
|----------------------|---|
| 7–0 EPDD <i>n</i> | Setting any bit in the EPDDR configures the corresponding pin as an output. Clearing any bit in EPDDR configures the corresponding pin as an input. Pin direction is independent of the level/edge detection configuration. Reset clears EPDD7–EPDD0. To use an EPORT pin as an external interrupt request source, its corresponding bit in EPDDR must be clear. Software can generate interrupt requests by programming the EPORT data register when the EPDDR selects output. O Corresponding EPORT pin configured as input Corresponding EPORT pin configured as output |

17.4.3 Edge Port Interrupt Enable Register (EPIER)

The EPORT interrupt enable register (EPIER) enables interrupt requests for each pin individually.

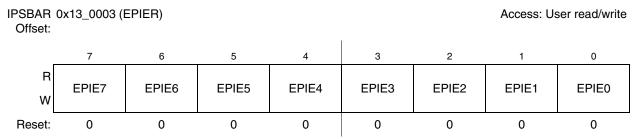


Figure 17-4. EPORT Port Interrupt Enable Register (EPIER)

Table 17-5. EPIER Field Descriptions

| Field | Description |
|----------------------|---|
| 7–0 EPIE <i>n</i> | Edge port interrupt enable bits enable EPORT interrupt requests. If a bit in EPIER is set, EPORT generates an interrupt request when: • The corresponding bit in the EPORT flag register (EPFR) is set or later becomes set • The corresponding pin level is low and the pin is configured for level-sensitive operation Clearing a bit in EPIER negates any interrupt request from the corresponding EPORT pin. Reset clears EPIE7—EPIE0. 0 Interrupt requests from corresponding EPORT pin disabled 1 Interrupt requests from corresponding EPORT pin enabled |

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Edge Port Module (EPORT)

Edge Port Data Register (EPDR) 17.4.4

The EPORT data register (EPDR) holds the data to be driven to the pins.

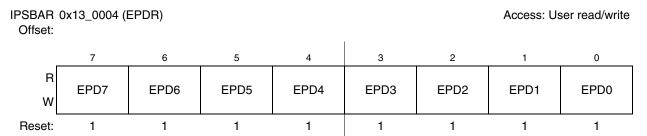


Figure 17-5. EPORT Port Data Register (EPDR)

Table 17-6. EPDR Field Descriptions

| Field | Description |
|---------------------|---|
| 7–0 EPD <i>n</i> | Edge port data bits. An internal register stores data written to EPDR; if any pin of the port is configured as an output, the bit stored for that pin is driven onto the pin. Reading EDPR returns the data stored in the register. Reset sets EPD7 – EPD0. |

Edge Port Pin Data Register (EPPDR) 17.4.5

The EPORT pin data register (EPPDR) reflects the current state of the pins.

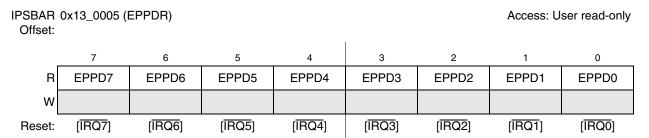


Figure 17-6. EPORT Port Pin Data Register (EPPDR)

Table 17-7. EPPDR Field Descriptions

| Field | Description |
|-------|---|
| | Edge port pin data bits. The read-only EPPDR reflects the current state of the EPORT pins $\overline{IRQ7} - \overline{IRQ0}$. Writing to EPPDR has no effect, and the write cycle terminates normally. Reset does not affect EPPDR. |



Edge Port Flag Register (EPFR) 17.4.6

The EPORT flag register (EPFR) individually latches EPORT edge events.

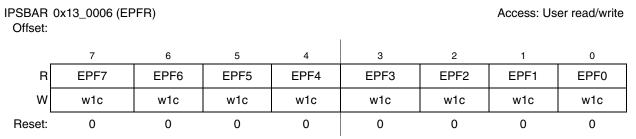


Figure 17-7. EPORT Port Flag Register (EPFR)

Table 17-8. EPFR Field Descriptions

| Field | Description |
|---------------------|---|
| 7–0 EPF <i>n</i> | Edge port flag bits. When an EPORT pin is configured for edge triggering, its corresponding read/write bit in EPFR indicates that the selected edge has been detected. Reset clears EPF7 – EPF0. Bits in this register are set when the selected edge is detected on the corresponding pin. A bit remains set until cleared by writing a 1 to it. Writing 0 has no effect. If a pin is configured as level-sensitive (EPPAR $n = 00$), pin transitions do not affect this register. 0 Selected edge for $\overline{IRQ}n$ pin not detected 1 Selected edge for $\overline{IRQ}n$ pin detected |

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Chapter 18 ColdFire Flash Module (CFM)

18.1 Introduction

18.1.1 Overview

The ColdFire Flash Module (CFM) is a non-volatile memory (NVM) module for integration with a CPU. The CFM provides 512 Kbytes of 32-bit Flash memory serving as electrically erasable and programmable, non-volatile memory. The flash memory is ideal for program and data storage for single-chip applications, allowing for field reprogramming without requiring external programming voltage sources.

The common flash bus interface executes read operations to the flash memory using one or two system bus cycles to access each flash physical block, with access latency depending on the factory setting of the CLKSEL bits in the CFMCLKSEL register. Flash physical blocks are interleaved between odd and even addresses to form a flash logical block. Interleaving allows back-to-back read operations to the flash memory at an effective access rate of one system bus cycle per word after the initial two-cycle access if the CLKSEL bits are not set for single cycle access.

It is not possible to read from any flash logical block while the same logical block is being erased, programmed, or verified. Flash logical blocks are divided into multiple 4-kByte logical pages that can be erased separately. An erased bit reads 1 and a programmed bit reads 0.



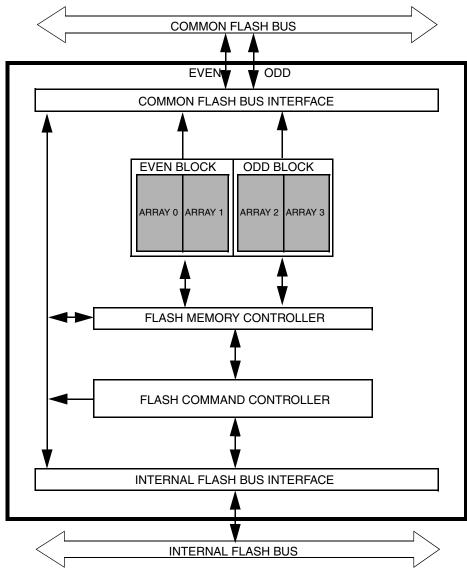


Figure 18-1. CFM Block Diagram

18.1.2 Features

- 512 kBytes of 32-bit Flash memory.
- Automated program, erase, and verify operations
- Single power supply for program and erase operations
- Software programmable interrupts on command completion, access violations, or protection violations
- Fast page erase operation
- Fast word program operation
- Protection scheme to prevent accidental program or erase of flash memory

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ColdFire Flash Module (CFM)

- Access restriction control for supervisor/user and data/instruction operations
- Security to prevent unauthorized access to the flash memory

18.2 External Signal Description

The CFM contains no signals that connect off-chip for the end customer.

18.3 Memory Map and Register Definition

This section describes the CFM memory map and registers.

18.3.1 Memory Map

The memory map for the CFM memory is shown in Figure 18-2. The starting address of the flash memory is determined by the flash array base address as defined by the system level configuration. The flash memory map shows how a pair of 32-bit flash physical blocks (even and odd) interleave every four bytes to form a contiguous memory space as follows:

Flash Block 0 includes byte addresses (PROGRAM_ARRAY_BASE+0x0000_0000) to (PROGRAM_ARRAY_BASE+0x0007_FFFF).

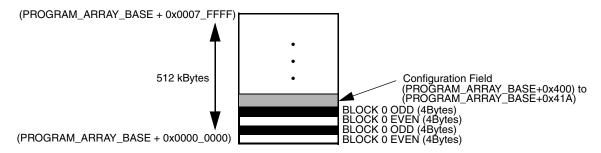


Figure 18-2. CFM Flash Memory Map

The CFM has hardware interlocks that protect data from accidental corruption using program or erase operations. A flexible scheme allows the protection of any combination of flash logical sectors as described in Section 18.3.3.4, "CFMPROT — CFM Protection Register". A similar scheme is available to control supervisor/user and data/instruction access to these flash logical sectors.

Security information that allows the MCU to prevent intrusive access to the flash memory is stored in the flash configuration field. The flash configuration field is composed of 24 bytes of reserved memory space within the flash memory, which contains information that determines the CFM protection and access restriction scheme out of reset. A description of each byte found in the flash configuration field is given in Table 18-1.

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| | | - | |
|---|-----------------|--|--------------------|
| Address Offset (from PROGRAM_ARRAY_BASE) | Size (bytes) | Description | Factory Default |
| 0x0400 - 0x0407 | 8 | Backdoor Comparison Key | 0xFFFF_FFFF_FFFF |
| 0x0408 - 0x040B | 4 | Flash Protection Bytes (see Section 18.3.3.4, "CFMPROT — CFM Protection Register") | 0xFFFF_FFFF |
| 0x040C - 0x040F | 4 | Flash SUPV Access Bytes (see Section 18.3.3.5, "CFMSACC — CFM Supervisor Access Register") | 0xFFFF_FFFF |
| 0x0410 - 0x0413 | 4 | Flash DATA Access Bytes (see Section 18.3.3.6, "CFMDACC — CFM Data Access Register") | 0xFFFF_FFFF |
| 0x0414 - 0x0417 | 4 | Flash Security Word | 0xFFFF_FFFF |

Table 18-1. CFM Configuration Field

Flash Base Address Register (FLASHBAR) 18.3.2

The configuration information in the flash base address register (FLASHBAR) controls the operation of the flash module.

The FLASHBAR holds the base address of the flash. The MOVEC instruction provides write-only access to this register.

(see Section 18.3.3.3, "CFMSEC — **CFM Security Register")**

- The FLASHBAR can be read or written from the debug module in a similar manner.
- All undefined bits in the register are reserved. These bits are ignored during writes to the FLASHBAR and return zeroes when read from the debug module.
- The FLASHBAR valid bit is programmed according to the chip mode selected at reset (see Chapter 13, "Chip Configuration Module (CCM)" for more details). All other bits are unaffected.

The FLASHBAR register contains several control fields. These fields are shown in Figure 18-3.

NOTE

The default value of the FLASHBAR is determined by the chip configuration selected at reset (see Chapter 13, "Chip Configuration Module (CCM)" for more information).

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ColdFire Flash Module (CFM)

NOTE

Flash accesses (reads/writes) by a bus master other than the core (e.g. DMA controller), or writes to flash by the core during programming must use the backdoor flash address of IPSBAR plus an offset of $0x0400_0000$. For example, for a DMA transfer from the first location of flash when IPSBAR is at its default location of $0x4000_0000$, the source register would be loaded with $0x4400_0000$. Backdoor access to flash for reads can be made by the bus master, but it takes two cycles longer than a direct read of the flash if using its FLASHBAR address.

NOTE

The flash is marked as valid on reset based on the RCON (reset configuration) pin state. Flash space is valid on reset when booting in single-chip mode . See Chapter 13, "Chip Configuration Module (CCM)" for more details. When the default reset configuration is not overridden, the MCU (by default) boots up in single-chip mode and the flash space is marked as valid at address 0x0. The flash configuration field is checked during the reset sequence to see if the flash is secured. If it is, the part always boots from internal flash because it is marked as valid regardless of what is done for chip configuration.

| Address | Address CPU + 0xC04 (FLASHBAR) Access: User read/write | | | | | | | | | | | | | | | |
|---------|--|------|------|------|------|------|------|------|------|------|------|------|------|----|----|----------------|
| | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
| R | BA31 | BA30 | BA29 | BA28 | BA27 | DAGE | DAGE | BA24 | BA23 | BA22 | BA21 | BA20 | BA19 | 0 | 0 | 0 |
| W | DASI | DASU | DAZ9 | DAZO | DAZI | DA20 | DAZS | DAZ4 | DAZS | DAZZ | DAZI | DA20 | DAIS | | | |
| Reset | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| R | 0 | 0 | 0 | 0 | 0 | 0 | 0 | WP | 0 | AFS | C/I | SC | SD | UC | UD | V ¹ |
| W | | | | | | | | | | AFS | C/I | 30 | 30 | UC | OD | V |
| Reset | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 |

Figure 18-3. Flash Base Address Register (FLASHBAR)

Table 18-2. FLASHBAR Field Descriptions

| Bits | Name | Description | | | | |
|-------|-----------|--|--|--|--|--|
| 31–19 | BA[31:18] | Base Address Field. Defines the 0-modulo-512K base address of the flash module. By programming this field, the flash may be located on any 512-Kbyte boundary within the processor's four gigabyte address space. | | | | |
| 18–9 | _ | Reserved, should be cleared. | | | | |
| 8 | WP | Write Protect. Read-only. Allows only read accesses to the flash. This bit is always set and any attempted write access generates an access error exception to the ColdFire processor core. O Allows read and write accesses to the flash module 1 Allows only read accesses to the flash module | | | | |

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The reset value for the valid bit is determined by the chip mode selected at reset (see Chapter 13, "Chip Configuration Module (CCM)").



Table 18-2. FLASHBAR Field Descriptions

| Bits | Name | Description | | | | | | |
|------|------------------------|---|--|--|--|--|--|--|
| 7 | _ | Reserved, should be cleared. | | | | | | |
| 6 | AFS | ddress fetch speculation. Performance enhancement to generate speculative flash accesses. to educe the effective flash access time from the actual two-cycle array time to a smaller number pproaching one cycle. Speculation enabled Disable speculation | | | | | | |
| 5–1 | C/I, SC, SD, UC, UD | Address Space Masks (ASn). These five bit fields allow certain types of accesses to be masked or inhibited from accessing the flash module. The address space mask bits are: C/I CPU space/interrupt acknowledge cycle mask SC Supervisor code address space mask SD Supervisor data address space mask UC User code address space mask UD User data address space mask UD User data address space mask UD User data address space bit: O An access to the flash module can occur for this address space 1 Disable this address space from the flash module. If a reference using this address space is made, it is inhibited from accessing the flash module, and is processed like any other non-flash reference. These bits are useful for power management as detailed in Chapter 10, "Power Management." | | | | | | |
| 0 | V | alid. When set, this bit enables the flash module; otherwise, the module is disabled. Contents of FLASHBAR are not valid Contents of FLASHBAR are valid | | | | | | |

The CFM contains a set of control and status registers located at the register base address as defined by the system level configuration. A summary of the CFM registers is given in Table 18-3.

Table 18-3. CFM Register Address Map

| IPSBAR Offset | | Register Bits | | | | | |
|---------------|----------|------------------------------|-----------------------|-----------------------|--|--|--|
| IFSBAN Oliset | 31 - 24 | 23 - 16 | 15 - 8 | 7 - 0 | | | |
| 0x1D_0000 | CFM | MCR | CFMCLKD | RESERVED ¹ | | | |
| 0x1D_0004 | | RESE | RVED ¹ | • | | | |
| 0x1D_0008 | | CFM | ISEC | | | | |
| 0x1D_000C | | RESE | RVED ¹ | | | | |
| 0x1D_0010 | | CFMI | PROT | | | | |
| 0x1D_0014 | | CFMS | SACC | | | | |
| 0x1D_0018 | | CFMI | DACC | | | | |
| 0x1D_001C | | RESE | RVED ¹ | | | | |
| 0x1D_0020 | CFMUSTAT | | RESERVED ¹ | | | | |
| 0x1D_0024 | CFMCMD | CFMCMD RESERVED ¹ | | | | | |
| 0x1D_0028 | | RESERVED ¹ | | | | | |
| 0x1D_002C | | RESERVED ¹ | | | | | |
| 0x1D_0030 | | RESE | RVED ¹ | | | | |

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ColdFire Flash Module (CFM)

Table 18-3. CFM Register Address Map

| IPSBAR Offset | Register Bits | | | | | |
|---------------|---------------------------------|-----------------------|--------|-------|--|--|
| IFSBAN Oliset | 31 - 24 | 23 - 16 | 15 - 8 | 7 - 0 | | |
| 0x1D_0034 | | RESERVED ¹ | | | | |
| 0x1D_0038 | | RESERVED ¹ | | | | |
| 0x1D_003C | | RESERVED ¹ | | | | |
| 0x1D_0040 | | RESERVED ¹ | | | | |
| 0x1D_0044 | RESERVED ¹ | | | | | |
| 0x1D_0048 | RESERVED ¹ CFMCLKSEL | | | | | |

Access to reserved address locations generate a cycle termination transfer error.

18.3.3 Register Descriptions

18.3.3.1 CFMMCR — CFM Module Configuration Register

The CFMMCR register is used to configure and control the operation of the internal bus interface.

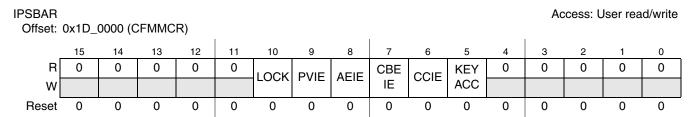


Figure 18-4. CFM Module Configuration Register (CFMMCR)

CFMMCR register bits [10:5] are readable and writable with restrictions, while the remaining bits read 0 and are not writable.

Table 18-4. CFMMCR Field Descriptions

| Field | Description |
|------------|---|
| 15-11 | Reserved, read as 0 |
| 10 LOCK | Write Lock Control. The LOCK bit is always readable and is set once. 0 CFMPROT, CMFSACC, and CFMDACC registers are writable. 1 CFMPROT, CMFSACC, and CFMDACC registers are write-locked. |
| 9 PVIE | Protection Violation interrupt Enable The PVIE bit is always readable and writable. The PVIE bit enables an interrupt in case the protection violation flag, PVIOL in the CFMUSTAT register, is set. 0 PVIOL interrupt disabled. 1 An interrupt is requested when the PVIOL flag is set. |
| 8 AEIE | Access Error Interrupt Enable The AEIE bit is always readable and writable. The AEIE bit enables an interrupt in case the access error flag, ACCERR in the CFMUSTAT register, is set. O ACCERR interrupt disabled. 1 An interrupt is requested when the ACCERR flag is set. |

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| Table 18-4. | CFMMCR | Field | Description | s (continued) |
|-------------|---------------|-------|-------------|---------------|
| | | | | |

| Field | Description |
|-------------|---|
| 7 CBEIE | Command Buffer Empty Interrupt Enable The CBEIE bit is always readable and writable. The CBEIE bit enables an interrupt in case the command buffer empty flag, CBEIF in the CFMUSTAT register, is set. 0 CBEIF interrupt disabled. 1 An interrupt is requested when the CBEIF flag is set. |
| 6 CCIE | Command Complete Interrupt Enable The CCIE bit is always readable and writable. The CCIE bit enables an interrupt in case the command completion flag, CCIF in the CFMUSTAT register, is set. 0 CCIF interrupt disabled. 1 An interrupt is requested when the CCIF flag is set. |
| 5 KEYACC | Enable Security Key Writing The KEYACC bit is readable and only writable if the KEYEN bits in the CFMSEC register are set to enable backdoor key access. 0 Writes to CFM flash memory are interpreted as the start of a command write sequence. 1 Writes to CFM flash memory are interpreted as keys to release security. |
| 4-0- | Reserved, read as 0 |

CFMCLKD — CFM Clock Divider Register 18.3.3.2

The CFMCLKD register is used to control the period of the clock used for timed events in program and erase algorithms.

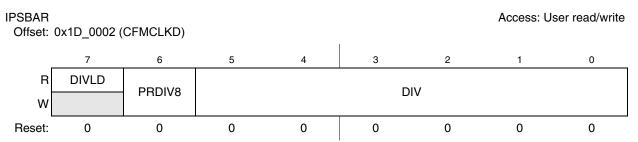


Figure 18-5. CFM Clock Divider Register (CFMCLKD)

All CFMCLKD register bits are readable, while bits [6:0] write once and bit 7 is not writable.

Table 18-5. CFMCLKD Field Descriptions

| Field | Description |
|------------|--|
| 7 DIVLD | Clock Divider Loaded 0 CFMCLKD register has not been written. 1 CFMCLKD register has been written to since the last reset. |

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Table 18-5. CFMCLKD Field Descriptions (continued)

| Field | Description | |
|-------------|--|--|
| 6 PRDIV8 | Enable Prescaler by 8 0 The internal flash bus clock is directly fed into the clock divider. 1 Enables a prescaler to divide the internal flash bus clock by 8 before feeding into the clock divider. | |
| 5-0 DIV | Clock Divider Bits The combination of PRDIV8 and DIV effectively divides the internal flash bus clock down to a frequency of 150 KHz - 200 KHz. The internal flash bus clock frequency range is 150 KHz less than the internal flash bus clock which is less than 102.4 MHz. The CFMCLKD register bits PRDIV8 and DIV must be set with appropriate values before programming or erasing the CFM flash memory Section 18.4.2.3.1, "Writing the CFMCLKD Register." | |

18.3.3.3 CFMSEC — CFM Security Register

The CFMSEC register is used to store the flash security word and CFM security state.

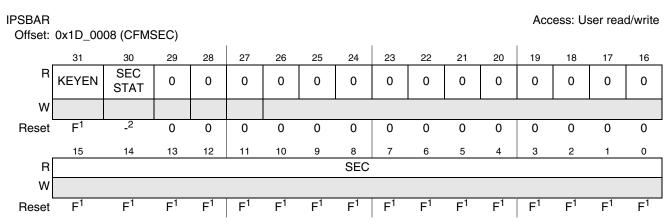


Figure 18-6. CFM Security Register (CFMSEC)

CFMSEC register bits [31:30,15:0] are readable, while remaining bits read 0 and all bits are not writable.

Table 18-6. CFMSEC Field Descriptions

| Field | Description | |
|---------------|---|--|
| 31 KEYEN | Enable backdoor key access to unlock security 0 Backdoor key access to flash module is disabled. 1 Backdoor key access to flash module is enabled. | |
| 30 SECSTAT | Flash memory security status 0 Flash security is disabled. 1 Flash security is enabled. | |
| 29-16 | Reserved, should read 0 | |
| 15–0 SEC | Flash memory security bits The SEC bits define the security state of the MCU as shown in Table 18-7, which defines the single code that enables the security in the CFM | |

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¹ Reset state loaded from flash configuration field during reset.

Reset state determined by security state of CFM.

18-10



1

The CFMSEC register is loaded from the flash configuration field in the flash block at offset 0x0414 during the reset sequence, indicated by F in Figure 18-6.

Table 18-7. CFM Security States

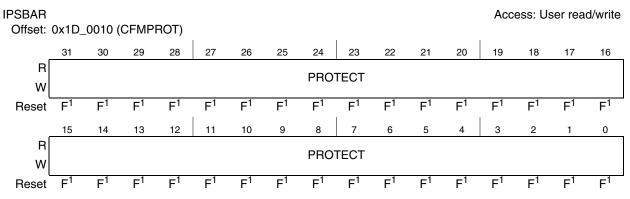
| SEC[15:0] | Description | |
|------------------------|------------------------|--|
| 0x4AC8 ¹ | Flash Memory Secured | |
| All other combinations | Flash Memory Unsecured | |

This value was chosen because it represents the ColdFire HALT instruction, making it unlikely that a user compiled code accidentally programmed at the security configuration field location would unintentionally secure the flash memory.

The CFM flash security operation is described in Section 18.4.3, "Flash Security Operation".

18.3.3.4 CFMPROT — CFM Protection Register

The CFMPROT register defines which flash logical sectors are protected against program and erase operations.



Reset state loaded from flash configuration field during reset.

Figure 18-7. CFM Protection Register (CFMPROT)

All CFMPROT register bits are readable and only writable when LOCK=0.

The flash memory is divided into logical sectors for the purpose of data protection using the CFMPROT register. The flash memory consists of 1 lower 16-kByte sector, 1 upper 16-kByte sector, and 2 middle sectors each with 16 kBytes as shown in Figure 18-8.

To change the flash memory protection on a temporary basis, the CFMPROT register should be written after the LOCK bit in the CFMMCR register has been cleared. To change the flash memory protection loaded during the reset sequence, the flash logical sector containing the flash configuration field must first be unprotected, and then the flash protection bytes must be programmed with the desired value.

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Table 18-8. CFMPROT Field Descriptions

| Field | Description | |
|-------|---|--|
| | Each flash logical sector can be protected from program and erase operations by setting the PROTECT[M] bit. 1 Flash logical sector M is protected. 0 Flash logical sector M is not protected. | |

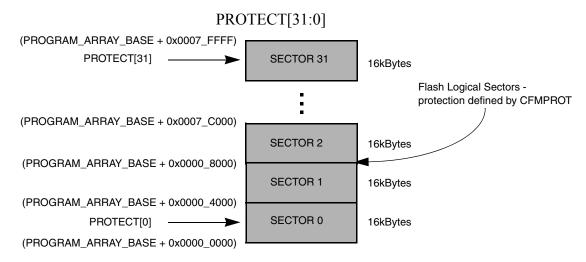
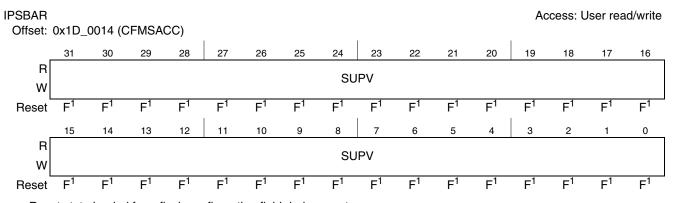


Figure 18-8. CFMPROT Protection Diagram

18.3.3.5 CFMSACC — CFM Supervisor Access Register

The CFMSACC register is used to control supervisor/user access to the flash memory.



Reset state loaded from flash configuration field during reset.

Figure 18-9. CFM Supervisor Access Register (CFMSACC)

All CFMSACC register bits are readable and only writable when LOCK is cleared.

To change the flash supervisor access on a temporary basis, the CFMSACC register should be written after the LOCK bit in the CFMMCR register has been cleared. To change the flash supervisor access loaded

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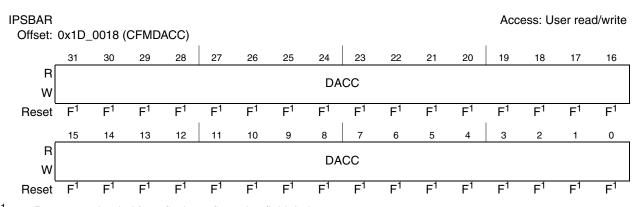
during the reset sequence, the flash logical sector containing the flash configuration field must first be unprotected, and then the flash supervisor access bytes must be programmed with the desired value. Each flash logical sector may be mapped into supervisor or unrestricted address space (see Figure 18-8 for details on flash sector mapping).

Table 18-9. CFMSACC Field Descriptions

| Ī | Field | Description |
|---|--------------|--|
| | 31–0 SUPV | Flash address space assignment for supervisor/user access O Flash logical sector M is placed in unrestricted address space. 1 Flash logical sector M is placed in supervisor address space |

18.3.3.6 CFMDACC — CFM Data Access Register

The CFMDACC register is used to control data/instruction access to the flash memory.



Reset state loaded from flash configuration field during reset.

Figure 18-10. CFM Data Access Register (CFMDACC)

All CFMDACC register bits are readable and only writable when LOCK is cleared.

To change the flash data access on a temporary basis, the CFMDACC register should be written after the LOCK bit in the CFMMCR register has been cleared. To change the flash data access loaded during the reset sequence, the flash logical sector containing the flash configuration field must first be unprotected, and then the flash data access bytes must be programmed with the desired value. Each flash logical sector may be mapped into data or both data and instruction address space (see

<f-helvetica><st-bold>Figure 18-8. for details on flash sector mapping).

Table 18-10. CFMDACC Field Descriptions

| Field | Description |
|--------------|---|
| 31–0 DACC | Flash memory address space assignment for data/instruction access 0 Flash logical sector M is placed in data and instruction address space. 1 Flash logical sector M is placed in data address space. |

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18.3.3.7 CFMUSTAT — CFM User Status Register

The CFMUSTAT register defines the flash command controller status and flash memory access, protection and verify status.

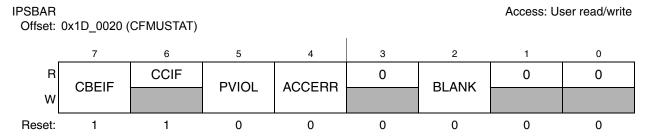


Figure 18-11. CFM User Status Register (CFMUSTAT)

CFMUSTAT register bits CBEIF, PVIOL, ACCERR, and BLANK are readable and writable while CCIF is readable but not writable, and remaining bits read 0 and are not writable.

The CFMUSTAT register bits CBEIF, CCIF, PVIOL, ACCERR, and BLANK are available as external signals CFM STATUS BITS[7:4,2] on the module boundary.

NOTE

Only one CFMUSTAT register bit can be cleared at a time.

Table 18-11. CFMUSTAT Field Descriptions

| Field | Description | |
|------------|--|--|
| 7 CBEIF | Command Buffer Empty Interrupt Flag The CBEIF flag, set by the flash command controller, indicates that the address, data, and command buffers are empty so that a new command write sequence can be started. The CBEIF flag is cleared by writing a 1 to CBEIF as part of a command write sequence. Writing a 0 to the CBEIF flag has no effect on CBEIF, but can be used to abort a command write sequence. The CBEIF flag can generate an interrupt if the CBEIE bit in the CFMMCR register is set. 0 Buffers are full. 1 Buffers are ready to accept a new command write sequence. | |
| 6 CCIF | Command Complete Interrupt Flag The CCIF flag, set by the flash command controller, indicates that there are no more commands pending. The CCIF flag is cleared by the flash command controller when CBEIF is cleared and sets upon completion of all active and pending commands. Writing to the CCIF flag has no effect on CCIF. The CCIF flag can generate an interrupt if the CCIE bit in the CFMMCR register is set. O Command in progress. All commands are completed. | |
| 5 PVIOL | Protection Violation The PVIOL flag, set by the flash command controller, indicates an attempt was made to program or en an address in a protected flash logical sector. The PVIOL flag is cleared by writing a 1 to PVIOL. Writ a 0 to the PVIOL flag has no effect on PVIOL. While the PVIOL flag is set, it is not possible to launch command or start a command write sequence. O No protection violation has been detected. 1 Protection violation has occurred. | |

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Table 18-11. CFMUSTAT Field Descriptions

| Field | Description | |
|-------------|--|--|
| 4 ACCERR | Access Error The ACCERR flag, set by the flash command controller, indicates an illegal access was made to the flash memory or registers caused by an illegal command write sequence. The ACCERR flag is cleared by writing a 1 to the ACCERR flag. Writing a 0 to the ACCERR flag has no effect on ACCERR. While the ACCERR flag is set, it is not possible to launch a command or start a command write sequence. See Section 18.4.2.3.5, "Flash Normal Mode Illegal Operations" for details on what action sets the ACCERR flag. 0 No access error has been detected. 1 Access error has occurred. | |
| 3 | Reserved, should read 0 | |
| 2 BLANK | All flash memory locations or the selected flash logical page have been verified as erased. The BLANK flag, set by the flash command controller, indicates that a blank check or page erase verify operation has checked all flash memory locations or the selected flash logical page and found them to be erased. The BLANK flag is cleared by writing a 1 to BLANK. Writing a 0 to the BLANK flag has no effect on BLANK. O If a blank check or page erase verify command has been executed, and the CCIF flag is set, then a 0 in the BLANK flag indicates that all flash memory locations are not erased or the selected flash logical page is not erased. 1 All flash memory locations or selected logical page verify as erased. | |
| 1 -0 | Reserved, should read 0 | |

18.3.3.8 CFMCMD — CFM Command Register

The CFMCMD register is the flash command register.

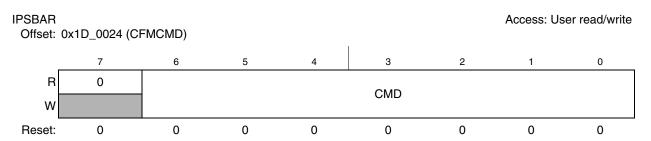


Figure 18-12. CFM Command Buffer and Register (CFMCMD)

All CFMCMD register bits are readable and writable except bit 7, which reads zero and is not writable.

Table 18-12. CFMCMD Field Descriptions

| Field | Description | |
|--------------|--|--|
| 7 | Reserved, should read 0 | |
| 6 - 0 CMD | Valid flash memory commands are shown in Table 18-13. Writing a command other than those listed in Table 18-13 during a command write sequence causes the ACCERR flag in the CFMUSTAT register to set. | |

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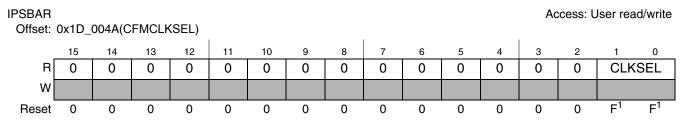
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Table 18-13. CFM Flash Memory Commands

| CMD[6:0] | Description | |
|----------|-------------------|--|
| 0x05 | Blank Check | |
| 0x06 | Page Erase Verify | |
| 0x20 | Word Program | |
| 0x40 | Page Erase | |
| 0x41 | Mass Erase | |

18.3.3.9 CFMCLKSEL — CFM Clock Select Register

The CFMCLKSEL register reflects the factory setting for read access latency from the system bus to the flash block.



¹Reset state set by factory and is not modifiable.

Figure 18-13. CFM Clock Select Register (CFMCLKSEL)

CFMCLKSEL register bits [1:0] are read-only, while the remaining bits read 0 and are not writable.

Table 18-14. CFMCLKSEL Field Descriptions

| Field | Description | |
|-----------------|---|--|
| 15 - 2 | Reserved, should read 0 | |
| 1 - 0 CLKSEL | Flash Read Access Latency Select The CLKSEL bits set the read access latency to the flash block. Table 18-15 describes the setting that selects between single-cycle and two-cycle flash block read access. | |

Table 18-15. Clock Select States

| CLKSEL[1:0] | Description | Burst Read Access |
|------------------------|--------------------------------------|-------------------|
| 2'b10 | Single-Cycle Flash Block Read Access | 1-1-1-1 |
| All other combinations | Two-cycle Flash Block Read Access | 2-1-1-1 |

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18.4 Functional Description

18.4.1 General

The following modes and operations are described in the corresponding sections:

- 1. Flash normal mode (Section 18.4.2, "Flash Normal Mode")
 - a) Read operation (Section 18.4.2.1, "Read Operation")
 - b) Write operation (Section 18.4.2.2, "Write Operation")
 - c) Program, erase, and verify operations (Section 18.4.2.3, "Program, Erase, and Verify Operations")
 - d) Stop mode (Section 18.4.2.4, "Stop Mode")
- 2. Flash security operation (Section 18.4.3, "Flash Security Operation")

18.4.2 Flash Normal Mode

In flash normal mode, the user can access the CFM registers and the CFM flash memory (see Section 18.3.1, "Memory Map").

18.4.2.1 Read Operation

A valid read operation occurs when a transfer request is initiated, the address is equal to an address within the valid range of the CFM flash memory space, and the read/write control indicates a read cycle.

18.4.2.2 Write Operation

A valid write operation occurs when a transfer request is initiated, the address is equal to an address within the valid range of the CFM flash memory space and the read/write control indicates a write cycle. The action taken on a valid flash array write depends on the subsequent user command issued as part of a valid command write sequence. Only 32-bit write operations are allowed to the flash memory space. Byte and half-word write operations to the flash memory space results in a cycle termination transfer error.

18.4.2.3 Program, Erase, and Verify Operations

Write and read operations are used for the program, erase, and verify algorithms described in this section. These algorithms are controlled by the flash memory controller whose timebase, for program and erase operations, is derived from the internal flash bus clock via a programmable counter. The command register as well as the associated address and data registers operate as a buffer and a register (2-stage FIFO), so that a new command along with the necessary data and address can be stored to the buffer while the previous command is in progress. This buffering operation provides time optimization when programming more than one word on a physical row in the flash memory as the high voltage generation can be kept active in between two programming operations. This saves the time overhead needed for setup of the high voltage charge pumps. Buffer empty, as well as command completion, is signaled by flags in the CFMUSTAT register with interrupts generated, if enabled.

The next four sections describe:

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ColdFire Flash Module (CFM)

- How to write the CFMCLKD register
- Command write sequences used to program, erase, and verify the flash memory
- Valid flash commands
- Errors resulting from illegal command write sequences to the flash memory

18.4.2.3.1 Writing the CFMCLKD Register

Prior to issuing any command, it is necessary to write the CFMCLKD register to divide the internal bus frequency to within the 150- to 200-kHz range. CFMCLKD[PRDIV8 and DIV] are set as follows:

For bus frequencies greater than 12.8 MHz, the CFMCLKD bit PRDIV8 must be set.

CFMCLKD DIV bit field must be chosen so that the following equation is valid:

```
If PRDIV8 == 1 then FCLK = input clock / 8, else FCLK = input clock
If (FCLK[KHz] / 200KHz) is integer then DIV = (FCLK[KHz] / 200KHz) - 1,
else DIV = INT (FCLK[KHz] / 200kHz)
```

Therefore, the clock to the flash block timing control, FCLK, is:

```
FCLK = (input clock) / (DIV + 1)
150KHz < FCLK <= 200KHz
```

For example, if the bus frequency is 33 MHz, CFMCLKD[DIV] should be set to 0x14 and bit PRDIV8 set to 1. The resulting FCLK is 196.4 KHz. As a result, the flash memory program and erase algorithm timings are increased over the optimum target by:

```
(200 - 196.4) / 200 \times 100\% = 1.78\%
```

Remark: INT(X) means taking the integer part of X

Example: INT(33MHz/8/200KHz) = 20

CAUTION

Programming the flash with bus frequency < 150 KHz should be avoided. Setting CFMCLKD to a value such that FCLK < 150 KHz can destroy the flash memory due to overstress. Setting CFMCLKD to a value such that FCLK > 200 KHz can result in incomplete programming or erasure of the flash memory array cells.

NOTE

Program and Erase command execution time increases proportionally with the period of FCLK.

If the CFMCLKD register is written, the DIVLD bit is set automatically. If the DIVLD bit is 0, the CFMCLKD register has not been written since the last reset. No command can be executed if the CFMCLKD register has not been written to Section 18.4.2.3.5, "Flash Normal Mode Illegal Operations."

18.4.2.3.2 Command Write Sequence

The flash command controller is used to supervise the command write sequence to execute blank check, page erase verify, program, page erase, and mass erase algorithms.

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Before starting a command write sequence, the ACCERR and PVIOL flags in the CFMUSTAT register must be clear and the CBEIF flag should be tested to determine the state of the address, data, and command buffers. If the CBEIF flag is set, indicating the buffers are empty, a new command write sequence can be executed.

A command write sequence consists of three steps that must be strictly adhered to, because writes to the CFM are not permitted between steps. However, flash register and array reads are allowed during a command write sequence. The basic command write sequence is as follows:

- 1. Write to one or more addresses in the flash memory.
- 2. Write a valid command to the CFMCMD register.
- 3. Clear CBEIF flag by writing a 1 to CBEIF to launch the command.

When the CBEIF flag is cleared, the CCIF flag is cleared on the same bus cycle by the flash command controller indicating that the command was successfully launched. The CBEIF flag is set again indicating that the address, data, and command buffers are ready for a new command write sequence to begin. A buffered command waits for the active command to be completed before being launched. The CCIF flag in the CFMUSTAT register set upon completion of all active and buffered commands.

A command write sequence can be aborted at anytime prior to clearing the CBEIF flag in the CFMUSTAT register by writing a 0 to the CBEIF flag. The ACCERR flag in the CFMUSTAT register is set after successfully aborting a command write sequence and the ACCERR flag must be cleared prior to starting a new command write sequence.

18.4.2.3.3 Bus Arbitration During Write Operations

After a command has been successfully launched, the CFM signals the core platform to hold off read accesses to any active flash physical block until all active and buffered commands have completed (CCIF=1). A flash write operation from the internal flash bus holds off the Core platform until it is completed.

18.4.2.3.4 Flash Normal Mode Commands

Table 18-16 summarizes the valid flash normal mode commands.

Table 18-16. CFM Flash Memory Command Description

| CFMCMD | Meaning | Description |
|--------|----------------------|--|
| 0x05 | Blank Check | Verify that the entire flash memory is erased. If all bits are erased, the BLANK bit sets in the CFMUSTAT register, Figure 18-11, upon command completion. |
| 0x06 | Page Erase Verify | Verifies that a flash logical page is erased. If the flash logical page is erased, the BLANK bit sets in the CFMUSTAT register, Figure 18-11, upon command completion. |
| 0x20 | Program | Program a 32-bit word. |
| 0x40 | Page Erase | Erase a flash logical page. |
| 0x41 | Mass Erase | Erase the entire flash memory. All flash memory protection must be disabled. |

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Blank Check

The blank check operation verifies all flash memory addresses in the CFM are erased.

An example flow to execute the blank check command is shown in Figure 18-14. The blank check command write sequence is as follows:

- 1. Write to any flash memory address to start the command write sequence for the blank check command. The specific address and data written during the blank check command write sequence is ignored.
- 2. Write the blank check command, 0x05, to the CFMCMD register.
- 3. Clear the CBEIF flag by writing a 1 to CBEIF to launch the blank check command.

Because all flash physical blocks are verified simultaneously, the number of internal flash bus cycles required to execute the blank check operation on a fully erased flash memory is equal to the number of word addresses in a flash logical block plus 15 internal flash bus cycles as measured from the time the CBEIF flag is cleared until the CCIF flag is set in the CFMUSTAT register. Upon completion of the blank check operation (CCIF=1), the BLANK flag sets in the CFMUSTAT register if the entire flash memory is erased. If any flash memory location is not erased, the blank check operation terminates and the BLANK flag remains clear.

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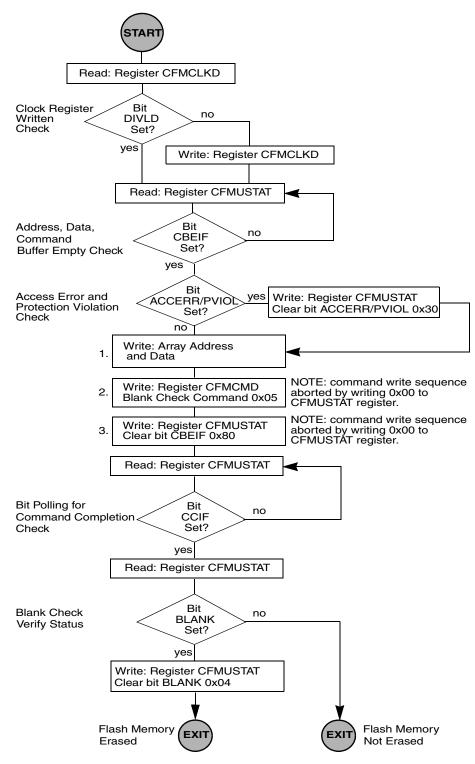


Figure 18-14. Example Blank Check Command Flow

Page Erase Verify

The page erase verify operation verifies all memory addresses in a flash logical page are erased.

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An example flow to execute the page erase verify operation is shown in Figure 18-15. The page erase verify command write sequence is as follows:

- 1. Write to any word address in a flash logical page to start the command write sequence for the page erase verify command. The address written determines the flash logical page to be verified, while the data written during the page erase verify command write sequence is ignored.
- 2. Write the page erase verify command, 0x06, to the CFMCMD register.
- 3. Clear the CBEIF flag by writing a 1 to CBEIF to launch the page erase verify command.

Because the word addresses in even and odd flash blocks are interleaved, pages from adjacent interleaving flash physical blocks are automatically erase verified at the same time. The number of internal flash bus cycles required to execute the page erase verify operation on a fully erased flash logical page is equal to the number of word addresses in a flash logical page plus 15 internal flash bus cycles as measured from the time the CBEIF flag is cleared until the CCIF flag is set in the CFMUSTAT register.

Upon completion of any page erase verify operation (CCIF=1), the BLANK flag in the CFMUSTAT register is set if all addresses in the selected flash logical page are verified to be erased. If any address in the selected flash logical page is not erased, the page erase verify operation terminates and the BLANK flag remains clear.

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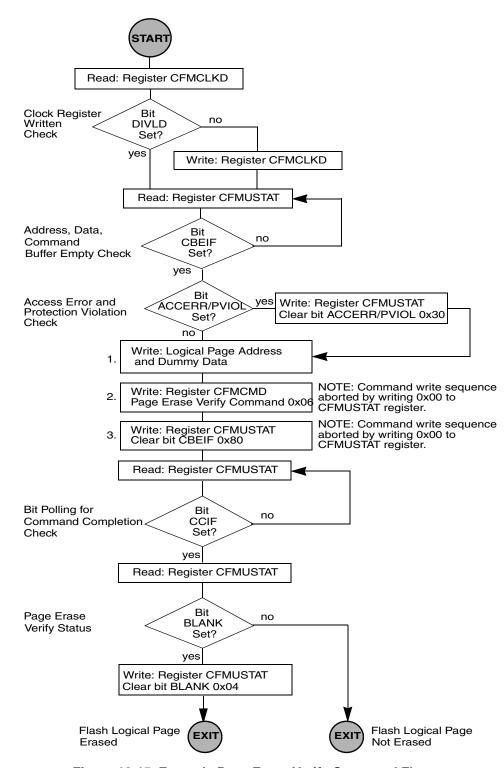


Figure 18-15. Example Page Erase Verify Command Flow

Program

The operation programs a previously erased address in the flash memory using an embedded algorithm.

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An example flow to execute the program operation is shown in Figure 18-16. The program command write sequence is as follows:

1. Write to a word address in a flash physical block to start the command write sequence for the program command. The word address written determines the flash physical block address to program while the data written during the program command write sequence determines the data stored at that address.

To write to two physical blocks simultaneously, perform the following steps:

- a) Write data to even address (where address is a multiple of eight)
- b) Write data to odd address (previous address + 4)
- c) Write PROGRAM command to CFMCMD
- d) Clear CBEIF, by writing a 1 to it

The flash physical block written to in the first array write limits the ability to simultaneously program in block order only those flash physical blocks that remain.

- 2. Write the program command, 0x20, to the CFMCMD register.
- 3. Clear the CBEIF flag by writing a 1 to CBEIF to launch the program command.

If the address to be programmed is in a protected sector of the flash memory, the PVIOL flag in the CFMUSTAT register sets and the program command does not launch. After the program command has successfully launched, the CCIF flag in the CFMUSTAT register sets after the program operation has completed unless a new command write sequence has been buffered.



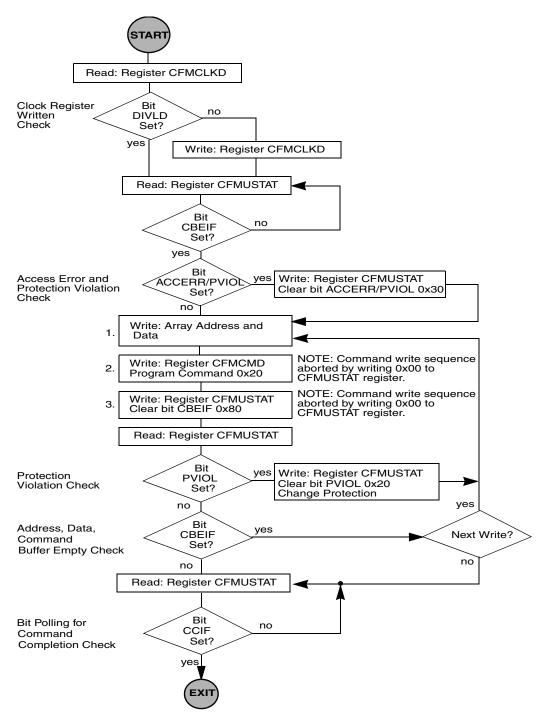


Figure 18-16. Example Program Command Flow

Page Erase

The page erase operation erases all memory addresses in a flash logical page using an embedded algorithm.



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An example flow to execute the page erase operation is shown in Figure 18-17. The page erase command write sequence is as follows:

- 1. Write to any word address in a flash logical page to start the command write sequence for the page erase command. The word address written determines the flash logical page to erase while the data written during the page erase command write sequence is ignored.
- 2. Write the page erase command, 0x40, to the CFMCMD register.
- 3. Clear the CBEIF flag by writing a 1 to CBEIF to launch the page erase command.

If the flash logical page to be erased is in a protected sector of the flash memory, the PVIOL flag in the CFMUSTAT register sets and the page erase command does not launch. After the page erase command has successfully launched, the CCIF flag in the CFMUSTAT register sets after the page erase operation has completed, unless a new command write sequence has been buffered.

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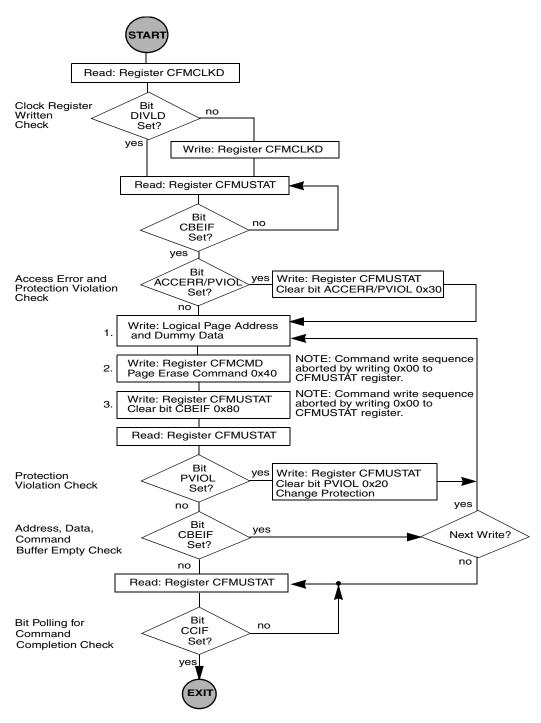


Figure 18-17. Example Page Erase Command Flow

Mass Erase

The mass erase operation erases all flash memory addresses using an embedded algorithm.



ColdFire Flash Module (CFM)

An example flow to execute the mass erase command is shown in Figure 18-18. The mass erase command write sequence is as follows:

- 1. Write to any flash memory address to start the command write sequence for the mass erase command. The specific address and data written during the mass erase command write sequence is ignored.
- 2. Write the mass erase command, 0x41, to the CFMCMD register.
- 3. Clear the CBEIF flag by writing a 1 to CBEIF to launch the mass erase command.

If any flash logical sector is protected, the PVIOL flag in the CFMUSTAT register sets during the command write sequence and the mass erase command does not launch. After the mass erase command has successfully launched, the CCIF flag in the CFMUSTAT register sets after the mass erase operation has completed, unless a new command write sequence has been buffered.

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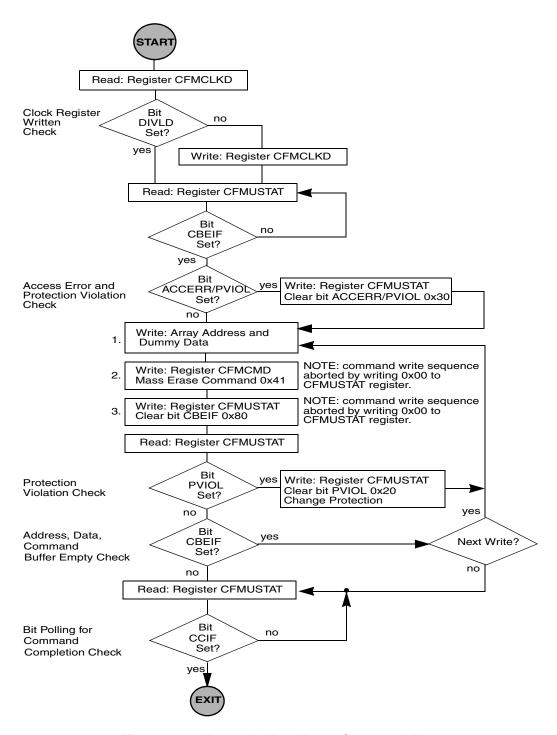


Figure 18-18. Example Mass Erase Command Flow



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18.4.2.3.5 Flash Normal Mode Illegal Operations

The ACCERR flag is set during the command write sequence if any of the following illegal operations are performed, causing the command write sequence to immediately abort:

- Writing to the flash memory before initializing CFMCLKD.
- Writing to the flash memory while CBEIF is not set.
- Writing to a flash block with a data size other than 32 bits.
- After writing to the flash even block, writing an additional word to the flash memory during the flash command write sequence other than the flash odd block.
- Writing an invalid flash normal mode command to the CFMCMD register.
- Writing to any CFM register other than CFMCMD after writing to the flash memory.
- Writing a second command to the CFMCMD register before executing the previously written command.
- Writing to any CFM register other than CFMUSTAT (to clear CBEIF) after writing to the command register, CFMCMD.
- The part enters stop mode and any command is in progress. Upon entering STOP mode, any active command is aborted.
- Aborting a command write sequence by writing a 0 to the CBEIF flag after writing to the flash memory or after writing a command to the CFMCMD register but before the command is launched.

The PVIOL flag is set during the command write sequence if any of the following illegal operations are performed, causing the command write sequence to immediately abort:

- Writing a program command if the address to program is in a protected flash logical sector.
- Writing a page erase command if the address to erase is in a protected flash logical sector.
- Writing a mass erase command while any protection is enabled.

If a read operation is attempted on a flash logical block while a command is active on that logical block (CCIF=0), the read operation returns invalid data and the ACCERR flag in the CFMUSTAT register is not set.

18.4.2.4 Stop Mode

If a command is active (CCIF=0) when the MCU enters stop mode, the flash command controller and flash memory controller performs the following:

- The active command is aborted. Therefore, if data was being programmed, it is now lost.
- The high voltage circuitry to the flash arrays is switched off.
- Any buffered command (CBEIF=0) is not executed after the MCU exits stop mode.
- The CCIF and ACCERR flags is set if a command is active when the MCU enters stop mode.

CAUTION

As active commands are immediately aborted when the MCU enters stop mode, it is strongly recommended not to execute the stop instruction during program and erase operations.

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If a command is not active (CCIF=1) when the MCU enters stop mode, the ACCERR flag does not set.

18.4.3 Flash Security Operation

The CFM provides security information to the integration module and the rest of the MCU. This security information is stored within a word in the flash configuration field. This security word is read automatically after each reset and stored in the CFMSEC register.

NOTE

Enabling flash security disables BDM communications.

In flash normal mode, it is possible to bypass the security via a backdoor access sequence using an 8-byte long key. Upon successful completion of the backdoor access sequence, the SECSTAT bit in the CFMSEC register is cleared indicating that the MCU is unsecured.

The CFM may be unsecured by:

- Executing a backdoor access sequence.
- Passing a blank check operation on the flash memory.
- Executing the JTAG lockout recovery sequence.

18.4.3.1 Backdoor Access Sequence

If the KEYEN bits in the CFMSEC register are set to the enabled state, it is possible to bypass security by:

- 1. Setting the KEYACC bit in the CFMMCR register.
- 2. Writing the correct 8-byte backdoor comparison key to the flash memory at offset 0x0400 0x0407. This operation must be composed of two 32-bit writes to address 0x0400 and 0x0404 in that order. The two backdoor write cycles can be separated by any number of internal flash bus cycles.

NOTE

Any attempt to use a key of all zeros or all ones locks the backdoor access sequence until the CFM is reset.

- 3. Clearing the KEYACC bit.
- 4. If all eight bytes written match the flash memory content at offset 0x0400 0x0407, security is bypassed until the next reset.

In the unsecured state, the software has full control of the contents of the 8-byte backdoor comparison key by programming the bytes at offset 0x0400 - 0x0407 of the flash configuration field. If at any time a key of all zeroes or all ones is received, the backdoor access sequence is terminated and cannot be successfully restarted until after the CFM is reset.

The security of the CFM as defined in the flash security word at address offset 0x0414 is not changed by the executing the backdoor access sequence to unsecure the device. After the next reset sequence, the CFM is secured again and the same backdoor key is in effect unless the flash configuration field was changed by program or erase prior to reset. The backdoor access sequence to unsecure the device has no effect on the program and erase protections defined in the CFM protection register.

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ColdFire Flash Module (CFM)

The contents of the flash security word at address offset 0x0414 must be changed by programming that address when the device is unsecured and the sector containing the flash configuration field is unprotected.

18.4.3.2 **Blank Check**

A secured CFM can be unsecured by verifying that the entire flash memory is erased. If required, the mass erase command can be executed on the flash memory. The blank check command must then be executed on the flash memory. The CFM is unsecured if the blank check operation determines that the entire flash memory is erased. After the next reset sequence, the security state of the CFM is determined by the flash security word at address offset 0x0414. For further details on security, see the MCU security specification.

18.4.3.3 JTAG Lockout Recovery

A secured CFM can be unsecured by mass erasing the flash memory via a sequence of JTAG commands, as specified in the system level security documentation followed by a reset of the MCU.

18.4.3.4 **EzPort Lockout Recovery**

A secured CFM can also be unsecured by mass erasing the flash memory via the EzPort bulk erase (BE) command. Doing so clears the flash security (FS) bit in the EzPort status register, after which a reset chip (RESET) command can be issued to regain access to the device.

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Chapter 19 Mini-FlexBus

19.1 Introduction

This chapter describes external bus data transfer operations and error conditions. It describes transfers initiated by the ColdFire processor (or any other bus master) and includes detailed timing diagrams showing the interaction of signals in supported bus operations.

The Mini-FlexBus is a subset of the FlexBus module found on other ColdFire microprocessors. The Mini-FlexBus minimizes package pin-outs while maintaining a high level of configurability and functionality.

NOTE

- In this chapter, unless otherwise noted, clock refers to the FB_CLK used for the external bus (f_{sys/2} or f_{sys} depending on CCE[MBMOD] in the chip configuration module).
- Most pin functions default to GPIO and must be software configured before using Mini-FlexBus.

19.1.1 **Overview**

A multi-function external bus interface called the Mini-FlexBus interface controller is provided on the device with basic functionality of interfacing to slave-only devices. It can be directly connected to the following asynchronous or synchronous devices with little or no additional circuitry:

- External ROMs
- Flash memories
- Programmable logic devices
- Other simple target (slave) devices

For asynchronous devices, a simple chip-select based interface can be used.

The Mini-FlexBus interface has up to two general purpose chip-selects, $\overline{FB_CS}[1:0]$. The actual number of chip selects available depends upon the device and its pin configuration. Control signal timing is compatible with common ROM and flash memories.

19.1.2 Features

Key Mini-FlexBus features include:

• Two independent, user-programmable chip-select signals (FB_CS[1:0]) that can interface with external SRAM, PROM, EPROM, EEPROM, flash, and other peripherals

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- 8- and 16-bit port sizes with configuration for multiplexed or non-multiplexed address and data buses
- Byte-, word-, longword-, and 16-byte line-sized transfers
- Programmable address-setup time with respect to the assertion of chip select
- Programmable address-hold time with respect to the negation of chip select and transfer direction

19.1.3 Modes of Operation

The external interface is a configurable multiplexed bus set to one of the following modes:

- Up to a 20-bit address (non-multiplexed) with 8-bit data
- Up to a 20-bit address (multiplexed) with 16-bit data (write masking of upper/lower bytes not supported)
- Up to a 20-bit address (multiplexed) with 8-bit data

19.2 External Signals

This section describes the external signals involved in data-transfer operations.

| Signal Name | I/O | Description |
|-------------|-----|---|
| FB_A[19:0] | I/O | In a non-multiplexed configuration: Address bus. In a multiplexed configuration: Address/data bus, FB_AD[19:0]. |
| FB_D[7:0] | I/O | In a non-multiplexed configuration: Data bus. In a multiplexed configuration: Not used. |
| FB_CS[1:0] | 0 | General purpose chip-selects. In multiplexed mode, only FB_CS0 is available. FB_CS1 is multiplexed with FB_ALE on a configurable package pin. |
| FB_OE | 0 | Output enable |
| FB_R/W | 0 | Read/write. 1 = Read, 0 = Write |
| FB_ALE | 0 | Address latch enable. This signal is multiplexed with FB_CS1 on a configurable package pin. |

Table 19-1. Mini-FlexBus Signal Summary

19.2.1 Address and Data Buses (FB_An, FB_Dn, FB_ADn)

In non-multiplexed mode, the FB_An and FB_Dn buses carry the address and data, respectively.

In multiplexed mode, the FB_ADn bus carries the address and data. The full 20-bit address is driven on the first clock of a bus cycle (address phase). Following the first clock, the data is driven on the bus (data phase). During the data phase, the address continues driving on the pins not used for data. For example, in 16-bit mode the address continues driving on FB_AD[19:16] and in 8-bit mode the address continues driving on FB_AD[19:8].

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Chip Selects (FB CS[1:0]) 19.2.2

The chip-select signal indicates which device is selected. A particular chip-select asserts when the transfer address is within the device's address space, as defined in the base- and mask-address registers. The actual number of chip selects available depends upon the pin configuration.

Output Enable (FB OE) 19.2.3

The output enable signal (FB OE) is sent to the interfacing memory and/or peripheral to enable a read transfer. FB OE is only asserted during read accesses when a chip select matches the current address decode.

Read/Write (FB R/W) 19.2.4

The processor drives the FB R/\overline{W} signal to indicate the current bus operation direction. It is driven high during read bus cycles and low during write bus cycles.

19.2.5 Address Latch Enable (FB_ALE)

The assertion of FB ALE indicates that the device has begun a bus transaction and the address and attributes are valid. FB ALE is asserted for one bus clock cycle. FB ALE may be used externally to capture the bus transfer address (Figure 19-7).

19.3 **Memory Map/Register Definition**

The following tables describe the registers and bit meanings for configuring chip-select operation. Table 19-2 shows the chip-select register memory map.

The actual number of chip select registers available depends upon the device and its pin configuration. If the device does not support certain chip select signals or the pin is not configured for a chip-select function, then that corresponding set of chip-select registers has no effect on an external pin.

NOTE

You must set CSMR0[V] before the chip select registers take effect.

Table 19-2. Mini-FlexBus Chip Select Memory Map

| IPSBAR Offset | Register | Width (bits) | Access | Reset Value | Section/ Page |
|------------------------|---|-----------------|--------|-------------|------------------|
| 0x00_0080 0x00_008C | Chip-Select Address Register (CSAR n) $n = 0 - 1$ | 32 | R/W | 0x0000_0000 | 19.3.1/19-4 |
| 0x00_0084 0x00_0090 | Chip-Select Mask Register (CSMR n) n = 0 - 1 | 32 | R/W | 0x0000_0000 | 19.3.2/19-4 |
| 0x00_0088 0x00_0094 | Chip-Select Control Register (CSCR n) n = 0 - 1 | 32 | R/W | See Section | 19.3.3/19-5 |

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19.3.1 Chip-Select Address Registers (CSAR0 – CSAR1)

The CSAR*n* registers specify the chip-select base addresses.

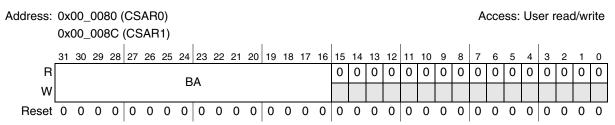


Figure 19-1. Chip-Select Address Registers (CSARn)

Table 19-3. CSARn Field Descriptions

| Field | Description |
|-------|---|
| | Base address. Defines the base address for memory dedicated to chip-select FB_CSn. BA is compared to bits 31–16 on the internal address bus to determine if chip-select memory is being accessed. |
| 15–0 | Reserved, must be cleared. |

19.3.2 Chip-Select Mask Registers (CSMR0 – CSMR1)

CSMR*n* registers specify the address mask and allowable access types for the respective chip-selects.

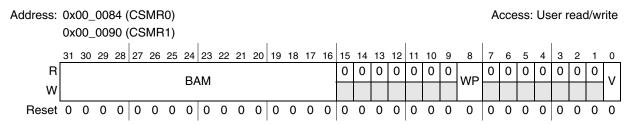


Figure 19-2. Chip-Select Mask Registers (CSMRn)

Table 19-4. CSMRn Field Descriptions

| Field | Description |
|--------------|--|
| 31–16 BAM | Base address mask. Defines the chip-select block size by masking address bits. Setting a BAM bit causes the corresponding CSAR bit to be a don't care in the decode. 0 Corresponding address bit is used in chip-select decode. 1 Corresponding address bit is a don't care in chip-select decode. The block size for FB_CSn is 2 ⁿ ; n = (number of bits set in respective CSMR[BAM]) + 16. For example, if CSAR0[BA] equals 0x8000 and CSMR0[BAM] equals 0x0007, FB_CS0 addresses one 512 KB memory block from 0x8000_0000 – 0x8007_FFFF To access 2 MB of address space starting at location 0x8000_0000, FB_CS1 must begin at the next byte after FB_CS0 for a 1 MB address space. Therefore, CSAR0[BA] equals 0x8000, CSMR0[BAM] equals 0x000F, CSAR1[BA] equals 0x8010, and CSMR1[BAM] equals 0x000F. Then, FB_CS0 addresses one 1 MB memory block from 0x8000_0000 – 0x800F_FFFF. FB_CS1 addresses one 1MB memory block from 0x8010_0000 – 0x801F_FFFF. |
| 15–9 | Reserved, must be cleared. |

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Table 19-4. CSMRn Field Descriptions (Continued)

| Field | Description | | |
|---------|---|--|--|
| 8 WP | Write protect. Controls write accesses to the address range in the corresponding CSAR. Attempting to write to the range of addresses for which CSAR n[WP] is set results in a bus error termination of the internal cycle and no external cycle. O Read and write accesses are allowed Only read accesses are allowed | | |
| 7–1 | Reserved, must be cleared. | | |
| 0 V | Valid bit. Indicates whether the corresponding CSAR, CSMR, and CSCR contents are valid. Programmed chip-selects do not assert until V bit is set. Reset clears each CSMRn[V]. Note: At reset, no chip-select can be used until the CSMR0[V] is set. Afterward, FB_CS[1:0] functions as programmed. O Chip-select invalid Chip-select valid | | |

Chip-Select Control Registers (CSCR0 - CSCR1) 19.3.3

Each CSCRn controls the auto-acknowledge, address setup and hold times, port size, and number of wait states. CSCR0 resets to a value that configures FB CS0 for an 8-bit, non-multiplexed external device.

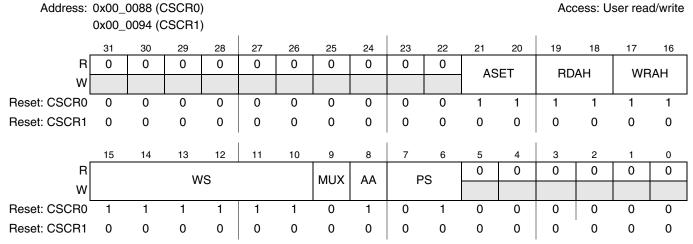


Figure 19-3. Chip-Select Control Registers (CSCRn)

Table 19-5. CSCRn Field Descriptions

| Field | Description |
|---------------|--|
| 31–22 | Reserved, must be cleared |
| 21–20 ASET | Address setup. This field controls the assertion of the chip-select with respect to assertion of a valid address and attributes. The address and attributes are considered valid at the same time FB_ALE asserts. 00 Assert FB_CSn on first rising clock edge after address is asserted. (Default FB_CS1) 01 Assert FB_CSn on second rising clock edge after address is asserted. 10 Assert FB_CSn on fourth rising clock edge after address is asserted. 11 Assert FB_CSn on fourth rising clock edge after address is asserted. (Default FB_CS0) |

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Table 19-5. CSCRn Field Descriptions (Continued)

| Field | Description | | | |
|---------------|---|----------------------------|-----------------|--------------------|
| 19–18 RDAH | Read address hold or deselect. This field controls the address and attribute hold time after the termination during a read cycle that hits in the chip-select address space. Note: The hold time applies only at the end of a transfer. Therefore, during a transfer to a port size smaller than the transfer size, the hold time is only added after the last bus cycle. The number of cycles the address and attributes are held after FB_CSn negation depends on the value of CSCRn[AA] as shown below. | | | |
| | RDAH AA = 1 | | | |
| | | 00 (FB_CS1 Default) | 0 cycles | |
| | | 01 | 1 cycles | - |
| | | 10 | 2 cycles | |
| | | 11 (FB_CS0 Default) | 3 cycles | |
| 17–16 WRAH | Write address hold or deselect. This field controls the address, data, and attribute hold time after the termination of a write cycle that hits in the chip-select address space. Note: The hold time applies only at the end of a transfer. Therefore, during a transfer to a port size smaller than the transfer size, the hold time is only added after the last bus cycle. O0 Hold address and attributes one cycle after FB_CSn negates on writes. (Default FB_CS1) O1 Hold address and attributes two cycles after FB_CSn negates on writes. 10 Hold address and attributes three cycles after FB_CSn negates on writes. 11 Hold address and attributes four cycles after FB_CSn negates on writes. (Default FB_CS0) | | | |
| 15–10 WS | Wait states. The number of wait states inserted after FB_CSn asserts and before an internal transfer acknowledge is generated (WS = 0 inserts zero wait states, WS = 0x3F inserts 63 wait states). | | | |
| 9 MUX | Multiplexed mode. Selects between multiplexed and non-multiplexed address/data bus. 0 Non-multiplexed configuration. Address information is driven on FB_ADn and data is read/written on FB_dn. 1 Multiplexed configuration. Address information is driven on FB_ADn, and low-order address lines (FB_AD[7:0] for byte port size or FB_AD[15:0] for word port size) must be latched using the falling edge of FB_ALE as the latch enable. Data is read/written on FB_AD[7:0] for byte port size and FB_AD[15:0] for word port size. | | | |
| 8 AA | Auto-acknowledge enable. Determines the assertion of the internal transfer acknowledge for accesses specified by the chip-select address. This bit must be set. O Reserved 1 Internal transfer acknowledge is asserted as specified by WS | | | |
| | Note: This bit must be set, since only | internal termination is | supported by th | e iviirii-riexbus. |
| 7–6 PS | Port size. Specifies the data port width associated with each chip-select. It determines where data is driven during write cycles and where data is sampled during read cycles. 00 Reserved 01 8-bit port size. Valid data sampled and driven on FB_D[7:0] 1x 16-bit port size. Valid data sampled and driven on FB_AD[15:0]. Only supported in multiplexed mode. | | | |
| 5–0 | Reserved, must be cleared. | Reserved, must be cleared. | | |

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Functional Description 19.4

19.4.1 **Chip-Select Operation**

Each chip-select has a dedicated set of registers for configuration and control:

- Chip-select address registers (CSARn) control the base address space of the chip-select. See Section 19.3.1, "Chip-Select Address Registers (CSAR0 – CSAR1)."
- Chip-select mask registers (CSMRn) provide 16-bit address masking and access control. See Section 19.3.2, "Chip-Select Mask Registers (CSMR0 – CSMR1)."
- Chip-select control registers (CSCRn) provide port size, wait-state generation, address setup and hold times, and automatic acknowledge generation features. See Section 19.3.3, "Chip-Select Control Registers (CSCR0 – CSCR1)."

19.4.1.1 **General Chip-Select Operation**

When a bus cycle is routed to the Mini-FlexBus, the device first compares its address with the base address and mask configurations programmed for chip-selects 0 and 1 (configured in CSCR0 – CSCR1). The results depend on if the address matches or not as shown in Table 19-6.

| Address Matches CSARn? | Result | | |
|------------------------|--|--|--|
| Yes, one CSAR | The appropriate chip-select is asserted, generating an external bus cycle as defined in the chip-select control register. If CSMR[WP] is set and a write access is performed, the internal bus cycle terminates with a bus error, no chip select is asserted, and no external bus cycle is performed. | | |
| No | The internal bus cycle terminates with a bus error, no chip select is asserted, and no external bus cycle is performed. | | |
| Yes, multiple CSARs | The internal bus cycle terminates with a bus error, no chip select is asserted, and no external bus cycle is performed. | | |

Table 19-6. Results of Address Comparison

19.4.1.2 8- and 16-Bit Port Sizing

Static bus sizing is programmable through the port size bits, CSCR[PS]. The processor always drives a 20-bit address on the FB AD bus regardless of the external device's address size. The external device must connect its address lines to the appropriate FB AD bits from FB AD0 upward. Its data bus must be connected to FB AD[7:0] in non-multiplexed mode (CSCR[MUX] = 0) or FB AD0 to FB ADn in multiplexed mode (CSCR[MUX] = 1) where n = 15 if CSCR[PS] = 1x or n = 7 if CSCR[PS] = 01. No bit ordering is required when connecting address and data lines to the FB AD bus. For example, a full 16-bit address/16-bit data device connects its addr[15:0] to FB AD[16:1] and data[15:0] to FB AD[15:0]. See Figure 19-4 for a graphical connection.

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19.4.1.3 **Global Chip-Select Operation**

Booting from external memory is not supported on this device. Therefore global chip-select operation is not available.

19.4.2 **Data Transfer Operation**

Data transfers between the chip and other devices involve these signals:

- Address/data bus (FB AD[19:0])
- Control signals (FB ALE, FB CSn, FB OE)
- Attribute signals (FB R/\overline{W})

The address, write data, FB ALE, \overline{FB} CSn, and all attribute signals change on the rising edge of the Mini-FlexBus clock (FB CLK). Read data is latched into the device on the rising edge of the clock.

The Mini-FlexBus supports byte-, word-, longword-, and 16-byte (line) operand transfers and allows accesses to 8- and 16-bit data ports. Transfer parameters (address setup and hold, port size, the number of wait states for the external device being accessed, automatic internal transfer termination enable or disable) are programmed in the chip-select control registers (CSCRs). See Section 19.3.3, "Chip-Select Control Registers (CSCR0 – CSCR1)."

19.4.3 **Data Byte Alignment and Physical Connections**

The device aligns data transfers in Mini-FlexBus byte lanes with the number of lanes depending on the data port width. Figure 19-4 shows the byte lanes that external memory connects to and the sequential transfers of a longword transfer for the supported port sizes . For example, an 8-bit memory connects to the single lane FB AD[7:0]. A longword transfer through this 8-bit port takes four transfers, starting with the MSB to the LSB.

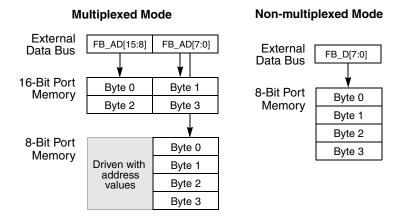


Figure 19-4. Connections for External Memory Port Sizes

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19.4.4 Address/Data Bus Multiplexing

The interface supports a single 20-bit wide multiplexed address and data bus (FB_AD[19:0]). The full 20-bit address is always driven on the first clock of a bus cycle. During the data phase, the FB_AD[15:0] lines used for data are determined by the programmed port size for the corresponding chip select. The device continues to drive the address on any FB_AD[15:0] lines not used for data.

The table below lists the supported combinations of address and data bus widths.

FB_AD Port Size & Phase [19:16] [15:8] [7:0] Address Address phase Data Data phase Address Address phase Address 8-bit Data phase Address Data

Table 19-8.

19.4.5 Bus Cycle Execution

As shown in Figure 19-7 and Figure 19-9, basic bus operations occur in four clocks:

- 1. S0: At the first clock edge, the address, attributes, and FB ALE are driven.
- 2. S1: FB_CSn is asserted at the second rising clock edge to indicate the device selected; by that time, the address and attributes are valid and stable. FB_ALE is negated at this edge. For a write transfer, data is driven on the bus at this clock edge and continues to be driven until one clock cycle after FB_CSn negates. For a read transfer, data is also driven into the device during this cycle.
- 3. S2: Read data is sampled on the third clock edge. After this edge read data can be tri-stated.
- 4. S3: FB_CSn is negated at the fourth rising clock edge. This last clock of the bus cycle uses what would be an idle clock between cycles to provide hold time for address, attributes, and write data.



19.4.5.1 Data Transfer Cycle States

An on-chip state machine controls the data-transfer operation in the device. Figure 19-5 shows the state-transition diagram for basic read and write cycles.

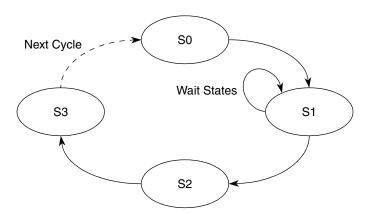


Figure 19-5. Data-Transfer-State-Transition Diagram

Table 19-9 describes the states as they appear in subsequent timing diagrams.

| Table 15 5. But Cycle States | | | | |
|------------------------------|-------|--|--|--|
| State | Cycle | Description | | |
| S0 | All | The read or write cycle is initiated. On the rising clock edge, the device places a valid address on FB_AD[19:0], asserts FB_ALE, and drives FB_R/ \overline{W} high for a read and low for a write. | | |
| S1 | All | FB_ALE is negated on the rising edge of FB_CLK, and FB_CSn is asserted. Data is driven on FB_AD[X:0] for writes, and FB_AD[X:0] is tristated for reads. Address continues to be driven on the FB_AD pins that are unused for data. | | |
| | Read | Data is driven by the external device before the next rising edge of FB_CLK (the rising edge that begins S2). | | |
| S2 | All | FB_CSn is negated and the internal system bus transfer is completed. | | |
| | Read | The processor latches data on the rising clock edge entering S2. The external device can stop driving data after this edge. However, data can be driven until the end of S3 or any additional address hold cycles. | | |
| S3 | All | Address, data, and FB_R/W go invalid off the rising edge of FB_CLK at the beginning of S3, terminating the read or write cycle. | | |

Table 19-9. Bus Cycle States

19.4.6 Mini-FlexBus Timing Examples

19.4.6.1 Basic Read Bus Cycle

During a read cycle, the ColdFire device receives data from memory or a peripheral device. Figure 19-6 is a read cycle flowchart.

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NOTE

Throughout this chapter FB_AD[X:0] indicates a 16-, or 8-bit wide data bus. FB_AD[19:X+I] is an address bus that can be 12-, or 4-bits in width.

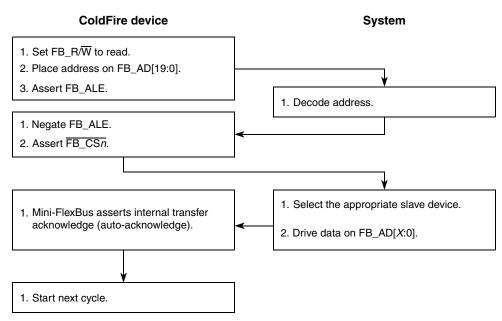


Figure 19-6. Read Cycle Flowchart

The read cycle timing diagram is shown in Figure 19-7.

NOTE

The processor drives the data lines during the first clock cycle of the transfer with the full 20-bit address. This may be ignored by standard connected devices using non-multiplexed address and data buses. However, some applications may find this beneficial.



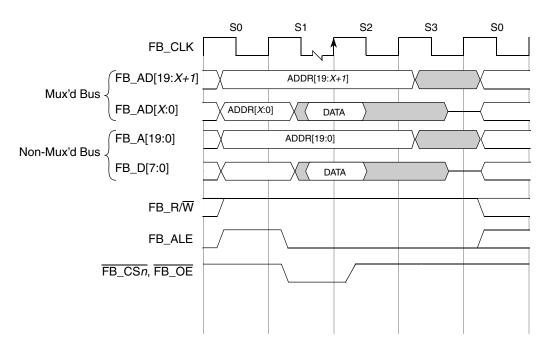


Figure 19-7. Basic Read-Bus Cycle

19.4.6.2 Basic Write Bus Cycle

During a write cycle, the device sends data to memory or to a peripheral device. Figure 19-8 shows the write cycle flowchart.

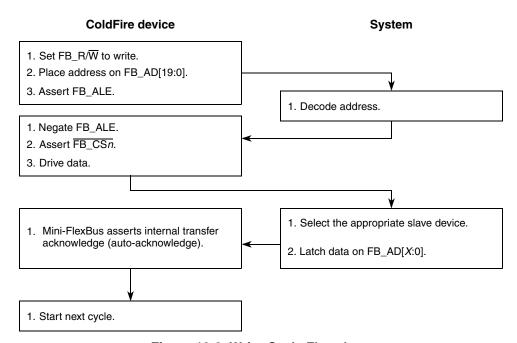


Figure 19-8. Write-Cycle Flowchart

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Figure 19-9 shows the write cycle timing diagram.

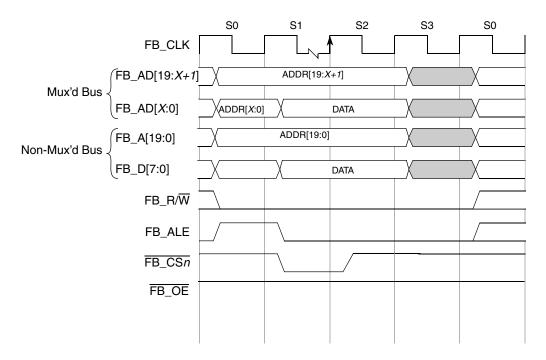


Figure 19-9. Basic Write-Bus Cycle

19.4.6.3 Bus Cycle Sizing

This section shows timing diagrams for various port size scenarios. Figure 19-10 illustrates the basic byte read transfer to an 8-bit device with no wait states. The address is driven on the full FB_AD[19:8] bus in



the first clock. The device tristates FB_AD[7:0] on the second clock and continues to drive address on FB AD[19:8] throughout the bus cycle. The external device returns the read data on FB AD[7:0].

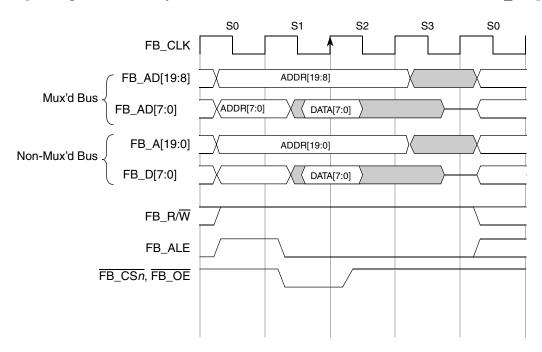


Figure 19-10. Single Byte-Read Transfer

Figure 19-11 shows the similar configuration for a write transfer. The data is driven from the second clock on FB_AD[7:0].

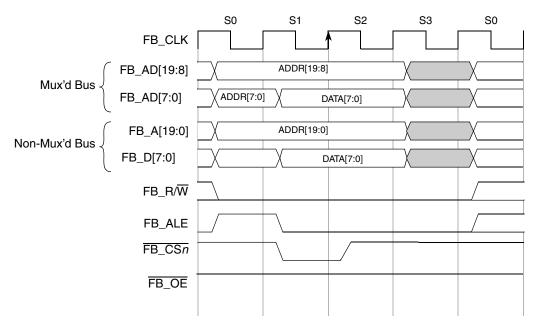


Figure 19-11. Single Byte-Write Transfer

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Figure 19-12 illustrates the basic word read transfer to a 16-bit device with no wait states. The address is driven on the full FB_AD[19:0] bus in the first clock. The device tristates FB_AD[15:0] on the second clock and continues to drive the address on FB_AD[19:16] throughout the bus cycle. The external device returns the read data on FB_AD[15:0].

NOTE

In non-multiplexed mode, the Mini-FlexBus does not support connection to a 16-bit device.

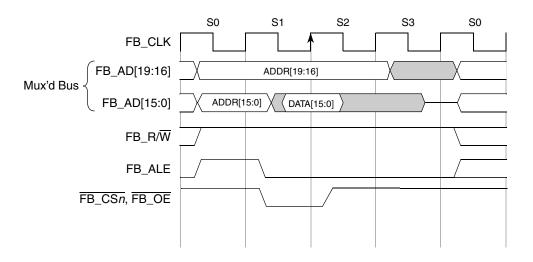


Figure 19-12. Single Word-Read Transfer

Figure 19-13 shows the similar configuration for a write transfer. The data is driven from the second clock on FB AD[15:0].

NOTE

In non-multiplexed mode, the Mini-FlexBus does not support connection to a 16-bit device.



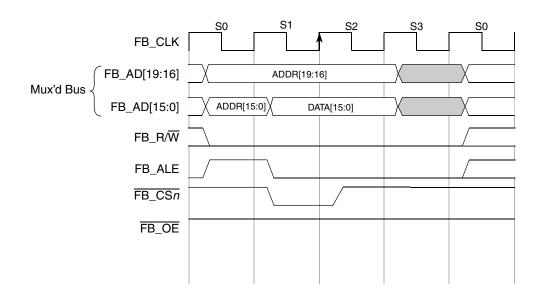


Figure 19-13. Single Word-Write Transfer

19.4.6.4 Timing Variations

The Mini-FlexBus module has several features that can change the timing characteristics of a basic reador write-bus cycle to provide additional address setup, address hold, and time for a device to provide or latch data.

19.4.6.4.1 Wait States

Wait states can be inserted before each beat of a transfer by programming the CSCR*n* registers. Wait states can give the peripheral or memory more time to return read data or sample write data.

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Figure 19-14 and Figure 19-15 show the basic read and write bus cycles (also shown in Figure 19-7 and Figure 19-12) with the default of no wait states.

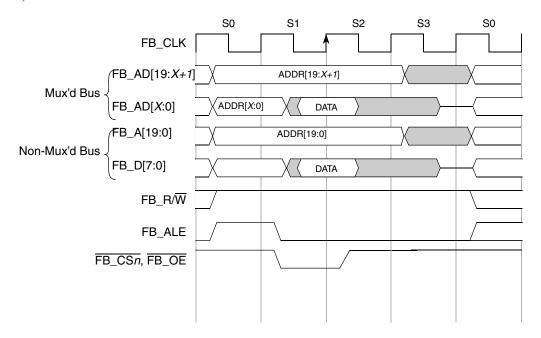


Figure 19-14. Basic Read-Bus Cycle (No Wait States)

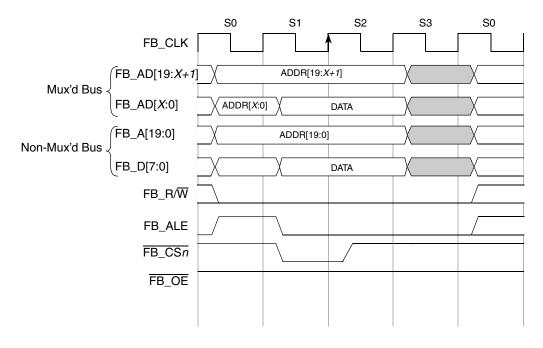


Figure 19-15. Basic Write-Bus Cycle (No Wait States)



If wait states are used, the S1 state repeats continuously until the chip-select auto-acknowledge unit asserts internal transfer acknowledge. Figure 19-16 and Figure 19-17 show a read and write cycle with one wait state.

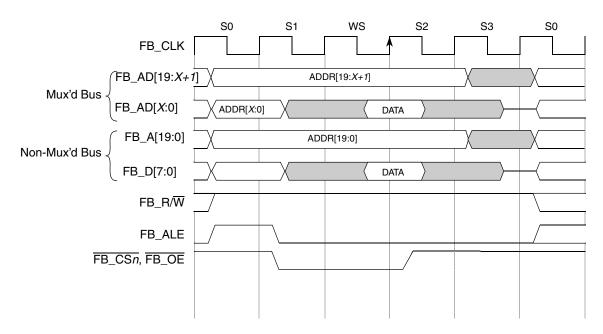


Figure 19-16. Read-Bus Cycle (One Wait State)

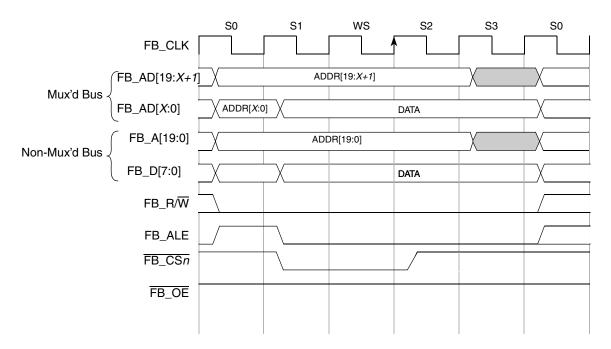


Figure 19-17. Write-Bus Cycle (One Wait State)

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19.4.6.4.2 Address Setup and Hold

The timing of the assertion and negation of the chip selects, byte selects, and output enable can be programmed on a chip-select basis. Each chip-select can be programmed to assert one to four clocks after address-latch enable (FB_ALE) is asserted. Figure 19-18 and Figure 19-19 show read- and write-bus cycles with two clocks of address setup.

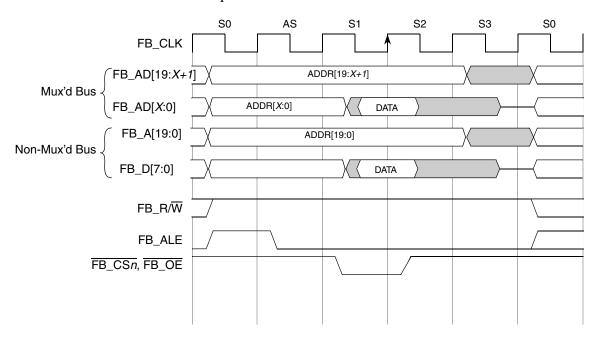


Figure 19-18. Read-Bus Cycle with Two-Clock Address Setup (No Wait States)

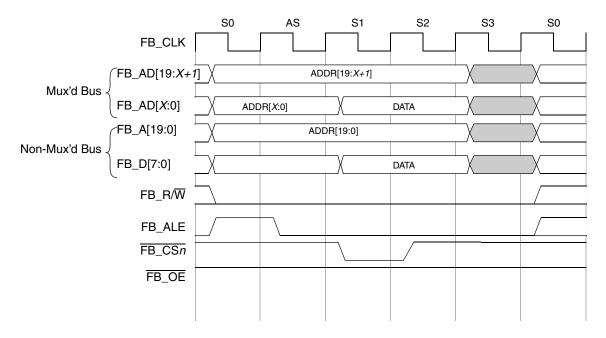


Figure 19-19. Write-Bus Cycle with Two Clock Address Setup (No Wait States)

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In addition to address setup, a programmable address hold option for each chip select exists. Address and attributes can be held one to four clocks after chip-select, byte-selects, and output-enable negate. Figure 19-20 and Figure 19-21 show read and write bus cycles with two clocks of address hold.

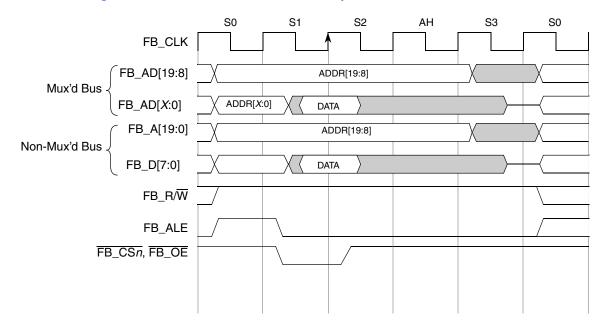


Figure 19-20. Read Cycle with Two-Clock Address Hold (No Wait States)

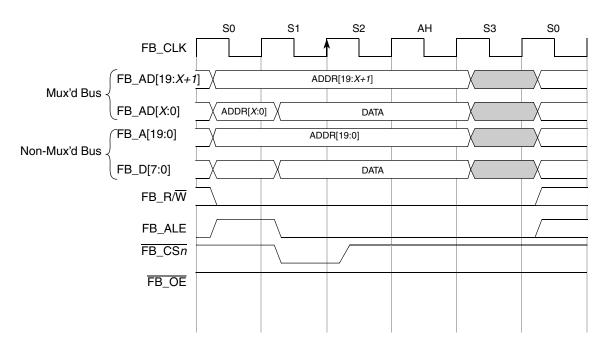
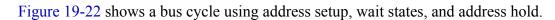


Figure 19-21. Write Cycle with Two-Clock Address Hold (No Wait States)

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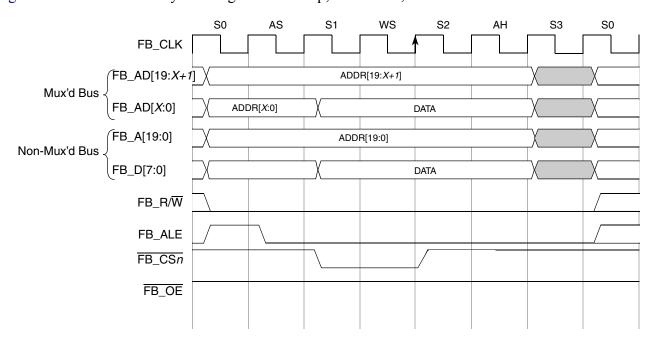


Figure 19-22. Write Cycle with Two-Clock Address Setup and Two-Clock Hold (One Wait State)

19.4.7 Bus Errors

There are certain accesses to the Mini-FlexBus that cause the system bus to hang. It is important to have a good access-error handler to manage these conditions.

One such access is if CSCRn[AA] is cleared, the system hangs. Four other types of accesses cause the access to terminate with a bus error.

- Mini-Flexbus module disabled using the platform peripheral power management control.
 Mini-FlexBus accesses cause an error termination on the bus and prohibit the access to the Mini-FlexBus.
- Attempted writes to space defined as write protected (CSMRn[WP] is set) are terminated with an error response and the access is inhibited to the Mini-FlexBus.
- Mini-FlexBus access not hitting in either chip select region is terminated with an error response and the access is inhibited to the Mini-FlexBus.
- Mini-FlexBus access hitting in both chip select regions is terminated with an error response and the access is inhibited to the Mini-FlexBus



Chapter 20 Universal Serial Bus, OTG Capable Controller

NOTE

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This chapter describes the USB Dual Mode FS/LS Host - FS Device Controller and Universal Serial Bus (USB) interface, which implements many industry standards. However, it is beyond the scope of this document to document the intricacies of these standards. Instead, it is left to the reader to refer to the governing specifications.

The following documents are available from the USB Implementers Forum web page at http://www.usb.org/developers/docs:

- Universal Serial Bus Specification, Revision 1.1
- On-The-Go Supplement to the USB 2.0 Specification, Revision 1.0a

20.1 Introduction

This section describes the USB Dual-Mode (DM) controller. The OTG implementation in this module provides limited host functionality as well as device FS solutions for implementing a USB 2.0 full-speed/low-speed compliant peripheral. The OTG implementation supports the On-The-Go (OTG) addendum to the USB 2.0 Specification. Only one protocol can be active at any time. A negotiation protocol must be used to switch to a USB host functionality from a USB device. This is known as the Master Negotiation Protocol (MNP).

20.1.1 USB

The USB is a cable bus that supports data exchange between a host computer and a wide range of simultaneously accessible peripherals. The attached peripherals share USB bandwidth through a host-scheduled, token-based protocol. The bus allows peripherals to be attached, configured, used, and detached while the host and other peripherals are in operation.



Universal Serial Bus, OTG Capable Controller

USB software provides a uniform view of the system for all application software, hiding implementation details making application software more portable. It manages the dynamic attach and detach of peripherals.

There is only one host in any USB system. The USB interface to the host computer system is referred to as the Host Controller.

There may be multiple USB devices in any system such as joysticks, speakers, printers, etc. USB devices present a standard USB interface in terms of comprehension, response, and standard capability.

The host initiates transactions to specific peripherals, while the device responds to control transactions. The device sends and receives data to and from the host using a standard USB data format. USB 2.0 full-speed /low-speed peripherals operate at 12Mb/s or 1.5 MB/s.

For additional information, refer to the USB2.0 specification [2].

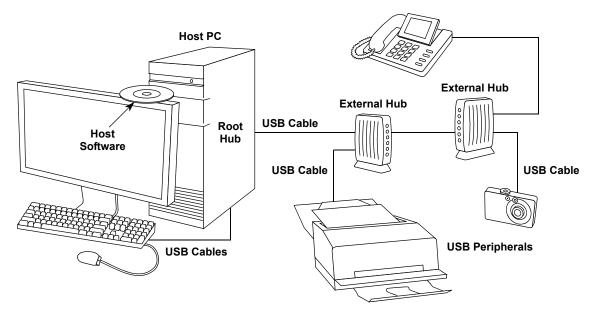


Figure 20-1. Example USB 2.0 System Configuration

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20.1.2 USB On-The-Go

USB (Universal Serial Bus) is a popular standard for connecting peripherals and portable consumer electronic devices such as digital cameras and hand-held computers to host PCs. The On-The-Go (OTG) Supplement to the USB Specification extends USB to peer-to-peer application. Using USB OTG technology consumer electronics, peripherals and portable devices can connect to each other (for example, a digital camera can connect directly to a printer, or a keyboard can connect to a Personal Digital Assistant) to exchange data.

With the USB On-The-Go product, you can develop a fully USB-compliant peripheral device that can also assume the role of a USB host. Software determines the role of the device based on hardware signals, and then initializes the device in the appropriate mode of operation (host or peripheral) based on how it is connected. After connecting the devices can negotiate using the OTG protocols to assume the role of host or peripheral based on the task to be accomplished.

For additional information, refer to the *On-The-Go Supplement to the USB 2.0 Specification* [3].

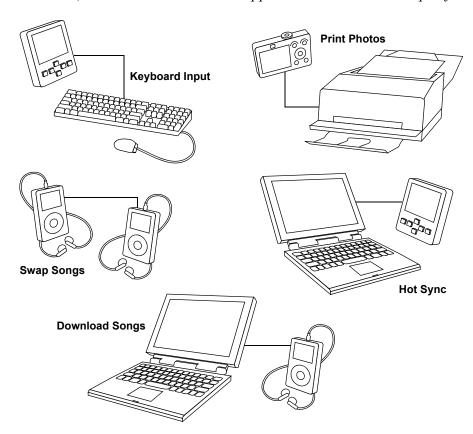


Figure 20-2. Example USB 2.0 On-The-Go Configurations



20.1.3 USB-FS Features

- USB 1.1 and 2.0 compliant full-speed device controller
- 16-Bidirectional end points
- DMA or FIFO data stream interfaces
- Low-power consumption
- On-The-Go protocol logic

20.2 Functional Description

The USB-FS 2.0 full-speed/low-speed module communicates with the ColdFire processor core through status and control registers, and data structures in memory.

20.2.1 Data Structures

The function of the device operation is to transfer a request in the memory image to and from the Universal Serial Bus. To efficiently manage USB endpoint communications the USB-FS implements a Buffer Descriptor Table (BDT) in system memory. See Figure 20-3.

20.3 Programmers Interface

20.3.1 Buffer Descriptor Table

To efficiently manage USB endpoint communications the USB-FS implements a Buffer Descriptor Table (BDT) in system memory. The BDT resides on a 512 byte boundary in system memory and is pointed to by the BDT Page Registers. Every endpoint direction requires two eight-byte Buffer Descriptor entries. Therefore, a system with 16 fully bidirectional endpoints would require 512 bytes of system memory to implement the BDT. The two Buffer Descriptor (BD) entries allows for an EVEN BD and ODD BD entry for each endpoint direction. This allows the microprocessor to process one BD while the USB-FS is processing the other BD. Double buffering BDs in this way allows the USB-FS to easily transfer data at the maximum throughput provided by USB.

The software API intelligently manages buffers for the USB-FS by updating the BDT when needed. This allows the USB-FS to efficiently manage data transmission and reception, while the microprocessor performs communication overhead processing and other function dependent applications. Because the buffers are shared between the microprocessor and the USB-FS a simple semaphore mechanism is used to distinguish who is allowed to update the BDT and buffers in system memory. A semaphore bit, the OWN bit, is cleared to 0 when the BD entry is owned by the microprocessor. The microprocessor is allowed read and write access to the BD entry and the buffer in system memory when the OWN bit is 0. When the OWN bit is set to 1, the BD entry and the buffer in system memory are owned by the USB-FS. The USB-FS now has full read and write access and the microprocessor should not modify the BD or its corresponding data buffer. The BD also contains indirect address pointers to where the actual buffer resides in system memory. This indirect address mechanism is shown in the following diagram.

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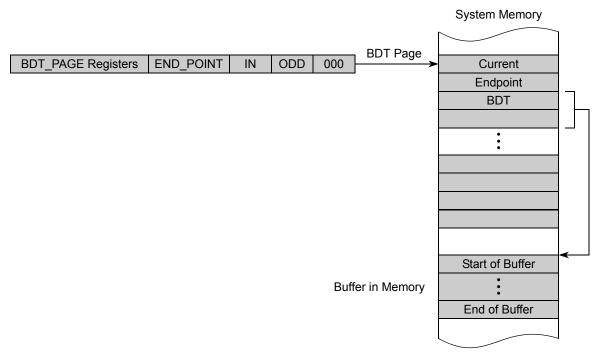


Figure 20-3. Buffer Descriptor Table

20.3.2 Rx vs. Tx as a USB Target Device or USB Host

The USB-FS core can function as a USB target device (function), or as a USB hosts, and may switch modes of operation between host and target device under software control. In either mode, USB host or USB target device, the same data paths and buffer descriptors are used for the transmission and reception of data. For this reason, a USB-FS core centric nomenclature is used to describe the direction of the data transfer between the USB-FS core and the USB. Rx or receive is used to describe transfers that move data from the USB to memory, and Tx, or transmit is used to describe transfers that move data from memory to the USB. The following table shows how the data direction corresponds to the USB token type in host and target device applications.

Table 20-1. Data Direction for USB Host or USB Target

| | Rx | Тх |
|--------|--------------|--------------|
| Device | OUT or Setup | IN |
| Host | IN | Out or Setup |

20.3.3 Addressing Buffer Descriptor Table Entries

To access endpoint data via the USB-FS or microprocessor, the addressing mechanism of the Buffer Descriptor Table must be understood. As stated earlier, the Buffer Descriptor Table occupies up to 512 bytes of system memory. Sixteen bidirectional endpoints can be supported with a full BDT of 512 bytes. Sixteen bytes are needed for each USB endpoint direction. Applications with less than 16 End Points require less RAM to implement the BDT. The BDT Page Registers point to the starting location of the

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BDT. The BDT must be located on a 512-byte boundary in system memory. All enabled TX and RX endpoint BD entries are indexed into the BDT to allow easy access via the USB-FS or ColdFire Core.

When the USB-FS receives a USB token on an enabled endpoint it uses its integrated DMA controller to interrogate the BDT. The USB-FS must read the corresponding endpoint BD entry and determine if it owns the BD and corresponding buffer in system memory. To compute the entry point in to the BDT, the BDT_PAGE registers is concatenated with the current endpoint and the TX and ODD fields to form a 32-bit address. This address mechanism is shown in the following diagrams:

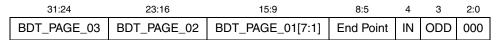


Figure 20-4. BDT Address Calculation

Table 20-2. BDT Address Calculation Fields

| Field | Description |
|-----------|---|
| BDT_PAGE | BDT_PAGE registers in the Control Register Block |
| END_POINT | END POINT field from the USB TOKEN |
| TX | 1 for an TX transmit transfers and 0 for an RX receive transfers |
| ODD | This bit is maintained within the USB-FS SIE. It corresponds to the buffer currently in use. The buffers are used in a ping-pong fashion. |

20.3.4 Buffer Descriptor Formats

The Buffer Descriptors (BD) provide endpoint buffer control information for the USB-FS and microprocessor. The Buffer Descriptors have different meaning based on who is reading the BD in memory. The USB-FS Controller uses the data stored in the BDs to determine:

- Who owns the buffer in system memory
- Data0 or Data1 PID
- Release Own upon packet completion
- No address increment (FIFO Mode)
- Data toggle synchronization enable
- How much data is to be transmitted or received
- Where the buffer resides in system memory

While the microprocessor uses the data stored in the BDs to determine:

- Who owns the buffer in system memory
- Data0 or Data1 PID
- The received TOKEN PID
- How much data was transmitted or received
- Where the buffer resides in system memory

The format for the BD is shown in the following figure.

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| 31:26 | 25:16 | 15:8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|-----------------|------|-----|---------|---------------------|---------------------|----------------------|--------------------------|---|---|
| RSVD | BC (10-Bits) | RSVD | OWN | DATA0/1 | KEEP/ TOK_PID[3] | NINC/ TOK_PID[2] | DTS/ 5 TOK_PID[1] | BDT_STALL/ TOK_PID[0] | 0 | 0 |
| | | | | ! | Buffer Address (| 32-Bits) | | | | |

Figure 20-5. Buffer Descriptor Byte Format

Table 20-3. Buffer Descriptor Byte Fields

| Field | Description |
|------------------------------|--|
| 31 – 26 RSVD | Reserved |
| 25 – 16 BC[9:0] | The Byte Count bits represent the 10-bit Byte Count. The USB-FS SIE changes this field upon the completion of a RX transfer with the byte count of the data received. |
| 15 – 8 RSVD | Reserved |
| 7 OWN | If OWN=1 USB-FS has exclusive access to the BD. If OWN=0 the microprocessor has exclusive access to the BD. This OWN bit determines who currently owns the buffer. The SIE generally writes a 0 to this bit when it has completed a token, except when KEEP=1. The USB-FS ignores all other fields in the BD when OWN=0. The microprocessor has access to the entire BD when OWN=0. This byte of the BD should always be the last byte the microprocessor updates when it initializes a BD. After the BD has been assigned to the USB-FS, the microprocessor should not change it in any way. |
| 6 DATA0/1 | This bit defines if a DATA0 field (DATA0/1=0) or a DATA1 (DATA0/1=1) field was transmitted or received. It is unchanged by the USB-FS. |
| 5 KEEP/ TOK_PID[3] | If KEEP equals 1, after the OWN bit is set it remains owned by the USB-FS forever. KEEP must equal 0 to allow the USB-FS to release the BD when a token has been processed. Typically this bit is set to 1 with ISO endpoints that are feeding a FIFO. The microprocessor is not informed that a token has been processed, the data is simply transferred to or from the FIFO. The NINC bit is normally also set when KEEP=1 to prevent address increment. If KEEP=1 this bit is unchanged by the USB-FS, otherwise bit 3 of the current token PID is written back in to the BD by the USB-FS. |
| 4 NINC/ TOK_PID[2] | The No INCrement bit disables the DMA engine address increment. This forces the DMA engine to read or write from the same address. This is useful for endpoints when data needs to be read from or written to a single location such as a FIFO. Typically this bit is set with the KEEP bit for ISO endpoints that are interfacing to a FIFO. If KEEP=1 this bit is unchanged by the USB-FS, otherwise bit 2 of the current token PID is written back in to the BD by the USB-FS. |
| 3 DTS/ TOK_PID[1] | Setting this bit enables the USB-FS to perform Data Toggle Synchronization. When this bit is 0 no Data Toggle Synchronization is performed. If KEEP=1 this bit is unchanged by the USB-FS, otherwise bit 1 of the current token PID is written back in to the BD by the USB-FS. |
| 2 BDT_STALL TOK_PID[0] | Setting this bit causes the USB-FS to issue a STALL handshake if a token is received by the SIE that would use the BDT in this location. The BDT is not consumed by the SIE (the owns bit remains and the rest of the BDT are unchanged) when a BDT-STALL bit is set. If KEEP=1 this bit is unchanged by the USB-FS, otherwise bit 0 of the current token PID is written back in to the BD by the USB-FS |
| TOK_PID[n] | Bits [5:2] can also represent the current token PID. The current token PID is written back in to the BD by the USB-FS when a transfer completes. The values written back are the token PID values from the USB specification: 0x1 for an OUT token, 0x9 for and IN token or 0xd for a SETUP token. In host mode this field is used to report the last returned PID or a transfer status indication. The possible values returned are: 0x3 DATA0, 0xb DATA1, 0x2 ACK, 0xe STALL, 0xa NAK, 0x0 Bus Timeout, 0xf Data Error. |



Table 20-3. Buffer Descriptor Byte Fields (continued)

| 1–0 Reserved | Reserved, should read as zeroes |
|-----------------|---|
| ADDR[31:0] | The Address bits represent the 32 -bit buffer address in system memory. These bits are unchanged by the USB-FS. |

20.3.5 USB Transaction

When the USB-FS transmits or receives data, it computes the BDT address using the address generation shown in Table 2. After the BDT has been read and if the OWN bit equals 1, the SIE transfers the data via the DMA to or from the buffer pointed to by the ADDR field of the BD. When the TOKEN is complete, the USB-FS updates the BDT and change the OWN bit to 0 if KEEP is 0. The STAT register is updated and the TOK_DNE interrupt is set. When the microprocessor processes the TOK_DNE interrupt it reads the status register, this gives the microprocessor all the information it needs to process the endpoint. At this point, the microprocessor allocates a new BD so additional USB data can be transmitted or received for that endpoint, and process then the last BD. The following figure shows a time line how a typical USB token would be processed.

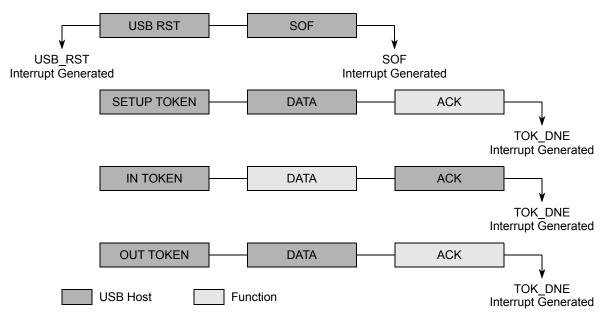


Figure 20-6. USB Token Transaction

The USB has two sources for the DMA overrun error. First, the memory latency on the BVCI initiator interface may be too high and cause the receive FIFO to overflow. This is predominantly a hardware performance issue, usually caused by transient memory access issues. Second, the packet received may be larger than the negotiated *MaxPacket* size. This would be caused by a software bug.

In the first case, the USB responds with a NAK or Bus Timeout (BTO - See bit 4 in Section 20.4.1.11, "Error Interrupt Status Register (ERR_STAT)") as appropriate for the class of transaction. The DMA_ERR bit is set in the ERR_STAT register of the core for host and device modes of operation. Depending on the values of the INT_ENB and ERR_ENB register, the core may assert an interrupt to notify the processor of the DMA error. In device mode, the BDT is not written back nor is the TOK_DNE interrupt triggered

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because it is assumed that a second attempt is queued and succeed in the future. For host mode, the TOK_DNE interrupt fires and the TOK_PID field of the BDT is 1111 to indicate the DMA latency error. Host mode software can decide to retry or move to another item in its schedule.

In the second case of oversized data packets the USB specification is ambiguous. It assumes correct software drivers on both sides. The overrun is not due to memory latency but due to a lack of space to put the excess data. NAKing the packet may cause another retransmission of the already oversized packet data. In response to oversized packets, the USB core continues ACKing the packet for non-isochronous transfers. The data written to memory is clipped to the MaxPacket size so as not to corrupt system memory. The core asserts the DMA_ERR bit of the ERR_STAT register (which could trigger an interrupt, as above) and a TOK_DNE interrupt fires. The TOK_PID field of the BDT is not 1111 because the DMA_ERR is not due to latency. The packet length field written back to the BDT is the MaxPacket value that represents the length of the clipped data actually written to memory. The software can decide an appropriate course of action from here for future transactions such as stalling the endpoint, canceling the transfer, disabling the endpoint, etc.

20.4 Memory Map/Register Definitions

This section provides the memory map and detailed descriptions of all USB interface registers. The memory map of the USB interface is shown in Table 20-4.

| Address | Register | Acronym | Bits |
|--------------------|-------------------------------------|--------------|------|
| | USB OTG Registers | | |
| IPSBAR + 0x1C_0000 | Peripheral ID Register | PER_ID | 8 |
| IPSBAR + 0x1C_0004 | Peripheral ID Complement Register | ID_COMP | 8 |
| IPSBAR + 0x1C_0008 | Peripheral Revision Register | REV | 8 |
| IPSBAR + 0x1C_000C | Peripheral Additional Info Register | ADD_INFO | 8 |
| IPSBAR + 0x1C_0010 | OTG Interrupt Status Register | OTG_INT_STAT | 8 |
| IPSBAR + 0x1C_0014 | OTG Interrupt Control Register | OTG_INT_EN | 8 |
| IPSBAR + 0x1C_0018 | OTG Status Register | OTG_STATUS | 8 |
| IPSBAR + 0x1C_001C | OTG Control Register | OTG_CTRL | 8 |
| IPSBAR + 0x1C_0080 | Interrupt Status Register | INT_STAT | 8 |
| IPSBAR + 0x1C_0084 | Interrupt Enable Register | INT_ENB | 8 |
| IPSBAR + 0x1C_0088 | Error Interrupt Status Register | ERR_STAT | 8 |
| IPSBAR + 0x1C_008C | Error Interrupt Enable Register | ERR_ENG | 8 |
| IPSBAR + 0x1C_0090 | Status Register | STAT | 8 |
| IPSBAR + 0x1C_0094 | Control Register | CTL | 8 |
| IPSBAR + 0x1C_0098 | Address Register | ADDR | 8 |
| IPSBAR + 0x1C_009C | BDT Page Register 1 | BDT_PAGE_01 | 8 |
| IPSBAR + 0x1C_00A0 | Frame Number Register Low | FRM_NUML | 8 |

Table 20-4. USB Interface Memory Map

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Table 20-4. USB Interface Memory Map (continued)

| Address | Register | Acronym | Bits |
|--------------------|------------------------------|-----------------|------|
| IPSBAR + 0x1C_00A4 | Frame Number Register High | FRM_NUMH | 8 |
| IPSBAR + 0x1C_00A8 | Token Register | TOKEN | 8 |
| IPSBAR + 0x1C_00AC | SOF Threshold Register | SOF_THLD | 8 |
| IPSBAR + 0x1C_00B0 | BDT Page Register 2 | BDT_PAGE_02 | 8 |
| IPSBAR + 0x1C_00B4 | BDT Page Register 3 | BDT_PAGE_03 | 8 |
| IPSBAR + 0x1C_00C0 | Endpoint Control Register 0 | ENDPT0 | 8 |
| IPSBAR + 0x1C_00C4 | Endpoint Control Register 1 | ENDPT1 | 8 |
| IPSBAR + 0x1C_00C8 | Endpoint Control Register 2 | ENDPT2 | 8 |
| IPSBAR + 0x1C_00CC | Endpoint Control Register 3 | ENDPT3 | 8 |
| IPSBAR + 0x1C_00D0 | Endpoint Control Register 4 | ENDPT4 | 8 |
| IPSBAR + 0x1C_00D4 | Endpoint Control Register 5 | ENDPT5 | 8 |
| IPSBAR + 0x1C_00D8 | Endpoint Control Register 6 | ENDPT6 | 8 |
| IPSBAR + 0x1C_00DC | Endpoint Control Register 7 | ENDPT7 | 8 |
| IPSBAR + 0x1C_00E0 | Endpoint Control Register 8 | ENDPT8 | 8 |
| IPSBAR + 0x1C_00E4 | Endpoint Control Register 9 | ENDPT9 | 8 |
| IPSBAR + 0x1C_00E8 | Endpoint Control Register 10 | ENDPT10 | 8 |
| IPSBAR + 0x1C_00EC | Endpoint Control Register 11 | ENDPT11 | 8 |
| IPSBAR + 0x1C_00F0 | Endpoint Control Register 12 | ENDPT12 | 8 |
| IPSBAR + 0x1C_00F4 | Endpoint Control Register 13 | ENDPT13 | 8 |
| IPSBAR + 0x1C_00F8 | Endpoint Control Register 14 | ENDPT14 | 8 |
| IPSBAR + 0x1C_00FC | Endpoint Control Register 15 | ENDPT15 | 8 |
| IPSBAR + 0x1C_0100 | USB Control Register | USB_CTRL | 8 |
| IPSBAR + 0x1C_0104 | USB OTG Observe Register | USB_OTG_OBSERVE | 8 |
| IPSBAR + 0x1C_0108 | USB OTG Control Register | USB_OTG_CONTROL | 8 |

The following sections provide details about the registers in the USB OTG memory map.

20.4.1 Capability Registers

The capability registers specify the software limits, restrictions, and capabilities of the host/device controller implementation. Most of these registers are defined by the EHCI specification. Registers that are not defined by the EHCI specification are noted in their descriptions.

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20.4.1.1 Peripheral ID Register (PER_ID)

The Peripheral ID Register reads back the value of 0x04. This value is defined for the USB Peripheral. Figure 20-7 shows the PER ID register.

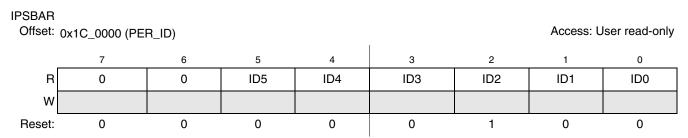


Figure 20-7. Peripheral ID Register (PER_ID)

Table 20-11. PER_ID Field Descriptions

| Field | Description |
|--------------------|--|
| 7–6 | These bits always read zeros |
| 5–0 ID <i>x</i> | Peripheral identification bits. These bits always read 0x04 (00_0100). |

20.4.1.2 Peripheral ID Complement Register (ID_COMP)

The Peripheral ID Complement Register reads back the complement of the Peripheral ID Register. For the USB Peripheral, this is the value 0xFB. Figure 20-8 shows the ID COMP register.

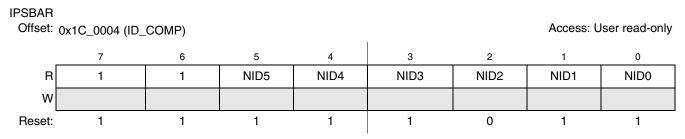


Figure 20-8. Peripheral ID Complement Register

Table 20-12. ID_COMP Field Descriptions

| Field | Description |
|---------------------|--|
| 7–6 | These bits always read ones |
| 5–0 NID <i>x</i> | Ones complement of peripheral identification bits. |

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20.4.1.3 Peripheral Revision Register (REV)

This register contains the revision number of the USB Module. Figure 20-9 shows the REV register.

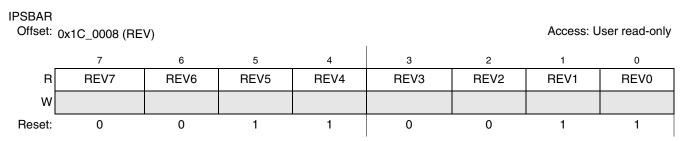


Figure 20-9. Peripheral Revision Register

Table 20-13. REV Field Descriptions

| Field | Description |
|---------------------|--|
| 7–0 REV <i>x</i> | REV[7:0] indicate the revision number of the USB Core. |

20.4.1.4 Peripheral Additional Info Register (ADD_INFO)

The Peripheral Additional info Register reads back the value of the fixed Interrupt Request Level (IRQ_NUM) along with the Host Enable bit. If set to 1, the Host Enable bit indicates the USB peripheral is operating in host mode. Figure 20-10 shows the ADD_INFO register.

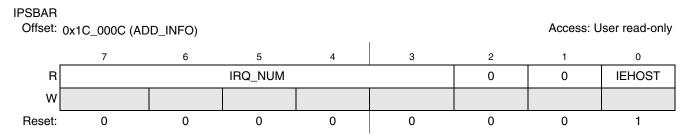


Figure 20-10. Peripheral Additional Info Register

Table 20-14. ADD_INFO Field Descriptions

| Field | Description |
|-----------------|--|
| 7–3 IRQ_NUM | Assigned Interrupt Request Number. |
| 2–1 Reserved | RESERVED. These bits read back zeros. |
| 0 IEHOST | This bit is set if host mode is enabled. |

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20.4.1.5 OTG Interrupt Status Register (OTG_INT_STAT)

The OTG Interrupt Status Register records changes of the ID sense and VBUS signals. Software can read this register to determine which event has caused an interrupt. Only bits that have changed since the last software read are set. Writing a one to a bit clears the associated interrupt. Figure 20-11 shows the OTG INT STAT register.



Figure 20-11. OTG Interrupt Status Register

Table 20-15. OTG_INT_STAT Field Descriptions

| Field | Description |
|------------------------|---|
| 7 ID_CHG | This bit is set when a change in the ID Signal from the USB connector is sensed. |
| 6 1_MSEC | This bit is set when the 1 millisecond timer expires. This bit stays asserted until cleared by software. The interrupt must be serviced every millisecond to avoid losing 1msec counts. |
| 5 LINE_STAT _CHG | This bit is set when the USB line state changes. The interrupt associated with this bit can be used to detect Reset, Resume, Connect, and Data Line Pulse signals. |
| 4 Reserved | Reserved |
| 3 SESS_VLD _CHG | This bit is set when a change in VBUS is detected indicating a session valid or a session no longer valid |
| 2 B_SESS _CHG | This bit is set when a change in VBUS is detected on a B device. |
| 1 Reserved | Reserved |
| 0 A_VBUS _CHG | This bit is set when a change in VBUS is detected on an A device. |



20.4.1.6 OTG Interrupt Control Register (OTG_INT_EN)

The OTG Interrupt Control Register enables the corresponding interrupt status bits defined in the OTG Interrupt Status Register. Figure 20-12 shows the OTG INT EN register.

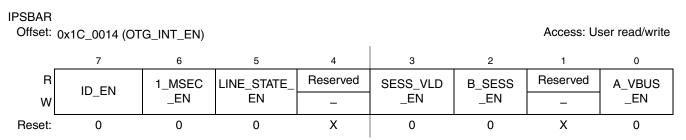


Figure 20-12. OTG Interrupt Control Register

Table 20-16. OTG_INT_EN Field Descriptions

| Field | Description |
|------------------------|---|
| 7 ID_EN | ID interrupt enable 0 The ID interrupt is disabled 1 The ID interrupt is enabled |
| 6 1_MSEC_EN | 1 millisecond interrupt enable 0 The 1msec timer interrupt is disabled 1 The 1msec timer interrupt is enabled |
| 5 LINE_STATE _EN | Line State change interrupt enable 0 The LINE_STAT_CHG interrupt is disabled 1 The LINE_STAT_CHG interrupt is enabled |
| 4 | Reserved. |
| 3 SESS_VLD _EN | Session valid interrupt enable 0 The SESS_VLD_CHG interrupt is disabled 1 The SESS_VLD_CHG interrupt is enabled |
| 2 B_SESS_EN | B Session END interrupt enable 0 The B_SESS_CHG interrupt is disabled 1 The B_SESS_CHG interrupt is enabled |
| 1 | Reserved. |
| 0 A_VBUS_EN | A VBUS Valid interrupt enable 0 The A_VBUS_CHG interrupt is disabled 1 The A_VBUS_CHG interrupt is enabled |

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20.4.1.7 Interrupt Status Register (OTG_STAT)

The Interrupt Status Register displays the actual value from the external comparator outputs of the ID pin and VBUS. Figure 20-13 shows the OTG STAT register.

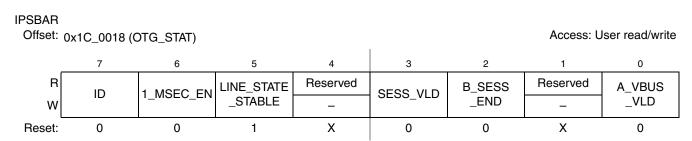


Figure 20-13. Interrupt Status Register

Table 20-17. OTG_STAT Field Descriptions

| Field | Description |
|----------------------------|--|
| 7 ID | Indicates the current state of the ID pin on the USB connector O Indicates a Type A cable has been plugged into the USB connector I Indicates no cable is attached or a Type B cable has been plugged into the USB connector |
| 6 1_MSEC_EN | This bit is reserved for the 1msec count, but it is not useful to software. |
| 5 LINE_STATE _STABLE | This bit indicates that the internal signals that control the LINE_STATE_CHG bit (bit 5) of the OTG_INT_STAT register have been stable for at least 1 millisecond. First read the LINE_STATE_CHG bit, and then read this bit. If this bit reads as 1, then the value of LINE_STATE_CHG can be considered stable. 0 The LINE_STAT_CHG bit is not yet stable 1 The LINE_STAT_CHG bit has been debounced and is stable |
| 4 | Reserved. |
| 3 SESS_VLD | Session Valid O The VBUS voltage is below the B session Valid threshold 1 The VBUS voltage is above the B session Valid threshold |
| 2 B_SESS _END | B Session END 0 The VBUS voltage is above the B session End threshold 1 The VBUS voltage is below the B session End threshold |
| 1 | Reserved. |
| 0 A_VBUS _VLD | A VBUS Valid O The VBUS voltage is below the A VBUS Valid threshold The VBUS voltage is above the A VBUS Valid threshold |



20.4.1.8 OTG Control Register (OTG_CTRL)

The OTG Control Register controls the operation of VBUS and Data Line termination resistors. Figure 20-14 shows the OTG_CTRL register.

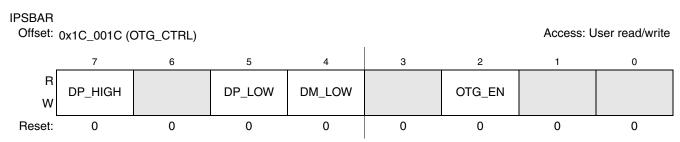


Figure 20-14. OTG Control Register

Table 20-18. OTG_CTRL Field Descriptions

| Field | Description |
|---------------|---|
| 7 DP_HIGH | D+ Data Line pull-up resistor enable 0 D+ pull-up resistor is not enabled 1 D+ pull-up resistor is enabled |
| 6 Reserved | Reserved. |
| 5 DP_LOW | D+ Data Line pull-down resistor enable 0 D+ pull-down resistor is not enabled 1 D+ pull-down resistor is enabled This bit should always be enabled together with bit 4 (DM_LOW) |
| 4 DM_LOW | D- Data Line pull-down resistor enable 0 D- pull-down resistor is not enabled 1 D- pull-down resistor is enabled This bit should always be enabled together with bit 5 (DP_LOW) |
| 3 Reserved | Reserved. |
| 2 OTG_EN | On-The-Go pull-up/pull-down resistor enable 0 If USB_EN is set and HOST_MODE is clear in the Control Register (CTL), then the D+ Data Line pull-up resistors are enabled. If HOST_MODE is set the D+ and D- Data Line pull-down resistors are engaged. 1 The pull-up and pull-down controls in this register are used |
| 1 Reserved | Reserved. |
| 0 Reserved | Reserved. |

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20.4.1.9 Interrupt Status Register (INT_STAT)

The Interrupt Status Register contains bits for each of the interrupt sources within the USB Module. Each of these bits are qualified with their respective interrupt enable bits (see Section 20.4.1.10, "Interrupt Enable Register (INT_ENB)"). All bits of this register are logically OR'd together along with the OTG Interrupt Status Register (OTG_STAT) to form a single interrupt source for the ColdFire core. After an interrupt bit has been set it may only be cleared by writing a one to the respective interrupt bit. This register contains the value of 0x00 after a reset. Figure 20-15 shows the INT_STAT register.

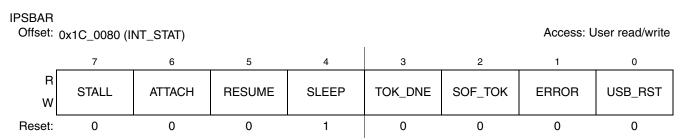


Figure 20-15. Interrupt Status Register

Table 20-19. INT_STAT Field Descriptions

| Field | Description |
|--------------|---|
| 7 STALL | Stall Interrupt In Target mode this bit is asserted when a STALL handshake is sent by the SIE. In Host mode this bit is set when the USB Module detects a STALL acknowledge during the handshake phase of a USB transaction. This interrupt can be use to determine is the last USB transaction was completed successfully or if it stalled. |
| 6 ATTACH | Attach Interrupt This bit is set when the USB Module detects an attach of a USB device. This signal is only valid if HOST_MODE_EN is true. This interrupt signifies that a peripheral is now present and must be configured. |
| 5 RESUME | This bit is set depending upon the DP/DM signals, and can be used to signal remote wake-up signaling on the USB bus. When not in suspend mode this interrupt should be disabled. |
| 4 SLEEP | This bit is set when the USB Module detects a constant idle on the USB bus for 3 milliseconds. The sleep timer is reset by activity on the USB bus. |
| 3 TOK_DNE | This bit is set when the current token being processed has completed. The ColdFire core should immediately read the STAT register to determine the EndPoint and BD used for this token. Clearing this bit (by writing a one) causes the STAT register to be cleared or the STAT holding register to be loaded into the STAT register. |
| 2 SOF_TOK | This bit is set when the USB Module receives a Start Of Frame (SOF) token. In Host mode this bit is set when the SOF threshold is reached, so that software can prepare for the next SOF. |
| 1 ERROR | This bit is set when any of the error conditions within the ERR_STAT register occur. The ColdFire core must then read the ERR_STAT register to determine the source of the error. |
| 0 USB_RST | This bit is set when the USB Module has decoded a valid USB reset. This informs the Microprocessor that it should write 0x00 into the address register and enable endpoint 0. USB_RST is set after a USB reset has been detected for 2.5 microseconds. It is not asserted again until the USB reset condition has been removed and then reasserted. |



20.4.1.10 Interrupt Enable Register (INT_ENB)

The Interrupt Enable Register contains enable bits for each of the interrupt sources within the USB Module. Setting any of these bits enables the respective interrupt source in the INT_STAT register. This register contains the value of 0x00 after a reset. Figure 20-16 shows the INT_ENB register.

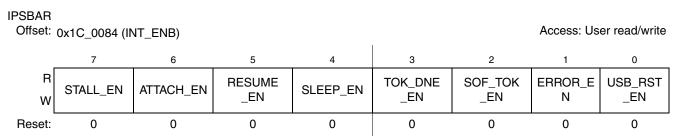


Figure 20-16. Interrupt Enable Register

Table 20-20. INT_ENB Field Descriptions

| Field | Description |
|---------------------|--|
| 7 STALL_EN | STALL Interrupt Enable 0 The STALL interrupt is not enabled 1 The STALL interrupt is enabled |
| 6 ATTACH_EN | ATTACH Interrupt Enable 0 The ATTACH interrupt is not enabled 1 The ATTACH interrupt is enabled |
| 5 RESUME_EN | RESUME Interrupt Enable 1 The RESUME interrupt is not enabled 1 The RESUME interrupt is enabled |
| 4 SLEEP_EN | SLEEP Interrupt Enable 0 The SLEEP interrupt is not enabled 1 The SLEEP interrupt is enabled |
| 3 TOK_DNE _EN | TOK_DNE Interrupt Enable 1 The TOK_DNE interrupt is not enabled 1 The TOK_DNE interrupt is enabled |
| 2 SOF_TOK _EN | SOF_TOK Interrupt Enable 1 The SOF_TOK interrupt is not enabled 1 The SOF_TOK interrupt is enabled |
| 1 ERROR_EN | ERROR Interrupt Enable 1 The ERROR interrupt is enabled 1 The ERROR interrupt is enabled |
| 0 USB_RST _EN | USB_RST Interrupt Enable 0 The USB_RST interrupt is not enabled 1 The USB_RST interrupt is enabled |

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20.4.1.11 Error Interrupt Status Register (ERR_STAT)

The Error Interrupt Status Register contains enable bits for each of the error sources within the USB Module. Each of these bits are qualified with their respective error enable bits (see Section 20.4.1.12, "Error Interrupt Enable Register (ERR_ENB)"). All bits of this Register are logically OR'd together and the result placed in the ERROR bit of the INT_STAT register. After an interrupt bit has been set it may only be cleared by writing a one to the respective interrupt bit. Each bit is set as soon as the error conditions is detected. Therefore, the interrupt does not typically correspond with the end of a token being processed. This register contains the value of 0x00 after a reset. Figure 20-17 shows the ERR_STAT register.

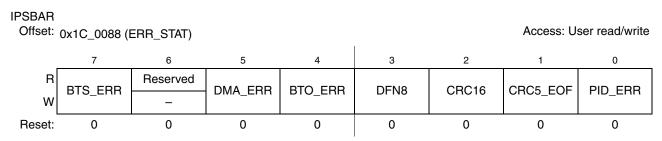


Figure 20-17. Error Interrupt Status Register

Table 20-21. ERR_STAT Field Descriptions

| Field | Description |
|---------------|--|
| 7 | This bit is set when a bit stuff error is detected. If set, the corresponding packet is rejected due to the error. |
| BTS_ERR | pasients is justiced and the mineral statement of the sta |
| 6 | Reserved |
| 5 DMA_ERR | This bit is set if the USB Module has requested a DMA access to read a new BDT but has not been given the bus before it needs to receive or transmit data. If processing a TX transfer this would cause a transmit data underflow condition. If processing a RX transfer this would cause a receive data overflow condition. This interrupt is useful when developing device arbitration hardware for the microprocessor and the USB Module to minimize bus request and bus grant latency. This bit is also set if a data packet to or from the host is larger than the buffer size allocated in the BDT. In this case the data packet is truncated as it is put into buffer memory. |
| 4 BTO_ERR | This bit is set when a bus turnaround timeout error occurs. The USB Module contains a bus turnaround timer that keeps track of the amount of time elapsed between the token and data phases of a SETUP or OUT TOKEN or the data and handshake phases of a IN TOKEN. If more than 16 bit times are counted from the previous EOP before a transition from IDLE, a bus turnaround timeout error occurs. |
| 3 DFN8 | This bit is set if the data field received was not 8 bits in length. USB Specification 1.0 requires that data fields be an integral number of bytes. If the data field was not an integral number of bytes, this bit is set. |
| 2 CRC16 | This bit is set when a data packet is rejected due to a CRC16 error. |
| 1 CRC5_EOF | This error interrupt has two functions. When the USB Module is operating in peripheral mode (HOST_MODE_EN=0), this interrupt detects CRC5 errors in the token packets generated by the host. If set the token packet was rejected due to a CRC5 error. When the USB Module is operating in host mode (HOST_MODE_EN=1), this interrupt detects End Of Frame (EOF) error conditions. This occurs when the USB Module is transmitting or receiving data and the SOF counter reaches zero. This interrupt is useful when developing USB packet scheduling software to ensure that no USB transactions cross the start of the next frame. |
| 0 PID_ERR | This bit is set when the PID check field fails. |



20.4.1.12 Error Interrupt Enable Register (ERR_ENB)

The Error Interrupt Enable Register contains enable bits for each of the error interrupt sources within the USB Module. Setting any of these bits enables the respective interrupt source in the ERR_STAT register. Each bit is set as soon as the error conditions is detected. Therefore, the interrupt does not typically correspond with the end of a token being processed. This register contains the value of 0x00 after a reset. Figure 20-18 shows the ERR_ENB register.

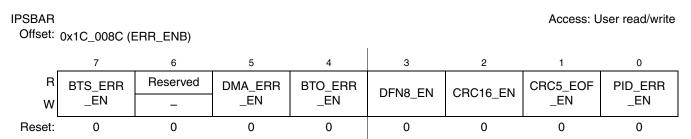


Figure 20-18. Error Interrupt Enable Register

Table 20-22. ERR_ENB Field Descriptions

| Field | Description |
|----------------------|---|
| 7 BTS_ERR _EN | BTS_ERR Interrupt Enable 0 The BTS_ERR interrupt is not enabled 1 The BTS_ERR interrupt is enabled |
| 6 | Reserved |
| 5 DMA_ERR _EN | DMA_ERR Interrupt Enable 0 The DMA_ERR interrupt is not enabled 1 The DMA_ERR interrupt is enabled |
| 4 BTO_ERR _EN | BTO_ERR Interrupt Enable 0 The BTO_ERR interrupt is not enabled 1 The BTO_ERR interrupt is enabled |
| 3 DFN8_EN | DFN8 Interrupt Enable 0 The DFN8 interrupt is not enabled 1 The DFN8 interrupt is enabled |
| 2 CRC16_EN | CRC16 Interrupt Enable 0 The CRC16 interrupt is not enabled 1 The CRC16 interrupt is enabled |
| 1 CRC5_EOF _EN | CRC5/EOF Interrupt Enable 0 The CRC5/EOF interrupt is not enabled 1 The CRC5/EOF interrupt is enabled |
| 0 PID_ERR _EN | PID_ERR Interrupt Enable 0 The PID_ERR interrupt is not enabled 1 The PID_ERR interrupt is enabled |

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20.4.1.13 Status Register (STAT)

The Status Register reports the transaction status within the USB Module. When the ColdFire core has received a TOK_DNE interrupt the Status Register should be read to determine the status of the previous endpoint communication. The data in the status register is valid when the TOK_DNE interrupt bit is asserted. The STAT register is actually a read window into a status FIFO maintained by the USB Module. When the USB Module uses a BD, it updates the Status Register. If another USB transaction is performed before the TOK_DNE interrupt is serviced, the USB Module stores the status of the next transaction in the STAT FIFO. Thus the STAT register is actually a four byte FIFO that allows the ColdFire core to process one transaction while the SIE is processing the next transaction. Clearing the TOK_DNE bit in the INT_STAT register causes the SIE to update the STAT register with the contents of the next STAT value. If the data in the STAT holding register is valid, the SIE immediately reasserts to TOK_DNE interrupt. Figure 20-19 shows the STAT register.

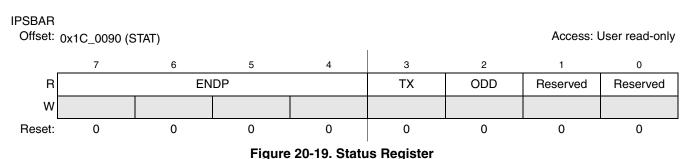


Table 20-23. STAT Field Descriptions

| Field | Description |
|--------------------|---|
| 7 - 5 ENDP[3:0] | This four-bit field encodes the endpoint address that received or transmitted the previous token. This allows the ColdFire core to determine which BDT entry was updated by the last USB transaction. |
| 3 TX | Transmit Indicator 0 The most recent transaction was a Receive operation 1 The most recent transaction was a Transmit operation |
| 2 ODD | this bit is set if the last Buffer Descriptor updated was in the odd bank of the BDT. |
| 1 - 0 | Reserved |



20.4.1.14 Control Register (CTL)

The Control Register provides various control and configuration information for the USB Module. Figure 20-20 shows the CTL register.

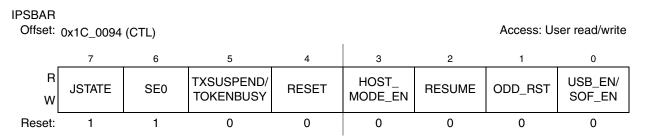


Figure 20-20. Control Register

Table 20-24. CTL Field Descriptions

| Field | Description |
|------------------------------|--|
| 7 JSTATE | Live USB differential receiver JSTATE signal. The polarity of this signal is affected by the current state of LS_EN (See) |
| 6 SE0 | Live USB Single Ended Zero signal |
| 5 TXSUSPEND/ TOKENBUSY | When the USB Module is in Host mode TOKEN_BUSY is set when the USB Module is busy executing a USB token and no more token commands should be written to the Token Register. Software should check this bit before writing any tokens to the Token Register to ensure that token commands are not lost. In Target mode TXD_SUSPEND is set when the SIE has disabled packet transmission and reception. Clearing this bit allows the SIE to continue token processing. This bit is set by the SIE when a Setup Token is received allowing software to dequeue any pending packet transactions in the BDT before resuming token processing. |
| 4 RESET | Setting this bit enables the USB Module to generate USB reset signaling. This allows the USB Module to reset USB peripherals. This control signal is only valid in Host mode (HOST_MODE_EN=1). Software must set RESET to 1 for the required amount of time and then clear it to 0 to end reset signaling. For more information on RESET signaling see Section 7.1.4.3 of the USB specification version 1.0. |
| 3 HOST_ MODE_EN | When set to 1, this bit enables the USB Module to operate in Host mode. In host mode, the USB module performs USB transactions under the programmed control of the host processor. |
| 2 RESUME | When set to 1 this bit enables the USB Module to execute resume signaling. This allows the USB Module to perform remote wake-up. Software must set RESUME to 1 for the required amount of time and then clear it to 0. If the HOST_MODE_EN bit is set, the USB module appends a Low Speed End of Packet to the Resume signaling when the RESUME bit is cleared. For more information on RESUME signaling see Section 7.1.4.5 of the USB specification version 1.0. |
| 1 ODD_RST | Setting this bit to 1 resets all the BDT ODD ping/pong bits to 0, which then specifies the EVEN BDT bank. |
| 0 USB_EN/ SOF_EN | USB Enable 0 The USB Module is disabled 1 The USB Module is enabled. Setting this bit causes the SIE to reset all of its ODD bits to the BDTs. Therefore, setting this bit resets much of the logic in the SIE. When host mode is enabled, clearing this bit causes the SIE to stop sending SOF tokens. |

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20.4.1.15 Address Register (ADDR)

The Address Register holds the unique USB address that the USB Module decodes when in Peripheral mode (HOST_MODE_EN=0). When operating in Host mode (HOST_MODE_EN=1) the USB Module transmits this address with a TOKEN packet. This enables the USB Module to uniquely address an USB peripheral. In either mode, the USB_EN bit within the control register must be set. The Address Register is reset to 0x00 after the reset input becomes active or the USB Module decodes a USB reset signal. This action initializes the Address Register to decode address 0x00 as required by the USB specification. Figure 20-21 shows the ADDR register.

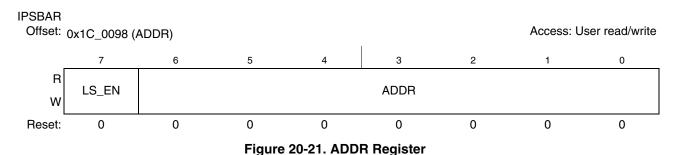


Table 20-25. ADDR Field Descriptions

| Field | Description |
|-------------|--|
| 7 LS_EN | Low Speed Enable bit. This bit informs the USB Module that the next token command written to the token register must be performed at low speed. This enables the USB Module to perform the necessary preamble required for low-speed data transmissions. |
| 6–0 ADDR | USB address. This 7-bit value defines the USB address that the USB Module decodes in peripheral mode, or transmit when in host mode. |



20.4.1.16 BDT Page Register 1 (BDT_PAGE_01)

The Buffer Descriptor Table Page Register 1 contains an 8-bit value used to compute the address where the current Buffer Descriptor Table (BDT) resides in system memory. Figure 20-22 shows the BDT Page Register 1.

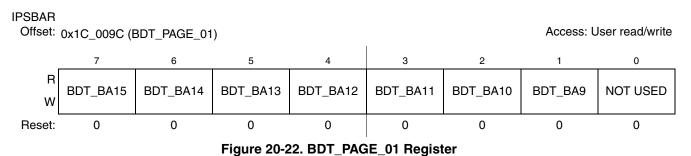


Table 20-26. BDT_PAGE_01 Field Descriptions

| Field | Description |
|---------------------------|--|
| 7 – 1 BDT_ BA[15:8] | This 7 bit field provides address bits 15 through 9 of the BDT base address, which defines where the Buffer Descriptor Table resides in system memory. |
| 0 NOT USED | This bit is always zero. The 32-bit BDT Base Address is always aligned on 512 byte boundaries in memory. |



20.4.1.17 Frame Number Register Low/High (FRM_NUML, FRM_NUMH)

The Frame Number Register Low contains an 8-bit value used to compute the address where the current Buffer Descriptor Table (BDT) resides in system memory. Figure 20-23 shows the FRM NUML Register.

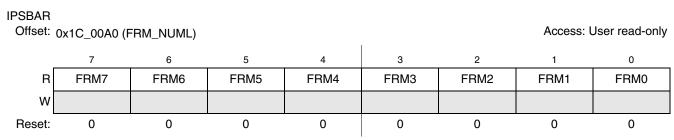


Figure 20-23. FRM_NUML Register

Table 20-27. FRM_NUML Field Descriptions

| Field | Description |
|-----------------|---|
| 7–0 FRM[7:0] | These 8 bits represent the low-order bits of the11-bit Frame Number |

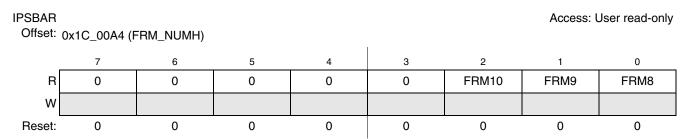


Figure 20-24. FRM_NUMH Register

Table 20-28. FRM_NUMH Field Descriptions

| Field | Description |
|------------------|--|
| 2-0 FRM[10:8] | These 3 bits represent the high-order bits of the11-bit Frame Number |
| 7–3 NOT USED | This bits always read zero. |

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20.4.1.18 Token Register (TOKEN)

The Token Register is used to perform USB transactions when in host mode (HOST_MODE_EN=1). When the ColdFire core processor wishes to execute a USB transaction to a peripheral, it writes the TOKEN type and endpoint to this register. After this register has been written, the USB module begins the specified USB transaction to the address contained in the address register. The ColdFire core should always check that the TOKEN_BUSY bit in the control register is not set before performing a write to the Token Register. This ensures token commands are not overwritten before they can be executed. The address register and endpoint control register 0 are also used when performing a token command and therefore must also be written before the Token Register. The address register is used to correctly select the USB peripheral address transmitted by the token command. The endpoint control register determines the handshake and retry policies used during the transfer. Figure 20-25 shows the TOKEN Register.

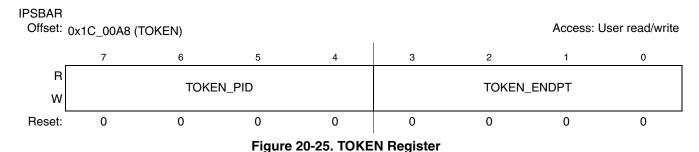


Table 20-29. TOKEN Field Descriptions

| Field | Description | | | |
|--------------------------|---|---|--|--|
| 7 – 4 TOKEN _ENDPT | This 4 bit field holds the Endpoint address for the token command. The four bit value written must be a valid endpoint. | | | |
| 3-0 | | his 4-bit field contains the token type executed by the USB Module. | | |
| TOKEN_PID | Valid tokens are: | | HOD M. L.L. (C. OUT (TV)) | |
| | TOKEN_PID=0001 | OUT Token | USB Module performs an OUT (TX) transaction | |
| | TOKEN_PID=1001 | IN Token | USB Module performs an In (RX) transaction | |
| | TOKEN_PID=1101 | SETUP Token | USB Module performs a SETUP (TX) transaction | |

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20.4.1.19 SOF Threshold Register (SOF_THLD)

The SOF Threshold Register is used only in Hosts mode (HOST_MODE_EN=1). When in Host mode, the 14-bit SOF counter counts the interval between SOF frames. The SOF must be transmitted every 1msec so the SOF counter is loaded with a value of 12000. When the SOF counter reaches zero, a Start Of Frame (SOF) token is transmitted. The SOF threshold register is used to program the number of USB byte times *before* the SOF to stop initiating token packet transactions. This register must be set to a value that ensures that other packets are not actively being transmitted when the SOF time counts to zero. When the SOF counter reaches the threshold value, no more tokens are transmitted until after the SOF ha been transmitted. The value programmed into the threshold register must reserve enough time to ensure the worst case transaction completes. In general the worst case transaction is a IN token followed by a data packet from the target followed by the response from the host. The actual time required is a function of the maximum packet size on the bus. Typical values for the SOF threshold are: 64-byte packets=74; 32-byte packets=42; 16-byte packets=26; 8-byte packets=18. Figure 20-26 shows the SOF_THLD Register.

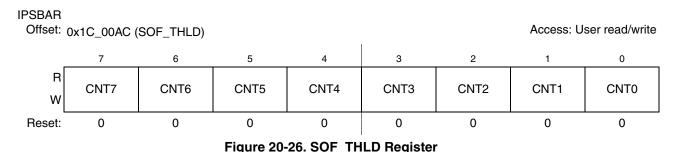


Table 20-30. SOF_THLD Field Descriptions

| Field | Description |
|-------------------|--|
| 7 – 0 CNT[7:0] | This 8 bit field represents the SOF count threshold in byte times. |

20.4.1.20 BDT Page Register 2 (BDT_PAGE_02)

The Buffer Descriptor Table Page Register 2 contains an 8-bit value used to compute the address where the current Buffer Descriptor Table (BDT) resides in system memory. See Section 20.4.1.16, "BDT Page Register 1 (BDT_PAGE_01)" for more information on the format of the Buffer Descriptor Table. Figure 20-27 shows the BDT Page Register 2.

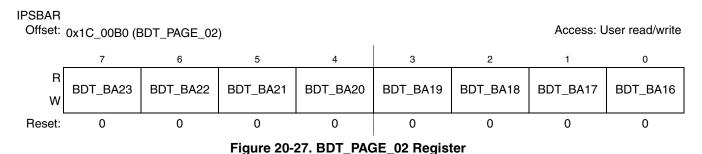


Table 20-31. BDT_PAGE_02 Field Descriptions

| Field | Description |
|----------------------------|---|
| 7 – 0 BDT_ BA[23:16] | This 8 bit field provides address bits 23 through 16 of the BDT base address, which defines where the Buffer Descriptor Table resides in system memory. |

20.4.1.21 BDT Page Register 3 (BDT_PAGE_03)

The Buffer Descriptor Table Page Register 3 contains an 8-bit value used to compute the address where the current Buffer Descriptor Table (BDT) resides in system memory. See Section 20.4.1.16, "BDT Page Register 1 (BDT_PAGE_01)" for more information on the format of the Buffer Descriptor Table. Figure 20-28 shows the BDT Page Register 3.

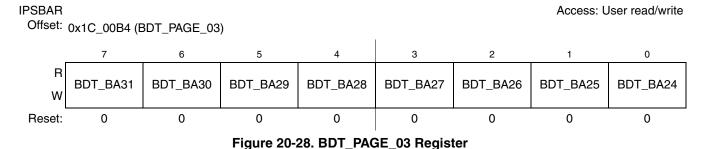


Table 20-32. BDT PAGE 03 Field Descriptions

| Field | Description |
|----------------------------|--|
| 7 – 0 BDT_ BA[31:24] | This 8 bit field provides address bits 31through 24 of the BDT base address, which defines where the Buffer Descriptor Table resides in system memory. |

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20.4.1.22 Endpoint Control Registers 0 – 15 (ENDPT0–15)

The Endpoint Control Registers contain the endpoint control bits for each of the 16 endpoints available within the USB Module for a decoded address. The format for these registers is shown in the following figure. Endpoint 0 (ENDPT0) is associated with control pipe 0, which is required for all USB functions. Therefore, after a USB RST interrupt occurs the ColdFire core should set the ENDPT0 register to contain 0x0D.

In Host mode ENDPT0 is used to determine the handshake, retry and low speed characteristics of the host transfer. For Host mode control, bulk and interrupt transfers the EP HSHK bit should be set to 1. Fort Isochronous transfers it should be set to 0. Common values to use for ENDPT0 in host mode are 0x4D for Control, Bulk, and Interrupt transfers, and 0x4C for Isochronous transfers.

Figure 20-29 shows the Endpoint Control Registers.

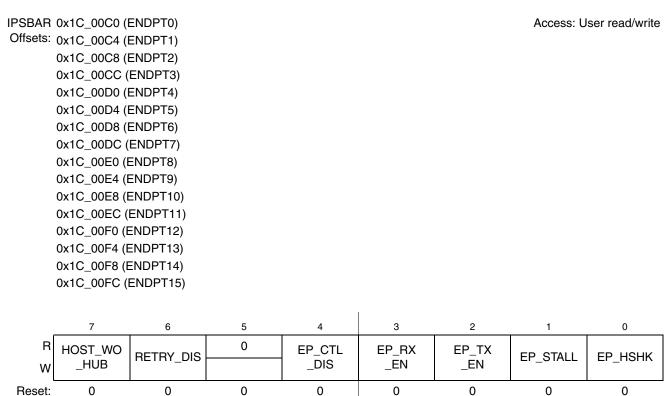


Figure 20-29. Endpoint Control Registers

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Table 20-33. Endpoint Control Registers Field Descriptions

| Field | Description | |
|--|---|--|
| 7 HOST_WO _HUB | This is a Host mode only bit and is only present in the control register for endpoint 0 (ENDPT0). When set this bit allows the host to communicate to a directly connected low speed device. When cleared, the host produces the PRE_PID then switch to low speed signaling when sending a token to a low speed device as required to communicate with a low speed device through a hub. | |
| 6 RETRY_DIS | This is a Host mode only bit and is only present in the control register for endpoint 0 (ENDPT0). When set the bit causes the host to not retry NAK'ed (Negative Acknowledgement) transactions. When a transaction is NAKed, the BDT PID field is updated with the NAK PID, and the TOKEN_DNE interrupt is set. When this bit cleared NAKed transactions is retried in hardware. This bit must be set when the host is attempting to poll a interrupt endpoint. | |
| 5 | Reserved | |
| 4 EP_CTL_DIS | This bit, when set, disables control (SETUP) transfers. When cleared, control transfers are enabled. This applies if and only if the EP_RX_EN and EP_TX_EN bits are also set. SeeTable 20-34 | |
| 3 EP_RX_EN | This bit, when set, enables the endpoint for RX transfers. SeeTable 20-34 | |
| 2 EP_TX_EN | This bit, when set, enables the endpoint for TX transfers. SeeTable 20-34 | |
| 1 EP_STALL | When set this bit indicates that the endpoint is called. This bit has priority over all other control bits in the EndPoint Enable Register, but it is only valid if EP_TX_EN=1 or EP_RX_EN=1. Any access to this endpoint causes the USB Module to return a STALL handshake. After an endpoint is stalled it requires intervention from the Host Controller. | |
| 0 When set this bet enables an endpoint to perform handshaking during a transaction to this endpoint generally set unless the endpoint is Isochronous. | | |

Table 20-34. Endpoint Direction and Control

| EPL_CTL_DIS | EP_RX_EN | EP_TX_EN | Endpoint Enable / Direction Control | |
|-------------|----------|----------|--|--|
| Х | 0 | 0 | Disable Endpoint | |
| Х | 0 | 1 | Enable Endpoint for TX transfers only | |
| Х | 1 | 0 | Enable Endpoint for RX transfers only | |
| 1 | 1 | 1 | Enable Endpoint for RX and TX transfers | |
| 0 | 1 | 1 | Enable Endpoint for RX and TX as well as control (SETUP) transfers | |

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20.4.1.23 USB Control Register (USB_CTRL)

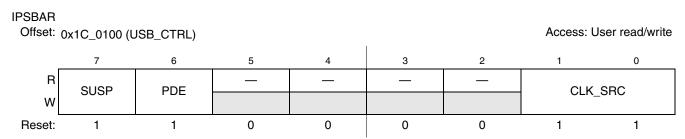


Figure 20-30. USB Control Register

Table 20-35. USB_CTRL Field Descriptions

| Field | Description | | |
|----------------|--|--|--|
| 7 SUSP | Places the USB transceiver into the suspend state. USB transceiver is not in suspend state. USB transceiver is in suspend state. | | |
| 6 PDE | Enables the non-functional weak pulldowns on the USB transceiver 0 Weak pulldowns are disabled on D+ and D- 1 Weak pulldowns are enabled on D+ and D- | | |
| 5 –2 | Reserved | | |
| 1-0 CLK_SRC | Determines the clock source for the USB 48 MHz clock 00 USB_ALT_CLK pin (External clock that can feed in from PTG0) 01 External OSC on EXTAL pin 10 Reserved 11 System clock source (MCGPLLSCLK) | | |

20.4.1.24 USB OTG Observe Register (USB_OTG_OBSERVE)

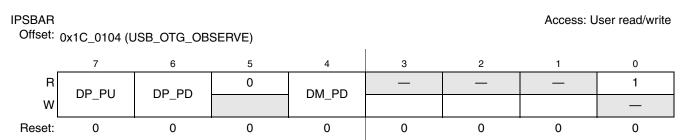


Figure 20-31. USB OTG Observe Register



Table 20-36. USB_OTG_OBSERVE Field Descriptions

| Field | Description | | | |
|-----------------|--|--|--|--|
| 7 DP_PU | Provides observability of the D+ Pull Up signal output from the USB OTG module. This bit is useful when interfacing to an external OTG control module via a serial interface. 0 D+ pullup disabled. 1 D+ pullup enabled. | | | |
| 6 DP_PD | Provides observability of the D+ Pull Down signal output from the USB OTG module. Useful when interfacing to an external OTG control module via a serial interface. 0 D+ pulldown disabled. 1 D+ pulldown enabled. | | | |
| 5 Reserved | Reserved. Should always read zero. | | | |
| 4 DM_PD | Provides observability of the D+ Pull Down signal output from the USB OTG module. Useful when interfacing to an external OTG control module via a serial interface. 0 D+ pulldown disabled. 1 D+ pulldown enabled. | | | |
| 3-0 Reserved | Reserved | | | |

20.4.1.25 USB OTG Control Register (USB_OTG_CONTROL)

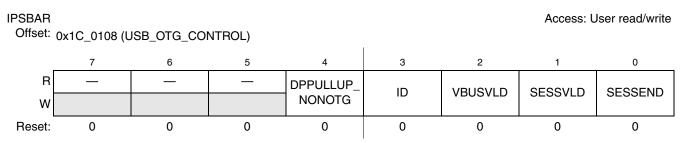


Figure 20-32. USB OTG Control Register

Table 20-37. USB_OTG_CONTROL Field Descriptions

| Field | Description | | |
|---|--|--|--|
| 7 — 5 | Reserved | | |
| 4 Provides control of the DP PULLUP in the USB OTG module, if USB is configured in non-OTG device DPPULLUP_ NONOTG DP Pull up in non-OTG device mode is not enabled. 1 DP Pull up in non-OTG device mode is enabled. | | | |
| Provides control of the USB ID signal into the USB OTG module if a pin has not been configur function. Useful when interfacing to an external OTG control module via a serial interface. USB ID input is negated. USB ID input is asserted. | | | |
| 2 VBUSVLD | Provides control of the VBUS Valid signal into the USB OTG module if a pin has not been configured for this function. Useful when interfacing to an external OTG control module via a serial interface. 0 VBUS Valid input is negated. 1 VBUS Valid input is asserted. | | |

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Table 20-37. USB_OTG_CONTROL Field Descriptions

| Field | Description |
|--------------|---|
| 1 SESSVLD | Provides observability of the Session Valid signal output from the USB OTG module. Useful when interfacing to an external OTG control module via a serial interface. O Session Valid input is negated. Session Valid input is asserted. |
| 0 SESSEND | Provides observability of the Session End signal output from the USB OTG module. Useful when interfacing to an external OTG control module via a serial interface. O Session End input is negated. Session End input is asserted. |

20.5 OTG and Host Mode Operation

The Host Mode logic allows devices such as digital cameras and palmtop computers to function as a USB Host Controller. The OTG logic adds an interface to allow the OTG Host Negotiation and Session Request Protocols (HNP and SRP) to be implemented in software. Host Mode allows a peripheral such as a digital camera to be connected directly to a USB compliant printer. Digital photos can then be easily printed without having to upload them to a PC. In the palmtop computer application, a USB compliant keyboard/mouse can be connected to the palmtop computer with the obvious advantages of easier interaction.

Host mode is intended for use in handheld-portable devices to allow easy connection to simple HID class devices such as printers and keyboards. It is NOT intended to perform the functions of a full OHCI or UHCI compatible host controller found on PC motherboards. The USB-FS is not supported by Windows 98 as a USB host controller. Host mode allows bulk, Isochronous, interrupt and control transfers. Bulk data transfers are performed at nearly the full USB bus bandwidth. Support is provided for ISO transfers, but the number of ISO streams that can be practically supported is affected by the interrupt latency of the processor servicing the token during interrupts from the SIE. Custom drivers must be written to support Host mode operation.

Setting the HOST_MODE_EN bit in the CTL register enables host Mode. The USB-FS core can only operate as a peripheral device or in Host Mode. It cannot operate in both modes simultaneously. When HOST MODE is enabled, only endpoint zero is used. All other endpoints should be disabled by software.

20.6 Host Mode Operation Examples

The following sections illustrate the steps required to perform USB host functions using the USB-FS core. The following sections are useful to understand the interaction of the hardware and the software at a detailed level, but an understanding of the interactions at this level is not required to write host applications using the API software.

To enable host mode and discover a connected device:

1. Enable Host Mode (CTL[HOST_MODE_EN]=1). Pull down resistors enabled, pull-up disabled. SOF generation begins. SOF counter loaded with 12,000. Eliminate noise on the USB by disabling Start of Frame packet generation by writing the USB enable bit to 0 (CTL[USB_EN]=0).



- 2. Enable the ATTACH interrupt (INT ENB[ATTACH]=1).
- 3. Wait for ATTACH interrupt (INT_STAT[ATTACH]). Signaled by USB Target pull-up resistor changing the state of DPLUS or DMINUS from 0 to 1 (SE0 to J or K state).
- 4. Check the state of the JSTATE and SE0 bits in the control register. If the JSTATE bit is 0 then the connecting device is low speed. If the connecting device is low speed then set the low speed bit in the address registers (ADDR[LS_EN]=1) and the host the host without hub bit in endpoint 0 register control (EP_CTL0[HOST_WO_HUB]=1).
- 5. Enable RESET (CTL[RESET]=1) for 10 ms
- 6. Enable SOF packet to keep the connected device from going to suspend (CTL[USB EN=1])
- 7. Start enumeration by sending a sequence of Chapter 9, device frame work packets to the default control pipe of the connected device.

To complete a control transaction to a connected device:

- 1. Complete all steps discover a connected device
- 2. Set up the endpoint control register for bidirectional control transfers EP CTL0[4:0] = 0x0d.
- 3. Place a copy of the device framework setup command in a memory buffer. See Chapter 9 of the USB 2.0 specification [2] for information on the device framework command set.
- 4. Initialize current (even or odd) TX EP0 BDT to transfer the 8 bytes of command data for a device framework command (i.e. a GET DEVICE DESCRIPTOR).
 - Set the BDT command word to 0x00080080 Byte count to 8, own bit to 1
 - Set the BDT buffer address field to the start address of the 8 byte command buffer
- 5. Set the USB device address of the target device in the address register (ADDR[6:0]). After the USB bus reset, the device USB address is zero. It is set to some other value (usually 1) by the Set Address device framework command.
- 6. Write the token register with a SETUP to Endpoint 0 the target device default control pipe (TOKEN=0xD0). This initiates a setup token on the bus followed by a data packet. The device handshake is returned in the BDT PID field after the packets complete. When the BDT is written a token done (INT_STAT[TOK_DNE]) interrupt is asserted. This completes the setup phase of the setup transaction as referenced in chapter 9 of the USB specification.
- 7. To initiate the data phase of the setup transaction (i.e., get the data for the GET DEVICE descriptor command) set up a buffer in memory for the data to be transferred.
- 8. Initialize the current (even or odd) TX EP0 BDT to transfer the data.
 - Set the BDT command word to 0x004000C0 Byte count to the length of the data buffer in this case 64, own bit to 1, Data toggle to Data1.
 - Set the BDT buffer address field to the start address of the data buffer
- 9. Write the token register with a IN or OUT token to Endpoint 0 the target device default control pipe, an IN token for a GET DEVICE DESCRIPTOR command (TOKEN=0x90). This initiates an IN token on the bus followed by a data packet from the device to the host. When the data packet completes the BDT is written and a token done (INT_STAT[TOK_DNE]) interrupt is asserted. For control transfers with a single packet data phase this completes the data phase of the setup transaction as referenced in chapter 9 of the USB specification.

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- 10. To initiate the Status phase of the setup transaction set up a buffer in memory to receive or send the zero length status phase data packet.
- 11. Initialize the current (even or odd) TX EP0 BDT to transfer the status data.
 - Set the BDT command word to 0x00000080 Byte count to the length of the data buffer in this case 0, own bit to 1, Data toggle to Data0.
 - Set the BDT buffer address field to the start address of the data buffer
- 12. Write the token register with a IN or OUT token to Endpoint 0 the target device default control pipe, an OUT token for a GET DEVICE DESCRIPTOR command (TOKEN=0x10). This initiates an OUT token on the bus followed by a zero length data packet from the host to the device. When the data packet completes the BDT is written with the handshake form the device and a token done (INT_STAT[TOK_DNE]) interrupt is asserted. This completes the data phase of the setup transaction as referenced in chapter 9 of the USB specification.

To send a Full speed bulk data transfer to a target device:

- 1. Complete all steps discover a connected device and to configure a connected device. Write the ADDR register with the address of the target device. Typically, there is only one other device on the USB bus in host mode so it is expected that the address is 0x01 and should remain constant.
- 2. Write the ENDPT0 to 0x1D register to enable transmit and receive transfers with handshaking enabled.
- 3. Setup the Even TX EP0 BDT to transfer up to 64 bytes.
- 4. Set the USB device address of the target device in the address register (ADDR[6:0]).
- 5. Write the TOKEN register with an OUT token to the desired endpoint. The write to this register triggers the USB-FS transmit state machines to begin transmitting the TOKEN and the data.
- 6. Setup the Odd TX EP0 BDT to transfer up to 64 bytes.
- 7. Write the TOKEN register with an OUT token as in step 4. Two Tokens can be queued at a time to allow the packets to be double buffered to achieve maximum throughput.
- 8. Wait for the TOK_DNE interrupt. This indicates one of the BDTs has been released back to the microprocessor and that the transfer has completed. If the target device asserts NAKs, the USB-FS continues to retry the transfer indefinitely without processor intervention unless the RETRY_DIS retry disable bit is set in the EP0 control register. If the retry disable bit is set, the handshake (ACK, NAK, STALL, or ERROR (0xf)) is returned in the BDT PID field. If a stall interrupt occurs, the pending packet must be dequeued and the error condition in the target device cleared. If a RESET interrupt occurs (SE0 for more than 2.5us), the target has detached.
- 9. After the TOK_DNE interrupt occurs, the BDTs can be examined and the next data packet queued by returning to step 2.

20.7 On-The-Go Operation

The USB-OTG core provides sensors and controls to enable On-The-Go (OTG) operation. These sensors are used by the OTG API software to implement the Host Negotiation Protocol (HNP) and Session Request Protocol (SRP). API calls are provided to give access the OTG protocol control signals, and include the OTG capabilities in the device application. The following state machines show the OTG operations involved with HNP and SRP protocols from either end of the USB cable.

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20.7.1 OTG Dual Role A Device Operation

A device is considered the A device because of the type of cable attached. If the USB Type A connector or the USB Type Mini A connector is plugged into the device, he is considered the A device.

A dual role A device operates as the following flow diagram and state description table illustrates.

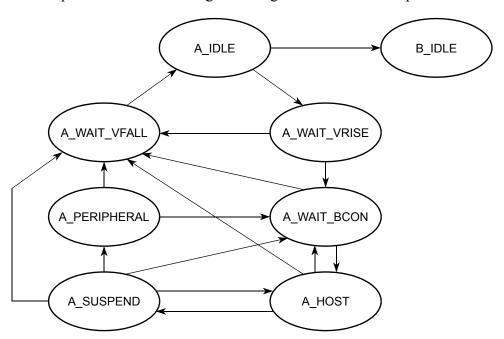


Figure 20-33. Dual Role A Device Flow Diagram

Table 20-38. State Descriptions for Figure 20-33

| State | Action | Response |
|--------------|--|---|
| A_IDLE | If ID Interrupt. The cable has been un-plugged or a Type B cable has been attached. The device now acts as a Type B device. | Go to B_IDLE |
| | If the A application wants to use the bus or if the B device is doing an SRP as indicated by an A_SESS_VLD Interrupt or Attach or Port Status Change Interrupt check data line for 5 –10 msec pulsing. | Go to A_WAIT_VRISE Turn on DRV_VBUS |
| A_WAIT_VRISE | If ID Interrupt or if A_VBUS_VLD is false after 100 msec The cable has been changed or the A device cannot support the current required from the B device. | Go to A_WAIT_VFALL Turn off DRV_VBUS |
| | If A_VBUS_VLD interrupt | Go to A_WAIT_BCON |
| A_WAIT_BCON | After 200 msec without Attach or ID Interrupt. (This could wait forever if desired.) | Go to A_WAIT_FALL Turn off DRV_VBUS |
| | A_VBUS_VLD Interrupt and B device attaches | Go to A_HOST Turn on Host Mode |

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Go to A_IDLE



| State | Action | Response |
|--------------|--|---|
| A_HOST | Enumerate Device determine OTG Support. | |
| | If A_VBUS_VLD/ Interrupt or A device is done and doesn't think he wants to do something soon or the B device disconnects | Go to A_WAIT_VFALL Turn off Host Mode Turn off DRV_VBUS |
| | If the A device is finished with session or if the A device wants to allow the B device to take bus. | Go to A_SUSPEND |
| | ID Interrupt or the B device disconnects | Go to A_WAIT_BCON |
| A_SUSPEND | If ID Interrupt, or if 150 msec B disconnect timeout (This timeout value could be longer) or if A_VBUS_VLD\ Interrupt | Go to A_WAIT_VFALL Turn off DRV_VBUS |
| | If HNP enabled, and B disconnects in 150 msec then B device is becoming the host. | Go to A_PERIPHERAL Turn off Host Mode |
| | If A wants to start another session | Go to A_HOST |
| A_PERIPHERAL | If ID Interrupt or if A_VBUS_VLD interrupt | Go to A_WAIT_VFALL Turn off DRV_VBUS. |
| | If 3 –200 msec of Bus Idle | Go to A_WAIT_BCON Turn on Host Mode |
| | | |

Table 20-38. State Descriptions for Figure 20-33 (continued)

20.7.2 OTG Dual Role B Device Operation

A_WAIT_VFALL

A device is considered a B device if it connected to the bus with a USB Type B cable or a USB Type Mini B cable.

A dual role B device operates as the following flow diagram and state description table illustrates.

If ID Interrupt or (A_SESS_VLD/ & b_conn/)

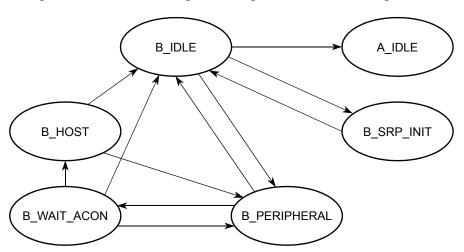


Figure 20-34. Dual Role B Device Flow Diagram

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Table 20-39. State Descriptions for Figure 20-34

| State | Action | Response |
|--------------|--|--|
| B_IDLE | If ID\ Interrupt. A Type A cable has been plugged in and the device should now respond as a Type A device. | Go to A_IDLE |
| | If B_SESS_VLD Interrupt. The A device has turned on VBUS and begins a session. | Go to B_PERIPHERAL Turn on DP_HIGH |
| | If B application wants the bus and Bus is Idle for 2 ms and the B_SESS_END bit is set, the B device can perform an SRP. | Go to B_SRP_INIT Pulse CHRG_VBUS Pulse DP_HIGH 5-10 ms |
| B_SRP_INIT | If ID\ Interrupt or SRP Done (SRP must be done in less than 100 msecs.) | Go to B_IDLE |
| B_PERIPHERAL | If HNP enabled and the bus is suspended and B wants the bus, the B device can become the host. | Go to B_WAIT_ACON Turn off DP_HIGH |
| B_WAIT_ACON | If A connects, an attach interrupt is received | Go to B_HOST Turn on Host Mode |
| | If ID\ Interrupt or B_SESS_VLD/ Interrupt If the cable changes or if VBUS goes away, the host doesn't support us. Go to B_IDLE | Go to B_IDLE |
| | If 3.125 ms expires or if a Resume occurs | Go to B_PERIPHERAL |
| B_HOST | If ID\ Interrupt or B_SESS_VLD\ Interrupt If the cable changes or if VBUS goes away, the host doesn't support us. | Go to B_IDLE |
| | If B application is done or A disconnects | Go to B_PERIPHERAL |

20.7.3 Power

The USB-FS core is a fully synchronous static design. The power used by the design is dependant on the application usage of the core. Applications that transfer more data or cause a greater number of packets to be sent consumes a greater amount of power.

Because the design is synchronous and static, reducing the transitions on the clock net may conserve power. This may be done in the following ways.

The first is to reduce the clock frequency to the USB module. The clock frequency may not be reduced below the minimum recommended operating frequency of the USB module without first disabling the USB operation and disconnecting (via software disconnect) the USB module from the USB bus.

Alternately, the clock may be shut off to the core to conserve power. Again, this may only be done after the USB operations on the bus have been disabled and the device has been disconnected from the USB.

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20.7.4 USB Suspend State

USB bus powered devices are required to respond to a 3ms lack of activity on the USB bus by going into a suspend state. Software is notified of the suspend condition via the transition in the port status and control register. Optionally, an interrupt can be generated that is controlled by the interrupt enable register. In the suspend state, a USB device has a maximum USB bus power budget of 500uA. To achieve that level of power conservation, most of the device circuits need to be switched off. When the clock is disabled to the USB-FScore all functions are disabled, but all operational states are retained. The transceiver VP and VM signals can be used to construct a circuit able to detect the resume signaling on the bus and restore the clocks to the rest of the circuit when the USB host takes the bus out of the suspend state.



Chapter 21 Fast Ethernet Controller (FEC)

21.1 Introduction

This chapter provides a -set overview, a functional block diagram, and transceiver connection information for the 10 and 100 Mbps MII (media independent interface), as well as the 7-wire serial interface. Additionally, detailed descriptions of operation and the programming model are included.

21.1.1 Overview

The Ethernet media access controller (MAC) supports 10 and 100 Mbps Ethernet/IEEE 802.3 networks. An external transceiver interface and transceiver function are required to complete the interface to the media. The FEC supports three different standard MAC-PHY (physical) interfaces for connection to an external Ethernet transceiver. The FEC supports the 10/100 Mbps MII and the 10 Mbps-only 7-wire interface.

NOTE

The GPIO module must be configured to enable the peripheral function of the appropriate pins (refer to Chapter 15, "General Purpose I/O Module") prior to configuring the FEC.



21.1.2 Block Diagram

Figure 21-1 shows the block diagram of the FEC. The FEC is implemented with a combination of hardware and microcode. The off-chip (Ethernet) interfaces are compliant with industry and IEEE 802.3 standards.

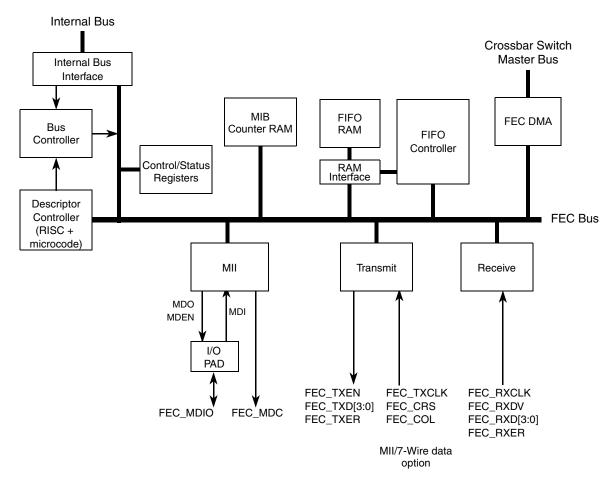


Figure 21-1. FEC Block Diagram

The descriptor controller is a RISC-based controller providing these functions in the FEC:

- Initialization (those internal registers not initialized by you or hardware)
- High level control of the DMA channels (initiating DMA transfers)
- Interpreting buffer descriptors
- Address recognition for receive frames
- Random number generation for transmit collision backoff timer

NOTE

DMA references in this section refer to the FEC's DMA engine. This DMA engine transfers FEC data only and is not related to the eDMA controller described in Chapter 22, "DMA Controller Module," nor to the DMA timers described in Chapter 26, "DMA Timers (DTIM0–DTIM3)."

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The RAM is the focal point of all data flow in the Fast Ethernet controller and divides into transmit and receive FIFOs. The FIFO boundaries are programmable using the FRSR register. User data flows to/from the DMA block from/to the receive/transmit FIFOs. Transmit data flows from the transmit FIFO into the transmit block, and receive data flows from the receive block into the receive FIFO.

You control the FEC by writing into control registers located in each block. The CSR (control and status registers) block provides global control (Ethernet reset and enable) and interrupt managing registers.

The MII block provides a serial channel for control/status communication with the external physical layer device (transceiver). This serial channel consists of the FEC_MDC (management data clock) and FEC_MDIO (management data input/output) lines of the MII interface.

The FEC DMA block (not to be confused with the device's eDMA controller) provides multiple channels allowing transmit data, transmit descriptor, receive data and receive descriptor accesses to run independently.

The transmit and receive blocks provide the Ethernet MAC functionality (with some assist from microcode).

The message information block (MIB) maintains counters for a variety of network events and statistics. It is not necessary for operation of the FEC, but provides valuable counters for network management. The counters supported are the RMON (RFC 1757) Ethernet Statistics group and some of the IEEE 802.3 counters. See Section 21.4.1, "MIB Block Counters Memory Map," for more information.

21.1.3 Features

The FEC incorporates the following features:

- Support for three different Ethernet physical interfaces:
 - 100-Mbps IEEE 802.3 MII
 - 10-Mbps IEEE 802.3 MII
 - 10-Mbps 7-wire interface (industry standard)
- IEEE 802.3 full duplex flow control
- Programmable max frame length supports IEEE 802.1 VLAN tags and priority
- Support for full-duplex operation (200 Mbps throughput) with a minimum internal bus clock rate of 50 MHz
- Support for half-duplex operation (100 Mbps throughput) with a minimum internal bus clock rate of 50 MHz
- Retransmission from transmit FIFO following a collision (no processor bus utilization)
- Automatic internal flushing of the receive FIFO for runts (collision fragments) and address recognition rejects (no processor bus utilization)
- Address recognition
 - Frames with broadcast address may be always accepted or always rejected
 - Exact match for single 48-bit individual (unicast) address
 - Hash (64-bit hash) check of individual (unicast) addresses



- Hash (64-bit hash) check of group (multicast) addresses
- Promiscuous mode

21.2 **Modes of Operation**

The primary operational modes are described in this section.

Full and Half Duplex Operation 21.2.1

Full duplex mode is for use on point-to-point links between switches or end node to switch. Half duplex mode works in connections between an end node and a repeater or between repeaters. TCR[FDEN] controls duplex mode selection.

When configured for full duplex mode, flow control may be enabled. Refer to the TCR[RFC PAUSE, TFC PAUSE] bits, the RCR[FCE] bit, and Section 21.5.11, "Full Duplex Flow Control," for more details.

21.2.2 **Interface Options**

The following interface options are supported. A detailed discussion of the interface configurations is provided in Section 21.5.6, "Network Interface Options."

10 Mbps and 100 Mbps MII Interface 21.2.2.1

The IEEE 802.3 standard defines the media independent interface (MII) for 10/100 Mbps operation. The MAC-PHY interface may be configured to operate in MII mode by setting RCR[MII MODE].

FEC TXCLK and FEC RXCLK pins driven by the external transceiver determine the operation speed. The transceiver auto-negotiates the speed or software controls it via the serial management interface (FEC MDC/FEC MDIO pins) to the transceiver. Refer to the MMFR and MSCR register descriptions, as well as the section on the MII, for a description of how to read and write registers in the transceiver via this interface

21.2.2.2 10 Mpbs 7-Wire Interface Operation

The FEC supports 7-wire interface used by many 10 Mbps Ethernet transceivers. The RCR[MII MODE] bit controls this functionality. If this bit is cleared, MII mode is disabled and the 10 Mbps 7-wire mode is enabled.

21.2.3 **Address Recognition Options**

The address options supported are promiscuous, broadcast reject, individual address (hash or exact match), and multicast hash match. Address recognition options are discussed in detail in Section 21.5.9, "Ethernet Address Recognition."

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21.2.4 Internal Loopback

Internal loopback mode is selected via RCR[LOOP]. Loopback mode is discussed in detail in Section 21.5.14, "MII Internal and External Loopback."

21.3 External Signal Description

Table 21-1 describes the various FEC signals, as well as indicating which signals work in available modes.

Table 21-1. FEC Signal Descriptions

| Signal Name | W | 7-wire | Description |
|--------------|---|--------|--|
| FEC_COL | Х | Х | Asserted upon detection of a collision and remains asserted while the collision persists. This signal is not defined for full-duplex mode. |
| FEC_CRS | Х | _ | When asserted, indicates that transmit or receive medium is not idle. |
| FEC_MDC | Х | _ | Output clock which provides a timing reference to the PHY for data transfers on the FEC_MDIO signal. |
| FEC_MDIO | Х | _ | Transfers control information between the external PHY and the media-access controller. Data is synchronous to FEC_MDC. This signal is an input after reset. When the FEC is operated in 10Mbps 7-wire interface mode, this signal should be connected to VSS. |
| FEC_RXCLK | Х | Χ | Provides a timing reference for FEC_RXDV, FEC_RXD[3:0], and FEC_RXER. |
| FEC_RXDV | Х | Х | Asserting the FEC_RXDV input indicates that the PHY has valid nibbles present on the MII. FEC_RXDV should remain asserted from the first recovered nibble of the frame through to the last nibble. Assertion of FEC_RXDV must start no later than the SFD and exclude any EOF. |
| FEC_RXD0 | Х | Х | This pin contains the Ethernet input data transferred from the PHY to the media-access controller when FEC_RXDV is asserted. |
| FEC_RXD1 | Х | | This pin contains the Ethernet input data transferred from the PHY to the media access controller when FEC_RXDV is asserted. |
| FEC_RXD[3:2] | Х | | These pins contain the Ethernet input data transferred from the PHY to the media access controller when FEC_RXDV is asserted. |
| FEC_RXER | Х | _ | When asserted with FEC_RXDV, indicates that the PHY has detected an error in the current frame. When FEC_RXDV is not asserted FEC_RXER has no effect. |
| FEC_TXCLK | Х | Χ | Input clock which provides a timing reference for FEC_TXEN, FEC_TXD[3:0] and FEC_TXER. |
| FEC_TXD0 | Х | Х | The serial output Ethernet data and is only valid during the assertion of FEC_TXEN. |
| FEC_TXD1 | Х | | This pin contains the serial output Ethernet data and is valid only during assertion of FEC_TXEN. |
| FEC_TXD[3:2] | Х | | These pins contain the serial output Ethernet data and are valid only during assertion of FEC_TXEN. |
| FEC_TXEN | Х | Х | Indicates when valid nibbles are present on the MII. This signal is asserted with the first nibble of a preamble and is negated before the first FEC_TXCLK following the final nibble of the frame. |
| FEC_TXER | Х | _ | When asserted for one or more clock cycles while FEC_TXEN is also asserted, the PHY sends one or more illegal symbols. FEC_TXER has no effect at 10 Mbps or when FEC_TXEN is negated. |

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21.4 Memory Map/Register Definition

The FEC is programmed by a combination of control/status registers (CSRs) and buffer descriptors. The CSRs control operation modes and extract global status information. The descriptors pass data buffers and related buffer information between the hardware and software.

Each FEC implementation requires a 1-Kbyte memory map space, which is divided into two sections of 512 bytes each for:

- Control/status registers
- Event/statistic counters held in the MIB block

Table 21-2 defines the top level memory map.

Table 21-2. Module Memory Map

| Address | Function |
|------------------------|--------------------------|
| IPSBAR + 0x1000 - 11FF | Control/Status Registers |
| IPSBAR + 0x1200 - 12FF | MIB Block Counters |

Table 21-3 shows the FEC register memory map.

Table 21-3. FEC Register Memory Map

| IPSBAR Offset | Register | Width (bits) | Access | Reset Value | Section/Page |
|---------------|---|--------------|--------|-------------|---------------|
| 0x1004 | Interrupt Event Register (EIR) | 32 | R/W | 0x0000_0000 | 21.4.2/21-9 |
| 0x1008 | Interrupt Mask Register (EIMR) | 32 | R/W | 0x0000_0000 | 21.4.3/21-11 |
| 0x1010 | Receive Descriptor Active Register (RDAR) | 32 | R/W | 0x0000_0000 | 21.4.4/21-11 |
| 0x1014 | Transmit Descriptor Active Register (TDAR) | 32 | R/W | 0x0000_0000 | 21.4.5/21-12 |
| 0x1024 | Ethernet Control Register (ECR) | 32 | R/W | 0xF000_0000 | 21.4.6/21-13 |
| 0x1040 | MII Management Frame Register (MMFR) | 32 | R/W | Undefined | 21.4.7/21-13 |
| 0x1044 | MII Speed Control Register (MSCR) | 32 | R/W | 0x0000_0000 | 21.4.8/21-15 |
| 0x1064 | MIB Control/Status Register (MIBC) | 32 | R/W | 0x0000_0000 | 21.4.9/21-16 |
| 0x1084 | Receive Control Register (RCR) | 32 | R/W | 0x05EE_0001 | 21.4.10/21-16 |
| 0x10C4 | Transmit Control Register (TCR) | 32 | R/W | 0x0000_0000 | 21.4.11/21-17 |
| 0x10E4 | Physical Address Low Register (PALR) | 32 | R/W | Undefined | 21.4.12/21-18 |
| 0x10E8 | Physical Address High Register (PAUR) | 32 | R/W | See Section | 21.4.13/21-19 |
| 0x10EC | Opcode/Pause Duration (OPD) | 32 | R/W | See Section | 21.4.14/21-19 |
| 0x1118 | Descriptor Individual Upper Address Register (IAUR) | 32 | R/W | Undefined | 21.4.15/21-20 |
| 0x111C | Descriptor Individual Lower Address Register (IALR) | 32 | R/W | Undefined | 21.4.16/21-20 |
| 0x1120 | Descriptor Group Upper Address Register (GAUR) | 32 | R/W | Undefined | 21.4.17/21-21 |
| 0x1124 | Descriptor Group Lower Address Register (GALR) | 32 | R/W | Undefined | 21.4.18/21-21 |



Table 21-3. FEC Register Memory Map (continued)

| IPSBAR Offset | Register | Width (bits) | Access | Reset Value | Section/Page |
|---------------|---|--------------|--------|-------------|---------------|
| 0x1144 | Transmit FIFO Watermark (TFWR) | 32 | R/W | 0x0000_0000 | 21.4.19/21-22 |
| 0x114C | FIFO Receive Bound Register (FRBR) | 32 | R | 0x0000_0600 | 21.4.20/21-22 |
| 0x1150 | FIFO Receive FIFO Start Register (FRSR) | 32 | R | 0x0000_0500 | 21.4.21/21-23 |
| 0x1180 | Pointer to Receive Descriptor Ring (ERDSR) | 32 | R/W | Undefined | 21.4.22/21-23 |
| 0x1184 | Pointer to Transmit Descriptor Ring (ETDSR) | 32 | R/W | Undefined | 21.4.23/21-24 |
| 0x1188 | Maximum Receive Buffer Size (EMRBR) | 32 | R/W | Undefined | 21.4.24/21-24 |

21.4.1 MIB Block Counters Memory Map

The MIB counters memory map (Table 21-4) defines the locations in the MIB RAM space where hardware-maintained counters reside. The counters are divided into two groups:

- RMON counters include the Ethernet statistics counters defined in RFC 1757
- A counter is included to count truncated frames since only frame lengths up to 2047 bytes are supported

The transmit and receive RMON counters are independent, which ensures accurate network statistics when operating in full duplex mode.

The included IEEE counters support the mandatory and recommended counter packages defined in Section 5 of ANSI/IEEE Std. 802.3 (1998 edition). The FEC supports IEEE Basic Package objects, but these do not require counters in the MIB block. In addition, some of the recommended package objects supported do not require MIB counters. Counters for transmit and receive full duplex flow control frames are also included

Table 21-4. MIB Counters Memory Map

| IPSBAR Offset | Register |
|---------------|--|
| 0x1200 | Count of frames not counted correctly (RMON_T_DROP) |
| 0x1204 | RMON Tx packet count (RMON_T_PACKETS) |
| 0x1208 | RMON Tx broadcast packets (RMON_T_BC_PKT) |
| 0x120C | RMON Tx multicast packets (RMON_T_MC_PKT) |
| 0x1210 | RMON Tx packets with CRC/align error (RMON_T_CRC_ALIGN) |
| 0x1214 | RMON Tx packets < 64 bytes, good CRC (RMON_T_UNDERSIZE) |
| 0x1218 | RMON Tx packets > MAX_FL bytes, good CRC (RMON_T_OVERSIZE) |
| 0x121C | RMON Tx packets < 64 bytes, bad CRC (RMON_T_FRAG) |
| 0x1220 | RMON Tx packets > MAX_FL bytes, bad CRC (RMON_T_JAB) |
| 0x1224 | RMON Tx collision count (RMON_T_COL) |
| 0x1228 | RMON Tx 64 byte packets (RMON_T_P64) |

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Table 21-4. MIB Counters Memory Map (continued)

| IPSBAR Offset | Register |
|---------------|---|
| 0x122C | RMON Tx 65 to 127 byte packets (RMON_T_P65TO127) |
| 0x1230 | RMON Tx 128 to 255 byte packets (RMON_T_P128TO255) |
| 0x1234 | RMON Tx 256 to 511 byte packets (RMON_T_P256TO511) |
| 0x1238 | RMON Tx 512 to 1023 byte packets (RMON_T_P512TO1023) |
| 0x123C | RMON Tx 1024 to 2047 byte packets (RMON_T_P1024TO2047) |
| 0x1240 | RMON Tx packets with > 2048 bytes (RMON_T_P_GTE2048) |
| 0x1244 | RMON Tx Octets (RMON_T_OCTETS) |
| 0x1248 | Count of transmitted frames not counted correctly (IEEE_T_DROP) |
| 0x124C | Frames transmitted OK (IEEE_T_FRAME_OK) |
| 0x1250 | Frames transmitted with single collision (IEEE_T_1COL) |
| 0x1254 | Frames transmitted with multiple collisions (IEEE_T_MCOL) |
| 0x1258 | Frames transmitted after deferral delay (IEEE_T_DEF) |
| 0x125C | Frames transmitted with late collision (IEEE_T_LCOL) |
| 0x1260 | Frames transmitted with excessive collisions (IEEE_T_EXCOL) |
| 0x1264 | Frames transmitted with Tx FIFO underrun (IEEE_T_MACERR) |
| 0x1268 | Frames transmitted with carrier sense error (IEEE_T_CSERR) |
| 0x126C | Frames transmitted with SQE error (IEEE_T_SQE) |
| 0x1270 | Flow control pause frames transmitted (IEEE_T_FDXFC) |
| 0x1274 | Octet count for frames transmitted without error (IEEE_T_OCTETS_OK) |
| 0x1280 | Count of received frames not counted correctly (RMON_R_DROP) |
| 0x1284 | RMON Rx packet count (RMON_R_PACKETS) |
| 0x1288 | RMON Rx broadcast packets (RMON_R_BC_PKT) |
| 0x128C | RMON Rx multicast packets (RMON_R_MC_PKT) |
| 0x1290 | RMON Rx packets with CRC/Align error (RMON_R_CRC_ALIGN) |
| 0x1294 | RMON Rx packets < 64 bytes, good CRC (RMON_R_UNDERSIZE) |
| 0x1298 | RMON Rx packets > MAX_FL bytes, good CRC (RMON_R_OVERSIZE) |
| 0x129C | RMON Rx packets < 64 bytes, bad CRC (RMON_R_FRAG) |
| 0x12A0 | RMON Rx packets > MAX_FL bytes, bad CRC (RMON_R_JAB) |
| 0x12A4 | Reserved (RMON_R_RESVD_0) |
| 0x12A8 | RMON Rx 64 byte packets (RMON_R_P64) |
| 0x12AC | RMON Rx 65 to 127 byte packets (RMON_R_P65TO127) |
| 0x12B0 | RMON Rx 128 to 255 byte packets (RMON_R_P128TO255) |
| 0x12B4 | RMON Rx 256 to 511 byte packets (RMON_R_P256TO511) |

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Table 21-4. MIB Counters Memory Map (continued)

| IPSBAR Offset | Register |
|---------------|--|
| 0x12B8 | RMON Rx 512 to 1023 byte packets (RMON_R_P512TO1023) |
| 0x12BC | RMON Rx 1024 to 2047 byte packets (RMON_R_P1024TO2047) |
| 0x12C0 | RMON Rx packets with > 2048 bytes (RMON_R_P_GTE2048) |
| 0x12C4 | RMON Rx octets (RMON_R_OCTETS) |
| 0x12C8 | Count of received frames not counted correctly (IEEE_R_DROP) |
| 0x12CC | Frames received OK (IEEE_R_FRAME_OK) |
| 0x12D0 | Frames received with CRC error (IEEE_R_CRC) |
| 0x12D4 | Frames received with alignment error (IEEE_R_ALIGN) |
| 0x12D8 | Receive FIFO overflow count (IEEE_R_MACERR) |
| 0x12DC | Flow control pause frames received (IEEE_R_FDXFC) |
| 0x12E0 | Octet count for frames received without error (IEEE_R_OCTETS_OK) |

21.4.2 Ethernet Interrupt Event Register (EIR)

When an event occurs that sets a bit in EIR, an interrupt occurs if the corresponding bit in the interrupt mask register (EIMR) is also set. Writing a 1 to an EIR bit clears it; writing 0 has no effect. This register is cleared upon hardware reset.

These interrupts can be divided into operational interrupts, transceiver/network error interrupts, and internal error interrupts. Interrupts which may occur in normal operation are GRA, TXF, TXB, RXF, RXB, and MII. Interrupts resulting from errors/problems detected in the network or transceiver are HBERR, BABR, BABT, LC, and RL. Interrupts resulting from internal errors are HBERR and UN.

Some of the error interrupts are independently counted in the MIB block counters:

- HBERR IEEE T SQE
- BABR RMON R OVERSIZE (good CRC), RMON R JAB (bad CRC)
- BABT RMON T OVERSIZE (good CRC), RMON T JAB (bad CRC)
- LATE COL IEEE T LCOL
- COL RETRY LIM IEEE T EXCOL
- XFIFO UN IEEE T MACERR

Software may choose to mask off these interrupts because these errors are visible to network management via the MIB counters.



IPSBAR 0x1004 Access: User read/write Offset: НВ ΕB R BABR BABT GRA TXF TXB **RXF RXB** MII LC RLUN **ERR ERR** W w1c Reset R Reset

Figure 21-2. Ethernet Interrupt Event Register (EIR)

Table 21-5. EIR Field Descriptions

| Field | Description |
|-------------|---|
| 31 HBERR | Heartbeat error. Indicates TCR[HBC] is set and that the COL input was not asserted within the heartbeat window following a transmission. |
| 30 BABR | Babbling receive error. Indicates a frame was received with length in excess of RCR[MAX_FL] bytes. |
| 29 BABT | Babbling transmit error. Indicates the transmitted frame length exceeds RCR[MAX_FL] bytes. Usually this condition is caused by a frame that is too long is placed into the transmit data buffer(s). Truncation does not occur. |
| 28 GRA | Graceful stop complete. Indicates the graceful stop is complete. During graceful stop the transmitter is placed into a pause state after completion of the frame currently being transmitted. This bit is set by one of three conditions: 1) A graceful stop initiated by the setting of the TCR[GTS] bit is now complete. 2) A graceful stop initiated by the setting of the TCR[TFC_PAUSE] bit is now complete. 3) A graceful stop initiated by the reception of a valid full duplex flow control pause frame is now complete. Refer to Section 21.5.11, "Full Duplex Flow Control." |
| 27 TXF | Transmit frame interrupt. Indicates a frame has been transmitted and the last corresponding buffer descriptor has been updated. |
| 26 TXB | Transmit buffer interrupt. Indicates a transmit buffer descriptor has been updated. |
| 25 RXF | Receive frame interrupt. Indicates a frame has been received and the last corresponding buffer descriptor has been updated. |
| 24 RXB | Receive buffer interrupt. Indicates a receive buffer descriptor not the last in the frame has been updated. |
| 23 MII | MII interrupt. Indicates the MII has completed the data transfer requested. |
| 22 EBERR | Ethernet bus error. Indicates a system bus error occurred when a DMA transaction is underway. When the EBERR bit is set, ECR[ETHER_EN] is cleared, halting frame processing by the FEC. When this occurs, software needs to ensure that the FIFO controller and DMA also soft reset. |
| 21 LC | Late collision. Indicates a collision occurred beyond the collision window (slot time) in half duplex mode. The frame truncates with a bad CRC and the remainder of the frame is discarded. |



Table 21-5. EIR Field Descriptions (continued)

| Field | Description |
|----------|--|
| 20 RL | Collision retry limit. Indicates a collision occurred on each of 16 successive attempts to transmit the frame. The frame is discarded without being transmitted and transmission of the next frame commences. This error can only occur in half duplex mode. |
| 19 UN | Transmit FIFO underrun. Indicates the transmit FIFO became empty before the complete frame was transmitted. A bad CRC is appended to the frame fragment and the remainder of the frame is discarded. |
| 18–0 | Reserved, must be cleared. |

21.4.3 Interrupt Mask Register (EIMR)

The EIMR register controls which interrupt events are allowed to generate actual interrupts. All implemented bits in this CSR are read/write. A hardware reset clears this register. If the corresponding bits in the EIR and EIMR registers are set, an interrupt is generated. The interrupt signal remains asserted until a 1 is written to the EIR bit (write 1 to clear) or a 0 is written to the EIMR bit.

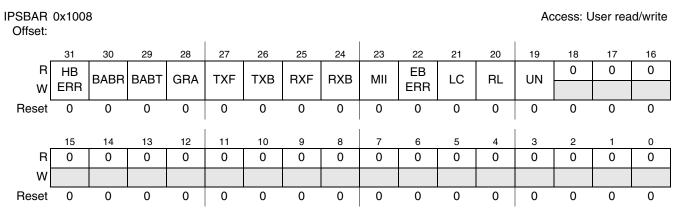


Figure 21-3. Ethernet Interrupt Mask Register (EIMR)

Table 21-6. EIMR Field Descriptions

| Field | Description |
|---|---|
| 31–19 See Figure 21-3 and Table 21-5 | Interrupt mask. Each bit corresponds to an interrupt source defined by the EIR register. The corresponding EIMR bit determines whether an interrupt condition can generate an interrupt. At every processor clock, the EIR samples the signal generated by the interrupting source. The corresponding EIR bit reflects the state of the interrupt signal even if the corresponding EIMR bit is set. O The corresponding interrupt source is masked. 1 The corresponding interrupt source is not masked. |
| 18–0 | Reserved, must be cleared. |

21.4.4 Receive Descriptor Active Register (RDAR)

RDAR is a command register, written by the user, indicating the receive descriptor ring is updated (the driver produced empty receive buffers with the empty bit set).

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When the register is written, the RDAR bit is set. This is independent of the data actually written by the user. When set, the FEC polls the receive descriptor ring and processes receive frames (provided ECR[ETHER_EN] is also set). After the FEC polls a receive descriptor whose empty bit is not set, FEC clears the RDAR bit and ceases receive descriptor ring polling until the user sets the bit again, signifying that additional descriptors are placed into the receive descriptor ring.

The RDAR register is cleared at reset and when ECR[ETHER EN] is cleared.

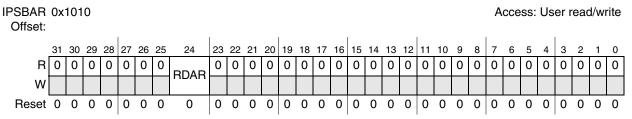


Figure 21-4. Receive Descriptor Active Register (RDAR)

Table 21-7. RDAR Field Descriptions

| Field | Description |
|------------|---|
| 31–25 | Reserved, must be cleared. |
| 24 RDAR | Set to 1 when this register is written, regardless of the value written. Cleared by the FEC device when no additional empty descriptors remain in the receive ring. Also cleared when ECR[ETHER_EN] is cleared. |
| 23–0 | Reserved, must be cleared. |

21.4.5 Transmit Descriptor Active Register (TDAR)

The TDAR is a command register which the user writes to indicate the transmit descriptor ring is updated (transmit buffers have been produced by the driver with the ready bit set in the buffer descriptor).

When the register is written, the TDAR bit is set. This value is independent of the data actually written by the user. When set, the FEC polls the transmit descriptor ring and processes transmit frames (provided ECR[ETHER_EN] is also set). After the FEC polls a transmit descriptor that is a ready bit not set, FEC clears the TDAR bit and ceases transmit descriptor ring polling until the user sets the bit again, signifying additional descriptors are placed into the transmit descriptor ring.

The TDAR register is cleared at reset, when ECR[ETHER EN] is cleared, or when ECR[RESET] is set.

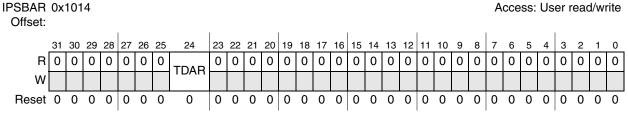


Figure 21-5. Transmit Descriptor Active Register (TDAR)

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Table 21-8. TDAR Field Descriptions

| Field | Description |
|------------|--|
| 31–25 | Reserved, must be cleared. |
| 24 TDAR | Set to 1 when this register is written, regardless of the value written. Cleared by the FEC device when no additional ready descriptors remain in the transmit ring. Also cleared when ECR[ETHER_EN] is cleared. |
| 23–0 | Reserved, must be cleared. |

21.4.6 Ethernet Control Register (ECR)

ECR is a read/write user register, though hardware may alter fields in this register as well. The ECR enables/disables the FEC.

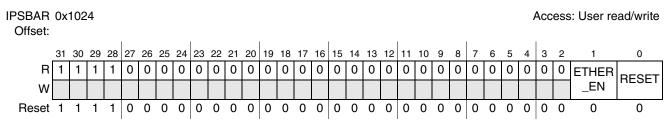


Figure 21-6. Ethernet Control Register (ECR)

Table 21-9. ECR Field Descriptions

| Field | Description |
|---------------|---|
| 31–2 | Reserved, must be cleared. |
| 1 ETHER_EN | When this bit is set, FEC is enabled, and reception and transmission are possible. When this bit is cleared, reception immediately stops and transmission stops after a bad CRC is appended to any currently transmitted frame. The buffer descriptor(s) for an aborted transmit frame are not updated after clearing this bit. When ETHER_EN is cleared, the DMA, buffer descriptor, and FIFO control logic are reset, including the buffer descriptor and FIFO pointers. Hardware alters the ETHER_EN bit under the following conditions: • ECR[RESET] is set by software, in which case ETHER_EN is cleared • An error condition causes the EIR[EBERR] bit to set, in which case ETHER_EN is cleared |
| 0 RESET | When this bit is set, the equivalent of a hardware reset is performed but it is local to the FEC. ECR[ETHER_EN] is cleared and all other FEC registers take their reset values. Also, any transmission/reception currently in progress is abruptly aborted. This bit is automatically cleared by hardware during the reset sequence. The reset sequence takes approximately eight internal bus clock cycles after this bit is set. |

21.4.7 MII Management Frame Register (MMFR)

The MMFR is user-accessible and does not reset to a defined value. The MMFR register is used to communicate with the attached MII compatible PHY device(s), providing read/write access to their MII registers. Performing a write to the MMFR causes a management frame to be sourced unless the MSCR is programmed to 0. If MSCR is cleared while MMFR is written and then MSCR is written with a non-zero value, an MII frame is generated with the data previously written to the MMFR. This allows MMFR and MSCR to be programmed in either order if MSCR is currently zero.

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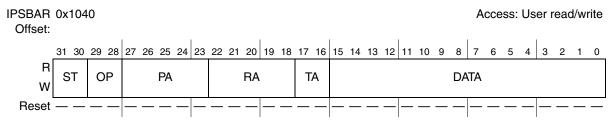


Figure 21-7. MII Management Frame Register (MMFR)

Table 21-10. MMFR Field Descriptions

| Field | Description |
|--------------|---|
| 31–30 ST | Start of frame delimiter. These bits must be programmed to 0b01 for a valid MII management frame. |
| 29–28 OP | Operation code. 00 Write frame operation, but not MII compliant. 01 Write frame operation for a valid MII management frame. 10 Read frame operation for a valid MII management frame. 11 Read frame operation, but not MII compliant. |
| 27–23 PA | PHY address. This field specifies one of up to 32 attached PHY devices. |
| 22–18 RA | Register address. This field specifies one of up to 32 registers within the specified PHY device. |
| 17–16 TA | Turn around. This field must be programmed to 10 to generate a valid MII management frame. |
| 15–0 DATA | Management frame data. This is the field for data to be written to or read from the PHY register. |

To perform a read or write operation on the MII Management Interface, write the MMFR register. To generate a valid read or write management frame, ST field must be written with a 01 pattern, and the TA field must be written with a 10. If other patterns are written to these fields, a frame is generated, but does not comply with the IEEE 802.3 MII definition.

To generate an IEEE 802.3-compliant MII Management Interface write frame (write to a PHY register), the user must write {01 01 PHYAD REGAD 10 DATA} to the MMFR register. Writing this pattern causes the control logic to shift out the data in the MMFR register following a preamble generated by the control state machine. During this time, contents of the MMFR register are altered as the contents are serially shifted and are unpredictable if read by the user. After the write management frame operation completes, the MII interrupt is generated. At this time, contents of the MMFR register match the original value written.

To generate an MII management interface read frame (read a PHY register), the user must write {01 10 PHYAD REGAD 10 XXXX} to the MMFR register (the content of the DATA field is a don't care). Writing this pattern causes the control logic to shift out the data in the MMFR register following a preamble generated by the control state machine. During this time, contents of the MMFR register are altered as the contents are serially shifted and are unpredictable if read by the user. After the read management frame operation completes, the MII interrupt is generated. At this time, the contents of the MMFR register match



the original value written except for the DATA field whose contents are replaced by the value read from the PHY register.

If the MMFR register is written while frame generation is in progress, the frame contents are altered. Software must use the MII interrupt to avoid writing to the MMFR register while frame generation is in progress.

21.4.8 MII Speed Control Register (MSCR)

The MSCR provides control of the MII clock (FEC_MDC pin) frequency and allows a preamble drop on the MII management frame.

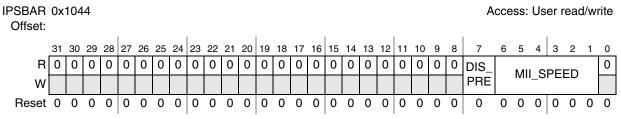


Figure 21-8. MII Speed Control Register (MSCR)

Table 21-11. MSCR Field Descriptions

| Field | Description |
|------------------|---|
| 31–8 | Reserved, must be cleared. |
| 7 DIS_PRE | Setting this bit causes the preamble (32 ones) not to be prepended to the MII management frame. The MII standard allows the preamble to be dropped if the attached PHY device(s) does not require it. |
| 6–1 MII_SPEED | Controls the frequency of the MII management interface clock (FEC_MDC) relative to the internal bus clock. A value of 0 in this field turns off the FEC_MDC and leaves it in low voltage state. Any non-zero value results in the FEC_MDC frequency of 1/(MII_SPEED × 2) of the internal bus frequency. |
| 0 | Reserved, must be cleared. |

The MII_SPEED field must be programmed with a value to provide an FEC_MDC frequency of less than or equal to 2.5 MHz to be compliant with the IEEE 802.3 MII specification. The MII_SPEED must be set to a non-zero value to source a read or write management frame. After the management frame is complete, the MSCR register may optionally be set to 0 to turn off the FEC_MDC. The FEC_MDC generated has a 50% duty cycle except when MII_SPEED changes during operation (change takes effect following a rising or falling edge of FEC_MDC).

If the internal bus clock is 25 MHz, programming this register to 0x0000_0005 results in an FEC_MDC as stated the equation below.

$$25 \text{ MHz} \times \frac{1}{5 \times 2} = 2.5 \text{ MHz}$$
 Eqn. 21-1

A table showing optimum values for MII_SPEED as a function of internal bus clock frequency is provided below.

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| Internal FEC Clock Frequency | MSCR[MII_SPEED] | FEC_MDC frequency |
|---------------------------------|-----------------|-------------------|
| 25 MHz | 0x5 | 2.50 MHz |
| 33 MHz | 0x7 | 2.36 MHz |
| 40 MHz | 0x8 | 2.50 MHz |
| 50 MHz | 0xA | 2.50 MHz |
| 66 MHz | 0xE | 2.36 MHz |

Table 21-12. Programming Examples for MSCR

MIB Control Register (MIBC) 21.4.9

The MIBC is a read/write register controlling and observing the state of the MIB block. User software accesses this register if there is a need to disable the MIB block operation. For example, to clear all MIB counters in RAM:

- 1. Disable the MIB block
- 2. Clear all the MIB RAM locations
- 3. Enable the MIB block

The MIB DIS bit is reset to 1. See Table 21-4 for the locations of the MIB counters.

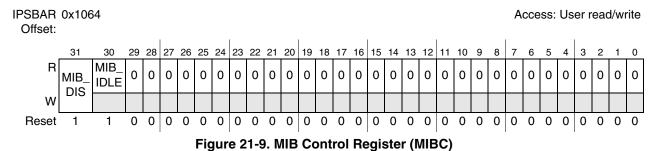


Table 21-13. MIBC Field Descriptions

| Field | Description |
|----------------|--|
| 31 MIB_DIS | A read/write control bit. If set, the MIB logic halts and not update any MIB counters. |
| 30 MIB_IDLE | A read-only status bit. If set the MIB block is not currently updating any MIB counters. |
| 29–0 | Reserved. |

21.4.10 Receive Control Register (RCR)

RCR controls the operational mode of the receive block and must be written only when ECR[ETHER EN] is cleared (initialization time).

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IPSBAR 0x1084 Access: User read/write Offset: R MAX_FL Reset R BC $MII_{\underline{}}$ FCE PROM DRT LOOP REJ MODE Reset

Figure 21-10. Receive Control Register (RCR)

Table 21-14. RCR Field Descriptions

| Field | Description |
|-----------------|---|
| 31–27 | Reserved, must be cleared. |
| 26–16 MAX_FL | Maximum frame length. Resets to decimal 1518. Length is measured starting at DA and includes the CRC at the end of the frame. Transmit frames longer than MAX_FL causes the BABT interrupt to occur. Receive frames longer than MAX_FL causes the BABR interrupt to occur and sets the LG bit in the end of frame receive buffer descriptor. The recommended default value to be programmed is 1518 or 1522 if VLAN tags are supported. |
| 15–6 | Reserved, must be cleared. |
| 5 FCE | Flow control enable. If asserted, the receiver detects PAUSE frames. Upon PAUSE frame detection, the transmitter stops transmitting data frames for a given duration. |
| 4 BC_REJ | Broadcast frame reject. If asserted, frames with DA (destination address) equal to FFFF_FFFF_FFFF are rejected unless the PROM bit is set. If BC_REJ and PROM are set, frames with broadcast DA are accepted and the M (MISS) is set in the receive buffer descriptor. |
| 3 PROM | Promiscuous mode. All frames are accepted regardless of address matching. |
| 2 MII_MODE | Media independent interface mode. Selects the external interface mode for transmit and receive blocks. 0 7-wire mode (used only for serial 10 Mbps) 1 MII mode |
| 1 DRT | Disable receive on transmit. O Receive path operates independently of transmit (use for full duplex or to monitor transmit activity in half duplex mode). 1 Disable reception of frames while transmitting (normally used for half duplex mode). |
| 0 LOOP | Internal loopback. If set, transmitted frames are looped back internal to the device and transmit output signals are not asserted. The internal bus clock substitutes for the FEC_TXCLK when LOOP is asserted. DRT must be set to 0 when setting LOOP. |

21.4.11 Transmit Control Register (TCR)

TCR is read/write and configures the transmit block. This register is cleared at system reset. Bits 2 and 1 must be modified only when ECR[ETHER_EN] is cleared.

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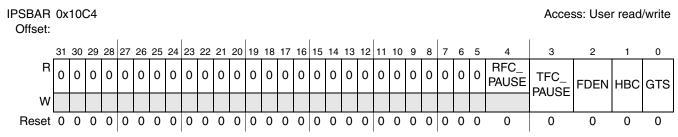


Figure 21-11. Transmit Control Register (TCR)

Table 21-15. TCR Field Descriptions

| Field | Description |
|----------------|---|
| 31–5 | Reserved, must be cleared. |
| 4 RFC_PAUSE | Receive frame control pause. This read-only status bit is asserted when a full duplex flow control pause frame is received and the transmitter pauses for the duration defined in this pause frame. This bit automatically clears when the pause duration is complete. |
| 3 TFC_PAUSE | Transmit frame control pause. Transmits a PAUSE frame when asserted. When this bit is set, the MAC stops transmission of data frames after the current transmission is complete. At this time, GRA interrupt in the EIR register is asserted. With transmission of data frames stopped, MAC transmits a MAC Control PAUSE frame. Next, the MAC clears the TFC_PAUSE bit and resumes transmitting data frames. If the transmitter pauses due to user assertion of GTS or reception of a PAUSE frame, the MAC may continue transmitting a MAC Control PAUSE frame. |
| 2 FDEN | Full duplex enable. If set, frames transmit independent of carrier sense and collision inputs. This bit should only be modified when ECR[ETHER_EN] is cleared. |
| 1 HBC | Heartbeat control. If set, the heartbeat check performs following end of transmission and the HB bit in the status register is set if the collision input does not assert within the heartbeat window. This bit should only be modified when ECR[ETHER_EN] is cleared. |
| 0 GTS | Graceful transmit stop. When this bit is set, MAC stops transmission after any frame currently transmitted is complete and GRA interrupt in the EIR register is asserted. If frame transmission is not currently underway, the GRA interrupt is asserted immediately. After transmission finishes, clear GTS to restart. The next frame in the transmit FIFO is then transmitted. If an early collision occurs during transmission when GTS is set, transmission stops after the collision. The frame is transmitted again after GTS is cleared. There may be old frames in the transmit FIFO that transmit when GTS is reasserted. To avoid this, clear ECR[ETHER_EN] following the GRA interrupt. |

21.4.12 Physical Address Lower Register (PALR)

PALR contains the lower 32 bits (bytes 0,1,2,3) of the 48-bit address used in the address recognition process to compare with the DA (destination address) field of receive frames with an individual DA. In addition, this register is used in bytes 0 through 3 of the 6-byte source address field when transmitting PAUSE frames. This register is not reset and you must initialize it.



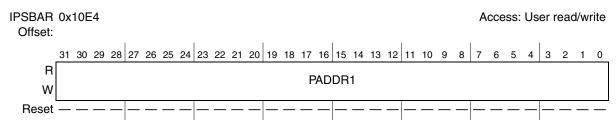


Figure 21-12. Physical Address Lower Register (PALR)

Table 21-16. PALR Field Descriptions

| Field | Description |
|-------|---|
| | Bytes 0 (bits 31:24), 1 (bits 23:16), 2 (bits 15:8), and 3 (bits 7:0) of the 6-byte individual address are used for exact match and the source address field in PAUSE frames. |

21.4.13 Physical Address Upper Register (PAUR)

PAUR contains the upper 16 bits (bytes 4 and 5) of the 48-bit address used in the address recognition process to compare with the DA (destination address) field of receive frames with an individual DA. In addition, this register is used in bytes 4 and 5 of the 6-byte Source Address field when transmitting PAUSE frames. Bits 15:0 of PAUR contain a constant type field (0x8808) for transmission of PAUSE frames. The upper 16 bits of this register are not reset and you must initialize it.

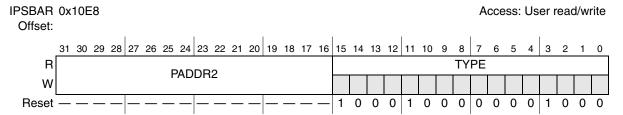


Figure 21-13. Physical Address Upper Register (PAUR)

Table 21-17. PAUR Field Descriptions

| Field | Description |
|--------------|--|
| | Bytes 4 (bits 31:24) and 5 (bits 23:16) of the 6-byte individual address used for exact match, and the source address field in PAUSE frames. |
| 15–0 TYPE | Type field in PAUSE frames. These 16 read-only bits are a constant value of 0x8808. |

21.4.14 Opcode/Pause Duration Register (OPD)

The OPD is read/write accessible. This register contains the 16-bit opcode and 16-bit pause duration fields used in transmission of a PAUSE frame. The opcode field is a constant value, 0x0001. When another node detects a PAUSE frame, that node pauses transmission for the duration specified in the pause duration field. The lower 16 bits of this register are not reset and you must initialize them.

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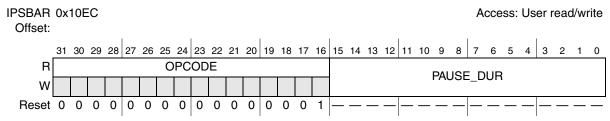


Figure 21-14. Opcode/Pause Duration Register (OPD)

Table 21-18. OPD Field Descriptions

| Field | Description |
|-------------------|---|
| 31–16 OPCODE | Opcode field used in PAUSE frames. These read-only bits are a constant, 0x0001. |
| 15–0 PAUSE_DUR | Pause Duration field used in PAUSE frames. |

21.4.15 Descriptor Individual Upper Address Register (IAUR)

IAUR contains the upper 32 bits of the 64-bit individual address hash table. The address recognition process uses this table to check for a possible match with the destination address (DA) field of receive frames with an individual DA. This register is not reset and you must initialize it.

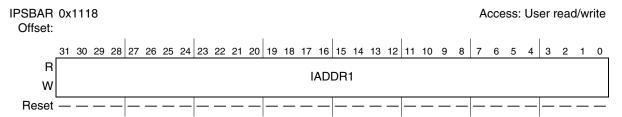


Figure 21-15. Descriptor Individual Upper Address Register (IAUR)

Table 21-19. IAUR Field Descriptions

| Field | Description |
|-------|--|
| | The upper 32 bits of the 64-bit hash table used in the address recognition process for receive frames with a unicast address. Bit 31 of IADDR1 contains hash index bit 63. Bit 0 of IADDR1 contains hash index bit 32. |

21.4.16 Descriptor Individual Lower Address Register (IALR)

IALR contains the lower 32 bits of the 64-bit individual address hash table. The address recognition process uses this table to check for a possible match with the DA field of receive frames with an individual DA. This register is not reset and you must initialize it.



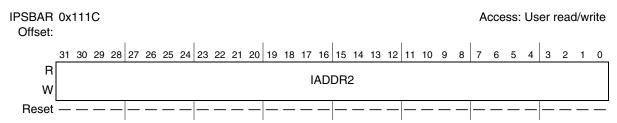


Figure 21-16. Descriptor Individual Lower Address Register (IALR)

Table 21-20. IALR Field Descriptions

| Field | Description |
|----------------|---|
| 31–0 IADDR2 | The lower 32 bits of the 64-bit hash table used in the address recognition process for receive frames with a unicast address. Bit 31 of IADDR2 contains hash index bit 31. Bit 0 of IADDR2 contains hash index bit 0. |

21.4.17 Descriptor Group Upper Address Register (GAUR)

GAUR contains the upper 32 bits of the 64-bit hash table used in the address recognition process for receive frames with a multicast address. You must initialize this register.

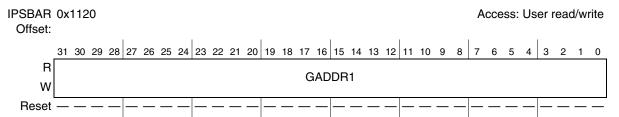


Figure 21-17. Descriptor Group Upper Address Register (GAUR)

Table 21-21. GAUR Field Descriptions

| Field | Description |
|----------------|---|
| 31–0 GADDR1 | The GADDR1 register contains the upper 32 bits of the 64-bit hash table used in the address recognition process for receive frames with a multicast address. Bit 31 of GADDR1 contains hash index bit 63. Bit 0 of GADDR1 contains hash index bit 32. |

21.4.18 Descriptor Group Lower Address Register (GALR)

GALR contains the lower 32 bits of the 64-bit hash table used in the address recognition process for receive frames with a multicast address. You must initialize this register.

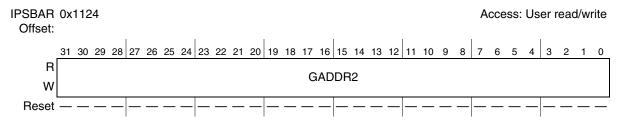


Figure 21-18. Descriptor Group Lower Address Register (GALR)

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Table 21-22. GALR Field Descriptions

| Field | Description |
|----------------|--|
| 31–0 GADDR2 | The GADDR2 register contains the lower 32 bits of the 64-bit hash table used in the address recognition process for receive frames with a multicast address. Bit 31 of GADDR2 contains hash index bit 31. Bit 0 of GADDR2 contains hash index bit 0. |

21.4.19 Transmit FIFO Watermark Register (TFWR)

The TFWR controls the amount of data required in the transmit FIFO before transmission of a frame can begin. This allows you to minimize transmit latency (TFWR = 00 or 01) or allow for larger bus access latency (TFWR = 11) due to contention for the system bus. Setting the watermark to a high value minimizes the risk of transmit FIFO underrun due to contention for the system bus. The byte counts associated with the TFWR field may need to be modified to match a given system requirement (worst case bus access latency by the transmit data DMA channel).

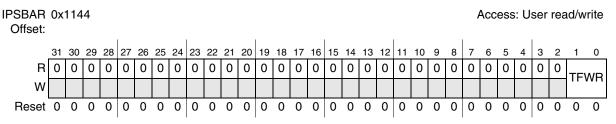


Figure 21-19. Transmit FIFO Watermark Register (TFWR)

Table 21-23. TFWR Field Descriptions

| Field | Description | | |
|-------------|--|--|--|
| 31–2 | eserved, must be cleared. | | |
| 1–0 TFWR | Number of bytes written to transmit FIFO before transmission of a frame begins 00 64 bytes written 01 64 bytes written 10 128 bytes written 11 192 bytes written | | |

21.4.20 FIFO Receive Bound Register (FRBR)

FRBR indicates the upper address bound of the FIFO RAM. Drivers can use this value, along with the FRSR, to appropriately divide the available FIFO RAM between the transmit and receive data paths.

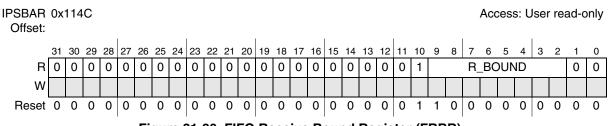


Figure 21-20. FIFO Receive Bound Register (FRBR)



Table 21-24. FRBR Field Descriptions

| Field | Description | | |
|----------------|--|--|--|
| 31–10 | Reserved, read as 0 (except bit 10, which is read as 1). | | |
| 9–2 R_BOUND | Read-only. Highest valid FIFO RAM address. | | |
| 1–0 | Reserved, read as 0. | | |

21.4.21 FIFO Receive Start Register (FRSR)

FRSR indicates the starting address of the receive FIFO. FRSR marks the boundary between the transmit and receive FIFOs. The transmit FIFO uses addresses from the start of the FIFO to the location four bytes before the address programmed into the FRSR. The receive FIFO uses addresses from FRSR to FRBR inclusive.

Hardware initializes the FRSR register at reset. FRSR only needs to be written to change the default value.

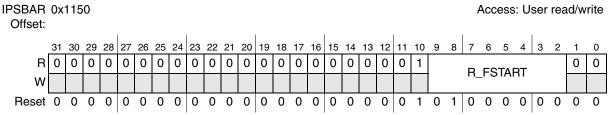


Figure 21-21. FIFO Receive Start Register (FRSR)

Table 21-25. FRSR Field Descriptions

| Field | Description | |
|-------|---|--|
| 31–11 | Reserved, must be cleared. | |
| 10 | Reserved, must be set. | |
| | Address of first receive FIFO location. Acts as delimiter between receive and transmit FIFOs. For proper operation, ensure that R_FSTART is set to 0x48 or greater. | |
| 1–0 | Reserved, must be cleared. | |

21.4.22 Receive Descriptor Ring Start Register (ERDSR)

ERDSR points to the start of the circular receive buffer descriptor queue in external memory. This pointer must be 32-bit aligned; however, it is recommended it be made 128-bit aligned (evenly divisible by 16).

This register is not reset and must be initialized prior to operation.

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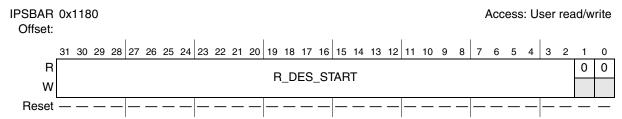


Figure 21-22. Ethernet Receive Descriptor Ring Start Register (ERDSR)

Table 21-26. ERDSR Field Descriptions

| Field | Description |
|---------------------|--|
| 31–2 R_DES_START | Pointer to start of receive buffer descriptor queue. |
| 1–0 | Reserved, must be cleared. |

21.4.23 Transmit Buffer Descriptor Ring Start Registers (ETSDR)

ETSDR provides a pointer to the start of the circular transmit buffer descriptor queue in external memory. This pointer must be 32-bit aligned; however, it is recommended it be made 128-bit aligned (evenly divisible by 16). You should write zeros to bits 1 and 0. Hardware ignores non-zero values in these two bit positions.

This register is undefined at reset and must be initialized prior to operation.

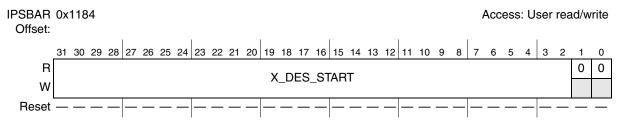


Figure 21-23. Transmit Buffer Descriptor Ring Start Register (ETDSR)

Table 21-27. ETDSR Field Descriptions

| Field | Description |
|---------------------|---|
| 31–2 X_DES_START | Pointer to start of transmit buffer descriptor queue. |
| 1–0 | Reserved, must be cleared. |

21.4.24 Receive Buffer Size Register (EMRBR)

The EMRBR is a user-programmable register that dictates the maximum size of all receive buffers. This value should take into consideration that the receive CRC is always written into the last receive buffer. To allow one maximum size frame per buffer, EMRBR must be set to RCR[MAX_FL] or larger. To properly align the buffer, EMRBR must be evenly divisible by 16. To ensure this, bits 3–0 are forced low.



To minimize bus utilization (descriptor fetches), it is recommended that EMRBR be greater than or equal to 256 bytes.

The EMRBR register is undefined at reset and must be initialized by the user.

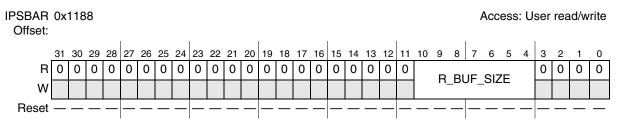


Figure 21-24. Receive Buffer Size Register (EMRBR)

Table 21-28. EMRBR Field Descriptions

| Field | Description | | |
|--------------------|--|--|--|
| 31–11 | Reserved, must be cleared. | | |
| 10–4 R_BUF_SIZE | Maximum size of receive buffer size in bytes. To minimize bus utilization (descriptor fetches), set this field to 256 bytes (0x10) or larger. 0x10 256 + 15 bytes (minimum size recommended) 0x11 272 + 15 bytes 0x7F 2032 + 15 bytes. The FEC writes up to 2047 bytes in the receive buffer. If data larger than 2047 is received, the FEC truncates it and shows 0x7FF in the receive descriptor | | |
| 3–0 | Reserved, must be cleared. | | |

21.5 Functional Description

This section describes the operation of the FEC, beginning with the buffer descriptors, the hardware and software initialization sequence, then the software (Ethernet driver) interface for transmitting and receiving frames.

Following the software initialization and operation sections are sections providing a detailed description of the functions of the FEC.

21.5.1 Buffer Descriptors

This section provides a description of the operation of the driver/DMA via the buffer descriptors. It is followed by a detailed description of the receive and transmit descriptor fields.

21.5.1.1 Driver/DMA Operation with Buffer Descriptors

The data for the FEC frames resides in one or more memory buffers external to the FEC. Associated with each buffer is a buffer descriptor (BD), which contains a starting address (32-bit aligned pointer), data length, and status/control information (which contains the current state for the buffer). To permit maximum user flexibility, the BDs are also located in external memory and are read by the FEC DMA engine.

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Software produces buffers by allocating/initializing memory and initializing buffer descriptors. Setting the RxBD[E] or TxBD[R] bit produces the buffer. Software writing to TDAR or RDAR tells the FEC that a buffer is placed in external memory for the transmit or receive data traffic, respectively. The hardware reads the BDs and consumes the buffers after they have been produced. After the data DMA is complete and the DMA engine writes the buffer descriptor status bits, hardware clears RxBD[E] or TxBD[R] to signal the buffer has been consumed. Software may poll the BDs to detect when the buffers are consumed or may rely on the buffer/frame interrupts. The driver may process these buffers, and they can return to the free list.

The ECR[ETHER_EN] bit operates as a reset to the BD/DMA logic. When ECR[ETHER_EN] is cleared, the DMA engine BD pointers are reset to point to the starting transmit and receive BDs. The buffer descriptors are not initialized by hardware during reset. At least one transmit and receive buffer descriptor must be initialized by software before ECR[ETHER_EN] is set.

The buffer descriptors operate as two separate rings. ERDSR defines the starting address for receive BDs and ETDSR defines the starting address for transmit BDs. The wrap (W) bit defines the last buffer descriptor in each ring. When W is set, the next descriptor in the ring is at the location pointed to by ERDSR and ETDSR for the receive and transmit rings, respectively. Buffer descriptor rings must start on a 32-bit boundary; however, it is recommended they are made 128-bit aligned.

21.5.1.1.1 Driver/DMA Operation with Transmit BDs

Typically, a transmit frame is divided between multiple buffers. An example is to have an application payload in one buffer, TCP header in a second buffer, IP header in a third buffer, and Ethernet/IEEE 802.3 header in a fouth buffer. The Ethernet MAC does not prepend the Ethernet header (destination address, source address, length/type field(s)), so the driver must provide this in one of the transmit buffers. The Ethernet MAC can append the Ethernet CRC to the frame. TxBD[TC], which must be set by the driver, determines whether the MAC or driver appends the CRC.

The driver (TxBD software producer) should set up Tx BDs so a complete transmit frame is given to the hardware at once. If a transmit frame consists of three buffers, the BDs should be initialized with pointer, length, and control (W, L, TC, ABC) and then the TxBD[R] bit should be set in reverse order (third, second, then first BD) to ensure that the complete frame is ready in memory before the DMA begins. If the TxBDs are set up in order, the DMA controller could DMA the first BD before the second was made available, potentially causing a transmit FIFO underrun.

In the FEC, the driver notifies the DMA that new transmit frame(s) are available by writing to TDAR. When this register is written to (data value is not significant) the FEC, RISC tells the DMA to read the next transmit BD in the ring. After started, the RISC + DMA continues to read and interpret transmit BDs in order and DMA the associated buffers until a transmit BD is encountered with the R bit cleared. At this point, the FEC polls this BD one more time. If the R bit is cleared the second time, RISC stops the transmit descriptor read process until software sets up another transmit frame and writes to TDAR.

When the DMA of each transmit buffer is complete, the DMA writes back to the BD to clear the R bit, indicating that the hardware consumer is finished with the buffer.



21.5.1.1.2 Driver/DMA Operation with Receive BDs

Unlike transmit, the length of the receive frame is unknown by the driver ahead of time. Therefore, the driver must set a variable to define the length of all receive buffers. In the FEC, this variable is written to the EMRBR register.

The driver (RxBD software producer) should set up some number of empty buffers for the Ethernet by initializing the address field and the E and W bits of the associated receive BDs. The hardware (receive DMA) consumes these buffers by filling them with data as frames are received and clearing the E bit and writing to the L bit (1 indicates last buffer in frame), the frame status bits (if L is set), and the length field.

If a receive frame spans multiple receive buffers, the L bit is only set for the last buffer in the frame. For non-last buffers, the length field in the receive BD is written by the DMA (at the same time the E bit is cleared) with the default receive buffer length value. For end-of-frame buffers, the receive BD is written with L set and information written to the status bits (M, BC, MC, LG, NO, CR, OV, TR). Some of the status bits are error indicators which, if set, indicate the receive frame should be discarded and not given to higher layers. The frame status/length information is written into the receive FIFO following the end of the frame (as a single 32-bit word) by the receive logic. The length field for the end of frame buffer is written with the length of the entire frame, not only the length of the last buffer.

For simplicity, the driver may assign a large enough default receive buffer length to contain an entire frame, keeping in mind that a malfunction on the network or out-of-spec implementation could result in giant frames. Frames of 2K (2048) bytes or larger are truncated by the FEC at 2047 bytes so software never sees a receive frame larger than 2047 bytes.

Similar to transmit, the FEC polls the receive descriptor ring after the driver sets up receive BDs and writes to the RDAR register. As frames are received, the FEC fills receive buffers and updates the associated BDs, then reads the next BD in the receive descriptor ring. If the FEC reads a receive BD and finds the E bit cleared, it polls this BD once more. If RxBD[E] is clear a second time, FEC stops reading receive BDs until the driver writes to RDAR

21.5.1.2 Ethernet Receive Buffer Descriptor (RxBD)

In the RxBD, the user initializes the E and W bits in the first longword and the pointer in the second longword. When the buffer has been DMA'd, the Ethernet controller modifies the E, L, M, BC, MC, LG, NO, CR, OV, and TR bits and writes the length of the used portion of the buffer in the first longword. The M, BC, MC, LG, NO, CR, OV, and TR bits in the first longword of the buffer descriptor are only modified by the Ethernet controller when the L bit is set.

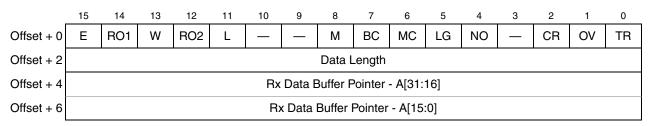


Figure 21-25. Receive Buffer Descriptor (RxBD)

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Table 21-29. Receive Buffer Descriptor Field Definitions

| Word | Field | Description |
|------------|------------------------|---|
| Offset + 0 | 15 E | Empty. Written by the FEC (=0) and user (=1). The data buffer associated with this BD is filled with received data, or data reception has aborted due to an error condition. The status and length fields have been updated as required. The data buffer associated with this BD is empty, or reception is currently in progress. |
| Offset + 0 | 14 RO1 | Receive software ownership. This field is reserved for use by software. This read/write bit is not modified by hardware, nor does its value affect hardware. |
| Offset + 0 | 13 W | Wrap. Written by user. O The next buffer descriptor is found in the consecutive location 1 The next buffer descriptor is found at the location defined in ERDSR. |
| Offset + 0 | 12 RO2 | Receive software ownership. This field is reserved for use by software. This read/write bit is not modified by hardware, nor does its value affect hardware. |
| Offset + 0 | 11 L | Last in frame. Written by the FEC. O The buffer is not the last in a frame. 1 The buffer is the last in a frame. |
| Offset + 0 | 10–9 | Reserved, must be cleared. |
| Offset + 0 | 8 M | Miss. Written by the FEC. This bit is set by the FEC for frames accepted in promiscuous mode, but flagged as a miss by the internal address recognition. Therefore, while in promiscuous mode, you can use the M-bit to quickly determine whether the frame was destined to this station. This bit is valid only if the L-bit is set and the PROM bit is set. O The frame was received because of an address recognition hit. The frame was received because of promiscuous mode. |
| Offset + 0 | 7 BC | Set if the DA is broadcast (FFFF_FFFF). |
| Offset + 0 | 6 MC | Set if the DA is multicast and not BC. |
| Offset + 0 | 5 LG | Rx frame length violation. Written by the FEC. A frame length greater than RCR[MAX_FL] was recognized. This bit is valid only if the L-bit is set. The receive data is not altered in any way unless the length exceeds 2047 bytes. |
| Offset + 0 | 4 NO | Receive non-octet aligned frame. Written by the FEC. A frame that contained a number of bits not divisible by 8 was received, and the CRC check that occurred at the preceding byte boundary generated an error. This bit is valid only if the L-bit is set. If this bit is set, the CR bit is not set. |
| Offset + 0 | 3 | Reserved, must be cleared. |
| Offset + 0 | 2 CR | Receive CRC error. Written by the FEC. This frame contains a CRC error and is an integral number of octets in length. This bit is valid only if the L-bit is set. |
| Offset + 0 | 1 OV | Overrun. Written by the FEC. A receive FIFO overrun occurred during frame reception. If this bit is set, the other status bits, M, LG, NO, CR, and CL lose their normal meaning and are zero. This bit is valid only if the L-bit is set. |
| Offset + 0 | 0 TR | Set if the receive frame is truncated (frame length > 2047 bytes). If the TR bit is set, the frame must be discarded and the other error bits must be ignored as they may be incorrect. |
| Offset + 2 | 15–0 Data Length | Data length. Written by the FEC. Data length is the number of octets written by the FEC into this BD's data buffer if L equals 0 (the value is equal to EMRBR), or the length of the frame including CRC if L is set. It is written by the FEC once as the BD is closed. |



Table 21-29. Receive Buffer Descriptor Field Definitions (continued)

| Word | Field | Description |
|------------|------------------|---|
| Offset + 4 | 15–0 A[31:16] | RX data buffer pointer, bits [31:16] ¹ |
| Offset + 6 | 15–0 A[15:0] | RX data buffer pointer, bits [15:0] |

The receive buffer pointer, containing the address of the associated data buffer, must always be evenly divisible by 16. The buffer must reside in memory external to the FEC. The Ethernet controller never modifies this value.

NOTE

When the software driver sets an E bit in one or more receive descriptors, the driver should follow with a write to RDAR.

21.5.1.3 Ethernet Transmit Buffer Descriptor (TxBD)

Data is presented to the FEC for transmission by arranging it in buffers referenced by the channel's TxBDs. The Ethernet controller confirms transmission by clearing the ready bit (TxBD[R]) when DMA of the buffer is complete. In the TxBD, the user initializes the R, W, L, and TC bits and the length (in bytes) in the first longword and the buffer pointer in the second longword.

The FEC clears the R bit when the buffer is transferred. Status bits for the buffer/frame are not included in the transmit buffer descriptors. Transmit frame status is indicated via individual interrupt bits (error conditions) and in statistic counters in the MIB block. See Section 21.4.1, "MIB Block Counters Memory Map," for more details.

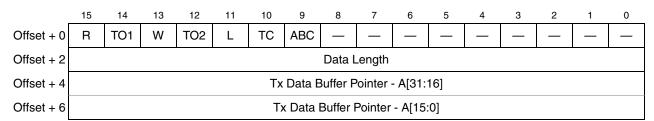


Figure 21-26. Transmit Buffer Descriptor (TxBD)

Table 21-30. Transmit Buffer Descriptor Field Definitions

| Word | Field | Description |
|------------|-----------|---|
| Offset + 0 | 15 R | Ready. Written by the FEC and you. The data buffer associated with this BD is not ready for transmission. You are free to manipulate this BD or its associated data buffer. The FEC clears this bit after the buffer has been transmitted or after an error condition is encountered. The data buffer, prepared for transmission by you, has not been transmitted or currently transmits. You may write no fields of this BD after this bit is set. |
| Offset + 0 | 14 TO1 | Transmit software ownership. This field is reserved for software use. This read/write bit is not modified by hardware nor does its value affect hardware. |

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| Word | Field | Description |
|------------|------------------------|--|
| Offset + 0 | 13 W | Wrap. Written by user. 0 The next buffer descriptor is found in the consecutive location 1 The next buffer descriptor is found at the location defined in ETDSR. |
| Offset + 0 | 12 TO2 | Transmit software ownership. This field is reserved for use by software. This read/write bit is not modified by hardware nor does its value affect hardware. |
| Offset + 0 | 11 L | Last in frame. Written by user. O The buffer is not the last in the transmit frame 1 The buffer is the last in the transmit frame |
| Offset + 0 | 10 TC | Transmit CRC. Written by user (only valid if L is set). 0 End transmission immediately after the last data byte 1 Transmit the CRC sequence after the last data byte |
| Offset + 0 | 9 ABC | Append bad CRC. Written by user (only valid if L is set). 0 No effect 1 Transmit the CRC sequence inverted after the last data byte (regardless of TC value) |
| Offset + 0 | 8–0 | Reserved, must be cleared. |
| Offset + 2 | 15–0 Data Length | Data length, written by user. Data length is the number of octets the FEC should transmit from this BD's data buffer. It is never modified by the FEC. |
| Offset + 4 | 15–0 A[31:16] | Tx data buffer pointer, bits [31:16] ¹ |
| Offset + 6 | 15–0 A[15:0] | Tx data buffer pointer, bits [15:0] |

¹ The transmit buffer pointer, containing the address of the associated data buffer, must always be evenly divisible by 4. The buffer must reside in memory external to the FEC. This value is never modified by the Ethernet controller.

NOTE

After the software driver has set up the buffers for a frame, it should set up the corresponding BDs. The last step in setting up the BDs for a transmit frame is setting the R bit in the first BD for the frame. The driver must follow that with a write to TDAR that triggers the FEC to poll the next BD in the ring.

21.5.2 Initialization Sequence

This section describes which registers are reset due to hardware reset, which are reset by the FEC RISC, and what locations you must initialize prior to enabling the FEC.

21.5.2.1 Hardware Controlled Initialization

In the FEC, hardware resets registers and control logic that generate interrupts. A hardware reset negates output signals and resets general configuration bits.



Other registers reset when the ECR[ETHER_EN] bit is cleared (which is accomplished by a hard reset or software to halt operation). By clearing ECR[ETHER_EN], configuration control registers such as the TCR and RCR are not reset, but the entire data path is reset.

Table 21-31. ECR[ETHER_EN] De-Assertion Effect on FEC

| Register/Machine | Reset Value |
|-----------------------------|--|
| XMIT block | Transmission is aborted (bad CRC appended) |
| RECV block | Receive activity is aborted |
| DMA block | All DMA activity is terminated |
| RDAR | Cleared |
| TDAR | Cleared |
| Descriptor Controller block | Halt operation |

21.5.3 User Initialization (Prior to Setting ECR[ETHER_EN])

You need to initialize portions the FEC prior to setting the ECR[ETHER_EN] bit. The exact values depend on the particular application. The sequence is not important.

Table 21-32 defines Ethernet MAC registers requiring initialization.

Table 21-32. User Initialization (Before ECR[ETHER_EN])

| Description |
|--|
| Initialize EIMR |
| Clear EIR (write 0xFFFF_FFFF) |
| TFWR (optional) |
| IALR / IAUR |
| GAUR / GALR |
| PALR / PAUR (only needed for full duplex flow control) |
| OPD (only needed for full duplex flow control) |
| RCR |
| TCR |
| MSCR (optional) |
| Clear MIB_RAM |

Table 21-33 defines FEC FIFO/DMA registers that require initialization.

Table 21-33. FEC User Initialization (Before ECR[ETHER_EN])

| Description |
|----------------------------|
| Initialize FRSR (optional) |
| Initialize EMRBR |
| Initialize ERDSR |
| Initialize ETDSR |

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Table 21-33. FEC User Initialization (Before ECR[ETHER_EN]) (continued)

| Description | |
|---|--|
| Initialize (Empty) Transmit Descriptor ring | |
| Initialize (Empty) Receive Descriptor ring | |

21.5.4 Microcontroller Initialization

In the FEC, the descriptor control RISC initializes some registers after ECR[ETHER_EN] is asserted. After the microcontroller initialization sequence is complete, hardware is ready for operation.

Table 21-34 shows microcontroller initialization operations.

Table 21-34. Microcontroller Initialization

| Description |
|---------------------------------------|
| Initialize BackOff Random Number Seed |
| Activate Receiver |
| Activate Transmitter |
| Clear Transmit FIFO |
| Clear Receive FIFO |
| Initialize Transmit Ring Pointer |
| Initialize Receive Ring Pointer |
| Initialize FIFO Count Registers |

21.5.5 User Initialization (After Setting ECR[ETHER_EN])

After setting ECR[ETHER_EN], you can set up the buffer/frame descriptors and write to TDAR and RDAR. Refer to Section 21.5.1, "Buffer Descriptors," for more details.

21.5.6 Network Interface Options

The FEC supports an MII interface for 10/100 Mbps Ethernet and a 7-wire serial interface for 10 Mbps Ethernet. The RCR[MII_MODE] bit select the interface mode. In MII mode (RCR[MII_MODE] set), there are 18 signals defined by the IEEE 802.3 standard and supported by the EMAC. Table 21-35 shows these signals.

Table 21-35. MII Mode

| Signal Description | EMAC pin |
|--------------------|--------------|
| Transmit Clock | FEC_TXCLK |
| Transmit Enable | FEC_TXEN |
| Transmit Data | FEC_TXD[3:0] |
| Transmit Error | FEC_TXER |

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Table 21-35. MII Mode (continued)

| Signal Description | EMAC pin |
|---------------------------------|--------------|
| Collision | FEC_COL |
| Carrier Sense | FEC_CRS |
| Receive Clock | FEC_RXCLK |
| Receive Data Valid | FEC_RXDV |
| Receive Data | FEC_RXD[3:0] |
| Receive Error | FEC_RXER |
| Management Data Clock | FEC_MDC |
| Management Data Input/Output | FEC_MDIO |

The 7-wire serial mode interface (RCR[MII_MODE] cleared) is generally referred to as AMD mode. Table 21-36 shows the 7-wire mode connections to the external transceiver.

Table 21-36. 7-Wire Mode Configuration

| Signal description | EMAC Pin |
|--------------------|------------|
| Transmit Clock | FEC_TXCLK |
| Transmit Enable | FEC_TXEN |
| Transmit Data | FEC_TXD[0] |
| Collision | FEC_COL |
| Receive Clock | FEC_RXCLK |
| Receive Data Valid | FEC_RXDV |
| Receive Data | FEC_RXD[0] |

21.5.7 FEC Frame Transmission

The Ethernet transmitter is designed to work with almost no intervention from software. After ECR[ETHER_EN] is set and data appears in the transmit FIFO, the Ethernet MAC can transmit onto the network. The Ethernet controller transmits bytes least significant bit (lsb) first.

When the transmit FIFO fills to the watermark (defined by TFWR), MAC transmit logic asserts FEC_TXEN and starts transmitting the preamble (PA) sequence, the start frame delimiter (SFD), and then the frame information from the FIFO. However, the controller defers the transmission if the network is busy (FEC_CRS is asserted). Before transmitting, the controller waits for carrier sense to become inactive, then determines if carrier sense stays inactive for 60 bit times. If so, transmission begins after waiting an additional 36 bit times (96 bit times after carrier sense originally became inactive). See Section 21.5.15.1, "Transmission Errors," for more details.



If a collision occurs during transmission of the frame (half duplex mode), the Ethernet controller follows the specified backoff procedures and attempts to retransmit the frame until the retry limit is reached. The transmit FIFO stores at least the first 64 bytes of the transmit frame, so they do not have to be retrieved from system memory in case of a collision. This improves bus utilization and latency in case immediate retransmission is necessary.

When all the frame data is transmitted, FCS (frame check sequence) or 32-bit cyclic redundancy check (CRC) bytes are appended if the TC bit is set in the transmit frame control word. If the ABC bit is set in the transmit frame control word, a bad CRC is appended to the frame data regardless of the TC bit value. Following the transmission of the CRC, the Ethernet controller writes the frame status information to the MIB block. Transmit logic automatically pads short frames (if the TC bit in the transmit buffer descriptor for the end of frame buffer is set).

Settings in the EIMR determine interrupts generated to the buffer (TXB) and frame (TFINT).

The transmit error interrupts are HBERR, BABT, LATE_COL, COL_RETRY_LIM, and XFIFO_UN. If the transmit frame length exceeds MAX_FL bytes, BABT interrupt is asserted. However, the entire frame is transmitted (no truncation).

To pause transmission, set TCR[GTS] (graceful transmit stop). The FEC transmitter stops immediately if transmission is not in progress; otherwise, it continues transmission until the current frame finishes or terminates with a collision. After the transmitter has stopped, the GRA (graceful stop complete) interrupt is asserted. If TCR[GTS] is cleared, the FEC resumes transmission with the next frame.

21.5.7.1 Duplicate Frame Transmission

The FEC fetches transmit buffer descriptors (TxBDs) and the corresponding transmit data continuously until the transmit FIFO is full. It does not determine whether the TxBD to be fetched is already being processed internally (as a result of a wrap). As the FEC nears the end of the transmission of one frame, it begins to DMA the data for the next frame. To remain one BD ahead of the DMA, it also fetches the TxBD for the next frame. It is possible that the FEC fetches from memory a BD that has already been processed but not yet written back (it is read a second time with the R bit remains set). In this case, the data is fetched and transmitted again.

Using at least three TxBDs fixes this problem for large frames, but not for small frames. To ensure correct operation for large or small frames, one of the following must be true:

- The FEC software driver ensures that there is always at least one TxBD with the ready bit cleared.
- Every frame uses more than one TxBD and every TxBD but the last is written back immediately after the data is fetched.
- The FEC software driver ensures a minimum frame size, n. The minimum number of TxBDs is then (Tx FIFO Size \div (n + 4)) rounded up to the nearest integer (though the result cannot be less than three). The default Tx FIFO size is 192 bytes; this size is programmable.



21.5.8 FEC Frame Reception

The FEC receiver works with almost no intervention from the host and can perform address recognition, CRC checking, short frame checking, and maximum frame length checking. The Ethernet controller receives serial data lsb first.

When the driver enables the FEC receiver by setting ECR[ETHER_EN], it immediately starts processing receive frames. When FEC_RXDV is asserted, the receiver first checks for a valid PA/SFD header. If the PA/SFD is valid, it is stripped and the receiver processes the frame. If a valid PA/SFD is not found, the frame is ignored.

In serial mode, the first 16 bit times of RX_D0 following assertion of FEC_RXDV are ignored. Following the first 16 bit times, the data sequence is checked for alternating 1/0s. If a 11 or 00 data sequence is detected during bit times 17 to 21, the remainder of the frame is ignored. After bit time 21, the data sequence is monitored for a valid SFD (11). If a 00 is detected, the frame is rejected. When a 11 is detected, the PA/SFD sequence is complete.

In MII mode, the receiver checks for at least one byte matching the SFD. Zero or more PA bytes may occur, but if a 00 bit sequence is detected prior to the SFD byte, the frame is ignored.

After the first 6 bytes of the frame are received, the FEC performs address recognition on the frame.

After a collision window (64 bytes) of data is received and if address recognition has not rejected the frame, the receive FIFO signals the frame is accepted and may be passed on to the DMA. If the frame is a runt (due to collision) or is rejected by address recognition, the receive FIFO is notified to reject the frame. Therefore, no collision fragments are presented to you except late collisions, which indicate serious LAN problems.

During reception, the Ethernet controller checks for various error conditions and after the entire frame is written into the FIFO, a 32-bit frame status word is written into the FIFO. This status word contains the M, BC, MC, LG, NO, CR, OV, and TR status bits, and the frame length. See Section 21.5.15.2, "Reception Errors," for more details.

Receive buffer (RXB) and frame interrupts (RFINT) may be generated if enabled by the EIMR register. A receive error interrupt is a babbling receiver error (BABR). Receive frames are not truncated if they exceed the max frame length (MAX_FL); however, the BABR interrupt occurs and the LG bit in the receive buffer descriptor (RxBD) is set. See Section 21.5.1.2, "Ethernet Receive Buffer Descriptor (RxBD)," for more details.

When the receive frame is complete, the FEC sets the L-bit in the RxBD, writes the other frame status bits into the RxBD, and clears the E-bit. The Ethernet controller next generates a maskable interrupt (RFINT bit in EIR, maskable by RFIEN bit in EIMR), indicating that a frame is received and is in memory. The Ethernet controller then waits for a new frame.

21.5.9 Ethernet Address Recognition

The FEC filters the received frames based on destination address (DA) type — individual (unicast), group (multicast), or broadcast (all-ones group address). The difference between an individual address and a



group address is determined by the I/G bit in the destination address field. A flowchart for address recognition on received frames appears in the figures below.

Address recognition is accomplished through the use of the receive block and microcode running on the microcontroller. The flowchart shown in Figure 21-27 illustrates the address recognition decisions made by the receive block, while Figure 21-28 illustrates the decisions made by the microcontroller.

If the DA is a broadcast address and broadcast reject (RCR[BC_REJ]) is cleared, then the frame is accepted unconditionally, as shown in Figure 21-27. Otherwise, if the DA is not a broadcast address, then the microcontroller runs the address recognition subroutine, as shown in Figure 21-28.

If the DA is a group (multicast) address and flow control is disabled, then the microcontroller performs a group hash table lookup using the 64-entry hash table programmed in GAUR and GALR. If a hash match occurs, the receiver accepts the frame.

If flow control is enabled, the microcontroller does an exact address match check between the DA and the designated PAUSE DA (01:80:C2:00:00:01). If the receive block determines the received frame is a valid PAUSE frame, the frame is rejected. The receiver detects a PAUSE frame with the DA field set to the designated PAUSE DA or the unicast physical address.

If the DA is the individual (unicast) address, the microcontroller performs an individual exact match comparison between the DA and 48-bit physical address that you program in the PALR and PAUR registers. If an exact match occurs, the frame is accepted; otherwise, the microcontroller does an individual hash table lookup using the 64-entry hash table programmed in registers, IAUR and IALR. In the case of an individual hash match, the frame is accepted. Again, the receiver accepts or rejects the frame based on PAUSE frame detection, shown in Figure 21-27.

If neither a hash match (group or individual) nor an exact match (group or individual) occur, and if promiscuous mode is enabled (RCR[PROM] set), the frame is accepted and the MISS bit in the receive buffer descriptor is set; otherwise, the frame is rejected.

Similarly, if the DA is a broadcast address, broadcast reject (RCR[BC_REJ]) is asserted, and promiscuous mode is enabled, the frame is accepted and the MISS bit in the receive buffer descriptor is set; otherwise, the frame is rejected.

In general, when a frame is rejected, it is flushed from the FIFO.



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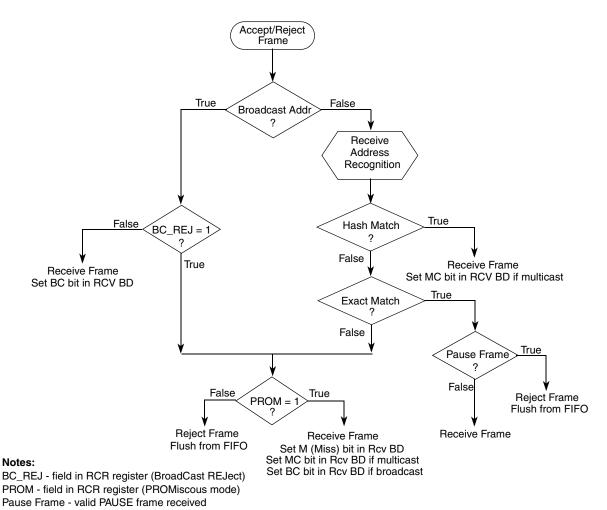
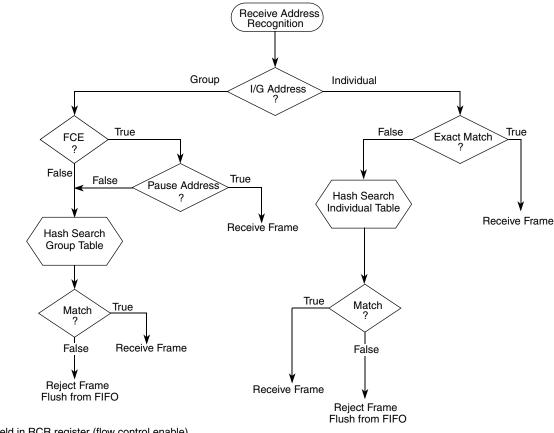


Figure 21-27. Ethernet Address Recognition—Receive Block Decisions





FCE - field in RCR register (flow control enable)

I/G - Individual/Group bit in destination address (Isb in first byte received in MAC frame)

Figure 21-28. Ethernet Address Recognition—Microcode Decisions

21.5.10 Hash Algorithm

Notes:

The hash table algorithm used in the group and individual hash filtering operates as follows. The 48-bit destination address is mapped into one of 64 bits, represented by 64 bits stored in GAUR, GALR (group address hash match), or IAUR, IALR (individual address hash match). This mapping is performed by passing the 48-bit address through the on-chip 32-bit CRC generator and selecting the six most significant bits of the CRC-encoded result to generate a number between 0 and 63. The msb of the CRC result selects GAUR (msb = 1) or GALR (msb = 0). The five least significant bits of the hash result select the bit within the selected register. If the CRC generator selects a bit set in the hash table, the frame is accepted; otherwise, it is rejected.

For example, if eight group addresses are stored in the hash table and random group addresses are received, the hash table prevents roughly 56/64 (87.5%) of the group address frames from reaching memory. Those that do reach memory must be further filtered by the processor to determine if they truly contain one of the eight desired addresses.

The effectiveness of the hash table declines as the number of addresses increases.

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The user must initialize the hash table registers. Use this CRC32 polynomial to compute the hash:

$$X^{32} + X^{26} + X^{23} + X^{22} + X^{16} + X^{12} + X^{11} + X^{10} + X^{8} + X^{7} + X^{5} + X^{4} + X^{2} + X + 1$$
 Eqn. 21-2

Table 21-37 contains example destination addresses and corresponding hash values.

Table 21-37. Destination Address to 6-Bit Hash

| 48-bit DA | 6-bit Hash (in hex) | Hash Decimal Value |
|----------------|------------------------|-----------------------|
| 65FF_FFFF_FFF | 0x0 | 0 |
| 55FF_FFFF_FFF | 0x1 | 1 |
| 15FF_FFFF_FFFF | 0x2 | 2 |
| 35FF_FFFF_FFFF | 0x3 | 3 |
| B5FF_FFFF_FFFF | 0x4 | 4 |
| 95FF_FFFF_FFFF | 0x5 | 5 |
| D5FF_FFFF_FFFF | 0x6 | 6 |
| F5FF_FFFF_FFFF | 0x7 | 7 |
| DBFF_FFFF_FFFF | 0x8 | 8 |
| FBFF_FFFF_FFFF | 0x9 | 9 |
| BBFF_FFFF_FFF | 0xA | 10 |
| 8BFF_FFFF_FFF | 0xB | 11 |
| 0BFF_FFFF_FFFF | 0xC | 12 |
| 3BFF_FFFF_FFF | 0xD | 13 |
| 7BFF_FFFF_FFF | 0xE | 14 |
| 5BFF_FFFF_FFF | 0xF | 15 |
| 27FF_FFFF_FFFF | 0x10 | 16 |
| 07FF_FFFF_FFFF | 0x11 | 17 |
| 57FF_FFFF_FFFF | 0x12 | 18 |
| 77FF_FFFF_FFFF | 0x13 | 19 |
| F7FF_FFFF_FFFF | 0x14 | 20 |
| C7FF_FFFF_FFFF | 0x15 | 21 |
| 97FF_FFFF_FFF | 0x16 | 22 |
| A7FF_FFFF_FFF | 0x17 | 23 |
| 99FF_FFFF_FFF | 0x18 | 24 |
| B9FF_FFFF_FFF | 0x19 | 25 |
| F9FF_FFFF_FFFF | 0x1A | 26 |
| C9FF_FFFF_FFFF | 0x1B | 27 |



Table 21-37. Destination Address to 6-Bit Hash (continued)

| 48-bit DA | 6-bit Hash (in hex) | Hash Decimal Value |
|----------------|------------------------|-----------------------|
| 59FF_FFFF_FFFF | 0x1C | 28 |
| 79FF_FFFF_FFFF | 0x1D | 29 |
| 29FF_FFFF_FFFF | 0x1E | 30 |
| 19FF_FFFF_FFFF | 0x1F | 31 |
| D1FF_FFFF_FFFF | 0x20 | 32 |
| F1FF_FFFF_FFFF | 0x21 | 33 |
| B1FF_FFFF_FFFF | 0x22 | 34 |
| 91FF_FFFF_FFFF | 0x23 | 35 |
| 11FF_FFFF_FFFF | 0x24 | 36 |
| 31FF_FFFF_FFFF | 0x25 | 37 |
| 71FF_FFFF_FFFF | 0x26 | 38 |
| 51FF_FFFF_FFFF | 0x27 | 39 |
| 7FFF_FFFF_FFFF | 0x28 | 40 |
| 4FFF_FFFF_FFFF | 0x29 | 41 |
| 1FFF_FFFF_FFFF | 0x2A | 42 |
| 3FFF_FFFF_FFFF | 0x2B | 43 |
| BFFF_FFFF_FFFF | 0x2C | 44 |
| 9FFF_FFFF_FFFF | 0x2D | 45 |
| DFFF_FFFF_FFFF | 0x2E | 46 |
| EFFF_FFFF_FFFF | 0x2F | 47 |
| 93FF_FFFF_FFFF | 0x30 | 48 |
| B3FF_FFFF_FFFF | 0x31 | 49 |
| F3FF_FFFF_FFFF | 0x32 | 50 |
| D3FF_FFFF_FFFF | 0x33 | 51 |
| 53FF_FFFF_FFFF | 0x34 | 52 |
| 73FF_FFFF_FFFF | 0x35 | 53 |
| 23FF_FFFF_FFFF | 0x36 | 54 |
| 13FF_FFFF_FFFF | 0x37 | 55 |
| 3DFF_FFFF_FFFF | 0x38 | 56 |
| 0DFF_FFFF_FFFF | 0x39 | 57 |
| 5DFF_FFFF_FFFF | 0x3A | 58 |
| 7DFF_FFFF_FFFF | 0x3B | 59 |

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Table 21-37. Destination Address to 6-Bit Hash (continued)

| 48-bit DA | 6-bit Hash (in hex) | Hash Decimal Value |
|----------------|------------------------|-----------------------|
| FDFF_FFFF_FFFF | 0x3C | 60 |
| DDFF_FFFF_FFF | 0x3D | 61 |
| 9DFF_FFFF_FFF | 0x3E | 62 |
| BDFF_FFFF_FFF | 0x3F | 63 |

21.5.11 Full Duplex Flow Control

Full-duplex flow control allows you to transmit pause frames and to detect received pause frames. Upon detection of a pause frame, MAC data frame transmission stops for a given pause duration.

To enable PAUSE frame detection, the FEC must operate in full-duplex mode (TCR[FDEN] set) with flow control (RCR[FCE] set). The FEC detects a pause frame when the fields of the incoming frame match the pause frame specifications, as shown in Table 21-38. In addition, the receive status associated with the frame should indicate that the frame is valid.

Table 21-38. PAUSE Frame Field Specification

| 48-bit Destination Address | 0x0180_C200_0001 or Physical Address |
|----------------------------|--------------------------------------|
| 48-bit Source Address | Any |
| 16-bit Type | 0x8808 |
| 16-bit Opcode | 0x0001 |
| 16-bit PAUSE Duration | 0x0000 – 0xFFFF |

The receiver and microcontroller modules perform PAUSE frame detection. The microcontroller runs an address recognition subroutine to detect the specified pause frame destination address, while the receiver detects the type and opcode pause frame fields. On detection of a pause frame, TCR[GTS] is set by the FEC internally. When transmission has paused, the EIR[GRA] interrupt is asserted and the pause timer begins to increment. The pause timer uses the transmit backoff timer hardware for tracking the appropriate collision backoff time in half-duplex mode. The pause timer increments once every slot time, until OPD[PAUSE_DUR] slot times have expired. On OPD[PAUSE_DUR] expiration, TCR[GTS] is cleared allowing MAC data frame transmission to resume. The receive flow control pause status bit (TCR[RFC_PAUSE]) is set while the transmitter pauses due to reception of a pause frame.

To transmit a pause frame, the FEC must operate in full-duplex mode and you must set flow control pause (TCR[TFC_PAUSE]). After TCR[TFC_PAUSE] is set, the transmitter sets TCR[GTS] internally. When the transmission of data frames stops, the EIR[GRA] (graceful stop complete) interrupt asserts and the pause frame is transmitted. TCR[TFC_PAUSE,GTS] are then cleared internally.

You must specify the desired pause duration in the OPD register.

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When the transmitter pauses due to receiver/microcontroller pause frame detection, TCR[TFC_PAUSE] may remain set and cause the transmission of a single pause frame. In this case, the EIR[GRA] interrupt is not asserted.

21.5.12 Inter-Packet Gap (IPG) Time

The minimum inter-packet gap time for back-to-back transmission is 96 bit times. After completing a transmission or after the backoff algorithm completes, the transmitter waits for carrier sense to be negated before starting its 96 bit time IPG counter. Frame transmission may begin 96 bit times after carrier sense is negated if it stays negated for at least 60 bit times. If carrier sense asserts during the last 36 bit times, it is ignored and a collision occurs.

The receiver accepts back-to-back frames with a minimum spacing of at least 28 bit times. If an inter-packet gap between receive frames is less than 28 bit times, the receiver may discard the following frame.

21.5.13 Collision Managing

If a collision occurs during frame transmission, the Ethernet controller continues the transmission for at least 32 bit times, transmitting a JAM pattern consisting of 32 ones. If the collision occurs during the preamble sequence, a JAM pattern is sent after the end of the preamble sequence.

If a collision occurs within 512 bit times (one slot time), the retry process is initiated. The transmitter waits a random number of slot times. If a collision occurs after 512 bit times, then no retransmission is performed and the end of frame buffer is closed with a Late Collision (LC) error indication.

21.5.14 MII Internal and External Loopback

Internal and external loopback are supported by the Ethernet controller. In loopback mode, both of the FIFOs are used and the FEC actually operates in a full-duplex fashion. Internal and external loopback are configured using combinations of the RCR[LOOP, DRT] and TCR[FDEN] bits.

Set FDEN for internal and external loopback.

For internal loopback, set RCR[LOOP] and clear RCR[DRT]. FEC_TXEN and FEC_TXER do not assert during internal loopback. During internal loopback, the transmit/receive data rate is higher than in normal operation because the transmit and receive blocks use the internal bus clock instead of the clocks from the external transceiver. This causes an increase in the required system bus bandwidth for transmit and receive data being DMA'd to/from external memory. It may be necessary to pace the frames on the transmit side and/or limit the size of the frames to prevent transmit FIFO underruns and receive FIFO overflows.

For external loopback, clear RCR[LOOP] and RCR[DRT], and configure the external transceiver for loopback.

21.5.15 Ethernet Error-Managing Procedure

The Ethernet controller reports frame reception and transmission error conditions using the MIB block counters, the FEC RxBDs, and the EIR register.

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Fast Ethernet Controller (FEC)

21.5.15.1 Transmission Errors

21.5.15.1.1 Transmitter Underrun

If this error occurs, the FEC sends 32 bits that ensure a CRC error and stops transmitting. All remaining buffers for that frame are then flushed and closed, and EIR[UN] is set. The FEC then continues to the next transmit buffer descriptor and begin transmitting the next frame. The UN interrupt is asserted if enabled in the EIMR register.

21.5.15.1.2 Retransmission Attempts Limit Expired

When this error occurs, the FEC terminates transmission. All remaining buffers for that frame are flushed and closed, and EIR[RL] is set. The FEC then continues to the next transmit buffer descriptor and begins transmitting the next frame. The RL interrupt is asserted if enabled in the EIMR register.

21.5.15.1.3 Late Collision

When a collision occurs after the slot time (512 bits starting at the Preamble), the FEC terminates transmission. All remaining buffers for that frame are flushed and closed, and EIR[LC] is set. The FEC then continues to the next transmit buffer descriptor and begin transmitting the next frame. The LC interrupt is asserted if enabled in the EIMR register.

21.5.15.1.4 Heartbeat

Some transceivers have a self-test called heartbeat or signal quality error. To signify a good self-test, the transceiver indicates a collision to the FEC within four microseconds after completion of a frame transmitted by the Ethernet controller. This indication of a collision does not imply a real collision error on the network, but is rather an indication that the transceiver continues to function properly. This is the heartbeat condition.

If TCR[HBC] is set and the heartbeat condition is not detected by the FEC after a frame transmission, a heartbeat error occurs. When this error occurs, the FEC closes the buffer, sets EIR[HB], and generates the HBERR interrupt if it is enabled.

21.5.15.2 Reception Errors

21.5.15.2.1 Overrun Error

If the receive block has data to put into the receive FIFO and the receive FIFO is full, FEC sets RxBD[OV]. All subsequent data in the frame is discarded and subsequent frames may also be discarded until the receive FIFO is serviced by the DMA and space is made available. At this point the receive frame/status word is written into the FIFO with the OV bit set. The driver must discard this frame.

21.5.15.2.2 Non-Octet Error (Dribbling Bits)

The Ethernet controller manages up to seven dribbling bits when the receive frame terminates past an non-octet aligned boundary. Dribbling bits are not used in the CRC calculation. If there is a CRC error, the frame non-octet aligned (NO) error is reported in the RxBD. If there is no CRC error, no error is reported.

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21.5.15.2.3 CRC Error

When a CRC error occurs with no dribble bits, FEC closes the buffer and sets RxBD[CR]. CRC checking cannot be disabled, but the CRC error can be ignored if checking is not required.

21.5.15.2.4 Frame Length Violation

When the receive frame length exceeds MAX_FL bytes the BABR interrupt is generated, and RxBD[LG] is set. The frame is not truncated unless the frame length exceeds 2047 bytes.

21.5.15.2.5 Truncation

When the receive frame length exceeds 2047 bytes, frame is truncated and RxBD[TR] is set.

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Chapter 22 DMA Controller Module

22.1 Introduction

This chapter describes the direct memory access (DMA) controller module. It provides an overview of the module and describes in detail its signals and registers. The latter sections of this chapter describe operations, features, and supported data transfer modes in detail.

NOTE

The designation *n* is used throughout this section to refer to registers or signals associated with one of the four identical DMA channels: DMA0, DMA1, DMA2, or DMA3.

22.1.1 Overview

The DMA controller module enables fast transfers of data, providing an efficient way to move blocks of data with minimal processor interaction. The DMA module, shown in Figure 22-1, has four channels that allow byte, word, longword, or 16-byte burst data transfers. Each channel has a dedicated source address register (SAR*n*), destination address register (DAR*n*), byte count register (BCR*n*), control register (DCR*n*), and status register (DSR*n*). Transfers are dual address to on-chip devices, such as UART and GPIOs.

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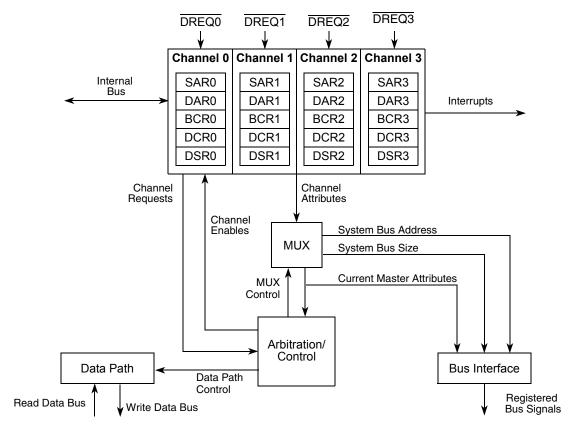


Figure 22-1. DMA Signal Diagram

NOTE

Throughout this chapter, the terms external request and DREQ are used to refer to a DMA request from one of the on-chip UARTS, DMA timers or DREQ signals. For details on the connections associated with DMA request inputs, see Section 22.3.1, "DMA Request Control (DMAREQC)."

22.1.2 Features

The DMA controller module features:

- Four independently programmable DMA controller channels
- Auto-alignment for source or destination accesses
- Dual-address transfers
- Channel arbitration on transfer boundaries
- Data transfers in 8-, 16-, 32-, or 128-bit blocks using a 16-byte buffer
- Continuous-mode or cycle-steal transfers
- Independent transfer widths for source and destination
- Independent source and destination address registers
- Modulo addressing on source and destination addresses
- Automatic channel linking

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DMA Controller Module

22.2 DMA Transfer Overview

The DMA module can move data within system memory (including memory and peripheral devices) with minimal processor intervention, greatly improving overall system performance. The DMA module consists of four independent, functionally equivalent channels, so references to DMA in this chapter apply to any of the channels. It is not possible to implicitly address all four channels at once.

The processor generates DMA requests internally by setting DCR[START]; the UART modules and DMA timers can generate a DMA request by asserting internal DREQ signals. The processor can program bus bandwidth for each channel. The channels support cycle-steal and continuous transfer modes; see Section 22.4.1, "Transfer Requests (Cycle-Steal and Continuous Modes)."

The DMA controller supports dual-address transfers. The DMA channels support up to 32 data bits.

• Dual-address transfers—A dual-address transfer consists of a read followed by a write and is initiated by an internal request using the START bit or by a peripheral DMA request. Two types of transfer can occur: a read from a source device or a write to a destination device. See Figure 22-2 for more information.

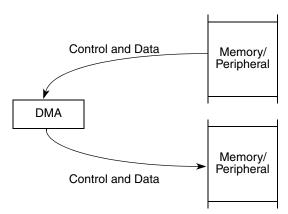


Figure 22-2. Dual-Address Transfer

Any operation involving the DMA module follows the same three steps:

- 1. Channel initialization—Channel registers are loaded with control information, address pointers, and a byte-transfer count.
- 2. Data transfer—The DMA accepts requests for operand transfers and provides addressing and bus control for the transfers.
- 3. Channel termination—Occurs after the operation is finished, successfully or due to an error. The channel indicates the operation status in the channel's DSR, described in Section 22.3.4, "Byte Count Registers (BCRn) and DMA Status Registers (DSRn)."

22.3 Memory Map/Register Definition

This section describes each internal register and its bit assignment. Modifying DMA control registers during a DMA transfer can result in undefined operation. Table 22-1 shows the mapping of DMA controller registers.

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| | | • | • | | |
|-------------------------|--|-------|--------|-------------|--------------|
| IPSBAR Offset | Register | Width | Access | Reset Value | Section/Page |
| 0x00_0014 | DMA request control register (DMAREQC) ¹ | 32 | R/W | 0x0000_0000 | 22.3.1/22-4 |
| 0x00_0100 + n * 0x10 | Source address register n (SAR n) where $n = 0-3$ | 32 | R/W | 0x0000_0000 | 22.3.2/22-5 |
| 0x00_0104 + n * 0x10 | Destination address register n (DAR n) where $n = 0-3$ | 32 | R/W | 0x0000_0000 | 22.3.3/22-6 |
| 0x00_0108 + n * 0x10 | DMA status (DSR n) and byte count register n (BCR n) where $n = 0-3$ | 32 | R/W | 0x0000_0000 | 22.3.4/22-6 |
| 0x00_010C + n * 0x10 | DMA control register n (DCR n) where $n = 0-3$ | 32 | R/W | 0x0000_0000 | 22.3.5/22-8 |

Table 22-1. DMA Controller Memory Map

DMA Request Control (DMAREQC) 22.3.1

The DMAREQC register provides a software-controlled connection matrix for DMA requests. It logically routes DMA requests from the DMA timers and UARTs to the four channels of the DMA controller. Writing to this register determines the exact routing of the DMA request to the four channels of the DMA modules.

If DCRn[EEXT] is set and the channel is idle, the assertion of the appropriate external $\overline{\text{DREQ}n}$ signal activates channel n.

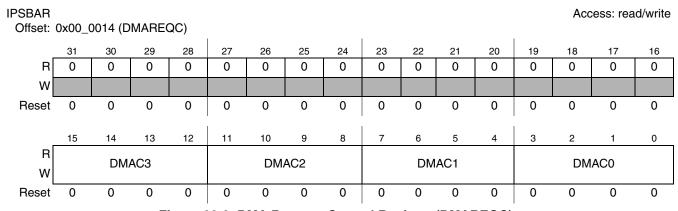


Figure 22-3. DMA Request Control Register (DMAREQC)

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Located within the SCM, but listed here for clarity.



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Table 22-2. DMAREQC Field Description

| Field | Description |
|-----------------------|---|
| 15–0 DMAC <i>n</i> | DMA channel <i>n</i> . Each four bit field defines the logical connection between the DMA requesters and that DMA channel. There are ten possible requesters (4 DMA Timers and 6 UARTs). Any request can be routed to any of the DMA channels. Effectively, the DMAREQC provides a software-controlled routing matrix of the 10 DMA request signals to the 4 channels of the DMA module. DMAC3 controls DMA channel 3, DMAC2 controls DMA channel 2, etc. 0100 DMA Timer 0 0101 DMA Timer 1 0110 DMA Timer 2 0111 DMA Timer 3 1000 UART0 Receive 1001 UART1 Receive 1100 UART2 Receive 1100 UART0 Transmit 1101 UART1 Transmit 1110 UART2 Transmit All other values are reserved and do not generate a DMA request. |

22.3.2 Source Address Registers (SAR*n*)

SARn, shown in Figure 22-4, contains the address from which the DMA controller requests data.

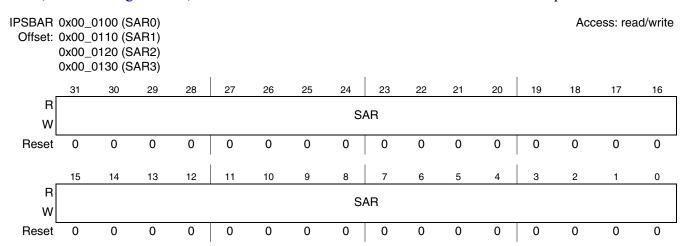


Figure 22-4. Source Address Registers (SARn)

NOTE

The backdoor enable bit must be set in the SCM RAMBAR, as well as the secondary port valid bit in the core RAMBAR to enable backdoor accesses from the DMA to SRAM. See Section 14.5.2, "Memory Base Address Register (RAMBAR) and Section 12.2.1, "SRAM Base Address Register (RAMBAR)," for more details.

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22.3.3 Destination Address Registers (DARn)

DAR*n* holds the address to which the DMA controller sends data.

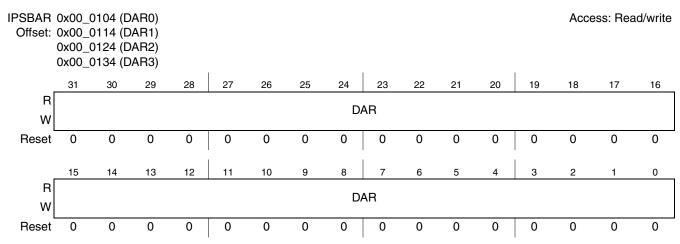


Figure 22-5. Destination Address Registers (DARn)

22.3.4 Byte Count Registers (BCRn) and DMA Status Registers (DSRn)

The BCR*n* and DSR*n* registers are two logical registers that occupy one 32-bit register, as shown in Figure 22-6. The address used to access both registers is the same; DSR*n* occupies bits 31–24, and BCR*n* occupies bits 23–0. BCR*n* contains the number of bytes yet to be transferred for a given block. BCR*n* decrements on the successful completion of the address transfer of a write transfer. BCR*n* decrements by 1, 2, 4, or 16 for byte, word, longword, or line accesses, respectively.

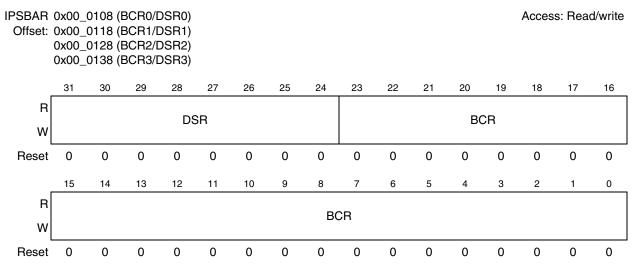


Figure 22-6. Byte Count Registers (BCRn) and DMA Status Registers (DSRn)

The fields of the DSRn register (bits 31–24 in Figure 22-6) are shown in Figure 22-7. In response to an event, the DMA controller writes to the appropriate DSRn bit. Only a write to DSRn[DONE] results in action. DSRn[DONE] is set when the block transfer is complete.

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When a transfer sequence is initiated and BCRn[BCR] is not a multiple of 16, 4, or 2 when the DMA is configured for line, longword, or word transfers, respectively, DSRn[CE] is set and no transfer occurs.

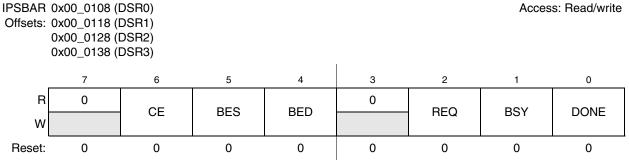


Figure 22-7. DMA Status Registers (DSRn)

Table 22-3. DSRn Field Descriptions

| Field | Description |
|-----------|---|
| 7 | Reserved, should be cleared. |
| 6 CE | Configuration error. Occurs when BCR, SAR, or DAR does not match the requested transfer size, or if BCR equals 0 when the DMA receives a start condition. CE is cleared at hardware reset or by writing a 1 to DSR[DONE]. 0 No configuration error exists. 1 A configuration error has occurred. |
| 5 BES | Bus error on source 0 No bus error occurred. 1 The DMA channel terminated with a bus error during the read portion of a transfer. |
| 4 BED | Bus error on destination 0 No bus error occurred. 1 The DMA channel terminated with a bus error during the write portion of a transfer. |
| 3 | Reserved, should be cleared. |
| 2 REQ | Request 0 No request is pending or the channel is currently active. Cleared when the channel is selected. 1 The DMA channel has a transfer remaining and the channel is not selected. |
| 1 BSY | Busy 0 DMA channel is inactive. Cleared when the DMA has finished the last transaction. 1 BSY is set the first time the channel is enabled after a transfer is initiated. |
| 0 DONE | Transactions done. Set when all DMA controller transactions complete, as determined by transfer count or error conditions. When BCR reaches zero, DONE is set when the final transfer completes successfully. DONE can also be used to abort a transfer by resetting the status bits. When a transfer completes, software must clear DONE before reprogramming the DMA. 0 Writing or reading a 0 has no effect. 1 DMA transfer completed. Writing a 1 to this bit clears all DMA status bits and can be used in an interrupt handler to clear the DMA interrupt and error bits. |

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Reset

22.3.5 DMA Control Registers (DCRn)

The DMA control registers (DCRn) are described in Figure 22-8 and Table 22-4.

IPSBAR 0x00_010C (DCR0) Access: Read/write Offsets: 0x00_011C (DCR1) 0x00_012C (DCR2) 0x00_013C (DCR3) R INT **EEXT** CS AΑ **BWC** SINC SSIZE DINC **DSIZE** START Reset R SMOD DMOD D_REQ LINKCC LCH2 LCH1

Figure 22-8. DMA Control Registers (DCRn)

Table 22-4. DCRn Field Descriptions

| Field | Description |
|------------|--|
| 31 INT | Interrupt on completion of transfer. Determines whether an interrupt is generated by completing a transfer or by the occurrence of an error condition. O No interrupt is generated. Internal interrupt signal is enabled. |
| 30 EEXT | Enable external request. Care should be taken because a collision can occur between the START bit and DREQn when EEXT equals 1. 0 External request is ignored. 1 Enables external request to initiate transfer. The internal request (initiated by setting the START bit) is always enabled. |
| 29 CS | Cycle steal. 0 DMA continuously makes read/write transfers until the BCR decrements to 0. 1 Forces a single read/write transfer per request. |
| 28 AA | Auto-align. AA and SIZE determine whether the source or destination is auto-aligned, that is, transfers are optimized based on the address and size. See Section 22.4.4.1, "Auto-Alignment." O Auto-align disabled If SSIZE indicates a transfer no smaller than DSIZE, source accesses are auto-aligned; otherwise, destination accesses are auto-aligned. Source alignment takes precedence over destination alignment. If auto-alignment is enabled, the appropriate address register increments, regardless of DINC or SINC. |

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Table 22-4. DCRn Field Descriptions (continued)

| Field | | | Description | | | | |
|----------------|---|--------------------------|---|---------|--|--|--|
| 27–25 BWC | Bandwidth control. Indicates the number of bytes in a block transfer. When the byte count reaches a multi the BWC value, the DMA releases the bus. | | | | | | |
| | BWC Number of kilobytes per block | | | | | | |
| | | 000 | DMA has priority and does not negate its request until transfer completes. | | | | |
| | | 001 | 16 Kbytes | | | | |
| | | 010 | 32 Kbytes | | | | |
| | | 011 | 64 Kbytes | | | | |
| | | 100 | 128 Kbytes | | | | |
| | | 101 | 256 Kbytes | | | | |
| | | 110 | 512 Kbytes | | | | |
| | | 111 | 1024 Kbytes | | | | |
| 24–23 | Reserved, should be cle | ared. | | | | | |
| 22 SINC | 0 No change to SAR af | ter a successful transf | address increments after each successful tracers. etermined by the transfer size. | ansfer. | | | |
| 21–20 SSIZE | Source size. Determines 00 Longword 01 Byte 10 Word 11 Line (16-byte burst) | s the data size of the s | source bus cycle for the DMA control module | | | | |
| 19 DINC | Destination increment. Controls whether a destination address increments after each successful transfer. 0 No change to the DAR after a successful transfer. 1 The DAR increments by 1, 2, 4, or 16, depending upon the size of the transfer. | | | | | | |
| 18–17 DSIZE | Destination size. Determ 00 Longword 01 Byte 10 Word 11 Line (16-byte burst) | nines the data size of t | the destination bus cycle for the DMA contro | ller. | | | |
| 16 START | Start transfer. 0 DMA inactive 1 The DMA begins the transfer in accordance to the values in the control registers. START is cleared automatically after one system clock and is always read as logic 0. | | | | | | |

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Table 22-4. DCRn Field Descriptions (continued)

| Field | Description | | | | | |
|---------------|--|---|---|--|--|--|
| 15–12 SMOD | Source address modulo. Defines the size of the source data circular buffer used by the DMA Controller. If enabled SMOD is non-zero), the buffer base address is located on a boundary of the buffer size. The value of this boundary is based upon the initial source address (SAR). The base address should be aligned to a 0-modulo-circular buffer size boundary. Misaligned buffers are not possible. The boundary is forced to the value determined by the upper address bits in the field selection. | | | | | |
| | | SMOD | Circular Buffer Size | | | |
| | | 0000 | Buffer Disabled | | | |
| | | 0001 | 16 Bytes | | | |
| | | 0010 | 32 Bytes | | | |
| | | | | | | |
| | | 1111 | 256 Kbytes | | | |
| 11–8 DMOD | Destination address modulo. Defines If enabled (DMOD value is non-zero) value of this boundary depends on the | , the buffer bas e initial destina | e address is located on a tion address (DAR). The | boundary of the buffer size. The base address should be aligned to | | |
| | If enabled (DMOD value is non-zero) | , the buffer bas se initial destina lary. Misaligned s in the field sel | e address is located on a tion address (DAR). The buffers are not possible. ection. | boundary of the buffer size. The base address should be aligned to | | |
| | If enabled (DMOD value is non-zero) value of this boundary depends on the a 0-modulo-circular buffer size bound | , the buffer bas e initial destina dary. Misaligned s in the field sel | e address is located on a tion address (DAR). The buffers are not possible. ection. Circular Buffer Size | boundary of the buffer size. The base address should be aligned to | | |
| | If enabled (DMOD value is non-zero) value of this boundary depends on the a 0-modulo-circular buffer size bound | , the buffer bas e initial destina dary. Misaligned s in the field sel | e address is located on a tion address (DAR). The buffers are not possible ection. Circular Buffer Size Buffer Disabled | boundary of the buffer size. The base address should be aligned to | | |
| | If enabled (DMOD value is non-zero) value of this boundary depends on the a 0-modulo-circular buffer size bound | , the buffer bas e initial destina dary. Misaligned s in the field sel DMOD 0000 0001 | e address is located on a tion address (DAR). The buffers are not possible. ection. Circular Buffer Size Buffer Disabled 16 Bytes | boundary of the buffer size. The base address should be aligned to | | |
| | If enabled (DMOD value is non-zero) value of this boundary depends on the a 0-modulo-circular buffer size bound | , the buffer bas e initial destina dary. Misaligned s in the field sel | e address is located on a tion address (DAR). The buffers are not possible ection. Circular Buffer Size Buffer Disabled | boundary of the buffer size. The base address should be aligned to | | |
| | If enabled (DMOD value is non-zero) value of this boundary depends on the a 0-modulo-circular buffer size bound | , the buffer bas le initial destina lary. Misaligned is in the field sel DMOD 0000 0001 0010 | e address is located on a tion address (DAR). The buffers are not possible, ection. Circular Buffer Size Buffer Disabled 16 Bytes 32 Bytes | boundary of the buffer size. The base address should be aligned to | | |
| | If enabled (DMOD value is non-zero) value of this boundary depends on the a 0-modulo-circular buffer size bound | , the buffer bas le initial destinal lary. Misaligned s in the field sel DMOD 0000 0001 0010 1111 comatically clears | e address is located on a tion address (DAR). The buffers are not possible, ection. Circular Buffer Size Buffer Disabled 16 Bytes 32 Bytes 256 Kbytes | a boundary of the buffer size. The base address should be aligned to The boundary is forced to the value | | |

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Table 22-4. DCRn Field Descriptions (continued)

| Field | Description |
|---------------|--|
| 5–4 LINKCC | Link channel control. Allows DMA channels to have their transfers linked. The current DMA channel triggers a DMA request to the linked channels (LCH1 or LCH2) depending on the condition described by the LINKCC bits. 00 No channel-to-channel linking 01 Perform a link to channel LCH1 after each cycle-steal transfer followed by a link to LCH2 after the BCR decrements to zero. 10 Perform a link to channel LCH1 after each cycle-steal transfer 11 Perform a link to channel LCH1 after the BCR decrements to zero 11 Perform a link to channel LCH1 after the BCR decrements to zero 12 If not in cycle steal mode (DCRn[CS]=0) and LINKCC equals 01 or 10, no link to LCH1 occurs. 13 If LINKCC equals 01, a link to LCH1 is created after each cycle-steal transfer performed by the current DMA channel is completed. As the last cycle-steal is performed and the BCR reaches zero, then the link to LCH1 is closed and a link to LCH2 is created. 14 If the LINKCC field is non-zero, the contents of the bandwidth control field (DCRn[BWC]) are ignored and effectively forced to zero by the DMA hardware. This is done to prevent any non-zero bandwidth control settings from allowing channel arbitration while any type of link is to be performed. |
| 3-2 LCH1 | Link channel 1. Indicates the DMA channel assigned as link channel 1. The link channel number cannot be the same as the currently executing channel, and generates a configuration error if this is attempted (DSRn[CE] is set). 00 DMA Channel 0 01 DMA Channel 1 10 DMA Channel 2 11 DMA Channel 3 |
| 1-0 LCH2 | Link channel 2. Indicates the DMA channel assigned as link channel 2. The link channel number cannot be the same as the currently executing channel, and generates a configuration error if this is attempted (DSRn[CE] is set). 00 DMA Channel 0 01 DMA Channel 1 10 DMA Channel 2 11 DMA Channel 3 |

22.4 Functional Description

In the following discussion, the term DMA request implies that DCR*n*[START or EEXT] is set, followed by assertion of an internal or external DMA request. The START bit is cleared when the channel begins an internal access.

Before initiating a dual-address access, the DMA module verifies that DCRn[SSIZE,DSIZE] are consistent with the source and destination addresses. If they are not consistent, the configuration error bit, DSRn[CE], is set. If misalignment is detected, no transfer occurs, DSRn[CE] is set, and, depending on the DCR configuration, an interrupt event is issued. If the auto-align bit, DCRn[AA], is set, error checking is performed on the appropriate registers.

A read/write transfer reads bytes from the source address and writes them to the destination address. The number of bytes is the larger of the sizes specified by DCRn[SSIZE] and DCRn[DSIZE]. See 22.3.5, "DMA Control Registers (DCRn)."

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Source and destination address registers (SARn and DARn) can be programmed in the DCRn to increment at the completion of a successful transfer.

22.4.1 Transfer Requests (Cycle-Steal and Continuous Modes)

The DMA channel supports internal and external requests. A request is issued by setting DCRn[START] or when a UART or DMA timer asserts a DMA request. Setting DCRn[EEXT] enables recognition of external DMA requests. Selecting between cycle-steal and continuous modes minimizes bus usage for internal or external requests.

- Cycle-steal mode (DCRn[CS] = 1)—Only one complete transfer from source to destination occurs for each request. If DCRn[EEXT] is set, a request can be internal or external. An internal request is selected by setting DCRn[START]. An external request is initiated by an on-chip peripheral while DCRn[EEXT] is set.
- Continuous mode (DCRn[CS] = 0)—After an internal or external request, the DMA continuously transfers data until BCRn reaches zero or a multiple of DCRn[BWC] or until DSRn[DONE] is set. If BCRn is a multiple of BWC, the DMA request signal is negated until the bus cycle terminates to allow the internal arbiter to switch masters. DCRn[BWC] equaling 000 specifies the maximum transfer rate; other values specify a transfer rate limit.
 - The DMA performs the specified number of transfers, then relinquishes bus control. The DMA negates its internal bus request on the last transfer before BCRn reaches a multiple of the boundary specified in BWC. Upon completion, the DMA reasserts its bus request to regain mastership at the earliest opportunity. The DMA loses bus control for a minimum of one bus cycle.

22.4.2 **Dual-Address Data Transfer Mode**

Each channel supports dual-address transfers. Dual-address transfers consist of a source data read and a destination data write. The DMA controller module begins a dual-address transfer sequence during a DMA request. If no error condition exists, DSRn[REQ] is set.

- Dual-address read—The DMA controller drives the SARn value onto the internal address bus. If DCRn[SINC] is set, the SARn increments by the appropriate number of bytes upon a successful read cycle. When the appropriate number of read cycles complete (multiple reads if the destination size is larger than the source), the DMA initiates the write portion of the transfer.
 - If a termination error occurs, DSRn[BES, DONE] are set and DMA transactions stop.
- Dual-address write—The DMA controller drives the DARn value onto the address bus. If DCRn[DINC] is set, DARn increments by the appropriate number of bytes at the completion of a successful write cycle. BCRn decrements by the appropriate number of bytes. DSRn[DONE] is set when BCR*n* reaches zero. If the BCR*n* is greater than zero, another read/write transfer is initiated. If the BCRn is a multiple of DCRn[BWC], the DMA request signal is negated until termination of the bus cycle to allow the internal arbiter to switch masters.
 - If a termination error occurs, DSRn[BED, DONE] are set and DMA transactions stop.

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DMA Controller Module

22.4.3 Channel Initialization and Startup

Before a block transfer starts, channel registers must be initialized with information describing configuration, request-generation method, and the data block.

22.4.3.1 Channel Prioritization

The four DMA channels are prioritized in ascending order (channel 0 having highest priority and channel 3 having the lowest) or in an order determined by DCRn[BWC]. If the BWC encoding for a DMA channel is 000, that channel has priority only over the channel immediately preceding it. For example, if DCR3[BWC] equals 000, DMA channel 3 has priority over DMA channel 2 (assuming $DCR2[BWC] \neq 000$), but not over DMA channel 1.

If DCR0[BWC] equals 000 and DCR1[BWC] equals 000, DMA0 continues having priority over DMA1. In this case, DCR1[BWC] equals 000 does not affect prioritization.

Simultaneous external requests are prioritized in ascending order or in an order determined by each channel's DCRn[BWC] bits.

22.4.3.2 Programming the DMA Controller Module

General guidelines for programming the DMA are:

- No mechanism exists within the DMA module itself to prevent writes to control registers during DMA accesses.
- If the DCRn[BWC] value of sequential channels are equal, the channels are prioritized in ascending order.

The DMAREQC register is configured to assign peripheral DMA requests to the individual DMA channels.

The SAR*n* is loaded with the source (read) address. If the transfer is from a peripheral device to memory, the source address is the location of the peripheral data register. If the transfer is from memory to a peripheral device or memory, the source address is the starting address of the data block. This can be any aligned byte address.

The DAR*n* should contain the destination (write) address. If the transfer is from a peripheral device to memory, or from memory to memory, the DAR*n* is loaded with the starting address of the data block to be written. If the transfer is from memory to a peripheral device, DAR*n* is loaded with the address of the peripheral data register. This address can be any aligned byte address.

SAR*n* and DAR*n* change after each cycle depending on DCR*n*[SSIZE,DSIZE, SINC,DINC,SMOD,DMOD] and on the starting address. Increment values can be 1, 2, 4, or 16 for byte, word, longword, or 16-byte line transfers, respectively. If the address register is programmed to remain unchanged (no count), the register is not incremented after the data transfer.

BCRn[BCR] must be loaded with the number of byte transfers to occur. It is decremented by 1, 2, 4, or 16 at the end of each transfer, depending on the transfer size. DSRn[DONE] must be cleared for channel startup.

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As soon as the channel has been initialized, it is started by writing a one to DCR*n*[START], or a peripheral DMA request, depending on the status of DCR*n*[EEXT]. Programming the channel for internal requests causes the channel to request the bus and start transferring data immediately. If the channel is programmed for external request, a peripheral DMA request must be asserted before the channel requests the bus.

Changes to DCRn are effective immediately while the channel is active. To avoid problems with changing a DMA channel setup, write a one to DSRn[DONE] to stop the DMA channel.

22.4.4 Data Transfer

This section describes auto-alignment and bandwidth control for DMA transfers.

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22.4.4.1 Auto-Alignment

Auto-alignment allows block transfers to occur at the optimal size based on the address, byte count, and programmed size. To use this, DCRn[AA] must be set. The source is auto-aligned if DCRn[SSIZE] indicates a transfer size larger than DCRn[DSIZE]. Source alignment takes precedence over the destination when the source and destination sizes are equal. Otherwise, the destination is auto-aligned. The address register chosen for alignment increments regardless of the increment value. Configuration error checking is performed on registers not chosen for alignment.

If BCRn is greater than 16, the address determines transfer size. Bytes, words, or longwords are transferred until the address is aligned to the programmed size boundary, at which time accesses begin using the programmed size.

If BCR*n* is less than 16 at the start of a transfer, the number of bytes remaining dictates transfer size. For example, AA equals 1, SAR*n* equals 0x0001, BCR*n* equals 0x00F0, SSIZE equals 00 (longword), and DSIZE equals 01 (byte). Because SSIZE > DSIZE, the source is auto-aligned. Error checking is performed on destination registers. The access sequence is as follows:

- 1. Read byte from 0x0001—write 1 byte, increment SARn.
- 2. Read word from 0x0002—write 2 bytes, increment SARn.
- 3. Read longword from 0x0004—write 4 bytes, increment SARn.
- 4. Repeat longwords until SARn = 0x00F0.
- 5. Read byte from 0x00F0—write byte, increment SARn.

If DSIZE is another size, data writes are optimized to write the largest size allowed based on the address, but not exceeding the configured size.

22.4.4.2 Bandwidth Control

Bandwidth control makes it possible to force the DMA off the bus to allow access to another device. DCRn[BWC] provides seven levels of block transfer sizes. If the BCRn decrements to a multiple of the decode of the BWC, the DMA bus request negates until the bus cycle terminates. If a request is pending, the arbiter may then pass bus mastership to another device. If auto-alignment is enabled,

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DMA Controller Module

DCR*n*[AA] equals 1, the BCR*n* may skip over the programmed boundary, in which case, the DMA bus request is not negated.

If BWC equals 000, the request signal remains asserted until BCR*n* reaches zero. DMA has priority over the core. In this scheme, the arbiter can always force the DMA to relinquish the bus.

22.4.5 Termination

An unsuccessful transfer can terminate for one of the following reasons:

- Error conditions—When the DMA encounters a read or write cycle that terminates with an error condition, DSRn[BES] is set for a read and DSRn[BED] is set for a write before the transfer is halted. If the error occurred in a write cycle, data in the internal holding register is lost.
- Interrupts—If DCRn[INT] is set, the DMA drives the appropriate internal interrupt signal. The processor can read DSRn to determine whether the transfer terminated successfully or with an error. DSRn[DONE] is then written with a one to clear the interrupt and the DONE and error bits.

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Chapter 23 EzPort

The EzPort is a serial programming interface that allows the microcontroller's on-chip flash memory to be read, erased, and programmed using the command set of industry-standard, SPI-compatible flash memory devices.

23.1 Features

The EzPort includes the following features:

- Same serial interface as, and subset of, the command set used by industry-standard SPI flash memories
- Ability to read, erase, and program flash memory
- Reset command to boot the system after flash programming

The EzPort allows the on-chip flash memory to be programmed like industry-standard SPI flash memories. The EzPort implements the core industry-standard SPI flash commands so that existing code, whether written for another microcontroller or for automated test equipment, can be used to program, erase, and verify the on-chip flash under the control of an external device. In essence, the EzPort virtualizes the on-chip flash by making it mimic the behavior of simple, industry-standard SPI flash devices, thus eliminating the need to use the background-debug-mode interface to download and run user-developed flash-programming code.

23.2 Modes of Operation

The EzPort can operate in one of two different modes:

- Enabled—When enabled, the EzPort steals access to the flash memory, preventing access from other cores or peripherals. The rest of the micro-controller is disabled when the EzPort is enabled to avoid conflicts.
- Disabled—When the EzPort is disabled, the rest of the micro-controller can access flash memory as normal.



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Figure 23-1 is a block diagram of the EzPort.

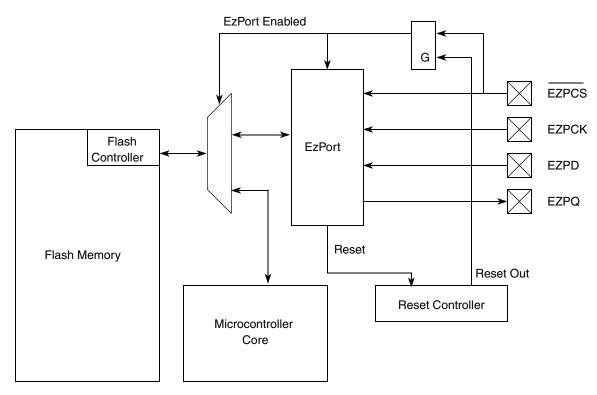


Figure 23-1. EzPort Block Diagram

23.3 External Signal Description

23.3.1 Overview

Table 23-1 contains a list of EzPort external signals.

 Name
 Description
 I/O

 EZPCK
 EzPort Clock
 Input

 EZPCS
 EzPort Chip Select
 Input

 EZPD
 EzPort Serial Data In
 Input

 EZPQ
 EzPort Serial Data Out
 Output

Table 23-1. Signal Descriptions

23.3.2 Detailed Signal Descriptions

23.3.2.1 EZPCK — EzPort Clock

EzPort clock (EZPCK) is the serial clock for data transfers. Serial data in (EZPD) and chip select (\overline{EZPCS}) are registered on the rising edge of EZPCK while serial data out (EZPQ) is driven on the falling edge of

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EZPCK. The maximum frequency of the EzPort clock is half the system clock frequency for all commands except when executing the read data command. When executing the Read Data command, the EzPort clock has a maximum frequency of one eighth the system clock frequency.

23.3.2.2 EZPCS — EzPort Chip Select

EzPort chip select (\overline{EZPCS}) is the chip select for signalling the start and end of serial transfers. If \overline{EZPCS} is asserted during and when the micro-controller's reset out signal is negated, then EzPort is enabled out of reset; otherwise it is disabled. After EzPort is enabled, asserting \overline{EZPCS} commences a serial data transfer, which continues until \overline{EZPCS} is negated again. The negation of \overline{EZPCS} indicates the current command is finished and resets the EzPort state machine so that it is ready to receive the next command.

23.3.2.3 EZPD — EzPort Serial Data In

EzPort serial data in (EZPD) is the serial data in for data transfers. It is registered on the rising edge of EZPCK. All commands, addresses, and data are shifted in most significant bit first. When EzPort is driving output data on EZPQ, the data shifted in EZPD is ignored.

23.3.2.4 EZPQ — EzPort Serial Data Out

EzPort serial data out (EZPQ) is the serial data out for data transfers. It is driven on the falling edge of EZPCK. It is tri-stated, unless EZPCS is asserted and the EzPort is driving data out. All data is shifted out most significant bit first.

23.4 Command Definition

The EzPort receives commands from an external device and translates those commands into flash memory accesses. Table 23-2 lists the supported commands.

| Command | Description | Code | Address Bytes | Dummy Bytes | Data Bytes | Compatible Commands ¹ |
|-----------|-------------------------|------|------------------|----------------|---------------|-------------------------------------|
| WREN | Write Enable | 0x06 | 0 | 0 | 0 | WREN |
| WRDI | Write Disable | 0x04 | 0 | 0 | 0 | WRDI |
| RDSR | Read Status Register | 0x05 | 0 | 0 | 1 | RDSR |
| WRCR | Write Config Register | 0x01 | 0 | 0 | 1 | WRSR |
| READ | Read Data | 0x03 | 3 | 0 | 1+ | READ |
| FAST_READ | Read Data at High Speed | 0x0B | 3 | 1 | 1+ | FAST_READ |
| PP | Page Program | 0x02 | 3 | 0 | 4 to 256 | PP |
| SE | Sector Erase | 0xD8 | 3 | 0 | 0 | SE |
| BE | Bulk Erase | 0xC7 | 0 | 0 | 0 | BE |
| RESET | Reset Chip | 0xB9 | 0 | 0 | 0 | DP |

Table 23-2. EzPort Commands

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¹Lists the compatible commands on the ST Microelectronics Serial Flash Memory parts.



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23.4.1 Command Descriptions

23.4.1.1 Write Enable

The Write Enable command sets the write enable register bit in the status register. The write enable bit must be set for a Write Configuration Register (WRCR), Page Program (PP), Sector Erase (SE), or Bulk Erase (BE) command to be accepted. The write enable register bit clears on reset, on a Write Disable command, and at the completion of a write, program, or erase command.

This command should not be used if a write is already in progress.

23.4.1.2 Write Disable

The Write Disable command clears the write enable register bit in the status register.

This command should not be used if a write is already in progress.

23.4.1.3 Read Status Register

The read status register command returns the contents of the EzPort status register.

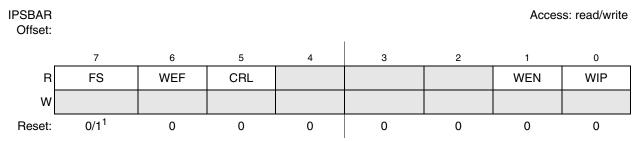


Figure 23-2. EzPort Status Register

Table 23-3. EzPort Status Register Field Description

| Field | Descriptions |
|----------|---|
| 7 FS | Flash Security. Status flag that indicates if the flash memory is in secure mode. In secure mode, the following commands are not accepted: Read (READ), Fast Read (FAST_READ), Page Program (PP), Sector Erase (SE). Secure mode can be exited by performing a Bulk Erase (BE) command, which erases the entire contents of the flash memory. O Flash is not in secure mode. 1 Flash is in secure mode. |
| 6 WEF | Write Error Flag. Status flag that indicates if there has been an error with an erase or program instruction inside the flash controller due to attempting to program or erase a protected sector, or if there is an error in the flash memory after performing a Bulk Erase command. The flag clears after a Read Status Register (RDSR) command. 0 No error on previous erase/program command. 1 Error on previous erase/program command. |

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¹Reset value reflects if flash security is enabled or disabled out of reset.



| Field | Descriptions |
|----------|--|
| 5 CRL | Configuration Register Loaded. Status flag that indicates if the configuration register has been loaded. The configuration register initializes the flash controllers clock configuration register to generate a divided down clock from the system clock that runs at a frequency of 150 kHz to 200 kHz. This register must be initialized before any erase or program commands are accepted. O Configuration register has not been loaded; erase and program commands are not accepted. Configuration register has been loaded; erase and program commands are accepted. |
| 4–2 — | Reserved, should be cleared. |
| 1 WEN | Write Enable. Control bit that must be set before a Write Configuration Register (WRCR), Page Program (PP), Sector Erase (SE), or Bulk Erase (BE) command is accepted. Is set by the Write Enable (WREN) command and cleared by reset or a Write Disable (WRDI) command. It also clears on completion of a write, erase, or program command. O Disables the following write, erase, or program command. Enables the following write, erase, or program command. |
| 0 WIP | Write In Progress. Status flag that sets after a Write Configuration Register (WRCR), Page Program (PP), Sector Erase (SE), or Bulk Erase (BE) command is accepted and clears after the flash memory erase or program is completed. Only the Read Status Register (RDSR) command is accepted while a write is in progress. 0 Write is not in progress. Accept any command. 1 Write is in progress. Only accept RDSR command. |

23.4.1.4 Write Configuration Register

The Write Configuration Command updates the flash controller's clock configuration register. The clock configuration register divides down the flash controller's internal system clock to a 150 kHz to 200 kHz clock. This register must be initialized before any erase or program commands are issued to the flash controller.

This command should not be used if the write error flag is set, a write is in progress, or the configuration register has already been loaded (as it is a write-once register).

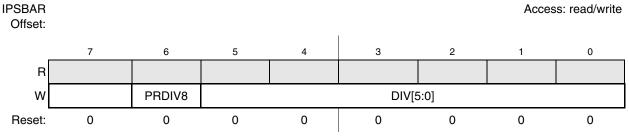


Figure 23-3. EzPort Configuration Register

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Table 23-4. EzPort Configuration Register Field Description

| Field | Descriptions |
|-----------------|--|
| 7 | Reserved, should be cleared. |
| 6 PRDIV | Enables prescaler divide by 8. O The system clock is fed directly into the divider. 1 Enables a prescaler that divides the system clock by 8 before it enters the divider. |
| 5–0 DIV[5:0] | Clock divider field. The combination of PRDIV8 and DIV[5:0] effectively divides the system clock down to a frequency between 150 kHz and 200 kHz. |

23.4.1.5 Read Data

The Read Data command returns data from the flash memory, starting at the address specified in the command word. Data continues being returned for as long as the EzPort chip select (EZPCS) is asserted, with the address automatically incrementing. When the address reaches the highest flash memory address, it wraps around to the lowest flash memory address. In this way, the entire contents of the flash memory can be returned by one command.

For this command to return the correct data, the EzPort Clock (EZPCK) must run at no more than divide by eight of the internal system clock.

This command should not be used if the write error flag is set, or a write is in progress. This command is not accepted if flash security is enabled.

23.4.1.6 Read Data at High Speed

This command is identical to the Read Data command, except for the inclusion of a dummy byte following the address bytes and before the first data byte is returned.

This allows the command to run at any frequency of the EzPort Clock (EZPCK) up to and including half the internal system clock frequency of the micro-controller. This command should not be used if the write error flag is set, or a write is in progress. This command is not accepted if flash security is enabled.

23.4.1.7 Page Program

The Page Program command programs locations in flash memory that have previously been erased. The starting address of the memory to program is sent after the command word and must be a 32-bit aligned address (the two LSBs must be zero). After every four bytes of data are received by the EzPort, that 32-bit word is programmed into flash memory with the address automatically incrementing after each write. For this reason, the number of bytes to program must be a multiple of four. Only a maximum of 256 bytes can be programmed at a time; when the address reaches the highest address within any given 256-byte space of memory, it wraps around to the lowest address in that same space.

This command should not be used if the write error flag is set, a write is in progress, the write enable bit is not set, or the configuration register has not been written. This command is not accepted if flash security is enabled.

The write error flag sets if there is an attempt to program a protected area of the flash memory.

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23.4.1.8 Sector Erase

The Sector Erase command erases the contents of a 2-Kbyte space of flash memory. The 3-byte address sent after the command byte can be any address within the space to erase.

This command should not be used if the write error flag is set, a write is in progress, the write enable bit is not set, or the configuration register has not been written. This command is not accepted if flash security is enabled.

The write error flag sets if there is an attempt to erase a protected area of the flash memory.

23.4.1.9 Bulk Erase

The Bulk Erase command erases the entire contents of flash memory, ignoring any protected sectors or flash security. The write error flag sets if the Bulk Erase command does not successfully erase the entire contents of flash memory. Flash security is disabled if the Bulk Erase command is followed by a Reset Chip command.

This command should not be used if the write error flag is set, a write is in progress, the write enable bit is not set, or the configuration register has not been written.

23.4.1.10 Reset Chip

The Reset Chip command forces the chip into the reset state. If the EzPort chip select (\overline{EZPCS}) pin is asserted at the end of the reset period, EzPort is enabled; otherwise, it is disabled.

This command allows the chip to boot up from flash memory after it has been programmed by an external source.

This command should not be used if a write is in progress.

23.5 Functional Description

The EzPort provides a simple interface to connect an external device to the flash memory on board a 32 bit microcontroller.

The interface itself is compatible with the SPI interface (with the EzPort operating as a slave) running in either of the two following modes with data transmitted most significant bit first:

- CPOL = 0, CPHA = 0
- CPOL = 1, CPHA = 1

Commands are issued by the external device to erase, program, or read the contents of the flash memory. The serial data out from the EzPort is tri-stated unless data is being driven, allowing the signal to be shared among several different EzPort (or compatible) devices in parallel, provided they have different chip selects.



EzPort

23.6 Initialization/Application Information

Prior to issuing any program or erase commands, the clock configuration register must be written to set the flash state machine clock (FCLK). The flash controller module runs at the system clock frequency divide by 2, but FCLK must be divided down from this frequency to a frequency between 150 kHz and 200 kHz. Use the following procedure to set the PRDIV8 and DIV[5:0] bits in the clock configuration register.

- 1. If f_{SYS} is greater than 25.6 MHz, PRDIV8 = 1; otherwise PRDIV8 = 0.
- 2. Determine DIV[5:0] by using the following equation. Keep only the integer portion of the result and discard any fraction. Do not round the result.

DIV =
$$\frac{\text{Fsys}}{2\text{x}200\text{kHzx}(1 + (\text{PRDIV8x7}))}$$
 Eqn. 23-1

3. Therefore, the flash state machine clock is:

Fclk =
$$\frac{Fsys}{2x(DIV+1)x(1+(PRDIV8x7))}$$
 Eqn. 23-2

Therefore, for Fsys equaling 66 MHz, writing 0x54 to the clock configuration register sets Fclk to 196.43 kHz, which is a valid frequency for the timing of program and erase operations.

For proper program and erase operations, it is critical to set Fclk between 150 kHz and 200 kHz. Array damage due to overstress can occur when Fclk is less than 150 kHz. Incomplete programming and erasure can occur when Fclk is greater than 200 kHz.



Chapter 24 Programmable Interrupt Timers (PIT0–PIT1)

24.1 Introduction

This chapter describes the operation of the two programmable interrupt timer modules: PIT0-PIT1.

24.1.1 Overview

Each PIT is a 16-bit timer that provides precise interrupts at regular intervals with minimal processor intervention. The timer can count down from the value written in the modulus register or it can be a free-running down-counter.

24.1.2 Block Diagram

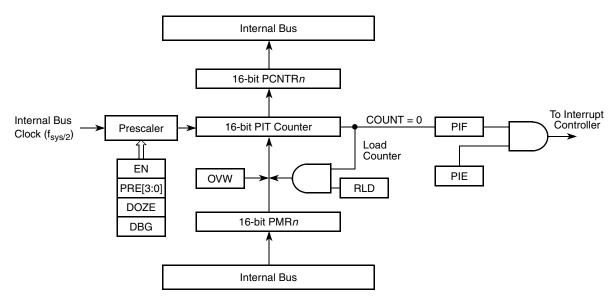


Figure 24-1. PIT Block Diagram

24.1.3 Low-Power Mode Operation

This subsection describes the operation of the PIT modules in low-power modes and debug mode of operation. Low-power modes are described in the power management module, Chapter 10, "Power Management." Table 24-1 shows the PIT module operation in low-power modes and how it can exit from each mode.

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NOTE

The low-power interrupt control register (LPICR) in the system control module specifies the interrupt level at or above which the device can be brought out of a low-power mode.

| Low-power Mode | PIT Operation | Mode Exit | |
|----------------|--|--|--|
| Wait | Normal | N/A | |
| Doze | Normal if PCSRn[DOZE] cleared, stopped otherwise | Any interrupt at or above level in LPICR, exit doze mode if PCSRn[DOZE] is set. Otherwise interrupt assertion has no effect. | |
| Stop | Stopped | No | |
| Debug | Normal if PCSRn[DBG] cleared, stopped otherwise | No. Any interrupt is serviced upon normal exit from debug mode | |

Table 24-1. PIT Module Operation in Low-power Modes

In wait mode, the PIT module continues to operate as in run mode and can be configured to exit the low-power mode by generating an interrupt request. In doze mode with the PCSR*n*[DOZE] bit set, PIT module operation stops. In doze mode with the PCSR*n*[DOZE] bit cleared, doze mode does not affect PIT operation. When doze mode is exited, PIT continues operating in the state it was in prior to doze mode. In stop mode, the internal bus clock is absent and PIT module operation stops.

In debug mode with the PCSR*n*[DBG] bit set, PIT module operation stops. In debug mode with the PCSR*n*[DBG] bit cleared, debug mode does not affect PIT operation. When debug mode is exited, the PIT continues to operate in its pre-debug mode state, but any updates made in debug mode remain.

24.2 Memory Map/Register Definition

This section contains a memory map (see Table 24-2) and describes the register structure for PIT0–PIT1.

IPSBAR Offset Width Access¹ Register **Reset Value** Section/Page PIT 0 (bits) PIT 1 Supervisor Access Only Registers² 0x15 0000 PIT Control and Status Register (PCSRn) R/W 0x0000 16 24.2.1/24-3 0x16_0000 0x15 0002 PIT Modulus Register (PMRn) R/W 0xFFFF 24.2.2/24-4 0x16_0002 **User/Supervisor Access Registers** 0x15_0004 PIT Count Register (PCNTRn) 16 R 0xFFFF 24.2.3/24-5 0x16_0004

Table 24-2. Programmable Interrupt Timer Modules Memory Map

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Accesses to reserved address locations have no effect and result in a cycle termination transfer error.



² User mode accesses to supervisor only addresses have no effect and result in a cycle termination transfer error.

24.2.1 PIT Control and Status Register (PCSRn)

The PCSR*n* registers configure the corresponding timer's operation.

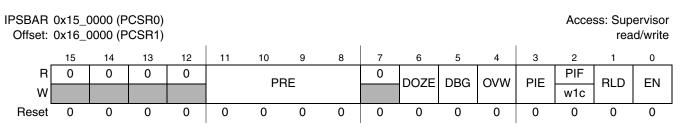


Figure 24-2. PCSRn Register

Table 24-3. PCSRn Field Descriptions

| Field | Description | | | | |
|-------------|---|----------------------------|-------------------------------|-----------------------|-------------------------|
| 15–12 | Reserved, must be cleared. | | | | |
| 11–8 PRE | Prescaler. The read/write prescaler bits select the internal bus clock divisor to generate the PIT clock. To accurately predict the timing of the next count, change the PRE[3:0] bits only when the enable bit (EN) is clear. Changing PRE[3:0] resets the prescaler counter. System reset and the loading of a new value into the counter also reset the prescaler counter. Setting the EN bit and writing to PRE[3:0] can be done in this same write cycle. Clearing the EN bit stops the prescaler counter. | | | | |
| | | PRE | Internal Bus Clock Divisor | Decimal Equivalent | |
| | | 0000 | 2 ⁰ | 1 | |
| | | 0001 | 2 ¹ | 2 | |
| | | 0010 | 2 ² | 4 | |
| | | | | | |
| | | 1101 | 2 ¹³ | 8192 | |
| | | 1110 | 2 ¹⁴ | 16384 | |
| | | 1111 | 2 ¹⁵ | 32768 | |
| 7 | Reserved, must be cleared. | | | | |
| 6 DOZE | Doze Mode Bit. The read/w 0 PIT function not affected 1 PIT function stopped in d before entering doze mod | in doze mod oze mode. V | de | | ode. Reset clears DOZE. |

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Programmable Interrupt Timers (PIT0-PIT1)

Table 24-3. PCSRn Field Descriptions (continued)

| Field | Description |
|----------|---|
| 5 DBG | Debug mode bit. Controls the function of PIT in halted/debug mode. Reset clears DBG. During debug mode, register read and write accesses function normally. When debug mode is exited, timer operation continues from the state it was in before entering debug mode, but any updates made in debug mode remain. O PIT function not affected in debug mode 1 PIT function stopped in debug mode Note: Changing the DBG bit from 1 to 0 during debug mode starts the PIT timer. Likewise, changing the DBG bit from 0 to 1 during debug mode stops the PIT timer. |
| 4 OVW | Overwrite. Enables writing to PMR <i>n</i> to immediately overwrite the value in the PIT counter. O Value in PMR <i>n</i> replaces value in PIT counter when count reaches 0x0000. 1 Writing PMR <i>n</i> immediately replaces value in PIT counter. |
| 3 PIE | PIT interrupt enable. This read/write bit enables PIF flag to generate interrupt requests. O PIF interrupt requests disabled 1 PIF interrupt requests enabled |
| 2 PIF | PIT interrupt flag. This read/write bit is set when PIT counter reaches 0x0000. Clear PIF by writing a 1 to it or by writing to PMR. Writing 0 has no effect. Reset clears PIF. 0 PIT count has not reached 0x0000. 1 PIT count has reached 0x0000. |
| 1 RLD | Reload bit. The read/write reload bit enables loading the value of PMRn into PIT counter when the count reaches 0x0000. 0 Counter rolls over to 0xFFFF on count of 0x0000 1 Counter reloaded from PMRn on count of 0x0000 |
| 0 EN | PIT enable bit. Enables PIT operation. When PIT is disabled, counter and prescaler are held in a stopped state. This bit is read anytime, write anytime. 0 PIT disabled 1 PIT enabled |

24.2.2 PIT Modulus Register (PMRn)

The 16-bit read/write PMR*n* contains the timer modulus value loaded into the PIT counter when the count reaches 0x0000 and the PCSR*n*[RLD] bit is set.

When the PCSR*n*[OVW] bit is set, PMR*n* is transparent, and the value written to PMR*n* is immediately loaded into the PIT counter. The prescaler counter is reset (0xFFFF) anytime a new value is loaded into the PIT counter and also during reset. Reading the PMR*n* returns the value written in the modulus latch. Reset initializes PMR*n* to 0xFFFF.

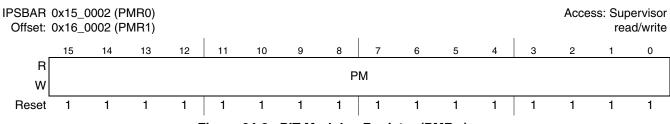


Figure 24-3. PIT Modulus Register (PMRn)

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Table 24-4. PMRn Field Descriptions

| Field | Description |
|------------|--|
| 15–0 PM | Timer modulus. The value of this register is loaded into the PIT counter when the count reaches zero and the PCSRn[RLD] bit is set. However, if PCSRn[OVW] is set, the value written to this field is immediately loaded into the counter. Reading this field returns the value written. |

24.2.3 PIT Count Register (PCNTRn)

The 16-bit, read-only PCNTRn contains the counter value. Reading the 16-bit counter with two 8-bit reads is not guaranteed coherent. Writing to PCNTRn has no effect, and write cycles are terminated normally.

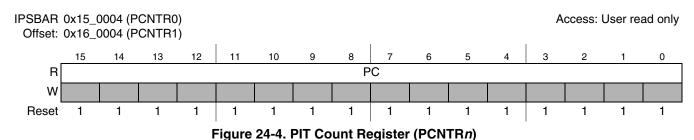


Table 24-5. PCNTRn Field Descriptions

| Field | Description |
|-------|---|
| | Counter value. Reading this field with two 8-bit reads is not guaranteed coherent. Writing to $PCNTRn$ has no effect, and write cycles are terminated normally. |

Functional Description 24.3

This section describes the PIT functional operation.

24.3.1 **Set-and-Forget Timer Operation**

This mode of operation is selected when the RLD bit in the PCSR register is set.

When PIT counter reaches a count of 0x0000, PIF flag is set in PCSRn. The value in the modulus register loads into the counter, and the counter begins decrementing toward 0x0000. If the PCSRn[PIE] bit is set, the PIF flag issues an interrupt request to the CPU.

When the PCSRn[OVW] bit is set, the counter can be directly initialized by writing to PMRn without having to wait for the count to reach 0x0000.



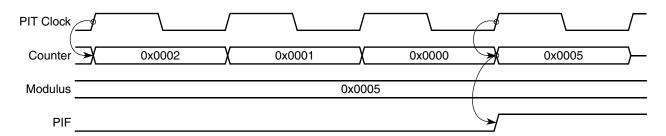


Figure 24-5. Counter Reloading from the Modulus Latch

24.3.2 Free-Running Timer Operation

This mode of operation is selected when the PCSRn[RLD] bit is clear. In this mode, the counter rolls over from 0x0000 to 0xFFFF without reloading from the modulus latch and continues to decrement.

When the counter reaches a count of 0x0000, PCSRn[PIF] flag is set. If the PCSRn[PIE] bit is set, PIF flag issues an interrupt request to the CPU.

When the PCSR*n*[OVW] bit is set, counter can be directly initialized by writing to PMR*n* without having to wait for the count to reach 0x0000.

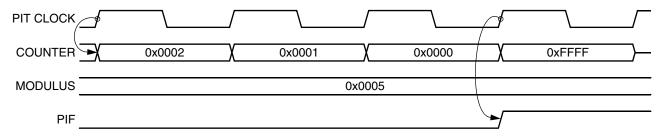


Figure 24-6. Counter in Free-Running Mode

24.3.3 Timeout Specifications

The 16-bit PIT counter and prescaler supports different timeout periods. The prescaler divides the internal bus clock period as selected by the PCSRn[PRE] bits. The PMRn[PM] bits select the timeout period.

Timeout period =
$$\frac{2^{\text{PCSRn[PRE]}} \times (\text{PMRn[PM]} + 1)}{f_{\text{sys/2}}}$$
 Eqn. 24-1

24.3.4 Interrupt Operation

Table 24-6 shows the interrupt request generated by the PIT.

Table 24-6. PIT Interrupt Requests

| Interrupt Request | Flag | Enable Bit |
|-------------------|------|------------|
| Timeout | PIF | PIE |

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The PIF flag is set when the PIT counter reaches 0x0000. The PIE bit enables the PIF flag to generate interrupt requests. Clear PIF by writing a 1 to it or by writing to the PMR.



Chapter 25 General Purpose Timer Module (GPT)

25.1 Introduction

This device has one 4-channel general purpose timer module (GPT). It consists of a 16-bit counter driven by a 7-stage programmable prescaler.

A timer overflow function allows software to extend the timing capability of the system beyond the 16-bit range of the counter. Each of the four timer channels can be configured for input capture, which can capture the time of a selected transition edge, or for output compare, which can generate output waveforms and timer software delays. These functions allow simultaneous input waveform measurements and output waveform generation.

Additionally, channel 3 can be configured as a 16-bit pulse accumulator that can operate as a simple event counter or as a gated time accumulator. The pulse accumulator uses the GPT channel 3 input/output pin in event mode or gated time accumulation mode.

25.2 Features

Features of the general-purpose timer include the following:

- Four 16-bit input capture/output compare channels
- 16-bit architecturef
- Programmable prescaler
- · Pulse-widths variable from microseconds to seconds
- Single 16-bit pulse accumulator
- Toggle-on-overflow for pulse-width modulator (PWM) generation



25.3 Block Diagram

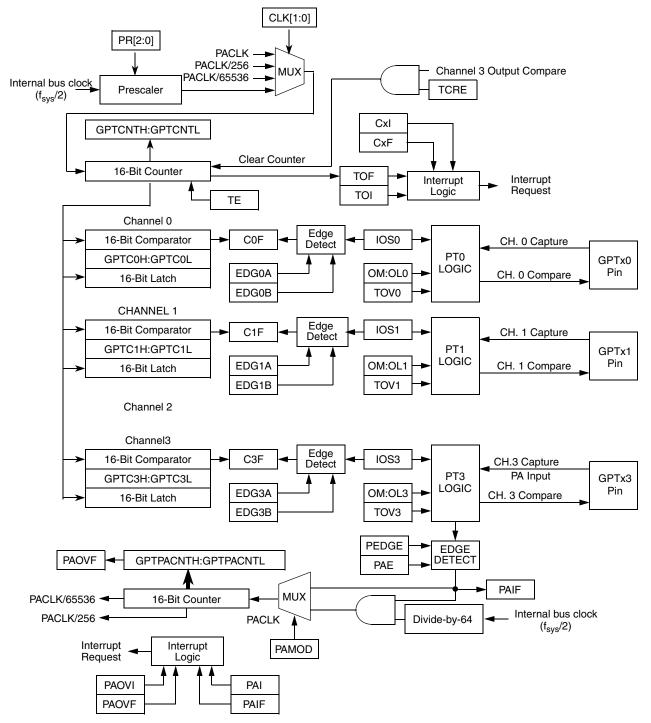


Figure 25-1. GPT Block Diagram



25.4 Low-Power Mode Operation

This subsection describes the operation of the general purpose timer module in low-power modes and halted mode of operation. Low-power modes are described in Chapter 10, "Power Management." Table 25-1 shows the general purpose timer module operation in the low-power modes, and shows how this module may facilitate exit from each mode.

| Low-power Mode | Watchdog Operation | Mode Exit |
|----------------|--------------------|-----------|
| Wait | Normal | No |
| Doze | Normal | No |
| Stop | Stopped | No |
| Halted | Normal | No |

Table 25-1. Watchdog Module Operation in Low-power Modes

General purpose timer operation stops in stop mode. When stop mode is exited, the general purpose timer continues to operate in its pre-stop mode state.

25.5 Signal Description

Table 25-2 provides an overview of the signal properties.

GPTPORT Pin **Function Reset State** Pull-up Name Register Bit GPT0 PORTTn0 GPT channel 0 IC/OC pin Input Active GPT1 PORTTn1 GPT channel 1 IC/OC pin Input Active GPT2 PORTTn2 GPT channel 2 IC/OC pin Input Active GPT3 PORTTn3 GPT channel 3 IC/OC or PA pin Input Active

Table 25-2. Signal Properties

25.5.1 GPT[2:0]

The GPT[2:0] pins are for channel 2–0 input capture and output compare functions. These pins are available for general-purpose input/output (I/O) when not configured for timer functions.

25.5.2 GPT3

The GPT3 pin is for channel 3 input capture and output compare functions or for the pulse accumulator input. This pin is available for general-purpose I/O when not configured for timer functions.

25.6 Memory Map and Registers

Table 25-3 shows the memory map of the GPT module. The base address for GPT is IPSBAR + 0x1A 0000.

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NOTE

Reading reserved or unimplemented locations returns zeros. Writing to reserved or unimplemented locations has no effect.

Table 25-3. GPT Memory Map

| IPSBAR Offset ¹ | Register | Width (bits) | Access | Reset Value | Section/Page |
|-------------------------------|--|-----------------|--------|-------------|---------------|
| | Supervisor Mode Access C | Only | | | |
| 0x1A_0000 | GPT IC/OC Select Register (GPTIOS) | 8 | R/W | 0x00 | 25.6.1/25-5 |
| 0x1A_0001 | GPT Compare Force Register (GPTCFORC) | 8 | R/W | 0x00 | 25.6.2/25-5 |
| 0x1A_0002 | GPT Output Compare 3 Mask Register (GPTOC3M) | 8 | R/W | 0x00 | 25.6.3/25-6 |
| 0x1A_0003 | GPT Output Compare 3 Data Register (GPTOC3D) | 8 | R/W | 0x00 | 25.6.4/25-7 |
| 0x1A_0004 | GPT Counter Register High (GPTCNTH) ² | 8 | R | 0x00 | 25.6.5/25-7 |
| 0x1A_0005 | GPT Counter Register Low (GPTCNTL) ² | 8 | R | 0x00 | 25.6.5/25-7 |
| 0x1A_0006 | GPT System Control Register 1 (GPTSCR1) | 8 | R/W | 0x00 | 25.6.6/25-8 |
| 0x1A_0008 | GPT Toggle-on-Overflow Register (GPTTOV) | 8 | R/W | 0x00 | 25.6.7/25-9 |
| 0x1A_0009 | GPT Control Register 1 (GPTCTL1) | 8 | R/W | 0x00 | 25.6.8/25-9 |
| 0x1A_000B | GPT Control Register 2 (GPTCTL2) | 8 | R/W | 0x00 | 25.6.9/25-10 |
| 0x1A_000C | GPT Interrupt Enable Register (GPTIE) | 8 | R/W | 0x00 | 25.6.10/25-10 |
| 0x1A_000D | GPT System Control Register 2 (GPTSCR2) | 8 | R/W | 0x00 | 25.6.11/25-11 |
| 0x1A_000E | GPT Flag Register 1 (GPTFLG1) | 8 | R/W | 0x00 | 25.6.12/25-12 |
| 0x1A_000F | GPT Flag Register 2 (GPTFLG2) | 8 | R/W | 0x00 | 25.6.13/25-12 |
| 0x1A_0010 | GPT Channel 0 Register High (GPTC0H) ² | 8 | | | 25.6.14/25-13 |
| 0x1A_0011 | GPT Channel 0 Register Low (GPTC0L) ² | 8 | | | 25.6.14/25-13 |
| 0x1A_0012 | GPT Channel 1 Register High (GPTC1H) ² | 8 | | | 25.6.14/25-13 |
| 0x1A_0013 | GPT Channel 1 Register Low (GPTC1L) ² | 8 | | | 25.6.14/25-13 |
| 0x1A_0014 | GPT Channel 2 Register High (GPTC2H) ² | 8 | | | 25.6.14/25-13 |
| 0x1A_0015 | GPT Channel 2 Register Low (GPTC2L) ² | 8 | | | 25.6.14/25-13 |
| 0x1A_0016 | GPT Channel 3 Register High (GPTC3H) ² | 8 | | | 25.6.14/25-13 |
| 0x1A_0017 | GPT Channel 3 Register Low (GPTC3L) ² | 8 | | | 25.6.14/25-13 |
| 0x1A_0018 | Pulse Accumulator Control Register (GPTPACTL) | 8 | R/W | 0x00 | 25.6.15/25-13 |
| 0x1A_0019 | Pulse Accumulator Flag Register (GPTPAFLG) | 8 | R/W | 0x00 | 25.6.16/25-14 |
| 0x1A_001A | Pulse Accumulator Counter Register High (GPTPACNTH) ² | 8 | R/W | | 25.6.17/25-15 |
| 0x1A_001B | Pulse Accumulator Counter Register Low (GPTPACNTL) ² | 8 | R/W | | 25.6.17/25-15 |



Table 25-3. GPT Memory Map (continued)

| IPSBAR Offset ¹ | Register | Width (bits) | Access | Reset Value | Section/Page |
|-------------------------------|---|-----------------|--------|-------------|---------------|
| 0x1A_001D | GPT Port Data Register (GPTPORT) | 8 | R/W | 0x00 | 25.6.18/25-16 |
| 0x1A_001E | GPT Port Data Direction Register (GPTDDR) | 8 | R/W | 0x00 | 25.6.19/25-16 |

Addresses not assigned to a register and undefined register bits are reserved for expansion.

25.6.1 GPT Input Capture/Output Compare Select Register (GPTIOS)

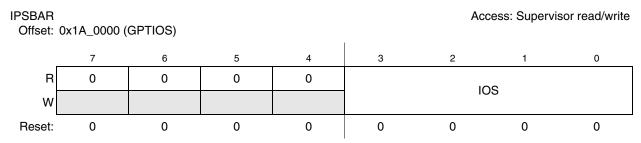


Figure 25-2. GPT Input Capture/Output Compare Select Register (GPTIOS)

Table 25-4. GPTIOS Field Descriptions

| Field | Description |
|------------|--|
| 7–4 | Reserved, should be cleared. |
| 3–0 IOS | I/O select. The IOS[3:0] bits enable input capture or output compare operation for the corresponding timer channels. These bits are read anytime (always read 0x00), write anytime. 1 Output compare enabled 0 Input capture enabled |

25.6.2 GPT Compare Force Register (GPCFORC)

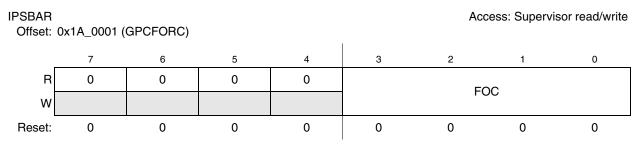


Figure 25-3. GPT Input Compare Force Register (GPCFORC)

² This register is 16 bits wide, and should be read using only word accesses.



Table 25-5. GPTCFORC Field Descriptions

| Field | Description |
|------------|--|
| 7–4 | Reserved, should be cleared. |
| 3–0 FOC | Force output compare. Setting an FOC bit causes an immediate output compare on the corresponding channel. Forcing an output compare does not set the output compare flag. These bits are read anytime, write anytime. 1 Force output compare 0 No effect |

NOTE

A successful channel 3 output compare overrides any compare on channels 2:0. For each OC3M bit that is set, the output compare action reflects the corresponding OC3D bit.

GPT Output Compare 3 Mask Register (GPTOC3M) 25.6.3

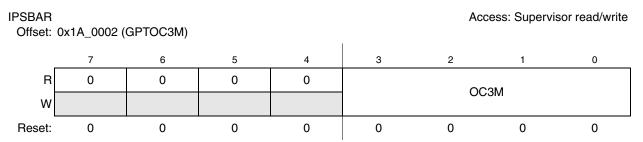


Figure 25-4. GPT Output Compare 3 Mask Register (GPTOC3M)

Table 25-6. GPTOC3M Field Descriptions

| Field | Description |
|-------------|--|
| 7–4 | Reserved, should be cleared. |
| 3-0 OC3M | Output compare 3 mask. Setting an OC3M bit configures the corresponding PORTT <i>n</i> pin to be an output. OC3M <i>n</i> makes the GPT port pin an output regardless of the data direction bit when the pin is configured for output compare (IOSx = 1). The OC3M <i>n</i> bits do not change the state of the PORTT <i>n</i> DDR bits. These bits are read anytime, write anytime. 1 Corresponding PORTT <i>n</i> pin configured as output 0 No effect |

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25.6.4 GPT Output Compare 3 Data Register (GPTOC3D)

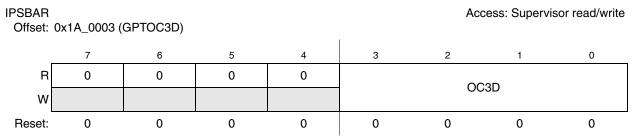


Figure 25-5. GPT Output Compare 3 Data Register (GPTOC3D)

Table 25-7. GPTOC3D Field Descriptions

| Field | Description |
|-------------|--|
| 7–4 | Reserved, should be cleared. |
| 3–0 OC3D | Output compare 3 data. When a successful channel 3 output compare occurs, these bits transfer to the PORTT <i>n</i> data register if the corresponding OC3M <i>n</i> bits are set. These bits are read anytime, write anytime. |

NOTE

A successful channel 3 output compare overrides any channel 2:0 compares. For each OC3M bit that is set, the output compare action reflects the corresponding OC3D bit.

25.6.5 GPT Counter Register (GPTCNT)

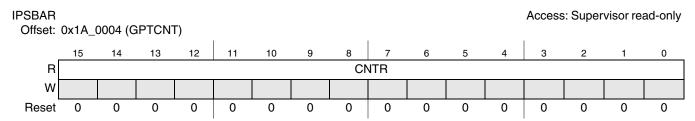


Figure 25-6. GPT Counter Register (GPTCNT)

Table 25-8. GPTCNT Field Descriptions

| Field | Description |
|--------------|--|
| 15–0 CNTF | Read-only field that provides the current count of the timer counter. To ensure coherent reading of the timer counter, such that a timer rollover does not occur between two back-to-back 8-bit reads, it is recommended that only word (16-bit) accesses be used. A write to GPTCNT may have an extra cycle on the first count because the write is not synchronized with the prescaler clock. The write occurs at least one cycle before the synchronization of the prescaler clock. These bits are read anytime. They should be written to only in test (special) mode; writing to them has no effect in normal modes. |

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25.6.6 GPT System Control Register 1 (GPTSCR1)

IPSBAR Access: Supervisor read/write Offset: 0x1A_0006 (GPTSCR1) 0 0 0 0 0 0 **GPTEN TFFCA** 0 0 0 Reset: 0 0 0

Figure 25-7. GPT System Control Register 1 (GPTSCR1)

Table 25-9. GPTSCR1 Field Descriptions

| Field | Description |
|------------|--|
| 7 GPTEN | Enables the general purpose timer. When the timer is disabled, only the registers are accessible. Clearing GPTEN reduces power consumption. These bits are read anytime, write anytime. 1 GPT enabled 0 GPT and GPT counter disabled |
| 6–5 | Reserved, should be cleared. |
| 4 TFFCA | Timer fast flag clear all. Enables fast clearing of the main timer interrupt flag registers (GPTFLG1 and GPTFLG2) and the PA flag register (GPTPAFLG). TFFCA eliminates the software overhead of a separate clear sequence. See Figure 25-8. When TFFCA is set: • An input capture read or a write to an output compare channel clears the corresponding channel flag, CxF. • Any access of the GPT count registers (GPTCNTH/L) clears the TOF flag. • Any access of the PA counter registers (GPTPACNT) clears the PAOVF and PAIF flags in GPTPAFLG. Writing logic 1s to the flags clears them only when TFFCA is clear. 1 Fast flag clearing 0 Normal flag clearing |
| 3–0 | Reserved, should be cleared. |

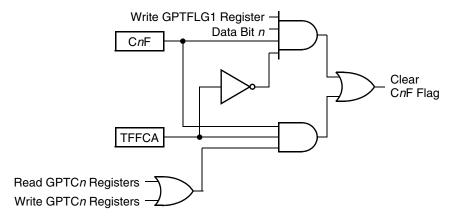


Figure 25-8. Fast Clear Flag Logic



25.6.7 GPT Toggle-On-Overflow Register (GPTTOV)

IPSBAR Access: Supervisor read/write Offset: 0x1A_0008 (GPTTOV) 3 0 R 0 0 0 0 TOV 0 Reset: 0 0 0 0 0 0 0

Figure 25-9. GPT Toggle-On-Overflow Register (GPTTOV)

Table 25-10. GPTTOV Field Description

| Field | Description |
|------------|---|
| 7–4 | Reserved, should be cleared. |
| 3–0 TOV | Toggles the output compare pin on overflow for each channel. This only takes effect when in output compare mode. When set, it takes precedence over forced output compare but not channel 3 override events. These bits are read anytime, write anytime. 1 Toggle output compare pin on overflow enabled 0 Toggle output compare pin on overflow disabled |

25.6.8 GPT Control Register 1 (GPTCTL1)

IPSBAR Access: Supervisor read/write Offset: 0x1A_0009 (GPTCTL1) 7 5 3 2 0 6 4 1 R ОМЗ OL3 OM2 OL2 OM₁ OL1 OM0 OL₀ W 0 0 0 0 0 0 0 0 Reset:

Figure 25-10. GPT Control Register 1 (GPTCTL1)

Table 25-11. GPTCL1 Field Descriptions

| Field | Description |
|----------------|---|
| 7–0 OMx/OLx | Output mode/output level. Selects the output action to be taken as a result of a successful output compare on each channel. When OMn or OLn is set and the IOSn bit is set, the pin is an output regardless of the state of the corresponding DDR bit. These bits are read anytime, write anytime. 00 GPT disconnected from output pin logic 01 Toggle OCn output line 10 Clear OCn output line 11 Set OCn line Note: Channel 3 shares a pin with the pulse accumulator input pin. To use the PAI input, clear the OM3 and OL3 bits and clear the OC3M3 bit in the output compare 3 mask register. |

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GPT Control Register 2 (GPTCTL2) 25.6.9

IPSBAR Access: Supervisor read/write Offset: 0x1A_000B (GPTCTL2) 5 3 2 0 R EDG3B EDG3A EDG2B EDG2A EDG1B EDG1A EDG0B EDG0A 0 0 0 0 0 0 Reset: 0

Figure 25-11. GPT Control Register 2(GPTCTL2)

Table 25-12. GPTLCTL2 Field Descriptions

| Field | Description |
|------------------|--|
| 7–0 EDGn[B:A] | Input capture edge control. Configures the input capture edge detector circuits for each channel. These bits are read anytime, write anytime. On Input capture disabled Input capture on rising edges only Input capture on falling edges only Input capture on any edge (rising or falling) |

25.6.10 GPT Interrupt Enable Register (GPTIE)

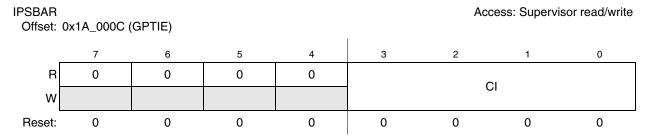


Figure 25-12. GPT Interrupt Enable Register (GPTIE)

Table 25-13. GPTIE Field Descriptions

| Field | Description |
|---------------------|--|
| 7–4 | Reserved, should be cleared. |
| 3–0 C <i>n</i> l | Channel interrupt enable. Enables the C[3:0]F flags in GPT flag register 1 to generate interrupt requests for each channel. These bits are read anytime, write anytime. 1 Corresponding channel interrupt requests enabled 0 Corresponding channel interrupt requests disabled |

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25.6.11 GPT System Control Register 2 (GPTSCR2)

IPSBAR Access: Supervisor read/write Offset: 0x1A_000D (GPTSCR2) 5 3 0 R 0 **PUPT** RDPT TOI **TCRE** PR 0 0 0 0 0 0 0 0 Reset:

Figure 25-13. GPT System Control Register 2 (GPTSCR2)

Table 25-14. GPTSCR2 Field Descriptions

| Field | Description |
|-----------|--|
| 7 TOI | Enables timer overflow interrupt requests. 1 Overflow interrupt requests enabled 0 Overflow interrupt requests disabled |
| 6 | Reserved, should be cleared. |
| 5 PUPT | Enables pull-up resistors on the GPT ports when the ports are configured as inputs. 1 Pull-up resistors enabled 0 Pull-up resistors disabled |
| 4 RDPT | GPT drive reduction. Reduces the output driver size. 1 Output drive reduction enabled 0 Output drive reduction disabled |
| 3 TCRE | Enables a counter reset after a channel 3 compare. 1 Counter reset enabled 0 Counter reset disabled Note: When the GPT channel 3 registers contain 0x0000 and TCRE is set, the GPT counter registers remain at 0x0000 all the time. When the GPT channel 3 registers contain 0xFFFF and TCRE is set, TOF does not get set even though the GPT counter registers go from 0xFFFF to 0x0000. |
| 2–0 PR | Prescaler bits. Select the prescaler divisor for the GPT counter. 000 Prescaler divisor 1 001 Prescaler divisor 2 010 Prescaler divisor 4 011 Prescaler divisor 8 100 Prescaler divisor 16 101 Prescaler divisor 32 110 Prescaler divisor 64 111 Prescaler divisor 128 Note: The newly selected prescaled clock does not take effect until the next synchronized edge of the prescaled clock when the clock count transitions to 0x0000.) |

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25.6.12 GPT Flag Register 1 (GPTFLG1)

IPSBAR Access: Supervisor read/write Offset: 0x1A_000E (GPTFLG1) 4 3 0 R 0 0 0 0 CF 0 0 0 Reset: 0 0 0 0 0

Figure 25-14. GPT Flag Register 1 (GPTFLG1)

Table 25-15. GPTFLG1 Field Descriptions

| Field | Description |
|---------------------|--|
| 7–4 | Reserved, should be cleared. |
| 3–0 C <i>n</i> F | Channel flags. A channel flag is set when an input capture or output compare event occurs. These bits are read anytime, write anytime (writing 1 clears the flag, writing 0 has no effect). Note: When the fast flag clear all bit, GPTSCR1[TFFCA], is set, an input capture read or an output compare write clears the corresponding channel flag. When a channel flag is set, it does not inhibit subsequent output compares or input captures. |

25.6.13 GPT Flag Register 2 (GPTFLG2)

IPSBAR Access: Supervisor read/write

Offset: 0x1A_000F (GPTFLG2)

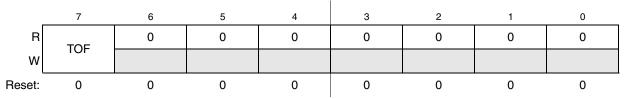


Figure 25-15. GPT Flag Register 2 (GPTFLG2)

Table 25-16. GPTFLG2 Field Descriptions

| Field | Description |
|----------|---|
| 7 TOF | Timer overflow flag. Set when the GPT counter rolls over from 0xFFFF to 0x0000. If the TOI bit in GPTSCR2 is also set, TOF generates an interrupt request. This bit is read anytime, write anytime (writing 1 clears the flag, and writing 0 has no effect). 1 Timer overflow 0 No timer overflow Note: When the GPT channel 3 registers contain 0xFFFF and TCRE is set, TOF does not get set even though the GPT counter registers go from 0xFFFF to 0x0000. When TOF is set, it does not inhibit subsequent overflow events. |
| 6–0 | Reserved, should be cleared. |

NOTE

When the fast flag clear all bit, GPTSCR1[TFFCA], is set, any access to the GPT counter registers clears GPT flag register 2.

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25.6.14 GPT Channel Registers (GPTCn)

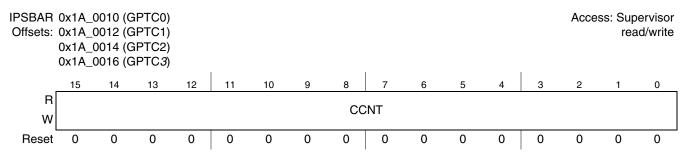


Figure 25-16. GPT Channel[0:3] Register (GPTCn)

Table 25-17. GPTCn Field Descriptions

| Field | Description |
|--------------|---|
| 15–0 CCNT | When a channel is configured for input capture ($IOSn = 0$), the GPT channel registers latch the value of the free-running counter when a defined transition occurs on the corresponding input capture pin. When a channel is configured for output compare ($IOSn = 1$), the GPT channel registers contain the output compare value. To ensure coherent reading of the GPT counter, such that a timer rollover does not occur between back-to-back 8-bit reads, it is recommended that only word (16-bit) accesses be used. These bits are read anytime, write anytime (for the output compare channel); writing to the input capture channel has no effect. |

25.6.15 Pulse Accumulator Control Register (GPTPACTL)

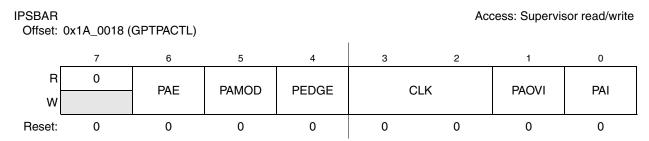


Figure 25-17. Pulse Accumulator Control Register (GPTPACTL)

Table 25-18. GPTPACTL Field Descriptions

| Field | Description |
|------------|---|
| 7 | Reserved, should be cleared. |
| 6 PAE | Enables the pulse accumulator. 1 Pulse accumulator enabled 0 Pulse accumulator disabled Note: The pulse accumulator can operate in event mode even when the GPT enable bit, GPTEN, is clear. |
| 5 PAMOD | Pulse accumulator mode. Selects event counter mode or gated time accumulation mode. 1 Gated time accumulation mode 0 Event counter mode |

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Table 25-18. GPTPACTL Field Descriptions (continued)

| Field | Description |
|------------|---|
| 4 PEDGE | Pulse accumulator edge. Selects falling or rising edges on the PAI pin to increment the counter. In event counter mode (PAMOD = 0): 1 Rising PAI edge increments counter 0 Falling PAI edge increments counter In gated time accumulation mode (PAMOD = 1): 1 Low PAI input enables divide-by-64 clock to pulse accumulator and trailing rising edge on PAI sets PAIF flag. 0 High PAI input enables divide-by-64 clock to pulse accumulator and trailing falling edge on PAI sets PAIF flag. Note: The timer prescaler generates the divide-by-64 clock. If the timer is not active, there is no divide-by-64 clock. To operate in gated time accumulation mode: 1. Apply logic 0 to RSTI pin. 2. Initialize registers for pulse accumulator mode test. 3. Apply appropriate level to PAI pin. 4. Enable GPT. |
| 3–2 CLK | Select the GPT counter input clock. Changing the CLK bits causes an immediate change in the GPT counter clock input. 00 GPT prescaler clock (When PAE = 0, the GPT prescaler clock is always the GPT counter clock.) 10 PACLK 10 PACLK/256 11 PACLK/65536 |
| 1 PAOVI | Pulse accumulator overflow interrupt enable. Enables the PAOVF flag to generate interrupt requests. 1 PAOVF interrupt requests enabled 0 PAOVF interrupt requests disabled |
| 0 PAI | Pulse accumulator input interrupt enable. Enables the PAIF flag to generate interrupt requests. 1 PAIF interrupt requests enabled 0 PAIF interrupt requests disabled |

25.6.16 Pulse Accumulator Flag Register (GPTPAFLG)

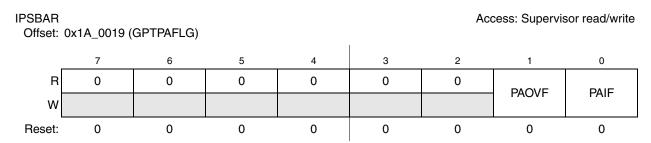


Figure 25-18. Pulse Accumulator Flag Register (GPTPAFLG)

Table 25-19. GPTPAFLG Field Descriptions

| Field | Description |
|-------|------------------------------|
| 7–2 | Reserved, should be cleared. |



Table 25-19. GPTPAFLG Field Descriptions (continued)

| Field | Description |
|------------|--|
| 1 PAOVF | Pulse accumulator overflow flag. Set when the 16-bit pulse accumulator rolls over from 0xFFFF to 0x0000. If the GPTPACTL[PAOVI] bit is also set, PAOVF generates an interrupt request. Clear PAOVF by writing a 1 to it. This bit is read anytime, write anytime. (Writing 1 clears the flag; writing 0 has no effect.) 1 Pulse accumulator overflow 0 No pulse accumulator overflow |
| 0 PAIF | Pulse accumulator input flag. Set when the selected edge is detected at the PAI pin. In event counter mode, the event edge sets PAIF. In gated time accumulation mode, the trailing edge of the gate signal at the PAI pin sets PAIF. If the PAI bit in GPTPACTL is also set, PAIF generates an interrupt request. Clear PAIF by writing a 1 to it. 1 Active PAI input 0 No active PAI input |

NOTE

When the fast flag clear all enable bit (GPTSCR1[TFFCA]) is set, any access to the pulse accumulator counter registers clears all the flags in GPTPAFLG.

25.6.17 Pulse Accumulator Counter Register (GPTPACNT)

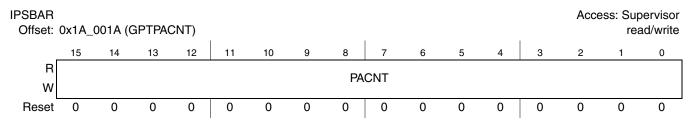


Figure 25-19. Pulse Accumulator Counter Register (GPTPACNT)

Table 25-20. GPTPACR Field Descriptions

| Field | Description |
|---------------|--|
| 15–0 PACNT | Contains the number of active input edges on the PAI pin since the last reset. Note: Reading the pulse accumulator counter registers immediately after an active edge on the PAI pin may miss the last count because the input first has to be synchronized with the bus clock. To ensure coherent reading of the PA counter, such that the counter does not increment between back-to-back 8-bit reads, it is recommended that only word (16-bit) accesses be used. These bits are read anytime, write anytime. |

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25.6.18 GPT Port Data Register (GPTPORT)

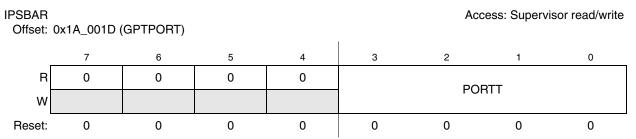


Figure 25-20. GPT Port Data Register (GPTPORT)

Table 25-21. GPTPORT Field Descriptions

| Field | Description |
|--------------|---|
| 7–4 | Reserved, should be cleared. |
| 3–0 PORTT | GPT port input capture/output compare data. Data written to GPTPORT is buffered and drives the pins only when they are not used in output compare. Reading an input (DDR bit = 0) reads the pin state; reading an output (DDR bit = 1) reads the latched value. Writing to a pin configured as a GPT output does not change the pin state. These bits are read anytime (read pin state when corresponding GPTDDR n bit is 0, read pin driver state when corresponding GPTDDR bit is 1), write anytime. |

25.6.19 GPT Port Data Direction Register (GPTDDR)

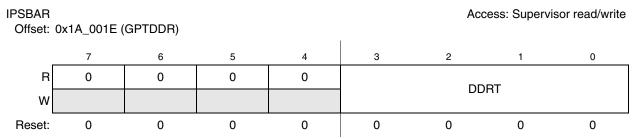


Figure 25-21. GPT Port Data Direction Register (GPTDDR)

Table 25-22. GPTDDR Field Descriptions

| Bit(s) | Name | Description |
|--------|------|---|
| 7–4 | _ | Reserved, should be cleared. |
| 3–0 | DDRT | Control the port logic of PORTT <i>n</i> . Reset clears the PORTT <i>n</i> data direction register, configuring all GPT port pins as inputs. These bits are read anytime, write anytime. 1 Corresponding pin configured as output 0 Corresponding pin configured as input |

25.7 Functional Description

The general purpose timer (GPT) module is a 16-bit, 4-channel timer with input capture and output compare functions and a pulse accumulator.



25.7.1 Prescaler

The prescaler divides the module clock by 1 or 16. The PR[2:0] bits in GPTSCR2 select the prescaler divisor.

25.7.2 Input Capture

Clearing an I/O select bit (IOSn) configures channel n as an input capture channel. The input capture function captures the time at which an external event occurs. When an active edge occurs on the pin of an input capture channel, the timer transfers the value in the GPT counter into the GPT channel registers (GPTCn).

The minimum pulse width for the input capture input is greater than two module clocks.

The input capture function does not force data direction. The GPT port data direction register controls the data direction of an input capture pin. Pin conditions such as rising or falling edges can trigger an input capture only on a pin configured as an input.

An input capture on channel n sets the CnF flag. The CnI bit enables the CnF flag to generate interrupt requests.

25.7.3 Output Compare

Setting an I/O select bit (IOS*n*) configures channel *n* as an output compare channel. The output compare function can generate a periodic pulse with a programmable polarity, duration, and frequency. When the GPT counter reaches the value in the channel registers of an output compare channel, the timer can set, clear, or toggle the channel pin. An output compare on channel *n* sets the C*n*F flag. The C*n*I bit enables the C*n*F flag to generate interrupt requests.

The output mode (OMn) and level bits (OLn) select, set, clear, or toggle on output compare. Clearing OMn and OLn disconnects the pin from the output logic.

Setting a force output compare bit (FOCn) causes an output compare on channel n. A forced output compare does not set the channel flag.

A successful output compare on channel 3 overrides output compares on all other output compare channels. A channel 3 output compare can cause bits in the output compare 3 data register to transfer to the GPT port data register, depending on the output compare 3 mask register. The output compare 3 mask register masks the bits in the output compare 3 data register. The GPT counter reset enable bit, TCRE, enables channel 3 output compares to reset the GPT counter. A channel 3 output compare can reset the GPT counter even if the OC3/PAI pin is being used as the pulse accumulator input.

An output compare overrides the data direction bit of the output compare pin but does not change the state of the data direction bit.

Writing to the PORTTn bit of an output compare pin does not affect the pin state. The value written is stored in an internal latch. When the pin becomes available for general-purpose output, the last value written to the bit appears at the pin.



25.7.4 Pulse Accumulator

The pulse accumulator (PA) is a 16-bit counter that can operate in two modes:

- Event counter mode: counts edges of selected polarity on the pulse accumulator input pin, PAI
- Gated time accumulation mode: counts pulses from a divide-by-64 clock

The PA mode bit (PAMOD) selects the mode of operation.

The minimum pulse width for the PAI input is greater than two module clocks.

25.7.5 Event Counter Mode

Clearing the PAMOD bit configures the PA for event counter operation. An active edge on the PAI pin increments the PA. The PA edge bit (PEDGE) selects falling edges or rising edges to increment the PA.

An active edge on the PAI pin sets the PA input flag (PAIF). The PA input interrupt enable bit (PAI) enables the PAIF flag to generate interrupt requests.

NOTE

The PAI input and GPT channel 3 use the same pin. To use the PAI input, disconnect it from the output logic by clearing the channel 3 output mode and output level bits, OM3 and OL3. Also clear the channel 3 output compare 3 mask bit (OC3M3).

The PA counter register (GPTPACNT) reflects the number of active input edges on the PAI pin since the last reset.

The PA overflow flag (PAOVF) is set when the PA rolls over from 0xFFFF to 0x0000. The PA overflow interrupt enable bit (PAOVI) enables the PAOVF flag to generate interrupt requests.

NOTE

The PA can operate in event counter mode even when the GPT enable bit (GPTEN) is clear.

25.7.6 Gated Time Accumulation Mode

Setting the PAMOD bit configures the PA for gated time accumulation operation. An active level on the PAI pin enables a divide-by-64 clock to drive the PA. The PA edge bit (PEDGE) selects low levels or high levels to enable the divide-by-64 clock.

The trailing edge of the active level at the PAI pin sets the PA input flag (PAIF). The PA input interrupt enable bit (PAI) enables the PAIF flag to generate interrupt requests.

NOTE

The PAI input and GPT channel 3 use the same pin. To use the PAI input, disconnect it from the output logic by clearing the channel 3 output mode (OM3) and output level (OL3) bits. Also clear the channel 3 output compare mask bit (OC3M3).

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The PA counter register (GPTPACNT) reflects the number of pulses from the divide-by-64 clock since the last reset.

NOTE

The GPT prescaler generates the divide-by-64 clock. If the timer is not active, there is no divide-by-64 clock.

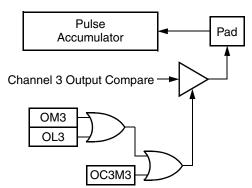


Figure 25-22. Channel 3 Output Compare/Pulse Accumulator Logic

25.7.7 General-Purpose I/O Ports

An I/O pin used by the timer defaults to general-purpose I/O unless an internal function that uses that pin is enabled.

The PORTT*n* pins can be configured for an input capture function or an output compare function. The IOS*n* bits in the GPT IC/OC select register configure the PORTT*n* pins as input capture or output compare pins.

The PORTT*n* data direction register controls the data direction of an input capture pin. External pin conditions trigger input captures on input capture pins configured as inputs.

To configure a pin for input capture:

- 1. Clear the pin's IOS bit in GPTIOS.
- 2. Clear the pin's DDR bit in PORTT*n*DDR.
- 3. Write to GPTCTL2 to select the input edge to detect.

PORTT*n*DDR does not affect the data direction of an output compare pin. The output compare function overrides the data direction register but does not affect the state of the data direction register.

To configure a pin for output compare:

- 1. Set the pin's IOS bit in GPTIOS.
- 2. Write the output compare value to GPTCn.
- 3. Clear the pin's DDR bit in PORTT*n*DDR.
- 4. Write to the OMn/OLn bits in GPTCTL1 to select the output action.

Table 25-23 shows how various timer settings affect pin functionality.



Table 25-23. GPT Settings and Pin Functions

| GPTEN | DDR ¹ | GPTIOS | EDGx [B:A] | OMx/ OLx ² | OC3Mx ³ | Pin Data Dir. | Pin Driven by | Pin Function | Comments |
|-------|------------------|----------------|--------------------|--------------------------|--------------------|---------------------|---------------------|-----------------------------|---|
| 0 | 0 | X ⁴ | Х | Х | Х | In | Ext. | Digital input | GPT disabled by GPTEN = 0 |
| 0 | 1 | Х | Х | Х | Х | Out | Data reg. | Digital output | GPT disabled by GPTEN = 0 |
| 1 | 0 | 0 (IC) | 0 (IC disabled) | Х | 0 | In | Ext. | Digital input | Input capture disabled by EDGn setting |
| 1 | 1 | 0 | 0 | Х | 0 | Out | Data reg. | Digital output | Input capture disabled by EDGn setting |
| 1 | 0 | 0 | <> 0 | Х | 0 | In | Ext. | IC and digital input | Normal settings for input capture |
| 1 | 1 | 0 | <> 0 | Х | 0 | Out | Data reg. | Digital output | Input capture of data driven to output pin by CPU |
| 1 | 0 | 0 | <> 0 | Х | 1 | In | Ext. | IC and digital input | OC3M setting has no effect because IOS = 0 |
| 1 | 1 | 0 | <> 0 | Х | 1 | Out | Data reg. | Digital output | OC3M setting has no effect because IOS = 0; input capture of data driven to output pin by CPU |
| 1 | 0 | 1 (OC) | X ⁽³⁾ | 0 ⁵ | 0 | In | Ext. | Digital input | Output compare takes place but does not affect the pin because of the OMn/OLn setting |
| 1 | 1 | 1 | Х | 0 | 0 | Out | Data reg. | Digital output | Output compare takes place but does not affect the pin because of the OMn/OLn setting |
| 1 | 0 | 1 | Х | <> 0 | 0 | Out | OC action | Output compare | Pin readable only if DDR = 0 ⁽⁵⁾ |
| 1 | 1 | 1 | Х | <> 0 | 0 | Out | OC action | Output compare | Pin driven by OC action ⁽⁵⁾ |
| 1 | 0 | 1 | Х | Х | 1 | Out | OC action/ OC3Dn | Output compare (ch 3) | Pin readable only if DDR = 0 ⁶ |
| 1 | 1 | 1 | Х | Х | 1 | Out | OC action/ OC3Dn | Output compare/OC3Dn (ch 3) | Pin driven by channel OC action and OC3D <i>n</i> via channel 3 OC ⁽⁶⁾ |

When DDR sets the pin as input (0), reading the data register returns the state of the pin. When DDR set the pin as output (1), reading the data register returns the content of the data latch. Pin conditions such as rising or falling edges can trigger an input capture on a pin configured as an input.

² OM*n*/OL*n* bit pairs select the output action to be taken as a result of a successful output compare. When OM*n* or OL*n* is set and the IOS*n* bit is set, the pin is an output regardless of the state of the corresponding DDR bit.

³ Setting an OC3M bit configures the corresponding PORTT*n* pin to be output. OC3M*n* makes the PORTT*n* pin an output regardless of the data direction bit when the pin is configured for output compare (IOSn = 1). The OC3Mn bits do not change the state of the PORTTnDDR bits.

⁴ X = Don't care

An output compare overrides the data direction bit of the output compare pin but does not change the state of the data direction bit. Enabling output compare disables data register drive of the pin.

A successful output compare on channel 3 causes an output value determined by OC3Dn value to temporarily override the output compare pin state of any other output compare channel. The next OC action for the specific channel continues to be output to the pin. A channel 3 output compare can cause bits in the output compare 3 data register to transfer to the GPT port data register, depending on the output compare 3 mask register.



25.8 Reset

Reset initializes the GPT registers to a known startup state as described in Section 25.6, "Memory Map and Registers."

25.9 Interrupts

Table 25-24 lists the interrupt requests generated by the timer.

Table 25-24. GPT Interrupt Requests

| Interrupt Request | Flag | Enable Bit |
|-------------------|-------|------------|
| Channel 3 IC/OC | C3F | C3I |
| Channel 2 IC/OC | C2F | C2I |
| Channel 1 IC/OC | C1F | C1I |
| Channel 0 IC/OC | C0F | COI |
| PA overflow | PAOVF | PAOVI |
| PA input | PAIF | PAI |
| Timer overflow | TOF | TOI |

25.9.1 GPT Channel Interrupts (CnF)

A channel flag is set when an input capture or output compare event occurs. Clear a channel flag by writing a 1 to it.

NOTE

When the fast flag clear all bit (GPTSCR1[TFFCA]) is set, an input capture read or an output compare write clears the corresponding channel flag.

When a channel flag is set, it does not inhibit subsequent output compares or input captures

25.9.2 Pulse Accumulator Overflow (PAOVF)

PAOVF is set when the 16-bit pulse accumulator rolls over from 0xFFFF to 0x0000. If the PAOVI bit in GPTPACTL is also set, PAOVF generates an interrupt request. Clear PAOVF by writing a 1 to this flag.

NOTE

When the fast flag clear all enable bit (GPTSCR1[TFFCA]) is set, any access to the pulse accumulator counter registers clears all the flags in GPTPAFLG.

25.9.3 Pulse Accumulator Input (PAIF)

PAIF is set when the selected edge is detected at the PAI pin. In event counter mode, the event edge sets PAIF. In gated time accumulation mode, the trailing edge of the gate signal at the PAI pin sets PAIF. If the

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PAI bit in GPTPACTL is also set, PAIF generates an interrupt request. Clear PAIF by writing a 1 to this flag.

NOTE

When the fast flag clear all enable bit (GPTSCR1[TFFCA]) is set, any access to the pulse accumulator counter registers clears all the flags in GPTPAFLG.

25.9.4 Timer Overflow (TOF)

TOF is set when the GPT counter rolls over from 0xFFFF to 0x0000. If the GPTSCR2[TOI] bit is also set, TOF generates an interrupt request. Clear TOF by writing a 1 to this flag.

NOTE

When the GPT channel 3 registers contain 0xFFFF and TCRE is set, TOF does not get set even though the GPT counter registers go from 0xFFFF to 0x0000.

When the fast flag clear all bit (GPTSCR1[TFFCA]) is set, any access to the GPT counter registers clears GPT flag register 2.

When TOF is set, it does not inhibit future overflow events.



Chapter 26 DMA Timers (DTIM0-DTIM3)

26.1 Introduction

This chapter describes the configuration and operation of the four direct memory access (DMA) timer modules (DTIM0, DTIM1, DTIM2, and DTIM3). These 32-bit timers provide input capture and reference compare capabilities with optional signaling of events using interrupts or DMA triggers. Additionally, programming examples are included.

NOTE

The designation *n* appears throughout this section to refer to registers or signals associated with one of the four identical timer modules: DTIM0, DTIM1, DTIM2, or DTIM3.

26.1.1 Overview

Each DMA timer module has a separate register set for configuration and control. The timers can be configured to operate from the internal bus clock (f_{Sys}) or from an external clocking source using the DTIN*n* signal. If the internal bus clock is selected, it can be divided by 16 or 1. The selected clock source is routed to an 8-bit programmable prescaler that clocks the actual DMA timer counter register (DTCN*n*). Using the DTMR*n*, DTXMR*n*, DTCR*n*, and DTRR*n* registers, the DMA timer may be configured to assert an output signal, generate an interrupt, or request a DMA transfer on a particular event.

NOTE

The GPIO module must be configured to enable the peripheral function of the appropriate pins (refer to Chapter 15, "General Purpose I/O Module") prior to configuring the DMA Timers.



Figure 26-1 is a block diagram of one of the four identical timer modules.

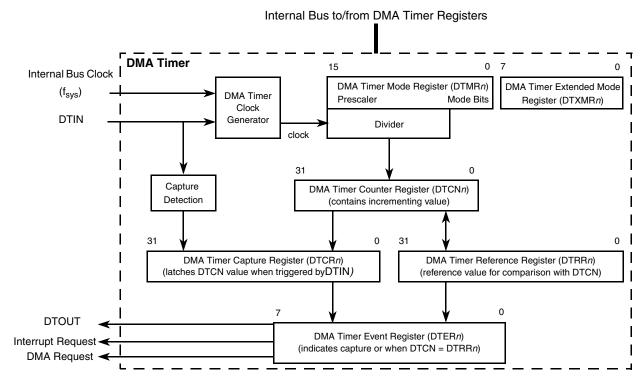


Figure 26-1. DMA Timer Block Diagram

26.1.2 Features

Each DMA timer module has:

- Maximum timeout period of 109,951 seconds at 80 MHz (~31 hours)
- 12.5-ns resolution at 80 MHz
- Programmable sources for the clock input, including external clock
- Programmable prescaler
- Input-capture capability with programmable trigger edge on input pin
- Programmable mode for the output pin on reference compare
- Free run and restart modes
- Programmable interrupt or DMA request on input capture or reference-compare
- Ability to stop the timer from counting when the ColdFire core is halted



DMA Timers (DTIM0-DTIM3)

26.2 Memory Map/Register Definition

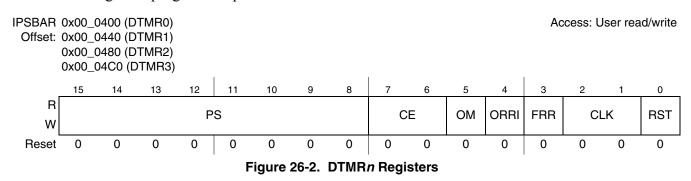
The timer module registers, shown in Table 26-1, can be modified at any time.

Table 26-1. DMA Timer Module Memory Map

| IPSBAR Offset | | | | | |
|--|--|-----------------|--------|-------------|--------------|
| DMA Timer 0 DMA Timer 1 DMA Timer 2 DMA Timer 3 | Register | Width (bits) | Access | Reset Value | Section/Page |
| 0x00_0400 0x00_0440 0x00_0480 0x00_04C0 | DMA Timer <i>n</i> Mode Register (DTMR <i>n</i>) | 16 | R/W | 0x0000 | 26.2.1/26-3 |
| 0x00_0402 0x00_0442 0x00_0482 0x00_04C2 | DMA Timer n Extended Mode Register (DTXMRn) | 8 | R/W | 0x00 | 26.2.2/26-5 |
| 0x00_0403 0x00_0443 0x00_0483 0x00_04C3 | DMA Timer n Event Register (DTERn) | 8 | R/W | 0x00 | 26.2.3/26-5 |
| 0x00_0404 0x00_0444 0x00_0484 0x00_04C4 | DMA Timer n Reference Register (DTRRn) | 32 | R/W | 0xFFFF_FFFF | 26.2.4/26-7 |
| 0x00_0408 0x00_0448 0x00_0488 0x00_04C8 | DMA Timer <i>n</i> Capture Register (DTCR <i>n</i>) | 32 | R/W | 0x0000_0000 | 26.2.5/26-7 |
| 0x00_040C 0x00_044C 0x00_048C 0x00_04CC | DMA Timer n Counter Register (DTCNn) | 32 | R | 0x0000_0000 | 26.2.6/26-8 |

26.2.1 DMA Timer Mode Registers (DTMR*n*)

The DTMR*n* registers program the prescaler and various timer modes.



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Table 26-2. DTMRn Field Descriptions

| Field | Description |
|------------|--|
| 15–8 PS | Prescaler value. Divides the clock input (internal bus clock/(16 or 1) or clock on DTINn) 0x00 1 0xFF 256 |
| 7–6 CE | Capture edge. 00 Disable capture event output. Timer in reference mode. 01 Capture on rising edge only 10 Capture on falling edge only 11 Capture on any edge |
| 5 OM | Output mode. 0 Active-low pulse for one internal bus clock cycle (12.5-ns resolution at 80 MHz) 1 Toggle output. |
| 4 ORRI | Output reference request, interrupt enable. If ORRI is set when DTERn[REF] is set, a DMA request or an interrupt occurs, depending on the value of DTXMRn[DMAEN] (DMA request if set, interrupt if cleared). 0 Disable DMA request or interrupt for reference reached (does not affect DMA request or interrupt on capture function). 1 Enable DMA request or interrupt upon reaching the reference value. |
| 3 FRR | Free run/restart 0 Free run. Timer count continues incrementing after reaching the reference value. 1 Restart. Timer count is reset immediately after reaching the reference value. |
| 2–1 CLK | Input clock source for the timer. Avoid setting CLK when RST is already set. Doing so causes CLK to zero (stop counting). 00 Stop count 01 Internal bus clock divided by 1 10 Internal bus clock divided by 16. This clock source is not synchronized with the timer; therefore, successive time-outs may vary slightly. 11 DTINn pin (falling edge) |
| 0 RST | Reset timer. Performs a software timer reset similar to an external reset, although other register values can be written while RST is cleared. A transition of RST from 1 to 0 resets register values. The timer counter is not clocked unless the timer is enabled. 0 Reset timer (software reset) 1 Enable timer |



DMA Timers (DTIM0-DTIM3)

DMA Timer Extended Mode Registers (DTXMRn) 26.2.2

The DTXMR*n* registers program DMA request and increment modes for the timers.

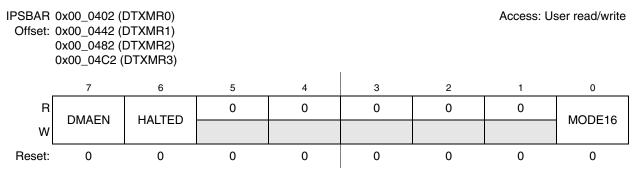


Figure 26-3. DTXMRn Registers

Table 26-3. DTXMRn Field Descriptions

| Field | Description |
|-------------|--|
| 7 DMAEN | DMA request. Enables DMA request output on counter reference match or capture edge event. 0 DMA request disabled 1 DMA request enabled |
| | Controls the counter when the core is halted. This allows debug mode to be entered without timer interrupts affecting the debug flow. 0 Timer function is not affected by core halt. 1 Timer stops counting while the core is halted. Note: This bit is only applicable in reference compare mode, see Section 26.3.3, "Reference Compare." |
| 5–1 | Reserved, must be cleared. |
| 0 MODE16 | Selects the increment mode for the timer. Setting MODE16 is intended to exercise the upper bits of the 32-bit timer in diagnostic software without requiring the timer to count through its entire dynamic range. When set, the counter's upper 16 bits mirror its lower 16 bits. All 32 bits of the counter remain compared to the reference value. 0 Increment timer by 1 1 Increment timer by 65,537 |

DMA Timer Event Registers (DTERn) 26.2.3

DTERn, shown in Figure 26-4, reports capture or reference events by setting DTERn[CAP] or DTERn[REF]. This reporting happens regardless of the corresponding DMA request or interrupt enable values, DTXMRn[DMAEN] and DTMRn[ORRI,CE].

Writing a 1 to DTERn[REF] or DTERn[CAP] clears it (writing a 0 does not affect bit value); both bits can be cleared at the same time. If configured to generate an interrupt request, clear REF and CAP early in the interrupt service routine so the timer module can negate the interrupt request signal to the interrupt controller. If configured to generate a DMA request, processing of the DMA data transfer automatically clears the REF and CAP flags via the internal DMA ACK signal.

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Field

7-2

Reserved, must be cleared.

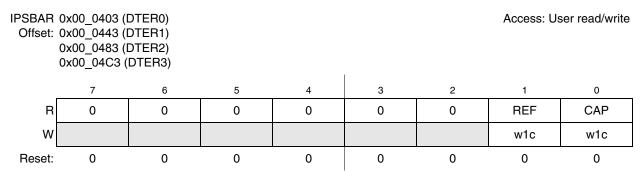


Figure 26-4. DTERn Registers

Table 26-4. DTERn Field Descriptions

Description

| 1 REF | Output reference event. The counter value (DTCNn) equals DTRRn. Writing a 1 to REF clears the event condition. Writing a 0 has no effect. | | | | | |
|----------|---|-----|-------------|---------------|----------------------------|---|
| | | REF | DTMRn[ORRI] | DTXMRn[DMAEN] | | 1 |
| | | 0 | Х | Х | No event | |
| | | 1 | 0 | 0 | No request asserted | 1 |
| | | 1 | 0 | 1 | No request asserted | |
| | | 1 | 1 | 0 | Interrupt request asserted | |
| | | 1 | 1 | 1 | DMA request asserted | |

O Capture event. The counter value has been latched into DTCR*n*. Writing a 1 to CAP clears the event condition. Writing a 0 has no effect.

| CAP | DTMRn[CE] | DTXMR <i>n</i> [DMAEN] | |
|-----|-----------|---------------------------|---|
| 0 | XX | Х | No event |
| 1 | 00 | 0 | Disable capture event output |
| 1 | 00 | 1 | Disable capture event output |
| 1 | 01 | 0 | Capture on rising edge and trigger interrupt |
| 1 | 01 | 1 | Capture on rising edge and trigger DMA |
| 1 | 10 | 0 | Capture on falling edge and trigger interrupt |
| 1 | 10 | 1 | Capture on falling edge and trigger DMA |
| 1 | 11 | 0 | Capture on any edge and trigger interrupt |
| 1 | 11 | 1 | Capture on any edge and trigger DMA |



DMA Timers (DTIM0-DTIM3)

26.2.4 DMA Timer Reference Registers (DTRR*n*)

As part of the output-compare function, each DTRRn contains the reference value compared with the respective free-running timer counter (DTCNn).

The reference value is matched when DTCNn equals DTRRn. The prescaler indicates that DTCNn should be incremented again. Therefore, the reference register is matched after DTRRn + 1 time intervals.

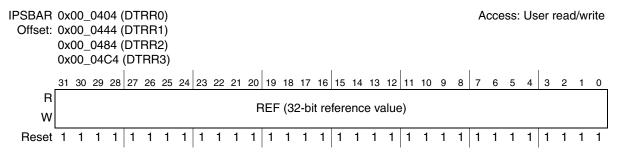


Figure 26-5. DTRR*n* Registers

Table 26-5. DTRRn Field Descriptions

| Field | Description | |
|-------|---|--|
| | Reference value compared with the respective free-running timer counter (DTCNn) as part of the output-compare function. | |

26.2.5 DMA Timer Capture Registers (DTCR*n*)

Each DTCRn latches the corresponding DTCNn value during a capture operation when an edge occurs on DTINn, as programmed in DTMRn. The internal bus clock is assumed to be the clock source. DTINn cannot simultaneously function as a clocking source and as an input capture pin. Indeterminate operation results if DTINn is set as the clock source when the input capture mode is used.

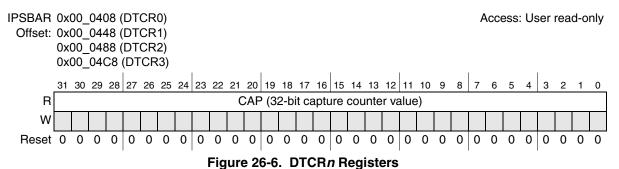


Table 26-6. DTCRn Field Descriptions

| Field | Description |
|-------|--|
| | Captures the corresponding DTCN n value during a capture operation when an edge occurs on DTIN n , as programmed in DTMR n . |

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26.2.6 DMA Timer Counters (DTCNn)

The current value of the 32-bit timer counter can be read at anytime without affecting counting. Writes to DTCN*n* clear the timer counter. The timer counter increments on the clock source rising edge (internal bus clock divided by 1, internal bus clock divided by 16, or DTIN*n*).

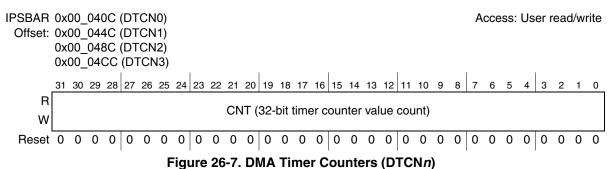


Table 26-7. DTCNn Field Descriptions

| Field | Description |
|-------------|---|
| 31–0 CNT | Timer counter. Can be read at anytime without affecting counting and any write to this field clears it. |

26.3 Functional Description

26.3.1 Prescaler

The prescaler clock input is selected from the internal bus clock (f_{sys} divided by 1 or 16) or from the corresponding timer input, DTINn. DTINn is synchronized to the internal bus clock, and the synchronization delay is between two and three internal bus clocks. The corresponding DTMRn[CLK] selects the clock input source. A programmable prescaler divides the clock input by values from 1 to 256. The prescaler output is an input to the 32-bit counter, DTCNn.

26.3.2 Capture Mode

Each DMA timer has a 32-bit timer capture register (DTCR*n*) that latches the counter value when the corresponding input capture edge detector senses a defined DTIN*n* transition. The capture edge bits (DTMR*n*[CE]) select the type of transition that triggers the capture and sets the timer event register capture event bit, DTER*n*[CAP]. If DTER*n*[CAP] and DTXMR*n*[DMAEN] are set, a DMA request is asserted. If DTER*n*[CAP] is set and DTXMR*n*[DMAEN] is cleared, an interrupt is asserted.

26.3.3 Reference Compare

Each DMA timer can be configured to count up to a reference value. If the reference value is met, DTER*n*[REF] is set.

- If DTMR*n*[ORRI] is set and DTXMR*n*[DMAEN] is cleared, an interrupt is asserted.
- If DTMRn[ORRI] and DTXMRn[DMAEN] are set, a DMA request is asserted.

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DMA Timers (DTIM0-DTIM3)

If the free run/restart bit (DTMRn[FRR]) is set, a new count starts. If it is clear, the timer keeps running.

26.3.4 Output Mode

When a timer reaches the reference value selected by DTRR, it can send an output signal on DTOUTn. DTOUTn can be an active-low pulse or a toggle of the current output, as selected by the DTMRn[OM] bit.

26.4 Initialization/Application Information

The general-purpose timer modules typically, but not necessarily, follow this program order:

- The DTMR*n* and DTXMR*n* registers are configured for the desired function and behavior.
 - Count and compare to a reference value stored in the DTRR*n* register
 - Capture the timer value on an edge detected on DTINn
 - Configure DTOUT*n* output mode
 - Increment counter by 1 or by 65,537 (16-bit mode)
 - Enable/disable interrupt or DMA request on counter reference match or capture edge
- The DTMR*n*[CLK] register is configured to select the clock source to be routed to the prescaler.
 - Internal bus clock (can be divided by 1 or 16)
 - DTINn, the maximum value of DTINn is 1/5 of the internal bus clock, as described in the device's electrical characteristics

NOTE

DTIN*n* may not be configured as a clock source when the timer capture mode is selected or indeterminate operation results.

- The 8-bit DTMR*n*[PS] prescaler value is set.
- Using DTMRn[RST], counter is cleared and started.
- Timer events are managed with an interrupt service routine, a DMA request, or by a software polling mechanism.

26.4.1 Code Example

The following code provides an example of how to initialize and use DMA Timer0 for counting time-out periods.

```
DTMR0 EQU IPSBARx+0x400 ;Timer0 mode register
DTMR1 EQU IPSBARx+0x440 ;Timer1 mode register
DTRR0 EQU IPSBARx+0x404 ;Timer0 reference register
DTRR1 EQU IPSBARx+0x444 ;Timer1 reference register
DTCR0 EQU IPSBARx+0x448 ;Timer0 capture register
DTCR1 EQU IPSBARx+0x448 ;Timer1 capture register
DTCN0 EQU IPSBARx+0x440 ;Timer0 counter register
DTCN1 EQU IPSBARx+0x440 ;Timer1 counter register
DTCN1 EQU IPSBARx+0x440 ;Timer1 counter register
DTER0 EQU IPSBARx+0x443 ;Timer0 event register
DTER1 EQU IPSBARx+0x443 ;Timer1 event register

* TMR0 is defined as: *
*[PS] = 0xFF, divide clock by 256
```

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```
*[CE] = 00
                 disable capture event output
*[OM] = 0
                 output=active-low pulse
*[ORRI] = 0,
               disable ref. match output
*[FRR] = 1,
               restart mode enabled
*[CLK] = 10,
                 internal bus clock/16
*[RST] = 0,
                 timer0 disabled
        move.w #0xFF0C,D0
        move.w D0, TMR0
        move.1 #0x0000,D0; writing to the timer counter with any
        move.l DO, TCNO ; value resets it to zero
        move.1 #0xAFAF, DO ; set the timer0 reference to be
        move.1 #D0, TRR0 ; defined as 0xAFAF
```

The simple example below uses Timer0 to count time-out loops. A time-out occurs when the reference value, 0xAFAF, is reached.

```
timer0 ex
        clr.1 DO
        clr.1 D1
        clr.1 D2
        move.1 #0x0000,D0
        move.1 D0, TCN0
                                    ; reset the counter to 0x0000
        move.b \#0x03,D0
                                    ;writing ones to TERO[REF, CAP]
        move.b D0, TER0
                                   ; clears the event flags
        move.w TMR0,D0
                                   ; save the contents of TMRO while setting
        bset #0,D0
                                    ; the 0 bit. This enables timer 0 and starts counting
        move.w D0, TMR0
                                    ; load the value back into the register, setting TMRO[RST]
TO LOOP
        move.b TER0,D1
                                    ;load TERO and see if
        btst #1,D1
                                    ;TER0[REF] has been set
        beq T0 LOOP
        addi.1 #1,D2
                                    ;Increment D2
        cmp.1 #5,D2
                                    ;Did D2 reach 5? (i.e. timer ref has timed)
        beq T0 FINISH
                                   ; If so, end timer0 example. Otherwise jump back.
        move.b \#0x02,D0
                                    ; writing one to TERO[REF] clears the event flag
        move.b D0, TER0
        jmp T0 LOOP
TO FINISH
                                    ; End processing. Example is finished
        HALT
```

26.4.2 Calculating Time-Out Values

Equation 26-1 determines time-out periods for various reference values:

```
Timeout period = (1/\text{clock frequency}) \times (1 \text{ or } 16) \times (DTMRn[PS] + 1) \times (DTRRn[REF] + 1) Eqn. 26-1
```

When calculating time-out periods, add one to the prescaler to simplify calculating, because DTMRn[PS] equal to 0x00 yields a prescaler of one, and DTMRn[PS] equal to 0xFF yields a prescaler of 256.

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DMA Timers (DTIM0-DTIM3)

For example, if a 80-MHz timer clock is divided by 16, DTMRn[PS] equals 0x7F, and the timer is referenced at 0x1312C (78,124 decimal), the time-out period is:

Timeout period =
$$\frac{1}{80 \times 10^6} \times 16 \times (127 + 1) \times (78124 + 1) = 2.00 \text{ seconds}$$
 Eqn. 26-2

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Chapter 27 Queued Serial Peripheral Interface (QSPI)

27.1 Introduction

This chapter describes the queued serial peripheral interface (QSPI) module.

27.1.1 Block Diagram

Figure 27-1 illustrates the QSPI module.

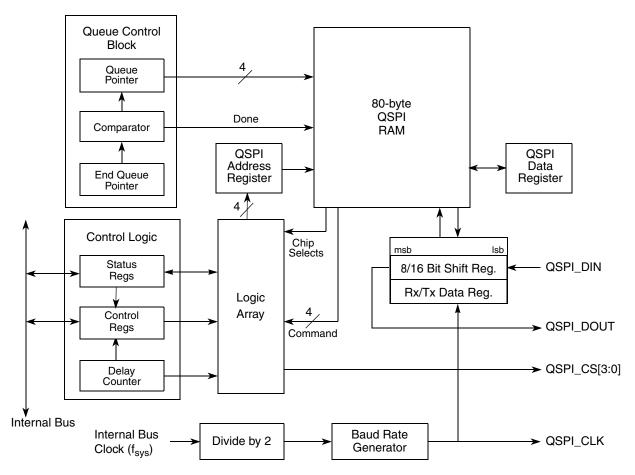


Figure 27-1. QSPI Block Diagram



Queued Serial Peripheral Interface (QSPI)

27.1.2 Overview

The queued serial peripheral interface module provides a serial peripheral interface with queued transfer capability. It allows users to queue up to 16 transfers at once, eliminating CPU intervention between transfers. Transfer RAM in the QSPI is indirectly accessible using address and data registers.

NOTE

The GPIO module must be configured to enable the peripheral function of the appropriate pins (refer to Chapter 15, "General Purpose I/O Module") prior to configuring the QSPI module.

27.1.3 Features

Features include:

- Programmable queue to support up to 16 transfers without user intervention
 - 80 bytes of data storage provided
- Supports transfer sizes of 8 to 16 bits in 1-bit increments
- Four peripheral chip-select lines for control of up to 7 devices (All chip selects may not be available on all devices. See Chapter 2, "Signal Descriptions," for details on which chip-selects are pinned-out.)
- Baud rates from 156.9 Kbps to 20 Mbps at 80 MHz internal bus frequency
- Programmable delays before and after transfers
- Programmable QSPI clock phase and polarity
- Supports wraparound mode for continuous transfers

27.1.4 Modes of Operation

Because the QSPI module only operates in master mode, the master bit in the QSPI mode register (QMR[MSTR]) must be set for the QSPI to function properly. If the master bit is not set, QSPI activity is indeterminate. The QSPI can initiate serial transfers but cannot respond to transfers initiated by other QSPI masters.

27.2 External Signal Description

The module provides access to as many as 7 devices with a total of six signals: QSPI_DOUT, QSPI_DIN, QSPI_CLK, QSPI_CS[3, 2, 0].

Peripheral chip-select signals, QSPI_CSn, are used to select an external device as the source or destination for serial data transfer. Signals are asserted when a command in the queue is executed. More than one chip-select signal can be asserted simultaneously.

Although QSPI_CSn signals function as simple chip selects in most applications, up to 7 devices can be selected by decoding them with an external 3-to-8 decoder.



| Signal Name | Hi-Z or Actively Driven | Function |
|------------------------------------|-------------------------|------------------------------|
| Data output (QSPI_DOUT) | Configurable | Serial data output from QSPI |
| Data input (QSPI_DIN) | N/A | Serial data input to QSPI |
| Serial clock (QSPI_CLK) | Actively driven | Clock output from QSPI |
| Peripheral chip selects (QSPI_CSn) | Actively driven | Peripheral selects from QSPI |

27.3 Memory Map/Register Definition

Table 27-2 is the QSPI register memory map. Reading reserved locations returns zeros.

Table 27-2. QSPI Memory Map

| IPSBAR Offset ¹ | Register | Width (bits) | Access | Reset Value | Section/Page |
|-------------------------------|-------------------------------|-----------------|------------------|-------------|--------------|
| 0x00_0340 | QSPI Mode Register (QMR) | 16 | R/W | 0x0104 | 27.3.1/27-3 |
| 0x00_0344 | QSPI Delay Register (QDLYR) | 16 | R/W | 0x0404 | 27.3.2/27-5 |
| 0x00_0348 | QSPI Wrap Register (QWR) | 16 | R/W ² | 0x0000 | 27.3.3/27-6 |
| 0x00_034C | QSPI Interrupt Register (QIR) | 16 | R/W ² | 0x0000 | 27.3.4/27-6 |
| 0x00_0350 | QSPI Address Register (QAR) | 16 | R/W ² | 0x0000 | 27.3.5/27-7 |
| 0x00_0354 | QSPI Data Register (QDR) | 16 | R/W | 0x0000 | 27.3.6/27-8 |

Addresses not assigned to a register and undefined register bits are reserved for expansion.

27.3.1 QSPI Mode Register (QMR)

The QMR, shown in Figure 27-2, determines the basic operating modes of the QSPI module. Parameters such as QSPI_CLK polarity and phase, baud rate, master mode operation, and transfer size are determined by this register.

NOTE

Because the QSPI does not operate in slave mode, the master mode enable bit (QMR[MSTR]) must be set for the QSPI module to operate correctly.

NOTE

Because of the implementation of the QSPI module on this device, CPOL and CPHA may be modified only once, typically during software initialization. Changing CPOL and CPHA during operation is not supported.

² See the register description for special cases. Some bits may be read- or write-only.



Queued Serial Peripheral Interface (QSPI)

IPSBAR 0x00_0340 (QMR) Access: User read/write Offset: 12 10 14 13 11 9 0 **BITS** CPOL CPHA BAUD 0 0 0 0 0 0 0 0 0 0 Reset 0

Figure 27-2. QSPI Mode Register (QMR)

Table 27-3. QMR Field Descriptions

| Field | Description | | | |
|---------------|---|-------------------|--------------------------|-----------------|
| 15 MSTR | Master mode enable. 0 Reserved, do not use. 1 The QSPI is in master mode. Must be set for the QSPI module to operate correctly. | | | |
| 14 | Reserved, must be cleared. | | | |
| 13–10 BITS | Transfer size. Determines the number | of bits to be tra | ansferred for each entry | y in the queue. |
| Dire | | BITS | Bits per Transfer | |
| | | 0000 | 16 | |
| | | 0001–0111 | Reserved | |
| | | 1000 | 8 | |
| | | 1001 | 9 | |
| | | 1010 | 10 | |
| | | 1011 | 11 | |
| | | 1100 | 12 | |
| | | 1101 | 13 | |
| | | 1110 | 14 | |
| | | 1111 | 15 | |
| 9 CPOL | Clock polarity. Defines the clock polarity of QSPI_CLK. 0 The inactive state value of QSPI_CLK is logic level 0. 1 The inactive state value of QSPI_CLK is logic level 1. | | | |
| 8 CPHA | Clock phase. Defines the QSPI_CLK clock-phase. 0 Data captured on the leading edge of QSPI_CLK and changed on the following edge of QSPI_CLK. 1 Data changed on the leading edge of QSPI_CLK and captured on the following edge of QSPI_CLK. | | | |
| 7–0 BAUD | Baud rate divider. The baud rate is selected by writing a value in the range 2–255. A value of zero disables the QSPI. A value of 1 is an invalid setting. The desired QSPI_CLK baud rate is related to the internal bus clock and QMR[BAUD] by the following expression: QMR[BAUD] = f _{sys/} / (2 × [desired QSPI_CLK baud rate]) | | | |

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Figure 27-3 shows an example of a QSPI clocking and data transfer.

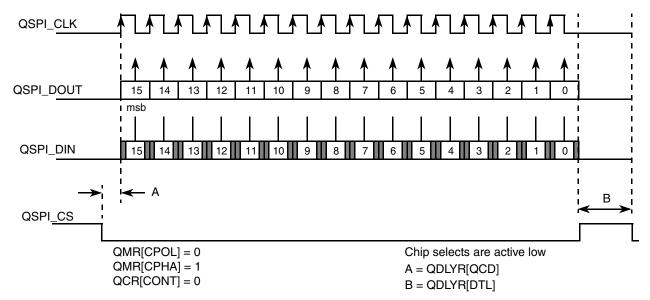


Figure 27-3. QSPI Clocking and Data Transfer Example

QSPI Delay Register (QDLYR) 27.3.2

The QDLYR is used to initiate master mode transfers and to set various delay parameters.

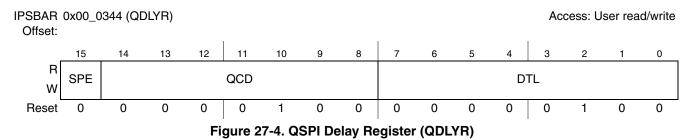


Table 27-4. QDLYR Field Descriptions

| Field | Description |
|-------------|--|
| 15 SPE | QSPI enable. When set, the QSPI initiates transfers in master mode by executing commands in the command RAM. The QSPI clears this bit automatically when a transfer completes. The user can also clear this bit to abort transfer unless QIR[ABRTL] is set. The recommended method for aborting transfers is to set QWR[HALT]. |
| 14–8 QCD | QSPI_CLK delay. When the DSCK bit in the command RAM is set this field determines the length of the delay from assertion of the chip selects to valid QSPI_CLK transition. See Section 27.4.3, "Transfer Delays" for information on setting this bit field. |
| 7–0 DTL | Delay after transfer. When the DT bit in the command RAM is set this field determines the length of delay after the serial transfer. |

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Queued Serial Peripheral Interface (QSPI)

27.3.3 QSPI Wrap Register (QWR)

The QSPI wrap register provides halt transfer control, wraparound settings, and queue pointer locations.

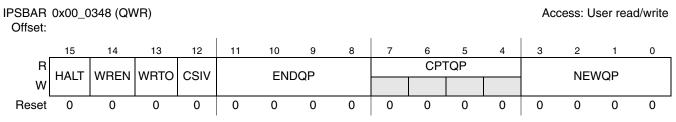


Figure 27-5. QSPI Wrap Register (QWR)

Table 27-5. QWR Field Descriptions

| Field | Description |
|---------------|---|
| 15 HALT | Halt transfers. Assertion of this bit causes the QSPI to stop execution of commands after it has completed execution of the current command. |
| 14 WREN | Wraparound enable. Enables wraparound mode. 0 Execution stops after executing the command pointed to by QWR[ENDQP]. 1 After executing command pointed to by QWR[ENDQP], wrap back to entry zero, or the entry pointed to by QWR[NEWQP] and continue execution. |
| 13 WRTO | Wraparound location. Determines where the QSPI wraps to in wraparound mode. 0 Wrap to RAM entry zero. 1 Wrap to RAM entry pointed to by QWR[NEWQP]. |
| 12 CSIV | QSPI_CS inactive level. QSPI chip select outputs return to zero when not driven from the value in the current command RAM entry during a transfer (that is, inactive state is 0, chip selects are active high). QSPI chip select outputs return to one when not driven from the value in the current command RAM entry during a transfer (that is, inactive state is 1, chip selects are active low). |
| 11–8 ENDQP | End of queue pointer. Points to the RAM entry that contains the last transfer description in the queue. |
| 7–4 CPTQP | Completed queue entry pointer. Points to the RAM entry that contains the last command to have been completed. This field is read only. |
| 3–0 NEWQP | Start of queue pointer. This 4-bit field points to the first entry in the RAM to be executed on initiating a transfer. |

27.3.4 QSPI Interrupt Register (QIR)

The QIR contains QSPI interrupt enables and status flags.

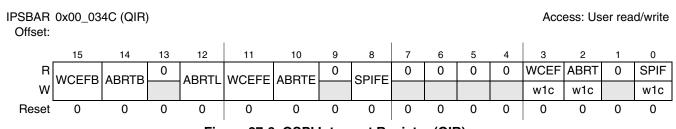


Figure 27-6. QSPI Interrupt Register (QIR)

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Table 27-6. QIR Field Descriptions

| Field | Description |
|-------------|--|
| 15 WCEFB | Write collision access error enable. A write collision occurs during a data transfer when the RAM entry containing the current command is written to by the CPU with the QDR. When this bit is asserted, the write access to QDR results in an access error. |
| 14 ABRTB | Abort access error enable. An abort occurs when QDLYR[SPE] is cleared during a transfer. When set, an attempt to clear QDLYR[SPE] during a transfer results in an access error. |
| 13 | Reserved, must be cleared. |
| 12 ABRTL | Abort lock-out. When set, QDLYR[SPE] cannot be cleared by writing to the QDLYR. QDLYR[SPE] is only cleared by the QSPI when a transfer completes. |
| 11 WCEFE | Write collision (WCEF) interrupt enable. 0 Write collision interrupt disabled 1 Write collision interrupt enabled |
| 10 ABRTE | Abort (ABRT) interrupt enable. 0 Abort interrupt disabled 1 Abort interrupt enabled |
| 9 | Reserved, must be cleared. |
| 8 SPIFE | QSPI finished (SPIF) interrupt enable. 0 SPIF interrupt disabled 1 SPIF interrupt enabled |
| 7–4 | Reserved, must be cleared. |
| 3 WCEF | Write collision error flag. Indicates that an attempt has been made to write to the RAM entry that is currently being executed. Writing a 1 to this bit (w1c) clears it and writing 0 has no effect. |
| 2 ABRT | Abort flag. Indicates that QDLYR[SPE] has been cleared by the user writing to the QDLYR rather than by completion of the command queue by the QSPI. Writing a 1 to this bit (w1c) clears it and writing 0 has no effect. |
| 1 | Reserved, must be cleared. |
| 0 SPIF | QSPI finished flag. Asserted when the QSPI has completed all the commands in the queue. Set on completion of the command pointed to by QWR[ENDQP], and on completion of the current command after assertion of QWR[HALT]. In wraparound mode, this bit is set every time the command pointed to by QWR[ENDQP] is completed. Writing a 1 to this bit (w1c) clears it and writing 0 has no effect. |

27.3.5 QSPI Address Register (QAR)

The QAR is used to specify the location in the QSPI RAM that read and write operations affect. As shown in Section 27.4.1, "QSPI RAM", the transmit RAM is located at addresses 0x0 to 0xF, the receive RAM is located at 0x10 to 0x1F, and the command RAM is located at 0x20 to 0x2F. (These addresses refer to the QSPI RAM space, not the device memory map.)

NOTE

A read or write to the QSPI RAM causes QAR to increment. However, the QAR does not wrap after the last queue entry within each section of the RAM. The application software must manage address range errors.



Queued Serial Peripheral Interface (QSPI)

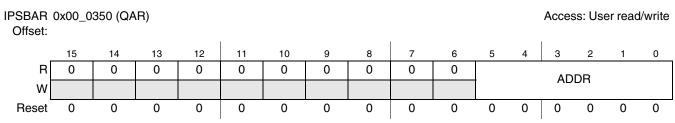


Figure 27-7. QSPI Address Register (QAR)

Table 27-7. QAR Field Descriptions

| Field | Description |
|-------------|---|
| 15–6 | Reserved, must be cleared. |
| 5–0 ADDR | Address used to read/write the QSPI RAM. Ranges are as follows: 0x00–0x0F Transmit RAM 0x10–0x1F Receive RAM 0x20–0x2F Command RAM 0x30–0x3F Reserved |

27.3.6 QSPI Data Register (QDR)

The QDR is used to access QSPI RAM indirectly. The CPU reads and writes all data from and to the QSPI RAM through this register.

A write to QDR causes data to be written to the RAM entry specified by QAR[ADDR]. This also causes the value in QAR to increment. Correspondingly, a read at QDR returns the data in the RAM at the address specified by QAR[ADDR]. This also causes QAR to increment. A read access requires a single wait state.

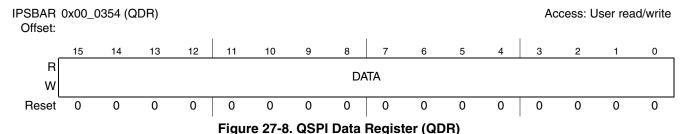


Table 27-8. QDR Field Descriptions

| Field | Description |
|--------------|--|
| 15–0 DATA | A write to this field causes data to be written to the QSPI RAM entry specified by QAR[ADDR]. Similarly, a read of this field returns the data in the QSPI RAM at the address specified by QAR[ADDR]. During command RAM accesses (QAR[ADDR] = 0x20–0x2F), only the most significant byte of this field is used. |

27.3.7 Command RAM Registers (QCR0-QCR15)

The command RAM is accessed using the upper byte of the QDR; the QSPI cannot modify information in command RAM. There are 16 bytes in the command RAM. Each byte is divided into two fields. The chip select field enables external peripherals for transfer. The command field provides transfer operations.

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NOTE

The command RAM is accessed only using the most significant byte of QDR and indirect addressing based on QAR[ADDR].

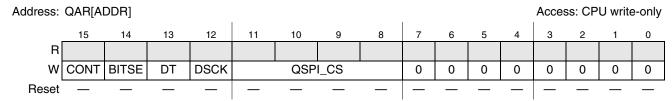


Figure 27-9. Command RAM Registers (QCR0-QCR15)

Table 27-9. QCR0-QCR15 Field Descriptions

| Field | Description |
|-----------------|--|
| 15 CONT | Continuous. O Chip selects return to inactive level defined by QWR[CSIV] when a single word transfer is complete. Chip selects return to inactive level defined by QWR[CSIV] only after the transfer of the queue entries (max of 16 words). Note: To keep the chip selects asserted for transfers beyond 16 words, the QWR[CSIV] bit must be set to control the level that the chip selects return to after the first transfer. |
| 14 BITSE | Bits per transfer enable. 0 Eight bits 1 Number of bits set in QMR[BITS] |
| 13 DT | Delay after transfer enable. 0 Default reset value. 1 The QSPI provides a variable delay at the end of serial transfer to facilitate interfacing with peripherals that have a latency requirement. The delay between transfers is determined by QDLYR[DTL]. |
| 12 DSCK | Chip select to QSPI_CLK delay enable. 0 Chip select valid to QSPI_CLK transition is one-half QSPI_CLK period. 1 QDLYR[QCD] specifies the delay from QSPI_CS valid to QSPI_CLK. |
| 11–8 QSPI_CS | Peripheral chip selects. Used to select an external device for serial data transfer. More than one chip select may be active at once, and more than one device can be connected to each chip select. Bits 11-8 map directly to the corresponding QSPI_CSn pins. If more than four chip selects are needed, then an external demultiplexor can be used with the QSPI_CSn pins. 0 Enable chip select. 1 Mask chip select. Note: Not all chip selects may be available on all device packages. See Chapter 2, "Signal Descriptions," for details on which chip selects are pinned-out. |
| 7–0 | Reserved, must be cleared. |

27.4 Functional Description

The QSPI uses a dedicated 80-byte block of static RAM accessible to the module and CPU to perform queued operations. The RAM is divided into three segments:

- 16 command control bytes (command RAM)
- 32 transmit data bytes (transmit data RAM)



Queued Serial Peripheral Interface (QSPI)

• 32 receive data bytes (receive data RAM)

The RAM is organized so that 1 byte of command control data, 1 word of transmit data, and 1 word of receive data comprise 1 of the 16 queue entries (0x0-0xF).

NOTE

Throughout ColdFire documentation, the term word is used to designate a 16-bit data unit. The only exceptions to this appear in discussions of serial communication modules such as QSPI that support variable-length data units. To simplify these discussions, the functional unit is referred to as a word regardless of length.

The user initiates QSPI operation by loading a queue of commands in command RAM, writing transmit data into transmit RAM, and then enabling the QSPI data transfer. The QSPI executes the queued commands and sets the completion flag in the QSPI interrupt register (QIR[SPIF]) to signal their completion. As another option, QIR[SPIFE] can be enabled to generate an interrupt.

The QSPI uses four queue pointers. The user can access three of them through fields in QSPI wrap register (QWR):

- New queue pointer (QWR[NEWQP])—points to the first command in the queue
- Internal queue pointer—points to the command currently being executed
- Completed queue pointer (QWR[CPTQP])—points to the last command executed
- End queue pointer (QWR[ENDQP]) —points to the final command in the queue

The internal pointer is initialized to the same value as QWR[NEWQP]. During normal operation, the following sequence repeats:

- 1. The command pointed to by the internal pointer is executed.
- 2. The value in the internal pointer is copied into QWR[CPTQP].
- 3. The internal pointer is incremented.

Execution continues at the internal pointer address unless the QWR[NEWQP] value is changed. After each command is executed, QWR[ENDQP] and QWR[CPTQP] are compared. When a match occurs, QIR[SPIF] is set and the QSPI stops unless wraparound mode is enabled. Setting QWR[WREN] enables wraparound mode.

QWR[NEWQP] is cleared at reset. When the QSPI is enabled, execution begins at address 0x0 unless another value has been written into QWR[NEWQP]. QWR[ENDQP] is cleared at reset but is changed to show the last queue entry before the QSPI is enabled. QWR[NEWQP] and QWR[ENDQP] can be written at any time. When the QWR[NEWQP] value changes, the internal pointer value also changes unless a transfer is in progress, in which case the transfer completes normally. Leaving QWR[NEWQP] and QWR[ENDQP] set to 0x0 causes a single transfer to occur when the QSPI is enabled.

Data is transferred relative to QSPI_CLK, which can be generated in any one of four combinations of phase and polarity using QMR[CPHA,CPOL]. Data is transferred with the most significant bit (msb) first. The number of bits transferred defaults to 8, but can be set to any value between 8 and 16 by writing a value into the BITSE field of the command RAM (QCR[BITSE]).



27.4.1 QSPI RAM

The QSPI contains an 80-byte block of static RAM that can be accessed by the user and the QSPI. This RAM does not appear in the device memory map, because it can only be accessed by the user indirectly through the QSPI address register (QAR) and the QSPI data register (QDR). The RAM is divided into three segments with 16 addresses each:

- Receive data RAM—the initial destination for all incoming data
- Transmit data RAM—a buffer for all out-bound data
- Command RAM—where commands are loaded

The transmit data and command RAM are user write-only. The receive RAM is user read-only. Figure 27-10 shows the RAM configuration. The RAM contents are undefined immediately after a reset.

The command and data RAM in the QSPI are indirectly accessible with QDR and QAR as 48 separate locations that comprise 16 words of transmit data, 16 words of receive data, and 16 bytes of commands.

A write to QDR causes data to be written to the RAM entry specified by QAR[ADDR] and causes the value in QAR to increment. Correspondingly, a read from QDR returns the data in the RAM at the address specified by QAR[ADDR]. This also causes QAR to increment. A read access requires a single wait state.

| Relative Address | Register | Function |
|---------------------|----------|--------------|
| 0x00 | QTR0 | Transmit RAM |
| 0x01 | QTR1 | |
| | | 16 bits wide |
| 0x0F | QTR15 | |

| 0x10 | QRR0 | Receive RAM |
|------|-------|--------------|
| 0x11 | QRR1 | |
| | | 16 bits wide |
| 0x1F | QRR15 | |

| 0x20 | QCR0 | Command RAM |
|------|-------|-------------|
| 0x21 | QCR1 | |
| | | 8 bits wide |
| 0x2F | QCR15 | |

Figure 27-10. QSPI RAM Model

27.4.1.1 Receive RAM

Data received by the QSPI is stored in the receive RAM segment located at 0x10 to 0x1F in the QSPI RAM space. Read this segment to retrieve data from the QSPI. Data words with less than 16 bits are stored in

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the least significant bits of the RAM. Unused bits in a receive queue entry are set to zero upon completion of the individual queue entry. Receive RAM is not writeable.

QWR[CPTQP] shows which queue entries have been executed. The user can query this field to determine which locations in receive RAM contain valid data.

27.4.1.2 Transmit RAM

Data to be transmitted by the QSPI is stored in the transmit RAM segment located at addresses 0x0 to 0xF. The user normally writes 1 word into this segment for each queue command to be executed. The user cannot read data in the transmit RAM.

Outbound data must be written to transmit RAM in a right-justified format. The unused bits are ignored. The QSPI copies the data to its data serializer (shift register) for transmission. The data is transmitted most significant bit first and remains in transmit RAM until overwritten by the user.

27.4.1.3 Command RAM

The CPU writes one byte of control information to this segment for each QSPI command to be executed. Command RAM, referred to as QCR0–15, is write-only memory from a user's perspective.

Command RAM consists of 16 bytes, each divided into two fields. The peripheral chip select field controls the QSPI_CS signal levels for the transfer. The command control field provides transfer options.

A maximum of 16 commands can be in the queue. Queue execution proceeds from the address in QWR[NEWQP] through the address in QWR[ENDQP].

The QSPI executes a queue of commands defined by the control bits in each command RAM entry that sequence the following actions:

- Chip-select pins are activated.
- Data is transmitted from the transmit RAM and received into the receive RAM.
- The synchronous transfer clock QSPI CLK is generated.

Before any data transfers begin, control data must be written to the command RAM, and any out-bound data must be written to the transmit RAM. Also, the queue pointers must be initialized to the first and last entries in the command queue.

Data transfer is synchronized with the internally generated QSPI_CLK, whose phase and polarity are controlled by QMR[CPHA] and QMR[CPOL]. These control bits determine which QSPI_CLK edge is used to drive outgoing data and to latch incoming data.

27.4.2 Baud Rate Selection

The maximum QSPI clock frequency is one-fourth the clock frequency of the internal bus clock (f_{sys}). Baud rate is selected by writing a value from 2–255 into QMR[BAUD]. The QSPI uses a prescaler to derive the QSPI_CLK rate from the internal bus clock divided by two. Table 27-10 shows the QSPI_CLK frequency as a function of internal bus clock and baud rate.

A baud rate value of zero turns off the QSPI CLK.



The desired QSPI_CLK baud rate is related to the internal bus clock and QMR[BAUD] by the following expression:

QMR[BAUD] =
$$\frac{f_{sys}}{2 \times [desired QSPI CLK baud rate]}$$
 Eqn. 27-1

Table 27-10. QSPI_CLK Frequency as Function of Internal Bus Clock and Baud Rate

| Internal Bus C | Clock = 80 MHz |
|----------------|----------------|
| QMR [BAUD] | QSPI_CLK |
| 2 | 20 MHz |
| 4 | 10 MHz |
| 8 | 5 MHz |
| 16 | 2.5 MHz |
| 32 | 1.25 Hz |
| 255 | 156.9 kHz |

27.4.3 Transfer Delays

The QSPI supports programmable delays for the QSPI_CS signals before and after a transfer. The time between QSPI_CS assertion and the leading QSPI_CLK edge, and the time between the end of one transfer and the beginning of the next, are both independently programmable.

The chip select to clock delay enable bit in the command RAM, QCR[DSCK], enables the programmable delay period from QSPI_CS assertion until the leading edge of QSPI_CLK. QDLYR[QCD] determines the period of delay before the leading edge of QSPI_CLK. The following expression determines the actual delay before the QSPI_CLK leading edge:

QSPI_CS-to-QSPI_CLK delay =
$$\frac{\text{QDLYR[QCD]}}{f_{\text{sys}}}$$
 Eqn. 27-2

QDLYR[QCD] has a range of 1-127.

When QDLYR[QCD] or QCR[DSCK] equals zero, the standard delay of one-half the QSPI_CLK period is used.

The command RAM delay after transmit enable bit, QCR[DT], enables the programmable delay period from the negation of the QSPI_CS signals until the start of the next transfer. The delay after transfer can be used to provide a peripheral deselect interval. A delay can also be inserted between consecutive transfers to allow serial A/D converters to complete conversion. There are two transfer delay options: the user can choose to delay a standard period after serial transfer is complete or can specify a delay period. Writing a value to QDLYR[DTL] specifies a delay period. QCR[DT] determines whether the standard delay period (DT = 0) or the specified delay period (DT = 1) is used. The following expression is used to calculate the delay when DT equals 1:

Delay after transfer =
$$\frac{32 \times QDLYR[DTL]}{f_{sys}}$$
 (DT = 1)

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where QDLYR[DTL] has a range of 1–255. A zero value for DTL causes a delay-after-transfer value of $8192/f_{\text{SVS}}$. Standard delay period (DT = 0) is calculated by the following:

Standard delay after transfer =
$$\frac{17}{f_{sys}}$$
 (DT = 0)

Adequate delay between transfers must be specified for long data streams because the QSPI module requires time to load a transmit RAM entry for transfer. Receiving devices need at least the standard delay between successive transfers. If the internal bus clock is operating at a slower rate, the delay between transfers must be increased proportionately.

27.4.4 Transfer Length

There are two transfer length options. The user can choose a default value of 8 bits or a programmed value of 8 to 16 bits. The programmed value must be written into QMR[BITS]. The command RAM bits per transfer enable field, QCR[BITSE], determines whether the default value (BITSE = 0) or the BITS[3–0] value (BITSE = 1) is used. QMR[BITS] indicates the required number of bits to be transferred, with the default value of 16 bits.

27.4.5 Data Transfer

The transfer operation is initiated by setting QDLYR[SPE]. Shortly after QDLYR[SPE] is set, the QSPI executes the command at the command RAM address pointed to by QWR[NEWQP]. Data at the pointer address in transmit RAM is loaded into the data serializer and transmitted. Data that is simultaneously received is stored at the pointer address in receive RAM.

When the proper number of bits has been transferred, the QSPI stores the working queue pointer value in QWR[CPTQP], increments the working queue pointer, and loads the next data for transfer from the transmit RAM. The command pointed to by the incremented working queue pointer is executed next unless a new value has been written to QWR[NEWQP]. If a new queue pointer value is written while a transfer is in progress, the current transfer is completed normally.

When the CONT bit in the command RAM is set, the QSPI_CSn signals are asserted between transfers. When CONT is cleared, QSPI_CSn are negated between transfers. The QSPI_CSn signals are not high impedance.

When the QSPI reaches the end of the queue, it asserts the SPIF flag, QIR[SPIF]. If QIR[SPIFE] is set, an interrupt request is generated when QIR[SPIF] is asserted. Then the QSPI clears QDLYR[SPE] and stops, unless wraparound mode is enabled.

Wraparound mode is enabled by setting QWR[WREN]. The queue can wrap to pointer address 0x0, or to the address specified by QWR[NEWQP], depending on the state of QWR[WRTO].

In wraparound mode, the QSPI cycles through the queue continuously, even while requesting interrupt service. QDLYR[SPE] is not cleared when the last command in the queue is executed. New receive data overwrites previously received data in the receive RAM. Each time the end of the queue is reached,



QIR[SPIFE] is set. QIR[SPIF] is not automatically reset. If interrupt driven QSPI service is used, the service routine must clear QIR[SPIF] to abort the current request. Additional interrupt requests during servicing can be prevented by clearing QIR[SPIFE].

There are two recommended methods of exiting wraparound mode: clearing QWR[WREN] or setting QWR[HALT]. Exiting wraparound mode by clearing QDLYR[SPE] is not recommended because this may abort a serial transfer in progress. The QSPI sets SPIF, clears QDLYR[SPE], and stops the first time it reaches the end of the queue after QWR[WREN] is cleared. After QWR[HALT] is set, the QSPI finishes the current transfer, then stops executing commands. After the QSPI stops, QDLYR[SPE] can be cleared.

27.5 Initialization/Application Information

The following steps are necessary to set up the QSPI 12-bit data transfers and a QSPI_CLK of 5 MHz. The QSPI RAM is set up for a queue of 16 transfers. All four QSPI_CS signals are used in this example.

- 1. Write the QMR with 0xB308 to set up 12-bit data words with the data shifted on the falling clock edge, and a QSPI_CLK frequency of 5 MHz (assuming a 80-MHz internal bus clock).
- 2. Write QDLYR with the desired delays.
- 3. Write QIR with 0xD00F to enable write collision, abort bus errors, and clear any interrupts.
- 4. Write QAR with 0x0020 to select the first command RAM entry.
- 5. Write QDR with 0x7E00, 0x7E00, 0x7E00, 0x7E00, 0x7D00, 0x7D00, 0x7D00, 0x7D00, 0x7D00, 0x7B00, 0x7B00, 0x7B00, 0x7B00, 0x7700, 0x7700, and 0x7700 to set up four transfers for each chip select. The chip selects are active low in this example.
- 6. Write QAR with 0x0000 to select the first transmit RAM entry.
- 7. Write QDR with sixteen 12-bit words of data.
- 8. Write QWR with 0x0F00 to set up a queue beginning at entry 0 and ending at entry 15.
- 9. Set QDLYR[SPE] to enable the transfers.
- 10. Wait until the transfers are complete. QIR[SPIF] is set when the transfers are complete.
- 11. Write QAR with 0x0010 to select the first receive RAM entry.
- 12. Read QDR to get the received data for each transfer.
- 13. Repeat steps 5 through 13 to do another transfer.



Chapter 28 UART Modules

28.1 Introduction

This chapter describes the use of the three universal asynchronous receiver/transmitters (UARTs) and includes programming examples.

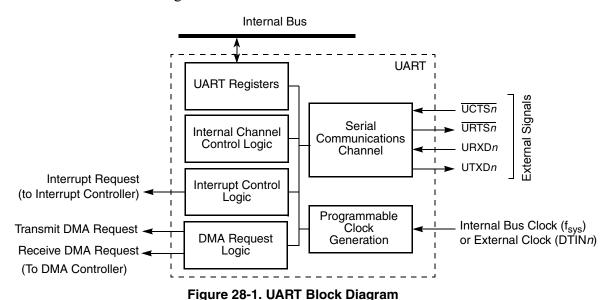
NOTE

The designation *n* appears throughout this section to refer to registers or signals associated with one of the three identical UART modules: UART0, UART1, or UART2.

28.1.1 Overview

The internal bus clock can clock each of the three independent UARTs, eliminating the need for an external UART clock. As Figure 28-1 shows, each UART module interfaces directly to the CPU and consists of:

- Serial communication channel
- Programmable clock generation
- Interrupt control logic and DMA request logic
- Internal channel control logic



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NOTE

The DTIN*n* pin can clock UART*n*. However, if the timers are operating and the UART uses DTIN*n* as a clock source, input capture mode is not available for that timer

The serial communication channel provides a full-duplex asynchronous/synchronous receiver and transmitter deriving an operating frequency from the internal bus clock or an external clock using the timer pin. The transmitter converts parallel data from the CPU to a serial bit stream, inserting appropriate start, stop, and parity bits. It outputs the resulting stream on the transmitter serial data output (UTXDn). See Section 28.4.2.1, "Transmitter."

The receiver converts serial data from the receiver serial data input (URXD*n*) to parallel format, checks for a start, stop, and parity bits, or break conditions, and transfers the assembled character onto the bus during read operations. The receiver may be polled, interrupt driven, or use DMA requests for servicing. See Section 28.4.2.2, "Receiver."

NOTE

The GPIO module must be configured to enable the peripheral function of the appropriate pins (refer to Chapter 15, "General Purpose I/O Module") prior to configuring the UART module.

28.1.2 Features

The device contains three independent UART modules with:

- Each clocked by external clock or internal bus clock (eliminates need for an external UART clock)
- Full-duplex asynchronous/synchronous receiver/transmitter
- Ouadruple-buffered receiver
- Double-buffered transmitter
- Independently programmable receiver and transmitter clock sources
- Programmable data format:
 - 5–8 data bits plus parity
 - Odd, even, no parity, or force parity
 - One, one-and-a-half, or two stop bits
- Each serial channel programmable to normal (full-duplex), automatic echo, local loopback, or remote loopback mode
- Automatic wake-up mode for multidrop applications
- Four maskable interrupt conditions
- All three UARTs have DMA request capability
- Parity, framing, and overrun error detection
- False-start bit detection
- Line-break detection and generation
- Detection of breaks originating in the middle of a character

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Start/end break interrupt/status

28.2 External Signal Description

Table 28-1 briefly describes the UART module signals.

Table 28-1. UART Module External Signals

| Signal | Description |
|---------------|---|
| UTXDn | Transmitter Serial Data Output. UTXDn is held high (mark condition) when the transmitter is disabled, idle, or operating in the local loopback mode. Data is shifted out on UTXDn on the falling edge of the clock source, with the least significant bit (lsb) sent first. |
| URXD <i>n</i> | Receiver Serial Data Input. Data received on URXDn is sampled on the rising edge of the clock source, with the lsb received first. |
| UCTSn | Clear-to- Send. This input can generate an interrupt on a change of state. |
| ŪRTS <i>n</i> | Request-to-Send. This output can be programmed to be negated or asserted automatically by the receiver or the transmitter. When connected to a transmitter's $\overline{\text{UCTS}n}$, $\overline{\text{URTS}n}$ can control serial data flow. |

Figure 28-2 shows a signal configuration for a UART/RS-232 interface.

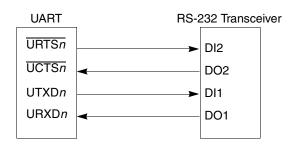


Figure 28-2. UART/RS-232 Interface

28.3 Memory Map/Register Definition

This section contains a detailed description of each register and its specific function. Flowcharts in Section 28.5, "Initialization/Application Information," describe basic UART module programming. Writing control bytes into the appropriate registers controls the operation of the UART module.

NOTE

UART registers are accessible only as bytes.

NOTE

Interrupt can mean an interrupt request asserted to the CPU or a DMA request.

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Table 28-2. UART Module Memory Map

| UARTO UART1 UART2 | Register | Width (bit) | Access | Reset Value | Section/Page |
|-------------------------|---|----------------|----------------|-------------|----------------------------|
| 0x00 0x0 0x0 | UART Mode Registers ¹ (UMR1 <i>n</i>), (UMR2 <i>n</i>) | 8 | R/W | 0x00 | 28.3.1/28-5 28.3.2/28-6 |
| 0x04 | UART Status Register (USRn) | 8 | R | 0x00 | 28.3.3/28-8 |
| 0x4 0x4 | UART Clock Select Register ¹ (UCSRn) | 8 | W | See Section | 28.3.4/28-9 |
| 0x08 0x8 0x8 | UART Command Registers (UCRn) | 8 | W | 0x00 | 28.3.5/28-9 |
| 0x0C | UART Receive Buffers (URBn) | 8 | R | 0xFF | 28.3.6/28-11 |
| 0xC 0xC | UART Transmit Buffers (UTBn) | 8 | W | 0x00 | 28.3.7/28-12 |
| 0x10 | UART Input Port Change Register (UIPCRn) | 8 | R | See Section | 28.3.8/28-12 |
| 0x0 0x0 | UART Auxiliary Control Register (UACRn) | 8 | W | 0x00 | 28.3.9/28-13 |
| 0x14 | UART Interrupt Status Register (UISRn) | 8 | R | 0x00 | 28.3.10/28-13 |
| 0x4 0x4 | UART Interrupt Mask Register (UIMRn) | 8 | W | 0x00 | |
| 0x18 0x8 0x8 | UART Baud Rate Generator Register (UBG1n) | 8 | W ² | 0x00 | 28.3.11/28-15 |
| 0x1C 0xC 0xC | UART Baud Rate Generator Register (UBG2n) | 8 | W ² | 0x00 | 28.3.11/28-15 |
| 0x34 0x4 0x4 | UART Input Port Register (UIPn) | 8 | R | 0xFF | 28.3.12/28-15 |
| 0x38 0x8 0x8 | UART Output Port Bit Set Command Register (UOP1n) | 8 | W ² | 0x00 | 28.3.13/28-16 |
| 0x3C 0xC 0xC | UART Output Port Bit Reset Command Register (UOP0n) | 8 | W ² | 0x00 | 28.3.13/28-16 |

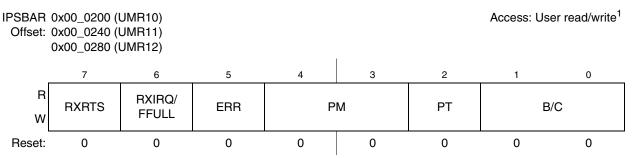
¹ UMR1*n*, UMR2*n*, and UCSR*n* must be changed only after the receiver/transmitter is issued a software reset command. If operation is not disabled, undesirable results may occur.

Reading this register results in undesired effects and possible incorrect transmission or reception of characters. Register contents may also be changed.



UART Mode Registers 1 (UMR1*n*) 28.3.1

The UMR1n registers control UART module configuration. UMR1n can be read or written when the mode register pointer points to it, at RESET or after a RESET MODE REGISTER POINTER command using UCRn[MISC]. After UMR1n is read or written, the pointer points to UMR2n.



¹ After UMR1*n* is read or written, the pointer points to UMR2*n*

Figure 28-3. UART Mode Registers 1 (UMR1n)

Table 28-3. UMR1n Field Descriptions

| Field | Description |
|----------------------|--|
| 7 RXRTS | Receiver request-to-send. Allows the URTSn output to control the UCTSn input of the transmitting device to prevent receiver overrun. If the receiver and transmitter are incorrectly programmed for URTSn control, URTSn control is disabled for both. Transmitter RTS control is configured in UMR2n[TXRTS]. 0 The receiver has no effect on URTSn. 1 When a valid start bit is received, URTSn is negated if the UART's FIFO is full. URTSn is reasserted when the FIFO has an empty position available. |
| 6 RXIRQ/ FFULL | Receiver interrupt select. 0 RXRDY is the source generating interrupt or DMA requests. 1 FFULL is the source generating interrupt or DMA requests. |
| 5 ERR | Error mode. Configures the FIFO status bits, USR <i>n</i> [RB,FE,PE]. 0 Character mode. The USR <i>n</i> values reflect the status of the character at the top of the FIFO. ERR must be 0 for correct A/D flag information when in multidrop mode. 1 Block mode. The USR <i>n</i> values are the logical OR of the status for all characters reaching the top of the FIFO since the last RESET ERROR STATUS command for the UART was issued. See Section 28.3.5, "UART Command Registers (UCRn)." |
| 4–3 PM | Parity mode. Selects the parity or multidrop mode for the UART. The parity bit is added to the transmitted character, and the receiver performs a parity check on incoming data. The value of PM affects PT, as shown below. |

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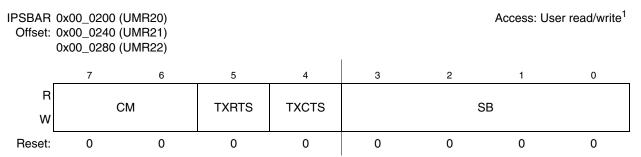


Table 28-3. UMR1n Field Descriptions (continued)

| Field | | | Description | | |
|------------|--|--------------------------|--------------------------|--------------------------|-----------------------|
| 2 PT | Parity type. PM and PT transmitted (PM = 11). | together select parity t | ype (PM = 0x) or detern | nine whether a data or a | ddress character is |
| | PI | Parity Mode | Parity Type (PT= 0) | Parity Type (PT= 1) | |
| | 00 |) With parity | Even parity | Odd parity | |
| | 01 | Force parity | Low parity | High parity | |
| | 10 | No parity | N | I/A | |
| | 11 | Multidrop mode | Data character | Address character | |
| 1–0 B/C | Bits per character. Select parity, or stop bits. 00 5 bits 01 6 bits 10 7 bits 11 8 bits | cts the number of data | bits per character to be | sent. The values shown | do not include start, |

28.3.2 UART Mode Register 2 (UMR2n)

The UMR2*n* registers control UART module configuration. UMR2*n* can be read or written when the mode register pointer points to it, which occurs after any access to UMR1*n*. UMR2*n* accesses do not update the pointer.



¹ After UMR1*n* is read or written, the pointer points to UMR2*n*

Figure 28-4. UART Mode Registers 2 (UMR2n)



Table 28-4. UMR2n Field Descriptions

| Field | | | | Descripti | on | | | |
|------------|---|---|--|---|---------------------|---|------------------------------------|--|
| 7–6 CM | Channel mode. Selects a ch 00 Normal 01 Automatic echo 10 Local loopback 11 Remote loopback | annel mod | e. Section | 28.4.3, "Loo | opin | g Modes," | describes in | ndividual modes. |
| 5 TXRTS | Transmitter ready-to-send. C Attempting to program a rece URTSn control for both. The transmitter has no eff In applications where the UOP[RTS] one bit time af including the programmed | eiver and tra fect on UR transmitter ter any cha | ansmitter ir TSn. is disabled iracters in t | the same | UAF miss | RT for URT | Sn control is | s not permitted and disables this bit automatically clears |
| 4 TXCTS | | he transmiteration. The serted, the delayed un | ter. e transmitte character i | er checks thes sent; if it i | ne st is de | tate of UC | ΓS <i>n</i> each ting the signal t | |
| 3–0 SB | Stop-bit length control. Select 2 bits are programmable for all cases, the receiver checks last data bit or after the parity selects one stop bit and setti | 6–8 bit cha s only for a y bit, if pari | racters. Le high condit ty is enable | ngths of 1-1 tion at the c ed. If an exte | /16 ente erna | to 2 bits are for of the firs al 1x clock | e programr st stop-bit p | nable for 5-bit characters. In osition, one bit time after the |
| | | SB | 5 Bits | 6-8 Bits | | SB | 5-8 Bits | |
| | | 0000 | 1.063 | 0.563 | | 1000 | 1.563 | |
| | | 0001 | 1.125 | 0.625 | | 1001 | 1.625 | |
| | | 0010 | 1.188 | 0.688 | | 1010 | 1.688 | |
| | | 0011 | 1.250 | 0.750 | | 1011 | 1.750 | |
| | | 0100 | 1.313 | 0.813 | | 1100 | 1.813 | |
| | | 0101 | 1.375 | 0.875 | | 1101 | 1.875 | |
| | | 0110 | 1.438 | 0.938 | | 1110 | 1.938 | |
| | | 0111 | 1.500 | 1.000 | | 1111 | 2.000 | |



28.3.3 UART Status Registers (USR*n*)

The USR*n* registers show the status of the transmitter, the receiver, and the FIFO.

IPSBAR 0x00_0204 (USR0) Access: User read-only Offset: 0x00_0244 (USR1) 0x00_0284 (USR2) 5 3 2 0 RB FΕ PΕ OE **TXEMP TXRDY FFULL RXRDY** W 0 0 0 0 0 0 0 0 Reset:

Figure 28-5. UART Status Registers (USRn)

Table 28-5. USRn Field Descriptions

| Field | Description |
|------------|--|
| 7 RB | Received break. The received break circuit detects breaks originating in the middle of a received character. However, a break in the middle of a character must persist until the end of the next detected character time. O No break was received. An all-zero character of the programmed length was received without a stop bit. Only a single FIFO position is occupied when a break is received. Further entries to the FIFO are inhibited until URXDn returns to the high state for at least one-half bit time, which equals two successive edges of the UART clock. RB is valid only when RXRDY is set. |
| 6 FE | Framing error. 0 No framing error occurred. 1 No stop bit was detected when the corresponding data character in the FIFO was received. The stop-bit check occurs in the middle of the first stop-bit position. FE is valid only when RXRDY is set. |
| 5 PE | Parity error. Valid only if RXRDY is set. 0 No parity error occurred. 1 If UMR1n[PM] equals 0x (with parity or force parity), the corresponding character in the FIFO was received with incorrect parity. If UMR1n[PM] equals 11 (multidrop), PE stores the received address or data (A/D) bit. PE is valid only when RXRDY is set. |
| 4 OE | Overrun error. Indicates whether an overrun occurs. No overrun occurred. One or more characters in the received data stream have been lost. OE is set upon receipt of a new character when the FIFO is full and a character is already in the shift register waiting for an empty FIFO position. When this occurs, the character in the receiver shift register and its break detect, framing error status, and parity error, if any, are lost. The RESET ERROR STATUS command in UCRn clears OE. |
| 3 TEMP | Transmitter empty. The transmit buffer is not empty. A character is shifted out, or the transmitter is disabled. The transmitter is enabled/disabled by programming UCRn[TC]. The transmitter has underrun (the transmitter holding register and transmitter shift registers are empty). This bit is set after transmission of the last stop bit of a character if there are no characters in the transmitter holding register awaiting transmission. |
| 2 TXRDY | Transmitter ready. Transmitter ready. The CPU loaded the transmitter holding register, or the transmitter is disabled. The transmitter holding register is empty and ready for a character. TXRDY is set when a character is sent to the transmitter shift register or when the transmitter is first enabled. If the transmitter is disabled, characters loaded into the transmitter holding register are not sent. |

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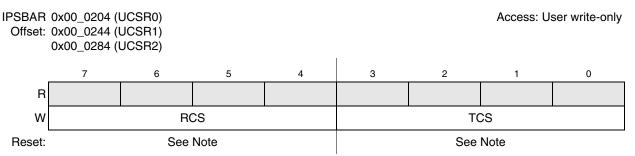


Table 28-5. USRn Field Descriptions (continued)

| Field | Description |
|------------|---|
| 1 FFULL | FIFO full. 0 The FIFO is not full but may hold up to two unread characters. 1 A character was received and the receiver FIFO is now full. Any characters received when the FIFO is full are lost. |
| 0 RXRDY | Receiver ready. 0 The CPU has read the receive buffer and no characters remain in the FIFO after this read. 1 One or more characters were received and are waiting in the receive buffer FIFO. |

28.3.4 UART Clock Select Registers (UCSRn)

The UCSRs select an external clock on the DTIN input (divided by 1 or 16) or a prescaled internal bus clock as the clocking source for the transmitter and receiver. See Section 28.4.1, "Transmitter/Receiver Clock Source." The transmitter and receiver can use different clock sources. To use the internal bus clock for both, set UCSRn to 0xDD.



Note: The RCS and TCS reset values are set so the receiver and transmitter use the prescaled internal bus clock as their clock source.

Figure 28-6. UART Clock Select Registers (UCSRn)

Table 28-6. UCSRn Field Descriptions

| Field | Description |
|------------|--|
| 7–4 RCS | Receiver clock select. Selects the clock source for the receiver. 1101 Prescaled internal bus clock (f _{sys}) 1110 DTIN <i>n</i> divided by 16 1111 DTIN <i>n</i> |
| 3–0 TCS | Transmitter clock select. Selects the clock source for the transmitter. 1101 Prescaled internal bus clock (f _{sys}) 1110 DTIN <i>n</i> divided by 16 1111 DTIN <i>n</i> |

28.3.5 UART Command Registers (UCRn)

The UCRs supply commands to the UART. Only multiple commands that do not conflict can be specified in a single write to a UCRn. For example, RESET TRANSMITTER and ENABLE TRANSMITTER cannot be specified in one command.

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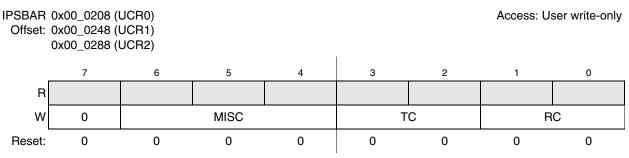


Figure 28-7. UART Command Registers (UCRn)

Table 28-7 describes UCR*n* fields and commands. Examples in Section 28.4.2, "Transmitter and Receiver Operating Modes," show how these commands are used.

Table 28-7. UCRn Field Descriptions

| Field | | | Description |
|-------------|----------|-----------------------------------|--|
| 7 | Reserved | I, must be cleared. | |
| 6–4 MISC | MISC Fie | ld (this field selects a | single command) |
| | | Command | Description |
| | 000 | NO COMMAND | _ |
| | 001 | RESET MODE REGISTER POINTER | Causes the mode register pointer to point to UMR1 n. |
| | 010 | RESET RECEIVER | Immediately disables the receiver, clears USR <i>n</i> [FFULL,RXRDY], and reinitializes the receiver FIFO pointer. No other registers are altered. Because it places the receiver in a known state, use this command instead of RECEIVER DISABLE when reconfiguring the receiver. |
| | 011 | RESET TRANSMITTER | Immediately disables the transmitter and clears USR <i>n</i> [TXEMP,TXRDY]. No other registers are altered. Because it places the transmitter in a known state, use this command instead of TRANSMITTER DISABLE when reconfiguring the transmitter. |
| | 100 | RESET ERROR STATUS | Clears USRn[RB,FE,PE,OE]. Also used in block mode to clear all error bits after a data block is received. |
| | 101 | RESET BREAK — CHANGE INTERRUPT | Clears the delta break bit, UISR <i>n</i> [DB]. |
| | 110 | START BREAK | Forces UTXD <i>n</i> low. If the transmitter is empty, break may be delayed up to one bit time. If the transmitter is active, break starts when character transmission completes. Break is delayed until any character in the transmitter shift register is sent. Any character in the transmitter holding register is sent after the break. Transmitter must be enabled for the command to be accepted. This command ignores the state of UCTS <i>n</i> . |
| | 111 | STOP BREAK | Causes UTXD <i>n</i> to go high (mark) within two bit times. Any characters in the transmit buffer are sent. |



Table 28-7. UCRn Field Descriptions (continued)

| Field | | | Description |
|-----------|------------|--------------------------|--|
| 3–2 TC | Transmi | command field. Sele | ects a single transmit command. |
| 10 | | Command | Description |
| | 00 | NO ACTION TAKEN | Causes the transmitter to stay in its current mode: if the transmitter is enabled, it remains enabled; if the transmitter is disabled, it remains disabled. |
| | 01 | TRANSMITTER ENABLE | Enables operation of the UART's transmitter. USRn[TXEMP,TXRDY] are set. If the transmitter is already enabled, this command has no effect. |
| | 10 | TRANSMITTER DISABLE | Terminates transmitter operation and clears USR <i>n</i> [TXEMP,TXRDY]. If a character is being sent when the transmitter is disabled, transmission completes before the transmitter becomes inactive. If the transmitter is already disabled, the command has no effect. |
| | | | |
| 1.0 | 11 | — | Reserved, do not use. |
| 1–0 RC | | command field. Sele | Reserved, do not use. cts a single receive command. Description |
| 1–0 RC | | | ects a single receive command. |
| - | Receive | Command | Description Causes the receiver to stay in its current mode. If the receiver is enabled, it |
| - | Receive 00 | Command NO ACTION TAKEN | Description Causes the receiver to stay in its current mode. If the receiver is enabled, it remains enabled; if disabled, it remains disabled. If the UART module is not in multidrop mode (UMR1n[PM] ≠ 11), RECEIVER ENABLE enables the UART's receiver and forces it into search-for-start-bit state. If the |

28.3.6 UART Receive Buffers (URBn)

The receive buffers contain one serial shift register and three receiver holding registers, which act as a FIFO. URXD*n* is connected to the serial shift register. The CPU reads from the top of the FIFO while the receiver shifts and updates from the bottom when the shift register is full (see Figure 28-18). RB contains the character in the receiver.

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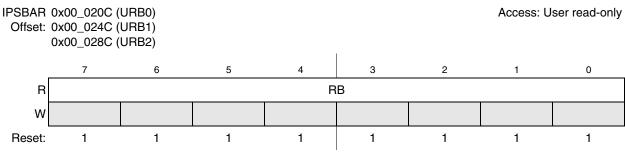
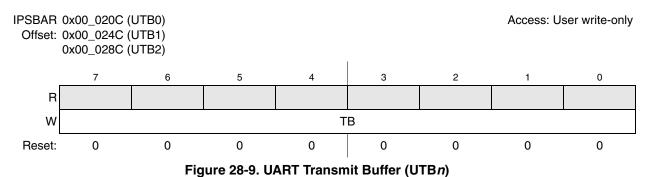


Figure 28-8. UART Receive Buffer (URBn)

28.3.7 **UART Transmit Buffers (UTB***n*)

The transmit buffers consist of the transmitter holding register and the transmitter shift register. The holding register accepts characters from the bus master if UART's USRn[TXRDY] is set. A write to the transmit buffer clears USRn[TXRDY], inhibiting any more characters until the shift register can accept more data. When the shift register is empty, it checks if the holding register has a valid character to be sent (TXRDY = 0). If there is a valid character, the shift register loads it and sets USRn[TXRDY] again. Writes to the transmit buffer when the UART's TXRDY is cleared and the transmitter is disabled have no effect on the transmit buffer.

Figure 28-9 shows UTBn. TB contains the character in the transmit buffer.



28.3.8 UART Input Port Change Registers (UIPCRn)

The UIPCRs hold the current state and the change-of-state for $\overline{\text{UCTS}n}$.

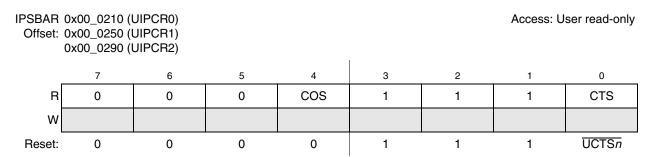


Figure 28-10. UART Input Port Changed Registers (UIPCRn)

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Table 28-8. UIPCRn Field Descriptions

| Field | Description |
|----------|---|
| 7–5 | Reserved |
| 4 COS | Change of state (high-to-low or low-to-high transition). 0 No change-of-state since the CPU last read UIPCR <i>n</i> . Reading UIPCR <i>n</i> clears UISR <i>n</i> [COS]. 1 A change-of-state longer than 25–50 μs occurred on the UCTS <i>n</i> input. UACR <i>n</i> can be programmed to generate an interrupt to the CPU when a change of state is detected. |
| 3–1 | Reserved |
| 0 CTS | Current state of clear-to-send. Starting two serial clock periods after reset, CTS reflects the state of UCTSn. If UCTSn is detected asserted at that time, COS is set, which initiates an interrupt if UACRn[IEC] is enabled. 1 The current state of the UCTSn input is deasserted. |

28.3.9 UART Auxiliary Control Register (UACRn)

The UACRs control the input enable.

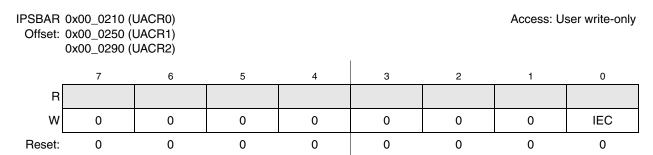


Figure 28-11. UART Auxiliary Control Registers (UACRn)

Table 28-9. UACRn Field Descriptions

| Field | Description |
|----------|---|
| 7–1 | Reserved, must be cleared. |
| 0 IEC | Input enable control. 0 Setting the corresponding UIPCRn bit has no effect on UISRn[COS]. 1 UISRn[COS] is set and an interrupt is generated when the UIPCRn[COS] is set by an external transition on the UCTSn input (if UIMRn[COS] = 1). |

28.3.10 UART Interrupt Status/Mask Registers (UISRn/UIMRn)

The UISRs provide status for all potential interrupt sources. UISRn contents are masked by UIMRn. If corresponding UISRn and UIMRn bits are set, internal interrupt output is asserted. If a UIMRn bit is cleared, state of the corresponding UISRn bit has no effect on the output.

The UISR*n* and UIMR*n* registers share the same space in memory. Reading this register provides the user with interrupt status, while writing controls the mask bits.

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NOTE

True status is provided in the UISR*n* regardless of UIMR*n* settings. UISR*n* is cleared when the UART module is reset.

IPSBAR 0x00_0214 (UISR0) Access: User read/write Offset: 0x00_0254 (UISR1) 0x00_0294 (UISR2) 5 3 1 0 FFULL/ cos 0 0 0 0 DB **TXRDY** RXRDY (UISRn) FFULL/ W COS 0 0 0 0 DB **TXRDY** (UIMRn) **RXRDY** Reset: 0 0 0 0 0 0 0 0

Figure 28-12. UART Interrupt Status/Mask Registers (UISRn/UIMRn)

Table 28-10. UISRn/UIMRn Field Descriptions

| | Ī | | | | | | |
|-----------------|--|------------------------|---|---|-----------------------------------|--|--|
| Field | Description | | | | | | |
| 7 COS | Change-of-state. 0 UIPCR <i>n</i> [COS] is not selected. 1 Change-of-state occurred on UCTS <i>n</i> and was programmed in UACR <i>n</i> [IEC] to cause an interrupt. | | | | | | |
| 6–3 | Reserved, must be cleared. | | | | | | |
| 2 DB | Delta break. O No new break-change condition to report. Section 28.3.5, "UART Command Registers (UCRn)," do RESET BREAK-CHANGE INTERRUPT command. The receiver detected the beginning or end of a received break. Status of FIFO or receiver, depending on UMR1[FFULL/RXRDY] bit. Duplicate of USRn[FIFO] and U | | | | | | |
| FFULL/ RXRDY | UIMRn | | UISRn | UMR1 <i>n</i> [FFULL/RXRDY] | | | |
| | | | [FFULL/RXRDY] | 0 (RXRDY) | 1 (FIFO) | | |
| | | 0 | 0 | Receiver not ready | FIFO not full | | |
| | | 1 | 0 | Receiver not ready | FIFO not full | | |
| | | 0 | 1 | Receiver is ready, Do not interrupt | FIFO is full, Do not interrupt | | |
| | | 1 | 1 | Receiver is ready, interrupt | FIFO is full, interrupt | | |
| 0 TXRDY | 0 The transmi | itter holding register | | CPU or the transmitter is o | disabled. Characters | | |
| | | | en TXRDY is cleared r is empty and ready | d are not sent. y to be loaded with a char | acter. | | |

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28.3.11 UART Baud Rate Generator Registers (UBG1n/UBG2n)

The UBG1*n* registers hold the MSB, and the UBG2*n* registers hold the LSB of the preload value. UBG1*n* and UBG2*n* concatenate to provide a divider to the internal bus clock for transmitter/receiver operation, as described in Section 28.4.1.2.1, "Internal Bus Clock Baud Rates."

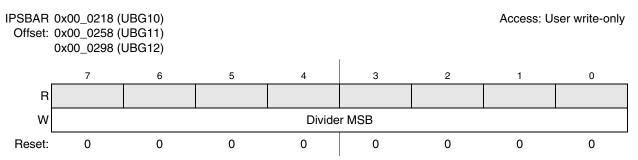


Figure 28-13. UART Baud Rate Generator Registers (UBG1n)

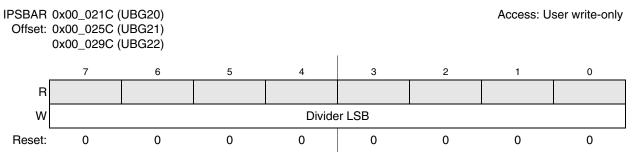


Figure 28-14. UART Baud Rate Generator Registers (UBG2n)

NOTE

The minimum value loaded on the concatenation of UBG1*n* with UBG2*n* is 0x0002. The UBG2*n* reset value of 0x00 is invalid and must be written to before the UART transmitter or receiver are enabled. UBG1*n* and UBG2*n* are write-only and cannot be read by the CPU.

28.3.12 UART Input Port Register (UIPn)

The UIP*n* registers show the current state of the $\overline{\text{UCTS}n}$ input.

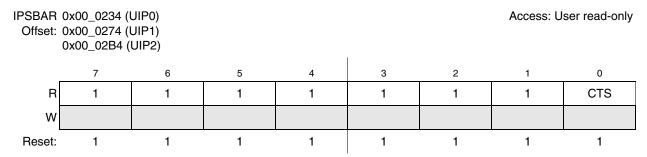


Figure 28-15. UART Input Port Registers (UIPn)

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| Field | Description | | | |
|-------|---|--|--|--|
| 7–1 | Reserved | | | |
| | Current state of clear-to-send. The UCTSn value is latched and reflects the state of the input pin when UIPn is read. Note: This bit has the same function and value as UIPCRn[CTS]. The current state of the UCTSn input is logic 0. The current state of the UCTSn input is logic 1. | | | |

28.3.13 UART Output Port Command Registers (UOP1*n*/UOP0*n*)

The $\overline{\text{URTS}n}$ output can be asserted by writing a 1 to UOP1n[RTS] and negated by writing a 1 to UOP0n[RTS].

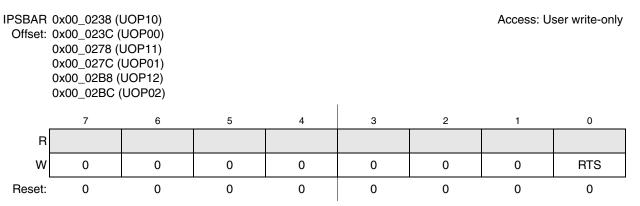


Figure 28-16. UART Output Port Command Registers (UOP1n/UOP0n)

Table 28-12. UOP1n/UOP0n Field Descriptions

| Field | Description | | | |
|----------|--|--|--|--|
| 7–1 | Reserved, must be cleared. | | | |
| 0 RTS | Output port output. Controls assertion (UOP1)/negation (UOP0) of URTSn output. 0 Not affected. 1 Asserts URTSn in UOP1. Negates URTSn in UOP0. | | | |

28.4 Functional Description

This section describes operation of the clock source generator, transmitter, and receiver.

28.4.1 Transmitter/Receiver Clock Source

The internal bus clock serves as the basic timing reference for the clock source generator logic, which consists of a clock generator and a programmable 16-bit divider dedicated to each UART. The 16-bit divider is used to produce standard UART baud rates.

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28.4.1.1 Programmable Divider

As Figure 28-17 shows, the UARTn transmitter and receiver can use the following clock sources:

- An external clock signal on the DTIN*n* pin. When not divided, DTIN*n* provides a synchronous clock; when divided by 16, it is asynchronous.
- The internal bus clock supplies an asynchronous clock source divided by 32 and then divided by the 16-bit value programmed in UBG1n and UBG2n. See Section 28.3.11, "UART Baud Rate Generator Registers (UBG1n/UBG2n)."

The choice of DTIN or internal bus clock is programmed in the UCSR.

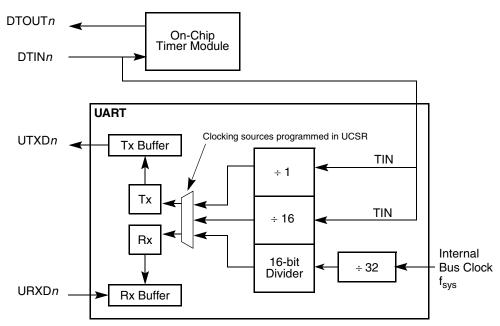


Figure 28-17. Clocking Source Diagram

NOTE

If DTINn is a clocking source for the timer or UART, that timer module cannot use DTINn for timer input capture.

28.4.1.2 Calculating Baud Rates

The following sections describe how to calculate baud rates.

28.4.1.2.1 Internal Bus Clock Baud Rates

When the internal bus clock is the UART clocking source, it goes through a divide-by-32 prescaler and then passes through the 16-bit divider of the concatenated UBG1n and UBG2n registers. The baud-rate calculation is:

Baudrate =
$$\frac{f_{sys}}{[32 \times Divider]}$$
 Eqn. 28-1

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Using a 80-MHz internal bus clock and letting baud rate equal 9600, then

Divider =
$$\frac{80\text{MHz}}{[32 \times 9600]}$$
 = 260(decimal) = 0x0104(hexadecimal) **Eqn. 28-2**

Therefore, UBG1*n* equals 0x01 and UBG2*n* equals 0x04.

28.4.1.2.2 External Clock

An external source clock (DTINn) passes through a divide-by-1 or 16 prescaler. If f_{extc} is the external clock frequency, baud rate can be described with this equation:

Baudrate =
$$\frac{f_{\text{extc}}}{(16 \text{ or } 1)}$$

28.4.2 Transmitter and Receiver Operating Modes

Figure 28-18 is a functional block diagram of the transmitter and receiver showing the command and operating registers, which are described generally in the following sections. For detailed descriptions, refer to Section 28.3, "Memory Map/Register Definition."

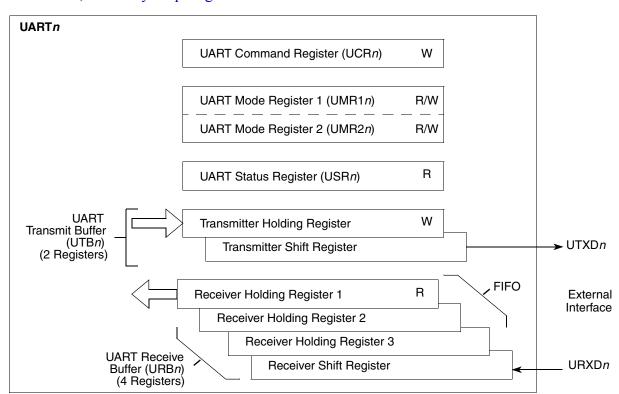


Figure 28-18. Transmitter and Receiver Functional Diagram

28.4.2.1 Transmitter

The transmitter is enabled through the UART command register (UCRn). When it is ready to accept a character, UART sets USRn[TXRDY]. The transmitter converts parallel data from the CPU to a serial bit stream on UTXDn. It automatically sends a start bit followed by the programmed number of data bits, an

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optional parity bit, and the programmed number of stop bits. The lsb is sent first. Data is shifted from the transmitter output on the falling edge of the clock source.

After the stop bits are sent, if no new character is in the transmitter holding register, the UTXD*n* output remains high (mark condition) and the transmitter empty bit (USR*n*[TXEMP]) is set. Transmission resumes and TXEMP is cleared when the CPU loads a new character into the UART transmit buffer (UTB*n*). If the transmitter receives a disable command, it continues until any character in the transmitter shift register is completely sent.

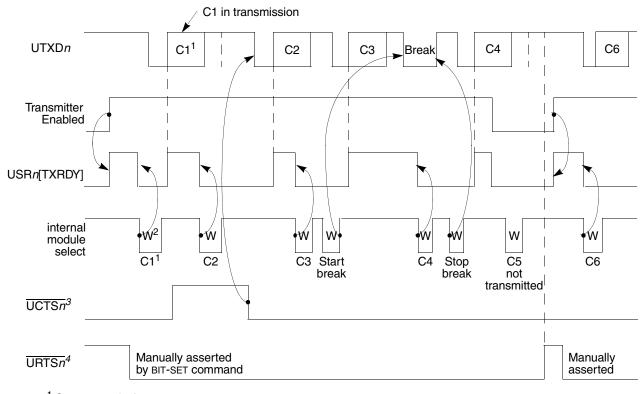
If the transmitter is reset through a software command, operation stops immediately (see Section 28.3.5, "UART Command Registers (UCRn)"). The transmitter is reenabled through the UCRn to resume operation after a disable or software reset.

If the clear-to-send operation is enabled, $\overline{\text{UCTS}n}$ must be asserted for the character to be transmitted. If $\overline{\text{UCTS}n}$ is negated in the middle of a transmission, the character in the shift register is sent and UTXDn remains in mark state until $\overline{\text{UCTS}n}$ is reasserted. If transmitter is forced to send a continuous low condition by issuing a SEND BREAK command, transmitter ignores the state of $\overline{\text{UCTS}n}$.

If the transmitter is programmed to automatically negate $\overline{\text{URTS}n}$ when a message transmission completes, $\overline{\text{URTS}n}$ must be asserted manually before a message is sent. In applications in which the transmitter is disabled after transmission is complete and $\overline{\text{URTS}n}$ is appropriately programmed, $\overline{\text{URTS}n}$ is negated one bit time after the character in the shift register is completely transmitted. The transmitter must be manually reenabled by reasserting $\overline{\text{URTS}n}$ before the next message is sent.

Figure 28-19 shows the functional timing information for the transmitter.





 $^{^{1}}$ Cn = transmit characters

Figure 28-19. Transmitter Timing Diagram

28.4.2.2 Receiver

The receiver is enabled through its UCR*n*, as described in Section 28.3.5, "UART Command Registers (UCRn)."

When the receiver detects a high-to-low (mark-to-space) transition of the start bit on URXDn, the state of URXDn is sampled eight times on the edge of the bit time clock starting one-half clock after the transition (asynchronous operation) or at the next rising edge of the bit time clock (synchronous operation). If URXDn is sampled high, start bit is invalid and the search for the valid start bit begins again.

If URXD*n* remains low, a valid start bit is assumed. The receiver continues sampling the input at one-bit time intervals at the theoretical center of the bit until the proper number of data bits and parity, if any, is assembled and one stop bit is detected. Data on the URXD*n* input is sampled on the rising edge of the programmed clock source. The lsb is received first. The data then transfers to a receiver holding register and USR*n*[RXRDY] is set. If the character is less than 8 bits, the most significant unused bits in the receiver holding register are cleared.

After the stop bit is detected, receiver immediately looks for the next start bit. However, if a non-zero character is received without a stop bit (framing error) and URXDn remains low for one-half of the bit period after the stop bit is sampled, receiver operates as if a new start bit were detected. Parity error,

 $^{^{2}}$ W = write

 $^{^{3}}$ UMR2n[TXCTS] = 1

 $^{^{4}}$ UMR2n[TXRTS] = 1



framing error, overrun error, and received break conditions set the respective PE, FE, OE, and RB error and break flags in the USRn at the received character boundary. They are valid only if USRn[RXRDY] is set.

If a break condition is detected (URXDn is low for the entire character including the stop bit), a character of all 0s loads into the receiver holding register and USRn[RB,RXRDY] are set. URXDn must return to a high condition for at least one-half bit time before a search for the next start bit begins.

The receiver detects the beginning of a break in the middle of a character if the break persists through the next character time. The receiver places the damaged character in the Rx FIFO and sets the corresponding USR*n* error bits and USR*n*[RXRDY]. Then, if the break lasts until the next character time, the receiver places an all-zero character into the Rx FIFO and sets USR*n*[RB,RXRDY].

Figure 28-20 shows receiver functional timing.

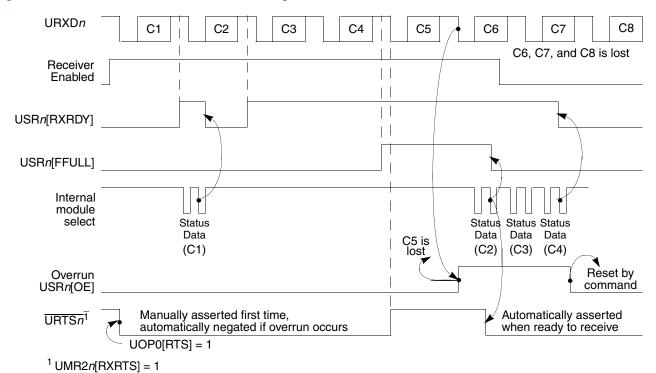


Figure 28-20. Receiver Timing Diagram

28.4.2.3 FIFO

The FIFO is used in the UART's receive buffer logic. The FIFO consists of three receiver holding registers. The receive buffer consists of the FIFO and a receiver shift register connected to the URXD*n* (see Figure 28-18). Data is assembled in the receiver shift register and loaded into the top empty receiver holding register position of the FIFO. Therefore, data flowing from the receiver to the CPU is quadruple-buffered.

In addition to the data byte, three status bits—parity error (PE), framing error (FE), and received break (RB)—are appended to each data character in the FIFO; overrun error (OE) is not appended. By

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programming the ERR bit in the UART's mode register (UMR1n), status is provided in character or block modes

USRn[RXRDY] is set when at least one character is available to be read by the CPU. A read of the receive buffer produces an output of data from the top of the FIFO. After the read cycle, the data at the top of the FIFO and its associated status bits are popped and the receiver shift register can add new data at the bottom of the FIFO. The FIFO-full status bit (FFULL) is set if all three positions are filled with data. The RXRDY or FFULL bit can be selected to cause an interrupt and TXRDY or RXRDY can be used to generate a DMA request.

The two error modes are selected by UMR1*n*[ERR]:

- In character mode (UMR1n[ERR] = 0), status is given in the USRn for the character at the top of the FIFO.
- In block mode, the USRn shows a logical OR of all characters reaching the top of the FIFO since the last RESET ERROR STATUS command. Status is updated as characters reach the top of the FIFO. Block mode offers a data-reception speed advantage where the software overhead of error-checking each character cannot be tolerated. However, errors are not detected until the check is performed at the end of an entire message—the faulting character is not identified.

In either mode, reading the USRn does not affect the FIFO. The FIFO is popped only when the receive buffer is read. The USRn should be read before reading the receive buffer. If all three receiver holding registers are full, a new character is held in the receiver shift register until space is available. However, if a second new character is received, the contents of the character in the receiver shift register is lost, the FIFOs are unaffected, and USRn[OE] is set when the receiver detects the start bit of the new overrunning character.

To support flow control, the receiver can be programmed to automatically negate and assert URTSn, in which case the receiver automatically negates $\overline{\text{URTS}n}$ when a valid start bit is detected and the FIFO is full. The receiver asserts $\overline{\text{URTS}n}$ when a FIFO position becomes available; therefore, connecting $\overline{\text{URTS}n}$ to the UCTSn input of the transmitting device can prevent overrun errors.

The receiver continues reading characters in the FIFO if the receiver is disabled. If the receiver is reset, the FIFO, URTSn control, all receiver status bits, interrupts, and DMA requests are reset. No more characters are received until the receiver is reenabled.

28.4.3 **Looping Modes**

The UART can be configured to operate in various looping modes. These modes are useful for local and remote system diagnostic functions. The modes are described in the following paragraphs and in Section 28.3, "Memory Map/Register Definition."

The UART's transmitter and receiver should be disabled when switching between modes. The selected mode is activated immediately upon mode selection, regardless of whether a character is being received or transmitted.

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28.4.3.1 Automatic Echo Mode

In automatic echo mode, shown in Figure 28-21, the UART automatically resends received data bit by bit. The local CPU-to-receiver communication continues normally, but the CPU-to-transmitter link is disabled. In this mode, received data is clocked on the receiver clock and re-sent on UTXD*n*. The receiver must be enabled, but the transmitter need not be.

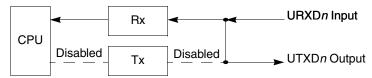


Figure 28-21. Automatic Echo

Because the transmitter is inactive, USR*n*[TXEMP,TXRDY] is inactive and data is sent as it is received. Received parity is checked but not recalculated for transmission. Character framing is also checked, but stop bits are sent as they are received. A received break is echoed as received until the next valid start bit is detected.

28.4.3.2 Local Loopback Mode

Figure 28-22 shows how UTXD*n* and URXD*n* are internally connected in local loopback mode. This mode is for testing the operation of a UART by sending data to the transmitter and checking data assembled by the receiver to ensure proper operations.

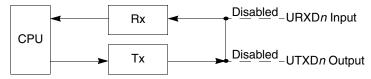


Figure 28-22. Local Loopback

Features of this local loopback mode are:

- Transmitter and CPU-to-receiver communications continue normally in this mode.
- URXD*n* input data is ignored.
- UTXD*n* is held marking.
- The receiver is clocked by the transmitter clock. The transmitter must be enabled, but the receiver need not be

28.4.3.3 Remote Loopback Mode

In remote loopback mode, shown in Figure 28-23, the UART automatically transmits received data bit by bit on the UTXD*n* output. The local CPU-to-transmitter link is disabled. This mode is useful in testing receiver and transmitter operation of a remote UART. For this mode, transmitter uses the receiver clock.

Because the receiver is not active, received data cannot be read by the CPU and all status conditions are inactive. Received parity is not checked and is not recalculated for transmission. Stop bits are sent as they are received. A received break is echoed as received until next valid start bit is detected.

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Figure 28-23. Remote Loopback

28.4.4 Multidrop Mode

Setting UMR1n[PM] programs the UART to operate in a wake-up mode for multidrop or multiprocessor applications. In this mode, a master can transmit an address character followed by a block of data characters targeted for one of up to 256 slave stations.

Although slave stations have their receivers disabled, they continuously monitor the master's data stream. When the master sends an address character, the slave receiver notifies its respective CPU by setting USRn[RXRDY] and generating an interrupt (if programmed to do so). Each slave station CPU then compares the received address to its station address and enables its receiver if it wishes to receive the subsequent data characters or block of data from the master station. Unaddressed slave stations continue monitoring the data stream. Data fields in the data stream are separated by an address character. After a slave receives a block of data, its CPU disables the receiver and repeats the process. Functional timing information for multidrop mode is shown in Figure 28-24.



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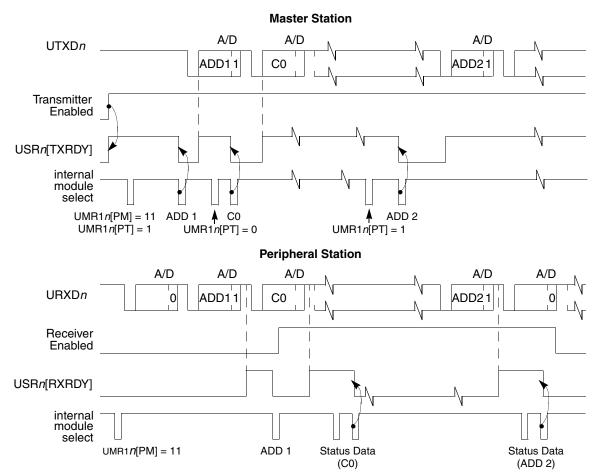


Figure 28-24. Multidrop Mode Timing Diagram

A character sent from the master station consists of a start bit, a programmed number of data bits, an address/data (A/D) bit flag, and a programmed number of stop bits. A/D equals 1 indicates an address character; A/D equals 0 indicates a data character. The polarity of A/D is selected through UMR1n[PT]. UMR1n should be programmed before enabling the transmitter and loading the corresponding data bits into the transmit buffer.

In multidrop mode, the receiver continuously monitors the received data stream, regardless of whether it is enabled or disabled. If the receiver is disabled, it sets the RXRDY bit and loads the character into the receiver holding register FIFO provided the received A/D bit is a 1 (address tag). The character is discarded if the received A/D bit is 0 (data tag). If the receiver is enabled, all received characters are transferred to the CPU through the receiver holding register during read operations.

In either case, data bits load into the data portion of the FIFO while the A/D bit loads into the status portion of the FIFO normally used for a parity error (USRn[PE]).

Framing error, overrun error, and break detection operate normally. The A/D bit takes the place of the parity bit; therefore, parity is neither calculated nor checked. Messages in this mode may continues containing error detection and correction information. If 8-bit characters are not required, one way to provide error detection is to use software to calculate parity and append it to the 5-, 6-, or 7-bit character.

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28.4.5 Bus Operation

This section describes bus operation during read, write, and interrupt acknowledge cycles to the UART module.

28.4.5.1 Read Cycles

The UART module responds to reads with byte data. Reserved registers return zeros.

28.4.5.2 Write Cycles

The UART module accepts write data as bytes only. Write cycles to read-only or reserved registers complete normally without an error termination, but data is ignored.

28.5 Initialization/Application Information

The software flowchart, Figure 28-25, consists of:

- UART module initialization—These routines consist of SINIT and CHCHK (See Sheet 1 p. 28-30 and Sheet 2 p. 28-31). Before SINIT is called at system initialization, the calling routine allocates 2 words on the system FIFO. On return to the calling routine, SINIT passes UART status data on the FIFO. If SINIT finds no errors, the transmitter and receiver are enabled. SINIT calls CHCHK to perform the checks. When called, SINIT places the UART in local loopback mode and checks for the following errors:
 - Transmitter never ready
 - Receiver never ready
 - Parity error
 - Incorrect character received
- I/O driver routine—This routine (See Sheet 4 p. 28-33 and Sheet 5 p. 28-34) consists of INCH, the terminal input character routine which gets a character from the receiver, and OUTCH, which sends a character to the transmitter.
- Interrupt handling—This consists of SIRQ (See Sheet 4 p. 28-33), which is executed after the UART module generates an interrupt caused by a change-in-break (beginning of a break). SIRQ then clears the interrupt source, waits for the next change-in-break interrupt (end of break), clears the interrupt source again, then returns from exception processing to the system monitor.

28.5.1 Interrupt and DMA Request Initialization

28.5.1.1 Setting up the UART to Generate Core Interrupts

The list below provides steps to properly initialize the UART to generate an interrupt request to the processor's interrupt controller. See Section 16.3.8.1, "Interrupt Sources," for details on interrupt assignments for the UART modules.

- 1. Initialize the appropriate ICRx register in the interrupt controller.
- 2. Unmask appropriate bits in IMR in the interrupt controller.

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- 3. Unmask appropriate bits in the core's status register (SR) to enable interrupts.
- 4. If TXRDY or RXRDY generates interrupt requests, verify that DMAREQC (in the SCM) does not also assign the UART's TXRDY and RXRDY into DMA channels.
- 5. Initialize interrupts in the UART, see Table 28-13.

Table 28-13. UART Interrupts

| Register | Bit | Interrupt |
|----------|-----|-----------------------|
| UMR1n | 6 | RxIRQ |
| UIMRn | 7 | Change of State (COS) |
| UIMRn | 2 | Delta Break |
| UIMRn | 1 | RxFIFO Full |
| UIMRn | 0 | TXRDY |

28.5.1.2 Setting up the UART to Request DMA Service

The UART is capable of generating two internal DMA request signals: transmit and receive.

The transmit DMA request signal is asserted when the TXRDY (transmitter ready) in the UART interrupt status register (UISRn[TXRDY]) is set. When the transmit DMA request signal is asserted, the DMA can initiate a data copy, reading the next character transmitted from memory and writing it into the UART transmit buffer (UTBn). This allows the DMA channel to stream data from memory to the UART for transmission without processor intervention. After the entire message has been moved into the UART, the DMA would typically generate an end-of-data-transfer interrupt request to the CPU. The resulting interrupt service routine (ISR) could query the UART programming model to determine the end-of-transmission status.

Similarly, the receive DMA request signal is asserted when the FIFO full or receive ready (FFULL/RXRDY) flag in the interrupt status register (UISR*n*[FFULL/RXRDY]) is set. When the receive DMA request signal is asserted, the DMA can initiate a data move, reading the appropriate characters from the UART receive buffer (URB*n*) and storing them in memory. This allows the DMA channel to stream data from the UART receive buffer into memory without processor intervention. After the entire message has been moved from the UART, the DMA would typically generate an end-of-data-transfer interrupt request to the CPU. The resulting interrupt service routine (ISR) should query the UART programming model to determine the end-of-transmission status. In typical applications, the receive DMA request should be configured to use RXRDY directly (and not FFULL) to remove any complications related to retrieving the final characters from the FIFO buffer.

The implementation described in this section allows independent DMA processing of transmit and receive data while continuing to support interrupt notification to the processor for \overline{CTS} change-of-state and delta break error managing.



To configure the UART for DMA requests:

- 1. Initialize the DMAREQC in the SCM to map the desired UART DMA requests to the desired DMA channels. For example, setting DMAREQC[7:4] to 1000 maps UART0 receive DMA requests to DMA channel 1, setting DMAREQC[11:8] to 1101 maps UART1 transmit DMA requests to DMA channel 2, and so on. It is possible to independently map transmit-based and receive-based UART DMA requests in the DMAREQC.
- 2. Disable interrupts using the UIMR register. The appropriate UIMR bits must be cleared so that interrupt requests are disabled for those conditions for which a DMA request is desired. For example, to generate transmit DMA requests from UART1, UIMR1[TXRDY] should be cleared. This prevents TXRDY from generating an interrupt request while a transmit DMA request is generated.
- 3. Enable DMA access to the UART*n* registers by setting the corresponding PACR register in the SCM for read/write in supervisor and user modes.
- 4. Enable DMA access to SRAM by setting the SPV bit in the core RAMBAR, and the BDE bit in the SCM RAMBAR
- 5. Initialize the DMA channel. The DMA should be configured for cycle steal mode and a source and destination size of one byte. This causes a single byte to be transferred for each UART DMA request. Set the disable request bit (DCRn[D_REQ] to disable external requests when the BCR reaches zero.
- 6. For a transmit process:
 - Set the DMA SAR register to the address of the source data
 - Set DCRn[SINC] to increment the source pointer
 - Set DAR to the address if the UART transmit buffer (UTB)
 - Clear DCRn[DINC]
 - Set BCR to the number of bytes to transmit.
- 7. For a receive process:
 - Set the DMA SAR register to the address of the UART receive buffer (URB)
 - Clear DCRn[SINC]
 - Set DAR to the address of the source data
 - Set DCRn[DINC] to increment the destination pointer
 - Set BCR to the number of bytes to transmit.
- 8. Start the data transfer by setting DCR*n*[EEXT], which enables the UART channel to issue DMA requests.

Table 28-14 shows the DMA requests.

Table 28-14. UART DMA Requests

| Register | Bit | DMA Request | |
|----------|-----|----------------------|--|
| UISRn | 1 | Receive DMA request | |
| UISRn | 0 | Transmit DMA request | |

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28.5.2 UART Module Initialization Sequence

The following shows the UART module initialization sequence.

- 1. UCR*n*:
 - a) Reset the receiver and transmitter.
 - b) Reset the mode pointer (MISC[2-0] = 0b001).
- 2. UIMR*n*: Enable the desired interrupt sources.
- 3. UACR*n*: Initialize the input enable control (IEC bit).
- 4. UCSRn: Select the receiver and transmitter clock. Use timer as source if required.
- 5. UMR1*n*:
 - a) If preferred, program operation of receiver ready-to-send (RXRTS bit).
 - a) Select receiver-ready or FIFO-full notification (RXRDY/FFULL bit).
 - b) Select character or block error mode (ERR bit).
 - c) Select parity mode and type (PM and PT bits).
 - d) Select number of bits per character (B/Cx bits).
- 6. UMR2*n*:
 - a) Select the mode of operation (CM bits).
 - b) If preferred, program operation of transmitter ready-to-send (TXRTS).
 - c) If preferred, program operation of clear-to-send (TXCTS bit).
 - d) Select stop-bit length (SB bits).
- 7. UCRn: Enable transmitter and/or receiver.



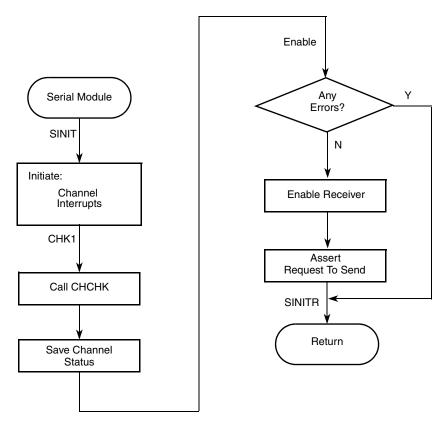


Figure 28-25. UART Mode Programming Flowchart (Sheet 1 of 5)



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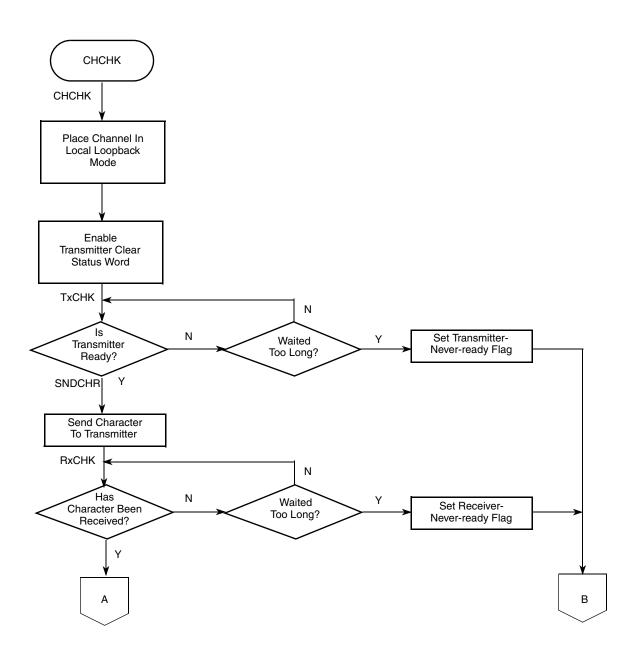


Figure 28-25. UART Mode Programming Flowchart (Sheet 2 of 5)

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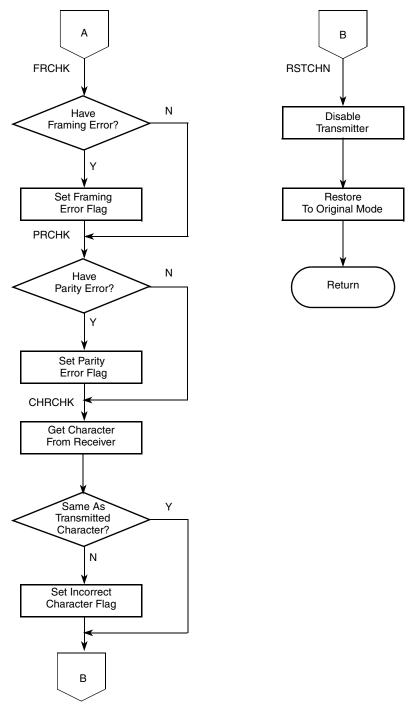


Figure 28-25. UART Mode Programming Flowchart (Sheet 3 of 5)



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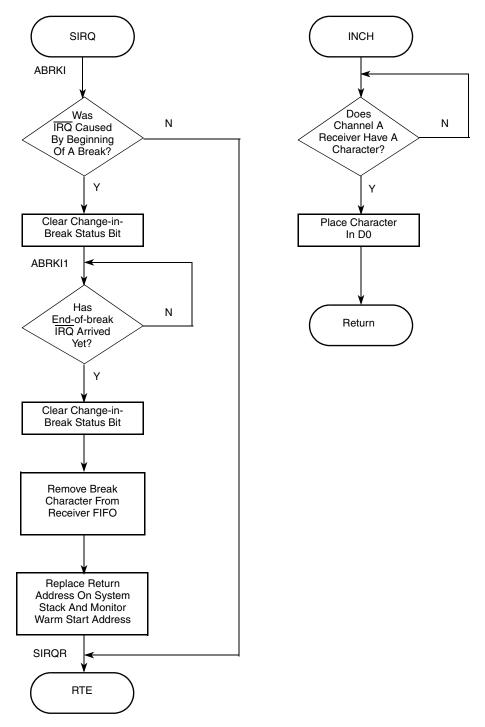


Figure 28-25. UART Mode Programming Flowchart (Sheet 4 of 5)

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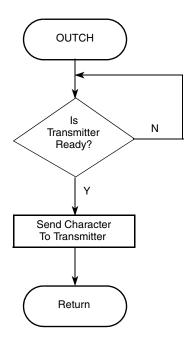


Figure 28-25. UART Mode Programming Flowchart (Sheet 5 of 5)



Chapter 29 I²C Interface

29.1 Introduction

This chapter describes the I²C module, clock synchronization, and I²C programming model registers. It also provides extensive programming examples.

NOTE

This device contains two I^2C modules, I^2C0 and I^2C1 . The designation 'n', with n = 0 or 1, is used throughout this chapter to refer to registers and signals associated with the two identical I^2C modules.



29.1.1 Block Diagram

Figure 29-1 is a I²C module block diagram, illustrating the interaction of the registers described in Section 29.2, "Memory Map/Register Definition".

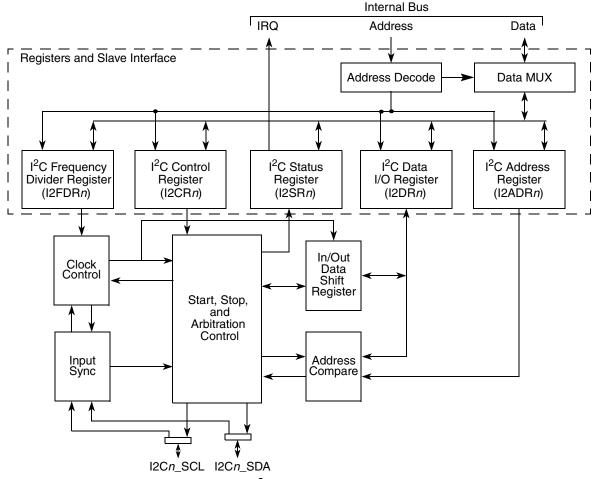


Figure 29-1. I²C Module Block Diagram

29.1.2 Overview

I²C is a two-wire, bidirectional serial bus that provides a simple, efficient method of data exchange, minimizing the interconnection between devices. This bus is suitable for applications that require occasional communication between many devices over a short distance. The flexible I²C bus allows additional devices to connect to the bus for expansion and system development.

The interface operates up to 100 Kbps with maximum bus loading and timing. The device is capable of operating at higher baud rates, up to a maximum of the internal bus clock divided by 20, with reduced bus loading. The maximum communication length and the number of devices connected are limited by a maximum bus capacitance of 400 pF.

The I²C system is a true multiple-master bus; it uses arbitration and collision detection to prevent data corruption in the event that multiple devices attempt to control the bus simultaneously. This supports



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complex applications with multiprocessor control and can be used for rapid testing and alignment of end products through external connections to an assembly-line computer.

NOTE

The I²C module is compatible with the Philips I²C bus protocol. For information on system configuration, protocol, and restrictions, see *The I*²C *Bus Specification, Version 2.1.*

NOTE

The GPIO module must be configured to enable the peripheral function of the appropriate pins (refer to Chapter 15, "General Purpose I/O Module") prior to configuring the I²C module.

29.1.3 Features

The I²C module has these key features:

- Compatibility with I²C bus standard version 2.1
- Multiple-master operation
- Software-programmable for one of 50 different serial clock frequencies
- Software-selectable acknowledge bit
- Interrupt-driven, byte-by-byte data transfer
- Arbitration-lost interrupt with automatic mode switching from master to slave
- Calling address identification interrupt
- START and STOP signal generation/detection
- Repeated START signal generation
- Acknowledge bit generation/detection
- Bus-busy detection

29.2 Memory Map/Register Definition

The below table lists the configuration registers used in the I²C interfaces.

Table 29-1. I²C Module Memory Map

| IPSBAR Offset I ² C0 I ² C1 | Register | Access | Reset Value | Section/Page |
|--|---|--------|-------------|--------------|
| 0x00_0300 0x00_0380 | I ² C Address Register (I2ADR <i>n</i>) | R/W | 0x00 | 29.2.1/29-4 |
| 0x00_0304 0x00_0384 | I ² C Frequency Divider Register (I2FDR <i>n</i>) | R/W | 0x00 | 29.2.2/29-4 |
| 0x00_0308 0x00_0388 | I ² C Control Register (I2CR <i>n</i>) | R/W | 0x00 | 29.2.3/29-5 |

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| Table 29-1. I ² C Module Memory | / Мар | (continued) |
|--|-------|-------------|
|--|-------|-------------|

| IPSBAR Offset I ² C0 I ² C1 | Register | Access | Reset Value | Section/Page |
|--|---|--------|-------------|--------------|
| 0x00_030C 0x00_038C | I ² C Status Register (I2SR <i>n</i>) | R/W | 0x81 | 29.2.4/29-6 |
| 0x00_0310 0x00_0390 | I ² C Data I/O Register (I2DR <i>n</i>) | R/W | 0x00 | 29.2.5/29-7 |

29.2.1 I²C Address Register (I2ADR*n*)

I2ADRn holds the address the I²C responds to when addressed as a slave. It is not the address sent on the bus during the address transfer when the module is performing a master transfer.



Figure 29-2. I²C Address Register (I2ADR*n*)

Table 29-2. I2ADRn Field Descriptions

| Field | Description |
|-------|--|
| | Slave address. Contains the specific slave address to be used by the I^2C module. Slave mode is the default I^2C mode for an address match on the bus. |
| 0 | Reserved, must be cleared. |

29.2.2 I²C Frequency Divider Register (I2FDR*n*)

The I2FDRn, shown in Figure 29-3, provides a programmable prescaler to configure the I 2 C clock for bit-rate selection.

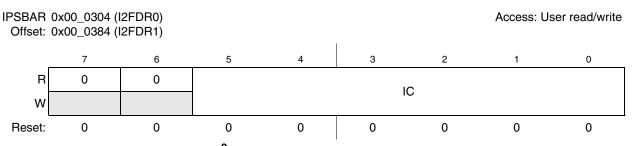


Figure 29-3. I²C Frequency Divider Register (I2FDR*n*)

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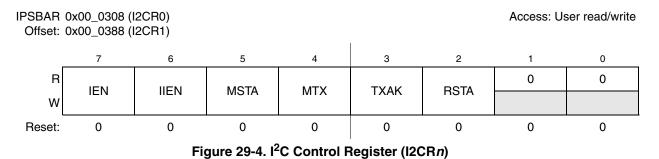
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Table 29-3. I2FDRn Field Descriptions

| Field | Description | | | | | | | | | |
|-----------|--|------------|-------------|----------|--------------|------|---------|------|---------|--|
| 7–6 | Reserved, must be cleared. | | | | | | | | | |
| 5–0 IC | I ² C clock rate. P clock divided by signals are samp | the divide | er shown be | low. Due | to potential | | | | | |
| | | IC | Divider | IC | Divider | IC | Divider | IC | Divider | |
| | | 0x00 | 28 | 0x10 | 288 | 0x20 | 20 | 0x30 | 160 | |
| | | 0x01 | 30 | 0x11 | 320 | 0x21 | 22 | 0x31 | 192 | |
| | | 0x02 | 34 | 0x12 | 384 | 0x22 | 24 | 0x32 | 224 | |
| | | 0x03 | 40 | 0x13 | 480 | 0x23 | 26 | 0x33 | 256 | |
| | | 0x04 | 44 | 0x14 | 576 | 0x24 | 28 | 0x34 | 320 | |
| | | 0x05 | 48 | 0x15 | 640 | 0x25 | 32 | 0x35 | 384 | |
| | | 0x06 | 56 | 0x16 | 768 | 0x26 | 36 | 0x36 | 448 | |
| | | 0x07 | 68 | 0x17 | 960 | 0x27 | 40 | 0x37 | 512 | |
| | | 0x08 | 80 | 0x18 | 1152 | 0x28 | 48 | 0x38 | 640 | |
| | | 0x09 | 88 | 0x19 | 1280 | 0x29 | 56 | 0x39 | 768 | |
| | | 0x0A | 104 | 0x1A | 1536 | 0x2A | 64 | 0x3A | 896 | |
| | | 0x0B | 128 | 0x1B | 1920 | 0x2B | 72 | 0x3B | 1024 | |
| | | 0x0C | 144 | 0x1C | 2304 | 0x2C | 80 | 0x3C | 1280 | |
| | | 0x0D | 160 | 0x1D | 2560 | 0x2D | 96 | 0x3D | 1536 | |
| | | 0x0E | 192 | 0x1E | 3072 | 0x2E | 112 | 0x3E | 1792 | |
| | | 0x0F | 240 | 0x1F | 3840 | 0x2F | 128 | 0x3F | 2048 | |

29.2.3 I²C Control Register (I2CR*n*)

I2CRn enables the I 2 C module and the I 2 C interrupt. It also contains bits that govern operation as a slave or a master.



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Table 29-4. I2CRn Field Descriptions

| Field | Description |
|-----------|--|
| 7 IEN | I ² C enable. Controls the software reset of the entire I ² C module. If the module is enabled in the middle of a byte transfer, slave mode ignores the current bus transfer and starts operating when the next START condition is detected. Master mode is not aware that the bus is busy; initiating a start cycle may corrupt the current bus cycle, ultimately causing the current master or the I ² C module to lose arbitration, after which bus operation returns to normal. O The I ² C module is disabled, but registers can be accessed. 1 The I ² C module is enabled. This bit must be set before any other I2CR <i>n</i> bits have any effect. |
| 6 IIEN | I ² C interrupt enable. 0 I ² C module interrupts are disabled, but currently pending interrupt condition is not cleared. 1 I ² C module interrupts are enabled. An I ² C interrupt occurs if I2SR <i>n</i> [IIF] is also set. |
| 5 MSTA | Master/slave mode select bit. If the master loses arbitration, MSTA is cleared without generating a STOP signal. O Slave mode. Changing MSTA from 1 to 0 generates a STOP and selects slave mode. 1 Master mode. Changing MSTA from 0 to 1 signals a START on the bus and selects master mode. |
| 4 MTX | Transmit/receive mode select bit. Selects the direction of master and slave transfers. O Receive 1 Transmit. When the device is addressed as a slave, software must set MTX according to I2SRn[SRW]. In master mode, MTX must be set according to the type of transfer required. Therefore, when the MCU addresses a slave device, MTX is always 1. |
| 3 TXAK | Transmit acknowledge enable. Specifies the value driven onto I2Cn_SDA during acknowledge cycles for master and slave receivers. Writing TXAK applies only when the I ² C bus is a receiver. O An acknowledge signal is sent to the bus at the ninth clock bit after receiving one byte of data. No acknowledge signal response is sent (acknowledge bit = 1). |
| 2 RSTA | Repeat start. Always read as 0. Attempting a repeat start without bus mastership causes loss of arbitration. 0 No repeat start 1 Generates a repeated START condition. |
| 1–0 | Reserved, must be cleared. |

I²C Status Register (I2SR*n*) 29.2.4

I2SR*n* contains bits that indicate transaction direction and status.

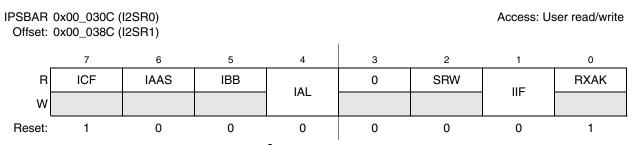


Figure 29-5. I²C Status Register (I2SR*n*)

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Table 29-5. I2SRn Field Descriptions

| Field | Description |
|-----------|---|
| 7 ICF | I ² C Data transferring bit. While one byte of data is transferred, ICF is cleared. 0 Transfer in progress 1 Transfer complete. Set by falling edge of ninth clock of a byte transfer. |
| 6 IAAS | I ² C addressed as a slave bit. The CPU is interrupted if I2CR <i>n</i> [IIEN] is set. Next, the CPU must check SRW and set its TX/RX mode accordingly. Writing to I2CR <i>n</i> clears this bit. 0 Not addressed. 1 Addressed as a slave. Set when its own address (IADR) matches the calling address. |
| 5 IBB | I ² C bus busy bit. Indicates the status of the bus. 0 Bus is idle. If a STOP signal is detected, IBB is cleared. 1 Bus is busy. When START is detected, IBB is set. |
| 4 IAL | I²C arbitration lost. Set by hardware in the following circumstances. (IAL must be cleared by software by writing zero to it.) I2Cn_SDA sampled low when the master drives high during an address or data-transmit cycle. I2Cn_SDA sampled low when the master drives high during the acknowledge bit of a data-receive cycle. A start cycle is attempted when the bus is busy. A repeated start cycle is requested in slave mode. A stop condition is detected when the master did not request it. |
| 3 | Reserved, must be cleared. |
| 2 SRW | Slave read/write. When IAAS is set, SRW indicates the value of the R/W command bit of the calling address sent from the master. SRW is valid only when a complete transfer has occurred, no other transfers have been initiated, and the I ² C module is a slave and has an address match. O Slave receive, master writing to slave. Slave transmit, master reading from slave. |
| 1 IIF | I²C interrupt. Must be cleared by software by writing a 0 in the interrupt routine. 0 No I²C interrupt pending 1 An interrupt is pending, which causes a processor interrupt request (if IIEN = 1). Set when one of the following occurs: • Complete one byte transfer (set at the falling edge of the ninth clock) • Reception of a calling address that matches its own specific address in slave-receive mode • Arbitration lost |
| 0 RXAK | Received acknowledge. The value of I2C <i>n_</i> SDA during the acknowledge bit of a bus cycle. O An acknowledge signal was received after the completion of 8-bit data transmission on the bus No acknowledge signal was detected at the ninth clock. |

29.2.5 I²C Data I/O Register (I2DR*n*)

In master-receive mode, reading I2DRn allows a read to occur and for the next data byte to be received. In slave mode, the same function is available after the I²C has received its slave address.



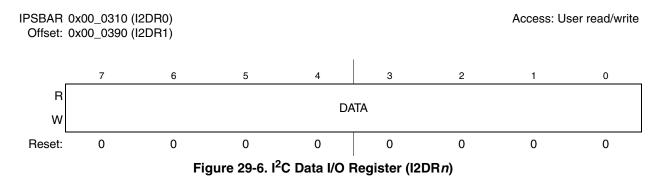


Table 29-6. I2DRn Field Description

| Field | Description |
|-------------|--|
| 7–0 DATA | I²C data. When data is written to this register in master transmit mode, a data transfer is initiated. The most significant bit is sent first. In master receive mode, reading this register initiates the reception of the next byte of data. In slave mode, the same functions are available after an address match has occurred. Note: In master transmit mode, the first byte of data written to I2DRn following assertion of I2CRn[MSTA] is used for the address transfer and should comprise the calling address (in position D7–D1) concatenated with the required R/W bit (in position D0). This bit (D0) is not automatically appended by the hardware, software must provide the appropriate R/W bit. Note: I2CRn[MSTA] generates a start when a master does not already own the bus. I2CRn[RSTA] generates a start (restart) without the master first issuing a stop (i.e., the master already owns the bus). To start the read of data, a dummy read to this register starts the read process from the slave. The next read of the I2DRn register contains the actual data. |

Functional Description 29.3

The I^2C module uses a serial data line (I2Cn SDA) and a serial clock line (I2Cn_SCL) for data transfer. For I²C compliance, all devices connected to these two signals must have open drain or open collector outputs. The logic AND function is exercised on both lines with external pull-up resistors.

Out of reset, the I²C default state is as a slave receiver. Therefore, when not programmed to be a master or responding to a slave transmit address, the I²C module should return to the default slave receiver state. See Section 29.4.1, "Initialization Sequence," for exceptions.

Normally, a standard communication is composed of four parts: START signal, slave address transmission, data transfer, and STOP signal. These are discussed in the following sections.

START Signal 29.3.1

When no other device is bus master (I2Cn SCL and I2Cn SDA lines are at logic high), a device can initiate communication by sending a START signal (see A in Figure 29-7). A START signal is defined as a high-to-low transition of I2Cn SDA while I2Cn SCL is high. This signal denotes the beginning of a data transfer (each data transfer can be several bytes long) and awakens all slaves.

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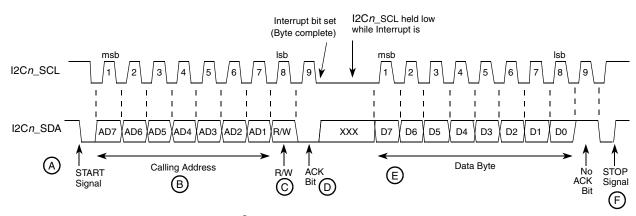


Figure 29-7. I²C Standard Communication Protocol

29.3.2 Slave Address Transmission

The master sends the slave address in the first byte after the START signal (B). After the seven-bit calling address, it sends the R/W bit (C), which tells the slave data transfer direction (0 equals write transfer, 1 equals read transfer).

Each slave must have a unique address. An I²C master must not transmit its own slave address; it cannot be master and slave at the same time.

The slave whose address matches that sent by the master pulls I2C*n*_SDA low at the ninth serial clock (D) to return an acknowledge bit.

29.3.3 Data Transfer

When successful slave addressing is achieved, data transfer can proceed (see E in Figure 29-7) on a byte-by-byte basis in the direction specified by the R/W bit sent by the calling master.

Data can be changed only while I2Cn_SCL is low and must be held stable while I2Cn_SCL is high, as Figure 29-7 shows. I2Cn_SCL is pulsed once for each data bit, with the msb being sent first. The receiving device must acknowledge each byte by pulling I2Cn_SDA low at the ninth clock; therefore, a data byte transfer takes nine clock pulses. See Figure 29-8.

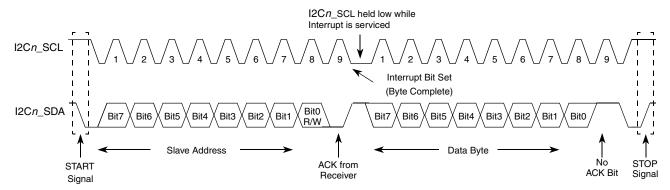


Figure 29-8. Data Transfer

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29.3.4 Acknowledge

The transmitter releases the I2C*n*_SDA line high during the acknowledge clock pulse as shown in Figure 29-9. The receiver pulls down the I2C*n*_SDA line during the acknowledge clock pulse so that it remains stable low during the high period of the clock pulse.

If it does not acknowledge the master, the slave receiver must leave I2C*n*_SDA high. The master can then generate a STOP signal to abort data transfer or generate a START signal (repeated start, shown in Figure 29-10 and discussed in Section 29.3.6, "Repeated START") to start a new calling sequence.

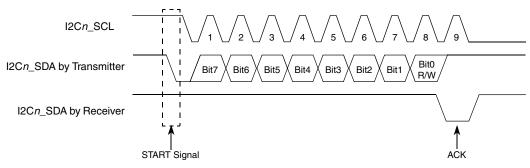


Figure 29-9. Acknowledgement by Receiver

If the master receiver does not acknowledge the slave transmitter after a byte transmission, it means end-of-data to the slave. The slave releases I2Cn_SDA for the master to generate a STOP or START signal (Figure 29-9).

29.3.5 STOP Signal

The master can terminate communication by generating a STOP signal to free the bus. A STOP signal is defined as a low-to-high transition of I2Cn_SDA while I2Cn_SCL is at logical high (see F in Figure 29-7). The master can generate a STOP even if the slave has generated an acknowledgment, at which point the slave must release the bus. The master may also generate a START signal following a calling address, without first generating a STOP signal. Refer to Section 29.3.6, "Repeated START."

29.3.6 Repeated START

A repeated START signal is a START signal generated without first generating a STOP signal to terminate the communication, as shown in Figure 29-10. The master uses a repeated START to communicate with another slave or with the same slave in a different mode (transmit/receive mode) without releasing the bus.



I²C Interface

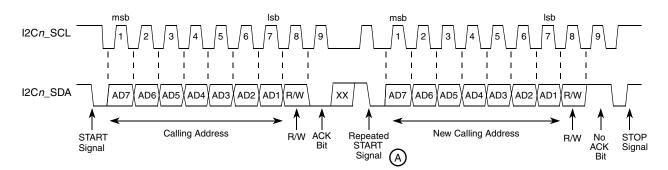


Figure 29-10. Repeated START

Various combinations of read/write formats are then possible:

- The first example in Figure 29-11 is the case of master-transmitter transmitting to slave-receiver. The transfer direction is not changed.
- The second example in Figure 29-11 is the master reading the slave immediately after the first byte. At the moment of the first acknowledge, the master-transmitter becomes a master-receiver and the slave-receiver becomes slave-transmitter.
- In the third example in Figure 29-11, START condition and slave address are repeated using the repeated START signal. This is to communicate with same slave in a different mode without releasing the bus. The master transmits data to the slave first, and then the master reads data from slave by reversing the R/W bit.

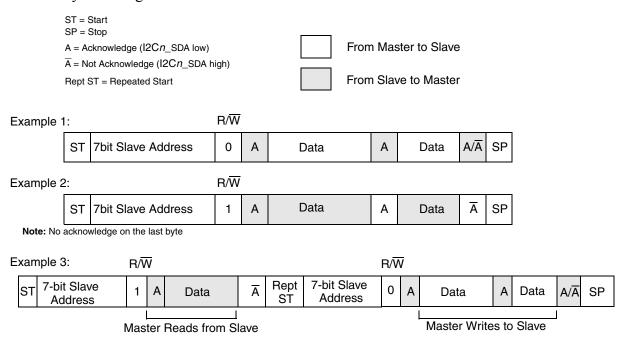


Figure 29-11. Data Transfer, Combined Format

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Proceeds Com



29.3.7 Clock Synchronization and Arbitration

I²C is a true multi-master bus that allows more than one master connected to it. If two or more master devices simultaneously request control of the bus, a clock synchronization procedure determines the bus clock. Because wire-AND logic is performed on the I2Cn_SCL line, a high-to-low transition on the I2Cn_SCL line affects all the devices connected on the bus. The devices start counting their low period and after a device's clock has gone low, it holds the I2Cn_SCL line low until the clock high state is reached. However, change of low to high in this device's clock may not change the state of the I2Cn_SCL line if another device clock remains within its low period. Therefore, synchronized clock I2Cn_SCL is held low by the device with the longest low period.

Devices with shorter low periods enter a high wait state during this time (see Figure 29-12). When all devices concerned have counted off their low period, the synchronized clock (I2Cn_SCL) line is released and pulled high. At this point, the device clocks and the I2Cn_SCL line are synchronized, and the devices start counting their high periods. The first device to complete its high period pulls the I2Cn_SCL line low again.

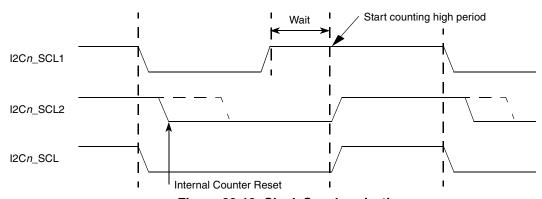


Figure 29-12. Clock Synchronization

A data arbitration procedure determines the relative priority of the contending masters. A bus master loses arbitration if it transmits logic 1 while another master transmits logic 0. The losing masters immediately switch over to slave receive mode and stop driving $I2Cn_SDA$ output (see Figure 29-13). In this case, transition from master to slave mode does not generate a STOP condition. Meanwhile, hardware sets I2SRn[IAL] to indicate loss of arbitration.

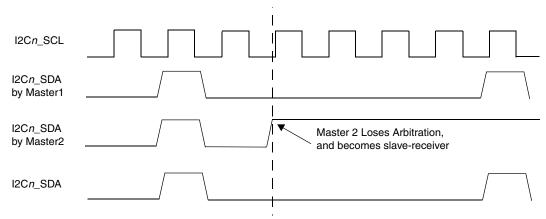


Figure 29-13. Arbitration Procedure

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I²C Interface

29.3.8 Handshaking and Clock Stretching

The clock synchronization mechanism can acts as a handshake in data transfers. Slave devices can hold I2C*n*_SCL low after completing one byte transfer. In such a case, the clock mechanism halts the bus clock and forces the master clock into wait states until the slave releases I2C*n*_SCL.

Slaves may also slow down the transfer bit rate. After the master has driven I2C*n*_SCL low, the slave can drive I2C*n*_SCL low for the required period and then release it. If the slave I2C*n*_SCL low period is longer than the master I2C*n*_SCL low period, the resulting I2C*n*_SCL bus signal low period is stretched.

29.4 Initialization/Application Information

The following examples show programming for initialization, signaling START, post-transfer software response, signaling STOP, and generating a repeated START.

29.4.1 Initialization Sequence

Before the interface can transfer serial data, registers must be initialized:

- 1. Set I2FDR*n*[IC] to obtain I2C*n*_SCL frequency from the system bus clock. See Section 29.2.2, "I2C Frequency Divider Register (I2FDRn)."
- 2. Update the I2ADR*n* to define its slave address.
- 3. Set I2CRn[IEN] to enable the I^2C bus interface system.
- 4. Modify the I2CR*n* to select or deselect master/slave mode, transmit/receive mode, and interrupt-enable or not.

NOTE

If I2SR*n*[IBB] is set when the I²C bus module is enabled, execute the following pseudocode sequence before proceeding with normal initialization code. This issues a STOP command to the slave device, placing it in idle state as if it were power-cycled on.

29.4.2 Generation of START

After completion of the initialization procedure, serial data can be transmitted by selecting the master transmitter mode. On a multiple-master bus system, I2SRn[IBB] must be tested to determine whether the serial bus is free. If the bus is free (IBB is cleared), the START signal and the first byte (the slave address) can be sent. The data written to the data register comprises the address of the desired slave and the lsb indicates the transfer direction

The free time between a STOP and the next START condition is built into the hardware that generates the START cycle. Depending on the relative frequencies of the system clock and the I2Cn_SCL period, the

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processor may need to wait until the I2C is busy after writing the calling address to the I2DRn before proceeding with the following instructions.

The following example signals START and transmits the first byte of data (slave address):

- 1. Check I2SR*n*[IBB]. If it is set, wait until it is clear.
- 2. After cleared, set to transmit mode by setting I2CRn[MTX].
- 3. Set master mode by setting I2CRn[MSTA]. This generates a START condition.
- 4. Transmit the calling address via the I2DRn.
- 5. Check I2SRn[IBB]. If it is clear, wait until it is set and go to step #1.

29.4.3 Post-Transfer Software Response

Sending or receiving a byte sets the I2SRn[ICF], which indicates one byte communication is finished. I2SRn[IIF] is also set. An interrupt is generated if the interrupt function is enabled during initialization by setting I2CRn[IIEN]. Software must first clear I2SRn[IIF] in the interrupt routine. Reading from I2DRn in receive mode or writing to I2DRn in transmit mode can clear I2SRn[ICF].

Software can service the I²C I/O in the main program by monitoring the IIF bit if the interrupt function is disabled. Polling should monitor IIF rather than ICF, because that operation is different when arbitration is lost.

When an interrupt occurs at the end of the address cycle, the master is always in transmit mode; the address is sent. If master receive mode is required, I2CRn[MTX] should be toggled.

During slave-mode address cycles (I2SRn[IAAS] = 1), I2SRn[SRW] is read to determine the direction of the next transfer. MTX is programmed accordingly. For slave-mode data cycles (IAAS = 0), SRW is invalid. MTX should be read to determine the current transfer direction.

The following is an example of a software response by a master transmitter in the interrupt routine (see Figure 29-14).

- 1. Clear the I2CR*n*[IIF] flag.
- 2. Check if acknowledge has been received, I2SRn[RXAK].
- 3. If no ACK, end transmission. Else, transmit next byte of data via I2DRn.

29.4.4 Generation of STOP

A data transfer ends when the master signals a STOP, which can occur after all data is sent, as in the following example.

- 1. Check if acknowledge has been received, I2SR*n*[RXAK]. If no ACK, end transmission and go to step #5.
- 2. Get value from transmitting counter, TXCNT. If no more data, go to step #5.
- 3. Transmit next byte of data via I2DRn.
- 4. Decrement TXCNT and go to step #1
- 5. Generate a stop condition by clearing I2CRn[MSTA].

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I²C Interface

For a master receiver to terminate a data transfer, it must inform the slave transmitter by not acknowledging the last data byte. This is done by setting I2CRn[TXAK] before reading the next-to-last byte. Before the last byte is read, a STOP signal must be generated, as in the following example.

- Decrement RXCNT.
- 2. If last byte (RXCNT = 0) go to step #4.
- 3. If next to last byte (RXCNT = 1), set I2CRn[TXAK] to disable ACK and go to step #5.
- 4. This is last byte, so clear I2CRn[MSTA] to generate a STOP signal.
- 5. Read data from I2DRn.
- 6. If there is more data to be read (RXCNT \neq 0), go to step #1 if desired.

29.4.5 Generation of Repeated START

If the master wants the bus after the data transfer, it can signal another START followed by another slave address without signaling a STOP, as in the following example.

- 1. Generate a repeated START by setting I2CRn[RSTA].
- 2. Transmit the calling address via I2DRn.

29.4.6 Slave Mode

In the slave interrupt service routine, software must poll the I2SRn[IAAS] bit to determine if the controller has received its slave address. If IAAS is set, software must set the transmit/receive mode select bit (I2CRn[MTX]) according to the I2SRn[SRW]. Writing to I2CRn clears IAAS automatically. The only time IAAS is read as set is from the interrupt at the end of the address cycle where an address match occurred; interrupts resulting from subsequent data transfers have IAAS cleared. A data transfer can now be initiated by writing information to I2DRn for slave transmits, or read from I2DRn in slave-receive mode. A dummy read of I2DRn in slave/receive mode releases I2Cn_SCL, allowing the master to send data

In the slave transmitter routine, I2SR*n*[RXAK] must be tested before sending the next byte of data. Setting RXAK means an end-of-data signal from the master receiver, after which software must switch it from transmitter to receiver mode. Reading I2DR*n* releases I2C*n*_SCL so the master can generate a STOP signal.

29.4.7 Arbitration Lost

If several devices try to engage the bus at the same time, one becomes master. Hardware immediately switches devices that lose arbitration to slave receive mode. Data output to I2Cn_SDA stops, but I2Cn_SCL continues generating until the end of the byte during which arbitration is lost. An interrupt occurs at the falling edge of the ninth clock of this transfer with I2SRn[IAL] set and I2CRn[MSTA] cleared.

If a non-master device tries to transmit or execute a START, hardware inhibits the transmission, clears MSTA without signaling a STOP, generates an interrupt to the CPU, and sets IAL to indicate a failed



attempt to engage the bus. When considering these cases, slave service routine should first test IAL and software should clear it if it is set.

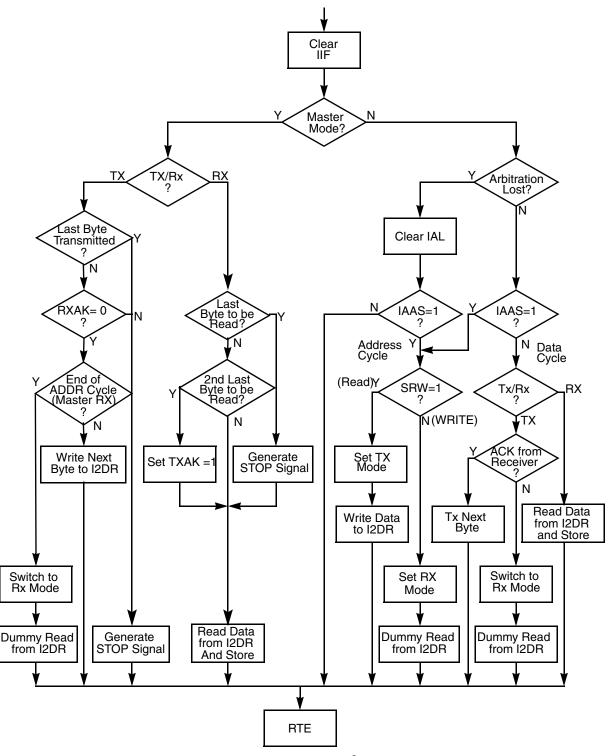


Figure 29-14. Flow-Chart of Typical I²C Interrupt Routine



Chapter 30 Analog-to-Digital Converter (ADC)

30.1 Introduction

The analog-to-digital converter (ADC) consists of two separate and complete ADCs, each with their own sample and hold circuits. The converters share a common voltage reference and common digital control module.

30.2 Features

The ADC's characteristics include the following:

- 12-bit resolution
- Maximum ADC clock frequency of 5.0 MHz, 200 ns period
- Sampling rate up to 1.66 million samples per second¹
- Single conversion time of 8.5 ADC clock cycles $(8.5 \times 200 \text{ ns} = 1.7 \mu\text{s})$
- Additional conversion time of 6 ADC clock cycles ($6 \times 200 \text{ ns} = 1.2 \mu \text{s}$)
- Eight conversions in 26.5 ADC clocks ($26.5 \times 200 \text{ ns} = 5.3 \mu \text{s}$) using simultaneous mode
- Ability to simultaneously sample and hold 2 inputs
- Ability to sequentially scan and store up to 8 measurements
- Internal multiplex to select two of 8 inputs
- Power savings modes allow automatic shutdown/startup of all or part of ADC
- Those inputs not selected tolerate injected/sourced current without affecting ADC performance, supporting operation in noisy industrial environments.
- Optional interrupts at the end of a scan, if an out-of-range limit is exceeded (high or low), or at zero crossing
- Optional sample correction by subtracting a pre-programmed offset value
- Signed or unsigned result
- Single ended or differential inputs for all input pins with support for an arbitrary mix of input types

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^{1.} In loop mode, the time between each conversion is 6 ADC clock cycles (1.2 μ s at 5.0 MHz). Using simultaneous conversion, two samples are captured in 1.2 μ s, providing an overall sample rate of 1.66 million samples per second.



30.3 Block Diagram

The ADC function, shown in **Figure 30-1**, consists of two four-channel input select functions, interfacing with two independent Sample and Hold (S/H) circuits, which feed two 12-bit ADCs. The two converters store their results in a buffer, awaiting further processing.

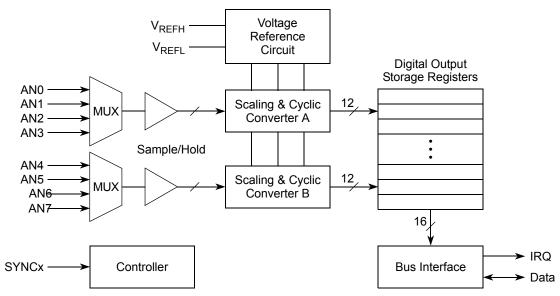


Figure 30-1. Dual ADC Block Diagram

30.4 Memory Map and Register Definition

This section presents the registers of the ADC module. A summary of these registers is given in Table 30-1. All ADC registers are supervisor-mode access only.

| IPSBAR Offset ¹ | Register | Width (bits) | Access | Reset Value | Section/Page |
|----------------------------|--|-----------------|--------|-------------|---------------|
| 0x19_0000 | Control Register 1 (CTRL1) | 16 | R/W | 0x5005 | 30.4.1/30-3 |
| 0x19_0002 | Control Register 2 (CTRL2) | 16 | R/W | 0x0002 | 30.4.2/30-5 |
| 0x19_0004 | Zero Crossing Control Register (ADZCC) | 16 | R/W | 0x0000 | 30.4.3/30-8 |
| 0x19_0006 | Channel List Register 1 (ADLST1) | 16 | R/W | 0x3210 | 30.4.4/30-8 |
| 0x19_0008 | Channel List Register 2 (ADLST2) | 16 | R/W | 0x7654 | 30.4.4/30-8 |
| 0x19_000A | Sample Disable Register (ADSDIS) | 16 | R/W | 0x0000 | 30.4.5/30-10 |
| 0x19_000C | Status Register (ADSTAT) | 16 | R/W | 0x0000 | 30.4.6/30-11 |
| 0x19_000E | Limit Status Register (ADLSTAT) | 16 | R/W | 0x0000 | 30.4.7/30-13 |
| 0x19_0010 | Zero Crossing Status Register (ADZCSTAT) | 16 | R/W | 0x0000 | 30.4.8/30-14 |
| 0x19_0012-20 | Result Registers 0-7 (ADRSLT0-7) | 16 | R/W | 0x0000 | 30.4.9/30-14 |
| 0x19_0022-30 | Low Limit Registers 0-7 (ADLLMT0-7) | 16 | R/W | 0x0000 | 30.4.10/30-15 |

Table 30-1. ADC Register Summary

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Analog-to-Digital Converter (ADC)

Table 30-1. ADC Register Summary (continued)

| IPSBAR Offset ¹ | Register | Width (bits) | Access | Reset Value | Section/Page |
|----------------------------|--------------------------------------|-----------------|--------|-------------|---------------|
| 0x19_0032-40 | High Limit Registers 0-7 (ADHLMT0-7) | 16 | R/W | 0x0000 | 30.4.10/30-15 |
| 0x19_0042-50 | Offset Registers 0-7 (ADOFS0-7) | 16 | R/W | 0x0000 | 30.4.11/30-17 |
| 0x19_0052 | Power Control Register (POWER) | 16 | R/W | 0x00D7 | 30.4.12/30-17 |
| 0x19_0054 | Voltage Reference Register (CAL) | 16 | R/W | 0x0000 | 30.4.13/30-20 |

¹ Addresses not assigned to a register and undefined register bits are reserved for expansion.

30.4.1 Control 1 Register (CTRL1)

The CTRL1 register, shown in Figure 30-2, is used to configure and control the ADC module. The associated field descriptions are given in Table 30-2. Please see Section 30.5.6, "Scan Configuration and Control" for details on the functionality controlled by this register.

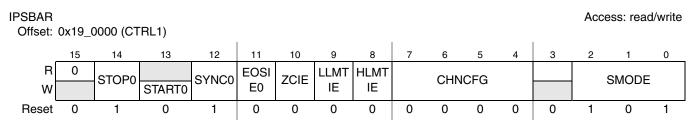


Figure 30-2. Control 1 Register (CTRL1)

Table 30-2. CTRL1 Field Descriptions

| Field | Description | | | | | | |
|--------------|--|--|--|--|--|--|--|
| 15 | Reserved, should be cleared. | | | | | | |
| 14 STOP0 | Stop Conversion 0 bit. When STOP0 is set, the current scan is stopped and no further scans can start. Any further SYNC0 input pulses (see the SYNC0 field description) or writes to START0 are ignored until STOP0 is cleared. After the ADC is in stop mode, the result registers can be modified by the processor. Any changes to the result registers in stop mode are treated as if the analog core supplied the data. Therefore, limit checking, zero crossing, and associated interrupts can occur if enabled. O Normal operation Stop mode | | | | | | |
| | Note: This is not the same as the device's STOP mode. | | | | | | |
| 13 START0 | Start Conversion 0 bit. A scan is started by writing a 1 to this bit. START0 is write-only. Writing 1 to the START0 bit again is ignored until the end of the current scan. The ADC must be in a stable power configuration prior to writing to START0 (see Section 30.5.8, "Power Management"). 0 No action 1 Start command is issued | | | | | | |

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Table 30-2. CTRL1 Field Descriptions (continued)

| Field | Description | | | | |
|--------------|---|--|--|--|--|
| 12 SYNC0 | Synchronization 0 Enable bit. When this bit is set, a conversion may be initiated by asserting a positive edge on the SYNC0 input. Any subsequent SYNC0 input pulses that occur during the scan are ignored. In once sequential and once parallel scan modes, only the first SYNC0 input pulse is honored. Subsequent SYNC0 input pulses are ignored until SYNC0 input is re-armed by setting SYNC0. This can be done at any time, eve during the execution of the scan. The ADC must be in a stable power configuration prior to writing to STARTO (see Section 30.5.8, "Power Management"). O Scan is initiated by a write to the STARTO bit only Scan is initiated by a SYNC0 input pulse or a write to the STARTO bit | | | | |
| 11 EOSIE0 | End of Scan Interrupt 0 Enable bit. This bit enables an EOSI0 interrupt to be generated upon completion of the scan. For looping scan modes, the interrupt triggers after the completion of each iteration of the loop. 0 Interrupt disabled 1 Interrupt enabled | | | | |
| 10 ZCIE | Zero Crossing Interrupt Enable bit. This bit enables the zero crossing interrupt if the current result value has a sign change from the previous result as configured by the ADZCC register. 1 Interrupt enabled | | | | |
| 9 LLMTIE | Low Limit Interrupt Enable bit. This bit enables the low limit exceeded interrupt when the current result value is less than the low limit register value. The raw result value is compared to ADLLMTn[LLMT] before the offset register value is subtracted. 0 Interrupt disabled 1 Interrupt enabled | | | | |
| 8 HLMTIE | High Limit Interrupt Enable bit. This bit enables the high limit exceeded interrupt if the current result value is greater than the high limit register value. The raw result value is compared to ADHLMT[HLMT] before the offset register value is subtracted. O Interrupt disabled Interrupt enabled | | | | |



Analog-to-Digital Converter (ADC)

Table 30-2. CTRL1 Field Descriptions (continued)

| 7–4 Ch | nannel Configure. This | field configuration | | | | |
|---------------------------------------|--|---|---|--|--|--|
| | | Channel Configure. This field configures the inputs for single-ended or differential conversions: | | | | |
| | CHNCFG | Inputs | Description | | | |
| | xxx1 | AN0-AN1 | Configured as differential pair (AN0 is + and AN1 is -) | | | |
| | xxx0 | | Both configured as single ended inputs | | | |
| | xx1x | AN2-AN3 | Configured as differential pair (AN2 is + and AN3 is -) | | | |
| | xx0x | | Both configured as single ended inputs | | | |
| | x1xx | AN4-AN5 | Configured as differential pair (AN4 is + and AN5 is -) | | | |
| | x0xx | = | Both configured as single ended inputs | | | |
| | 1xxx | AN6-AN7 | Configured as differential pair (AN6 is + and AN7 is -) | | | |
| | 0xxx | | Both configured as single ended inputs | | | |
| MODE Co 00 00 01 01 10 | onfiguration and Contro O Once sequential Once parallel Loop sequential Loop parallel Triggered sequential Triggered parallel (Reserved; do not u | ol" for details on al default) ise | ne scan mode of the ADC module. See Section 30.5.6, "Seach scan mode. | | | |

30.4.2 Control 2 Register (CTRL2)

The structure of the CTRL2 register depends on whether the ADC is operating in sequential or parallel mode (see Section 30.4.1, "Control 1 Register (CTRL1)").

30.4.2.1 CTRL2 Under Sequential Scan Modes

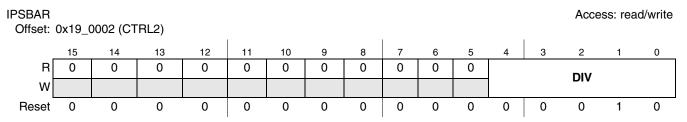


Figure 30-3. Control 2 Register (CTRL2) Under Sequential Scan Modes

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| Table 30-3. CTRL2 Field Descriptions Under Sequential Scan Mode | Table 30-3 | CTRL2 Field | Descriptions | Under Sec | uential Scan | Modes |
|---|------------|-------------|--------------|------------------|--------------|-------|
|---|------------|-------------|--------------|------------------|--------------|-------|

| Field | Description |
|------------|--|
| 15–5 | Reserved, should be cleared. |
| 4–0 DIV | Clock Divisor Select. This field controls the divider circuit, which generates the ADC clock by dividing the system clock by 2×(DIV+1). DIV must be chosen so the ADC clock does not exceed 5.0 MHz. See Table 30-5 for a listing of ADC clock frequency based on the value of DIV for several configurations. |

30.4.2.2 CTRL2 Under Parallel Scan Modes

When the ADC operates in a parallel scan mode, the CTRL2 register is used to control the operation of converter B. The interaction between converters A and B (and hence CTRL1 and CTRL2) is determined by the CTRL2[SIMULT] bit. By default, CTRL2[SIMULT] equals 1 and converter B operates together with converter A. In this case, the STOP1, START1, SYNC1, and EOSIE1 bits in the CTRL2 register do not affect converter B operation. If CTRL2[SIMULT] equals 0, these bits and the SYNC1 input are used to control the converter B scan. In this case, EOSIE1 enables the EOSI1 interrupt, signaling the end of a B converter scan. In addition, ADSTAT[CIP1] is used to indicate a converter B scan is active.

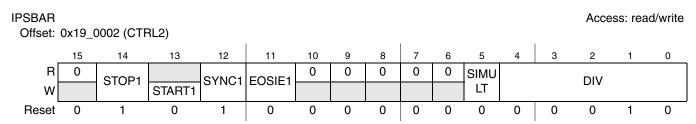


Figure 30-4. Control 2 Register (CTRL2) Under Parallel Scan Modes

Table 30-4. CTRL2 Field Descriptions Under Parallel Scan Modes

| Field | Description | | | | |
|--------------|---|--|--|--|--|
| 15 | Reserved, should be cleared. | | | | |
| 14 STOP1 | Stop Conversion 1bit. In parallel-scan modes when SIMULT equaling 0, setting STOP1 stops parallel scans in the B converter and prevents new scans from starting. Any further SYNC1 input pulses (see the SYNC1 field description) or writes to START1 are ignored until STOP1 is cleared. After the ADC is in stop mode, the result registers can be modified by the processor. Any changes to the result registers in stop mode are treated as if the analog core supplied the data. Therefore, limit checking, zero crossing, and associated interrupts can occur if enabled. O Normal operation Stop mode | | | | |
| | Note: This is not the same as the device's STOP mode. | | | | |
| 13 START1 | Start Conversion 1 bit. In parallel-scan modes when SIMULT equaling 0, a scan by the B converter is started by writing a 1 to this bit. START1 is write-only. Writing 1 to the START1 bit again is ignored until the end of the current scan. The ADC must be in a stable power configuration prior to writing to START1 (see Section 30.5.8, "Power Management"). O No action Start command is issued | | | | |



Analog-to-Digital Converter (ADC)

Table 30-4. CTRL2 Field Descriptions Under Parallel Scan Modes (continued)

| Field | Description |
|--------------|--|
| 12 SYNC1 | Synchronization 1 Enable bit. In parallel-scan modes when SIMULT equaling 0, setting SYNC1 allows a conversion to be initiated by asserting a positive edge on the SYNC1 input. Any subsequent SYNC1 input pulses that occur during the scan are ignored. In once sequential and once parallel scan modes, only the first SYNC1 input pulse is honored. Subsequent SYNC1 input pulses are ignored until SYNC1 input is re-armed by setting SYNC1. This can be done at any time, even during the execution of the scan. The ADC must be in a stable power configuration prior to writing to START0 (see Section 30.5.8, "Power Management"). O Scan is initiated by a write to the START1 bit only Scan is initiated by a SYNC1 input pulse or a write to the START1 bit |
| 11 EOSIE1 | End of Scan Interrupt 1 Enable bit. In parallel-scan modes when SIMULT equaling 0, this bit enables an EOSI1 interrupt to be generated upon completion of the scan. For looping scan modes, the interrupt triggers after the completion of each iteration of the loop. 0 Interrupt disabled 1 Interrupt enabled |
| 10–6 | Reserved, should be cleared. |
| 5 SIMULT | Simultaneous Mode bit. This bit only affects parallel scan modes. When SIMULT equals 1, parallel scans operate in simultaneous mode. The scans in the A and B converter operate simultaneously and always result in pairs of simultaneous conversions in the A and B converter. STARTO, STOPO, SYNCO, and EOSIEO control bits and the SYNCO input are used to start and stop scans in both converters simultaneously. A scan ends in both converters when either converter encounters a disabled sample slot. When the parallel scan completes, the EOSIO triggers if EOSIEO is set. The CIPO status bit indicates that a parallel scan is in process. When SIMULT equals 0, parallel scans in the A and B converters operate independently. The B converter has its own independent set of the above controls (START1, STOP1, SYNC1, EOSIE1, SYNC1) designed to control its operation and report its status. Each converter's scan continues until its sample list is exhausted (four samples) or a disabled sample is encountered. For looping parallel scan mode, each converter starts its next iteration as soon as the previous iteration in that converter is complete and continues until the STOP bit for that converter is asserted. O Parallel scans occur independently 1 Parallel scans occur simultaneously (default) |
| 4–0 DIV | Clock Divisor Select. This field controls the divider circuit, which generates the ADC clock by dividing the system clock by 2×DIV+1. DIV must be chosen so the ADC clock does not exceed 5.0 MHz. See Table 30-5 for a listing of ADC clock frequency based on the value of DIV for several configurations. |

Table 30-5. ADC Clock Frequency for Various Conversion Clock Sources

| DIV | Divisor | ROSC Standby 400 kHz | ROSC Normal 8 MHz | PLL 64 MHz | External CLK |
|-------|---------|-------------------------|----------------------|------------------|-----------------|
| | | 200 kHz Sys Clock | 4 MHz Sys Clock | 32 MHz Sys Clock | CLK/2 Sys Clock |
| 00000 | 2 | 100 kHz | 2.00 MHz | 16.0 MHz | CLK/4 |
| 00001 | 4 | 100 kHz | 1.00 MHz | 8.00 MHz | CLK/8 |
| 00010 | 6 | 100 kHz | 500 kHz | 5.33 MHz | CLK/12 |
| 00011 | 8 | 100 kHz | 250 kHz | 4.00 MHz | CLK/16 |
| 00100 | 10 | 100 kHz | 125 kHz | 3.20 MHz | CLK/20 |
| _ | _ | _ | _ | _ | _ |

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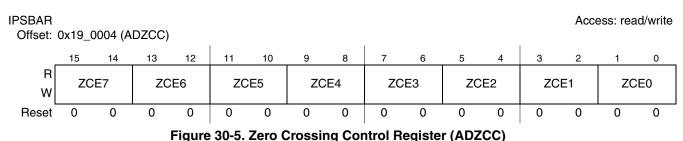


Table 30-5. ADC Clock Frequency for Various Conversion Clock Sources (continued)

| _ | 1 | _ | _ | _ | _ |
|-------|----|---------|----------|---------|---------|
| 11111 | 64 | 100 kHz | 62.5 kHz | 500 kHz | CLK/128 |

30.4.3 Zero Crossing Control Register (ADZCC)

The ADC zero crossing control (ADZCC) register provides the ability to monitor the selected channels and determine the direction of zero crossing triggering the optional interrupt. Zero crossing logic monitors only the sign change between current and previous sample. The ZCE0 bit monitors the sample stored in ADRSLT0, ZCE1 bit monitors ADRSLT1, and ZCE7 bit monitors ADRSLT7. When the zero crossing is disabled for a selected result register, sign changes are not monitored or updated in the ADZCSTAT register.



| Field | Description | | |
|----------------------|---|--|--|
| 15–0 ZCE <i>n</i> | Zero Crossing Enable. For each channel <i>n</i> , setting the ZCE <i>n</i> field allows detection of the indicated zero crossing condition, provided the corresponding offset register (ADOFS <i>n</i>) has a value <i>offset</i> , 0 < <i>offset</i> < 0x7FF8. 00 Zero crossing disabled 01 Zero crossing enabled for positive to negative sign change 10 Zero crossing enabled for negative to positive sign change 11 Zero crossing enabled for any sign change | | |

Table 30-6. ADZCC Field Descriptions

30.4.4 Channel List 1 and 2 Registers (ADLST1 and ADLST2)

The channel list register contains an ordered list of the analog input channels to be converted when the next scan is initiated. If all samples are enabled in the ADSDIS register, a sequential scan of inputs proceeds in order of SAMPLE0 through SAMPLE7. If one of the parallel sampling modes is selected instead, the converter A sampling order is SAMPLE0-3, and the converter B sampling order is SAMPLE4-7.

In sequential modes, the sample slots are converted in order from SAMPLE0 to SAMPLE7. Analog input pins can be sampled in any order, including sampling the same input pin more than once.

In parallel modes, converter A processes sample slots SAMPLE0 through SAMPLE3, while converter B processes sample slots SAMPLE4 through SAMPLE7. Because converter A only has access to analog inputs AN0 through AN3, sample slots SAMPLE0-3 should only contain binary values between 000 and 011. Likewise, because converter B only has access to analog inputs AN4 through AN7, sample slots



SAMPLE4-7 should only contain binary values between 100 and 111. No damage occurs if this constraint is violated, but results are undefined.

When inputs are configured as differential pairs, a reference to either analog input in a differential pair by a sample slot implies a differential measurement on the pair. The details of single ended and differential measurement are described in Section 30.5.2.1, "Single-Ended Samples" and Section 30.5.2.2, "Differential Samples". Sample slots are disabled using the ADSDIS register.

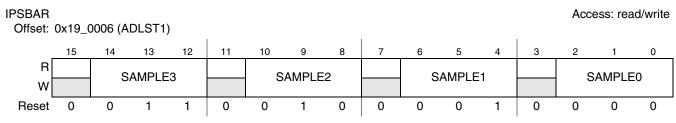


Figure 30-6. Channel List 1 Register (ADLST1)

Table 30-7. ADLST1 Field Descriptions

| Field | Description | |
|------------------|---|--|
| 15 | Reserved, should be cleared. | |
| 14–12 SAMPLE3 | Sample input channel select 3. The settings for this field are given in Table 30-9. | |
| 11 | Reserved, should be cleared. | |
| 10–8 SAMPLE2 | Sample input channel select 2. The settings for this field are given in Table 30-9. | |
| 7 | Reserved, should be cleared. | |
| 6–4 SAMPLE1 | Sample input channel select 1. The settings for this field are given in Table 30-9. | |
| 3 | Reserved, should be cleared. | |
| 2–0 SAMPLE0 | Sample input channel select 0. The settings for this field are given in Table 30-9. | |

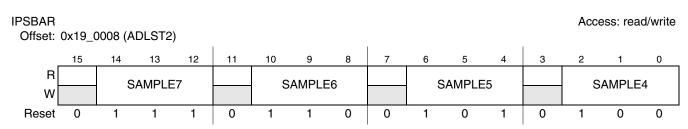


Figure 30-7. Channel List 2 Register (ADLST2)

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Table 30-8. ADLST2 Field Descriptions

| Field | Description | |
|------------------|---|--|
| 15 | Reserved, should be cleared. | |
| 14-12 SAMPLE7 | Sample input channel select 7. The settings for this field are given in Table 30-9. | |
| 11 | Reserved, should be cleared. | |
| 10–8 SAMPLE6 | Sample input channel select 6. The settings for this field are given in Table 30-9. | |
| 7 | Reserved, should be cleared. | |
| 6–4 SAMPLE5 | Sample input channel select 5. The settings for this field are given in Table 30-9. | |
| 3 | Reserved, should be cleared. | |
| 2-0 SAMPLE4 | Sample input channel select 4. The settings for this field are given in Table 30-9. | |

Table 30-9. ADC Input Conversion for Sample Bits

| SAMPLEn[2:0] | | | 400 14 | Nine Colombad |
|----------------------------|--------------------------------|--------------------------------|--------------|---------------|
| Sequential Mode Parallel N | | l Mode | ADC input i | Pins Selected |
| <i>n</i> =0,1,2,,7 | <i>n</i> =0,1,2,3 (Conv. A) | <i>n</i> =4,5,6,7 (Conv. B) | Single Ended | Differential |
| 000 | 000 | | AN0 | AN0+, AN1- |
| 001 | 001 | | AN1 | - |
| 010 | 010 | | AN2 | AN2+, AN3- |
| 011 | 011 | | AN3 | |
| 100 | | 100 | AN4 | AN4+, AN5- |
| 101 | | 101 | AN5 | |
| 110 | | 110 | AN6 | AN6+, AN7- |
| 111 | | 111 | AN7 | |

30.4.5 Sample Disable Register (ADSDIS)

This register is an extension to the ADLST1 and ADLST2, providing the ability to enable only the desired samples programmed in the SAMPLE0–SAMPLE7. At reset, all samples are enabled. For example, if in sequential mode and bit DS5 is set to 1, SAMPLE0 through SAMPLE4 are sampled. However, if in parallel mode and bits DS5 or DS1 are set to 1, only SAMPLE0 and SAMPLE4 are sampled.



IPSBAR Access: read/write Offset: 0x19_000A (ADSDIS) 12 11 10 8 7 6 4 1 0 0 0 0 0 0 0 0 0 R DS7 DS₆ DS5 DS4 DS3 DS₂ DS₁ DS0 W 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 Reset

Figure 30-8. Sample Disable Register (ADSDIS)

Table 30-10. ADSDIS Field Descriptions

| Field | Description | | |
|--------------------|--|--|--|
| 15–8 | Reserved, should be cleared. | | |
| 7–0 DS <i>n</i> | Disable Sample bits. Setting or clearing DSn enables or disables the corresponding SAMPLEn field. 1 Disable SAMPLEn and all subsequent samples. Which samples are actually disabled depends on the conversion mode, sequential/parallel, and the value of SIMULT. | | |

30.4.6 **Status Register (ADSTAT)**

This register provides the current status of the ADC module. RDYn bits are cleared by reading their corresponding result (ADRSLTn) registers. The HLMTI and LLMTI bits are cleared by writing 1 to each asserted bit in the ADC limit status (ADLSTAT) register. Likewise, the ZCI bit is cleared by writing 1 to each asserted bit in the ADC zero crossing status (ADZCSTAT) register. The EOSIn bits are cleared by writing 1 to them.

Except for CIP0 and CIP1 all bits in ADSTAT are sticky – after being set, they require some specific action to be cleared. They are not cleared automatically on the next scan sequence.

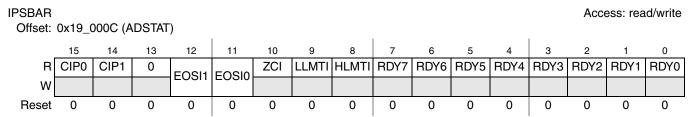


Figure 30-9. Status Register (ADSTAT)

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Table 30-11. ADSTAT Field Descriptions

| Field | Description |
|-------------|--|
| 15 CIP0 | Conversion in Progress 0 bit. This bit indicates when a scan is in progress. This bit supports any sequential scan or parallel scan with SIMULT equaling 1. When executing a parallel scan with SIMULT equaling 0, this bit services the scan of converter A, and the CIP1 bit services the scan of converter B. 0 Idle state 1 A scan cycle is in progress (the ADC ignores all sync pulses or start commands) |
| 14 CIP1 | Conversion in Progress 1 bit. This refers only to a B converter scan in non-simultaneous (SIMULT=0) parallel scan modes. O Idle state 1 A scan cycle is in progress (the ADC ignores all sync pulses or start commands) |
| 13 | Reserved, should be cleared. |
| 12 EOSI1 | End of Scan Interrupt 1 bit. This bit indicates whether a scan of analog inputs has been completed since the last read of ADSTAT or a reset. The EOSI1 bit is cleared by writing a 1 to it. This bit cannot be set by software. In looping scan modes, this interrupt is triggered at the completion of each iteration of the loop. This interrupt is triggered only by the completion of a B converter scan in non-simultaneous (SIMULT=0) parallel scan modes. In this case the EOSI0 interrupt is triggered when converter A completes its scan. O A scan cycle has not been completed, no end of scan IRQ pending A scan cycle has been completed, end of scan IRQ pending |
| 11 EOSI0 | End of Scan Interrupt 0 bit. This bit indicates whether a scan of analog inputs has been completed since the last read of ADSTAT or a reset. The EOSI0 bit is cleared by writing a 1 to it. This bit cannot be set by software. EOSI0 is the preferred bit to poll for scan completion if interrupts are not enabled. In looping scan modes, this interrupt is triggered at the completion of each iteration of a loop. This interrupt is triggered upon the completion of any sequential scan or parallel scan with SIMULT equaling 1. When executing parallel scans with SIMULT equaling 0, this interrupt is triggered when converter A completes its scan while the EOSI1 interrupt services converter B. O A scan cycle has not been completed, no end of scan IRQ pending 1 A scan cycle has been completed, end of scan IRQ pending |
| 10 ZCI | Zero Crossing Interrupt bit. This bit is asserted at the completion of an individual conversion experiencing a zero crossing enabled in the ADC zero crossing control (ADZCC) register. The bit is set as soon as an enabled zero crossing event occurs rather than at the end of the ADC scan. ZCI is cleared by writing 1 to all active ADZCSTAT[ZCS] bits. O No ZCI interrupt request 1 Zero crossing encountered; IRQ pending if CTRL1[ZCIE] is set |
| 9 LLMTI | Low Limit Interrupt bit. If any low limit register (ADLLMTn) is enabled by having a value other than 0x0, low limit checking is enabled. This bit is set at the completion of an individual conversion which may or may not be the end of a scan. It is cleared by writing 1 to all active ADLSTAT[LLS] bits. O No low limit interrupt request 1 Low limit exceeded, IRQ pending if CTRL1[LLMTIE] is set |



Table 30-11. ADSTAT Field Descriptions (continued)

| Field | Description | | |
|---------------------|--|--|--|
| 8 HLMTI | High Limit Interrupt bit. If any high limit register (ADHLMTn) is enabled by having a value other than 0x7FF8, high limit checking is enabled. This bit is set at the completion of an individual conversion which may or may not be the end of a scan. It is cleared by writing 1 to all active ADLSTAT[HLS] bits. O No high limit interrupt request High limit exceeded, IRQ pending if CTRL1[HLMTIE] is set | | |
| 7–0 RDY <i>n</i> | Ready Sample bits. These bits indicate samples 7-0 are ready to be read. The RDYn bits are set as the individual channel conversions are completed and stored in a ADRSLTn register. These bits are cleared after a read from the corresponding ADC results (ADRSLTn) register. If polling the RDYn bits to determine if a particular sample is executed, care should be taken not to start a new scan until all enabled samples are completed. O Sample not ready or has been read Sample ready to be read Note: RDYn bits can be cleared when the debugger reads the corresponding results register during a debug session. | | |

30.4.7 Limit Status Register (ADLSTAT)

The ADC limit status (ADLSTAT) register latches in the result of the comparison between the result of the sample in the ADRSLT*n* register and the respective limit register, ADHLMT*n* or ADLLMT*n*.

For example, if the result for ADRSLT0 is greater than the value programmed into ADHLMT0, then the the HLS0 bit is set. An interrupt is generated if CTRL1[HLMTIE] is set.

These bits are sticky—they are not cleared automatically by subsequent conversions. A bit may only be cleared by writing a 1 to it.

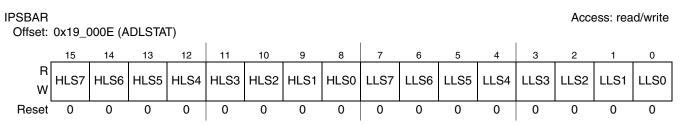


Figure 30-10. Limit Status Register (ADLSTAT)

Table 30-12. ADLSTAT Field Descriptions

| Field | Description | | |
|----------------------|---|--|--|
| 15–8 HLS <i>n</i> | High Limit Status bits. These bits hold the result of a comparison between the sample (stored in ADRSLTn) and the high-limit value (stored in ADHLMTn). O Sample n is less than or equal to the associated high-limit value 1 Sample n is greater than the associated high-limit value Note: These bits are sticky, and can only be cleared by writing a 1 to them. | | |
| 7–0 LLS <i>n</i> | Low Limit Status bits. These bits hold the result of a comparison between the sample (stored in ADRSLT and the low-limit value (stored in ADLLMT <i>n</i>). O Sample <i>n</i> is greater than or equal to the associated low-limit value Sample <i>n</i> is less than the associated low-limit value Note: These bits are sticky, and can only be cleared by writing a 1 to them. | | |

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30.4.8 Zero Crossing Status Register (ADZCSTAT)

The ADC zero crossing status (ADZCSTAT) register latches in the result of a sign comparison between the current and previous sample. The type of comparison is controlled by the ADZCC register (see Section 30.4.3, "Zero Crossing Control Register (ADZCC)").

For example, if the result for the channel programmed in SAMPLE0 changes sign from the previous conversion, and the respective ZCE bit in the ADZCC register is set to 0b11 (any edge change), then the ZCS0 bit is set. An interrupt is generated if CTRL1[ZCIE] is set.

These bits are sticky—they are not cleared automatically by subsequent conversions. A bit may only be cleared by writing a 1 to it.

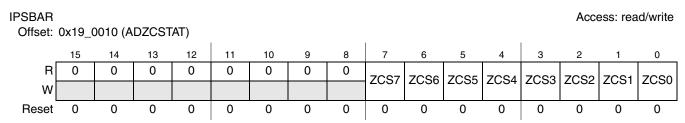


Figure 30-11. Zero Crossing Status Register (ADZCSTAT)

| Field | Description |
|-------------|---|
| 15–8 | Reserved, should be cleared. |
| 7–0 ZCSn | Zero Crossing Status bits. These bits hold the result of a sign comparison between the current and previous sample. The type of comparison is controlled by the ADZCC register (see Section 30.4.3, "Zero Crossing Control Register (ADZCC)"). 0 Sample did not change sign, or sign comparison is disabled 1 Sample changed sign Note: These bits are sticky, and can only be cleared by writing a 1 to them. |

Table 30-13. ADLSTAT Field Descriptions

30.4.9 Result Registers (ADRSLTn)

The 8 result registers contain the converted results from a scan. The SAMPLE*n* result is loaded into ADRSLT*n*. In a simultaneous parallel scan mode, the first channel pair, designated by SAMPLE0 and SAMPLE4 in register LIST1/2, is stored in ADRSLT0 and ADRSLT4, respectively.

When writing to this register, only the RSLT portion of the value written is used. This value is modified as shown in Figure 30-23 and the result of the subtraction is stored. The SEXT bit is only set as a result of this subtraction and is not directly determined by the value written.

RSLT can be interpreted as a signed integer or a signed fixed point (fractional) number. As a fixed point number, RSLT can be used directly. If RSLT is interpreted as a signed integer, you have two options:

- Right shift with sign extend (ASR) three places to fit it into the range [0,4095]
- Accept the number as presented in the register, knowing there are missing codes, because the lower three LSBs are always zero

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Negative results (SEXT = 1) are always presented in twos-complement format. If an application requires that the result be always positive, the corresponding offset register (ADOFSn) must be set to 0x0.

The interpretation of the numbers programmed into the ADC limit and offset registers (ADLLMT*n*, ADHLMT*n*, and ADOFS*n*) must match your interpretation of the result register.

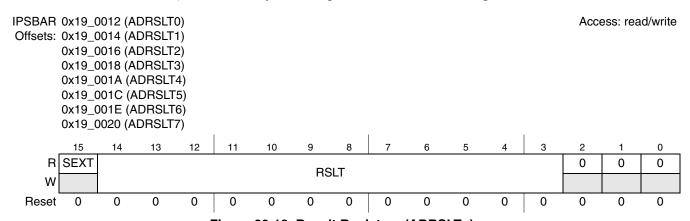


Figure 30-12. Result Registers (ADRSLT*n*)

Table 30-14. ADRSLTn Field Descriptions

| Field | Description | | |
|--------------|--|--|--|
| 15 SEXT | Sign Extend bit. 0 Result is positive 1 Result is negative Note: If only positive results are required, then the respective offset register (ADOFS <i>n</i>) must be set to 0x0. | | |
| 14–3 RSLT | Result of the conversion. | | |
| 2–0 | Reserved, should be cleared. | | |

30.4.10 Low and High Limit Registers (ADLLMT*n* and ADHLMT*n*)

Each ADC sample is compared against the values in the limit registers. The comparison is based upon the raw conversion value before the offset correction is applied. Refer to Figure 30-23. ADC limit registers (ADLLMTn) and ADHLMTn) correspond to result registers (ADRSLTn). The high limit register is used for the comparison of result > high limit. The low limit register is used for the comparison of result < low limit.

Limit checking can be disabled by programming the respective limit register with 0x7FF8 for the high limit and 0x0000 for the low limit. At reset, limit checking is disabled.

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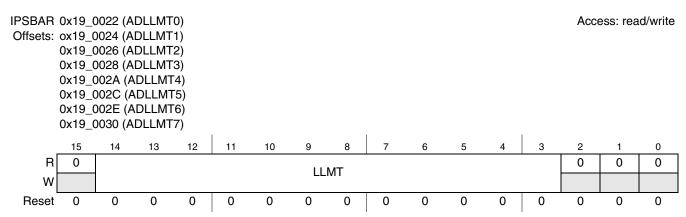


Figure 30-13. Low Limit Registers (ADLLMTn)

Table 30-15. ADLLMTn Field Descriptions

| Field | Description |
|--------------|------------------------------|
| 15 | Reserved, should be cleared. |
| 14–3 LLMT | Low limit. |
| 2–0 | Reserved, should be cleared. |

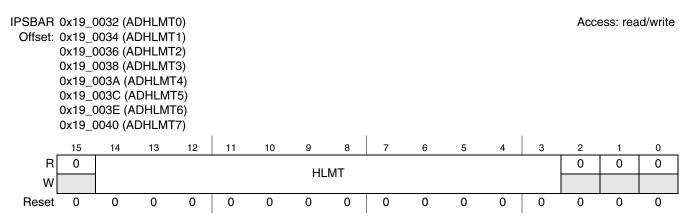


Figure 30-14. High Limit Registers (ADHLMTn)

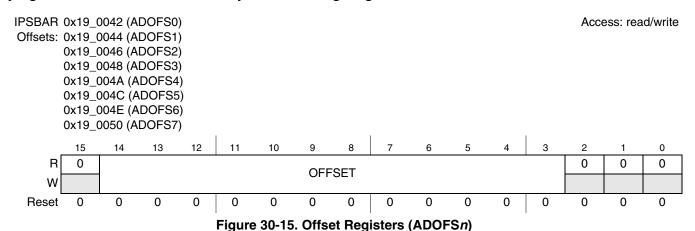
Table 30-16. ADHLMTn Field Descriptions

| Field | Description |
|--------------|------------------------------|
| 15 | Reserved, should be cleared. |
| 14–3 HLMT | High limit. |
| 2–0 | Reserved, should be cleared. |



30.4.11 Offset Registers (ADOFSn)

The values in the offset registers (ADOFSn) are subtracted from the raw ADC values, and the results are stored in the ADRSLTn registers. To obtain unsigned results, the respective offset register must be programmed with a value of 0x0 to yield a resulting range of 0x0 to 0x7FF8.



rigate of to. Offset flegisters (ABOTOM)

Table 30-17. ADOFS*n* Field Descriptions

| Field | Description | | | |
|----------------|---|--|--|--|
| 15 | Reserved, should be cleared. | | | |
| 14–3 OFFSET | Offset value. This value is subtracted from the raw ADC value, and the result is stored in the respective ADRSLT <i>n</i> register. | | | |
| 2–0 | Reserved, should be cleared. | | | |

30.4.12 Power Control Register (POWER)

This register controls the power management features of the ADC module. There are manual power-down control bits for the two ADC converters and the shared voltage reference generator. There are also 5 distinct power modes with related controls:

1. Powered-down state

Each converter and the voltage reference generator can individually be put into a powered down state. When powered down, the unit consumes no power. Results of scans referencing a powered down converter are undefined. The voltage reference generator and at least one converter must be powered up to use the ADC module.

2. Manual power-down controls

Each converter and the voltage reference generator have a manual power control bit capable of forcing that component into the power down state. Also, each converter and the voltage reference generator can be powered up/down automatically as part of ADC operation.

3. Idle state

The ADC module is idle when neither of the two converters has a scan in process.

4. Active state

The ADC module is active when at least one of the two converters has a scan in process.

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- 5. Current mode
- Normal current mode is used to power the converters at clock rates above 100 kHz.
- Standby current mode uses less power and is engaged only when the ADC clock is at 100 kHz. The current mode active does not affect the number of ADC clock cycles required to do a conversion or the accuracy of a conversion. The ADC module may change the current mode when idle as part of the power saving strategy. Both converters are in the same current mode at all times.

In addition to the power modes, there is startup delay:

Auto power-down and auto standby power modes cause a startup delay when the ADC module
goes between the idle and active states to allow time to switch clocks or power configurations. The
number of ADC clocks used in the startup delay is defined by the PUDELAY field.

See the discussion of power modes in the Functional Description Section 30.5, "Functional Description" for details of the 5 power modes and how to configure them. See Section 30.5.9, "ADC Clock," for a more detailed description of the clocking system and the control of current mode.

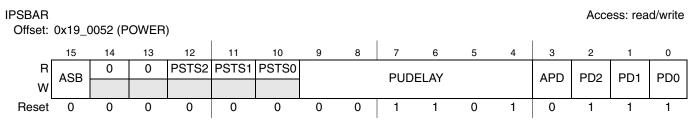


Figure 30-16. Power Control Register (POWER)

Table 30-18. POWER Field Descriptions

| Field | Description |
|-------------|---|
| 15 ASB | Auto Standby bit. This bit selects auto standby mode. ASB is ignored if APD is set. When the ADC is idle, auto standby mode selects the standby clock as the ADC clock source and puts the converters into standby current mode. At the start of any scan, the conversion clock is selected as the ADC clock and a delay of PUDELAY ADC clock cycles is imposed for current levels to stabilize. After this delay, the ADC initiates the scan. When the ADC returns to the idle state, the standby clock is again selected and the converters revert to the standby current state. O Auto standby mode disabled 1 Auto standby mode enabled |
| 14–13 | Reserved, should be cleared. |
| 12 PSTS2 | Voltage Reference Power Status bit. 0 Voltage reference circuit is currently enabled 1 Voltage reference circuit is currently disabled |
| 11 PSTS1 | Converter B Power Status bit. This bit is asserted immediately after PD1 is set. It is deasserted PUDELAY ADC clock cycles after PD1 is cleared if APD is 0. This bit can be read as a status bit to determine when the ADC is ready for operation. During auto power-down mode, this bit indicates the current powered state of converter B. 0 ADC converter B is currently enabled 1 ADC converter B is currently disabled |



Table 30-18. POWER Field Descriptions (continued)

| Field | Description | | | |
|----------------|---|--|--|--|
| 10 PSTS0 | Converter A Power Status bit. This bit is asserted immediately after PD0 is set. It is deasserted PUDELAY ADC clock cycles after PD0 is cleared if APD is 0. This bit can be read as a status bit to determine when the ADC is ready for operation. During auto power-down mode, this bit indicates the current powered state of converter A. 0 = ADC converter A is currently enabled 1 = ADC converter A is currently disabled | | | |
| 9–4 PUDELAY | Power-Up Delay. This field determines the number of ADC clock cycles provided to enable an ADC converter (after clearing PD0 or PD1) before allowing a scan to start. It also determines the number of ADC clock cycles of delay provided in auto power-down (APD) and auto standby (ASB) modes between when the ADC goes from the idle to active state and when the scan is allowed to start. The default value is 13 ADC clock cycles. Accuracy of the initial conversions in a scan is degraded if PUDELAY is too low. Note: PUDELAY defaults to a value typically sufficient for any power mode. The latency of a scan can be reduced by reducing PUDELAY to the lowest value for which accuracy is not degraded. Please refer | | | |
| | to the Device Data Sheet for further details. | | | |
| 3 APD | Auto Power-Down Mode bit. Auto power-down mode disables converters when they are not in use for a scan. APD takes precedence over ASB. When a scan is started in APD mode, a delay of PUDELAY ADC clock cycles is imposed during which the needed converter(s), if idle, are enabled. The ADC then initiates a scan equivalent to when APD is not active. When the scan is completed, the converter(s) are disabled again. O Auto power-down mode is not active 1 Auto power-down mode is active | | | |
| | Note: If ASB or APD is asserted while a scan is in progress, that scan is unaffected and the ADC waits to enter its low-power state until after all conversions are complete and both ADCs are idle. | | | |
| | Note: ASB and APD are not useful in looping modes. The continuous nature of scanning means the ADC can never enter the low-power state. | | | |
| 2 PD2 | Power-Down Control for Voltage Reference Circuit bit. This bit controls the power-down of the ADC's voltage reference circuit. This circuit is shared by both converters. When PD2 is set, the voltage reference is activated when PD1 or PD0 are enabled. It is not usually necessary to modify this bit, because disabling (powering-down) converter A and converter B automatically powers-down the voltage reference. O Manually power-up voltage reference circuit Power-down voltage reference circuit is controlled by PD0 and PD1 (default) | | | |

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Table 30-18. POWER Field Descriptions (continued)

| Field | Description |
|----------|---|
| 1 PD1 | Manual Power-Down for Converter B bit. This bit forces Converter B to power-down. Setting PD1 powers-down converter B immediately. The results of a scan using converter B is invalid when PD1 is set. When PD1 is cleared, converter B is continuously powered-up (APD = 0) or automatically powered-up when needed (APD = 1). O Power-up ADC converter B 1 Power-down ADC converter B Note: When clearing PD1 in any power mode except auto power-down (APD = 1), wait PUDELAY ADC clock cycles before initiating a scan to stabilize power levels within the converter. The PSTS1 bit can be polled to determine when the PUDELAY time has elapsed. Failure to follow this procedure can result in loss of accuracy of the first two samples. |
| 0 PD0 | Manual Power-Down for Converter A bit. This bit forces Converter A to power-down. Setting PD0 powers-down converter A immediately. The results of a scan using converter A is invalid when PD0 is set. When PD0 is cleared, converter A is continuously powered-up (APD = 0) or automatically powered-up when needed (APD = 1). 0 = Power-up ADC converter A 1 = Power-down ADC converter A Note: When clearing PD0 in any power mode except auto power-down (APD = 1), wait PUDELAY ADC clock cycles before initiating a scan to stabilize power levels within the converter. The PSTS0 bit can be polled to determine when the PUDELAY time has elapsed. Failure to follow this procedure can result in loss of accuracy of the first two samples. |

30.4.13 Voltage Reference Register (CAL)

In earlier series, this register supported ADC calibration and had a different name. Improvements in ADC performance have eliminated the need for on-chip calibration support, hence the new name.

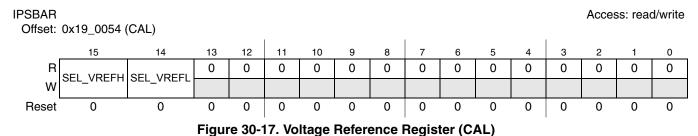


Table 30-19. CAL Field Descriptions

| Field | Description |
|-----------------|--|
| 15 SEL_VREFH | Select V _{REFH} Source bit. This bit selects the source of the V _{REFH} reference for conversions. 0 VRH 1 AN2 |
| 14 SEL_VREFL | Select V _{REFL} Source bit. This bit selects the source of the V _{REFL} reference for conversions. 0 VRL 1 AN6 |
| 13–0 | Reserved, should be cleared. |



30.5 Functional Description

The ADC's conversion process is initiated by a sync signal from one of two input pins (SYNCx) or by writing 1 to a START*n* bit.

Starting a single conversion actually begins a sequence of conversions, or a scan of up to 8 single-ended or differential samples one at a time in sequential scan mode. The operation of the module in sequential scan mode is shown in Figure 30-18.

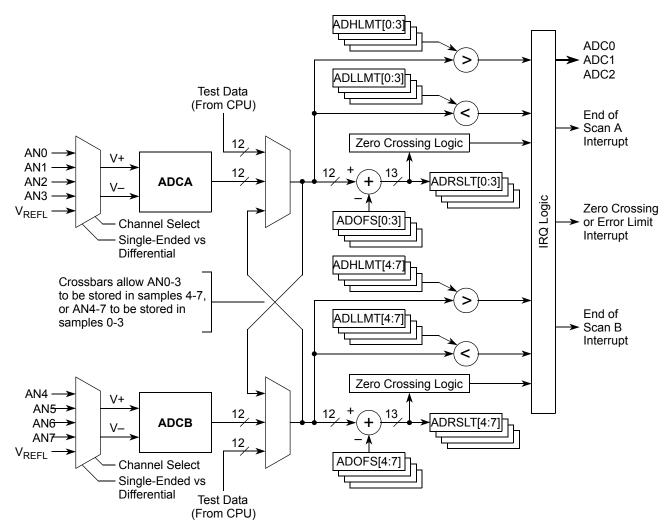


Figure 30-18. Sequential Mode Operation of the ADC

Scan sequence is determined by defining eight sample slots in ADLST1/2 registers, processed in order SAMPLE0-7 during sequential scan or in order SAMPLE0-3 by converter A and in order SAMPLE4-7 by converter B in parallel scan. SAMPLE slots may be disabled using the SDIS register.

The following pairs of analog inputs can be configured as a differential pair: AN0-1, AN2-3, AN4-5, and AN6-7. When configured as a differential pair, a reference to either member of the differential pair by a sample slot results in a differential measurement using that differential pair.

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Parallel scan can be simultaneous or non-simultaneous. During simultaneous scan, the scans in the two converters are done simultaneously and always result in simultaneous pairs of conversions, one by converter A and one by converter B. The two converters share the same start, stop, sync, end-of-scan interrupt enable control, and interrupt. Scanning in both converters is terminated when either converter encounters a disabled sample. In non-simultaneous scan, the parallel scans in the two converters are achieved independently. The two converters have their own start, stop, sync, end-of-scan interrupt enable controls, and end-of-scan interrupts. Scanning in either converter terminates only when that converter encounters a disabled sample in its part of SDIS register (DS0-DS3 for A, DS4-DS7 for B).

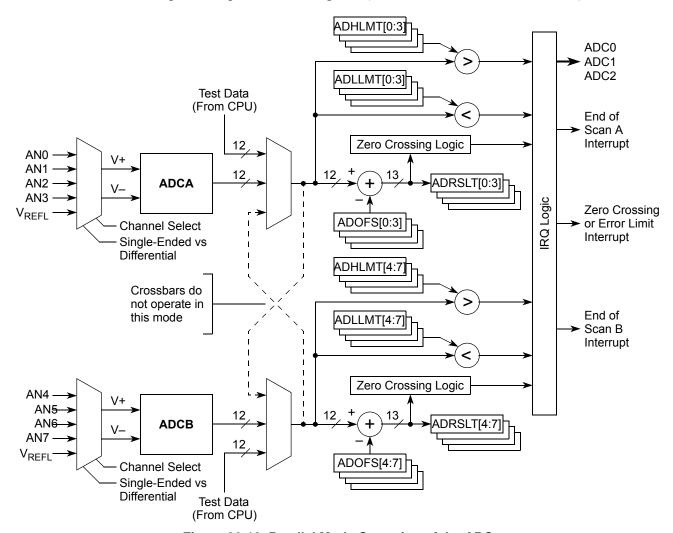


Figure 30-19. Parallel Mode Operation of the ADC

The ADC can be configured to perform a single scan and halt, perform a scan when triggered, or perform the scan sequence repeatedly until manually stopped. The single scan (once mode) differs from the triggered mode only in that SYNC input signals must be re-armed after each using a once mode scan, and subsequent SYNC inputs are ignored until the SYNC input is re-armed. This arming can occur anytime after the SYNC pulse occurs, even while the scan it initiated remains in process.



Optional interrupts can be generated at the end of a scan sequence. Interrupts are available simply to indicate the scan ended, that a sample was out of range, or at several different zero crossing conditions. Out-of-range is determined by the high and low limit registers.

To understand the operation of the ADC, it is important to understand the feature and limitations of each of the functional parts.

30.5.1 Input MUX Function

The input MUX function is shown in Figure 30-20. The channel select and single ended vs. differential switches are indirectly controlled based on settings within the LIST1, LIST2, and SDIS registers, and the CHNCFG field of the CTRL1 register.

- 1. MUXing for Sequential mode, single-ended conversions—During each conversion cycle (sample), any one input of the two muxes can be directed to any ADRSLT*n* register.
- 2. MUXing for sequential mode, differential conversions—During any conversion cycle (sample), either member of a differential pair may be referenced as a SAMPLE, resulting in a differential measurement on that pair being stored in the corresponding ADRSLT*n* register.
- 3. MUXing for parallel mode, single-ended conversions—During any conversion cycle (sample), any of AN0-AN3 can be directed to ADRSLT0-3 and any of AN4-AN7 can be directed to ADRSLT4-7.
- 4. MUXing for parallel mode, differential conversions—During any conversion cycle (sample), either member of differential pair AN0/1 or either member of differential pair AN2/3 can be referenced as a SAMPLE, resulting in a differential measurement of that pair being stored in one of the ADRSLT0-3 registers. Likewise, either member of differential pair AN4/5 or either member of differential pair AN6/7 can be referenced as a SAMPLE, resulting in a differential measurement of that pair being stored in one of the ADRSLT4-7 registers.

Details of switch operation is shown in Table 30-20. Internally, all measurements are performed differentially. During single ended measurements, V_{REFL} is used as the negative (-) input voltage, while the selected analog input is used as the positive (+) input.

| Conversion Mode | Channel Select Switches | Single Ended Differential Switches |
|--------------------------|--|---|
| Sequential, Single Ended | The two 1-of-4 select muxes can be set for the appropriate input line. | The lower switch selects V _{REFL} for the V- input of the A/D. The upper switch is always closed so that any of the four inputs can get to the V+ A/D input. |
| Sequential, Differential | The channel select switches are turned on in pairs, providing a dual 1-of-2 select function, such that either of the two differential channels can be routed to the A/D input. | The upper switch is open and the bottom switch selects the differential channel for the V- input of the A/D. |

Table 30-20. Analog MUX Controls for Each Conversion Mode

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Table 30-20. Analog MUX Controls for Each Conversion Mode (continued)

| Conversion Mode | Channel Select Switches | Single Ended Differential Switches |
|------------------------|--|---|
| Parallel, Single Ended | The two 1-of-4 select muxes can be set for the appropriate input line. | The lower switch selects V _{REFL} for the V- input of the A/D. The upper switch is always closed so that any of the four inputs can get to the V+ A/D input. |
| Parallel, Differential | The channel select switches are turned on in pairs, providing a dual 1-of-2 select function, such that either of the two differential channels can be routed to the A/D input. | The upper and lower switches are open and the middle switch is closed, providing the differential channel to the differential input of the A/D. |

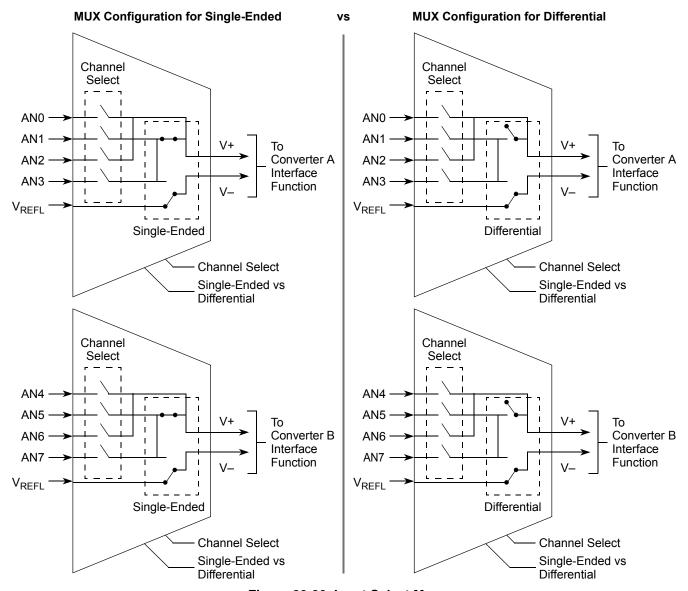


Figure 30-20. Input Select Mux



30.5.2 ADC Sample Conversion

The ADC consists of a cyclic, algorithmic architecture using two recursive sub-ranging sections (RSD#1 and RSD#2), shown in Figure 30-21. Each sub-ranging section resolves a single bit for each conversion clock, resulting in an overall conversion rate of two bits per clock cycle. Each sub-ranging section is designed to run at a maximum clock speed of 5.0 MHz. Thus a complete 12-bit conversion takes 6 ADC clocks ($1.2 \mu s$), not including sample or post processing time.

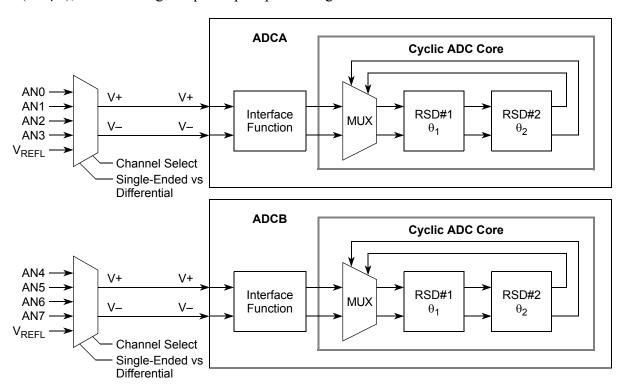


Figure 30-21. Cyclic ADC - Top Level Block Diagram

The input mode for a given sample is determined by the CHNCFG field of the CTRL1 register. The ADC has two input modes:

- Single-ended mode (CHNCFG bit=0)—In single-ended mode, input mux of the ADC selects one
 of the analog inputs and directs it to the plus terminal of the A/D core. The minus terminal of the
 A/D core is connected to the V_{REFL} reference during this mode. The ADC measures the voltage of
 the selected analog input and compares it against the (V_{REFH} V_{REFL}) reference voltage range.
- 2. Differential mode (CHNCFG bit = 1)—In differential mode, the ADC measures the voltage difference between two analog inputs and compares that against the (V_{REFH} V_{REFL}) voltage range. The input is selected as an input pair: AN0/1, AN2/3, AN4/5, or AN6/7. In this mode, the plus terminal of the A/D core is connected to the even analog input, while the minus terminal is connected to the odd analog input.

A mix and match combination of differential and single-ended configurations may exist.

Examples:

- AN0 and AN1 differential, AN2 and AN3 single-ended
- AN4 and AN5 differential, AN6 and AN7 single-ended

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30.5.2.1 Single-Ended Samples

The ADC module performs a ratio metric conversion. For single ended measurements, the digital result is proportional to the ratio of the analog input to the reference voltage in the following formula:

SingleEndedValue = round(
$$\frac{VIN - VREFL}{VREFH - VREFL} \times 4095$$
) × 8

VIN = Applied voltage at the input pin

VREFH and VREFL = Voltage at the external reference pins on the device (typically $V_{REFH} = V_{DDA}$ and $V_{REFL} = V_{DDA}$)

Note: The 12-bit result is rounded to the nearest LSB.

Note: The ADC is a 12-bit function with 4096 possible states. However, the 12 bits have been left

shifted three bits on the 16-bit data bus so its magnitude, as read from the data bus, is now

32760.

Single-ended measurements return the max value 32760 when the input is at V_{REFH} , return 0 when the input is at V_{REFL} , and scale linearly between based on the amount by which the input exceeds V_{REFL} .

30.5.2.2 Differential Samples

For differential measurements, the digital result is proportional to the ratio of the difference in the inputs to the difference in the reference voltages (V_{REFH} and V_{REFL}). Figure 30-22 shows typical configurations for differential inputs.

When converting differential measurements, the following formula is useful:

Differential Value = round
$$\left(\frac{Vin1 - Vin2}{VREFH - VREFLO} \times 4095\right) \times 8$$

 V_{IN} = Applied voltage at the input pin

 V_{REFH} and V_{REFL} = Voltage at the external reference pins on the device (typically V_{REFH} = V_{DDA} and V_{REFL} = V_{SSA})

Note: The 12-bit result is rounded to the nearest LSB.

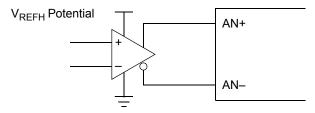
Note: The ADC is a 12-bit function with 4096 possible states. However, the 12 bits have been left

shifted three bits on the 16-bit data bus so its magnitude, as read from the data bus, is now

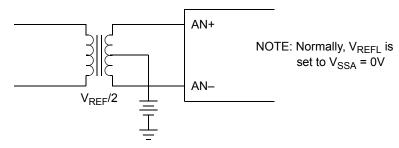
32760.

Differential measurements return the max value $32760 \ (= 4095 \times 8)$ when the plus (+) input is V_{REFH} and the minus (-) input is V_{REFL} , return 0 when the plus (+) input is at V_{REFL} and the minus (-) input is at V_{REFL} , and scale linearly between based on the voltage difference between the two signals.





Differential buffer centers about mid-point



Center tap held at (V_{REFH} + V_{REFL}) /2

Figure 30-22. Typical Connections for Differential Measurements

30.5.3 ADC Data Processing

As shown in Figure 30-23, the raw result of the ADC conversion process is sent to an adder for offset correction. The adder subtracts the ADOFS*n* register value from each sample and the result is stored in the corresponding result register (ADRSLT*n*). Concurrent to this the raw ADC value is checked for limit violations, and the ADRSLT*n* values are checked for zero-crossing. Appropriate interrupts are asserted, if enabled.

The sign of the result is calculated from the ADC unsigned result minus the respective offset register. If the offset register is programmed with a value of zero, the result register value is unsigned and equals the cyclic converter unsigned result. The range of the result registers (ADRSLTn) is 0x0000-0x7FF8, assuming the offset (ADOFSn) registers are set to zero.

The processor can write to the result registers when the ADC is in stop mode or powered down. The data from this write operation is treated as if it came from the ADC analog core; so the limit checking, zero crossing, and the offset registers function as if in normal mode. For example, if the ADC is stopped and the processor writes to ADRSLT5, the data written to ADRSLT5 is muxed to the ADC digital logic inputs, processed, and stored into ADRSLT5, as if the analog core had provided the data. This test data must be left justified by 3 bits (as shown in the ADRSLT register definition) and does not include the sign bit. The sign bit (SEXT) is calculated during subtraction of the corresponding ADOFS*n* offset value.



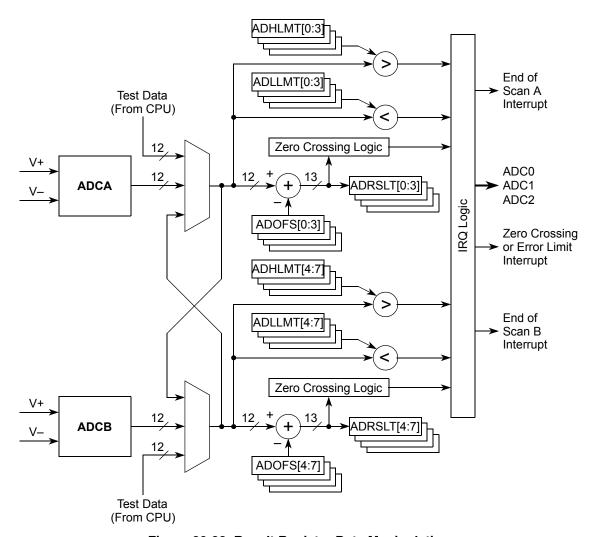


Figure 30-23. Result Register Data Manipulation

30.5.4 Sequential vs. Parallel Sampling

All scan modes make use of the 8 SAMPLE slots in the ADLST1 and ADLST2 registers. These slots are used to define which single-ended input or differential input pair is measured at each step in a scan sequence. The SDIS register is used to disable unneeded slots.

Differential measurements are made on input pairs AN0/1, AN2/3, AN4/5, and AN6/7 using the CHNCFG field of the CTRL1 register. A single ended measurement is made if a SAMPLE slot refers to an input not configured as a member of a differential pair by CHNCFG. A differential measurement is made if a SAMPLE slot refers to either member of a differential pair. Refer to the CHNCFG field description in the CTRL1 register for details of differential and single ended measurement.

Scan modes are sequential or parallel, as defined by the SMODE field of the CTRL1 register. In sequential scans, up to 8 SAMPLE slots are sampled one at a time in the order SAMPLE 0-7. Each SAMPLE slot may refer to any of the 8 analog inputs (AN0-7), thus the same input may be referenced by more than one SAMPLE slot. Scanning is initiated when the START0 bit is written as 1 or, if the SYNC0



bit is 1, when the SYNC0 input goes high. A scan ends when the first disabled sample slot is encountered in the SDIS register. Completion of the scan triggers the EOSI0 interrupt if the interrupt is enabled by the EOSIE0 bit. The START0 bit and SYNC0 input are ignored while a scan is in process. Scanning stops and cannot be initiated when the STOP0 bit is set.

Parallel scans differ in that converter A collects up to 4 samples (SAMPLE 0-3) in parallel to converter B collecting up to 4 samples (SAMPLE 4-7). SAMPLEs 0-3 may only reference inputs AN0-3, and SAMPLEs 4-7 may only reference inputs AN4-7. Within these constraints, any sample may reference any pin and the same input may be referenced by more than one sample slot.

By default (when SIMULT=1), parallel scans of the converters are initiated together when the START0 bit is written as 1 or, if the SYNC0 bit is 1, when the SYNC0 input goes high. The scan in both converters terminates when either converter encounters a disabled sample slot in SDIS. Completion of a scan triggers the EOSI0 interrupt provided the EOSIE0 interrupt enable is set. Samples are always taken simultaneously in the A and B converters. Setting the STOP0 bit stops and prevents the initiation of scanning in both converters.

Setting SIMULT equal to 0 (non-simultaneous mode) causes parallel scanning to operate independently in the A and B converter. Each converter has its own set of START*n*, STOP*n*, SYNC*n*, and EOSIE*n* control bits, SYNC*n* input, EOSI*n* interrupt, and CIP*n* status indicators (*n* = 0 for converter A, *n* = 1 for converter B). Although continuing to operate in parallel, the scans in the A and B converter start and stop independently according to their own controls. They may be simultaneous, phase shifted, or asynchronous, depending on when scans are initiated on the respective converters. The A and B converter may be of different length (up to a maximum of four) and each converter's scan completes when a disabled sample is encountered in that converters sample list only. STOP0 only stops the A converter, and STOP1 only stops the B converter. Looping scan modes repeat independently, with the A converter capturing SAMPLE 0-3, and B converter capturing SAMPLE 4-7. In loop modes, each converter independently restarts its scan after capturing its samples.

30.5.5 Scan Sequencing

Scan modes break down into three types based on how they repeat: once, triggered, or loop. Be certain to read Section 30.5.4, "Sequential vs. Parallel Sampling" to understand the operation of sequential and parallel scan modes before proceeding.

During a once mode scan, a single sequential or parallel scan is executed. Once scan modes differ from triggered scan modes in that they must be re-armed after each use. While all scan modes ignore sync pulses occurring while a scan is in process, once scan modes continues to ignore sync pulses even after the scan completes until re-armed. However, re-arming can occur any time, including during the scan, by writing to a CTRL*n* register. If operating in a sequential mode or simultaneous parallel, write to the CTRL1 register. If operating in a non-simultaneous parallel mode, re-arm converter A by writing to the CTRL1 register and converter B by writing to the CTRL2 register.

Triggered scan modes are identical to the corresponding once scan modes, except that re-arming of sync inputs is not necessary.

Loop scan modes automatically restart a scan as soon as the previous scan completes. In the loop sequential mode, up to 8 samples are captured in each loop, and the next scan starts immediately after the

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completion of the previous scan. In loop parallel scan modes, both converters restart together if SIMULT equals 1 and restart independently if SIMULT equals 0. All subsequent start and sync pulses are ignored after the scan begins. Scanning can only be terminated by setting a STOPn bit. Use STOP0 in the CTRL1 register if operating in a sequential or simultaneous parallel mode. If operating in a non-simultaneous parallel mode, use STOP0 to stop converter A and STOP1 in the CTRL2 register to stop converter B.

Scan Configuration and Control 30.5.6

The operation of the ADC module is controlled by the CTRL1 and CTRL2 registers. The CTRL1 register is described in Section 30.4.1, "Control 1 Register (CTRL1)". The structure of the CTRL2 register depends on whether the ADC is in sequential-scan or parallel-scan mode (see Section 30.4.2.1, "CTRL2 Under Sequential Scan Modes" and Section 30.4.2.2, "CTRL2 Under Parallel Scan Modes", respectively). These are used to set the scan mode, configure channels, and start/stop scans.

The ADC can operate in several sequential or parallel scan modes, as determined by CTRL1[SMODE]. These are summarized in Table 30-21. When the ADC operates in a parallel scan mode, its functionality can be further controlled by CTRL2[SIMULT].

All scan modes make use of the 8 sample slots defined by the ADLST1 and ADLST2 registers. A scan is the process of stepping through these sample slots, converting the analog input indicated by that slot, and storing the result. Slots that are not required may be disabled by writing 1 to the appropriate bits of the SDIS register.

Input pairs AN0-1, AN2-3, AN4-5, and AN6-7 may be configured as differential pairs using CTRL1[CHNCFG]. When a slot in ADLSTn refers to either member of a differential pair, a differential measurement on that pair is made; otherwise, a single-ended measurement is taken on that input. The details of single-ended and differential measurements are described in Section 30.5.2.1, "Single-Ended Samples" and Section 30.5.2.2, "Differential Samples", respectively.

CTRL1[SMODE] determines whether the slots are used to perform a sequential scan of up to 8 samples or 2 parallel scans up to 4 samples. It also controls how these scans are initiated/terminated and whether the scans are performed one time or repetitively. For more details, please see Figure 30-18 and Figure 30-19.

Parallel scans may be simultaneous or non-simultaneous depending on CTRL2[SIMULT]. This bit only applies to parallel operating modes and is ignored during sequential operating modes. During simultaneous parallel scans, A and B converters scan synchronously using one set of shared controls (CTRL1 register). During non-simultaneous scans, the A and B converters operate asynchronously with each converter using its own independent set of controls (CTRL1 for A and CTRL2 for B). Refer to Section 30.4.2.2, "CTRL2 Under Parallel Scan Modes," for more information.

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Table 30-21. ADC Scan Modes

| Scan Mode | Description |
|------------------------------|---|
| Once sequential | Upon START or an enabled sync signal, samples are taken one at a time starting with SAMPLE0 until a first disabled sample is encountered. If no disabled sample is encountered in the ADSDIS register, conversion concludes after SAMPLE7. If the scan is initiated by a sync signal, only one scan is completed until the converter is rearmed by writing to the CTRL1 register. |
| Once parallel | Upon START or an armed and enabled sync signal, converter A captures samples 0-3 and converter B captures samples 4-7. By default (CTRL2[SIMULT]=1), samples are taken simultaneously (synchronously), and scanning stops when either converter encounters a disabled sample or both converters complete all four samples. When SIMULT equals 0, samples are taken asynchronously, and scanning stops when each converter encounters a disabled sample in its part of the SDIS register or completes all 4 samples. If the scan is initiated by a sync signal, only one scan is completed until the converter is re-armed by writing to the CTRL1 register. (When SIMULT equals 0, the B converter must be re-armed separately by writing to the CTRL2 register.) |
| Loop sequential | Upon an initial start or enabled sync pulse, up to 8 samples are taken one at a time until a disabled sample is encountered. The process repeats until the STOP0 bit is set. While a loop mode is running, any additional start commands or sync pulses are ignored. If auto standby (POWER[ASB]=1) or auto power-down (POWER[APD]=1) is the selected power mode control, the power-up delay defined by PUDELAY is applied only on the first conversion. |
| Loop parallel | Upon an initial start or enabled sync pulse, converter A captures Samples 0-3, and converter B captures Samples 4-7. Each time a converter completes its current scan, it immediately restarts its scan sequence. This continues until a STOP <i>n</i> bit is asserted. While a loop is running, any additional start commands or sync pulses are ignored. By default (CTRL2[SIMULT]=1), samples are taken simultaneously (synchronously), and scanning stops when either converter encounters a disabled sample or both converters complete all four samples. When SIMULT equals 0, samples are taken asynchronously, and scanning stops when each converter encounters a disabled sample in its part of the SDIS register or completes all 4 samples. If auto standby or auto power-down is the selected power mode control, the power-up delay defined by PUDELAY is applied only on the first conversion. |
| Triggered sequential | Upon START or an enabled sync signal, samples are taken one at a time starting with SAMPLE0 until a first disabled sample is encountered. If no disabled sample is encountered, conversion concludes after SAMPLE7. If external sync is enabled, new scans are started for each sync pulse that is non-overlapping with a current scan in progress. |
| Triggered parallel (default) | Upon START or an enabled sync signal, converter A converts Samples 0-3, and converter B converts Samples 4-7 in parallel. By default (CTRL2[SIMULT]=1), samples are taken simultaneously (synchronously), and scanning stops when either converter encounters a disabled sample or both converters complete all four samples. When CTRL2[SIMULT] equals 0, samples are taken asynchronously, and scanning stops when each converter encounters a disabled sample in its part of the ADSDIS register or completes all 4 samples. If external sync is enabled (SYNC0=1), new scans are started for each sync pulse as long as the ADC has completed the previous scan (STAT[CIPn]=0). |

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30.5.7 Interrupt Sources

Figure 30-24 illustrates how five interrupt sources are combined into three entries in the interrupt vector table

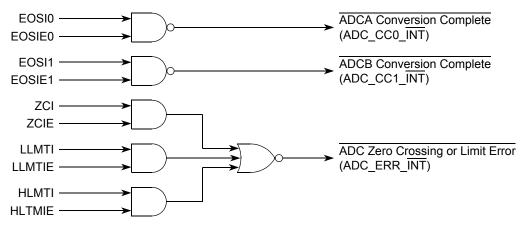


Figure 30-24. ADC Interrupt Sources

30.5.8 Power Management

The five supported power modes are described below. They are in order of highest to lowest power utilization at the expense of increased conversion latency and/or startup delay. Please see Section 30.5.9, "ADC Clock," for details of the various clocks referenced below.

30.5.8.1 Power Management Modes

- 1. Normal power mode This mode operates when:
 - At least one ADC converter is powered up (PD0 or PD1=0 in the POWER register);
 - Auto power-down and auto standby modes are disabled (APD=0, ASB=0 in the POWER register);
 - The ADC's clock is enabled (ADC=1 in the SIM module's SIM PCE register).

In this mode, the ADC uses the conversion clock as the ADC clock source when active or idle. To minimize conversion latency, it is recommended the conversion clock be configured to 5.0 MHz. No startup delay (defined by PUDELAY in the POWER register) is imposed.

- 2. Auto power-down mode This mode operates when:
 - At least one ADC converter is powered up (PD0 or PD1=0 in the POWER register);
 - Auto power-down mode is enabled (APD=1 in the POWER register);
 - The ADC's clock is enabled (ADC=1 in the SIM module's SIM PCE register).

Auto power-down and standby modes can be used together by setting APD equal to 1 in the above configuration. This hybrid mode converts at an ADC clock rate of 100 kHz using standby current mode when active, and gates off the ADC clock and powers down the converters when idle. A startup delay of



PUDELAY ADC clock cycles execute at the start of all scans while the ADC engages the conversion clock and the ADC powers up, stabilizing in the standby current mode. This provides the lowest possible power configuration for ADC operation.

- 3. Auto standby mode This mode operates when:
 - At least one ADC converter is powered up (PD0 or PD1=0 in the POWER register);
 - Auto power-down is disabled (APD=0 in the POWER register);
 - Auto standby is enabled (ASB=1 in the POWER register);
 - The ADC's clock is enabled (ADC=1 in the SIM module's SIM PCE register);
 - The relaxation oscillator must be enabled for 8-MHz operation or the external oscillator clock must be running at 8 MHz in this mode.

In auto standby mode, the ADC uses the conversion clock when active and the 100 kHz Standby clock when idle. The standby (low current) state automatically engages when the ADC is idle. The ADC executes a startup delay of PUDELAY ADC clocks at the start of all scans, allowing the ADC to switch to the Conversion clock and to revert from standby to normal current mode.

It is recommended the conversion clock be configured at or near 5.0 MHz to minimize conversion latency when active. In this mode, the ADC uses the conversion clock when active and gates off the conversion clock and powers down the converters when idle. A startup delay of PUDELAY ADC clocks is executed at the start of all scans, allowing the ADC to stabilize when switching to normal current mode from a completely powered off condition. This mode uses less power than normal and more power than auto standby. It requires more startup latency than auto standby when leaving the idle state to start a scan (higher PUDELAY value).

- 4. POWER-DOWN MODE
 - This mode operates when:
 - Both ADC converters are powered down (PD0=PD1=1 in the POWER register);
 - The ADC's clock is disabled (ADC=0 in the SIM module's SIM PCE register).

In this configuration, the clock trees to the ADC and all of its analog components are shut down and the ADC uses no power.

30.5.8.2 Power Management Details

The ADC voltage reference and converters are powered down (PDn=1 in the POWER register) on reset. Individual converters can be manually powered down when not in use (PD0=1 or PD1=1), and the voltage reference can be automatically powered down when no converter is in use (PD2=1) or manually powered up when no converters are powered (PD2=0). When the ADC voltage reference is powered down, output reference voltages are set to low (V_{SSA}).

A delay of PUDELAY ADC clock cycles is imposed when PD0 or PD1 are cleared to power-up a converter and when the ADC goes from an idle (neither converter has a scan in process) to an active state when not operating in normal power mode. The ADC is active when at least one converter has a scan in process. A device recommends the use of two PUDELAY values: a large value for full power-up and a smaller value for going from standby current levels to full power-up. The following paragraphs provide an explanation of how to use PUDELAY when starting the ADC up or changing modes.

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When starting up in normal mode, first set PUDELAY to the large power-up value. Next, clear the PD0 and or PD1 bits to power-up the required converters. Poll the status bits (PSTSn in the POWER register) until all required converters are powered up. Following polling, start scan operations. The value in PUDELAY provides a power-up delay before scans begin. Because normal mode does not use PUDELAY at start of scans, no further delays are imposed.

When starting up using auto standby mode, first use the normal mode startup procedure. Before starting scan operations, set PUDELAY to the smaller value, then set ASB in the POWER register. Auto standby mode automatically reduces current levels until active and then impose a PUDELAY wait to allow current levels to rise from standby to normal levels.

When starting up using auto power-down mode, first use the normal mode startup procedure. Before starting scan operations, set PUDELAY to the large power-up value. Next, set APD in the POWER register. Finally, clear the PD0 and or PD1 bits for the required converters. Converters remain powered off until scanning goes active, at which time the large PUDELAY executes as the ADC goes from powered down to fully powered at the start of the scan.

In auto power-down mode, when the ADC goes from idle to active, a converter is only powered up if it is required for the scan, as determined by the ADLST1, ADLST2, and SDIS registers.

It is recommended to power-off both converters (PD0=PD1=1 in the POWER register) when re-configuring clocking or power controls to avoid generating bad samples and ensure proper delays are applied when powering up or starting scans.

Attempts to start a scan during the PUDELAY time-out are ignored until the appropriate PSTS*n* bits are cleared in the POWER register.

Any attempt to use a converter when powered down or with the voltage reference disabled results in invalid results. It is possible to read ADC result registers after converter power down to see results calculated before power-down. However, a new scan sequence must be started with a SYNC*n* pulse or a write to the START*n* bit before new results are available.

30.5.8.3 ADC STOP Mode of Operation

Any conversion sequence in progress can be stopped by setting the relevant STOP*n* bit. Any further sync pulses or writes to the START*n* bit are ignored until the STOP*n* bit is cleared. In this stop mode, the results registers can be modified by writes from the processor. Any write to ADRSLT*n* in the ADC stop mode is treated as if the analog core supplied the data, so limit checking, zero crossing, and associated interrupts can occur if enabled.

30.5.9 ADC Clock

30.5.9.1 General

The ADC has two external clock inputs used to drive two clock domains within the ADC module.



| | | · |
|-------------------------------------|--|---|
| Clock input | Source | Characteristics |
| Peripheral Clock (=System Clock) | 1/2 Core clock | Maximum rate is PLL output divided by 2 if PLL enabled. When PLL disabled, max rate is oscillator clock divided by 2. |
| ADC 8MHz Clock | Relaxation Oscillator (8MHz), Crystal Oscillator (1-16MHz), or external Oscillator | Provides 8MHz for auto standby power saving mode. |

Table 30-22. ADC Clock Summary

30.5.9.2 Description of Clock Operation

As shown in Figure 30-25, the conversion clock is the primary source for the ADC clock and is always selected as the ADC clock when conversions are in process. The DIV value in the CTRL2 register should be configured so the conversion clock frequency falls between 100 kHz and 5.0 MHz. Operating the ADC at out-of-spec clock frequencies degrades conversion accuracy. Similarly, modifying the parameters affect clock rates or power modes while the regulators are powered up (PD0=0 or PD1=0) also degrades conversion accuracy.

The conversion clock ADC uses for sampling is calculated using the IPBus clock and the clock divisor bits within the CTRL2 register. Please see Section 30.4.1, "Control 1 Register (CTRL1)" or Section 30.4.2, "Control 2 Register (CTRL2)". The ADC clock is active 100% of the time while in loop modes, or if power management is set to normal. It is also active during all ADC power-up for a period of time determined by the PUDELAY field in the power (POWER) register. After the power-up delay times out, the ADC clock continues until the completion of the ADCn scan when operating in auto standby or auto power-down modes.

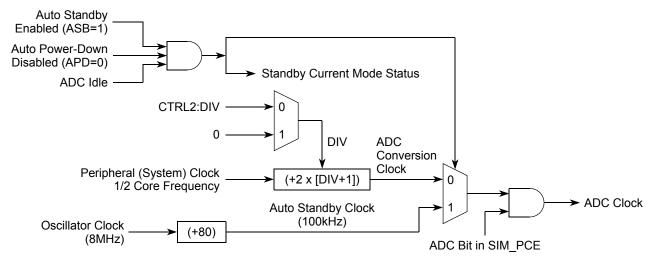


Figure 30-25. ADC Clock Generation

The oscillator clock feeds an 80:1 divider, generating the auto standby clock. The auto standby clock is selected as the ADC clock during the auto standby power mode when both converters are idle. The auto

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standby power mode requires an 8 MHz oscillator clock from the relaxation oscillator, crystal oscillator, or external oscillator.

30.5.9.3 ADC Clock Resynchronization at Start of Scan

At the fastest ADC speed, each ADC clock period is 6 system clock periods long. When asserting the start of a scan, by writing to a START*n* bit or by a SYNC*n* signal, the ADC clock is re-synchronized to align it to the system clock. This allows the commanded scan to begin as soon as possible rather than wait up to 5 additional system clocks for the start of the next ADC clock period. This is shown in Figure 30-26 for sequential and simultaneous parallel modes of operation. In these modes, both ADCs operate off of the same start signal.

In a parallel scan mode when SIMULT equals 0, both ADCs operate using independent START*n* bits and SYNC*n* signals. As shown in Figure 30-27, the first scan started is re-synchronized to the system clock, but the second scan may wait up to 5 additional system clocks before starting. Also, which converter is synchronized to the system clock depends on which convert first starts to use the ADC. The case shown has ADCA synchronized, but one could easily imagine the case where the ADCA start comes after instead of before the ADCB start. In this case, ADCAs start would be delayed up to 5 additional system clock periods instead of ADCBs.

If there is a known timing relationship between ADCA and ADCB when operating in a non-simultaneous parallel mode, then the application can control which ADC starts first and gets the re-synchronized clock. The application can also control the delay to starting the second ADC scan so that its start signal aligns with the ADC clock, and the start of the second ADC is not delayed.

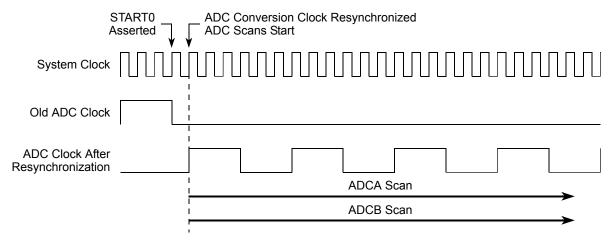


Figure 30-26. ADC Clock Resynchronization for Sequential and Simultaneous Parallel Modes



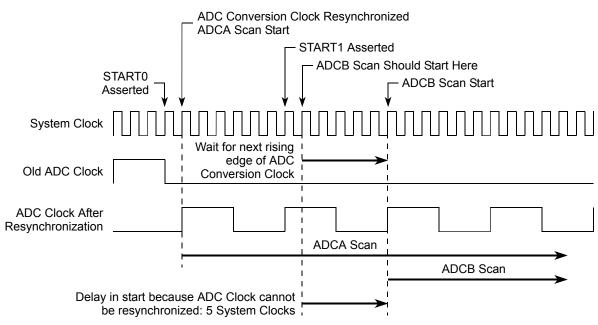


Figure 30-27. ADC Clock Resynchronization for Non-Simultaneous Parallel Modes

30.5.10 Voltage Reference Pins V_{REFH} and V_{REFL}

The voltage difference between V_{REFH} and V_{REFL} provides the reference voltage that all analog inputs are measured against. The reference voltage should be provided from a low noise filtered source capable of providing up to 1mA of reference current.

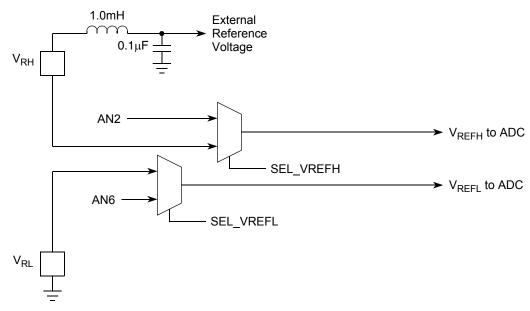


Figure 30-28. ADC Voltage Reference Circuit

When tying V_{REFH} to the same potential as V_{DDA} , relative measurements are being made with respect to the amplitude of V_{DDA} . It is imperative that special precautions be taken to assure the voltage applied to

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 V_{REFH} is as noise-free as possible. Any noise residing on the V_{REFH} voltage is directly transferred to the digital result.

Figure 30-28 illustrates the internal workings of the ADC voltage reference circuit. V_{REFH} must be noise filtered; a minimum configuration is shown in the figure.

30.5.11 Supply Pins V_{DDA} and V_{SSA}

Dedicated power supply pins are provided for the purposes of reducing noise coupling and to improve accuracy. The power provided to these pins is suggested to come from a low noise filtered source. Uncoupling capacitors ought to be connected between V_{DDA} and V_{SSA} .



Chapter 31 Pulse-Width Modulation (PWM) Module

31.1 Introduction

This chapter describes the configuration and operation of the pulse-width modulation (PWM) module. It includes a block diagram, programming model, and functional description.

31.1.1 Overview

The PWM module, shown in Figure 31-1, generates a synchronous series of pulses having programmable period and duty cycle. With a suitable low-pass filter, the PWM can be used as a digital-to-analog converter.

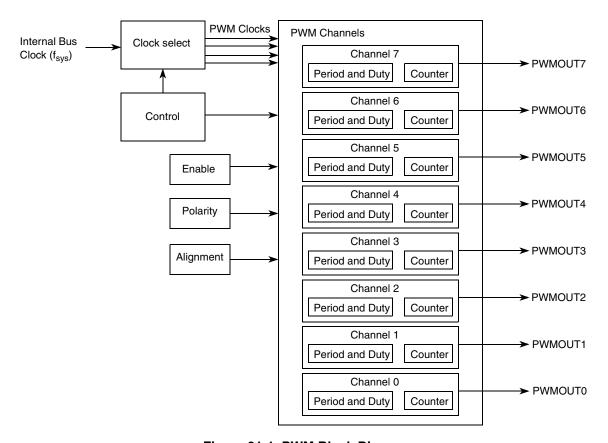


Figure 31-1. PWM Block Diagram



Main features include the following:

- Double-buffered period and duty cycle
- Left- or center-aligned outputs
- Eight independent PWM modules
- Byte-wide registers provide programmable duty cycle and period control
- Four programmable clock sources

NOTE

The GPIO module must be configured to enable the peripheral function of the appropriate pins (refer to Chapter 15, "General Purpose I/O Module") prior to configuring the PWM module.

31.2 Memory Map/Register Definition

This section describes the registers and control bits in the PWM module. There are eight independent PWM modules, each with its own control and counter registers. The memory map for the PWM is shown below.

Table 31-1. PWM Memory Map

| IPSBAR Offset ^{1,2} | Register | Width (bits) | Access | Reset Value | Section/Page |
|--|---|--------------|--------|-------------|---------------|
| | Supervisor Read/Write Only A | ccess | | | |
| 0x1B_0000 | PWM Enable Register (PWME) | 8 | R/W | 0x00 | 31.2.1/31-3 |
| 0x1B_0001 | PWM Polarity Register (PWMPOL) | 8 | R/W | 0x00 | 31.2.2/31-4 |
| 0x1B_0002 | PWM Clock Select Register (PWMCLK) | 8 | R/W | 0x00 | 31.2.3/31-4 |
| 0x1B_0003 | PWM Prescale Clock Select Register (PWMPRCLK) | 8 | R/W | 0x00 | 31.2.4/31-5 |
| 0x1B_0004 | PWM Center Align Enable Register (PWMCAE) | 8 | R/W | 0x00 | 31.2.5/31-6 |
| 0x1B_0005 | PWM Control Register (PWMCTL) | 8 | R/W | 0x00 | 31.2.6/31-7 |
| 0x1B_0008 | PWM Scale A Register (PWMSCLA) | 8 | R/W | 0x00 | 31.2.7/31-8 |
| 0x1B_0009 | PWM Scale B Register (PWMSCLB) | 8 | R/W | 0x00 | 31.2.8/31-9 |
| $0x1B_000C + n$ n = 0-7 | PWM Channel n Counter Register (PWMCNTn) | 8 | R/W | 0x00 | 31.2.9/31-9 |
| 0x1B_0014 + <i>n</i> <i>n</i> = 0-7 | PWM Channel n Period Register (PWMPERn) | 8 | R/W | 0xFF | 31.2.10/31-10 |
| $0x1B_001C + n$ n = 0-7 | PWM Channel n Duty Register (PWMDTYn) | 8 | R/W | 0xFF | 31.2.11/31-11 |
| 0x1B_0024 | PWM Shutdown Register (PWMSDN) | 8 | R/W | 0x00 | 31.2.12/31-12 |
| 0x1B_0026 | PWM PCM mode enable Register (PCME) | 8 | R/W | 0x00 | 31.2.13/31-13 |
| | | | | | |

Addresses not assigned to a register and undefined register bits are reserved for expansion. Write accesses to these reserved address spaces and reserved register bits have no effect.

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Pulse-Width Modulation (PWM) Module

31.2.1 PWM Enable Register (PWME)

Each PWM channel has an enable bit (PWMEn) to start its waveform output. While in run mode, if all eight PWM output channels are disabled (PWME[7:0] = 0), the prescaler counter shuts off for power savings. See Section 31.3.2.1, "PWM Enable" for more information.

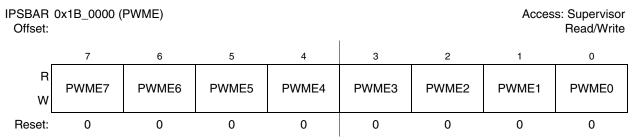


Figure 31-2. PWM Enable Register (PWME)

Table 31-2. PWME Field Descriptions

| Field | Description |
|------------|---|
| 7 PWME7 | PWM Channel 7 Enable. In normal mode, if enabled, the PWM signal becomes available at PWMOUT7 when its corresponding clock source begins its next cycle. When PWMSDN[SDNEN] is set this channel is an input for emergency shutdown. 0 PWM7 disabled 1 PWM7 enabled |
| 6 PWME6 | PWM Channel 6 Output Enable. If enabled, the PWM signal becomes available at PWMOUT6 when its corresponding clock source begins its next cycle. If PWMCTL[CON67] is set, then this bit has no effect and PWMOUT6 is disabled. 0 PWM output disabled 1 PWM output enabled |
| 5 PWME5 | PWM Channel 5 Output Enable. If enabled, the PWM signal becomes available at PWMOUT5 when its corresponding clock source begins its next cycle. 0 PWM output disabled 1 PWM output enabled |
| 4 PWME4 | PWM Channel 4 Output Enable. If enabled, the PWM signal becomes available at PWMOUT4 when its corresponding clock source begins its next cycle. If PWMCTL[CON45] is set, then this bit has no effect and PWMOUT4 is disabled. 0 PWM output disabled 1 PWM output enabled |
| 3 PWME3 | PWM Channel 3 Output Enable. If enabled, the PWM signal becomes available at PWMOUT3 when its corresponding clock source begins its next cycle. 0 PWM output disabled 1 PWM output enabled |
| 2 PWME2 | PWM Channel 2 Output Enable. If enabled, the PWM signal becomes available at PWMOUT2 when its corresponding clock source begins its next cycle. If PWMCTL[CON23] is set, then this bit has no effect and PWMOUT2 is disabled. 0 PWM output disabled 1 PWM output enabled, if PWMCTL[CON23]=0 |

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² A 32-bit access to any of these registers results in a bus transfer error.



| Field | Description | | | | | |
|------------|--|--|--|--|--|--|
| 1 PWME1 | PWM Channel 1 Output Enable. If enabled, the PWM signal becomes available at PWMOUT1 when its corresponding clock source begins its next cycle. 0 PWM output disabled 1 PWM output enabled | | | | | |
| 0 PWME0 | PWM Channel 0 Output Enable. If enabled, the PWM signal becomes available at PWMOUT0 when its corresponding clock source begins its next cycle. If PWMCTL[CON01] is set, then this bit has no effect and PWMOUT0 is disabled. 0 PWM output disabled 1 PWM output enabled, if PWMCTL[CON01]=0 | | | | | |

PWM Polarity Register (PWMPOL) 31.2.2

The starting polarity of each PWM channel waveform is determined by the associated PWMPOL[PPOL*n*] bit. If the polarity is changed while a PWM signal is being generated, a truncated or stretched pulse can occur during the transition.

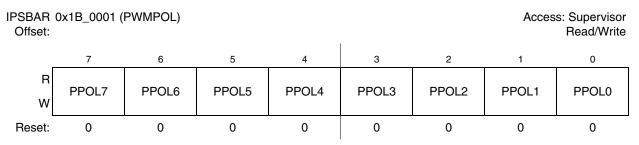


Figure 31-3. PWM Polarity Register (PWMPOL)

Table 31-3. PWMPOL Field Descriptions

| Field | Description |
|----------------------|---|
| 7–0 PPOL <i>n</i> | PWM Channel <i>n</i> Polarity. The even-numbered channels' polarity has no effect when the corresponding PWMCTL[CON <i>n</i> (<i>n</i> +1)] bit is set. For example, if PWMCTL[CON01] equals 1, PWMPOL[PPOL0] has no affect. 0 PWM channel <i>n</i> output is low at the beginning of the period, then goes high when the duty count is reached 1 PWM channel <i>n</i> output is high at the beginning of the period, then goes low when the duty count is reached |

PWM Clock Select Register (PWMCLK) 31.2.3

Each PWM channel has the capability of selecting one of two clocks. For channels 0, 1, 4, and 5, the clock choices are clock A or SA. For channels 2, 3, 6, and 7, the choices are clock B or SB. The clock selection is done with the below PWMCLK[PCLKn] control bits. If a clock select is changed while a PWM signal is being generated, a truncated or stretched pulse can occur during the transition.

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Pulse-Width Modulation (PWM) Module

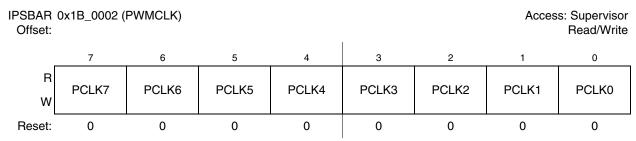


Figure 31-4. PWM Clock Select Register (PWMCLK)

Table 31-4. PWMCLK Field Descriptions

| Field | Description | | | | | | | | |
|----------------------|---|---|--|--|--|--|--|--|--|
| 7–0 PCLK <i>n</i> | PWM channel n clock select. Selects between one of two clock sources for each PWM channel. See Section 31.2.4, "PWM Prescale Clock Select Register (PWMPRCLK)" and Section 31.2.7, "PWM Scale A Register (PWMSCLA)" for more information on how the different clock rates are generated. The even-numbered channels' clock select has no effect when the corresponding PWMCTL[CON $n(n+1)$] bit is set. For example, if PWMCTL[CON01] equals 1, PWMCLK[PCLK0] has no affect. | | | | | | | | |
| | | | PCLK6 & PCLK7 (PWM6 & PWM7 Clock Source) | PCLK4 & PCLK5 (PWM4 & PWM5 Clock Source) | PCLK2 & PCLK3 (PWM2 & PWM3 Clock Source) | PCLK0 & PCLK1 (PWM0 & PWM1 Clock Source) | | | |
| | | 0 | В | Α | В | Α | | | |
| | | 1 | SB | SA | SB | SA | | | |

31.2.4 PWM Prescale Clock Select Register (PWMPRCLK)

The PWMPRCLK register selects the prescale clock source for clocks A and B independently. If the clock prescale is changed while a PWM signal is being generated, a truncated or stretched pulse can occur during the transition.

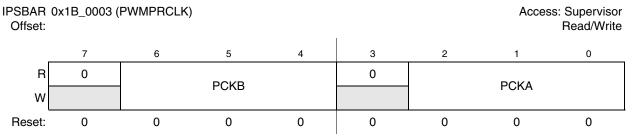


Figure 31-5. PWM Prescale Clock Select Register (PWMPRCLK)

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Table 31-5. PWMPRCLK Field Descriptions

| Field | | | Description | | |
|-------------|--|----------------|-------------------------------------|-------------------------------------|--|
| 7 | Reserved, must be cleared. | | | | |
| 6–4 PCKB | Clock B prescaler select. These three bits control the rate of Clock B, which can be used for PWM channels2, 3, 6 and 7. | | | | |
| | | РСКВ | Clock B Rate | | |
| | | 000 | Internal bus clock ÷ 2 ⁰ | | |
| | | 001 | Internal bus clock ÷ 2 ¹ | | |
| | | | | | |
| | | 111 | Internal bus clock ÷ 2 ⁷ | | |
| 3 | Reserved, must be cleared. | | | | |
| 2–0 PCKA | Clock A prescaler select. These three and 5. | e bits control | the rate of Clock A, which o | can be used for PWM channels0, 1, 4 | |
| | | PCKA | Clock A Rate | | |
| | | 000 | Internal bus clock ÷ 2 ⁰ | | |
| | | 001 | Internal bus clock ÷ 2 ¹ | | |
| | | | | | |
| | | 111 | Internal bus clock ÷ 2 ⁷ | | |
| | | | | • | |

31.2.5 PWM Center Align Enable Register (PWMCAE)

The PWMCAE register contains eight control bits for the selection of center-aligned outputs or left-aligned outputs for each PWM channel. Write these bits only when the corresponding channel is disabled. See Section 31.3.2.5, "Left-Aligned Outputs" and Section 31.3.2.6, "Center-Aligned Outputs" for a more detailed description of the PWM output modes.

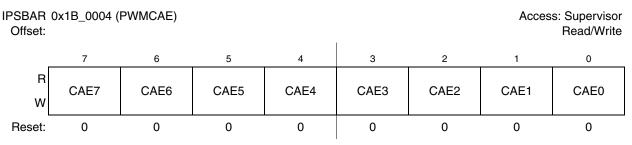


Figure 31-6. PWM Center Align Enable Register (PWMCAE)



Table 31-6. PWMCAE Field Descriptions

| Field | Description |
|---------------------|--|
| 7–0 CAE <i>n</i> | Center align enable for channel <i>n</i> . The even-numbered channels' center align enable has no effect when the corresponding PWMCTL[CON <i>n</i> (<i>n</i> +1 <i>)</i>] bit is set. For example, if PWMCTL[CON01] equals 1, PWMCAE[CAE0] has no affect. 0 Channel <i>n</i> operates in left-aligned output mode 1 Channel <i>n</i> operates in center-aligned output mode |

31.2.6 PWM Control Register (PWMCTL)

The PWMCTL register provides various control of the PWM module. Change the CONn(n+1) bits only when both corresponding channels are disabled. See Section 31.3.2.7, "PWM 16-Bit Functions" for a more detailed description of the concatenation function.

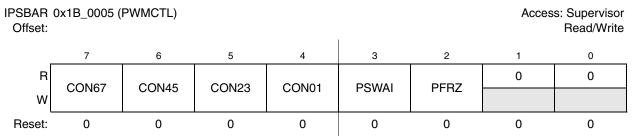


Figure 31-7. PWM Control Register (PWMCTL)

Table 31-7. PWMCTL Field Descriptions

| Field | Description |
|------------|---|
| 7 CON67 | Concatenates PWM channels 6 and 7 to form one 16-bit PWM channel. O Channels 6 and 7 are separate 8-bit PWMs 1 Concatenate PWM 6 and 7. Channel 6 becomes the high order byte and channel 7 the low order byte. PWMOUT7 is the output for this 16-bit PWM signal, and PWMOUT6 is disabled. The channel 7 clock select, polarity, center align enable, and enable bits control this concatenated output. |
| 6 CON45 | Concatenates PWM channels 4 and 5 to form one 16-bit PWM channel. O Channels 4 and 5 are separate 8-bit PWMs Concatenate PWM 4 and 5. Channel 4 becomes the high order byte and channel 5 the low order byte. PWMOUT5 is the output for this 16-bit PWM signal, and PWMOUT4 is disabled. The channel 5 clock select, polarity, center align enable, and enable bits control this concatenated output. |
| 5 CON23 | Concatenates PWM channels 2 and 3 to form one 16-bit PWM channel. O Channels 2 and 3 are separate 8-bit PWMs Concatenate PWM 2 and 3. Channel 2 becomes the high order byte and channel 3 the low order byte. PWMOUT3 is the output for this 16-bit PWM signal, and PWMOUT2 is disabled. The channel 3 clock select, polarity, center align enable, and enable bits control this concatenated output. |
| 4 CON01 | Concatenates PWM channels 0 and 1 to form one 16-bit PWM channel. O Channels 0 and 1 are separate 8-bit PWMs Concatenate PWM 0 and 1. Channel 0 becomes the high order byte and channel 1 the low order byte. PWMOUT1 is the output for this 16-bit PWM signal, and PWMOUT0 is disabled. The channel 1 clock select, polarity, center align enable, and enable bits control this concatenated output. |

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| Table 31-7. PWMCTL Field Descriptions (continued) |
|---|
|---|

| Field | Description |
|------------|--|
| 3 PSWAI | PWM stops in doze mode. Disables the input clock to the prescaler while in doze mode. O Allow the clock to the prescaler while in doze mode Stop the input clock to the prescaler when the core is in doze mode |
| 2 PFRZ | PWM counters stop in debug mode (BKPT asserted). 0 Allow PWM counters to continue while in debug mode 1 Disable PWM input clock to the prescaler when the core is in debug mode. Useful for emulation as it allows the PWM function to be suspended. |
| 1–0 | Reserved, must be cleared. |

31.2.7 PWM Scale A Register (PWMSCLA)

PWMSCLA is the programmable scale value used in scaling clock A to generate clock SA. Clock SA is generated with the following equation:

$$Clock SA = \frac{Clock A}{2 \times PWMSCLA}$$
 Eqn. 31-1

Any value written to this register causes the scale counter to load the new scale value (PWMSCLA).

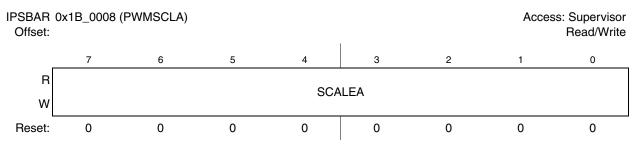


Figure 31-8. PWM Scale A Register (PWMSCLA)

Table 31-8. PWMSCLA Field Descriptions

| Description | | |
|---|--|---|
| Part of divisor used to form Clock SA from Clock A. | | |
| | SCALEA | Value |
| | 0x00 | 256 |
| | 0x01 | 1 |
| | 0x02 | 2 |
| | | ••• |
| | 0xFF | 255 |
| | Part of divisor used to form Clock SA from | Part of divisor used to form Clock SA from Clock A. SCALEA 0x00 0x01 0x02 |



Pulse-Width Modulation (PWM) Module

PWM Scale B Register (PWMSCLB) 31.2.8

PWMSCLB is the programmable scale value used in scaling clock B to generate clock SB. Clock SB is generated according to the following equation:

$$Clock SB = \frac{Clock B}{2 \times PWMSCLB}$$
 Eqn. 31-2

Any value written to this register causes the scale counter to load the new scale value (PWMSCLB).

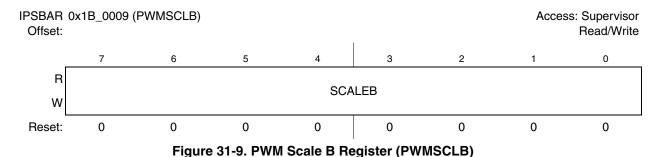


Table 31-9. PWMSCLB Field Descriptions

| Field | Description | | |
|---------------|---|--------|-------|
| 7–0 SCALEB | Divisor used to form Clock SB from Clock B. | | |
| | | SCALEB | Value |
| | | 0x00 | 256 |
| | | 0x01 | 1 |
| | | 0x02 | 2 |
| | | | |
| | | 0xFF | 255 |

31.2.9 PWM Channel Counter Registers (PWMCNTn)

Each channel has a dedicated 8-bit up/down counter that runs at the rate of the selected clock source, PWMCLK[PCLKn]. The user can read the counters at any time without affecting the count or the operation of the PWM channel. In left-aligned output mode, the counter counts from 0 to the value in the period register minus 1. In center-aligned output mode, the counter counts from 0 up to the value in the period register and then back down to 0. Therefore, given the same value in the period register, center-aligned mode is twice the period of left-aligned mode.

Any value written to the counter causes the counter to reset to 0x00, the counter direction to be set to up for center-aligned mode, the immediate load of duty and period registers with values from the buffers, and the output to change according to the polarity bit.

The counter is also cleared at the end of the effective period (see Section 31.3.2.5, "Left-Aligned Outputs" and Section 31.3.2.6, "Center-Aligned Outputs" for more details). When the channel is disabled

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(PWMEn=0), the PWMCNTn register does not count. When a channel is enabled (PWMEn=1), the associated PWM counter starts at the count in the PWMCNTn register. For more detailed information on the operation of the counters, refer to Section 31.3.2.4, "PWM Timer Counters."

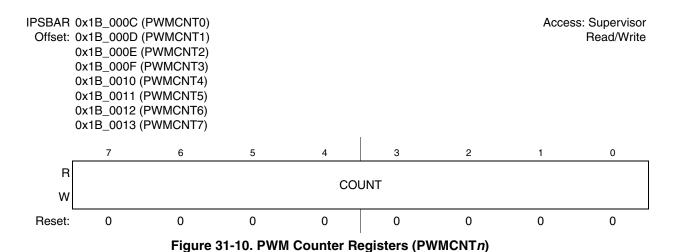


Table 31-10. PWMCNTn Field Descriptions

| Field | Description |
|--------------|---|
| 7–0 COUNT | Current value of the PWM up counter. Resets to zero when written. |

31.2.10 PWM Channel Period Registers (PWMPER*n*)

The PWM period registers determine the period of the associated PWM channel. Refer to Section 31.3.2.3, "PWM Period and Duty" for more information.

Calculating the output period depends on the output mode (center-aligned has twice the period as left-aligned mode) as well as PWMPER*n*. See the below equation:

> $PWMn \text{ period} = Channel clock period} \times (PWMCAE[CAEn] + 1) \times PWMPERn$ Ean. 31-3

For boundary case programming values (e.g. PWMPERn = 0x00), please refer to Section 31.3.2.8, "PWM Boundary Cases".

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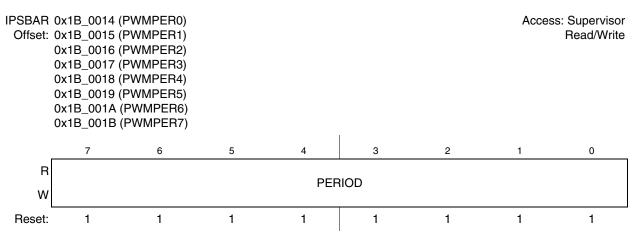


Figure 31-11. PWM Period Registers (PWMPERn)

Table 31-11. PWMPERn Field Descriptions

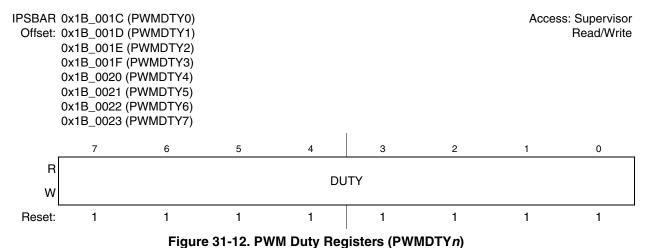
| Field | Description |
|--------|---|
| PERIOD | Period counter for the output PWM signal. If PERIOD equals 0x00, the PWMn output is always high (PPOLn=1) or always low (PPOLn=0). See Section 31.3.2.8, "PWM Boundary Cases" for other special cases. |

31.2.11 PWM Channel Duty Registers (PWMDTYn)

The PWM duty registers determine the duty cycle of the associated PWM channel. To calculate the output duty cycle (high time as a percentage of period) for a particular channel:

Duty Cycle =
$$\left| \left(1 - PWMPOL[PPOLn] - \frac{PWMDTYn}{PWMPERn} \right) \right| \times 100\%$$
 Eqn. 31-4

For boundary case programming values (e.g. PWMDTYn = 0x00 or PWMDTYn > PWMPERn), refer to Section Section 31.3.2.8, "PWM Boundary Cases".



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Table 31-12. PWMDTYn Field Descriptions

| Field | Description |
|-------------|---|
| 7–0 DUTY | Contains the duty value used to determine when a transition occurs on the PWM output signal. When a match occurs with the corresponding PWMCNT <i>n</i> register, the PWM output toggles. If DUTY equals 0x00, the PWM <i>n</i> output is always low (PPOL <i>n</i> =1) or always high (PPOL <i>n</i> =0). See Section 31.3.2.8, |
| | "PWM Boundary Cases" for other special cases. |

31.2.12 PWM Shutdown Register (PWMSDN)

The PWM shutdown register provides emergency shutdown functionality of the PWM module. The PWMSDN[7:1] bits are ignored if PWMSDN[SDNEN] is cleared.

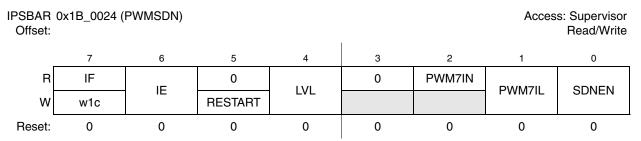


Figure 31-13. PWM Shutdown Register (PWMSDN)

Table 31-13. PWMSDN Field Descriptions

| Field | Description |
|--------------|--|
| 7 IF | PWM interrupt flag. Any change in state of PWM7IN is flagged by setting this bit. The flag is cleared by writing a 1 to it. Writing 0 has no effect. O No change in PWM7IN input Change in PWM7IN input |
| 6 IE | PWM interrupt enable. An interrupt is triggered to the device's interrupt controller when PWMSDN[IF] is set. 0 Interrupt is disabled 1 Interrupt is enabled |
| 5 RESTART | PWM restart. After setting the RESTART bit, the PWM channels start running after the corresponding counter resets to zero. Also, if emergency shutdown is cleared (after being set), the PWM outputs restart after the corresponding counter resets to zero. This bit is self-clearing, so is always read as zero. |
| 4 LVL | PWM shutdown output level. Describes the behavior of the PWM outputs when PWM7IN input is asserted and PWMSDN[SDNEN] is set. 0 PWM outputs are forced to logic 0 1 PWM outputs are forced to logic 1 |
| 3 | Reserved, must be cleared. |
| 2 PWM7IN | PWM channel 7 input status. Reflects the current status of the PWMOUT7 pin. Read only. |

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Table 31-13. PWMSDN Field Descriptions (continued)

| Field | Description |
|-------------|---|
| 1 PWM7IL | PWM channel 7 input polarity. If PWMSDN[SDNEN] is set, this bit sets the active level of the PWM 7 channel 0 PWM 7 input is active low 1 PWN 7 input is active high |
| 0 SDNEN | PWM emergency shutdown enable. If set, the pin associated with PWM channel 7 is forced to input and the emergency shutdown is enabled. 0 Emergency shutdown is disabled 1 Emergency shutdown is enabled |

31.2.13 PWM PCM Mode Enable Register (PCME)

Pulse Code Modulation (PCM) is a method to increase the dynamic range of a PWM. The pulse count modulation technique works by reversing the comparison done to modulate the duty cycle of a PWM signal. With PCM encoding the resulting output can be two times faster than with PWM, with less filtering required on the output.

The PCME register enables PCM encoding of the corresponding channels selected in the PCME register. For concatenated channels both corresponding channel bits should be set. The PCMEx bit only enables the PCM functionality; it is still necessary to set the corresponding PWMx bit to enable the channel itself.

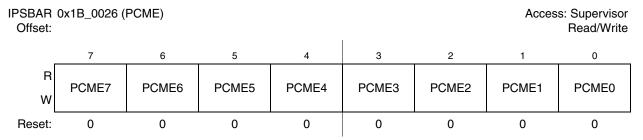


Figure 31-14. PWM PCM Mode Enable Register (PCME)

Table 31-14. PCME Field Descriptions

| Field | Description |
|------------|--|
| 7 PCME7 | PCM Channel 7 Enable. In normal mode, if enabled, the PCM signal becomes available at PWMOUT7 when its corresponding clock source begins its next cycle. 0 PCM output disabled 1 PCM output enabled |
| 6 PCME6 | PCM Channel 6 Output Enable. If enabled, the PCM signal becomes available at PWMOUT6 when its corresponding clock source begins its next cycle. O PCM output disabled 1 PCM output enabled |
| 5 PCME5 | PCM Channel 5 Output Enable. If enabled, the PCM signal becomes available at PWMOUT5 when its corresponding clock source begins its next cycle. O PCM output disabled 1 PCM output enabled |

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Table 31-14. PCME Field Descriptions (continued)

| Field | Description |
|------------|--|
| 4 PCME4 | PCM Channel 4 Output Enable. If enabled, the PCM signal becomes available at PWMOUT4 when its corresponding clock source begins its next cycle. 0 PCM output disabled 1 PCM output enabled |
| 3 PCME3 | PCM Channel 3 Output Enable. If enabled, the PCM signal becomes available at PWMOUT3 when its corresponding clock source begins its next cycle. O PCM output disabled 1 PCM output enabled |
| 2 PCME2 | PCM Channel 2 Output Enable. If enabled, the PCM signal becomes available at PWMOUT2 when its corresponding clock source begins its next cycle. O PCM output disabled 1 PCM output enabled |
| 1 PCME1 | PCM Channel 1 Output Enable. If enabled, the PCM signal becomes available at PWMOUT1 when its corresponding clock source begins its next cycle. O PCM output disabled 1 PCM output enabled |
| 0 PCME0 | PWM Channel 0 Output Enable. If enabled, the PCM signal becomes available at PWMOUT0 when its corresponding clock source begins its next cycle. 0 PCM output disabled 1 PCM output enabled |

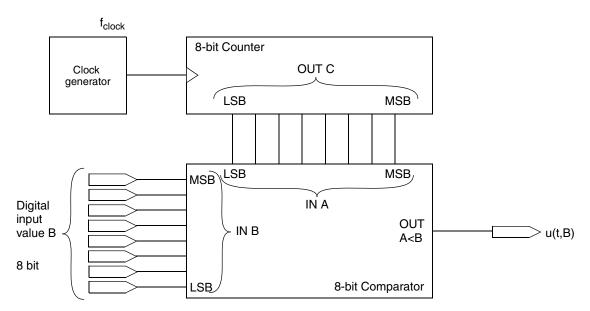


Figure 31-15. Block Diagram of an 8-bit PWM



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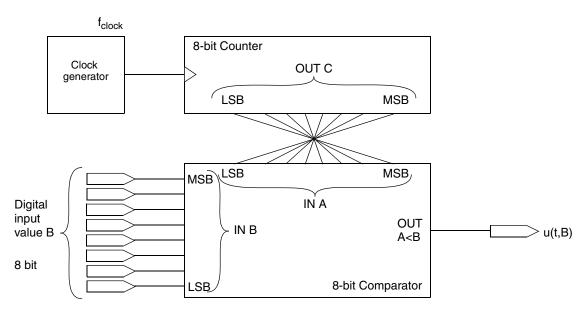


Figure 31-16. Block Diagram of an 8-bit PCM

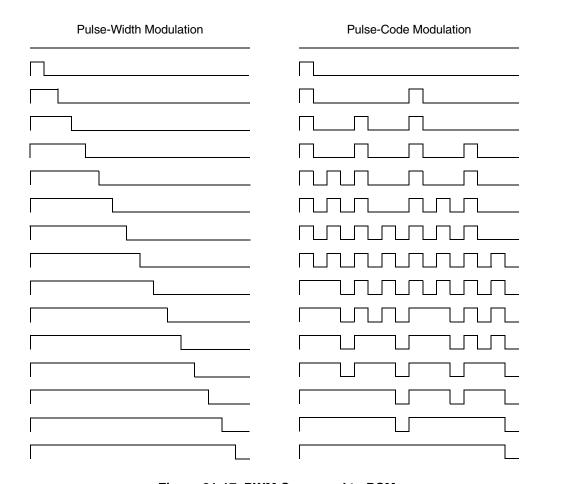


Figure 31-17. PWM Compared to PCM

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31.3 Functional Description

31.3.1 PWM Clock Select

There are four available clocks—clock A, B, SA (scaled A), and SB (scaled B)—all based on the internal bus clock.

Clock A and B can be programmed to run at 1, 1/2,..., 1/128 times the internal bus clock. Clock SA and SB use clock A and B respectively as an input and divide it further with a reloadable counter. The rates available for clock SA and SB are programmable to run at clock A and B divided by 2, 4,..., or 512. Each PWM channel has the capability of selecting one of two clocks, the prescaled clock (clock A or B) or the scaled clock (clock SA or SB). The block diagram in Figure 31-18 shows the four different clocks and how the scaled clocks are created.



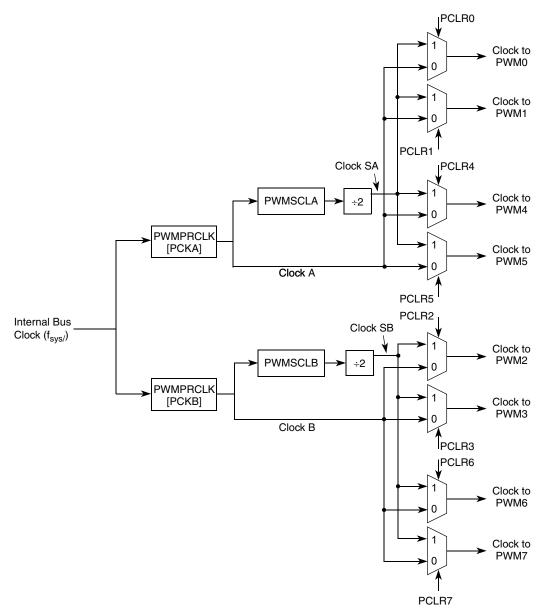


Figure 31-18. PWM Clock Select Block Diagram

31.3.1.1 Prescaled Clock (A or B)

The internal bus clock is the input clock to the PWM prescaler that can be disabled when the device is in debug mode by setting the PWMCTL[PFRZ] bit. This is useful for reducing power consumption and for emulation to freeze the PWM. The input clock is also disabled when all PWM channels are disabled (PWME*n*=0).

Clock A and B are scaled values of the input clock. The value is software selectable for clock A and B and has options of 1, 1/2,..., or 1/128 times the internal bus clock. The value selected for clock A and B is determined by the PWMPRCLK[PCKAn] and PWMPRCLK[PCKBn] bits.

31-18



31.3.1.2 Scaled Clock (SA or SB)

The scaled A (SA) and scaled B (SB) clocks use clock A and B respectively as inputs, divide it further with a user programmable value, then divide this by 2. The rates available for clock SA are programmable to run at clock A divided by 2, 4,..., or 512. Similar rates are available for clock SB.

Clock SA equals clock A divided by two times the value in the PWMSCLA register:

$$Clock SA = \frac{Clock A}{2 \times PWMSCLA}$$
 Eqn. 31-5

Similarly, clock SB is generated according to the following equation:

$$Clock SB = \frac{Clock B}{2 \times PWMSCLB}$$
 Eqn. 31-6

As an example, consider the case in which the user writes 0xFF into the PWMSCLA register. Clock A for this case is selected to be internal bus clock divided by 4. A pulse occurs at a rate of once every 255×4 bus cycles. Passing this through the divide by two circuit produces a clock signal of the internal bus clock divided by 2040. Similarly, a value of 0x01 in the PWMSCLA register when clock A is internal bus clock divided by 4 produces an internal bus clock divided by 8 rate.

Writing to PWMSCLA or PWMSCLB causes the associated 8-bit down counter to be re-loaded. Otherwise, when changing rates, the counter would have to count down to 0x01 before counting at the proper rate. Forcing the associated counter to re-load the scale register value every time PWMSCLA or PWMSCLB is written prevents this.

Writing to the scale registers while channels are operating can cause irregularities in the PWM outputs.

31.3.1.3 Clock Select

Each PWM channel has the capability of selecting one of two clocks. For channels 0, 1, 4, and 5 the clock choices are clock A or SA. For channels 2, 3, 6 and 7, the choices are clock B or SB. The clock selection is done with the PWMCLK[PCLKx] control bits.

Changing clock control bits while channels are operating can cause irregularities in the PWM outputs.

31.3.2 PWM Channel Timers

The main part of the PWM module is the actual timers. Each of the timer channels has a counter, a period register, and a duty register (each are 8-bit). The waveform output period is controlled by a match between the period register and the value in the counter. The duty is controlled by a match between the duty register and the counter value and causes the state of the output to change during the period. The starting polarity of the output is also selectable on a per channel basis. Figure 31-19 shows a block diagram for a PWM timer.

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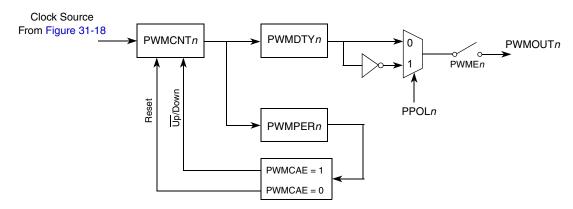


Figure 31-19. PWM Timer Channel Block Diagram

31.3.2.1 **PWM Enable**

Each PWM channel has an enable bit (PWMEn) to start its waveform output. When any of the PWMEn bits are set (PWMEn=1), the associated PWM output signal is enabled immediately. However, the actual PWM waveform is not available on the associated PWM output until its clock source begins its next cycle; this is due to the synchronization of PWMEn and the clock source. An exception is when channels are concatenated. Refer to Section 31.3.2.7, "PWM 16-Bit Functions" for more detail.

The first PWM cycle after enabling the channel can be irregular. When the channel is disabled (PWME*n*=0), the counter for the channel does not count.

31.3.2.2 PWM Polarity

Each channel has a polarity bit to allow starting a waveform cycle with a high or low signal. This is shown on the block diagram as a mux select. When one of the bits in the PWMPOL register is set, the associated PWM channel output is high at the beginning of the waveform, then goes low when the duty count is reached. Conversely, if the polarity bit is zero, the output starts low and then goes high when the duty count is reached.

31.3.2.3 PWM Period and Duty

Dedicated period and duty registers exist for each channel and are double buffered so that if they change while the channel is enabled, the change does not take effect until one of the following occurs:

- The effective period ends
- The PWMCNT*n* register is written (counter resets to 0x00)
- The channel is disabled, PWMEn = 0

In this way, the output of the PWM is always the old waveform or the new waveform, not some variation in between. If the channel is not enabled, writes to the period and duty registers go directly to the latches as well as the buffer.

A change in duty or period can be forced into effect immediately by writing the new value to the duty and/or period registers and then writing to the counter. This forces the counter to reset and the new duty

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and/or period values to be latched. In addition, because the counter is readable, it is possible to know where the count is with respect to the duty value, and software can be used to make adjustments. When forcing a new period or duty into effect immediately, an irregular PWM cycle can occur.

Depending on the polarity bit, the duty registers contain the count of the high time or the low time.

31.3.2.4 PWM Timer Counters

Each channel has a dedicated 8-bit up/down counter that runs at the rate of the selected clock source (see Figure 31-18 for the available clock sources and rates). The counter compares to two registers, a duty register and a period register, as shown in Figure 31-19. When the PWM counter matches the duty register, the output flip-flop changes state, causing the PWM waveform to also change state. A match between the PWM counter and the period register behaves differently depending on what output mode is selected as shown in Figure 31-19 and described in Section 31.3.2.5, "Left-Aligned Outputs" and Section 31.3.2.6, "Center-Aligned Outputs."

Each channel counter can be read at anytime without affecting the count or the operation of the PWM channel.

Any value written to the counter causes the counter to reset to 0x00, the counter direction to be set to up, the immediate load of duty and period registers with values from the buffers, and the output to change according to the polarity bit. When the channel is disabled (PWMEn = 0), the counter stops. When a channel becomes enabled (PWMEn = 1), the associated PWM counter continues from the count in the PWMCNTn register. This allows the waveform to continue where it left off when the channel is re-enabled. When the channel is disabled, writing 0 to the period register causes the counter to reset on the next selected clock.

NOTE

If the user wants to start a new clean PWM waveform without any history from the old waveform, the user must write to channel counter (PWMCNTn) prior to enabling the PWM channel (PWMEn = 1).

Generally, writes to the counter are done prior to enabling a channel to start from a known state. However, writing a counter can also be done while the PWM channel is enabled (counting). The effect is similar to writing the counter when the channel is disabled, except that the new period is started immediately with the output set according to the polarity bit. Writing to the counter while the channel is enabled can cause an irregular PWM cycle to occur.

The counter is cleared at the end of the effective period (see Section 31.3.2.5, "Left-Aligned Outputs" and Section 31.3.2.6, "Center-Aligned Outputs" for more details).

| Counter Clears (0x00) | Counter Counts | Counter Stops | |
|--|---|--|--|
| When PWMCNTn register written to any value | When PWM channel is enabled (PWMEn = 1). Counts from last value | When PWM channel is disabled $(PWMEn = 0)$ | |
| Effective period ends | in PWMCNT <i>n</i> . | (I VVIVILII = 0) | |

Table 31-15. PWM Timer Counter Conditions

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31.3.2.5 Left-Aligned Outputs

The PWM timer provides the choice of two types of outputs: left- or center-aligned. They are selected with the PWMCAE[CAE*n*] bits. If the CAE*n* bit is cleared, the corresponding PWM output is left-aligned.

In left-aligned output mode, the 8-bit counter is configured as an up counter only. It compares to two registers, a duty register and a period register, as shown in the block diagram in Figure 31-19. When the PWM counter matches the duty register, the output flip-flop changes state causing the PWM waveform to also change state. A match between the PWM counter and the period register resets the counter and the output flip-flop, as shown in Figure 31-20, as well as performing a load from the double buffer period and duty register to the associated registers, as described in Figure 31.3.2.3. The counter counts from 0 to the value in the period register minus 1.

NOTE

Changing the PWM output mode from left-aligned to center-aligned output (or vice versa) while channels are operating can cause irregularities in the PWM output. It is recommended to program the output mode before enabling the PWM channel.

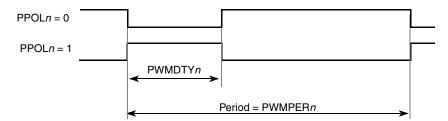


Figure 31-20. PWM Left-Aligned Output Waveform

To calculate the output frequency in left-aligned output mode for a particular channel, take the selected clock source frequency for the channel (A, B, SA, or SB) and divide it by the value in the period register for that channel.

$$PWMn \text{ frequency} = \frac{Clock (A, B, SA, or SB)}{PWMPERn}$$
Eqn. 31-7

The PWMn duty cycle (high time as a percentage of period) is expressed as:

Duty Cycle =
$$\left(1 - PWMPOL[PPOLn] - \frac{PWMDTYn}{PWMPERn}\right) \times 100\%$$
 Eqn. 31-8

31.3.2.5.1 Left-Aligned Output Example

As an example of a left-aligned output, consider the following case:

Clock source = internal bus clock, where internal bus clock = 40 MHz (25 ns period)

PPOLn = 0, PWMPERn = 4, PWMDTYn = 1

PWMn frequency = $40 \text{ MHz} \div 4 = 10 \text{ MHz}$

PWMn period = 100 ns

PWMn Duty Cycle = $\left(1 - \frac{1}{4}\right) \times 100\% = 75\%$

The output waveform generated is below:



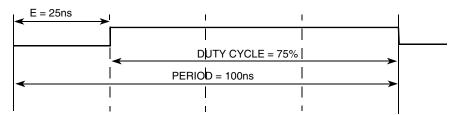


Figure 31-21. PWM Left-Aligned Output Example Waveform

31.3.2.6 Center-Aligned Outputs

For center-aligned output mode selection, set the PWMCAE[CAEn] bit and the corresponding PWM output is center-aligned.

The 8-bit counter operates as an up/down counter in this mode and is set to up when the counter is equal to 0x00. The counter compares to two registers, a duty register and a period register, as shown in the block diagram in Figure 31-19. When the PWM counter matches the duty register, the output flip-flop changes state, causing the PWM waveform to also change state. A match between the PWM counter and the period register changes the counter direction from an up-count to a down-count. When the PWM counter decrements and matches the duty register again, the output flip-flop changes state causing the PWM output to also change state. When the PWM counter decrements and reaches zero, the counter direction changes from a down-count back to an up-count, and a load from the double buffer period and duty registers to the associated registers is performed as described in Figure 31.3.2.3. The counter counts from 0 up to the value in the period register and then back down to 0. Thus the effective period is PWMPER $n \times 2$.

Changing the PWM output mode from left-aligned output to center-aligned output (or vice versa) while channels are operating can cause irregularities in the PWM output. It is recommended to program the output mode before enabling the PWM channel.

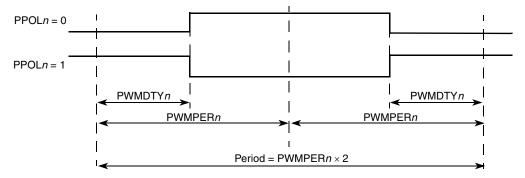


Figure 31-22. PWM Center-Aligned Output Waveform

To calculate the output frequency in center-aligned output mode for a particular channel, take the selected clock source frequency for the channel (A, B, SA, or SB) and divide it by twice the value in the period register for that channel.

$$PWMn \text{ frequency} = \frac{Clock (A, B, SA, or SB)}{2 \times PWMPERn}$$
Eqn. 31-9

The PWM*n* duty cycle (high time as a percentage of period) is expressed as:

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Duty Cycle =
$$\left(1 - \text{PWMPOL}[\text{PPOL}n] - \frac{\text{PWMDTY}n}{\text{PWMPFR}n}\right) \times 100\%$$
 Eqn. 31-10

31.3.2.6.1 Center-Aligned Output Example

As an example of a center-aligned output, consider the following case:

Clock source = internal bus clock, where internal bus clock = 40 MHz (25 ns period)

PPOLn = 0, PWMPERn = 4, PWMDTYn = 1

PWMn frequency = $40 \text{ MHz} / (2 \times 4) = 5 \text{ MHz}$

PWMn period = 200 ns

PWMn Duty Cycle = $\left(1 - \frac{1}{4}\right) \times 100\% = 75\%$

Shown below is the generated output waveform.

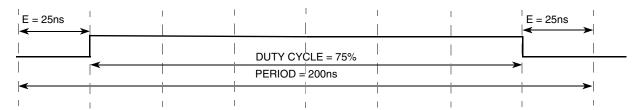


Figure 31-23. PWM Center-Aligned Output Example Waveform

31.3.2.7 PWM 16-Bit Functions

The PWM timer also has the option of generating eight 8-bit channels or four 16-bit channels for greater PWM resolution. This 16-bit channel option is achieved through the concatenation of two 8-bit channels.

The PWMCTL register contains four concatenation control bits, each used to concatenate a pair of PWM channels into one 16-bit channels. Channels 0 and 1 are concatenated with the CON01 bit, channels 2 and 3 are concatenated with the CON23 bit, and so on. Change these bits only when both corresponding channels are disabled.

As shown in Figure 31-24, when channels 2 and 3 are concatenated, channel 2 registers become the high order bytes of the double byte channel. When channels 0 and 1 are concatenated, channel 0 registers become the high order bytes of the double byte channel.

When using the 16-bit concatenated mode, the clock source is determined by the low order 8-bit channel clock select control bits (the odd numbered channel). The resulting PWM is output to the pins of the corresponding low order 8-bit channel, as shown in Figure 31-24. The polarity of the resulting PWM output is controlled by the PPOL*n* bit of the corresponding low order 8-bit channel as well.

After concatenated mode is enabled (PWMCTL[CONnn] bits set), enabling/disabling the corresponding 16-bit PWM channel is controlled by the low order PWMEn bit. In this case, the high order bytes' PWMEn bits have no effect, and their corresponding PWM output is disabled.

In concatenated mode, writes to the 16-bit counter by using a 16-bit access or writes to the low or high order byte of the counter resets the 16-bit counter. Reads of the 16-bit counter must be made by 16-bit access to maintain data coherency.



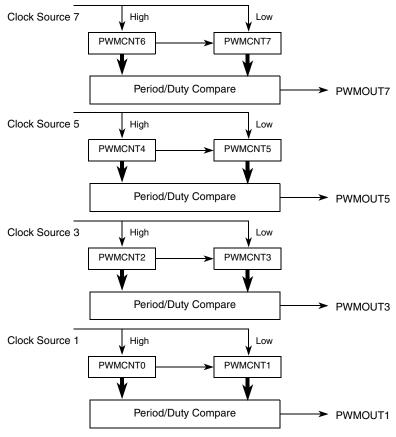


Figure 31-24. PWM 16-Bit Mode

Left- or center-aligned output mode can be used in concatenated mode and is controlled by the low order CAE*n* bit. The high order CAE*n* bit has no effect. The table shown below is used to summarize which channels are used to set the various control bits when in 16-bit mode.

Table 31-16. 16-bit Concatenation Mode Summary

| CONnn | PWME <i>n</i> | PPOLn | PCLKn | CAEn | PWM <i>n</i> Output |
|-------|---------------|-------|-------|------|------------------------|
| CON67 | PWM7 | PPOL7 | PCLK7 | CAE7 | PWMOUT7 |
| CON45 | PWM5 | PPOL5 | PCLK5 | CAE5 | PWMOUT5 |
| CON23 | PWME3 | PPOL3 | PCLK3 | CAE3 | PWMOUT3 |
| CON01 | PWME1 | PPOL1 | PCLK1 | CAE1 | PWMOUT1 |



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31.3.2.8 PWM Boundary Cases

The following table summarizes the boundary conditions for the PWM regardless of the output mode (left-or center-aligned) and 8-bit (normal) or 16-bit (concatenation):

Table 31-17. PWM Boundary Cases

| PWMDTY <i>n</i> | PWMPER <i>n</i> | PPOLn | PWM <i>n</i> Output |
|-----------------------------|--|-------|---------------------|
| 0x00 (indicates no duty) | >0x00 | 1 | Always Low |
| 0x00 (indicates no duty) | >0x00 | 0 | Always High |
| XX | 0x00 ¹ (indicates no period) | 1 | Always High |
| XX | 0x00 ¹ (indicates no period) | 0 | Always Low |
| ≥ PWMPER <i>n</i> | XX | 1 | Always High |
| ≥ PWMPER <i>n</i> | XX | 0 | Always Low |

¹ Counter = 0x00 and does not count.



Chapter 32 FlexCAN

32.1 Introduction

The FlexCAN is a communication controller implementing the controller area network (CAN) protocol, an asynchronous communications protocol used in automotive and industrial control systems. It is a high speed (1 Mbps), short distance, priority-based protocol that can communicate using a variety of mediums (such as fiber optic cable or an unshielded twisted pair of wires). The FlexCAN supports the standard and extended identifier (ID) message formats specified in the CAN protocol specification, revision 2.0, part B.

The CAN protocol was primarily, but not only, designed to be used as a vehicle serial data bus, meeting the specific requirements of this field: real-time processing, reliable operation in the EMI environment of a vehicle, cost-effectiveness, and required bandwidth. A general working knowledge of the CAN protocol revision 2.0 is assumed in this document. For details, refer to the CAN protocol revision 2.0 specification.

32.1.1 Block Diagram

A block diagram describing the various submodules of the FlexCAN module is shown in Figure 32-1. Each submodule is described in detail in subsequent sections.

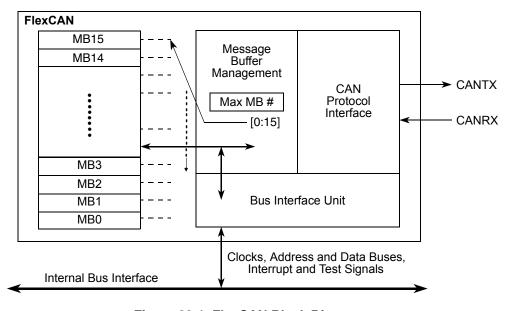


Figure 32-1. FlexCAN Block Diagram

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The message buffer architecture is shown in Figure 32-2.

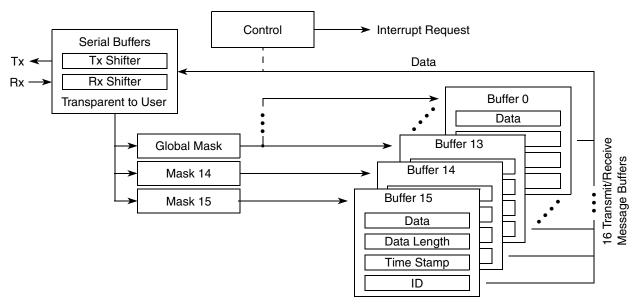


Figure 32-2. FlexCAN Message Buffer Architecture

32.1.1.1 The CAN System

A typical CAN system is shown below in Figure 32-3. Each CAN station is connected physically to the CAN bus through a transceiver. The transceiver provides the transmit drive, waveshaping, and receive/compare functions required for communicating on the CAN bus. It can also provide protection against damage to the FlexCAN caused by a defective CAN bus or defective stations.

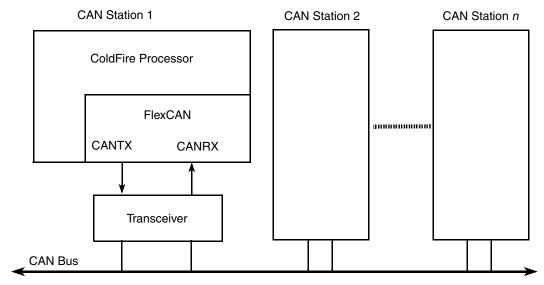


Figure 32-3. Typical CAN System

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32.1.2 Features

Following are the main features of the FlexCAN module:

- Full implementation of the CAN protocol specification version 2.0B
 - Standard data and remote frames (up to 109 bits long)
 - Extended data and remote frames (up to 127 bits long)
 - 0–8 bytes data length
 - Programmable bit rate up to 1 Mbps
 - Content-related addressing
- Up to 16 flexible message buffers of zero to eight bytes data length, each configurable as Rx or Tx, all supporting standard and extended messages
- Listen-only mode capability
- Three programmable mask registers: global (for MBs 0–13), special for MB14, and special for MB15
- Programmable transmission priority scheme: lowest ID or lowest buffer number
- Time stamp based on 16-bit, free-running timer
- Global network time, synchronized by a specific message
- Maskable interrupts
- Independent of the transmission medium (an external transceiver is assumed)
- Open network architecture
- Multimaster bus
- High immunity to EMI
- Short latency time due to an arbitration scheme for high-priority messages

32.1.3 Modes of Operation

32.1.3.1 Normal Mode

In normal mode, the module operates receiving and/or transmitting message frames, errors are managed normally, and all the CAN protocol functions are enabled. User and supervisor modes differ in the access to some restricted control registers.

32.1.3.2 Freeze Mode

Freeze mode is entered by setting:

- CANMCR[FRZ], and
- CANMCR[HALT], or by asserting the BKPT signal.

After entry into freeze mode is requested, the FlexCAN waits until an intermission or idle condition exists on the CAN bus, or until the FlexCAN enters the error passive or bus off state. After one of these conditions exists, the FlexCAN waits for the completion of all internal activity such as arbitration, matching, move-in, and move-out. When this happens, the following events occur:

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- The FlexCAN stops transmitting/receiving frames.
- The prescaler is disabled, thus halting all CAN bus communication.
- The FlexCAN ignores its Rx pins and drives its Tx pins as recessive.
- The FlexCAN loses synchronization with the CAN bus and the NOTRDY and FRZACK bits in CANMCR are set.
- The CPU is allowed to read and write the error counter registers (in other modes they are read-only).

After engaging one of the mechanisms to place the FlexCAN in freeze mode, the user must wait for the FRZACK bit to be set before accessing any other registers in the FlexCAN; otherwise, unpredictable operation may occur. In freeze mode, all memory mapped registers are accessible.

To exit freeze mode, the $\overline{\text{BKPT}}$ line must be negated or the HALT bit in CANMCR must be cleared. After freeze mode is exited, the FlexCAN resynchronizes with the CAN bus by waiting for 11 consecutive recessive bits before beginning to participate in CAN bus communication.

32.1.3.3 Module Disabled Mode

This mode disables the FlexCAN module; it is entered by setting CANMCR[MDIS]. If the module is disabled during freeze mode, it shuts down the system clocks, sets the LPMACK bit, and clears the FRZACK bit.

If the module is disabled during transmission or reception, FlexCAN does the following:

- Waits to be in idle or bus-off state, or else waits for the third bit of intermission and then checks it to be recessive
- Waits for all internal activities such as arbitration, matching, move-in, and move-out to finish
- Ignores its Rx input pin and drives its Tx pin as recessive
- Shuts down the system clocks

The bus interface unit continues to operate, enabling the CPU to access memory-mapped registers, except the free-running timer, the error counter register, and the message buffers, which cannot be accessed when the module is disabled. Exiting from this mode is done by negating the MDIS bit, which resumes the clocks and negate the LPMACK bit.

32.1.3.4 Loop-back Mode

The module enters this mode when the LPB bit in the control register is set. In this mode, FlexCAN performs an internal loop back that can be used for self test operation. The bit stream output of the transmitter is internally fed back to the receiver input. The Rx CAN input pin is ignored and the Tx CAN output goes to the recessive state (logic 1). FlexCAN behaves as it normally does when transmitting and treats its own transmitted message as a message received from a remote node. In this mode, FlexCAN ignores the bit sent during the ACK slot in the CAN frame acknowledge field to ensure proper reception of its own message. Transmit and receive interrupts are generated.

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32.1.3.5 Listen-only Mode

In listen-only mode, transmission is disabled, all error counters are frozen and the module operates in a CAN error passive mode. Only messages acknowledged by another CAN station are received. If FlexCAN detects a message that has not been acknowledged, it flags a BIT0 error (without changing the REC), as if it was trying to acknowledge the message. Because the module does not influence the CAN bus in this mode, the device is capable of functioning like a monitor or for automatic bit-rate detection.

32.2 External Signal Description

Each FlexCAN module has two I/O signals connected to the external MPU pins: CANTX and CANRX. CANTX transmits serial data to the CAN bus transceiver, while CANRX receives serial data from the CAN bus transceiver.

32.3 Memory Map/Register Definition

The FlexCAN module address space is split into 128 bytes starting at the base address, and 256 bytes starting at the base address + 0x80. Out of the lower 128 bytes, only part is occupied by various registers. The upper 256 bytes are fully used for the message buffer structures, as described in Section 32.3.9, "Message Buffer Structure."

| IPSBAR Offset FlexCAN | Register | Width (bits) | Affected by Hard Reset | Affected by Soft Reset | Access | Reset Value | Section/Page |
|-----------------------------|---|-----------------|------------------------------|------------------------------|--------|-------------|--------------|
| | Supervis | or-only | Access Re | egisters | l | | |
| 0x17_0000 | FlexCAN Module Configuration Register (CANMCR) | 32 | Y | Y | R/W | 0xD890_000F | 32.3.1/32-6 |
| | Supervisor/User Access Registers | | | | | | |
| 0x17_0004 | FlexCAN Control Register (CANCTRL) | 32 | Y | N | R/W | 0x0000_0000 | 32.3.2/32-8 |
| 0x17_0008 | Free Running Timer (TIMER) | 32 | Υ | Υ | R/W | 0x0000_0000 | 32.3.3/32-10 |
| 0x17_0010 | Rx Global Mask (RXGMASK) | 32 | Υ | N | R/W | 0x1FFF_FFFF | 32.3.4/32-11 |
| 0x17_0014 | Rx Buffer 14 Mask (RX14MASk) | 32 | Υ | N | R/W | 0x1FFF_FFFF | 32.3.4/32-11 |
| 0x17_0018 | Rx Buffer 15 Mask (RX15MASK) | 32 | Υ | N | R/W | 0x1FFF_FFFF | 32.3.4/32-11 |
| 0x17_001C | Error Counter Register (ERRCNT) | 32 | Υ | Υ | R/W | 0x0000_0000 | 32.3.6/32-13 |
| 0x17_0020 | Error and Status Register (ERRSTAT) | 32 | Υ | Y | R/W | 0x0000_0000 | 32.3.6/32-13 |
| 0x17_0028 | Interrupt Mask Register (IMASK) | 32 | Υ | Υ | R/W | 0x0000_0000 | 32.3.7/32-15 |
| 0x17_0030 | Interrupt Flag Register (IFLAG) | 32 | Υ | Υ | R/W | 0x0000_0000 | 32.3.8/32-16 |
| 0x17_0080 | Message Buffers 0–15 (MB0–15) | 2048 | N | N | R/W | _ | 32.3.9/32-16 |

Table 32-1. FlexCAN Memory Map

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NOTE

The FlexCAN has no hard-wired protection against invalid bit/field programming within its registers. Specifically, no protection is provided if the programming does not meet CAN protocol requirements.

Programming the FlexCAN control registers is typically done during system initialization, prior to the FlexCAN becoming synchronized with the CAN bus. The configuration registers can be changed after synchronization by halting the FlexCAN module. This is done when the user sets the CANMCR[HALT] bit. The FlexCAN responds by setting the CANMCR[NOTRDY] bit.

32.3.1 FlexCAN Configuration Register (CANMCR)

CANMCR defines global system configurations, such as the module operation mode and maximum message buffer configuration. Most of the fields in this register can be accessed at any time, except the MAXMB field, which should only be changed while the module is in freeze mode.

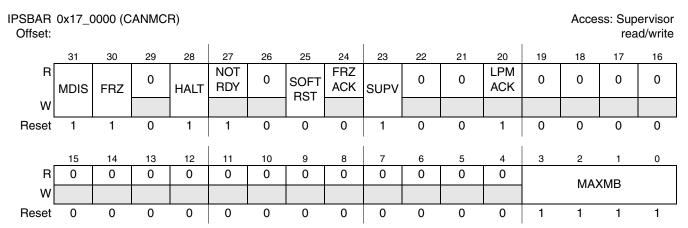


Figure 32-4. FlexCAN Configuration Register (CANMCR)

Table 32-2. CANMCR Field Descriptions

| Field | Description |
|------------|--|
| 31 MDIS | Module disable. This bit controls whether FlexCAN is enabled or not. When disabled, FlexCAN shuts down the FlexCAN clocks that drive the CAN interface and Message Buffer sub-module. This is the only bit in CANMCR not affected by soft reset. See Section 32.1.3.3, "Module Disabled Mode," for more information. 0 Enable the FlexCAN module, clocks enabled 1 Disable the FlexCAN module, clocks disabled |
| 30 FRZ | Freeze mode enable. When set, the FlexCAN can enter freeze mode when the BKPT line is asserted or the HALT bit is set. Clearing this bit causes the FlexCAN to exit freeze mode. Refer to Section 32.1.3.2, "Freeze Mode," for more information. 0 FlexCAN ignores the BKPT signal and the CANMCR[HALT] bit. 1 FlexCAN module enabled to enter debug mode. |
| 29 | Reserved, must be cleared. |

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Table 32-2. CANMCR Field Descriptions (continued)

| Field | Description |
|---------------|--|
| 28 HALT | Halt FlexCAN. Setting this bit puts the FlexCAN module into freeze mode. It has the same effect as assertion of the BKPT signal. This bit is set after reset and should be cleared after initializing the message buffers and control registers. FlexCAN message buffer receive and transmit functions are inactive until this bit is cleared. While in freeze mode, the CPU has write access to the error counter register (ERRCNT) that is otherwise read-only. 1 The FlexCAN enters freeze mode if FRZ equals 1 |
| 27 NOTRDY | FlexCAN not ready. This bit indicates that the FlexCAN is in disable or freeze mode. This bit is read-only and it is cleared after the FlexCAN exits these modes. O FlexCAN is in normal mode, listen-only mode, or loop-back mode. 1 FlexCAN is in disable or freeze mode. |
| 26 | Reserved, must be cleared. |
| 25 SOFTRST | Soft reset. When set, the FlexCAN resets its internal state machines (sequencer, error counters, error flags, and timer) and the host interface registers (CANMCR [except the MDIS bit], TIMER, ERRCNT, ERRSTAT, IMASK, and IFLAG). The configuration registers that control the interface with the CAN bus are not changed (CANCTRL, RXGMASK, RX14MASK, RX15MASK). Message buffers are also not changed. This allows SOFTRST to be used as a debug while the system is running. Because soft reset is synchronous and has to follow a request/acknowledge procedure across clock domains, it may take some time to fully propagate its effect. The SOFTRST bit remains set while reset is pending and is automatically cleared when reset completes. The user should poll this bit to know when the soft reset has completed. O Soft reset cycle completed Soft reset cycle initiated |
| 24 FRZACK | Freeze acknowledge. Indicates that the FlexCAN module has entered freeze mode. The user should poll this bit after freeze mode has been requested, to know when the module has actually entered freeze mode. When freeze mode is exited, this bit is cleared after the FlexCAN prescaler is enabled. This is a read-only bit. 1 The FlexCAN has entered freeze mode, and the prescaler is disabled. |
| 23 SUPV | Supervisor/user data space. Places the FlexCAN registers in supervisor or user data space. 0 Registers with access controlled by the SUPV bit are accessible in user or supervisor privilege mode. 1 Registers with access controlled by the SUPV bit are restricted to supervisor mode. |
| 22–21 | Reserved, must be cleared. |
| 20 LPMACK | Low power mode acknowledge. Indicates that FlexCAN is disabled. Disabled mode cannot be entered until all current transmission or reception processes have finished, so the CPU can poll the LPMACK bit to know when the FlexCAN has actually entered low power mode. See Section 32.1.3.3, "Module Disabled Mode," and Chapter 10, "Power Management," for more information. This bit is read-only. 0 FlexCAN not disabled. 1 FlexCAN is in disabled mode. |
| 19–4 | Reserved, must be cleared. |
| 3–0 MAXMB | Maximum number of message buffers. Defines the maximum number of message buffers that take part in the matching and arbitration process. The reset value (0xF) is equivalent to16 message buffer (MB) configuration. This field should be changed only while the module is in freeze mode. Note: Maximum MBs in Use = MAXMB + 1 |



32.3.2 FlexCAN Control Register (CANCTRL)

CANCTRL is defined for specific FlexCAN control features related to the CAN bus, such as bit-rate, programmable sampling point within an Rx bit, loop back mode, listen-only mode, bus off recovery behavior, and interrupt enabling. It also determines the division factor for the clock prescaler. Most of the fields in this register should only be changed while the module is disabled or in freeze mode. Exceptions are the BOFFMSK, ERRMSK, and BOFFREC bits, which can be accessed at any time.

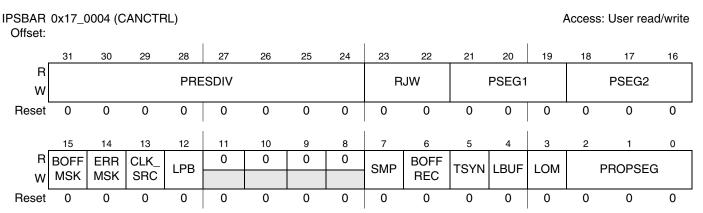


Figure 32-5. FlexCAN Control Register (CANCTRL)

Table 32-3. CANCTRL Field Descriptions

| Field | Description | |
|------------------|---|--|
| 31–24 PRESDIV | Prescaler division factor. Defines the ratio between the clock source frequency (set by CLK_SRC bit) and the serial clock (S clock) frequency. The S clock period defines the time quantum of the CAN protocol. For the reset value, the S clock frequency is equal to the clock source frequency. The maximum value of this register is 0xFF, that gives a minimum S clock frequency equal to the clock source frequency divided by 256. For more information refer to Section 32.3.18, "Protocol Timing." | |
| | S clock frequency = $\frac{f_{SVS} \text{ or EXTAL}}{PRESDIV + 1}$ Eqn. 32-1 | |
| 23–22 RJW | Resynchronization jump width. Defines the maximum number of time quanta (one time quantum is equal to the S clock period) that a bit time can be changed by one resynchronization. The valid programmable values are 0–3. | |
| | Resync jump width = (RJW + 1) time quanta | |
| 21–19 PSEG1 | Phase buffer segment 1. Defines the length of phase buffer segment 1 in the bit time. The valid programmable values are 0–7. | |
| | Phase buffer segment 1 = (PSEG1 + 1) time quanta Eqn. 32-3 | |
| 18–16 PSEG2 | Phase buffer segment 2. Defines the length of phase buffer segment 2 in the bit time. The valid programmable values are 1–7. | |
| | Phase buffer segment 2 = (PSEG2 + 1) time quanta Eqn. 32-4 | |
| 15 BOFFMSK | Bus off interrupt mask. 0 Bus off interrupt disabled 1 Bus off interrupt enabled | |

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Table 32-3. CANCTRL Field Descriptions (continued)

| Field | Description |
|---------------|---|
| 14 ERRMSK | Error interrupt mask. 0 Error interrupt disabled 1 Error interrupt enabled |
| 13 CLK_SRC | Clock source. Selects the clock source for the CAN interface to be fed to the prescalar. This bit should only be changed while the module is disabled. O Clock source is EXTAL Clock source is the internal bus clock, f _{sys} |
| 12 LPB | Loop back. Configures FlexCAN to operate in loop-back mode. In this mode, FlexCAN performs an internal loop back that can be used for self test operation. The bit stream output of the transmitter is fed back internally to the receiver input. The Rx CAN input pin is ignored and the Tx CAN output goes to the recessive state (logic 1). FlexCAN behaves as it normally does when transmitting, and treats its own transmitted message as a message received from a remote node. In this mode, FlexCAN ignores the bit sent during the ACK slot in the CAN frame acknowledge field, generating an internal acknowledge bit to ensure proper reception of its own message. Transmit and receive interrupts are generated. O Loop back disabled Loop back enabled |
| 11–8 | Reserved, must be cleared. |
| 7 SMP | Sampling mode. Determines whether the FlexCAN module samples each received bit one time or three times to determine its value. O One sample, taken at the end of phase buffer segment 1, is used to determine the value of the received bit. Three samples are used to determine the value of the received bit. The samples are taken at the normal sample point and at the two preceding periods of the S-clock; a majority rule is used. |
| 6 BOFFREC | Bus off recovery mode. Defines how FlexCAN recovers from bus off state. If this bit is cleared, automatic recovering from bus off state occurs according to the <i>CAN Specification 2.0B</i> . If the bit is set, automatic recovering from bus off is disabled and the module remains in bus off state until the bit is cleared by the user. If the bit is cleared before 128 sequences of 11 recessive bits are detected on the CAN bus, then bus off recovery happens as if the BOFFREC bit had never been set. If the bit is cleared after 128 sequences of 11 recessive bits occurred, FlexCAN re-synchronizes to the bus by waiting for 11 recessive bits before joining the bus. After clearing, the BOFFREC bit can be set again during bus off, but it is only effective the next time the module enters bus off. If BOFFREC was cleared when the module entered bus off, setting it during bus off is not effective for the current bus off recovery. O Automatic recovering from bus off state enabled, according to CAN Spec 2.0B Automatic recovering from bus off state disabled |
| 5 TSYN | Timer synchronize mode. Enables the mechanism that resets the free-running timer each time a message is received in Message Buffer 0. This provides the means to synchronize multiple FlexCAN stations with a special SYNC message (global network time). 0 Timer synchronization disabled. 1 Timer synchronization enabled. Note: There can be a bit clock skew of four to five counts between different FlexCAN modules that are using this on the same network. |
| 4 LBUF | Lowest buffer transmitted first. Defines the ordering mechanism for message buffer transmission. 0 Message buffer with lowest ID is transmitted first 1 Lowest numbered buffer is transmitted first |



Table 32-3. CANCTRL Field Descriptions (continued)

| Field | Description |
|----------------|---|
| 3 LOM | Listen-only mode. Configures FlexCAN to operate in listen-only mode. In this mode transmission is disabled, all error counters are frozen, and the module operates in a CAN error passive mode. Only messages acknowledged by another CAN station is received. If FlexCAN detects a message that has not been acknowledged, it flags a BITO error (without changing the REC), as if it was trying to acknowledge the message. O FlexCAN module is in normal active operation; listen-only mode is deactivated 1 FlexCAN module is in listen-only mode operation |
| 2–0 PROPSEG | Propagation segment. Defines the length of the propagation segment in the bit time. The valid programmable values are 0–7. |
| | Propagation segment time = (PROPSEG + 1) time-quanta Eqn. 32-5 |
| | Note: A time-quantum equals 1 S clock period. |

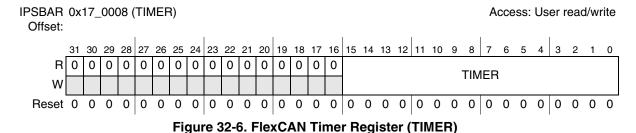
32.3.3 FlexCAN Free Running Timer Register (TIMER)

This register represents a 16-bit free running counter that can be read and written to by the CPU. The timer starts from 0x0000 after reset, counts linearly to 0xFFFF, and wraps around.

The timer is clocked by the FlexCAN bit-clock (which defines the baud rate on the CAN bus). During a message transmission/reception, it increments by one for each received or transmitted bit. When there is no message on the bus, it counts using the previously programmed baud rate. During freeze mode, the timer is not incremented.

The timer value is captured at the beginning of the identifier (ID) field of any frame on the CAN bus. This captured value is written into the TIMESTAMP entry in a message buffer after a successful reception or transmission of a message.

Writing to the timer is an indirect operation. The data is first written to an auxiliary register, then an internal request/acknowledge procedure across clock domains is executed. All this is transparent to the user, except for the fact that the data takes some time to be actually written to the register. If desired, software can poll the register to discover when the data was actually written.



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| Table 32-4. TIMER F | Field Descriptions |
|---------------------|--------------------|
|---------------------|--------------------|

| Field | Description |
|---------------|--|
| 31–16 | Reserved, must be cleared. |
| 15–0 TIMER | Free running timer. Captured at the beginning of the identifier (ID) field of any frame on the CAN bus. This captured value is written into the TIMESTAMP entry in a message buffer after a successful reception or transmission of a message. |

32.3.4 Rx Mask Registers (RXGMASK, RX14MASK, RX15MASK)

These registers are used as acceptance masks for received frame IDs. Three masks are defined: a global mask (RXGMASK) used for Rx buffers 0–13 and two separate masks for buffers 14 (RX14MASK) and 15 (RX15MASK). The meaning of each mask bit is the following:

MIn bit = 0: The corresponding incoming ID bit is don't care.

MIn bit = 1: The corresponding ID bit is checked against the incoming ID bit, to see if a match exists.

These masks are used for standard and extended ID formats. The value of the mask registers should not be changed while in normal operation (only while in freeze mode), as locked frames that matched a message buffer (MB) through a mask may be transferred into the MB (upon release) but may no longer match.

Base ID **Extended ID IDE** Match ID28.....ID18 ID17.....ID0 MB2-ID 11111111000 0 1 MB3-ID 1111111000 010101010101010101 MB4-ID 00000011111 0 MB5-ID 00000011101 1 010101010101010101 MB14-ID 11111111000 1 010101010101010101 Rx_Global_Mask 111111100000000001 11111111110 Rx Msg in¹ 11111111001 1 010101010101010101 MB3¹ Rx Msg in² 11111111001 0 $MB2^2$ 3 Rx Msg in³ 11111111001 1 010101010101010100 4 Rx_Msg in⁴ 0 01111111000 Rx Msg in⁵ 1 MB14⁵ 01111111000 010101010101010101 RX14MASK 01111111111 1111111000000000000 6 Rx Msg in⁶ 10111111000 1 010101010101010101 Rx_Msg in⁷ 1 MB14⁷ 01111111000 010101010101010101

Table 32-5. Mask Examples for Normal/Extended Messages

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Match for Extended Format (MB3).

² Match for Normal Format. (MB2).

³ Mismatch for MB3 because of ID0.



- Mismatch for MB2 because of ID28.
- ⁵ Mismatch for MB3 because of ID28, Match for MB14 (Uses RX14MASK).
- ⁶ Mismatch for MB14 because of ID27 (Uses RX14MASK).
- Match for MB14 (Uses RX14MASK).

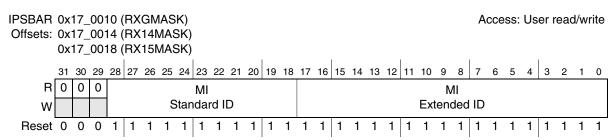


Figure 32-7. FlexCAN Rx Mask Registers (RXGMASK, RX14MASK, RX15MASK)

Table 32-6. RXxxMASK Field Descriptions

| Field | Description |
|------------------|---|
| 31–29 | Reserved, must be cleared. |
| 28–18 MI28–18 | Standard ID mask bits. These bits are the same mask bits for the Standard and Extended Formats. |
| 17–0 MI17–0 | Extended ID mask bits. These bits are used to mask comparison only in Extended Format. |

32.3.5 FlexCAN Error Counter Register (ERRCNT)

This register has two 8-bit fields reflecting the value of two FlexCAN error counters: transmit error counter (TXECTR) and receive error counter (RXECTR). The rules for increasing and decreasing these counters are described in the CAN protocol and are completely implemented in the FlexCAN module. Both counters are read-only, except in freeze mode, where they can be written by the CPU.

Writing to the ERRCNT register while in freeze mode is an indirect operation. The data is first written to an auxiliary register, then an internal request/acknowledge procedure across clock domains is executed. All this is transparent to the user, except for the fact that the data takes some time to be actually written to the register. If desired, software can poll the register to discover when the data was actually written.

FlexCAN responds to any bus state as described in the protocol, e.g. transmit error-active or error-passive flag, delay its transmission start time (error-passive), and avoid any influence on the bus when in bus off state. The following are the basic rules for FlexCAN bus state transitions:

- If the value of TXECTR or RXECTR increases to be greater than or equal to 128, the FLTCONF field in the error and status register (ERRSTAT) is updated to reflect error-passive state.
- If the FlexCAN state is error-passive, and TXECTR or RXECTR decrements to a value less than or equal to 127 while the other already satisfies this condition, the ERRSTAT[FLTCONF] field is updated to reflect error-active state.
- If the value of TXECTR increases to be greater than 255, the ERRSTAT[FLTCONF] field is updated to reflect bus off state, and an interrupt may be issued. The value of TXECTR is then reset to zero.

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- If FlexCAN is in bus off state, then TXECTR is cascaded together with another internal counter to count the 128th occurrences of 11 consecutive recessive bits on the bus. Hence, TXECTR is reset to zero and counts in a manner where the internal counter counts 11 such bits and then wraps around while incrementing the TXECTR. When TXECTR reaches the value of 128, the ERRSTAT[FLTCONF] field is updated to be error-active, and both error counters are reset to zero. At any instance of a dominant bit following a stream of less than 11 consecutive recessive bits, the internal counter resets itself to zero without affecting the TXECTR value.
- If during system start-up, only one node is operating, then its TXECTR increases in each message it is trying to transmit, as a result of acknowledge errors (indicated by the ERRSTAT[ACKERR] bit). After the transition to error-passive state, the TXECTR does not increment anymore by acknowledge errors. Therefore, the device never goes to the bus off state.
- If the RXECTR increases to a value greater than 127, it is not incremented further, even if more errors are detected while being a receiver. At the next successful message reception, the counter is set to a value between 119 and 127 to resume to error-active state.

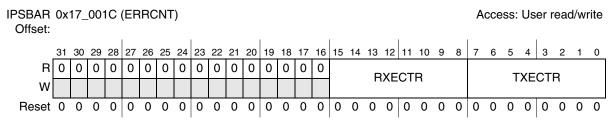


Figure 32-8. FlexCAN Error Counter Register (ERRCNT)

Table 32-7. ERRCNT Field Descriptions

| Field | Description |
|----------------|--|
| 31–16 | Reserved, must be cleared. |
| 15–8 RXECTR | Receive error counter. Indicates current number of receive errors. |
| 7–0 TXECTR | Transmit error counter. Indicates current number of transmit errors. |

32.3.6 FlexCAN Error and Status Register (ERRSTAT)

ERRSTAT reflects various error conditions, some general status of the device, and is the source of three interrupts to the CPU. The reported error conditions (bits 15:10) are those occurred since the last time the CPU read this register. The read action clears bits 15-10. Bits 9-3 are status bits.

Most bits in this register are read only, except for BOFFINT and ERRINT, which are interrupt flags that can be cleared by writing 1 to them. Writing 0 has no effect. Refer to Section 32.4.1, "Interrupts."

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IPSBAR 0x17_0020 (ERRSTAT) Access: User read/write Offset: R W Reset R BIT1 BIT0 ACK CRC FRM STF TX RXFLT **BOFF ERR IDLE TXRX ERR ERR ERR ERR ERR ERR** WRN WRN CONF INT INT W w1c w1c Reset

Figure 32-9. FlexCAN Error and Status Register (ERRSTAT)

Table 32-8. ERRSTAT Field Descriptions

| Field | Description |
|---------------|--|
| 31–16 | Reserved, must be cleared. |
| 15 BIT1ERR | Bit1 error. Indicates inconsistency between the transmitted and received bit in a message. O No transmit bit error At least one bit sent as recessive was received as dominant Note: The transmit bit error field is not modified during the arbitration field or the ACK slot bit time of a message, or by a transmitter that detects dominant bits while sending a passive error frame. |
| 14 BIT0ERR | Bit0 error. Indicates inconsistency between the transmitted and received bit in a message. 0 No transmit bit error 1 At least one bit sent as dominant was received as recessive |
| 13 ACKERR | Acknowledge error. Indicates whether an acknowledgment has been correctly received for a transmitted message. O No ACK error was detected since the last read of this register. An ACK error was detected since the last read of this register. |
| 12 CRCERR | Cyclic redundancy check error. Indicates whether or not a CRC error has been detected by the receiver. O No CRC error was detected since the last read of this register. 1 A CRC error was detected since the last read of this register. |
| 11 FRMERR | Message form error. Indicates that a form error has been detected by the receiver node, i.e. a fixed-form bit field contains at least one illegal bit. O No form error was detected since the last read of this register. 1 A form error was detected since the last read of this register. |
| 10 STFERR | Bit stuff error. O No bit stuffing error was detected since the last read of this register. 1 A bit stuffing error was detected since the last read of this register. |
| 9 TXWRN | Transmit error status flag. Reflects the status of the FlexCAN transmit error counter. 0 Transmit error counter < 96 1 TXErrCounter ≥ 96 |
| 8 RXWRN | Receiver error status flag. Reflects the status of the FlexCAN receive error counter. 0 Receive error counter < 96 1 RxErrCounter ≥ 96 |

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Table 32-8. ERRSTAT Field Descriptions (continued)

| Field | Description |
|----------------|--|
| 7 IDLE | Idle status. Indicates when there is activity on the CAN bus. 0 The CAN bus is not idle. 1 The CAN bus is idle. |
| 6 TXRX | Transmit/receive status. Indicates when the FlexCAN module is transmitting or receiving a message. TXRX has no meaning when IDLE equals 1. 0 The FlexCAN is receiving a message if IDLE equals 0. 1 The FlexCAN is transmitting a message if IDLE equals 0. |
| 5–4 FLTCONF | Fault confinement state. Indicates the confinement state of the FlexCAN module, as shown below. If the CANCTRL[LOM] bit is set, FLTCONF indicates error-passive. Because the CANCTRL register is not affected by soft reset, the FLTCONF field is not affected by soft reset if the LOM bit is set. 00 Error active 01 Error passive 1x Bus off |
| 3 | Reserved, must be cleared. |
| 2 BOFFINT | Bus off interrupt. Used to request an interrupt when the FlexCAN enters the bus off state. The user must write a 1 to clear this bit. Writing 0 has no effect. O No bus off interrupt requested. This bit is set when the FlexCAN state changes to bus off. If the CANCTRL[BOFFMSK] bit is set an interrupt request is generated. This interrupt is not requested after reset. |
| 1 ERRINT | Error interrupt. Indicates that at least one of the ERRSTAT[15:10] bits is set. The user must write a 1 to clear this bit. Writing 0 has no effect. 0 No error interrupt request. 1 At least one of the error bits is set. If the CANCTRL[ERRMSK] bit is set, an interrupt request is generated. |
| 0 | Reserved, must be cleared. |

32.3.7 **Interrupt Mask Register (IMASK)**

IMASK contains one interrupt mask bit per buffer. It enables the CPU to determine which buffer generates an interrupt after a successful transmission/reception (when the corresponding IFLAG bit is set).

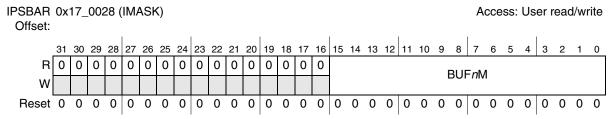


Figure 32-10. FlexCAN Interrupt Mask Register (IMASK)

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Table 32-9. IMASK Field Descriptions

| Field | Description |
|------------------------|---|
| 31–16 | Reserved, must be cleared. |
| 15–0 BUF <i>n</i> M | Buffer interrupt mask. Enables the respective FlexCAN message buffer (MB0 to MB15) interrupt. These bits allow the CPU to designate which buffers generate interrupts after successful transmission/reception. 1 The interrupt for the corresponding buffer is enabled. 1 The interrupt for the corresponding buffer is enabled. Note: Setting or clearing an IMASK bit can assert or negate an interrupt request, if the corresponding IFLAG bit it is set. |

32.3.8 Interrupt Flag Register (IFLAG)

IFLAG contains one interrupt flag bit per buffer. Each successful transmission/reception sets the corresponding IFLAG bit and, if the corresponding IMASK bit is set, generates an interrupt.

The interrupt flag is cleared by writing a 1, while writing 0 has no effect.

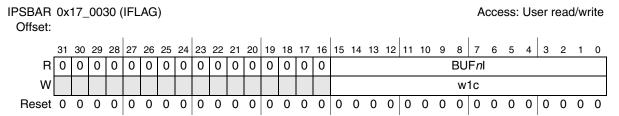


Figure 32-11. FlexCAN Interrupt Flags Register (IFLAG)

Table 32-10. IFLAG Field Descriptions

| Field | Description |
|------------------------|--|
| 31–16 | Reserved, must be cleared. |
| 15–0 BUF <i>n</i> l | Buffer interrupt flag. Indicates a successful transmission/reception for the corresponding message buffer. If the corresponding IMASK bit is set, an interrupt request is generated. The user must write a 1 to clear an interrupt flag; writing 0 has no effect. 0 No such occurrence. 1 The corresponding buffer has successfully completed transmission or reception. |

32.3.9 Message Buffer Structure

The message buffer memory map starts at an offset of 0x80 from the FlexCAN's base address (0x17 0000). The 256-byte message buffer space is fully used by the 16 message buffer structures.

Each message buffer consists of a control and status field that configures the message buffer, an identifier field for frame identification, and up to 8 bytes of data.

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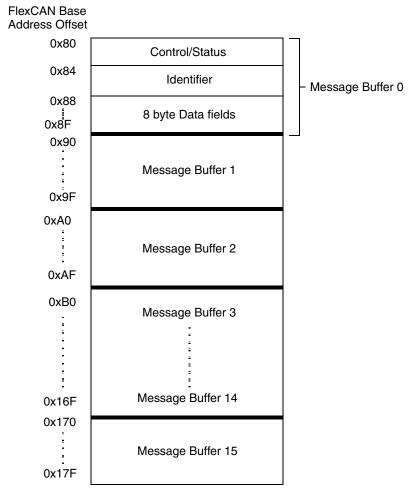


Figure 32-12. FlexCAN Message Buffer Memory Map

The message buffer structure used by the FlexCAN module is shown in Figure 32-13. Standard and extended frames used in the CAN Specification Version 2.0, Part B are represented. A standard frame is represented by the 11-bit standard identifier, and an extended frame is represented by the combined 29-bits of the standard identifier (11 bits) and the extended identifier (18 bits).

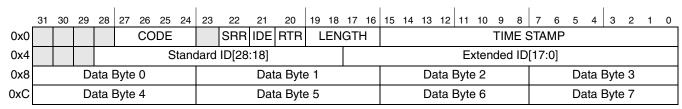


Figure 32-13. Message Buffer Structure for Extended and Standard Frames

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Table 32-11. Message Buffer Field Descriptions

| Field | Description |
|---------------------------------------|---|
| 31–28 | Reserved, must be cleared. |
| 27–24 CODE | Message buffer code. Can be accessed (read or write) by the CPU and by the FlexCAN module itself, as part of the message buffer matching and arbitration process. The encoding is shown in Table 32-12 and Table 32-13. See Section 32.3.10, "Functional Overview," for additional information. |
| 23 | Reserved, must be cleared. |
| 22 SRR | Substitute remote request. Fixed recessive bit, used only in extended format. It must be set by the user for transmission (Tx Buffers) and is stored with the value received on the CAN bus for Rx receiving buffers. It can be received as recessive or dominant. If FlexCAN receives this bit as dominant, then it is interpreted as arbitration loss. O Dominant is not a valid value for transmission in Extended Format frames Recessive value is compulsory for transmission in Extended Format frames |
| 21 IDE | ID extended bit. Identifies whether the frame format is standard or extended. 0 Standard frame format 1 Extended frame format |
| 20 RTR | Remote transmission request. Used for requesting transmissions of a data frame. If FlexCAN transmits this bit as 1 (recessive) and receives it as 0 (dominant), it is interpreted as arbitration loss. If this bit is transmitted as 0 (dominant), then if it is received as 1 (recessive), the FlexCAN module treats it as bit error. If the value received matches the value transmitted, it is considered as a successful bit transmission. 0 Indicates the current MB has a data frame to be transmitted 1 Indicates the current MB has a remote frame to be transmitted |
| 19–16 LENGTH | Length of data in bytes. Indicates the length (in bytes) of the Rx or Tx data; data is located in offset 0x8 through 0xF of the MB space (see Figure 32-13). In reception, this field is written by the FlexCAN module, copied from the DLC (data length code) field of the received frame. DLC is defined by the <i>CAN Specification</i> and refers to the data length of the actual frame before it is copied into the message buffer. In transmission, this field is written by the CPU and is used as the DLC field value of the frame to be transmitted. When RTR is set, the frame to be transmitted is a remote frame and is transmitted without the DATA field, regardless of the LENGTH field. |
| 150 TIME STAMP | Free-running counter time stamp. Stores the value of the free-running timer which is captured when the beginning of the identifier (ID) field appears on the CAN bus. |
| 31–29 | Reserved, must be cleared. |
| 28–0 | Standard frame identifier: In standard frame format, only the 11 most significant bits (28 to 18) are used for frame identification in receive and transmit cases. The 18 least significant bits are ignored. |
| ID | Extended frame identifier: In extended frame format, all bits (the 11 bits of the standard frame identifier and the 18 bits of the extended frame identifier) are used for frame identification in receive and transmit cases. |
| 31–24, 23–16, 15–8, 7–0 DATA | Data field. Up to eight bytes can be used for a data frame. For Rx frames, the data is stored as it is received from the CAN bus. For Tx frames, the CPU provides the data to be transmitted within the frame. |

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Table 32-12. Message Buffer Code for Rx Buffers

| Rx Code BEFORE Rx New Frame | Description | Rx Code AFTER Rx New Frame | Comment |
|-----------------------------------|--|---|---|
| 0000 | INACTIVE: MB is not active. | _ | MB does not participate in the matching process. |
| 0100 | EMPTY: MB is active and empty. | 0010 | MB participates in the matching process. When a frame is received successfully, the code is automatically updated to FULL. |
| 0010 | FULL: MB is full. | The act of reading the control followed by unlocking the Micode return to EMPTY. It remains written to the MB at read and the MB was unlock FULL. | |
| | | 0110 | If the MB is FULL and a new frame should be written into this MB before the CPU had time to read it, the MB is overwritten, and the code is automatically updated to OVERRUN. |
| 0110 | OVERRUN: A frame was overwritten into a full buffer. | 0010 | If the code indicates OVERRUN but the CPU reads the C/S word and then unlocks the MB, when a new frame is written to the MB, the code returns to FULL. |
| 0110 | | 0110 | If the code already indicates OVERRUN, and yet another new frame must be written, the MB is overwritten again, and the code remains OVERRUN. |
| 0XY1 ¹ | BUSY: Flexcan is updating the contents of the MB with a new receive frame. The CPU should not try to access the MB. | 0010 | An EMPTY buffer was written with a new frame (XY was 01). |
| | | 0110 | A FULL/OVERRUN buffer was overwritten (XY was 11). |

¹ For transmit message buffers (see Table 32-13), the BUSY bit should be ignored upon read.

Table 32-13. Message Buffer Code for Tx Buffers

| MBn[RTR] | Initial Tx Code | Code After Successful Transmission | Description | |
|----------|--------------------|--|--|--|
| Х | 1000 | _ | INACTIVE: Message buffer not ready for transmit and participates in the arbitration process. | |
| 0 | 1100 | 1000 | Data frame to be transmitted once, unconditionally. After transmission, the MB automatically returns to the INACTIVE state. | |
| 1 | 1100 | 0100 | Remote frame to be transmitted unconditionally once, and message buffer becomes an Rx message buffer with the same ID for data frames. | |

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Table 32-13. Message Buffer Code for Tx Buffers (continued)

| MBn[RTR] | Initial Tx Code | Code After Successful Transmission | Description |
|----------|--------------------|--|--|
| 0 | 1010 | 1010 | Transmit a data frame when a remote request frame with the same ID is received. This message buffer participates simultaneously in the matching and arbitration processes. The matching process compares the ID of the incoming remote request frame with the ID of the MB. If a match occurs, this message buffer is allowed to participate in the current arbitration process and the CODE field is automatically updated to 1110 to allow the MB to participate in future arbitration runs. When the frame is eventually transmitted successfully, the code automatically returns to 1010 to restart the process again. |
| 0 | 1110 | 1010 | This is an intermediate code automatically written to the message buffer as a result of match to a remote request frame. The data frame is transmitted unconditionally once, and then the code automatically returns to 1010. The CPU can also write this code with the same effect. |

32.3.10 Functional Overview

The FlexCAN module is flexible in that each one of its 16 message buffers (MBs) can be assigned as a transmit buffer or a receive buffer. Each MB, which is up to 8 bytes long, is also assigned an interrupt flag bit that indicates successful completion of transmission or reception.

An arbitration algorithm decides the prioritization of MBs to be transmitted based on the message ID or the MB ordering. A matching algorithm makes it possible to store received frames only into MBs that have the same ID programmed on its ID field. A masking scheme makes it possible to match the ID programmed on the MB with a range of IDs on received CAN frames. Data coherency mechanisms are implemented to guarantee data integrity during MB manipulation by the CPU.

Before proceeding with the functional description, an important concept must be explained. A message buffer is said to be active at a given time if it can participate in the matching and arbitration algorithms that are happening at that time. An Rx MB with a 0000 code is inactive (refer to Table 32-12). Similarly, a Tx MB with a 1000 code is inactive (refer to Table 32-13). An MB not programmed with 0000 or 1000 is temporarily deactivated (does not participate in the current arbitration/matching run) when the CPU writes to the C/S field of that MB.

32.3.11 Transmit Process

The CPU prepares or changes an MB for transmission by writing the following:

- 1. Control/status word to hold Tx MB inactive (CODE = 1000)
- 2. ID word
- 3. Data bytes
- 4. Control/status word (active CODE, LENGTH)

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NOTE

The first and last steps are mandatory.

The first write to the control/status word is important in case there was pending reception or transmission. The write operation immediately deactivates the MB, removing it from any currently ongoing arbitration or ID matching processes, giving time for the CPU to program the rest of the MB (see Section 32.3.15.1, "Message Buffer Deactivation"). After the MB is activated in the fourth step, it participates in the arbitration process and eventually be transmitted according to its priority. At the end of the successful transmission, the value of the free running timer (TIMER) is written into the message buffer's time stamp field, the code field in the control and status word is updated, a status flag is set in the IFLAG register, and an interrupt is generated if allowed by the corresponding IMASK register bit. The new code field after transmission depends on the code that was used to activate the MB in step four (see Table 32-13).

32.3.12 Arbitration Process

The arbitration process is an algorithm executed by the message buffer management (MBM) that scans the entire MB memory looking for the highest priority message to be transmitted. All MBs programmed as transmit buffers are scanned to find the lowest ID or the lowest MB number, depending on the CANCTRL[LBUF] bit.

NOTE

If CANCTRL[LBUF] is cleared, the arbitration considers not only the ID, but also the RTR and IDE bits placed inside the ID at the same positions they are transmitted in the CAN frame.

The arbitration process is triggered in the following events:

- During the CRC field of the CAN frame
- During the error delimiter field of the CAN frame
- During intermission, if the winner MB defined in a previous arbitration was deactivated, or if there was no MB to transmit, but the CPU wrote to the C/S word of any MB after the previous arbitration finished
- When MBM is in idle or bus off state and the CPU writes to the C/S word of any MB
- Upon leaving freeze mode

After the highest priority MB is selected, it is transferred to a temporary storage space called serial message buffer (SMB), which has the same structure as a normal MB but is not user accessible. This operation is called move-out.

At the first opportunity window on the CAN bus, the message on the SMB is transmitted according to the CAN protocol rules. FlexCAN transmits up to 8 data bytes, even if the data length code (DLC) value is bigger.

32.3.13 Receive Process

The CPU prepares or changes an MB for frame reception by writing the following:

1. Control/status word to hold Rx MB inactive (CODE = 0000)

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- 2. ID word
- 3. Control/status word to mark the Rx MB as active and empty (CODE = 0100)

NOTE

The first and last steps are mandatory.

The first write to the control/status word is important in case there was a pending reception or transmission. The write operation immediately deactivates the MB, removing it from any currently ongoing arbitration or matching process, giving time for the CPU to program the rest of the MB. After the MB is activated in the third step, it is able to receive CAN frames that match the programmed ID. At the end of a successful reception:

- The value of the free running timer (TIMER) is written into the time stamp field,
- The received ID, data (8 bytes at most) and length fields are stored,
- The CODE field in the control and status word is updated (see Table 32-12), and
- A status flag is set in the IFLAG register and an interrupt is generated if allowed by the corresponding IMASK bit.

The CPU should read a receive frame from its MB by reading the following:

- 1. Control/status word (mandatory—activates internal lock for this buffer)
- 2. ID (optional—needed only if a mask was used)
- 3. Data field words
- 4. Free-running timer (Releases internal lock —optional)

Upon reading the control and status word, if the BUSY bit is set in the CODE field, then the CPU should defer the access to the MB until this bit is negated. Reading the free running timer is not mandatory. If not executed the MB remains locked, unless the CPU reads the C/S word of another MB. Only a single MB is locked at a time. The only mandatory CPU read operation is the one on the control and status word to assure data coherency.

The CPU should synchronize to frame reception by an IFLAG bit for the specific MB (see Section 32.3.8, "Interrupt Flag Register (IFLAG)"), and not by the control/status word CODE field for that MB. Polling the CODE field does not work because after a frame was received and the CPU services the MB (by reading the C/S word followed by unlocking the MB), the CODE field does not return to EMPTY. It remains FULL, as explained in Table 32-12. If the CPU tries to workaround this behavior by writing to the C/S word to force an EMPTY code after reading the MB, the MB is actually deactivated from any currently ongoing matching process. As a result, a newly received frame matching the ID of that MB may be lost. In summary, never poll by directly reading the C/S word of the MBs. Instead, read the IFLAG register.

The received identifier field is always stored in the matching MB, thus the contents of the ID field in an MB may change if the match was due to masking.

32.3.13.1 Self-Received Frames

Self-received frames are frames that are sent by the FlexCAN and received by itself. The FlexCAN sends a frame externally through the physical layer onto the CAN bus. If the ID of the frame matches the ID of the FlexCAN MB, the frame is received by the FlexCAN. Such a frame is a self-received frame. FlexCAN

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does not receive frames transmitted by itself if another device on the CAN bus has an ID that matches the FlexCAN Rx MB ID.

32.3.14 Matching Process

The matching process is an algorithm that scans the entire MB memory looking for Rx MBs programmed with the same ID as the one received from the CAN bus. Only MBs programmed to receive participate in the matching process for received frames.

While the ID, DLC and data fields are retrieved from the CAN bus, they are stored temporarily in the serial message buffer. The matching process takes place during the CRC field. If a matching ID is found in one of the MBs, the contents of the SMB are transferred to the matched MB during the sixth bit of the end-of-frame field of the CAN protocol. This operation is called move-in. If any protocol error (CRC, ACK, etc.) is detected, than the move-in operation does not happen.

An MB with a matching ID is free to receive a new frame if the MB is not locked (see Section 32.3.15.2, "Locking and Releasing Message Buffers"). The CODE field is EMPTY, FULL, or OVERRUN but the CPU has already serviced the MB (read the C/S word and then unlocked the MB).

Matching to a range of IDs is possible by using ID acceptance masks. FlexCAN supports a masking scheme with three mask registers (RXGMASK, RX14MASK, and RX15MASK). During the matching algorithm, if a mask bit is asserted, then the corresponding ID bit is compared. If the mask bit is negated, the corresponding ID bit is don't care.

32.3.15 Message Buffer Managing

To maintain data coherency and FlexCAN proper operation, the CPU must obey the rules described in Section 32.3.11, "Transmit Process" and Section 32.3.13, "Receive Process." Any form of CPU accessing a MB structure within FlexCAN other than those specified may cause FlexCAN to behave in an unpredictable way.

32.3.15.1 Message Buffer Deactivation

If the CPU wants to change the function of an active MB, the recommended procedure is to put the module into freeze mode and then change the CODE field of that MB. This is a safe procedure because the FlexCAN waits for pending CAN bus and MB moving activities to finish before entering freeze mode. Nevertheless, a mechanism is provided to maintain data coherence when the CPU writes to the control and status word of active MBs out of freeze mode.

Any CPU write access to the C/S word of an MB causes that MB to be excluded from the transmit or receive processes during the current matching or arbitration round. This mechanism is called MB deactivation. It is temporary, affecting only for the current match/arbitration round.

The purpose of deactivation is data coherency. The match/arbitration process scans the MBs to decide which MB to transmit or receive. If the CPU updates the MB in the middle of a match or arbitration process, the data of that MB may no longer be coherent; therefore, that MB is deactivated.

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Even with the coherence mechanism described above, writing to the C/S word of active MBs when not in freeze mode may produce undesirable results. Examples are:

- Matching and arbitration are one-pass processes. If MBs are deactivated after they are scanned, no re-evaluation is done to determine a new match/winner. If an Rx MB with a matching ID is deactivated during the matching process after it was scanned, then this MB is marked as invalid to receive the frame, and FlexCAN continues looking for another matching MB within the ones it has not scanned yet. If it can not find one, the message is lost. Suppose, for example, that two MBs have a matching ID to a received frame, and the user deactivated the first matching MB after FlexCAN has scanned the second. The received frame is lost even if the second matching MB was free to receive
- If a Tx MB containing the lowest ID is deactivated after the FlexCAN has scanned it, the FlexCAN looks for another winner within the MBs that it has not yet scanned. Therefore, it may transmit an MB that may not have the lowest ID at the time because a lower ID might be present that it had already scanned before the deactivation.
- There is a point in time until which the deactivation of a Tx MB causes it not to be transmitted (end of move-out). After this point, it is transmitted, but no interrupt is issued and the CODE field is not updated.

32.3.15.2 Locking and Releasing Message Buffers

Besides MB deactivation, FlexCAN has another data coherence mechanism for the receive process. When the CPU reads the control and status word of an active not empty Rx MB, FlexCAN assumes that the CPU wants to read the whole MB in an atomic operation, and thus it sets an internal lock flag for that MB.

The lock is released when the CPU reads the free running timer (global unlock operation), or when it reads the control and status word of another MB. The MB locking is done to prevent a new frame to be written into the MB while the CPU is reading it.

NOTE

The locking mechanism only applies to Rx MBs which have a code different than INACTIVE (0000) or EMPTY1 (0100). Also, Tx MBs can not be locked.

Suppose, for example, that FlexCAN has already received and stored a message into one of the MBs. Suppose now that the CPU decides to read that MB at the same time another message with the same ID is arriving. When the CPU reads the control and status word, the MB is locked. The new message arrives and the matching algorithm finds out that the matching MB is not free to receive It remains in the SMB waiting for the MB to be unlocked, and only then, is it written to the MB. If the MB is not unlocked in time and yet another new message with the same ID arrives, then the new message overwrites the one on the SMB and there is no indication of lost messages in the code field of the MB or in the error and status register.

While the message is being moved-in from the SMB to the MB, the BUSY bit on the code field is set. If the CPU reads the control and status word and finds out that the BUSY bit is set, it should defer accessing the MB until the BUSY bit is cleared.

If the BUSY bit is set or if the MB is empty, then reading the control and status word does not lock the MB.

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NOTE

Deactivation takes precedence over locking. If the CPU deactivates a locked Rx MB, then its lock status is negated, and the MB is marked as invalid for the current matching round. Any pending message on the SMB is not transferred to the MB anymore.

32.3.16 CAN Protocol Related Frames

32.3.16.1 Remote Frames

The remote frame is a message frame transmitted to request a data frame. The FlexCAN can be configured to transmit a data frame automatically in response to a remote frame, or to transmit a remote frame and then wait for the responding data frame to be received.

When transmitting a remote frame, the user initializes a message buffer as a transmit message buffer with the RTR bit set. After this remote frame is transmitted successfully, the transmit message buffer automatically becomes a receive message buffer, with the same ID as the remote frame that was transmitted.

When a remote frame is received by the FlexCAN, the remote frame ID is compared to the IDs of all transmit message buffers programmed with a CODE of 1010. If there is an exact matching ID, the data frame in that message buffer is transmitted. If the RTR bit in the matching transmit message buffer is set, the FlexCAN transmits a remote frame as a response.

A received remote frame is not stored in a receive message buffer. It is only used to trigger the automatic transmission of a frame in response. The mask registers are not used in remote frame ID matching. All ID bits (except RTR) of the incoming received frame must match for the remote frame to trigger a response transmission. The matching message buffer immediately enters the internal arbitration process, but is considered as a normal Tx MB, with no higher priority. The data length of this frame is independent of the data length code (DLC) field in the remote frame that initiated its transmission.

32.3.16.2 Overload Frames

Overload frame transmissions are not initiated by the FlexCAN unless certain conditions are detected on the CAN bus. These conditions include detection of a dominant bit in the following:

- First or second bit of intermission
- Seventh (last) bit of the end-of-frame (EOF) field in receive frames
- Eighth (last) bit of the error frame delimiter or overload frame delimiter

32.3.17 Time Stamp

The value of TIMER is sampled at the beginning of the identifier field on the CAN bus. For a message being received, the time stamp is stored in the TIMESTAMP entry of the receive message buffer at the time the message is written into that buffer. For a message being transmitted, the TIMESTAMP entry is written into the transmit message buffer after the transmission has completed successfully.

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The free-running timer can optionally be reset upon the reception of a frame into message buffer 0. This allows network time synchronization to be performed. See the CANCTRL[TSYN] bit.

32.3.18 Protocol Timing

The FlexCAN module CANCTRL register configures the bit timing parameters required by the CAN protocol. The CLK_SRC, PRESDIV, RJW, PSEG1, PSEG2, and the PROPSEG fields allow the user to configure the bit timing parameters.

The CANCTRL[CLK_SRC] bit defines whether the module uses the internal bus clock or the output of the crystal oscillator via the EXTAL pin. The crystal oscillator clock should be selected when a tight tolerance (up to 0.1%) is required for the CAN bus timing. The crystal oscillator clock has better jitter performance than PLL generated clocks. The value of this bit should not be changed, unless the module is in disable mode (CANMCR[MDIS] bit is set)

The PRESDIV field controls a prescaler that generates the serial clock (S-clock), whose period defines the time quantum used to compose the CAN waveform. A time quantum is the atomic unit of time managed by the CAN engine.

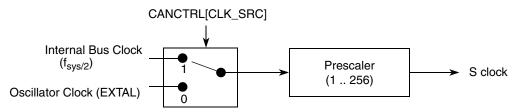


Figure 32-14. CAN Engine Clocking Scheme

$$f_{Tq} = \frac{f_{sys} \text{ or EXTAL}}{(PRESDIV + 1)}$$
 Eqn. 32-6

A bit time is subdivided into three segments¹ (see Figure 32-15 and Table 32-14):

- SYNC_SEG: Has a fixed length of one time quantum. Signal edges are expected to happen within this section.
- Time Segment 1: Includes the propagation segment and the phase segment 1 of the CAN standard. It can be programmed by setting the PROPSEG and the PSEG1 fields of the CANCTRL register so that their sum (plus 2) is in the range of 4 to 16 time quanta.
- Time Segment 2: Represents the phase segment 2 of the CAN standard. It can be programmed by setting the PSEG2 field of the CANCTRL register (plus 1) to be 2 to 8 time quanta long.

Bit Rate =
$$\frac{f_{Tq}}{\text{(number of Time Quanta)}}$$
 Eqn. 32-7

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^{1.} For further explanation of the underlying concepts please refer to ISO/DIS 11519–1, Section 10.3. Reference also the Bosch CAN 2.0A/B protocol specification dated September 1991 for bit timing.



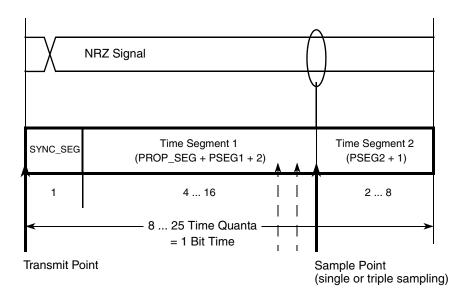


Figure 32-15. Segments within the Bit Time

Table 32-14. Time Segment Syntax

| Syntax | Description | | | |
|----------------|--|--|--|--|
| SYNC_SEG | System expects transitions to occur on the bus during this period. | | | |
| Transmit Point | A node in transmit mode transfers a new value to the CAN bus at this point. | | | |
| Sample Point | A node samples the bus at this point. If the three samples per bit option is selected, then this point marks the position of the third sample. | | | |

Table 32-15 gives an overview of the CAN compliant segment settings and the related parameter values.

NOTE

It is the user's responsibility to ensure the bit time settings are in compliance with the CAN standard. For bit time calculations, use an IPT (Information Processing Time) of 2, which is the value implemented in the FlexCAN module

Table 32-15. CAN Standard Compliant Bit Time Segment Settings

| Time Segment 1 | Time Segment 2 | Re-synchronization Jump Width | |
|----------------|----------------|----------------------------------|--|
| 5 10 | 2 | 1 2 | |
| 4 11 | 3 | 1 3 | |
| 5 12 | 4 | 1 4 | |
| 6 13 | 5 | 1 4 | |
| 7 14 | 6 | 1 4 | |

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Table 32-15. CAN Standard Compliant Bit Time Segment Settings (continued)

| Time Segment 1 | Time Segment 2 | Re-synchronization Jump Width | | |
|----------------|----------------|----------------------------------|--|--|
| 8 15 | 7 | 1 4 | | |
| 9 16 | 8 | 1 4 | | |

32.3.19 Arbitration and Matching Timing

During normal transmission or reception of frames, the arbitration, matching, move-in and move-out processes are executed during certain time windows inside the CAN frame, as shown in the following figure.

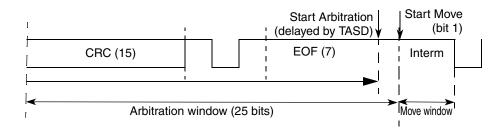


Figure 32-16. Arbitration and Move-Out Time Windows

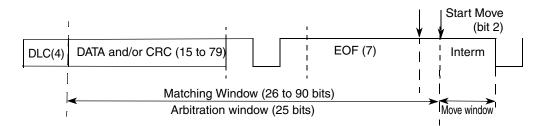


Figure 32-17. Matching and Move-In Time Windows

When doing matching and arbitration, FlexCAN needs to scan the whole Message Buffer memory during the available time slot. In order to have sufficient time to do that, the following requirements must be observed:

- A valid CAN bit timing must be programmed, as indicated in Table 32-15
- The peripheral clock frequency can not be smaller than the oscillator clock frequency, i.e. the PLL can not be programmed to divide down the oscillator clock
- There must be a minimum ratio between the peripheral clock frequency and the CAN bit rate, as specified in Table 31-20

Table 32-16. Minimum Ratio Between Peripheral Clock Frequency and CAN Bit Rate

| Number of Message Buffers | Minimum Ratio | |
|------------------------------|---------------|--|
| up to 64 | 16 | |

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A direct consequence of the first requirement is that the minimum number of time quanta per CAN bit must be 8, so the oscillator clock frequency should be at least 8 times the CAN bit rate. The minimum frequency ratio specified in Table 31-20 can be achieved by choosing a high enough peripheral clock frequency when compared to the oscillator clock frequency, or by adjusting one or more of the bit timing parameters (PRESDIV, PROPSEG, PSEG1, PSEG2). As an example, taking the case of 64 MBs, if the oscillator and peripheral clock frequencies are equal and the CAN bit timing is programmed to have 8 time quanta per bit, then the prescaler factor (PRESDIV + 1) should be at least 2. For prescaler factor equal to one and CAN bit timing with 8 time quanta per bit, the ratio between peripheral and oscillator clock frequencies should be at least 2.

32.4 Initialization/Application Information

Initialization of the FlexCAN includes the initial configuration of the message buffers and configuration of the CAN communication parameters following a reset, as well as any reconfiguration that may be required during operation. The FlexCAN module may be reset in three ways:

- Device level hard reset—resets all memory mapped registers asynchronously
- Device level soft reset—resets some of the memory mapped registers synchronously (refer to Table 32-1 to see which registers are affected by soft reset)
- CANMCR[SOFT_RST] bit—has the same effect as the device level soft reset

Soft reset is synchronous and has to follow an internal request/acknowledge procedure across clock domains. Therefore, it may take some time to fully propagate its effects. The CANMCR[SOFT_RST] bit remains asserted while soft reset is pending, so software can poll this bit to know when the reset has completed. Also, soft reset can not be applied while clocks are shut down in any of the low power modes. The low power mode should be exited and the clocks resumed before applying soft reset.

The clock source, CANCTRL[CLK_SRC], should be selected while the module is in disable mode. After the clock source is selected and the module is enabled (CANMCR[MDIS] bit cleared), the FlexCAN automatically enters freeze mode. In freeze mode, the FlexCAN is un-synchronized to the CAN bus, the CANMCR register's HALT and FRZ bits are set, the internal state machines are disabled, and the CANMCR register's FRZ_ACK and NOT_RDY bits are set. The CANTX pin is in recessive state and the FlexCAN does not initiate any transmission or reception of CAN frames. The message buffers are not affected by reset, so they are not automatically initialized.

For any configuration change/initialization, the FlexCAN must be in freeze mode (see Section 32.1.3.2, "Freeze Mode"). The following is a generic initialization sequence applicable to the FlexCAN module:

- 1. Initialize all operation modes in the CANCTRL register.
 - a) Initialize the bit timing parameters PROPSEG, PSEGS1, PSEG2, and RJW.
 - b) Select the S-clock rate by programming the PRESDIV field.
 - c) Select the internal arbitration mode via the LBUF bit.
- 2. Initialize message buffers.
 - a) The control/status word of all message buffers must be written as an active or inactive message buffer
 - b) All other entries in each message buffer should be initialized as required

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- 3. Initialize RXGMASK, RX14MASK, and RX15MASK registers for acceptance mask as needed.
- 4. Initialize FlexCAN interrupt handler.
 - a) Initialize the interrupt controller registers for any needed interrupts. See Chapter 16, "Interrupt Controller Module," for more information.
 - b) Set the required mask bits in the IMASK register (for all message buffer interrupts) and the CANCTRL (for bus off and error interrupts).
- 5. Clear the CANMCR[HALT] bit. At this point, the FlexCAN attempts to synchronize with the CAN bus.

32.4.1 Interrupts

There are 18 interrupt sources for the FlexCAN module. An interrupt for each of the 16 MBs. The other interrupt sources (bus off and error) act in the same manner, and are located in the ERRSTAT register. The bus off and error interrupt mask bits are located in the CANCTRL register.

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Chapter 33 Debug Module

33.1 Introduction

This chapter describes the revision B+ enhanced hardware debug module.

33.1.1 Block Diagram

The debug module is shown in Figure 33-1.

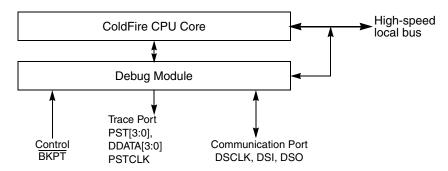


Figure 33-1. Processor/Debug Module Interface

33.1.2 Overview

Debug support is divided into three areas:

- Real-time trace support—The ability to determine the dynamic execution path through an application is fundamental for debugging. The ColdFire solution implements an 8-bit parallel output bus that reports processor execution status and data to an external emulator system. See Section 33.4.4, "Real-Time Trace Support".
- Background debug mode (BDM)—Provides low-level debugging in the ColdFire processor complex. In BDM, the processor complex is halted and a variety of commands can be sent to the processor to access memory, registers, and peripherals. The external emulator uses a three-pin, serial, full-duplex channel. See Section 33.4.1, "Background Debug Mode (BDM)," and Section 33.3, "Memory Map/Register Definition".
- Real-time debug support—BDM requires the processor to be halted, which many real-time embedded applications cannot do. Debug interrupts let real-time systems execute a unique service routine that can quickly save the contents of key registers and variables and return the system to normal operation. External development systems can access saved data, because the hardware supports concurrent operation of the processor and BDM-initiated commands. In addition, the option allows interrupts to occur. See Section 33.4.2, "Real-Time Debug Support".

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The first version 2 ColdFire core devices implemented the original debug architecture, now called revision A. Based on feedback from customers and third-party developers, enhancements have been added to succeeding generations of ColdFire cores. For revision A, CSR[HRL] is 0. See Section 33.3.2, "Configuration/Status Register (CSR)".

Revision B (and B+) of the debug architecture offers more flexibility for configuring the hardware breakpoint trigger registers and removing the restrictions involving concurrent BDM processing while hardware breakpoint registers are active. Revision B+ adds three additional PC breakpoint registers. For revision B, CSR[HRL] is 1, and for revision B+, CSR[HRL] is 0x9.

The following table summarizes the various debug revisions.

| Revision | CSR[HRL] | | Enhancements |
|----------|----------|---|---|
| Α | 0000 | _ | Initial debug revision |
| В | 0001 | 1 | BDM command execution does not affect hardware breakpoint logic Added BDM address attribute register (BAAR) BKPT configurable interrupt (CSR[BKD]) Level 1 and level 2 triggers on OR condition, in addition to AND SYNC_PC command to display the processor's current PC |
| B+ | 1001 | _ | 3 additional PC breakpoint registers PBR1-3 |

Table 33-1. Debug Revision Summary

33.2 Signal Descriptions

Table 33-2 describes debug module signals. All ColdFire debug signals are unidirectional and related to a rising edge of the processor core's clock signal. The standard 26-pin debug connector is shown in Section 33.4.6, "Freescale-Recommended BDM Pinout".

| Signal | Description |
|-------------------------------------|--|
| Development Serial Clock (DSCLK) | Internally synchronized input. (The logic level on DSCLK is validated if it has the same value on two consecutive rising bus clock edges.) Clocks the serial communication port to the debug module during packet transfers. Maximum frequency is 1/5 the processor status clock (PSTCLK). At the synchronized rising edge of DSCLK, the data input on DSI is sampled and DSO changes state. |
| Development Serial Input (DSI) | Internally synchronized input that provides data input for the serial communication port to the debug module after the DSCLK has been seen as high (logic 1). |
| Development Serial Output (DSO) | Provides serial output communication for debug module responses. DSO is registered internally. The output is delayed from the validation of DSCLK high. |
| Breakpoint (BKPT) | Input requests a manual breakpoint. Assertion of $\overline{\text{BKPT}}$ puts the processor into a halted state after the current instruction completes. Halt status is reflected on processor status signals (PST[3:0]) as the value 0xF. If CSR[BKD] is set (disabling normal $\overline{\text{BKPT}}$ functionality), asserting $\overline{\text{BKPT}}$ generates a debug interrupt exception in the processor. |

Table 33-2. Debug Module Signals

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Table 33-2. Debug Module Signals (continued)

| Signal | Description | | | |
|--|---|--|--|--|
| Processor Status Clock (PSTCLK) | Delayed version of the processor clock. Its rising edge appears in the center of valid PST and DDATA output. PSTCLK indicates when the development system should sample PST and DDATA values. The following figure shows PSTCLK timing with respect to PSTD and DATA. PSTCLK PSTCLK PST or DDATA If real-time trace is not used, setting CSR[PCD] keeps PSTCLK, PST and DDATA outputs from toggling without disabling triggers. Non-quiescent operation can be reenabled by clearing CSR[PCD], although the external development systems must resynchronize with the PST and DDATA outputs. PSTCLK starts clocking only when the first non-zero PST value (0xC, 0xD, or 0xF) occurs during system reset exception processing. Table 33-24 describes PST values. | | | |
| Debug Data (DDATA[3:0]) | These output signals display the register breakpoint status as a default, or optionally, captured address and operand values. The capturing of data values is controlled by the setting of the CSR. Additionally, execution of the WDDATA instruction by the processor captures operands that are displayed on DDATA. These signals are updated each processor cycle. These signals are not implemented on packages containing fewer than 100 pins. | | | |
| Processor Status (PST[3:0]) | These output signals report the processor status. Table 33-24 shows the encoding of these signals. These outputs indicate the current status of the processor pipeline and, as a result, are not related to the current bus transfer. The PST value is updated each processor cycle. These signals are not implemented on packages containing fewer than 100 pins. | | | |
| All Processor Status Outputs (ALLPST) | ALLPST is a logical AND of the four PST signals and is provided on all packages. PST[3:0] and DDATA[3:0] are not available on the low cost (less than 100 pin) packages. When asserted, reflects that the core is halted. | | | |

33.3 Memory Map/Register Definition

In addition to the existing BDM commands that provide access to the processor's registers and the memory subsystem, the debug module contain a number of registers to support the required functionality. These registers are also accessible from the processor's supervisor programming model by executing the WDEBUG instruction (write only). Therefore, the breakpoint hardware in debug module can be read or written by the external development system using the debug serial interface or written by the operating system running on the processor core. Software guarantees that accesses to these resources are serialized and logically consistent. Hardware provides a locking mechanism in CSR to allow external development system to disable any attempted writes by the processor to the breakpoint registers (setting CSR[IPW]). BDM commands must not be issued if the ColdFire processor is using the WDEBUG instruction to access debug module registers, or the resulting behavior is undefined. The DSCLK must be quiescent during operation of the WDEBUG command.

These registers, shown in Table 33-3, are treated as 32-bit quantities, regardless of the number of implemented bits. These registers are also accessed through the BDM port by the commands, WDMREG and RDMREG, described in Section 33.4.1.5, "BDM Command Set". These commands contain a 5-bit field, DRc, that specifies the register, as shown in Table 33-3.

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Table 33-3. Debug Module Memory Map

| DRc[4-0] | Register Name | | Access | Reset Value | Section/ Page |
|----------|---|-----------------|-----------------|-------------|------------------|
| 0x00 | Configuration/status register (CSR) | 32 | R/W See Note | 0x0090_0000 | 33.3.2/33-5 |
| 0x05 | BDM address attribute register (BAAR) | 32 ¹ | W | 0x05 | 33.3.3/33-8 |
| 0x06 | Address attribute trigger register (AATR) | 32 ¹ | W | 0x0005 | 33.3.4/33-9 |
| 0x07 | Trigger definition register (TDR) | 32 | W | 0x0000_0000 | 33.3.5/33-10 |
| 0x08 | PC breakpoint register 0 (PBR0) | 32 | W | Undefined | 33.3.6/33-13 |
| 0x09 | PC breakpoint mask register (PBMR) | 32 | W | Undefined | 33.3.6/33-13 |
| 0x0C | Address breakpoint high register (ABHR) | 32 | W | Undefined | 33.3.7/33-15 |
| 0x0D | Address breakpoint low register (ABLR) | 32 | W | Undefined | 33.3.7/33-15 |
| 0x0E | Data breakpoint register (DBR) | 32 | W | Undefined | 33.3.8/33-16 |
| 0x0F | Data breakpoint mask register (DBMR) | 32 | W | Undefined | 33.3.8/33-16 |
| 0x18 | PC breakpoint register 1 (PBR1) | 32 | W | See Section | 33.3.6/33-13 |
| 0x1A | PC breakpoint register 2 (PBR2) | 32 | W | See Section | 33.3.6/33-13 |
| 0x1B | PC breakpoint register 3 (PBR3) | 32 | W | See Section | 33.3.6/33-13 |

¹ Each debug register is accessed as a 32-bit register; reserved fields are not used (don't care).

NOTE

Debug control registers can be written by the external development system or the CPU through the WDEBUG instruction. These control registers are write-only from the programming model and they can be written through the BDM port using the WDMREG command. In addition, the configuration/status register (CSR) can be read through the BDM port using the RDMREG command.

The ColdFire debug architecture supports a number of hardware breakpoint registers, that can be configured into single- or double-level triggers based on the PC or operand address ranges with an optional inclusion of specific data values.

33.3.1 Shared Debug Resources

The debug module revision A implementation provides a common hardware structure for BDM and breakpoint functionality. Certain hardware structures are used for BDM and breakpoint purposes as shown in Table 33-4.



| Register | BDM Function | Breakpoint Function |
|----------|--|-----------------------------------|
| AATR | Bus attributes for all memory commands | Attributes for address breakpoint |
| ABHR | Address for all memory commands | Address for address breakpoint |
| DBR | Data for all BDM write commands | Data for data breakpoint |

Therefore, loading a register to perform a specific function that shares hardware resources is destructive to the shared function. For example, if an operand address breakpoint is loaded into the debug module, a BDM command to access memory overwrites an address breakpoint in ABHR. If a data breakpoint is configured, a BDM write command overwrites the data breakpoint in DBR.

Revision B added hardware registers to eliminate these shared functions. The BAAR is used to specify bus attributes for BDM memory commands and has the same format as the LSB of the AATR. The registers containing the BDM memory address and the BDM data are not program visible.

Configuration/Status Register (CSR) 33.3.2

The CSR defines the debug configuration for the processor and memory subsystem and contains status information from the breakpoint logic. CSR is write-only from the programming model. It can be read from and written to through the BDM port. CSR is accessible in supervisor mode as debug control register 0x00 using the WDEBUG instruction and through the BDM port using the RDMREG and WDMREG commands

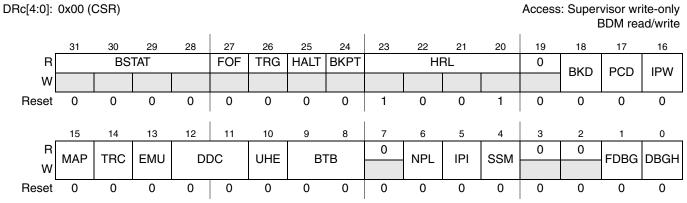


Figure 33-2. Configuration/Status Register (CSR)

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Table 33-5. CSR Field Descriptions

| Field | Description |
|----------------|---|
| 31–28 BSTAT | Breakpoint Status. Provides read-only status (from the BDM port only) information concerning hardware breakpoints. BSTAT is cleared by a TDR write or by a CSR read when a level-2 breakpoint is triggered or a level-1 breakpoint is triggered and the level-2 breakpoint is disabled. 0000 No breakpoints enabled 0001 Waiting for level-1 breakpoint 0010 Level-1 breakpoint triggered 0101 Waiting for level-2 breakpoint 0110 Level-2 breakpoint triggered Else Reserved |
| 27 FOF | Fault-on-fault. If FOF is set, a catastrophic halt occurred and forced entry into BDM. FOF is cleared when CSR is read (from the BDM port only). |
| 26 TRG | Hardware breakpoint trigger. If TRG is set, a hardware breakpoint halted the processor core and forced entry into BDM. Reset, the debug GO command or reading CSR (from the BDM port only) clear TRG. |
| 25 HALT | Processor halt. If HALT is set, the processor executed a HALT and forced entry into BDM. Reset, the debug GO command, or reading CSR (from the BDM port only) clear HALT. |
| 24 BKPT | Breakpoint assert. If BKPT is set, BKPT was asserted, forcing the processor into BDM. Reset, the debug GO command, or reading CSR (from the BDM port only) clear BKPT. |
| 23–20 HRL | Hardware revision level. Indicates, from the BDM port only, the level of debug module functionality. An emulator could use this information to identify the level of functionality supported. 0000 Revision A 0001 Revision B 0010 Revision C 0011 Revision D 1001 Revision B+ (This is the value used for this device) 1011 Revision D+ 1111 Revision D+PSTB |
| 19 | Reserved, must be cleared. |
| 18 BKD | Breakpoint disable. Disables the normal BKPT input signal functionality, and allows the assertion of this pin to generate a debug interrupt. Normal operation BKPT is edge-sensitive: a high-to-low edge on BKPT signals a debug interrupt to the ColdFire core. The processor makes this interrupt request pending until the next sample point occurs, when the exception is initiated. In the ColdFire architecture, the interrupt sample point occurs once per instruction. There is no support for nesting debug interrupts. |
| 17 PCD | PST/DDATA Disable. Disables the PST/DDATA output signal. PSTCLK is unaffected, it remains under the control of the SYNCR[DISCLK] bit. O Normal operation Disables the generation of the PSTDDATA output signals, and forces these signals to remain quiescent Note: When PCD is set, do not execute a wddata instruction or perform any debug captures. Doing so, hangs the device. |
| 16 IPW | Inhibit processor writes. Setting IPW inhibits processor-initiated writes to the debug module's programming model registers. Only commands from the external development system can modify IPW. |

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Table 33-5. CSR Field Descriptions (continued)

| Field | Description |
|--------------|--|
| 15 MAP | Force processor references in emulator mode. O All emulator-mode references are mapped into supervisor code and data spaces. The processor maps all references while in emulator mode to a special address space, TT equals 10, TM equals 101 or 110. The internal SRAM and caches are disabled. |
| 14 TRC | Force emulation mode on trace exception. O The processor enters supervisor mode The processor enters emulator mode when a trace exception occurs |
| 13 EMU | Force emulation mode. 0 Do not force emulator mode 1 The processor begins executing in emulator mode. See Section 33.4.2.2, "Emulator Mode". |
| 12–11 DDC | Debug data control. Controls operand data capture for DDATA, which displays the number of bytes defined by the operand reference size before the actual data; byte displays 8 bits, word displays 16 bits, and long displays 32 bits (one nibble at a time across multiple PSTCLK clock cycles). See Table 33-24. 00 No operand data is displayed. 01 Capture all write data. 10 Capture all read data. 11 Capture all read and write data. |
| 10 UHE | User halt enable. Selects the CPU privilege level required to execute the HALT instruction. 0 HALT is a supervisor-only instruction. 1 HALT is a supervisor/user instruction. |
| 9–8 BTB | Branch target bytes. Defines the number of bytes of branch target address DDATA displays. 00 0 bytes 01 Lower 2 bytes of the target address 10 Lower 3 bytes of the target address 11 Entire 4-byte target address See Section 33.4.4.1, "Begin Execution of Taken Branch (PST = 0x5)". |
| 7 | Reserved, must be cleared. |
| 6 NPL | Non-pipelined mode. Determines whether the core operates in pipelined mode or not. Pipelined mode Non-pipelined mode. The processor effectively executes one instruction at a time with no overlap. This adds at least 5 cycles to the execution time of each instruction. Given an average execution latency of 1.6 cycles/instruction, throughput in non-pipeline mode would be 6.6 cycles/instruction, approximately 25% or less of pipelined performance. Regardless of the NPL state, a triggered PC breakpoint is always reported before the triggering instruction executes. In normal pipeline operation, occurrence of an address and/or data breakpoint trigger is imprecise. In non-pipeline mode, triggers are always reported before the next instruction begins execution and trigger reporting can be considered precise. An address or data breakpoint should always occur before the next instruction begins execution. Therefore, the occurrence of the address/data breakpoints should be guaranteed. |
| 5 IPI | Ignore pending interrupts. O Core services any pending interrupt requests that were signalled while in single-step mode. Core ignores any pending interrupt requests signalled while in single-instruction-step mode. |
| 4 SSM | Single-Step Mode. Setting SSM puts the processor in single-step mode. Normal mode. Single-step mode. The processor halts after execution of each instruction. While halted, any BDM command can be executed. On receipt of the GO command, the processor executes the next instruction and halts again. This process continues until SSM is cleared. |

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Table 33-5. CSR Field Descriptions (continued)

| Field | Description |
|-----------|--|
| 3–2 | Reserved, must be cleared. |
| 1 FDBG | Force the debug mode core output signal (to the on-chip peripherals). The debug mode output is logically defined as: Debug mode output = CSR[FDBG] (CSR[DBGH] and Core is halted) Debug mode output is not forced asserted. Debug mode output core output signal is asserted. |
| 0 DBGH | Disable debug signal assertion during core halt. The debug mode output (to the on-chip peripherals) is logically defined as: Debug mode output = CSR[FDBG] (CSR[DBGH] and Core is halted) Debug mode output is asserted when the core is halted. Debug mode output is not asserted when the core is halted. |

33.3.3 BDM Address Attribute Register (BAAR)

The BAAR register defines the address space for memory-referencing BDM commands. BAAR[R, SZ] are loaded directly from the BDM command, while the low-order 5 bits can be programmed from the external development system. To maintain compatibility with revision A, BAAR is loaded any time the AATR is written. The BAAR is initialized to a value of 0x05, setting supervisor data as the default address space.

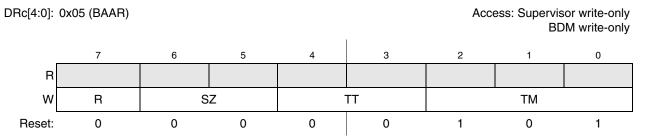


Figure 33-3. BDM Address Attribute Register (BAAR)

Table 33-6. BAAR Field Descriptions

| Field | Description |
|-----------|--|
| 7 R | Read/Write. 0 Write 1 Read |
| 6–5 SZ | Size. 00 Longword 01 Byte 10 Word 11 Reserved |
| 4–3 TT | Transfer Type. See the TT definition in the AATR description, Section 33.3.4, "Address Attribute Trigger Register (AATR)". |
| 2-0 TM | Transfer Modifier. See the TM definition in the AATR description, Section 33.3.4, "Address Attribute Trigger Register (AATR)". |

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33.3.4 Address Attribute Trigger Register (AATR)

The AATR defines address attributes and a mask to be matched in the trigger. The register value is compared with address attribute signals from the processor's local high-speed bus, as defined by the setting of the trigger definition register (TDR). AATR is accessible in supervisor mode as debug control register 0x06 using the WDEBUG instruction and through the BDM port using the WDMREG command.

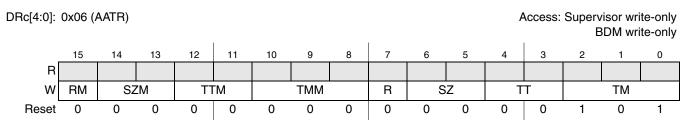


Figure 33-4. Address Attribute Trigger Register (AATR)

Table 33-7. AATR Field Descriptions

| Field | Description |
|--------------|---|
| 15 RM | Read/write Mask. Setting RM masks R in address comparisons. |
| 14–13 SZM | Size Mask. Setting an SZM bit masks the corresponding SZ bit in address comparisons. |
| 12–11 TTM | Transfer Type Mask. Setting a TTM bit masks the corresponding TT bit in address comparisons. |
| 10–8 TMM | Transfer Modifier Mask. Setting a TMM bit masks the corresponding TM bit in address comparisons. |
| 7 R | Read/Write. R is compared with the R/W signal of the processor's local bus. |
| 6–5 SZ | Size. Compared to the processor's local bus size signals. 00 Longword 01 Byte 10 Word 11 Reserved |

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Table 33-7. AATR Field Descriptions (continued)

| Field | Description | | | | | | |
|-----------|--|---------------|--|----------------------|---|--|--|
| 4–3 TT | Transfer Type. Compared with the local bus transfer type signals. 00 Normal processor access 01 Reserved 10 Emulator mode access 11 Acknowledge/CPU space access These bits also define the TT encoding for BDM memory commands. In this case, the 01 encoding indicates an external or DMA access (for backward compatibility). These bits affect the TM bits. | | | | | | |
| 2-0 TM | | transfer type | mpared with the local bus tra e. These bits also define the | • | • | | |
| | TM TT=00 TT=10 (acknowledge/C space transfer | | | | | | |
| | | 000 | Reserved | Reserved | CPU space access | | |
| | 001 User data access Reserved Interrupt ack level 1 | | | | | | |
| | 010 User code access Reserved Interrupt ack level 2 | | | | | | |
| | | | 011 Reserved Reserved Interrupt ack level 3 | | | | |
| | | 011 | Reserved | Reserved | Interrupt ack level 3 | | |
| | | 011 100 | Reserved Reserved | Reserved Reserved | Interrupt ack level 3 Interrupt ack level 4 | | |
| | | | | | • | | |
| | | 100 | Reserved | Reserved | Interrupt ack level 4 | | |

33.3.5 Trigger Definition Register (TDR)

The TDR configures the operation of the hardware breakpoint logic corresponding with the ABHR/ABLR/AATR, PBR/PBR1/PBR2/PBR3/PBMR, and DBR/DBMR registers within the debug module. TDR controls the actions taken under the defined conditions. Breakpoint logic may be configured as a one- or two-level trigger. TDR[31–16] bits define second-level trigger, and bits 15–0 define first-level trigger.

NOTE

The debug module has no hardware interlocks to prevent spurious breakpoint triggers while the breakpoint registers are being loaded. Disable TDR (by clearing TDR[29,13]) before defining triggers.

A write to TDR clears the CSR trigger status bits, CSR[BSTAT]. TDR is accessible in supervisor mode as debug control register 0x07 using the WDEBUG instruction and through the BDM port using the WDMREG command

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DRc[4:0]: 0x07 (TDR)

Access: Supervisor write-only
BDM write-only

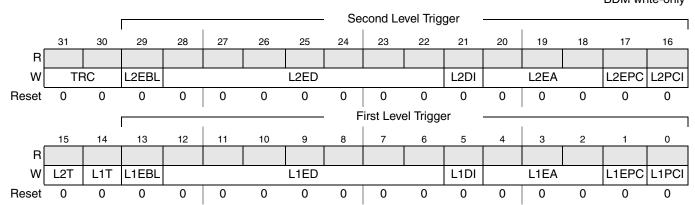


Figure 33-5. Trigger Definition Register (TDR)

Table 33-8. TDR Field Descriptions

| Field | | Description | | | |
|---------------|---|-------------|--|----------------------|--|
| 31–30 TRC | Trigger Response Control. Determines how the processor responds to a completed trigger condition. The trigger response is always displayed on DDATA. 00 Display on DDATA only 01 Processor halt 10 Debug interrupt 11 Reserved | | | | |
| 29 L2EBL | Enable Level 2 Breakpoint. Global enable for the breakpoint trigger. 0 Disables all level 2 breakpoints 1 Enables all level 2 breakpoint triggers | | | | |
| 28–22 L2ED | Enable Level 2 Data Breakpoint. Setting an L2ED bit enables the corresponding data breakpoint condition based on the size and placement on the processor's local data bus. Clearing all ED bits disables data breakpoints. | | | | |
| | | TDR Bit | Description | | |
| | | 28 | Data longword. Entire processor's local data bus. | | |
| | | 27 | Lower data word. | | |
| | | 26 | Upper data word. | | |
| | | 25 | Lower lower data byte. Low-order byte of the low-order word. | | |
| | | 24 | Lower middle data byte. High-order byte of the low-order word. | | |
| | | 23 | Upper middle data byte. Low-order byte of the high-order word. | | |
| | | 22 | Upper upper data byte. High-order byte of the high-order word. | | |
| 21 L2DI | • | occurren | t. Inverts the logical sense of all the data breakpoint comparators ce of a data value other than the DBR contents. parators. | . This can develop a | |

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Table 33-8. TDR Field Descriptions (continued)

| Field | | | Description | |
|---------------|--|-----------|--|-----------|
| 20–18 L2EA | Enable Level 2 Address Breakpoint. Setting an L2EA bit enables the corresponding address breakpoint. Clearing all three bits disables the breakpoint. | | | |
| | | TDR Bit | Description | |
| | | 20 | Address breakpoint inverted. Breakpoint is based outside the range between ABLR and ABHR. | |
| | | 19 | Address breakpoint range. The breakpoint is based on the inclusive range defined by ABLR and ABHR. | |
| | | 18 | Address breakpoint low. The breakpoint is based on the address in the ABLR. | |
| 17 L2EPC | Enable Level 2 PC Breakpoint. 0 Disable PC breakpoint 1 Enable PC breakpoint where the trigger is defined by the logical summation of: | | | |
| | | | (PBR0 and PBMR) PBR1 PBR2 PBR3 | Eqn. 33-1 |
| 16 L2PCI | Level 2 PC Breakpoint Invert. The PC breakpoint is defined within the region defined by PBRn and PBMR. The PC breakpoint is defined outside the region defined by PBRn and PBMR. | | | |
| 15 L2T | Level 2 Trigger. Determines the logic operation for the trigger between the PC_condition and the (Address_range & Data_condition) where the inclusion of a Data_condition is optional. The ColdFire debug architecture supports the creation of single or double-level triggers. 0 Level 2 trigger = PC_condition & Address_range & Data_condition 1 Level 2 trigger = PC_condition (Address_range & Data_condition) Note: Debug Rev A only had the AND condition available for the triggers. | | | |
| 14 L1T | Level 1 Trigger. Determines the logic operation for the trigger between the PC_condition and the (Address_range & Data_condition) where the inclusion of a Data_condition is optional. The ColdFire debug architecture supports the creation of single or double-level triggers. 0 Level 1 trigger = PC_condition & Address_range & Data_condition 1 Level 1 trigger = PC_condition (Address_range & Data_condition) Note: Debug Rev A only had the AND condition available for the triggers. | | | |
| 13 L1EBL | Enable Level 1 Brea 0 Disables all level 1 Enables all level | 1 breakpo | | |

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Table 33-8. TDR Field Descriptions (continued)

| Field | Description | | | |
|--------------|--|---------|---|---------------------|
| 12–6 L1ED | Enable Level 1 Data Breakpoint. Setting an L1ED bit enables the corresponding data breakpoint condition based on the size and placement on the processor's local data bus. Clearing all L1ED bits disables data breakpoints. | | | |
| | | TDR Bit | Description | |
| | | 12 | Data longword. Entire processor's local data bus. | |
| | | 11 | Lower data word. | |
| | | 10 | Upper data word. | |
| | | 9 | Lower lower data byte. Low-order byte of the low-order word. | |
| | | 8 | Lower middle data byte. High-order byte of the low-order word. | |
| | | 7 | Upper middle data byte. Low-order byte of the high-order word. | |
| | | 6 | Upper upper data byte. High-order byte of the high-order word. | |
| 4–2 L1EA | Enable Level 1 Addrethree bits disables the | | point. Setting an L1EA bit enables the corresponding address bre s breakpoint. | akpoint. Clearing a |
| | | TDR Bit | Description | |
| | | 4 | Enable address breakpoint inverted. Breakpoint is based outside the range between ABLR and ABHR. | |
| | | 3 | Enable address breakpoint range. The breakpoint is based on the inclusive range defined by ABLR and ABHR. | |
| | | 2 | Enable address breakpoint low. The breakpoint is based on the | |
| | | | address in the ABLR. | |
| 1 L1EPC | Enable Level 1 PC b 0 Disable PC break 1 Enable PC break | point | address in the ABLR. | |

33.3.6 Program Counter Breakpoint/Mask Registers (PBR0-3, PBMR)

The PBR*n* registers define an instruction address for use as part of the trigger. These registers' contents are compared with the processor's program counter register when the appropriate valid bit is set (for PBR1–3) and TDR is configured appropriately. PBR0 bits are masked by setting corresponding PBMR bits (PBMR has no effect on PBR1–3). Results are compared with the processor's program counter register, as defined in TDR. Breakpoint registers, PBR1–3, have no masking associated with them. The

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contents of the breakpoint registers are compared with the processor's program counter register when TDR is configured appropriately.

The PC breakpoint registers are accessible in supervisor mode using the WDEBUG instruction and through the BDM port using the WDMREG command using values shown in Section 33.4.1.5, "BDM Command Set".

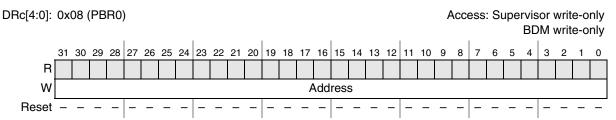


Figure 33-6. PC Breakpoint Register (PBR0)

Table 33-9. PBR0 Field Descriptions

| Field | Description |
|-------|---|
| | PC Breakpoint Address. The address to be compared with the PC as a breakpoint trigger. Note: PBR0[0] should always be loaded with a 0. |

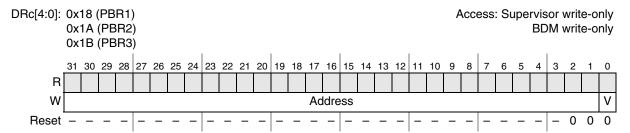


Figure 33-7. PC Breakpoint Register n (PBRn)

Table 33-10. PBRn Field Descriptions

| Field | Description | | | | |
|-----------------|--|--|--|--|--|
| 31–1 Address | PC Breakpoint Address. The 31-bit address to be compared with the PC as a breakpoint trigger. | | | | |
| 0 V | Valid Bit. This bit must be set for the PC breakpoint to occur at the address specified in the Address field. 0 PBR is disabled. 1 PBR is enabled. | | | | |

Figure 33-8 shows PBMR. PBMR is accessible in supervisor mode using the WDEBUG instruction and via the BDM port using the WDMREG command. PBMR only masks PBR0.

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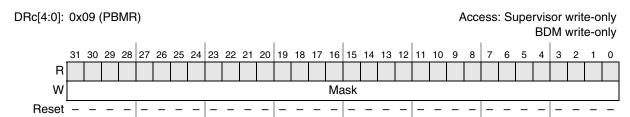


Figure 33-8. PC Breakpoint Mask Register (PBMR)

Table 33-11. PBMR Field Descriptions

| Field | Description |
|-------|--|
| | PC Breakpoint Mask. 0 The corresponding PBR0 bit is compared to the appropriate PC bit. 1 The corresponding PBR0 bit is ignored. |

33.3.7 Address Breakpoint Registers (ABLR, ABHR)

The ABLR and ABHR define regions in the processor's data address space that can act as part of the trigger. These register values are compared with the address for each transfer on the processor's high-speed local bus. The trigger definition register (TDR) identifies the trigger as one of three cases:

- Identically the value in ABLR
- Inside the range bound by ABLR and ABHR inclusive
- Outside that same range

ABLR and ABHR are accessible in supervisor mode using the WDEBUG instruction and via the BDM port using the WDMREG command.

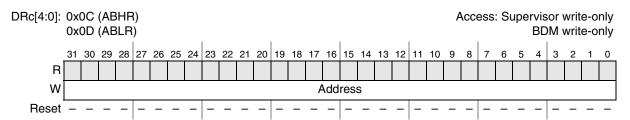


Figure 33-9. Address Breakpoint Registers (ABLR, ABHR,)

Table 33-12. ABLR Field Description

| Field | Description |
|-------|--|
| | Low Address. Holds the 32-bit address marking the lower bound of the address breakpoint range. Breakpoints for specific single addresses are programmed into ABLR. |

Table 33-13. ABHR Field Description

| Field | Description |
|-----------------|---|
| 31–0 Address | High Address. Holds the 32-bit address marking the upper bound of the address breakpoint range. |

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Data Breakpoint and Mask Registers (DBR, DBMR) 33.3.8

The data breakpoint register (DBR), specify data patterns used as part of the trigger into debug mode. DBR bits are masked by setting corresponding DBMR bits, as defined in TDR.

DBR and DBMR are accessible in supervisor mode using the WDEBUG instruction and through the BDM port using the WDMREG command.

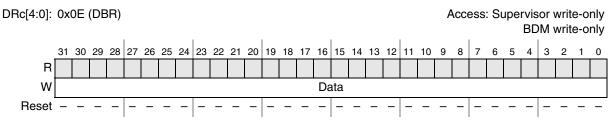


Figure 33-10. Data Breakpoint Registers (DBR)

Table 33-14. DBR Field Descriptions

| Field | Description |
|--------------|--|
| 31–0 Data | Data Breakpoint Value. Contains the value to be compared with the data value from the processor's local bus as a breakpoint trigger. |

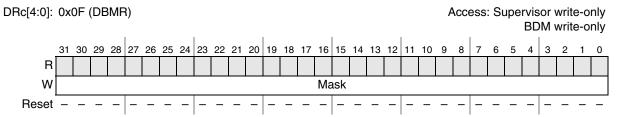


Figure 33-11. Data Breakpoint Mask Registers (DBMR)

Table 33-15. DBMR Field Descriptions

| Field | Description | | | | |
|--------------|--|--|--|--|--|
| 31–0 Mask | Data Breakpoint Mask. The 32-bit mask for the data breakpoint trigger. Clearing a DBMR bit allows the corresponding DBR bit to be compared to the appropriate bit of the processor's local data bus. Setting a DBMR bit causes that bit to be ignored. | | | | |

The DBR supports aligned and misaligned references. Table 33-16 shows relationships between processor address, access size, and location within the 32-bit data bus.

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| Address[1:0] | Access Size | Operand Location | |
|--------------|-------------|------------------|--|
| 00 | Byte | D[31:24] | |
| 01 | Byte | D[23:16] | |
| 10 | Byte | D[15:8] | |
| 11 | Byte | D[7:0] | |
| 0x | Word | D[31:16] | |
| 1x | Word | D[15:0] | |
| xx | Longword | D[31:0] | |

Table 33-16. Address, Access Size, and Operand Data Location

33.4 Functional Description

33.4.1 Background Debug Mode (BDM)

The ColdFire family implements a low-level system debugger in the microprocessor in a dedicated hardware module. Communication with the development system is managed through a dedicated, high-speed serial command interface. Although some BDM operations, such as CPU register accesses, require the CPU to be halted, other BDM commands, such as memory accesses, can be executed while the processor is running.

BDM is useful because:

- In-circuit emulation is not needed, so physical and electrical characteristics of the system are not affected.
- BDM is always available for debugging the system and provides a communication link for upgrading firmware in existing systems.
- Provides high-speed cache downloading (500 Kbytes/sec), especially useful for flash programming
- Provides absolute control of the processor, and thus the system. This allows quick hardware debugging with the same tool set used for firmware development.

33.4.1.1 CPU Halt

Although most BDM operations can occur in parallel with CPU operations, unrestricted BDM operation requires the CPU to be halted. The sources that can cause the CPU to halt are listed below in order of priority:

- 1. A catastrophic fault-on-fault condition automatically halts the processor.
- 2. A hardware breakpoint trigger can generate a pending halt condition similar to the assertion of BKPT. This type of halt is always first marked as pending in the processor, which samples for pending halt and interrupt conditions once per instruction. When a pending condition is asserted, the processor halts execution at the next sample point. See Section 33.4.2.1, "Theory of Operation".

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- 3. The execution of a HALT instruction immediately suspends execution. Attempting to execute HALT in user mode while CSR[UHE] is cleared generates a privilege violation exception. If CSR[UHE] is set, HALT can be executed in user mode. After HALT executes, the processor can be restarted by serial shifting a GO command into the debug module. Execution continues at the instruction after HALT.
- 4. The assertion of the BKPT input is treated as a pseudo-interrupt; asserting BKPT creates a pending halt postponed until the processor core samples for halts/interrupts. The processor samples for these conditions once during the execution of each instruction; if a pending halt is detected, the processor suspends execution and enters the halted state.

The are two special cases involving the assertion of \overline{BKPT} :

- After the system reset signal is negated, the processor waits for 16 processor clock cycles before beginning reset exception processing. If the BKPT input is asserted within eight cycles after RESET is negated, the processor enters the halt state, signaling halt status (0xF) on the PST outputs. While the processor is in this state, all resources accessible through the debug module can be referenced. This is the only chance to force the processor into emulation mode through CSR[EMU].
- After system initialization, the processor's response to the GO command depends on the set of BDM commands performed while it is halted for a breakpoint. Specifically, if the PC register was loaded, the GO command causes the processor to exit halted state and pass control to the instruction address in the PC, bypassing normal reset exception processing. If the PC was not loaded, the GO command causes the processor to exit halted state and continue reset exception processing.
- The ColdFire architecture also manages a special case of BKPT asserted while the processor is stopped by execution of the STOP instruction. For this case, the processor exits the stopped mode and enters the halted state, at which point all BDM commands may be exercised. When restarted, the processor continues by executing the next sequential instruction, which follows the STOP opcode.

The CSR[27–24] bits indicate the halt source, showing the highest priority source for multiple halt conditions.

33.4.1.2 BDM Serial Interface

When the CPU is halted and PST reflects the halt status, the development system can send unrestricted commands to the debug module. The debug module implements a synchronous serial protocol using two inputs (DSCLK and DSI) and one output (DSO), where DSO is specified as a delay relative to the rising edge of the processor clock. See Table 33-2. The development system serves as the serial communication channel master and must generate DSCLK.

The serial channel operates at a frequency from DC to 1/5 of the PSTCLK frequency. The channel uses full-duplex mode, where data is sent and received simultaneously by master and slave devices. The transmission consists of 17-bit packets composed of a status/control bit and a 16-bit data word. As shown in Figure 33-12, all state transitions are enabled on a rising edge of the PSTCLK clock when DSCLK is high; DSI is sampled and DSO is driven.

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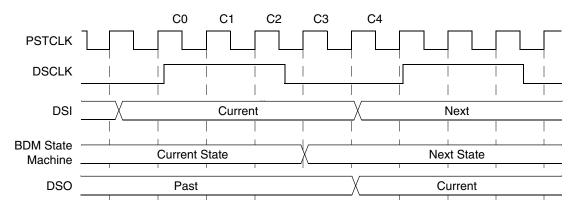


Figure 33-12. Maximum BDM Serial Interface Timing

DSCLK and DSI are synchronized inputs. DSCLK acts as a pseudo clock enable and is sampled, along with DSI, on the rising edge of PSTCLK. DSO is delayed from the DSCLK-enabled PSTCLK rising edge (registered after a BDM state machine state change). All events in the debug module's serial state machine are based on the PSTCLK rising edge. DSCLK must also be sampled low (on a positive edge of PSTCLK) between each bit exchange. The msb is sent first. Because DSO changes state based on an internally recognized rising edge of DSCLK, DSO cannot be used to indicate the start of a serial transfer. The development system must count clock cycles in a given transfer. C0–C4 are described as:

- C0: Set the state of the DSI bit
- C1: First synchronization cycle for DSI (DSCLK is high)
- C2: Second synchronization cycle for DSI (DSCLK is high)
- C3: BDM state machine changes state depending upon DSI and whether the entire input data transfer has been transmitted
- C4: DSO changes to next value

NOTE

A not-ready response can be ignored except during a memory-referencing cycle. Otherwise, the debug module can accept a new serial transfer after 32 processor clock periods.

33.4.1.3 Receive Packet Format

The basic receive packet consists of 16 data bits and 1 status bit

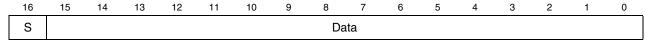


Figure 33-13. Receive BDM Packet

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Table 33-17. Receive BDM Packet Field Description

| Field | Description | | | | |
|--------------|---|------|--|--|--|
| 16 S | Status. Indicates the status of CPU-generated messages listed below. The not-ready response can be ignored unless a memory-referencing cycle is in progress. Otherwise, the debug module can accept a new serial transfer after 32 processor clock periods. | | | | |
| | s | Data | Message | | |
| | 0 | xxxx | Valid data transfer | | |
| | 0 | FFFF | Status OK | | |
| | 1 | 0000 | Not ready with response; come again | | |
| | 1 | 0001 | Error-Terminated bus cycle; data invalid | | |
| | 1 | FFFF | Illegal Command | | |
| | | | | | |
| 15–0 Data | Data. Contains the message to be sent from the debug module to the development system. The response message is always a single word, with the data field encoded as shown above. | | | | |

33.4.1.3.1 Transmit Packet Format

The basic transmit packet consists of 16 data bits and 1 reserved bit.

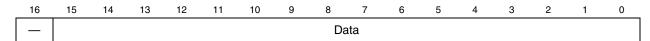


Figure 33-14. Transmit BDM Packet

Table 33-18. Transmit BDM Packet Field Description

| Field | Description |
|--------------|---|
| 16 | Reserved, must be cleared. |
| 15–0 Data | Data bits 15–0. Contains the data to be sent from the development system to the debug module. |

33.4.1.3.2 BDM Command Format

All ColdFire family BDM commands include a 16-bit operation word followed by an optional set of one or more extension words.

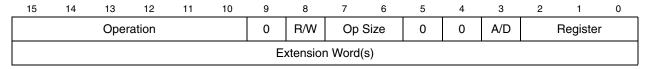


Figure 33-15. BDM Command Format

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Table 33-19. BDM Field Descriptions

| Field | Description | | | | |
|--------------------|---|----|--------------|------------|---|
| 15–10 Operation | Specifies the command. These values are listed in Table 33-20. | | | | |
| 9 | Reserved, must be cleared. | | | | |
| 8 R/W | Direction of operand transfer. 0 Data is written to the CPU or to memory from the development system. 1 The transfer is from the CPU to the development system. | | | | |
| 7–6 Op Size | | | | | |
| | | | Operand Size | Bit Values | |
| | | 00 | Byte | 8 bits | |
| | | 01 | Word | 16 bits | - |
| | | 10 | Longword | 32 bits | |
| | | 11 | Reserved | _ |] |
| 5–4 | Reserved, must be cleared. | | | | |
| 3 A/D | Address/Data. Determines whether the register field specifies a data or address register. 0 Data register. 1 Address register. | | | | |
| 2–0 Register | Contains the register number in commands that operate on processor registers. See Table 33-21. | | | | |

33.4.1.3.3 **Extension Words as Required**

Some commands require extension words for addresses and/or immediate data. Addresses require two extension words because only absolute long addressing is permitted. Longword accesses are forcibly longword-aligned and word accesses are forcibly word-aligned. Immediate data can be 1 or 2 words long. Byte and word data each requires a single extension word, while longword data requires two extension words.

Operands and addresses are transferred most-significant word first. In the following descriptions of the BDM command set, the optional set of extension words is defined as address, data, or operand data.

33.4.1.4 **Command Sequence Diagrams**

The command sequence diagram in Figure 33-16 shows serial bus traffic for commands. Each bubble represents a 17-bit bus transfer. The top half of each bubble indicates the data the development system sends to the debug module; the bottom half indicates the debug module's response to the previous development system commands. Command and result transactions overlap to minimize latency.

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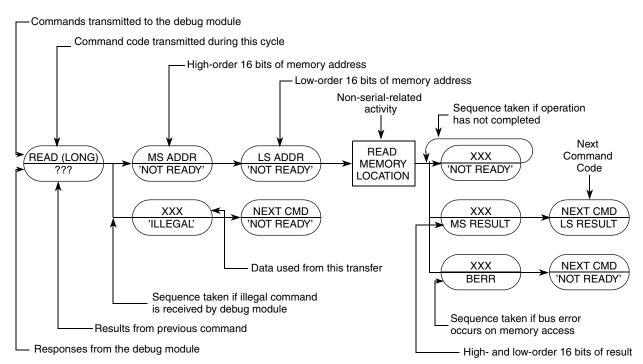


Figure 33-16. Command Sequence Diagram

The sequence is as follows:

- In cycle 1, the development system command is issued (READ in this example). The debug module responds with the low-order results of the previous command or a command complete status of the previous command, if no results are required.
- In cycle 2, the development system supplies the high-order 16 address bits. The debug module returns a not-ready response unless the received command is decoded as unimplemented, which is indicated by the illegal command encoding. If this occurs, the development system should retransmit the command.

NOTE

A not-ready response can be ignored except during a memory-referencing cycle. Otherwise, the debug module can accept a new serial transfer after 32 processor clock periods.

- In cycle 3, the development system supplies the low-order 16 address bits. The debug module always returns a not-ready response.
- At the completion of cycle 3, the debug module initiates a memory read operation. Any serial transfers that begin during a memory access return a not-ready response.
- Results are returned in the two serial transfer cycles after the memory access completes. For any command performing a byte-sized memory read operation, the upper 8 bits of the response data are undefined and the referenced data is returned in the lower 8 bits. The next command's opcode is sent to the debug module during the final transfer. If a bus error terminates a memory or register access, error status (S = 1, DATA = 0x0001) returns instead of result data.

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33.4.1.5 BDM Command Set

Table 33-20 summarizes the BDM command set. Subsequent sections contain detailed descriptions of each command. Issuing a BDM command when the processor is accessing debug module registers using the WDEBUG instruction causes undefined behavior. See Table 33-21 for register address encodings.

Table 33-20. BDM Command Summary

| Command | Mnemonic | Description | CPU State ¹ | Section/Page | Command (Hex) |
|-----------------------------------|-----------------|---|---------------------------|-------------------|--|
| Read A/D register | RAREG/ RDREG | Read the selected address or data register and return the results through the serial interface. | Halted | 33.4.1.5.1/33-24 | 0x218 {A/D, Reg[2:0]} |
| Write A/D register | WAREG/ WDREG | Write the data operand to the specified address or data register. | Halted | 33.4.1.5.2/33-24 | 0x208 {A/D, Reg[2:0]} |
| Read memory location | READ | Read the data at the memory location specified by the longword address. | Steal | 33.4.1.5.3/33-25 | 0x1900—byte 0x1940—word 0x1980—lword |
| Write memory location | WRITE | Write the operand data to the memory location specified by the longword address. | Steal | 33.4.1.5.4/33-26 | 0x1800—byte 0x1840—word 0x1880—lword |
| Dump memory block | DUMP | Used with READ to dump large blocks of memory. An initial READ executes to set up the starting address of the block and to retrieve the first result. A DUMP command retrieves subsequent operands. | Steal | 33.4.1.5.5/33-28 | 0x1D00—byte 0x1D40—word 0x1D80—lword |
| Fill memory block | FILL | Used with WRITE to fill large blocks of memory. An initial WRITE executes to set up the starting address of the block and to supply the first operand. A FILL command writes subsequent operands. | Steal | 33.4.1.5.6/33-30 | 0x1C00—byte 0x1C40—word 0x1C80—lword |
| Resume execution | GO | The pipeline is flushed and refilled before resuming instruction execution at the current PC. | Halted | 33.4.1.5.7/33-31 | 0x0C00 |
| No operation | NOP | Perform no operation; may be used as a null command. | Parallel | 33.4.1.5.8/33-32 | 0x0000 |
| Output the current PC | SYNC_PC | Capture the current PC and display it on the PST/DDATA outputs. | Parallel | 33.4.1.5.9/33-32 | 0x0001 |
| Read control register | RCREG | Read the system control register. | Halted | 33.4.1.5.10/33-33 | 0x2980 |
| Write control register | WCREG | Write the operand data to the system control register. | Halted | 33.4.1.5.13/33-35 | 0x2880 |
| Read debug module register | RDMREG | Read the debug module register. | Parallel | 33.4.1.5.14/33-36 | 0x2D {0x4 ² DRc[4:0]} |
| Write debug module register | WDMREG | Write the operand data to the debug module register. | Parallel | 33.4.1.5.15/33-37 | 0x2C {0x4 ² DRc[4:0]} |

General command effect and/or requirements on CPU operation:

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⁻ Halted: The CPU must be halted to perform this command.

⁻ Steal: Command generates bus cycles that can be interleaved with bus accesses.

⁻ Parallel: Command is executed in parallel with CPU activity.



Freescale reserves unassigned command opcodes. All unused command formats within any revision level perform a NOP and return the illegal command response.

The following sections describe the commands summarized in Table 33-20.

NOTE

The BDM status bit (S) is 0 for normally completed commands. S is set for illegal commands, not-ready responses, and transfers with bus-errors. Section 33.4.1.2, "BDM Serial Interface," describes the receive packet format.

33.4.1.5.1 Read A/D Register (RAREG/RDREG)

Read the selected address or data register and return the 32-bit result. A bus error response is returned if the CPU core is not halted.

Command/Result Formats:

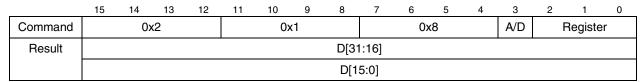


Figure 33-17. RAREG/RDREG Command Format

Command Sequence:

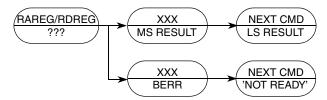


Figure 33-18. RAREG/RDREG Command Sequence

Operand Data: None

Result Data: The contents of the selected register are returned as a longword value,

most-significant word first.

33.4.1.5.2 Write A/D Register (WAREG/WDREG)

The operand longword data is written to the specified address or data register. A write alters all 32 register bits. A bus error response is returned if the CPU core is not halted.

Command Format:

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² 0x4 is a three-bit field.



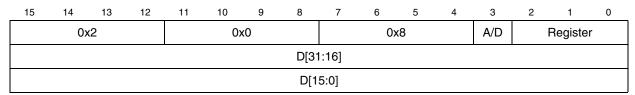


Figure 33-19. WAREG/WDREG Command Format

Command Sequence:

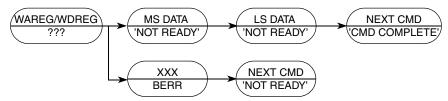


Figure 33-20. WAREG/WDREG Command Sequence

Operand Data: Longword data is written into the specified address or data register. The data is

supplied most-significant word first.

Result Data: Command complete status is indicated by returning 0xFFFF (with S cleared)

when the register write is complete.

33.4.1.5.3 Read Memory Location (READ)

Read data at the longword address. Address space is defined by BAAR[TT,TM]. Hardware forces low-order address bits to 0s for word and longword accesses to ensure that word addresses are word-aligned and longword addresses are longword-aligned.

Command/Result Formats:

| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
|----------|---------|----|----|----------------------|----|----------|----------|------------|------|-------|----|---------------|------|-----|----|----|---|--|--|
| Byte | | | 0) | k 1 | | | 0> | (9 | | | 0) | (0 | | | 0: | x0 | | | |
| | Command | | | | | | A[31:16] | | | | | | | | | | | | |
| | | | | | | | | | A[1 | 5:0] | | | | | | | | | |
| | Result | Х | Х | X X X X X X X D[7:0] | | | | | | | | | 7:0] | :0] | | | | | |
| Word | Command | | 0) | k1 | | | 0) | (9 | | | 0: | < 4 | | | 0: | x0 | | | |
| | | | | | | A[31:16] | | | | | | | | | | | | | |
| | | | | A[15:0] | | | | | | | | | | | | | | | |
| | Result | | | | | | | | D[1 | 5:0] | | | | | | | | | |
| Longword | Command | | 0) | k 1 | | | 0> | (9 | | | 0) | κ8 | | | 0: | x0 | | | |
| | | | | | | | | | A[31 | 1:16] | | | | | | | | | |
| | | | | | | | | | A[1 | 5:0] | | | | | | | | | |
| | Result | | | | • | D[31:16] | | | | | | | | | | | | | |
| | | | | | | | | | D[1 | 5:0] | | | | | | | | | |

Figure 33-21. READ Command/Result Formats

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Command Sequence:

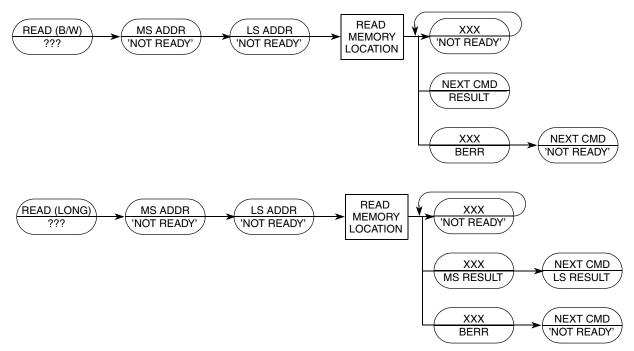


Figure 33-22. READ Command Sequence

Operand Data: The only operand is the longword address of the requested location.

Result Data: Word results return 16 bits of data; longword results return 32. Bytes are returned

in the LSB of a word result; the upper byte is undefined. 0x0001 (S = 1) is returned

if a bus error occurs.

33.4.1.5.4 Write Memory Location (WRITE)

Write data to the memory location specified by the longword address. BAAR[TT,TM] defines address space. Hardware forces low-order address bits to 0s for word and longword accesses to ensure that word addresses are word-aligned and longword addresses are longword-aligned.



Command Formats:

| | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----------|----|----------|----|----|----|----|----|------|-------|----|----|---|---|----|------------|---|
| Byte | | 0: | x1 | | | 0: | x8 | | | 0: | x0 | | | 0: | k 0 | |
| | | | | | | | | A[31 | 1:16] | | | | | | | |
| | | | | | | | | A[1 | 5:0] | | | | | | | |
| | Х | | | | | | | | | | | | | | | |
| Word | | 0: | x1 | | | 0: | x8 | | | 0: | x4 | | | 0 | k 0 | |
| | | A[31:16] | | | | | | | | | | | | | | |
| | | | | | | | | A[1 | 5:0] | | | | | | | |
| | | | | | | | | D[1 | 5:0] | | | | | | | |
| Longword | | 0: | x1 | | | 0: | x8 | | | 0: | x8 | | | 0: | κ 0 | |
| | | | | | | | | A[31 | 1:16] | | | | | | | |
| | | | | | | | | A[1 | 5:0] | | | | | | | |
| | | D[31:16] | | | | | | | | | | | | | | |
| | | D[15:0] | | | | | | | | | | | | | | |

Figure 33-23. WRITE Command Format



Command Sequence:

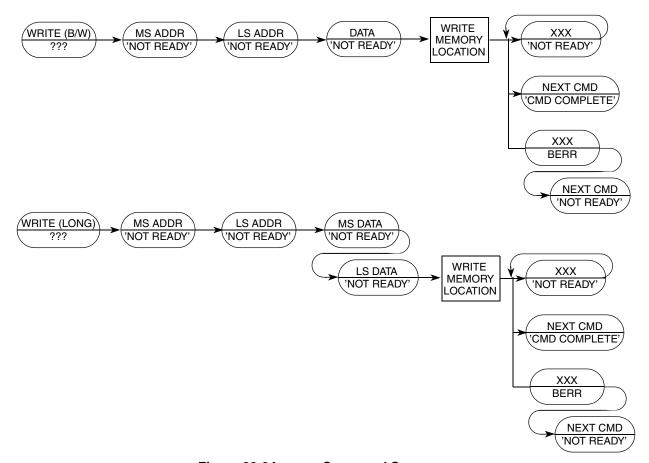


Figure 33-24. WRITE Command Sequence

Operand Data: This two-operand instruction requires a longword absolute address that specifies

a location the data operand is written. Byte data is sent as a 16-bit word, justified

in the LSB; 16- and 32-bit operands are sent as 16 and 32 bits, respectively.

Result Data: Command complete status is indicated by returning 0xFFFF (with S cleared)

when the register write is complete. A value of 0x0001 (with S set) is returned if

a bus error occurs.

33.4.1.5.5 Dump Memory Block (DUMP)

DUMP is used with the READ command to access large blocks of memory. An initial READ is executed to set up the starting address of the block and to retrieve the first result. If an initial READ is not executed before the first DUMP, an illegal command response is returned. The DUMP command retrieves subsequent operands. The initial address increments by the operand size (1, 2, or 4) and saves in a temporary register. Subsequent DUMP commands use this address, perform the memory read, increment it by the current operand size, and store the updated address in the temporary register.

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NOTE

DUMP does not check for a valid address; it is a valid command only when preceded by NOP, READ, or another DUMP command. Otherwise, an illegal command response is returned. NOP can be used for intercommand padding without corrupting the address pointer.

The size field is examined each time a DUMP command is processed, allowing the operand size to be dynamically altered.

Command/Result Formats:

| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----------|---------|----|----|----------|----|---------|----|----|------|-------|----|----|---|------|----|----|---|
| Byte | Command | | 0) | d | | | 0> | ďD | | | 0> | (Ο | | 0x0 | | | |
| | Result | Χ | Χ | Χ | Х | Х | Х | Х | Χ | | D[| | | 7:0] | | | |
| Word | Command | | 0) | d | | | 0> | (D | | | 0> | (4 | | | 0: | x0 | |
| | Result | | | | | | | | D[1 | 5:0] | | | | | | | |
| Longword | Command | | 0) | d | | | 0> | ďD | | | 0> | (8 | | 0x0 | | | |
| | Result | | l | | | | | | D[31 | 1:16] | | | | | | | |
| | | | | | | D[15:0] | | | | | | | | | | | |

Figure 33-25. DUMP Command/Result Formats

Command Sequence:

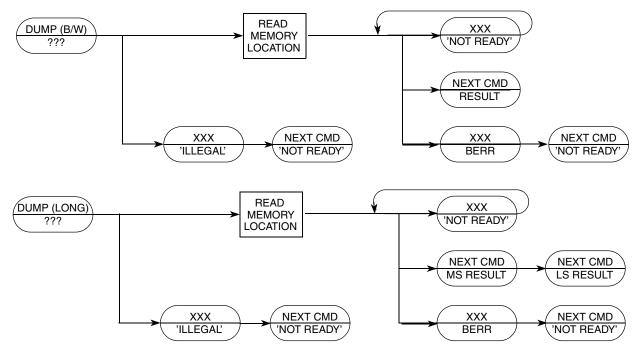


Figure 33-26. DUMP Command Sequence

Operand Data: None



Result Data: Requested data is returned as a word or longword. Byte data is returned in the

least-significant byte of a word result. Word results return 16 bits of significant data; longword results return 32 bits. A value of 0x0001 (with S set) is returned if

a bus error occurs.

33.4.1.5.6 Fill Memory Block (FILL)

A FILL command is used with the WRITE command to access large blocks of memory. An initial WRITE is executed to set up the starting address of the block and to supply the first operand. The FILL command writes subsequent operands. The initial address increments by the operand size (1, 2, or 4) and saves in a temporary register after the memory write. Subsequent FILL commands use this address, perform the write, increment it by the current operand size, and store the updated address in the temporary register.

If an initial WRITE is not executed preceding the first FILL command, the illegal command response is returned.

NOTE

The FILL command does not check for a valid address: FILL is a valid command only when preceded by another FILL, a NOP, or a WRITE command. Otherwise, an illegal command response is returned. The NOP command can be used for intercommand padding without corrupting the address pointer.

The size field is examined each time a FILL command is processed, allowing the operand size to be altered dynamically.

Command Formats:

| | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 4 3 2 1 | | | | | | |
|----------|---------|----------|------------|----|----|----|---|------|------|----|---------------|-----|---------|-----|----|--|--|--|--|
| Byte | | 0) | k 1 | | | 0x | C | | | 0> | (0 | | | 0x0 | | | | | |
| | Х | Χ | Х | Х | Х | Х | Х | Х | | | | D[7 | 7:0] | | | | | | |
| Word | | 0) | c 1 | | | 0x | C | | | 0> | < 4 | | | 0: | к0 | | | | |
| | | | | | | | | D[18 | 5:0] | | | | | | | | | | |
| Longword | | 0: | c 1 | | | 0x | C | | | 0) | κ8 | | | 0: | к0 | | | | |
| | | D[31:16] | | | | | | | | | | | | | | | | | |
| | D[15:0] | | | | | | | | | | | | | | | | | | |

Figure 33-27. FILL Command Format

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Command Sequence:

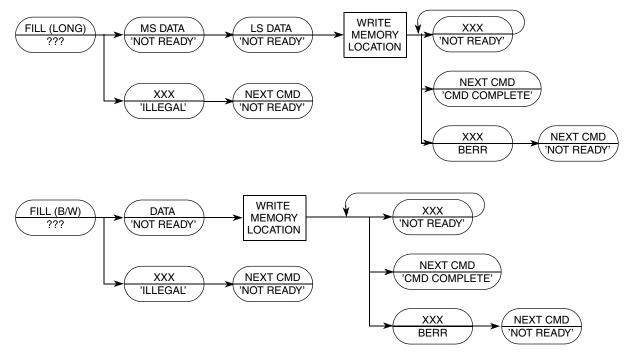


Figure 33-28. FILL Command Sequence

Operand Data: A single operand is data to be written to the memory location. Byte data is sent as

a 16-bit word, justified in the least-significant byte; 16- and 32-bit operands are

sent as 16 and 32 bits, respectively.

Result Data: Command complete status (0xFFFF) is returned when the register write is

complete. A value of 0x0001 (with S set) is returned if a bus error occurs.

33.4.1.5.7 Resume Execution (GO)

The pipeline is flushed and refilled before normal instruction execution resumes. Prefetching begins at the current address in the PC and at the current privilege level. If any register (such as the PC or SR) is altered by a BDM command while the processor is halted, the updated value is used when prefetching resumes. If a GO command issues and the CPU is not halted, the command is ignored.

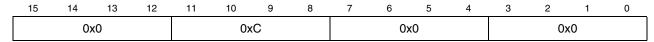


Figure 33-29. GO Command Format

Command Sequence:

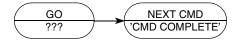


Figure 33-30. Go Command Sequence

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Operand Data: None

Result Data: The command-complete response (0xFFFF) is returned during the next shift

operation.

33.4.1.5.8 No Operation (NOP)

NOP performs no operation and may be used as a null command where required.

Command Formats:

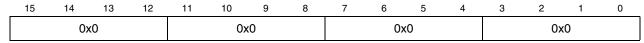


Figure 33-31. NOP Command Format

Command Sequence:

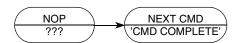


Figure 33-32. NOP Command Sequence

Operand Data: None

Result Data: The command-complete response, 0xFFFF (with S cleared), is returned during the

next shift operation.

33.4.1.5.9 Synchronize PC to the PST/DDATA Lines (SYNC_PC)

The SYNC_PC command captures the current PC and displays it on the PST/DDATA outputs. After the debug module receives the command, it sends a signal to the ColdFire processor that the current PC must be displayed. The processor then forces an instruction fetch at the next PC with the address being captured in the DDATA logic under control of the CSR[BTB] bits. The specific sequence of PST and DDATA values is defined below:

- 1. Debug signals a SYNC PC command is pending.
- 2. CPU completes the current instruction.
- 3. CPU forces an instruction fetch to the next PC, generates a PST equaling 0x5 value indicating a taken branch and signals the capture of DDATA.
- 4. The instruction address corresponding to the PC is captured.
- 5. The PST marker (0x9–0xB) is generated and displayed as defined by the CSR[BTB] bit followed by the captured PC address.

The SYNC_PC command can be used to dynamically access the PC for performance monitoring. The execution of this command is considerably less obtrusive to the real-time operation of an application than a HALT-CPU/READ-PC/RESUME command sequence.

Command Formats:





Figure 33-33. SYNC_PC Command Format

Command Sequence:

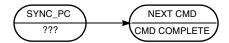


Figure 33-34. SYNC_PC Command Sequence

Operand Data: None

Result Data: Command complete status (0xFFFF) is returned when the register write is

complete.

33.4.1.5.10 Read Control Register (RCREG)

Read the selected control register and return the 32-bit result. Accesses to the processor/memory control registers are always 32 bits wide, regardless of register width. The second and third words of the command form a 32-bit address, which the debug module uses to generate a special bus cycle to access the specified control register. The 12-bit Rc field is the same the processor's MOVEC instruction uses.

Command/Result Formats:

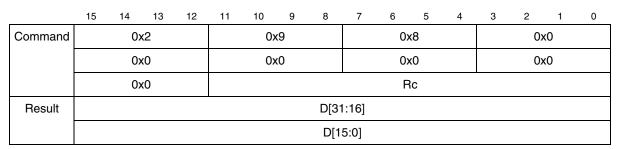


Figure 33-35. RCREG Command/Result Formats

Command Sequence:

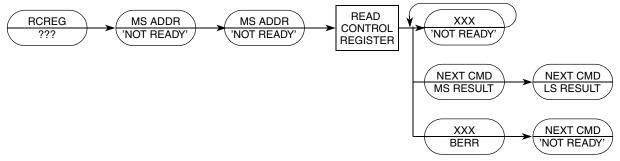


Figure 33-36. RCREG Command Sequence

Operand Data: The only operand is the 32-bit Rc control register select field.

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Result Data: Control register contents are returned as a longword, most-significant word first.

The implemented portion of registers smaller than 32 bits is guaranteed correct;

other bits are undefined.

Rc encoding: See Table 33-21.

Table 33-21. Control Register Map

| Rc | Register Definition |
|-----------------------|---|
| 0x009 | RGPIO Base Address Register (RGPIOBAR) ¹ |
| 0x(0,1)80 - 0x(0,1)87 | Data Registers 0–7 (0 = load, 1 = store) |
| 0x(0,1)88 - 0x(0,1)8F | Address Registers 0–7 (0 = load, 1 = store) (A7 is user stack pointer) |
| 0x800 | Other Stack Pointer (OTHER_A7) |
| 0x801 | Vector Base Register (VBR) |
| 0x804 | MAC Status Register (MACSR) |
| 0x805 | MAC Mask Register (MASK) |
| 0x806 | MAC Accumulator 0 (ACC0) |
| 0x807 | MAC Accumulator 0,1 Extension Bytes (ACCEXT01) |
| 0x808 | MAC Accumulator 2,3 Extension Bytes (ACCEXT23) |
| 0x809 | MAC Accumulator 1 (ACC1) |
| 0x80A | MAC Accumulator 2 (ACC2) |
| 0x80B | MAC Accumulator 3 (ACC3) |
| 0x80E | Status Register (SR) |
| 0x80F | Program Register (PC) |
| 0xC04 | Flash Base Address Register (FLASHBAR) |
| 0xC05 | RAM Base Address Register (RAMBAR) |

¹ If an RGPIO module is available on this device.

33.4.1.5.11 BDM Accesses of the Stack Pointer Registers (A7: SSP and USP)

The ColdFire core supports two unique stack pointer (A7) registers: the supervisor stack pointer (SSP) and the user stack pointer (USP). The hardware implementation of these two programmable-visible 32-bit registers does not uniquely identify one as the SSP and the other as the USP. Rather, the hardware uses one 32-bit register as the currently-active A7; the other is named the OTHER_A7. Therefore, the contents of the two hardware registers is a function of the operating mode of the processor:

The BDM programming model supports reads and writes to A7 and OTHER_A7 directly. It is the responsibility of the external development system to determine the mapping of A7 and OTHER_A7 to the two program-visible definitions (supervisor and user stack pointers), based on the SR[S] bit.

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33.4.1.5.12 BDM Accesses of the EMAC Registers

The presence of rounding logic in the output datapath of the EMAC requires special care for BDM-initiated reads and writes of its programming model. In particular, any result rounding modes must be disabled during the read/write process so the exact bit-wise EMAC register contents are accessed.

For example, a BDM read of an accumulator (ACCx) must be preceded by two commands accessing the MAC status register, as shown in the following sequence:

Likewise, to write an accumulator register, the following BDM sequence is needed:

Additionally, writes to the accumulator extension registers must be performed after the corresponding accumulators are updated because a write to any accumulator alters the corresponding extension register contents.

For more information on saving and restoring the complete EMAC programming model, see Section 4.3.1.2, "Saving and Restoring the EMAC Programming Model."

33.4.1.5.13 Write Control Register (WCREG)

The operand (longword) data is written to the specified control register. The write alters all 32 register bits. See the RCREG instruction description for the Rc encoding and for additional notes on writes to the A7 stack pointers and the EMAC programming model.

Command/Result Formats:

| | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
|---------|----|-----|----|----|----------|---------|----|---|---|----|----|---|-----|-----|---|---|--|--|
| Command | | 0x2 | | | | 0> | κ8 | | | 0: | x8 | | 0x0 | | | | | |
| | | 0x0 | | | | 0x0 0x0 | | | | | | | | 0x0 | | | | |
| | | 0x0 | | | | Rc | | | | | | | | | | | | |
| Result | | | | | D[31:16] | | | | | | | | | | | | | |
| | | | | | D[15:0] | | | | | | | | | | | | | |

Figure 33-37. WCREG Command/Result Formats

Command Sequence:

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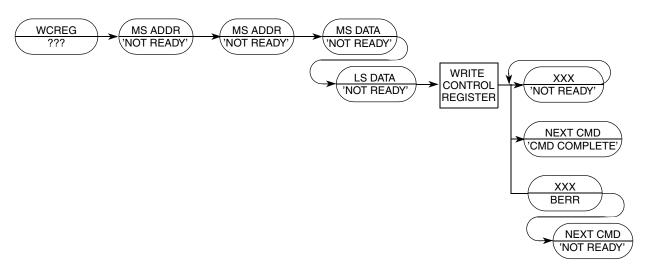


Figure 33-38. WCREG Command Sequence

Operand Data: This instruction requires two longword operands. The first selects the register to

the operand data writes to; the second contains the data.

Result Data: Successful write operations return 0xFFFF. Bus errors on the write cycle are

indicated by the setting of bit 16 in the status message and by a data pattern of

0x0001.

33.4.1.5.14 Read Debug Module Register (RDMREG)

Read the selected debug module register and return the 32-bit result. The only valid register selection for the RDMREG command is CSR (DRc=0x00).

Command/Result Formats:

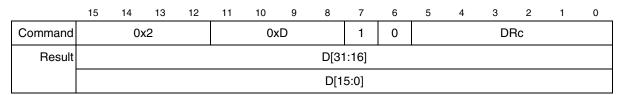


Figure 33-39. RDMREG Command/Result Formats

Table 33-22 shows the definition of DRc encoding.

Table 33-22. Definition of DRc Encoding—Read

| DRc[5:0] | Debug Register Definition | Mnemonic |
|----------|---------------------------|----------|
| 0x00 | Configuration/Status | CSR |

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Command Sequence:

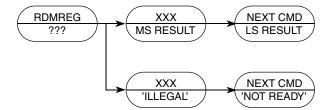


Figure 33-40. RDMREG Command Sequence

Operand Data: None

Result Data: The contents of the selected debug register are returned as a longword value. The

data is returned most-significant word first.

33.4.1.5.15 Write Debug Module Register (WDMREG)

The operand (longword) data is written to the specified debug module register. All 32 bits of the register are altered by the write. DSCLK must be inactive while the debug module register writes from the CPU accesses are performed using the WDEBUG instruction.

Command Format:

Figure 33-41. WDMREG BDM Command Format

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----|----|----|----|----|----------|---|---|---|---|---|---|----|----|---|---|
| | 0x | 2 | | | 0x | С | | 1 | 0 | | | DI | Rc | | |
| | | | | | D[31:16] | | | | | | | | | | |
| | | | | | D[15:0] | | | | | | | | | | |

Table 33-3 shows the definition of the DRc write encoding.

Command Sequence:

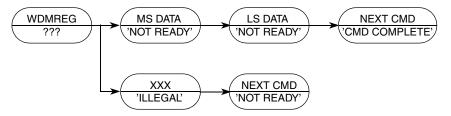


Figure 33-42. WDMREG Command Sequence

Operand Data: Longword data is written into the specified debug register. The data is supplied

most-significant word first.

Result Data: Command complete status (0xFFFF) is returned when register write is complete.

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33.4.2 Real-Time Debug Support

The ColdFire family provides support debugging real-time applications. For these types of embedded systems, the processor must continue to operate during debug. The foundation of this area of debug support is that while the processor cannot be halted to allow debugging, the system can generally tolerate the small intrusions of the BDM inserting instructions into the pipeline with minimal effect on real-time operation.

The debug module provides four types of breakpoints: PC with mask, PC without mask, operand address range, and data with mask. These breakpoints can be configured into one- or two-level triggers with the exact trigger response also programmable. The debug module programming model can be written from the external development system using the debug serial interface or from the processor's supervisor programming model using the WDEBUG instruction. Only CSR is readable using the external development system.

33.4.2.1 Theory of Operation

Breakpoint hardware can be configured through TDR[TCR] to respond to triggers by displaying DDATA, initiating a processor halt, or generating a debug interrupt. As shown in Table 33-23, when a breakpoint is triggered, an indication (CSR[BSTAT]) is provided on the DDATA output port when it is not displaying captured processor status, operands, or branch addresses.

| DDATA[3:0] ¹ | CSR[BSTAT] ¹ | Breakpoint Status |
|-------------------------|-------------------------|--------------------------------|
| 0000 | 0000 | No breakpoints enabled |
| 0010 | 0001 | Waiting for level-1 breakpoint |
| 0100 | 0010 | Level-1 breakpoint triggered |
| 1010 | 0101 | Waiting for level-2 breakpoint |
| 1100 | 0110 | Level-2 breakpoint triggered |

Table 33-23. DDATA[3:0]/CSR[BSTAT] Breakpoint Response

The breakpoint status is also posted in the CSR. CSR[BSTAT] is cleared by a CSR read when a level-2 breakpoint is triggered or a level-1 breakpoint is triggered and a level-2 breakpoint is not enabled. Status is also cleared by writing to either TDR to disable trigger options.

BDM instructions use the appropriate registers to load and configure breakpoints. As the system operates, a breakpoint trigger generates the response defined in TDR.

PC breakpoints are treated in a precise manner—exception recognition and processing are initiated before the excepting instruction executes. All other breakpoint events are recognized on the processor's local bus, but are made pending to the processor and sampled like other interrupt conditions. As a result, these interrupts are imprecise.

In systems that tolerate the processor being halted, a BDM-entry can be used. With TDR[TRC] equals 01, a breakpoint trigger causes the core to halt (PST = 0xF).

If the processor core cannot be halted, the debug interrupt can be used. With this configuration, TDR[TRC] equals 10, breakpoint trigger becomes a debug interrupt to the processor, which is treated

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¹ Encodings not shown are reserved for future use.



higher than the nonmaskable level-7 interrupt request. As with all interrupts, it is made pending until the processor reaches a sample point, which occurs once per instruction. Again, the hardware forces the PC breakpoint to occur before the targeted instruction executes and is precise. This is possible because the PC breakpoint is enabled when interrupt sampling occurs. For address and data breakpoints, reporting is considered imprecise, because several instructions may execute after the triggering address or data is detected.

As soon as the debug interrupt is recognized, the processor aborts execution and initiates exception processing. This event is signaled externally by the assertion of a unique PST value (PST = 0xD) for multiple cycles. The core enters emulator mode when exception processing begins. After the standard 8-byte exception stack is created, the processor fetches a unique exception vector, 12, from the vector table. Refer to the *ColdFire Programmer's Reference Manual*. for more information.

Execution continues at the instruction address in the vector corresponding to the debug interrupt. All interrupts are ignored while the processor is in emulator mode. The debug interrupt handler can use supervisor instructions to save the necessary context, such as the state of all program-visible registers into a reserved memory area.

When debug interrupt operations complete, the RTE instruction executes and the processor exits emulator mode. After the debug interrupt handler completes execution, the external development system can use BDM commands to read the reserved memory locations.

In revision B/B+, the hardware inhibits generation of another debug interrupt during the first instruction after the RTE exits emulator mode. This behavior is consistent with the logic involving trace mode where the first instruction executes before another trace exception is generated. Thus, all hardware breakpoints are disabled until the first instruction after the RTE completes execution, regardless of the programmed trigger response.

33.4.2.2 Emulator Mode

Emulator mode facilitates non-intrusive emulator functionality. This mode can be entered in three different ways:

- Setting CSR[EMU] forces the processor into emulator mode. EMU is examined only if \overline{RSTI} is negated and the processor begins reset exception processing. It can be set while the processor is halted before reset exception processing begins. See Section 33.4.1.1, "CPU Halt".
- A debug interrupt always puts the processor in emulation mode when debug interrupt exception processing begins.
- Setting CSR[TRC] forces the processor into emulation mode when trace exception processing begins.

While operating in emulation mode, the processor exhibits the following properties:

- All interrupts are ignored, including level-7 interrupts.
- If CSR[MAP] is set, all caching of memory and the SRAM module are disabled. All memory accesses are forced into a specially mapped address space signaled by TT equals 0x2, TM equals 0x5, or 0x6. This includes stack frame writes and vector fetch for the exception that forced entry into this mode.

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The RTE instruction exits emulation mode. The processor status output port provides a unique encoding for emulator mode entry (0xD) and exit (0x7).

33.4.3 Concurrent BDM and Processor Operation

The debug module supports concurrent operation of the processor and most BDM commands. BDM commands may be executed while the processor is running, except these following operations that access processor/memory registers:

- Read/write address and data registers
- Read/write control registers

For BDM commands that access memory, the debug module requests the processor's local bus. The processor responds by stalling the instruction fetch pipeline and waiting for current bus activity to complete before freeing the local bus for the debug module to perform its access. After the debug module bus cycle, the processor reclaims the bus.

NOTE

Breakpoint registers must be carefully configured in a development system if the processor is executing. The debug module contains no hardware interlocks, so TDR should be disabled while breakpoint registers are loaded, after which TDR can be written to define the exact trigger. This prevents spurious breakpoint triggers.

Because there are no hardware interlocks in the debug unit, no BDM operations are allowed while the CPU is writing the debug's registers (DSCLK must be inactive).

NOTE

The debug module requires the use of the internal bus to perform BDM commands. For this processor core, if the processor is executing a tight loop contained within a single aligned longword, the processor may never grant the internal bus to the debug module, for example:

```
align4
label1: nop
bra.b label1
or
align4
label2: bra.w label2
```

The processor grants the internal bus if these loops are forced across two longwords.

33.4.4 Real-Time Trace Support

Real-time trace, which defines the dynamic execution path and is also known as instruction trace, is a fundamental debug function. The ColdFire solution is to include a parallel output port providing encoded processor status and data to an external development system. This port is partitioned into two 4-bit nibbles: one nibble allows the processor to transmit processor status, (PST), and the other allows operand data to

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be displayed (debug data, DDATA). The processor status may not be related to the current bus transfer, due to the decoupling FIFOs.

External development systems can use PST outputs with an external image of the program to completely track the dynamic execution path. This tracking is complicated by any change in flow, where branch target address calculation is based on the contents of a program-visible register (variant addressing). DDATA outputs can display the target address of such instructions in sequential nibble increments across multiple processor clock cycles, as described in Section 33.4.4.1, "Begin Execution of Taken Branch (PST = 0x5)". Two 32-bit storage elements form a FIFO buffer connecting the processor's high-speed local bus to the external development system through PST[3:0] and DDATA[3:0]. The buffer captures branch target addresses and certain data values for eventual display on the DDATA port, one nibble at a time starting with the least significant bit (lsb).

Execution speed is affected only when both storage elements contain valid data to be dumped to the DDATA port. The core stalls until one FIFO entry is available.

Table 33-24 shows the encoding of these signals.

Table 33-24. Processor Status Encoding

| PST[3:0] | Definition |
|-------------|---|
| 0x0 | Continue execution. Many instructions execute in one processor cycle. If an instruction requires more clock cycles, subsequent clock cycles are indicated by driving PST outputs with this encoding. |
| 0x1 | Begin execution of one instruction. For most instructions, this encoding signals the first processor clock cycle of an instruction's execution. Certain change-of-flow opcodes, plus the PULSE and WDDATA instructions, generate different encodings. |
| 0x2 | Reserved |
| 0x3 | Entry into user-mode. Signaled after execution of the instruction that caused the ColdFire processor to enter user mode. |
| 0x4 | Begin execution of PULSE and WDDATA instructions. PULSE defines logic analyzer triggers for debug and/or performance analysis. WDDATA lets the core write any operand (byte, word, or longword) directly to the DDATA port, independent of debug module configuration. When WDDATA is executed, a value of 0x4 is signaled on the PST port, followed by the appropriate marker, and then the data transfer on the DDATA port. Transfer length depends on the WDDATA operand size. |
| 0x5 | Begin execution of taken branch or SYNC_PC command issued. For some opcodes, a branch target address may be displayed on DDATA depending on the CSR settings. CSR also controls the number of address bytes displayed, indicated by the PST marker value preceding the DDATA nibble that begins the data output. See Section 33.4.4.1, "Begin Execution of Taken Branch (PST = 0x5)". Also indicates that the SYNC_PC command has been issued. |
| 0x6 | Reserved |
| 0x7 | Begin execution of return from exception (RTE) instruction. |
| 0x8- 0xB | Indicates the number of bytes to be displayed on the DDATA port on subsequent clock cycles. The value is driven onto the PST port one PSTCLK cycle before the data is displayed on DDATA. 0x8 Begin 1-byte transfer on DDATA. 0x9 Begin 2-byte transfer on DDATA. 0xA Begin 3-byte transfer on DDATA. 0xB Begin 4-byte transfer on DDATA. |

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Table 33-24. Processor Status Encoding (continued)

| PST[3:0] | Definition |
|----------|--|
| 0xC | Normal exception processing. Exceptions that enter emulation mode (debug interrupt or optionally trace) generate a different encoding, as described below. Because the 0xC encoding defines a multiple-cycle mode, PST outputs are driven with 0xC until exception processing completes. |
| 0xD | Emulator mode exception processing. Displayed during emulation mode (debug interrupt or optionally trace). Because this encoding defines a multiple-cycle mode, PST outputs are driven with 0xD until exception processing completes. |
| 0xE | Processor is stopped. Appears in multiple-cycle format when the processor executes a STOP instruction. The ColdFire processor remains stopped until an interrupt occurs, thus PST outputs display 0xE until the stopped mode is exited. |
| 0xF | Processor is halted. Because this encoding defines a multiple-cycle mode, the PST outputs display 0xF until the processor is restarted or reset. See Section 33.4.1.1, "CPU Halt". |

33.4.4.1 Begin Execution of Taken Branch (PST = 0x5)

PST is 0x5 when a taken branch is executed. For some opcodes, a branch target address may be displayed on DDATA depending on the CSR settings. CSR also controls the number of address bytes displayed, which is indicated by the PST marker value immediately preceding the DDATA nibble that begins the data output.

Multiple byte DDATA values are displayed in least-to-most-significant order. The processor captures only those target addresses associated with taken branches that use a variant addressing mode (RTE and RTS instructions, JMP and JSR instructions using address register indirect or indexed addressing modes, and all exception vectors).

The simplest example of a branch instruction using a variant address is the compiled code for a C language case statement. Typically, the evaluation of this statement uses the variable of an expression as an index into a table of offsets, where each offset points to a unique case within the structure. For such change-of-flow operations, the ColdFire processor uses the debug pins to output the following sequence of information on two successive processor clock cycles:

- 1. Use PST (0x5) to identify that a taken branch is executed.
- 2. Signal the target address to be displayed sequentially on the DDATA pins. Encodings 0x9–0xB identify the number of bytes displayed. Using the PSTB, o
- 3. The new target address is optionally available on subsequent cycles using the DDATA port. The number of bytes of displayed on this port is configurable (2, 3, or 4 bytes, where the DDATA encoding is 0x9, 0xA, and 0xB, respectively).

Another example of a variant branch instruction would be a JMP (A0) instruction. Figure 33-43 shows the PST and DDATA outputs that indicate a JMP (A0) execution, assuming the CSR was programmed to display the lower 2 bytes of an address.

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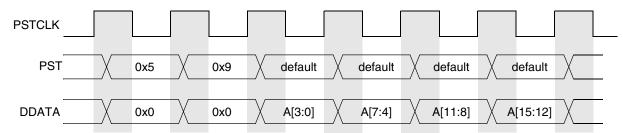


Figure 33-43. Example JMP Instruction Output on PST/DDATA

PST of 0x5 indicates a taken branch and the marker value 0x9 indicates a 2-byte address. Therefore, the subsequent 4 nibbles of DDATA display the lower two bytes of address register A0 in least-to-most-significant nibble order. The PST output after the JMP instruction completes depends on the target instruction. The PST can continue with the next instruction before the address has completely displayed on DDATA because of the DDATA FIFO. If the FIFO is full and the next instruction has captured values to display on DDATA, the pipeline stalls (PST = 0x0) until space is available in the FIFO.

33.4.5 Processor Status, Debug Data Definition

This section specifies the ColdFire processor and debug module's generation of the processor status (PST) and debug data (DDATA) output on an instruction basis. In general, the PST/DDATA output for an instruction is defined as follows:

PST = 0x1, {PST = [0x89B], DDATA = operand}

where the {...} definition is optional operand information defined by the setting of the CSR.

The CSR provides capabilities to display operands based on reference type (read, write, or both). A PST value {0x8, 0x9, or 0xB} identifies the size and presence of valid data to follow on the DDATA output {1, 2, or 4 bytes}. Additionally, for certain change-of-flow branch instructions, CSR[BTB] provides the capability to display the target instruction address on the DDATA output {2, 3, or 4 bytes} using a PST value of {0x9, 0xA, or 0xB}. Addresses use the markers x0D, x0E, or 0xF to store 2, 3, or 4 bytes of address packets with address shifted right by 1 bit.

33.4.5.1 User Instruction Set

Table 33-25 shows the PST/DDATA specification for user-mode instructions. Rn represents any {Dn, An} register. In this definition, the y suffix generally denotes the source, and x denotes the destination operand. For a given instruction, the optional operand data is displayed only for those effective addresses referencing memory. The DD nomenclature refers to the DDATA outputs.

 Instruction
 Operand Syntax
 PST/DDATA

 add.I
 <ea>y,Dx
 PST = 0x1, {PST = 0xB, DD = source operand}

 add.I
 Dy,<ea>x
 PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination}

 adda.I
 <ea>y,Ax
 PST = 0x1, {PST = 0xB, DD = source operand}

Table 33-25. PST/DDATA Specification for User-Mode Instructions

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Table 33-25. PST/DDATA Specification for User-Mode Instructions (continued)

| Instruction | Operand Syntax | PST/DDATA |
|-------------|----------------------------|--|
| addi.l | # <data>,Dx</data> | PST = 0x1 |
| addq.l | # <data>,<ea>x</ea></data> | PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} |
| addx.l | Dy,Dx | PST = 0x1 |
| and.l | <ea>y,Dx</ea> | PST = 0x1, {PST = 0xB, DD = source operand} |
| and.l | Dy, <ea>x</ea> | PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} |
| andi.l | # <data>,Dx</data> | PST = 0x1 |
| asl.l | {Dy,# <data>},Dx</data> | PST = 0x1 |
| asr.l | {Dy,# <data>},Dx</data> | PST = 0x1 |
| bcc.{b,w} | | if taken, then PST = 0x5, else PST = 0x1 |
| bchg.{b,l} | # <data>,<ea>x</ea></data> | PST = 0x1, {PST = 0x8, DD = source}, {PST = 0x8, DD = destination} |
| bchg.{b,l} | Dy, <ea>x</ea> | PST = 0x1, {PST = 0x8, DD = source}, {PST = 0x8, DD = destination} |
| bclr.{b,l} | # <data>,<ea>x</ea></data> | PST = 0x1, {PST = 0x8, DD = source}, {PST = 0x8, DD = destination} |
| bclr.{b,l} | Dy, <ea>x</ea> | PST = 0x1, {PST = 0x8, DD = source}, {PST = 0x8, DD = destination} |
| bitrev.l | Dx | PST = 0x1 |
| bra.{b,w} | | PST = 0x5 |
| bset.{b,l} | # <data>,<ea>x</ea></data> | PST = 0x1, {PST = 0x8, DD = source}, {PST = 0x8, DD = destination} |
| bset.{b,l} | Dy, <ea>x</ea> | PST = 0x1, {PST = 0x8, DD = source}, {PST = 0x8, DD = destination} |
| bsr.{b,w} | | PST = 0x5, {PST = 0xB, DD = destination operand} |
| btst.{b,l} | # <data>,<ea>x</ea></data> | PST = 0x1, {PST = 0x8, DD = source operand} |
| btst.{b,l} | Dy, <ea>x</ea> | PST = 0x1, {PST = 0x8, DD = source operand} |
| byterev.l | Dx | PST = 0x1 |
| clr.b | <ea>x</ea> | PST = 0x1, {PST = 0x8, DD = destination operand} |
| clr.l | <ea>x</ea> | PST = 0x1, {PST = 0xB, DD = destination operand} |
| clr.w | <ea>x</ea> | PST = 0x1, {PST = 0x9, DD = destination operand} |
| cmp.l | <ea>y,Dx</ea> | PST = 0x1, {PST = 0xB, DD = source operand} |
| cmpa.l | <ea>y,Ax</ea> | PST = 0x1, {PST = 0xB, DD = source operand} |
| cmpi.l | # <data>,Dx</data> | PST = 0x1 |
| divs.I | <ea>y,Dx</ea> | PST = 0x1, {PST = 0xB, DD = source operand} |
| divs.w | <ea>y,Dx</ea> | PST = 0x1, {PST = 0x9, DD = source operand} |
| divu.l | <ea>y,Dx</ea> | PST = 0x1, {PST = 0xB, DD = source operand} |
| divu.w | <ea>y,Dx</ea> | PST = 0x1, {PST = 0x9, DD = source operand} |
| eor.l | Dy, <ea>x</ea> | PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} |
| eori.l | # <data>,Dx</data> | PST = 0x1 |

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Table 33-25. PST/DDATA Specification for User-Mode Instructions (continued)

| ext.I Dx PST = 0x1 ext.W DX PST = 0x1 extb.I DX PST = 0x1 illegal PST = 0x1 jmp <ea>y PST = 0x5, [PST = [0x9AB], DD = target address), [PST = 0x8, DD = destination operand]² jsr <ea>y PST = 0x5, [PST = 0x8, DD = destination operand]² lea.I <ea>y,Ax PST = 0x1 link.w Ay#-displacement> PST = 0x1, [PST = 0xB, DD = destination operand] isr.I [Dy,#-data>],Dx PST = 0x1 isr.I [Dy,#-data>],Dx PST = 0x1 isr.I [Dy,#-data>],Dx PST = 0x1 move.b <ea>y,<ea>x PST = 0x1, [PST = 0x8, DD = source], [PST = 0x8, DD = destination] move.w ca>y,<ea>x PST = 0x1, [PST = 0x9, DD = source], [PST = 0x9, DD = destination] move.w (Dy,#-data>],CCR PST = 0x1 move.w [Dy,#-data>],CCR PST = 0x1 move.w [Dy,#-data>],CCR PST = 0x1 move.w [Dy,#-data>],Ax PST = 0x1, [PST = 0x8, DD = source] move.u [Dy,#-data>],Ax PST = 0x1, [PST = 0x8, DD =</ea></ea></ea></ea></ea></ea> | Instruction | Operand Syntax | PST/DDATA |
|---|-------------|------------------------------------|--|
| PST = 0x1 PST = 0x1 | ext.l | Dx | PST = 0x1 |
| PST = 0x1 | ext.w | Dx | PST = 0x1 |
| PST = 0x5, (PST = [0x9AB], DD = target address) ² | extb.l | Dx | PST = 0x1 |
| PST = 0x5, [PST = [0x9AB], DD = target address], PST = 0xB, DD = destination operand] ² lea.l <ea>y,Ax PST = 0x1 link.w Ay,#<displacement> PST = 0x1, [PST = 0xB, DD = destination operand] lst.l [Dy,#<data>],Dx PST = 0x1 lsr.l [Dy,#<data>],Dx PST = 0x1 lsr.l [Dy,#<data>],Dx PST = 0x1 lsr.l (Dy,#<data>],Dx PST = 0x1 lsr.l (Dy,#<data>],Dx PST = 0x1 move.b <ea>y,<ea>x PST = 0x1, [PST = 0xB, DD = source], [PST = 0xB, DD = destination] move.w <ea>x PST = 0x1, [PST = 0xB, DD = source], [PST = 0xB, DD = destination] move.w CCR,Dx PST = 0x1 move.w (Dy,#<data>],CCR PST = 0x1 movea.l <ea>y,Ax PST = 0x1, [PST = 0xB, DD = source] movea.l <ea>y,Ax PST = 0x1, [PST = 0xB, DD = source] movea.w <ea>y,Ax PST = 0x1, [PST = 0xB, DD = source] movem.l #ilst,<ea>x PST = 0x1, [PST = 0xB, DD = source] movem.l #<data>,Dx PST = 0x1 moveq.l #<data>,Dx PST = 0x1 muls.l <ea>y,Dx PST = 0x1, [PST = 0xB, DD = source operand] muls.w <ea>y,Dx PST = 0x1, [PST = 0xB, DD = source operand] mulu.w <ea>y,Dx PST = 0x1, [PST = 0xB, DD = source operand] mulu.w <ea>y,Dx PST = 0x1, [PST = 0xB, DD = source operand] mulu.w <ea>y,Dx PST = 0x1, [PST = 0xB, DD = source operand] mulu.w <ea>y,Dx PST = 0x1, [PST = 0xB, DD = source operand] mulu.w <ea>y,Dx PST = 0x1, [PST = 0xB, DD = source operand] mulu.w <ea>y,Dx PST = 0x1, [PST = 0xB, DD = source operand] mop PST = 0x1 nop PST = 0x1 not.l Dx PST = 0x1 or.l <ea>y,Dx PST = 0x1, [PST = 0xB, DD = source operand] or.l 9y,ea>x PST = 0x1 PST = 0x1 or.l 9y,ea>x PST = 0x1 FST = 0x1 or.l 9y,ea>x PST = 0x1 or.l 9y,ea</ea></ea></ea></ea></ea></ea></ea></ea></ea></data></data></ea></ea></ea></ea></data></ea></ea></ea></data></data></data></data></data></displacement></ea> | illegal | | $PST = 0x1^{1}$ |
| PST = 0xB, DD = destination operand] ² lea.l | jmp | <ea>y</ea> | PST = 0x5, {PST = [0x9AB], DD = target address} ² |
| Inik.w | jsr | <ea>y</ea> | |
| IsI. | lea.l | <ea>y,Ax</ea> | PST = 0x1 |
| Isr. | link.w | Ay,# <displacement></displacement> | PST = 0x1, {PST = 0xB, DD = destination operand} |
| Move.b | Isl.I | {Dy,# <data>},Dx</data> | PST = 0x1 |
| move.I <a>y,<a>x PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} move.w <a>y,<a>x PST = 0x1, {PST = 0x9, DD = source}, {PST = 0x9, DD = destination} move.w CCR,Dx PST = 0x1 move.w {Dy,#<data>},CCR PST = 0x1 movea.l <a>y,Ax PST = 0x1, {PST = 0xB, DD = source} movea.w <a>y,Ax PST = 0x1, {PST = 0x9, DD = source} movem.l #list,<a>x PST = 0x1, {PST = 0xB, DD = destination},³ movem.l <a>y,Hist PST = 0x1, {PST = 0xB, DD = source},³ muls.l <a>y,Dx PST = 0x1 muls.w <a>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} mulu.l <a>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} mulu.w <a>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} meg.l Dx PST = 0x1 neg.l Dx PST = 0x1 nop PST = 0x1 not.l Qx PST = 0x1 not.l Qx PST = 0x1 not.l >x PST = 0x1, {PST = 0xB, DD = source operand}<!--</td--><td>Isr.I</td><td>{Dy,#<data>},Dx</data></td><td>PST = 0x1</td></data> | Isr.I | {Dy,# <data>},Dx</data> | PST = 0x1 |
| move.w <ea>y,<ea>x PST = 0x1, {PST = 0x9, DD = source}, {PST = 0x9, DD = destination} move.w CCR,Dx PST = 0x1 move.w {Dy,#<data>},CCR PST = 0x1 movea.l <ea>y,Ax PST = 0x1, {PST = 0x8, DD = source} movea.w <ea>y,Ax PST = 0x1, {PST = 0x9, DD = source} movem.l #list,<ea>x PST = 0x1, {PST = 0x8, DD = source},³ movem.l #cab,y,Hist PST = 0x1, {PST = 0x8, DD = source},³ moveq.l #cata>,Dx PST = 0x1 muls.l <ea>y,Dx PST = 0x1, {PST = 0x8, DD = source operand} muls.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} mulu.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} mulu.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} neg.l Dx PST = 0x1 nop PST = 0x1 PST = 0x1 PST = 0x1 or.l <ea>y,Dx PST = 0x1, {PST = 0x8, DD = source operand} or.l <ea>y,Dx PST = 0x1 or.l <ea>y,Dx PST = 0x1, {PST = 0x8, DD = source operand}<</ea></ea></ea></ea></ea></ea></ea></ea></ea></ea></data></ea></ea> | move.b | <ea>y,<ea>x</ea></ea> | PST = 0x1, {PST = 0x8, DD = source}, {PST = 0x8, DD = destination} |
| move.w CCR,Dx PST = 0x1 move.w {Dy,# <data>},CCR PST = 0x1 movea.l <ea>y,Ax PST = 0x1, {PST = 0x9, DD = source} movea.w <ea>y,Ax PST = 0x1, {PST = 0x9, DD = source} movem.l #list, <ea>x PST = 0x1, {PST = 0x8, DD = destination},³ movem.l +ca>y,#list PST = 0x1, {PST = 0x8, DD = source},³ moveq.l #<data>,Dx PST = 0x1 muls.l <ea>y,Dx PST = 0x1, {PST = 0x8, DD = source operand} muls.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} mulu.l <ea>y,Dx PST = 0x1, {PST = 0x8, DD = source operand} mulu.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} neg.l Dx PST = 0x1 negx.l Dx PST = 0x1 nop PST = 0x1 not.l Dx PST = 0x1 or.l <ea>y,Dx PST = 0x1, {PST = 0x8, DD = source operand} or.l <ea>y,Dx PST = 0x1, {PST = 0x8, DD = source operand} or.l <ea>y,Dx PST = 0x1, {PST = 0x8, DD = source operand}</ea></ea></ea></ea></ea></ea></ea></data></ea></ea></ea></data> | move.l | <ea>y,<ea>x</ea></ea> | PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} |
| move.w {Dy,# <data>},CCR PST = 0x1 movea.l <ea>y,Ax PST = 0x1, {PST = 0x9, DD = source} movea.w <ea>y,Ax PST = 0x1, {PST = 0x9, DD = source} movem.l #list, <ea>x PST = 0x1, {PST = 0x8, DD = destination},³ movem.l <ea>y,#list PST = 0x1, {PST = 0x8, DD = source},³ moveq.l #<data>,Dx PST = 0x1 muls.l <ea>y,Dx PST = 0x1, {PST = 0x8, DD = source operand} muls.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} mulu.l <ea>y,Dx PST = 0x1, {PST = 0x8, DD = source operand} mulu.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} neg.l Dx PST = 0x1 negx.l Dx PST = 0x1 nop PST = 0x1 not.l Dx PST = 0x1 or.l <ea>y,Dx PST = 0x1, {PST = 0x8, DD = source operand} or.l <ea>y,Dx PST = 0x1, {PST = 0x8, DD = source operand} or.l <ea>y,Dx PST = 0x1, {PST = 0x8, DD = source operand} or.l <ea>y,Dx PST = 0x1, {PST = 0</ea></ea></ea></ea></ea></ea></ea></ea></data></ea></ea></ea></ea></data> | move.w | <ea>y,<ea>x</ea></ea> | PST = 0x1, {PST = 0x9, DD = source}, {PST = 0x9, DD = destination} |
| movea.I <ea>y,Ax PST = 0x1, {PST = 0xB, DD = source} movea.w <ea>y,Ax PST = 0x1, {PST = 0x9, DD = source} movem.I #list,<ea>x PST = 0x1, {PST = 0xB, DD = destination},³ movem.I <ea>y,#list PST = 0x1, {PST = 0xB, DD = source},³ moveq.I #<data>,Dx PST = 0x1 muls.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} muls.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} mulu.l <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} mulu.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} neg.I Dx PST = 0x1 negx.I Dx PST = 0x1 nop PST = 0x1 not.I Dx PST = 0x1 or.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} or.I #<data>,Dx PST = 0x1, {PST = 0xB, DD = source operand} or.I #<data>,Dx PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination}</data></data></ea></ea></ea></ea></ea></data></ea></ea></ea></ea> | move.w | CCR,Dx | PST = 0x1 |
| movea.w <a>y,Ax PST = 0x1, {PST = 0x9, DD = source} movem.l #list,<a>x PST = 0x1, {PST = 0xB, DD = destination},³ movem.l <a>y,#list PST = 0x1, {PST = 0xB, DD = source},³ moveq.l #<data>,Dx PST = 0x1 muls.l <a>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} muls.w <a>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} mulu.l <a>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} mulu.w <a>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} neg.l Dx PST = 0x1 negx.l Dx PST = 0x1 nop PST = 0x1 not.l Dx PST = 0x1 or.l <a>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} or.l Dy,<a>x PST = 0x1, {PST = 0xB, DD = source operand} or.l PS,<a>x PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} or.l #<data>,Dx PST = 0x1</data></data> | move.w | {Dy,# <data>},CCR</data> | PST = 0x1 |
| movem.I #list, <ea>x PST = 0x1, {PST = 0xB, DD = destination},³ movem.I <ea>y,#list PST = 0x1, {PST = 0xB, DD = source},³ moveq.I #<data>,Dx PST = 0x1 muls.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} muls.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} mulu.l <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} mulu.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} neg.I Dx PST = 0x1 negx.I Dx PST = 0x1 not.I Dx PST = 0x1 or.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} or.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} or.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} or.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} or.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} or.I #<data>,Dx PST = 0x1</data></ea></ea></ea></ea></ea></ea></ea></ea></ea></data></ea></ea> | movea.l | <ea>y,Ax</ea> | PST = 0x1, {PST = 0xB, DD = source} |
| movem.I <ea>y,#list PST = 0x1, {PST = 0xB, DD = source},³ moveq.I #<data>,Dx PST = 0x1 muls.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} muls.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} mulu.l <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} mulu.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} neg.I Dx PST = 0x1 negx.I Dx PST = 0x1 nop PST = 0x1 not.I Dx PST = 0x1 or.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} or.I Dy,<ea>x PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} ori.I #<data>,Dx PST = 0x1</data></ea></ea></ea></ea></ea></ea></data></ea> | movea.w | <ea>y,Ax</ea> | $PST = 0x1, \{PST = 0x9, DD = source\}$ |
| moveq.I # <data>,Dx PST = 0x1 muls.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} muls.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} mulu.l <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} mulu.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} neg.I Dx PST = 0x1 negx.I Dx PST = 0x1 nop PST = 0x1 not.I Dx PST = 0x1 or.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} or.I Dy,<ea>x PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} ori.I #<data>,Dx PST = 0x1</data></ea></ea></ea></ea></ea></ea></data> | movem.l | #list, <ea>x</ea> | PST = 0x1, {PST = 0xB, DD = destination}, 3 |
| muls.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} muls.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} mulu.l <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} mulu.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} neg.l Dx PST = 0x1 negx.l Dx PST = 0x1 nop PST = 0x1 not.l Dx PST = 0x1 or.l <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} or.l Dy,<ea>x PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} ori.l #<data>,Dx PST = 0x1</data></ea></ea></ea></ea></ea></ea> | movem.l | <ea>y,#list</ea> | PST = 0x1, {PST = 0xB, DD = source}, ³ |
| muls.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} mulu.l <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} mulu.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} neg.l Dx PST = 0x1 negx.l Dx PST = 0x1 nop PST = 0x1 not.l Dx PST = 0x1 or.l <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} or.l Dy,<ea>x PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} ori.l #<data>,Dx PST = 0x1</data></ea></ea></ea></ea></ea> | moveq.l | # <data>,Dx</data> | PST = 0x1 |
| mulu.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} mulu.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} neg.I Dx PST = 0x1 negx.I Dx PST = 0x1 nop PST = 0x1 not.I Dx PST = 0x1 or.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} or.I Dy,<ea>x PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} ori.I #<data>,Dx PST = 0x1</data></ea></ea></ea></ea> | muls.l | <ea>y,Dx</ea> | PST = 0x1, {PST = 0xB, DD = source operand} |
| mulu.w <ea>y,Dx PST = 0x1, {PST = 0x9, DD = source operand} neg.l Dx PST = 0x1 negx.l Dx PST = 0x1 nop PST = 0x1 not.l Dx PST = 0x1 or.l <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} or.l Dy,<ea>x PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} ori.l #<data>,Dx PST = 0x1</data></ea></ea></ea> | muls.w | <ea>y,Dx</ea> | PST = 0x1, {PST = 0x9, DD = source operand} |
| neg.I Dx PST = 0x1 negx.I Dx PST = 0x1 nop PST = 0x1 not.I Dx PST = 0x1 or.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} or.I Dy,<ea>x PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} ori.I #<data>,Dx PST = 0x1</data></ea></ea> | mulu.l | <ea>y,Dx</ea> | PST = 0x1, {PST = 0xB, DD = source operand} |
| negx.l Dx PST = 0x1 nop PST = 0x1 not.l Dx PST = 0x1 or.l <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} or.l Dy,<ea>x PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} ori.l #<data>,Dx PST = 0x1</data></ea></ea> | mulu.w | <ea>y,Dx</ea> | PST = 0x1, {PST = 0x9, DD = source operand} |
| nop PST = 0x1 not.I Dx PST = 0x1 or.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} or.I Dy,<ea>x PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} ori.I #<data>,Dx PST = 0x1</data></ea></ea> | neg.l | Dx | PST = 0x1 |
| not.I Dx PST = 0x1 or.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} or.I Dy,<ea>x PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} ori.I #<data>,Dx PST = 0x1</data></ea></ea> | negx.l | Dx | PST = 0x1 |
| or.I <ea>y,Dx PST = 0x1, {PST = 0xB, DD = source operand} or.I Dy,<ea>x PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} ori.I #<data>,Dx PST = 0x1</data></ea></ea> | nop | | PST = 0x1 |
| or.I Dy, <ea>x PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} ori.I #<data>,Dx PST = 0x1</data></ea> | not.l | Dx | PST = 0x1 |
| ori.l # <data>,Dx PST = 0x1</data> | or.l | <ea>y,Dx</ea> | PST = 0x1, {PST = 0xB, DD = source operand} |
| | or.l | Dy, <ea>x</ea> | PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} |
| pea.l | ori.l | # <data>,Dx</data> | PST = 0x1 |
| | pea.l | <ea>y</ea> | PST = 0x1, {PST = 0xB, DD = destination operand} |

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Table 33-25. PST/DDATA Specification for User-Mode Instructions (continued)

| Instruction | Operand Syntax | PST/DDATA |
|------------------------------|----------------------------|---|
| pulse | | PST = 0x4 |
| rems.l | <ea>y,Dw:Dx</ea> | PST = 0x1, {PST = 0xB, DD = source operand} |
| remu.l | <ea>y,Dw:Dx</ea> | PST = 0x1, {PST = 0xB, DD = source operand} |
| rts | | PST = 0x1, {PST = 0xB, DD = source operand}, PST = 0x5, {PST = 0x[9AB], DD = target address} |
| rts (not predicted) | | PSTDDATA = 0x1, {0xB, source operand}, 0x5, {0x[9AB], target address} |
| rts (predicted) ⁴ | | PSTDDATA = 0x1, {0xB, source operand}, 0x5 |
| scc.b | Dx | PST = 0x1 |
| sub.l | <ea>y,Dx</ea> | PST = 0x1, {PST = 0xB, DD = source operand} |
| sub.l | Dy, <ea>x</ea> | PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} |
| suba.l | <ea>y,Ax</ea> | PST = 0x1, {PST = 0xB, DD = source operand} |
| subi.l | # <data>,Dx</data> | PST = 0x1 |
| subq.l | # <data>,<ea>x</ea></data> | PST = 0x1, {PST = 0xB, DD = source}, {PST = 0xB, DD = destination} |
| subx.l | Dy,Dx | PST = 0x1 |
| swap.w | Dx | PST = 0x1 |
| tpf | | PST = 0x1 |
| tpf.I | # <data></data> | PST = 0x1 |
| tpf.w | # <data></data> | PST = 0x1 |
| trap | # <data></data> | PST = 0x1 ¹ |
| tst.b | <ea>x</ea> | PST = 0x1, {PST = 0x8, DD = source operand} |
| tst.l | <ea>y</ea> | PST = 0x1, {PST = 0xB, DD = source operand} |
| tst.w | <ea>y</ea> | PST = 0x1, {PST = 0x9, DD = source operand} |
| unlk | Ax | PST = 0x1, {PST = 0xB, DD = destination operand} |
| wddata.b | <ea>y</ea> | PST = 0x4, {PST = 0x8, DD = source operand} |
| wddata.l | <ea>y</ea> | PST = 0x4, {PST = 0xB, DD = source operand} |
| wddata.w | <ea>y</ea> | PST = 0x4, {PST = 0x9, DD = source operand} |

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During normal exception processing, the PST output is driven to a 0xC indicating the exception processing state. The exception stack write operands, as well as the vector read and target address of the exception handler may also be displayed.

The PST/DDATA specification for the reset exception is shown below:

```
Exception Processing: 

PST = 0xC, 

PST = 0x5, {PST = [0x9AB], DD = target}// handler PC
```

The initial references at address 0 and 4 are never captured nor displayed because these accesses are treated as instruction fetches.

For all types of exception processing, the PST = 0xC value is driven at all times, unless the PST output is needed for one of the optional marker values or for the taken branch indicator (0x5).

- For JMP and JSR instructions, the optional target instruction address is displayed only for those effective address fields defining variant addressing modes. This includes the following <ea>x values: (An), (d16,An), (d8,An,Xi), (d8,PC,Xi).
- For move multiple instructions (MOVEM), the processor automatically generates line-sized transfers if the operand address reaches a 0-modulo-16 boundary and there are four or more registers to be transferred. For these line-sized transfers, the operand data is never captured nor displayed, regardless of the CSR value.
 - The automatic line-sized burst transfers are provided to maximize performance during these sequential memory access operations.
- ⁴ For a predicted RTS instruction, the source operand is displayed if CSR[12], CSR[9], or CSR[8] is set.

Table 33-26 shows the PST/DDATA specification for multiply-accumulate instructions.

Table 33-26. PST/DDATA Values for User-Mode Multiply-Accumulate Instructions

| Instruction | Operand Syntax | PST/DDATA |
|-------------|-------------------------------|---|
| mac.l | Ry,Rx,ACCx | PST = 0x1 |
| mac.l | Ry,Rx, <ea>y,Rw,ACCx</ea> | PST = 0x1, {PST = 0xB, DD = source operand} |
| mac.w | Ry,Rx,ACCx | PST = 0x1 |
| mac.w | Ry,Rx,ea,Rw,ACCx | PST = 0x1, {PST = 0xB, DD = source operand} |
| move.l | {Ry,# <data>},ACCx</data> | PST = 0x1 |
| move.l | {Ry,# <data>},MACSR</data> | PST = 0x1 |
| move.l | {Ry,# <data>},MASK</data> | PST = 0x1 |
| move.l | {Ry,# <data>},ACCext01</data> | PST = 0x1 |
| move.l | {Ry,# <data>},ACCext23</data> | PST = 0x1 |
| move.l | ACCext01,Rx | PST = 0x1 |
| move.l | ACCext23,Rx | PST = 0x1 |
| move.l | ACCy,ACCx | PST = 0x1 |
| move.l | ACCy,Rx | PST = 0x1 |
| move.l | MACSR,CCR | PST = 0x1 |

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Table 33-26. PST/DDATA Values for User-Mode Multiply-Accumulate Instructions (continued)

| Instruction | Operand Syntax | PST/DDATA |
|-------------|---------------------------|---|
| move.l | MACSR,Rx | PST = 0x1 |
| move.l | MASK,Rx | PST = 0x1 |
| msac.l | Ry,Rx,ACCx | PST = 0x1 |
| msac.l | Ry,Rx, <ea>y,Rw,ACCx</ea> | PST = 0x1, {PST = 0xB, DD = source operand} |
| msac.w | Ry,Rx,ACCx | PST = 0x1 |
| msac.w | Ry,Rx, <ea>y,Rw,ACCx</ea> | PST = 0x1, {PST = 0xB, DD = source operand} |

33.4.5.2 Supervisor Instruction Set

The supervisor instruction set has complete access to the user mode instructions plus the opcodes shown below. The PST/DDATA specification for these opcodes is shown in Table 33-27.

Table 33-27. PST/DDATA Specification for Supervisor-Mode Instructions

| Instruction | Operand Syntax | PST/DDATA | |
|-------------|-------------------------|---|--|
| cpushl | (Ax) | PST = 0x1 | |
| halt | | PST = 0x1, PST = 0xF | |
| move.l | Ay,USP | PST = 0x1 | |
| move.l | USP,Ax | PST = 0x1 | |
| move.w | SR,Dx | PST = 0x1 | |
| move.w | {Dy,# <data>},SR</data> | $PST = 0x1, \{PST = 0x3\}$ | |
| movec.l | Ry,Rc | PST = 0x1 | |
| rte | | PST = 0x7, {PST = 0xB, DD = source operand}, {PST = 0x3},{ PST = 0xB, DD = source operand}, PST = 0x5, {[PST = 0x9AB], DD = target address} | |
| stldsr.w | #imm | PST = 0x1, {PST = 0xA, DD = destination operand, PST = 0x3} | |
| stop | # <data></data> | PST = 0x1, PST = 0xE | |
| wdebug.l | <ea>y</ea> | PST = 0x1, {PST = 0xB, DD = source, PST = 0xB, DD = source} | |

The move-to-SR and RTE instructions include an optional PST = 0x3 value, indicating an entry into user mode. Additionally, if the execution of a RTE instruction returns the processor to emulator mode, a multiple-cycle status of 0xD is signaled.

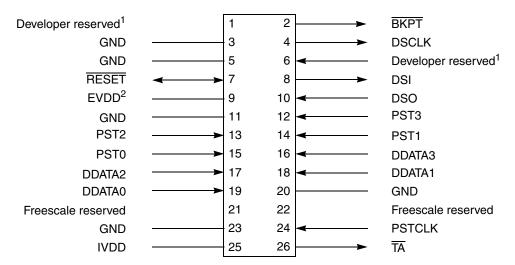
Similar to the exception processing mode, the stopped state (PST = 0xE) and the halted state (PST = 0xFF) display this status throughout the entire time the ColdFire processor is in the given mode.

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33.4.6 Freescale-Recommended BDM Pinout

The ColdFire BDM connector is a 26-pin Berg connector arranged 2 x 13 as shown below.



¹ Pins reserved for BDM developer use. ² Supplied by target

Figure 33-44. Recommended BDM Connector



Chapter 34 IEEE 1149.1 Test Access Port (JTAG)

34.1 Introduction

The Joint Test Action Group (JTAG) is a dedicated user-accessible test logic compliant with the IEEE 1149.1 standard for boundary-scan testability, which helps with system diagnostic and manufacturing testing.

This architecture provides access to all data and chip control pins from the board-edge connector through the standard four-pin test access port (TAP) and the JTAG reset pin, TRST.

34.1.1 Block Diagram

Figure 34-1 shows the block diagram of the JTAG module.

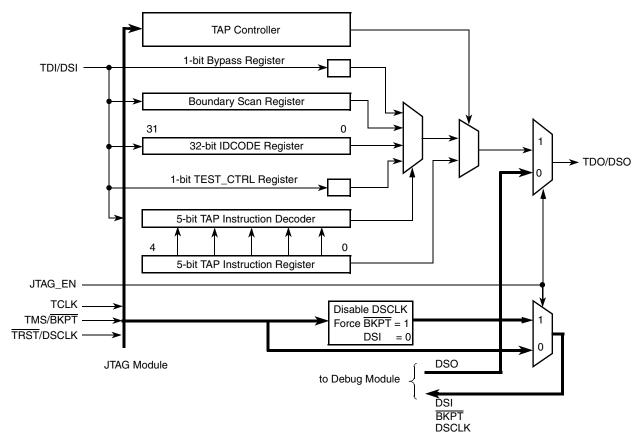


Figure 34-1. JTAG Block Diagram



34.1.2 Features

The basic features of the JTAG module are the following:

- Performs boundary-scan operations to test circuit board electrical continuity
- Bypasses instruction to reduce the shift register path to a single cell
- Sets chip output pins to safety states while executing the bypass instruction
- Samples the system pins during operation and transparently shifts out the result
- Selects between JTAG TAP controller and Background Debug Module (BDM) using a dedicated JTAG EN pin

34.1.3 Modes of Operation

The JTAG_EN pin can select between the following modes of operation:

- JTAG mode (JTAG EN = 1)
- Background debug mode (BDM)—for more information, refer to Section 33.4.1, "Background Debug Mode (BDM)"; (JTAG_EN = 0).

34.2 External Signal Description

The JTAG module has five input and one output external signals, as described in Table 34-1.

| Name | Direction | Function | Reset State | Pull up |
|------------|-----------|---|-------------|---------|
| JTAG_EN | Input | JTAG/BDM selector input | _ | _ |
| TCLK | Input | JTAG Test clock input | _ | Active |
| TMS/BKPT | Input | JTAG Test mode select / BDM Breakpoint | _ | Active |
| TDI/DSI | Input | JTAG Test data input / BDM Development serial input | _ | Active |
| TRST/DSCLK | Input | JTAG Test reset input / BDM Development serial clock | _ | Active |
| TDO/DSO | Output | JTAG Test data output / BDM Development serial output | Hi-Z / 0 | _ |

Table 34-1. Signal Properties

34.2.1 JTAG Enable (JTAG_EN)

The JTAG_EN pin selects between the debug module and JTAG. If JTAG_EN is low, the debug module is selected; if it is high, the JTAG is selected. Table 34-2 summarizes the pin function selected depending on JTAG_EN logic state.

IEEE 1149.1 Test Access Port (JTAG)

Table 34-2. Pin Function Selected

| | JTAG_EN = 0 | JTAG_EN = 1 | Pin Name |
|-----------------|----------------------------------|-----------------------------------|-------------------------------------|
| Module selected | BDM | JTAG | _ |
| Pin Function | — BKPT DSI DSO DSCLK | TCLK TMS TDI TDO TRST | TCLK BKPT DSI DSO DSCLK |

When one module is selected, the inputs into the other module are disabled or forced to a known logic level, as shown in Table 34-3, to disable the corresponding module.

Table 34-3. Signal State to the Disable Module

| | JTAG_EN = 0 | JTAG_EN = 1 |
|----------------|---------------------|--------------------------------------|
| Disabling JTAG | TRST = 0 TMS = 1 | _ |
| Disabling BDM | _ | Disable DSCLK DSI = 0 BKPT = 1 |

NOTE

The JTAG_EN does not support dynamic switching between JTAG and BDM modes.

34.2.2 Test Clock Input (TCLK)

The TCLK pin is a dedicated JTAG clock input to synchronize the test logic. Pulses on TCLK shift data and instructions into the TDI pin on the rising edge and out of the TDO pin on the falling edge. TCLK is independent of the processor clock. The TCLK pin has an internal pull-up resistor, and holding TCLK high or low for an indefinite period does not cause JTAG test logic to lose state information.

34.2.3 Test Mode Select/Breakpoint (TMS/BKPT)

The TMS pin is the test mode select input that sequences the TAP state machine. TMS is sampled on the rising edge of TCLK. The TMS pin has an internal pull-up resistor.

The \overline{BKPT} pin is used to request an external breakpoint. Assertion of \overline{BKPT} puts the processor into a halted state after the current instruction completes.

34.2.4 Test Data Input/Development Serial Input (TDI/DSI)

The TDI pin receives serial test and data, which is sampled on the rising edge of TCLK. Register values are shifted in least significant bit (lsb) first. The TDI pin has an internal pull-up resistor.

The DSI pin provides data input for the debug module serial communication port.

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Test Reset/Development Serial Clock (TRST/DSCLK) 34.2.5

The TRST pin is an active low asynchronous reset input with an internal pull-up resistor that forces the TAP controller to the test-logic-reset state.

The DSCLK pin clocks the serial communication port to the debug module. Maximum frequency is 1/5 the processor clock speed. At the rising edge of DSCLK, data input on DSI is sampled and DSO changes state.

34.2.6 Test Data Output/Development Serial Output (TDO/DSO)

The TDO pin is the lsb-first data output. Data is clocked out of TDO on the falling edge of TCLK. TDO is tri-stateable and actively driven in the shift-IR and shift-DR controller states.

The DSO pin provides serial output data in BDM mode.

34.3 Memory Map/Register Definition

The JTAG module registers are not memory mapped and are only accessible through the TDO/DSO pin. All registers described below are shift-in and parallel load.

Instruction Shift Register (IR) 34.3.1

The JTAG module uses a 4-bit shift register with no parity. The IR transfers its value to a parallel hold register and applies an instruction on the falling edge of TCLK when the TAP state machine is in the update-IR state. To load an instruction into the shift portion of the IR, place the serial data on the TDI pin before each rising edge of TCLK. The msb of the IR is the bit closest to the TDI pin, and the lsb is the bit closest to the TDO pin. See Section 34.4.3, "JTAG Instructions" for a list of possible instruction codes.

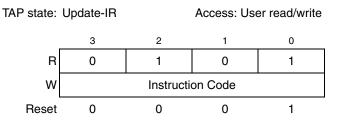


Figure 34-2. 4-Bit Instruction Register (IR)

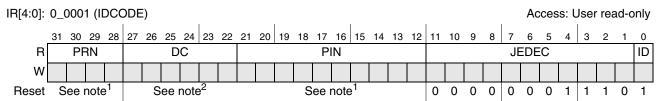
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IEEE 1149.1 Test Access Port (JTAG)

34.3.2 IDCODE Register

The IDCODE is a read-only register; its value is chip dependent. For more information, see Section 34.4.3.1, "IDCODE Instruction".



The reset values for PRN and PIN are device-dependent.

Figure 34-3. IDCODE Register

Table 34-4. IDCODE Field Descriptions

| Field | Description |
|---------------|---|
| 31–28 PRN | Part revision number. Indicate the revision number of the device. |
| 27–22 DC | Freescale design center number. |
| 21–12 PIN | Part identification number. Indicate the device number. |
| 11–1 JEDEC | Joint Electron Device Engineering Council ID bits. Indicate the reduced JEDEC ID for Freescale (0x0E). |
| 0 ID | IDCODE register ID. This bit is set to 1 to identify the register as the IDCODE register and not the bypass register according to the IEEE standard 1149.1. |

34.3.3 Bypass Register

The bypass register is a single-bit shift register path from TDI to TDO when the BYPASS instruction is selected.

34.3.4 JTAG_CFM_CLKDIV Register

The JTAG_CFM_CLKDIV register is a 7-bit clock divider for the CFM that is used with the LOCKOUT_RECOVERY instruction. It controls the period of the clock used for timed events in the CFM erase algorithm. The JTAG_CFM_CLKDIV register must be loaded before the lockout sequence can begin.

34.3.5 TEST_CTRL Register

The TEST_CTRL register is a 3-bit shift register path from TDI to TDO when the ENABLE_TEST_CTRL instruction is selected. The TEST_CTRL transfers its value to a parallel hold register on the rising edge of TCLK when the TAP state machine is in the update-DR state.

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² Varies, depending on design center location.



Boundary Scan Register 34.3.6

The boundary scan register is connected between TDI and TDO when the EXTEST or SAMPLE/PRELOAD instruction is selected. It captures input pin data, forces fixed values on output pins, and selects a logic value and direction for bidirectional pins or high impedance for tri-stated pins.

The boundary scan register contains bits for bonded-out and non bonded-out signals, excluding JTAG signals, analog signals, power supplies, compliance enable pins, and clock signals.

34.4 **Functional Description**

34.4.1 JTAG Module

The JTAG module consists of a TAP controller state machine, which is responsible for generating all control signals that execute the JTAG instructions and read/write data registers.

TAP Controller 34.4.2

The TAP controller is a state machine that changes state based on the sequence of logical values on the TMS pin. Figure 34-4 shows the machine's states. The value shown next to each state is the value of the TMS signal sampled on the rising edge of the TCLK signal.

Asserting the TRST signal asynchronously resets the TAP controller to the test-logic-reset state. As Figure 34-4 shows, holding TMS at logic 1 while clocking TCLK through at least five rising edges also causes the state machine to enter the test-logic-reset state, whatever the initial state.

IEEE 1149.1 Test Access Port (JTAG)

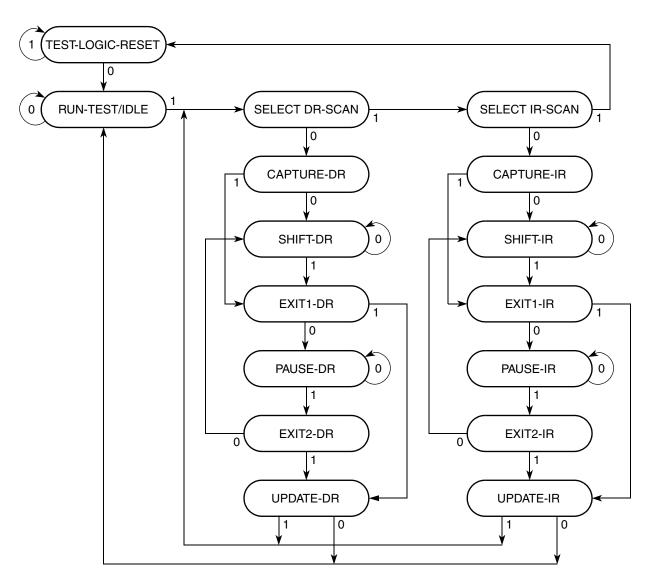


Figure 34-4. TAP Controller State Machine Flow

34.4.3 JTAG Instructions

Table 34-5 describes public and private instructions.

Table 34-5. JTAG Instructions

| Instruction | IR[3:0] | Instruction Summary |
|----------------|---------|---|
| EXTEST | 0000 | Selects boundary scan register while applying fixed values to output pins and asserting functional reset |
| IDCODE | 0001 | Selects IDCODE register for shift |
| SAMPLE/PRELOAD | 0010 | Selects boundary scan register for shifting, sampling, and preloading without disturbing functional operation |



| Instruction | IR[3:0] | Instruction Summary |
|------------------|-------------------------|--|
| TEST_LEAKAGE | 0101 | Selects bypass register while tri-stating all output pins and assert to high the jtag_leakage signal |
| ENABLE_TEST_CTRL | 0110 | Selects TEST_CTRL register |
| HIGHZ | 1001 | Selects bypass register while tri-stating all output pins and asserting functional reset |
| LOCKOUT_RECOVERY | 1011 | Allows for the erase of the TFM flash when the part is secure |
| CLAMP | 1100 | Selects bypass while applying fixed values to output pins and asserting functional reset |
| BYPASS | 1111 | Selects bypass register for data operations |
| Reserved | all others ¹ | Decoded to select bypass register |

Table 34-5. JTAG Instructions (continued)

34.4.3.1 IDCODE Instruction

The IDCODE instruction selects the 32-bit IDCODE register for connection as a shift path between the TDI and TDO pin. This instruction allows interrogation of the MCU to determine its version number and other part identification data. The shift register lsb is forced to logic 1 on the rising edge of TCLK following entry into the capture-DR state. Therefore, the first bit to be shifted out after selecting the IDCODE register is always a logic 1. The remaining 31 bits are also forced to fixed values on the rising edge of TCLK following entry into the capture-DR state.

IDCODE is the default instruction placed into the instruction register when the TAP resets. Thus, after a TAP reset, the IDCODE register is selected automatically.

34.4.3.2 SAMPLE/PRELOAD Instruction

The SAMPLE/PRELOAD instruction has two functions:

• SAMPLE - obtain a sample of the system data and control signals present at the MCU input pins and before the boundary scan cell at the output pins. This sampling occurs on the rising edge of TCLK in the capture-DR state when the IR contains the \$2 opcode. The sampled data is accessible by shifting it through the boundary scan register to the TDO output by using the shift-DR state. The data capture and the shift operation are transparent to system operation.

NOTE

External synchronization is required to achieve meaningful results because there is no internal synchronization between TCLK and the system clock.

 PRELOAD - initialize the boundary scan register update cells before selecting EXTEST or CLAMP. This is achieved by ignoring the data shifting out on the TDO pin and shifting in initialization data. The update-DR state and the falling edge of TCLK can then transfer this data to the update cells. The data is applied to the external output pins by the EXTEST or CLAMP instruction.

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Freescale reserves the right to change the decoding of the unused opcodes in the future.



IEEE 1149.1 Test Access Port (JTAG)

34.4.3.3 EXTEST Instruction

The external test (EXTEST) instruction selects the boundary scan register. It forces all output pins and bidirectional pins configured as outputs to the values preloaded with the SAMPLE/PRELOAD instruction and held in the boundary scan update registers. EXTEST can also configure the direction of bidirectional pins and establish high-impedance states on some pins. EXTEST asserts internal reset for the MCU system logic to force a predictable internal state while performing external boundary scan operations.

34.4.3.4 TEST LEAKAGE Instruction

The TEST_LEAKAGE instruction forces the jtag_leakage output signal to high. It is intended to tri-state all output pad buffers and disable all of the part's pad input buffers except TEST and TRST. The jtag_leakage signal is asserted at the rising edge of TCLK when the TAP controller transitions from update-IR to run-test/idle state. After asserted, the part disables the TCLK, TMS, and TDI inputs into JTAG and forces these JTAG inputs to logic 1. The TAP controller remains in the run-test/idle state until the TRST input is asserted (logic 0).

34.4.3.5 ENABLE TEST CTRL Instruction

The ENABLE_TEST_CTRL instruction selects a 3-bit shift register (TEST_CTRL) for connection as a shift path between the TDI and TDO pin. When the user transitions the TAP controller to the UPDATE_DR state, the register transfers its value to a parallel hold register. It allows the control chip to test functions independent of the JTAG TAP controller state.

34.4.3.6 HIGHZ Instruction

The HIGHZ instruction eliminates the need to backdrive the output pins during circuit-board testing. HIGHZ turns off all output drivers, including the 2-state drivers, and selects the bypass register. HIGHZ also asserts internal reset for the MCU system logic to force a predictable internal state.

34.4.3.7 LOCKOUT_RECOVERY Instruction

If a user inadvertently enables security on a MCU, the LOCKOUT_RECOVERY instruction allows the disabling of security by the complete erasure of the internal flash contents including the configuration field. This does not compromise security as the entire contents of the user's secured code stored in flash gets erased before security is disabled on the MCU on the next reset or power-up sequence.

The LOCKOUT_RECOVERY instruction selects a 7-bit shift register for connection as a shift path between the TDI pin and the TDO pin. When the user transitions the TAP controller to the UPDATE-DR state, the 7-bit shift register is loaded into the 7-bit JTAG_TFM_CLKDIV register and this value is output to the TFM's clock divider circuit. When the user transitions the TAP controller to the RUN-TEST/IDLE state, the erase signal to the TFM asserts and the lockout sequence starts. The controller must remain in that state until the erase sequence has completed. After the lockout recovery sequence has completed, the user must reset the JTAG TAP controller and the MCU to return to normal operation.

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34.4.3.8 CLAMP Instruction

The CLAMP instruction selects the bypass register and asserts internal reset while simultaneously forcing all output pins and bidirectional pins configured as outputs to the fixed values that are preloaded and held in the boundary scan update register. CLAMP enhances test efficiency by reducing the overall shift path to a single bit (the bypass register) while conducting an EXTEST type of instruction through the boundary scan register.

34.4.3.9 BYPASS Instruction

The BYPASS instruction selects the bypass register, creating a single-bit shift register path from the TDI pin to the TDO pin. BYPASS enhances test efficiency by reducing the overall shift path when a device other than the ColdFire processor is the device under test on a board design with multiple chips on the overall boundary scan chain. The shift register lsb is forced to logic 0 on the rising edge of TCLK after entry into the capture-DR state. Therefore, the first bit shifted out after selecting the bypass register is always logic 0. This differentiates parts that support an IDCODE register from parts that support only the bypass register.

34.5 Initialization/Application Information

34.5.1 Restrictions

The test logic is a static logic design, and TCLK can be stopped in a high or low state without loss of data. However, the system clock is not synchronized to TCLK internally. Any mixed operation using the test logic and system functional logic requires external synchronization.

Using the EXTEST instruction requires a circuit-board test environment that avoids device-destructive configurations in which MCU output drivers are enabled into actively driven networks.

Low-power stop mode considerations:

- The TAP controller must be in the test-logic-reset state to enter or remain in the low-power stop mode. Leaving the test-logic-reset state negates the ability to achieve low-power, but does not otherwise affect device functionality.
- The TCLK input is not blocked in low-power stop mode. To consume minimal power, the TCLK input should be externally connected to V_{DD}.
- The TMS, TDI, and \overline{TRST} pins include on-chip pull-up resistors. For minimal power consumption in low-power stop mode, these three pins should be connected to V_{DD} or left unconnected.

34.5.2 Nonscan Chain Operation

Keeping the TAP controller in the test-logic-reset state ensures that the scan chain test logic is transparent to the system logic. It is recommended that TMS, TDI, TCLK, and \overline{TRST} be pulled up. \overline{TRST} could be connected to ground. However, because there is a pull-up on \overline{TRST} , some amount of current results. The internal power-on reset input initializes the TAP controller to the test-logic-reset state on power-up without asserting \overline{TRST} .



Appendix A Revision History

This appendix lists major changes between versions of the MCF52259 document.

A.1 Changes Between Rev. 3 and Rev. 4

Table A-1. MCF52259 Rev. 3 to Rev. 4 Changes

| Chapter | Description |
|--------------|--|
| Overview | Updated Section 1.5 Features |
| Clock Module | Updated Section 7.2 Features Updated Table: Clocking modes in Section 7.3.5 Updated Section 7.5: Clock module block diagram |
| QSPI | Updated QMR register with a NOTE |
| FlexCAN | Updated Table: CANMCR field description (Field 27) Updated Table: CANCTRL field description (Field 31-24) Added Section: Arbitration and Matching Timing |

A.2 Changes Between Rev. 2 and Rev. 3

Table A-2. MCF52259 Rev. 2 to Rev. 3 Changes

| Chapter | Description |
|--|--|
| Overview | Updated Orderable Part Numbers table. |
| Signal Descriptions | Updated Pin Functions table. |
| Clock Module | Recreated clocking diagram. |
| Power Management | Updated PPMRL and PPMRH registers for missing bits. |
| Real-Time Clock | Added reference to Real Time Clock Signals section. |
| Static RAM (SRAM) | Added "16 KB of the 64 KB RAM is powered up during standby mode, and retains its contents." note. |
| General Purpose I/O Module | Added PHTHPAR register bit representation. |
| System Control Module (SCM) | Updated CWCR[CWRI] bit description. |
| Mini-FlexBus | Updated CSCRn[MUX] bit description. |
| Analog-to-Digit al Converter (ADC) | Corrected the unit of ADC clocks in ADC Sample Conversion section. Updated equation in CTRL2[DIV]. |
| Pulse Width Modulation (PWM) | Updated PWM CTL[CON67] bit description. |

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Revision History

A.3 Changes Between Rev. 1 and Rev. 2

Table A-3. MCF52259 Rev. 1 to Rev. 2 Changes

| Chapter | Description |
|---------------------------------------|---|
| Overview | Updated Table 1-2, added new part numbers. Added Table 1-3 for system memory map. Updated 144 LQFP pin-out diagram. |
| Signal Descriptions | Updated Table 2-1, added slew rate column, updated derive strength, pull-up/pull-down values, JTAG pin alternate functions, removed Wired/OR control column, and reordered AN[7:0] list of pin numbers for 144 LQFP and 100 LQFP. |
| Real Time Clock (RTC) | Updated Table 9-14 for RTCGOCNT [31:0] value for 1 Hz. |
| Chip Configuration Module (CCM) | Updated Table 13-7 for part numbers. |
| GPIO | Added CLKOUTPAR, clarifiedd PSRR, PSRRL, PSRRH, PDSR, PDSRL, and PDSRH registers . |
| Mini-FlexBus | Added software configurations limitation for GPIOs in mini-FlexdBus. |
| Fast Ethernet Controller (FEC) | Included MIB block information. |
| Pulse Width Modulator (PWM) | Marked all PWM registers as Supervisor Read/Write. |

A.4 Changes Between Rev. 0 and Rev. 1

Table A-4. MCF52259 Rev. 0 to Rev. 1 Changes

| Chapter | Description |
|---|--|
| Overview | Changed a sentence in the section Block Diagram from "The superset device in the MCF52259 family comes in a 100-lead leaded quad flat package (LQFP)" to "The superset device in the MCF52259 family comes in a 144-lead low-profile quad flat package (LQFP), or a 144-lead molded array process ball grid array (MAPBGA)" |
| Signal Descriptions | In the table USB Module Signals, added a description for USB_VBUSD Removed the diagram Suggested connection scheme for Power and Ground Updated the table Mini-FlexBus Signals |
| ColdFire Core | In the figure D0 Hardware Configuration Info , updated information for bit 10 |
| Cryptographic Acceleration Unit (CAU) | In the section Introduction, changed "message digest" to "hashing" |



Table A-4. MCF52259 Rev. 0 to Rev. 1 Changes (continued)

| Chapter | Description |
|---|---|
| Clock Module | In the table CCHR Field Descriptions, changed "system clock" to "PLL reference clock" In the table BWCR Field Descriptions, changed the bit assignment of BWDSEL from 3 to 0 Added the section Clock Mode Selection (CLKMOD[1:0]) Updated the footnote of the figure Real-Time Clock Control Register (RTCCR) Added the figure Clock Module Block Diagram Updated the reset values of the figure Real-Time Clock Control Register (RTCCR) In the section s, changed "2- to 8-MHz reference crystal oscillator for normal PLL mode" to "2- to 10-MHz reference crystal oscillator for normal PLL mode" In the section Clock Control High Register (CCHR), changed "above 2 MHz and below 8 MHz" to "that is from 2 MHz to 10 MHz" In the section RTC Mode, changed "32 kHz to 38.4 kHz" to "32 kHz to 40 kHz" In the table RTCCR Field Descriptions, updated the description of field 6 In the figure Clock Control High Register (CCHR), updated the reset values |
| Backup Watchdog Timer (BWT) Module | In the section Overview , changed "down-counter" to "up-counter" |
| Real-Time Clock | Updated the footnotes to the figures RTC Hours and Minutes Counter Register (HOURMIN) and RTC Seconds Counter Register (SECONDS) |
| Power Management | Updated the table Power Management Memory Map Updated the tables PPMRL[CDn] Assignments and IPSBMT Field Description Updated the figure IPS Bus Timeout Monitor (IPSBMT) Register Updated the table PPMRH[CDn] Assignments to include CAN information In the table Power Management Memory Map, changed the PPMRL reset value from 0x0000_0000 to 0x0040_0004 |
| Reset Controller Module | In the table Reset Status Register (RSR), updated the information for bit 7 |
| Static RAM (SRAM) | In the table RAMBAR Field Descriptions , updated the SPV row In the section Overview , changed "DMA or FEC access" to "DMA, FEC, or USB access" In the section s , added the bullet "Backdoor port for access by other system masters (DMA, FEC, and USB)" |
| Chip Configuration Module (CCM) | Added the table Chip Identification Numbers In the section Chip Configuration Extended Register (CCE), updated the explanations of the values of 0 and 1 Updated the figure Chip Configuration Extended Register (CCE) |
| System Control Module (SCM) | Updated Overview section of the chapter In the table CWCR Field Description, updated the CWRI row Updated the Overview sub-section of the Internal Bus Arbitration section In the table Peripheral Access Control Registers (PACRs), updated the PACR4 and PACR5 rows |



Revision History

Table A-4. MCF52259 Rev. 0 to Rev. 1 Changes (continued)

| Chapter | Description |
|---|---|
| Interrupt Controller Module | In the section 68K/ColdFire Interrupt Architecture Overview, changed "10:8 of the machine's status register (SR)" to "10:8 of the core's status register (SR)," and updated the instructions for finding the ColdFire Family Programmer's Reference Manual In the table IPRLn Field Descriptions, updated the Field 0 row In the section Interrupt Mask Registers (IMRHn, IMRLn), changed "A write that sets bit 0 of the IMR forces" to "A write that sets bit 0 of the IMRLn forces" In the table INTFRCLn Field Descriptions, updated the Field 0 row In the table IACKLPRn Field Descriptions, changed "Represents the interrupt level currently being acknowledged." to "Represents the interrupt level of the interrupt currently being acknowledged." In the table ICRnx Field Descriptions, updated the Field 7–6 and 2–0 IP rows Updated the table Interrupt Controller Memory Map Updated the figure Interrupt Force Register Low (INTFRCLn) |
| ColdFire Flash Module (CFM) | In the figure CFM Clock Select Register (CFMCLKSEL), clarified the footnote to indicate that the CLKSEL bits are not modifiable In the section Overview, changed "2-kByte logical pages" to "4-kByte logical pages" Updated the figure CFMPROT Protection Diagram |
| Mini-FlexBus | In the figure Basic Read-Bus Cycle (No Wait States), updated the bottom signal In the section Overview, changed "Gate-array logic" to "Programmable logic devices," and removed the sentence "Chip-select FB_CS0 can be dedicated to 8-bit boot memory access." In the section Modes of Operation, updated the bulleted list In the table CSCRn Field Descriptions, updated the MUX bit description Updated the section 8- and 16-bit Port Sizing |
| Universal Serial Bus, OTG Capable Controller | In the figure OTG Interrupt Status Register, changed the reset value of the LINE_STATE_CHG bit from 0 to 1 In the figure Interrupt Status Register (OTG_STAT), changed the reset value of the LINE_STATE_STABLE bit from 0 to 1 In the figure Interrupt Status Register (INT_STAT), changed the reset value of the SLEEP bit from 0 to 1 In the figure Control Register, changed the reset values of the JSTATE and SE0 bits from 0 to 1, respectively In the figure USB Control Register, changed the reset value of the SUSP bit from 0 to 1 In the table USB_CTRL Field Descriptions, updated CLK_SRC description for the bit value 01 |
| EzPort | Updated the feature section |
| DMA Timers (DTIM0-DTIM 3) | In the section s , updated the maximum timeout period information In the table DTMR <i>n</i> Field Descriptions , added the sentence "Avoid setting CLK when RST is" to the CLK row description |
| Queued Serial Peripheral Interface (QSPI) | Updated the Introduction section's text In the section External Signal Description, updated the final paragraph In the table QDLYR Field Descriptions, updated the 15 SPE row Updated the table QDR Field Descriptions Updated the second paragraph of the section QSPI RAM Updated the first paragraph of the section Receive RAM In the sections s and External Signal Description, changed "15 devices" references to "7 devices" In the section External Signal Description, changed "QSPI_CS[3:0]" to "QSPI_CS[3, 2, 0]" and changed "4-to-16 decoder" to "3-to-8 decoder" Updated the figure Command RAM Registers (QCR0-QCR15) In the table QCR0-QCR15 Field Descriptions, updated the QSPI_CS description |
| Pulse-Width Modulation (PWM) Module | In the table PWM Memory Map, added a table row for PWM PCM mode enable Register (PCME) Added the section PWM PCM Mode Enable Register (PCME) |

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MB91F579CHSPMC1-GSE1 MB91F528UWCEQ-GSE2 MB91F528USCPMC-GSE2 R5F104LJAFBV0 SPC5606BK0VLQ6

R5S726B0D216FP#V0 SPC564A70L7CFAY TC299TX128F300NBCKXUMA1 SPC58EC80E1Q0C0Y R5S72691W266FP#V0

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